

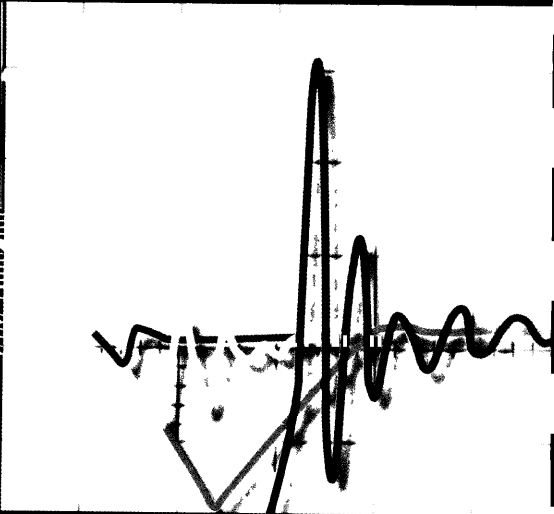
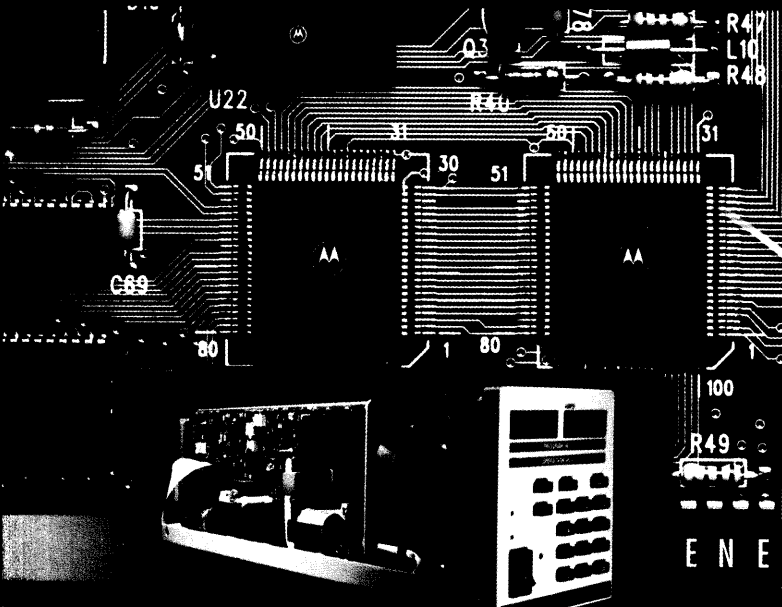


MOTOROLA

DL151/D
REV 2

Rectifier

Device Data



ENERGY EFFICIENCY

AC - DC

Low VF Schottky - Ultrafast & Ga




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Rectifier Device Data

This book presents technical data for Motorola's broad line of rectifiers. Complete specifications are provided in the form of data sheets and accompanying selection guides provide a quick comparison of characteristics to simplify the task of choosing the best device for a circuit.

The information in this book has been carefully checked and is believed to be accurate; however, no responsibility is assumed for inaccuracies.

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DATA CLASSIFICATION

PRODUCT PREVIEW

Data sheets herein contain information on a product under development. Motorola reserves the right to change or discontinue these products without notice.

ADVANCED INFORMATION

Data sheets herein contain information on new products. Specifications and information are subject to change without notice.

FORMAL

For a fully characterized device there must be devices in the warehouse and price authorization.

DESIGNER'S

The Designer's Data Sheet permits the design of most circuits entirely from the information presented. Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

MOTOROLA DEVICE CLASSIFICATIONS

In an effort to provide up-to-date information to the customer regarding the status of any given device, Motorola has classified all devices into three categories: "Preferred" products, "Current" products and "Not Recommended for New Design" products.

PREFERRED PRODUCTS

A Preferred Type is a device which is recommended as a first choice for future use. These devices are "preferred" by virtue of their performance, price, functionality, or combination of attributes which offer the overall "best" value to the customer. This category contains both advanced and mature devices which will remain available for the foreseeable future.

"Preferred Devices" are identified in the Selector Guide Section and the Data Sheet Sections.

CURRENT PRODUCTS

Device types identified as "current" may not be a first choice for **new** designs, but will continue to be available because of the popularity and/or standardization or volume usage in current production designs. These products can be acceptable for new designs but the preferred types are considered better alternatives for long term usage.

Any device that has not been identified as a "preferred device" is a "current" device.

NOT RECOMMENDED FOR NEW DESIGN PRODUCTS

Products designated as "Not Recommended for New Design" have become obsolete as dictated by poor market acceptance, or a technology or package that is reaching the end of its life cycle. Devices in this category have an uncertain future and do not represent a good selection for new device designs or long term usage.

The RF Device Data book does not contain any "Not Recommended for New Design" devices.

Designer's, MEGAHERTZ, POWERTAP, SCANSWITCH, SWITCHMODE and Surmetic are trademarks of Motorola Inc. Thermal Clad is a trademark of the Bergquist Company.

Section 1

Index and Cross Reference

Index and Cross Reference

The following table represents an index and cross reference guide for all rectifier devices which are either manufactured directly by Motorola or for which Motorola manufactures a suitable equivalent. Where the Motorola part number differs from the industry part number, the Motorola device is a form, fit and function replacement for the industry type number — however, subtle differences in characteristics and/or specifications may exist. The part numbers listed in this Cross Reference are in computer sort.

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10CTF30		MUR840	4-56	1N4246GP		1N4004	5-2
10CTF40		MUR840	4-56	1N4247		1N4005	5-2
10DL1		1N4934	5-3	1N4247GP		1N4005	5-2
10DL2		1N4935	5-3	1N4248		1N4006	5-2
10TQ030		MBR1045	3-86	1N4248GP		1N4006	5-2
10TQ035		MBR1045	3-86	1N4249		1N4007	5-2
10TQ040		MBR1045	3-86	1N4249GP		1N4007	5-2
10TQ045		MBR1045	3-86	1N4933	1N4933		5-3
11DQ03		1N5818	3-38	1N4933GP		1N4933	5-3
11DQ04		1N5819	3-38	1N4934	1N4934		5-3
11DQ05		MBR160	3-43	1N4934GP		1N4934	5-3
11DQ06		MBR160	3-43	1N4935	1N4935		5-3
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11DQ10		MBR1100	3-46	1N4936	1N4936		5-3
12CTQ030	MBR1545CT		3-64	1N4936GP		1N4936	5-3
12CTQ035	MBR1545CT		3-64	1N4937	1N4937		5-3
12CTQ040	MBR1545CT		3-64	1N4937GP		1N4937	5-3
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Section 2

Selector Guide

In Brief . . .

Continuing investment in research and development for discrete products has created a rectifier manufacturing facility that matches the precision and versatility of the most advanced integrated circuits. As a result, Motorola's silicon rectifiers span all high tech applications with quality levels capable of passing the most stringent environmental tests . . . including those for automotive under-hood applications.

Product Highlights:

- Surface Mount Devices — A major thrust has been the development and introduction of a broad range of power rectifiers, Schottky and Ultrafast, 1/2 amp to 25 amp, 15 to 600 volts.
- Application Specific Rectifiers —
 - MEGAHERTZ™ series for high frequency power supplies and power factor correction.
 - Schottky rectifiers having lower forward voltage drop (0.3 to 0.6 volts) for use in low voltage SMPS outputs and as “OR”ing diodes.
 - Automotive transient suppressors.
- Ultrafast rectifiers having reverse recovery times as low as 25 ns to complement the Schottky devices for higher voltage requirements in high frequency applications.
- A wide variety of package options to match virtually any potential requirement.

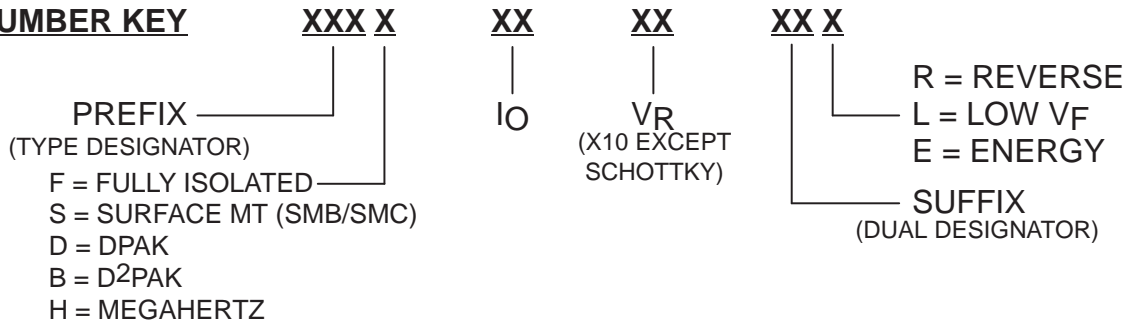
The rectifier selector section that follows has generally been arranged by package and technology. The individual tables have been sorted by voltage and current with the package types for the devices listed shown above each table. The Application Specific Rectifiers are also included in their respective tables.

Motorola's commitment to Six-Sigma is showing its worth. Refined processes no longer produce fallout as such and therefore only **Motorola Preferred Devices** are listed in the tables. The non-preferred devices will continue to be offered, but customers are encouraged to begin designing using the preferred types.

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RECTIFIER NUMBERING SYSTEM

PART NUMBER KEY



PREFIX KEY

MUR = MOTOROLA ULTRA FAST RECTIFIER
 MBR = MOTOROLA (SCHOTTKY) BARRIER RECTIFIER
 MR = MOTOROLA STANDARD & FAST RECOVERY

SUFFIX KEY

CT = CENTER TAP (DUAL) TO-220, TO-3, POWERTAP
 PT = CENTER TAP (DUAL) TO-218 PACKAGE
 WT = CENTER TAP (DUAL) TO-247 / TO-3P

EXAMPLE:	MUR	30	20	WT
	MOTOROLA ULTRAFAST	30 AMP	200 V	CENTER TAP (DUAL) TO-247
EXAMPLE:	MBR	30	45	WT
	MOTOROLA SCHOTTKY	30 AMP	45 V	CENTER TAP (DUAL) TO-247

Application Specific Rectifiers

The focus for Rectifier Products continues to be on Schottky and Ultrafast technologies, with process and packaging improvements to achieve greater efficiency in high frequency switching power supplies, and high current

mainframe supplies. Our new product thrust is intended to be more “application specific” than in the past, while continuing to strive for broad market acceptance.

Table 1. Low V_F Schottky Rectifiers

State of the art geometry is used in low V_F Schottky devices for improved efficiency in low voltage, high frequency switching power supplies, free-wheeling diodes, polarity protection diodes and “OR”ing diodes.

Device	I_O Amps	V_{RRM} (Volts)	V_F @ Rated I_O and Temperature Volts (Max)	I_R @ Rated V_{RRM} mAmps (Max)	Package	Page
<i>MBR0520LT1</i>	0.5	20	0.33	0.25	SOD-123	3-2
<i>MBRS130LT3</i>	1	30	0.395	1	SMB	3-7
<i>MBRD835L</i>	8	35	0.41	1.4	DPAK	3-21
<i>MBRD1035CTL</i>	10	35	0.41	6	DPAK	—
<i>MBR2030CTL</i>	20	30	0.48	5	TO-220	3-66
<i>MBRB2535CTL</i>	25	35	0.41	10	D ² PAK	3-34
<i>MBR2535CTL</i>	25	35	0.41	5	TO-220	3-78
<i>MBRB2515L</i>	25	15	0.42	15	D ² PAK	3-32
<i>MBR2515L</i>	25	15	0.42	15	TO-220	3-77
<i>MBRB3030CTL</i>	30	30	0.58	5	D ² PAK	—
<i>MBR4015LWT</i>	40	15	0.42	5	TO-247	3-129
<i>MBR5025L</i>	50	25	0.58	0.5	TO-218 TYPE	3-125
<i>MBR6030L</i>	60	30	0.38	50	DO-203AB	3-160
<i>MBRP20030CTL</i>	200	30	0.39	5	POWERTAP	3-181
<i>MBRP60035CTL</i>	600	35	0.50	10	POWERTAP	3-184

Table 2. MEGAHERTZ Rectifiers

MEGAHERTZ Series — This group of ultrafast rectifiers is designed to provide improved efficiency in very high frequency switching power supplies and for use in power factor correction circuits.

Device	I_O Amps	V_{RRM} (Volts)	Maximum		t_{rr} (Nanosecond)	Page
			V_F @ Rated I_O and Temp. (Volts)	I_R @ Rated V_{RRM} (mAmps)		
<i>MURH840CT</i>	8	400	1.7	0.01	28	4-41
<i>MURH860CT</i>	8	600	2.0	0.01	28	4-44

Table 3. SCANSWITCH Rectifiers

These ultrafast rectifiers are designed for improved performance in very high resolution monitors and work stations where forward recovery time (t_{fr}) and high voltage (1200–1500 volts) are primary considerations.

Device	I_O Amps	V_{RRM} (Volts)	Maximum		V_{RFM} (6) (Volts)	Page
			t_{fr} (Nanoseconds)	t_{rr} (Nanoseconds)		
<i>MUR5150E</i>	5	1500	225	175	20	4-54
<i>MUR880E</i>	8	800	—	75	—	—
<i>MUR10120E</i>	10	1200	175	175	14	4-65
<i>MUR10150E</i>	10	1500	175	175	16	4-68

Table 4. Automotive Transient Suppressors

Automotive transient suppressors are designed for protection against over-voltage conditions in the auto electrical system including the “LOAD DUMP” phenomenon that occurs when the battery open circuits while the car is running.

Device	I_O Amps	V_{RRM} (Volts)	$V_{(BR)}$ (Volts)	I_{RSM} (7) (Amps)	T (°C)	Page
<i>MR2535L</i>	35	20	24–32	110	175	5-19

(6) V_{RFM} = Maximum Transient Overshoot Voltage.

(7)Time constant = 10 ms, Duty Cycle ≤ 1%, $T_C = 25^\circ\text{C}$.

Devices listed in bold, italic are Motorola preferred devices.

SWITCHMODE™ Rectifiers

Schottky power rectifiers with the high speed and low forward voltage drop characteristic of Schottky's metal/silicon junctions are produced with ruggedness and temperature performance comparable to silicon-junction rectifiers. Ideal for use in low-voltage, high-frequency power supplies, and as very fast clamping diodes, these devices feature switching times less than 10 ns, and are offered in current ranges from 0.5 to 600 amperes, and reverse voltages to 200 volts.

In some current ranges, devices are available with junction temperature specifications of 125°C, 150°C and 175°C. Devices with higher T_J ratings can have significantly lower leakage currents, but higher forward-voltage specifications. These parameter tradeoffs should be considered when selecting devices for applications that can be satisfied by more than one device type number.

All devices are connected cathode-to-case or cathode-to-heatsink, where applicable. Contact your

Motorola representative for more information.

There are many other standard features in Motorola Schottky rectifiers that give added performance and reliability.

1. GUARDRINGS were pioneered by Motorola and are included in all Schottky die for reverse voltage stress protection from high rates of dv/dt to virtually eliminate the need for snubber networks. The guardring also operates like a zener and avalanches when subjected to voltage transients.

2. MOLYBDENUM DISCS on both sides of the die minimize fatigue from power cycling in all metal products. Plastic encapsulated devices have a special solder formulation for the same purpose.

3. QUALITY CONTROL monitors all critical fabrication operations and performs selected stress tests to assure constant processes. Motorola's commitment to six sigma has provided significant quality improvement.

Case 425
SOD-123



Cathode = Notch

Case 403A
SMB



Cathode = Notch

Case 403
SMC



Cathode = Notch

Table 5. Surface Mount Schottky Rectifiers

V _{RRM} (Volts)	I _O (1) (Amperes)	I _O Rating Condition	Device	Max V _F @ i _F T _C = 25°C (Volts)	I _{FSM} (Amperes)	T _J Max (°C)	Package	Page
20	0.5	T _L = 105°C	<i>MBR0520LT1</i> ★	0.310 @ 0.1 A 0.385 @ 0.5 A	5	125	SOD-123	3-2
30	0.5	T _L = 105°C	<i>MBR0530T1</i> ★	0.375 @ 0.1 A 0.430 @ 0.5 A	5	125	SOD-123	3-4
40	0.5	T _L = 110°C	<i>MBR0540T1</i> ★	0.53 @ 0.5 A	20	150	SOD-123	3-6
30	1	T _L = 120°C	<i>MBRS130LT3</i>	0.395 @ 1.0 A	40	125	SMB	3-7
40	1	T _L = 115°C	<i>MBRS140T3</i>	0.6 @ 1.0 A	40	125	SMB	3-9
100	1	T _L = 120°C	<i>MBRS1100T3</i>	0.75 @ 1.0 A	40	150	SMB	3-11
40	3	T _L = 100°C	<i>MBRS340T3</i>	0.525 @ 3.0 A	80	125	SMC	3-13
60	3	T _L = 100°C	<i>MBRS360T3</i> ★	0.74 @ 3.0 A	80	125	SMC	3-13

(1) I_O is total device current capability.

★ New Product

Devices listed in bold, italic are Motorola preferred devices.

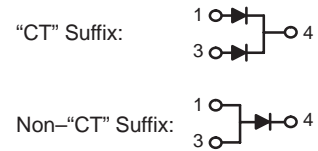
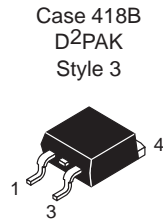
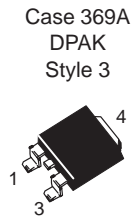


Table 5. Surface Mount Schottky Rectifiers (continued)

V _{RRM} (Volts)	I _O (1) (Amperes)	I _O Rating Condition	Device	Max V _F @ i _F T _C = 25°C (Volts)	I _{FSM} (Amperes)	T _J Max (°C)	Package	Page
40	3	T _C = 125°C	MBRD340	0.60 @ 3.0 A	75	150	DPAK	3-15
60	3	T _C = 125°C	MBRD360	0.60 @ 3.0 A	75	150	DPAK	3-15
40	6	T _C = 130°C	MBRD640CT	0.70 @ 3.0 A	75	150	DPAK	3-18
60	6	T _C = 130°C	MBRD660CT	0.70 @ 3.0 A	75	150	DPAK	3-18
35	8	T _C = 100°C	MBRD835L ★	0.40 @ 3.0 A 0.51 @ 8.0 A	100	125	DPAK	3-21
35	10	T _C = 90°C	MBRD1035CTL ★	0.49 @ 10 A	100	125	DPAK	—
45	15	T _C = 105°C	MBRB1545CT	0.84 @ 15 A	150	150	D ² PAK	3-24
60	20	T _C = 110°C	MBRB2060CT	0.95 @ 20 A	150	150	D ² PAK	3-26
100	20	T _C = 110°C	MBRB20100CT	0.85 @ 10 A 0.95 @ 20 A	150	150	D ² PAK	3-28
200	20	T _C = 125°C	MBRB20200CT ★	1.0 @ 20 A	150	150	D ² PAK	3-30
15	25	T _C = 90°C	MBRB2515L ★	0.45 @ 25 A	150	100	D ² PAK	3-32
35	25	T _C = 110°C	MBRB2535CTL	0.47 @ 12.5 A 0.55 @ 25 A	150	125	D ² PAK	3-34
45	25	T _C = 130°C	MBRB2545CT	0.82 @ 30 A	150	150	D ² PAK	3-36
30	30	T _C = 115°C	MBRB3030CT ★	0.51 @ 15 A 0.62 @ 30 A	300	150	D ² PAK	3-190
30	30	T _C = 95°C	MBRB3030CTL ★	0.45 @ 15 A 0.51 @ 30 A	150	125	D ² PAK	—
30	40	T _C = 110°C	MBRB4030 ★	0.46 @ 20 A 0.55 @ 40 A	300	150	D ² PAK	3-193

(1) I_O is total device current capability.

★ New Product

Devices listed in bold, italic are Motorola preferred devices.

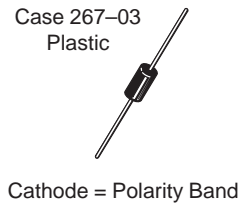
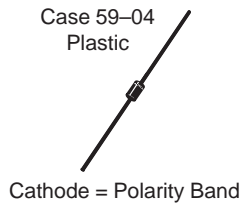
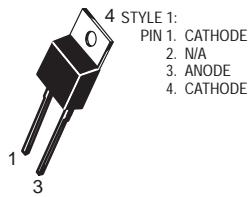


Table 6. Axial Lead Schottky Rectifiers

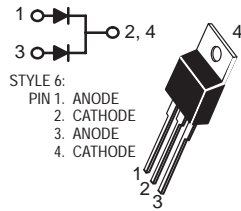
V _{RRM} (Volts)	I _O (Amperes)	I _O Rating Condition	Device	Max V _F @ i _F T _C = 25°C (Volts)	I _{FSM} (Amperes)	T _J Max (°C)	Case	Page
20	1	T _A = 55°C R _{θJA} = 80°C/W	1N5817	0.45 @ 1.0 A	25	125	59-04	3-38
30	1	T _A = 55°C R _{θJA} = 80°C/W	1N5818	0.55 @ 1.0 A	25	125	59-04	3-38
40	1	T _A = 55°C R _{θJA} = 80°C/W	1N5819	0.60 @ 1.0 A	25	125	59-04	3-38
60	1	T _A = 55°C R _{θJA} = 80°C/W	MBR160	0.75 @ 1.0 A	25	150	59-04	3-43
100	1	T _A = 120°C R _{θJA} = 50°C/W	MBR1100	0.79 @ 1.0 A	50	150	59-04	3-46
20	3	T _A = 76°C R _{θJA} = 28°C/W	1N5820	0.457 @ 3.0 A	80	125	267-03	3-49
30	3	T _A = 71°C R _{θJA} = 28°C/W	1N5821	0.500 @ 3.0 A	80	125	267-03	3-49
40	3	T _A = 61°C R _{θJA} = 28°C/W	1N5822	0.525 @ 3.0 A	80	125	267-03	3-49
40	3	T _A = 65°C R _{θJA} = 28°C/W	MBR340	0.600 @ 3.0 A	80	150	267-03	3-53
60	3	T _A = 65°C R _{θJA} = 28°C/W	MBR360	0.740 @ 3.0 A	80	150	267-03	3-53
100	3	T _A = 100°C R _{θJA} = 28°C/W	MBR3100	0.79 @ 3.0 A	150	150	267-03	3-57
20	5	T _A = 30°C R _{θJA} = 25°C/W	1N5823	0.360 @ 5.0 A	500	125	60-01	3-60
30	5	T _A = 40°C R _{θJA} = 25°C/W	1N5824	0.370 @ 5.0 A	500	125	60-01	3-60
40	5	T _A = 45°C R _{θJA} = 25°C/W	1N5825	0.380 @ 5.0 A	500	125	60-01	3-60

Devices listed in bold, italic are Motorola preferred devices.

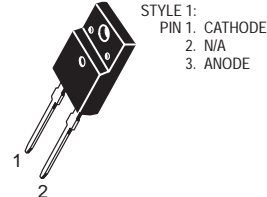
Case 221B
(TO-220AC)



Case 221A-06
(TO-220AB)



Case 221E



Case 221D

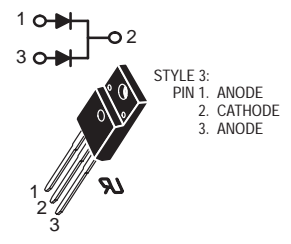


Table 7. TO-220 Type Schottky Rectifiers

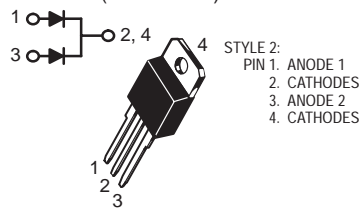
V _{RRM} (Volts)	I _O (Amperes)	I _O Rating Condition	Device	Max V _F @ i _F T _C = 25°C (Volts)	I _{FSM} (Amperes)	T _J Max (°C)	Case	Page
45	15	T _C = 105°C	MBR1545CT	0.84 @ 15 A	150	150	221A-06	3-64
30	20	T _C = 137°C	MBR2030CTL ★	0.52 @ 10 A 0.58 @ 20 A	150	150	221A-06	3-66
45	20	T _C = 135°C	MBR2045CT	0.84 @ 20 A	150	150	221A-06	3-69
60	20	T _C = 133°C	MBR2060CT	0.85 @ 10 A 0.95 @ 20 A	150	150	221A-06	3-73
100	20	T _C = 133°C	MBR20100CT	0.85 @ 10 A 0.95 @ 20 A	150	150	221A-06	3-73
200	20	T _C = 125°C	MBR20200CT	1.0 @ 20 A	150	150	221A-06	3-75
15	25	T _C = 90°C	MBR2515L ★	0.45 @ 25 A	150	100	221A-06	3-77
35	25	T _C = 95°C	MBR2535CTL ★	0.55 @ 25 A	150	125	221A-06	3-78
45	25	T _C = 130°C	MBR2545CT	0.82 @ 30 A	150	150	221A-06	3-80
45	30	T _C = 130°C	MBR3045ST ★	0.76 @ 30 A	150	150	221A-06	3-82
45	7.5	T _C = 105°C	MBR745	0.84 @ 15 A	150	150	221B	3-84
45	10	T _C = 135°C	MBR1045	0.84 @ 20 A	150	150	221B	3-86
60	10	T _C = 133°C	MBR1060	0.80 @ 10 A	150	150	221B	3-90
100	10	T _C = 133°C	MBR10100	0.80 @ 10 A	150	150	221B	3-90
45	16	T _C = 125°C	MBR1645	0.63 @ 16 A	150	150	221B	3-92
45	15	T _C = 105°C	Ⓜ MBRF1545CT ★	0.84 @ 15 A	150	150	ISOLATED 221D	3-94
45	20	T _C = 135°C	Ⓜ MBRF2045CT ★	0.84 @ 20 A	150	150	ISOLATED 221D	3-97
60	20	T _C = 133°C	Ⓜ MBRF2060CT ★	0.95 @ 20 A	150	150	ISOLATED 221D	3-100
100	20	T _C = 133°C	Ⓜ MBRF20100CT ★	0.95 @ 20 A	150	150	ISOLATED 221D	3-103
200	20	T _C = 125°C	Ⓜ MBRF20200CT ★	1.0 @ 20 A	150	150	ISOLATED 221D	3-106
45	25	T _C = 125°C	Ⓜ MBRF2545CT ★	0.82 @ 25 A	150	150	ISOLATED 221D	3-109
45	7.5	T _C = 105°C	MBRF745 ★	0.84 @ 15 A	150	150	ISOLATED 221E	3-112
45	10	T _C = 135°C	MBRF1045 ★	0.84 @ 20 A	150	150	ISOLATED 221E	3-115

Ⓜ Indicates UL Recognized — File #E69369

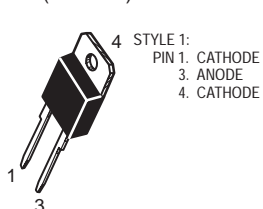
★ New Product

Devices listed in bold, italic are Motorola preferred devices.

Case 340D
(TO-218AC)



Case 340E
(TO-218)



Case 340F
(TO-247)

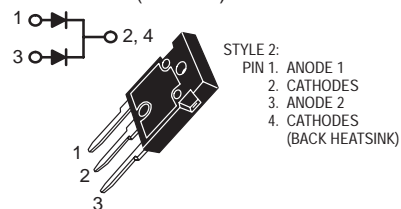


Table 8. TO-218 Types and TO-247 Schottky Rectifiers

V _{RRM} (Volts)	I _O (Amperes)	I _O Rating Condition	Device	Max V _F @ i _F T _C = 25°C (Volts)	I _{FSM} (Amperes)	T _J Max (°C)	Case	Page
45	30	T _C = 105°C	<i>MBR3045PT</i>	0.76 @ 30 A	200	150	340D	3-119
45	40	T _C = 125°C	<i>MBR4045PT</i>	0.70 @ 20 A 0.80 @ 40 A	400	150	340D	3-121
45	60	T _C = 125°C	<i>MBR6045PT</i> ★	0.62 @ 30 A 0.75 @ 60 A	500	150	340D	3-123
25	50	T _C = 125°C	<i>MBR5025L</i> ★	0.54 @ 30 A 0.62 @ 50 A	300	150	340E	3-125
45	30	T _C = 105°C	<i>MBR3045WT</i>	0.76 @ 30 A	200	150	340F	3-127
15	40	T _C = 125°C	<i>MBR4015LWT</i> ★	0.42 @ 20 A 0.50 @ 40 A	400	150	340F	3-129
45	40	T _C = 125°C	<i>MBR4045WT</i>	0.70 @ 20 A 0.80 @ 40 A	400	150	340F	3-131
45	60	T _C = 125°C	<i>MBR6045WT</i> ★	0.62 @ 30 A 0.75 @ 60 A	500	150	340F	3-133

★ New Product

Devices listed in bold, italic are Motorola preferred devices.

Case 56
(DO-203AA)



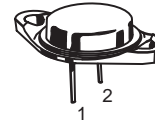
STYLE 2:
PIN 1. ANODE
2. CATHODE (CASE)

Case 257
(DO-203AB)



STYLE 2:
PIN 1. ANODE
2. CATHODE (CASE)

Case 11-03
(TO-204AA)



STYLE 4:
PIN 1. ANODE #1
2. ANODE #2
CASE. COMMON CATHODE



Table 9. TO-204AA (formerly TO-3), DO-203AA and DO-203AB (formerly DO-4 and DO-5)
Schottky Rectifier Metal Packages DEVICES NOT RECOMMENDED FOR NEW DESIGN

V _{RRM} (Volts)	I _O (Amperes)	I _O Rating Condition	Device	Max V _F @ I _F T _C = 25°C (Volts)	I _{FSM} (Amperes)	T _J Max (°C)	Case	Page
20	15	T _C = 85°C (V _R = 4 V)	1N5826	0.44 @ 15 A	500	125	56	3-135
30	15	T _C = 85°C (V _R = 6 V)	1N5827	0.47 @ 15 A	500	125	56	3-135
40	15	T _C = 85°C (V _R = 8 V)	1N5828	0.50 @ 15 A	500	125	56	3-135
20	25	T _C = 85°C (V _R = 4 V)	1N5829	0.44 @ 25 A	800	125	56	3-139
30	25	T _C = 85°C (V _R = 6 V)	1N5830	0.46 @ 25 A	800	125	56	3-139
40	25	T _C = 85°C (V _R = 8 V)	1N5831	0.48 @ 25 A	800	125	56	3-139
30	25	T _C = 70°C	1N6095	0.86 @ 78.5 A T _C = 70°C	400	125	56	3-144
40	25	T _C = 70°C	1N6096	0.86 @ 78.5 A T _C = 70°C	400	125	56	3-144
45	30	T _C = 105°C	SD41	0.55 @ 78.5 A T _C = 125°C	600	150	56	3-144
45	35	T _C = 110°C	MBR3545	0.63 @ 35 A	600	150	56	3-148
20	40	T _C = 75°C (V _R = 4 V)	1N5832	0.052 @ 40 A	800	125	257	3-152
30	40	T _C = 75°C (V _R = 6 V)	1N5833	0.55 @ 40 A	800	125	257	3-152
40	40	T _C = 75°C (V _R = 8 V)	1N5834	0.59 @ 40 A	800	125	257	3-152
30	50	T _C = 70°C	1N6097	0.86 @ 157 A T _C = 70°C	800	125	257	3-156
40	50	T _C = 70°C	1N6098	0.86 @ 157 A T _C = 70°C	800	125	257	3-156
30	60	T _C = 120°C	MBR6030L	0.42 @ 30 A 0.48 @ 60 A	1000	150	257	3-160
45	60	T _C = 90°C	SD51	0.70 @ 60 A	800	150	257	3-156
45	60	T _C = 100°C	MBR6045	0.70 @ 60 A	800	150	257	3-164
45	65	T _C = 120°C	MBR6545	0.78 @ 65 A	800	175	257	3-168
45	75	T _C = 90°C	MBR7545	0.60 @ 60 A T _C = 125°C	1000	150	257	3-172
45	80	T _C = 120°C	MBR8045	0.72 @ 80 A	1000	175	257	3-174
45	30	T _C = 105°C	MBR3045CT	0.76 @ 30 A	400	150	11-03	3-178
45	30	T _C = 105°C	SD241	0.60 @ 20 A T _C = 125°C	400	150	11-03	3-178

Devices listed in bold, italic are Motorola preferred devices.

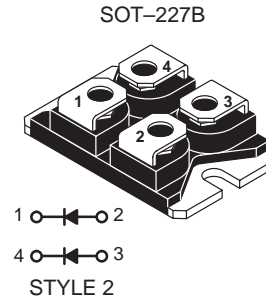
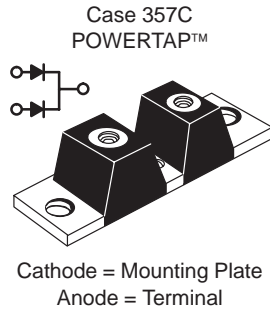


Table 10. POWER TAP II and SOT-227B Schottky Rectifiers

V _{RRM} (Volts)	I _O (1) (Amperes)	I _O Rating Condition	Device	Max V _F @ i _F T _C = 25°C (Volts)	I _{FSM} (Amperes)	T _J Max (°C)	Case	Page
30	200	T _C = 125°C	<i>MBRP20030CTL</i> ★	0.52 @ 100 A 0.60 @ 200 A	1500	150	357C	3-181
45	200	T _C = 125°C	<i>MBRP20045CT</i> ★	0.78 @ 100 A	1500	175	357C	3-182
60	200	T _C = 125°C	<i>MBRP20060CT</i> ★	0.800 @ 100 A	1500	175	357C	3-182
45	300	T _C = 120°C	<i>MBRP30045CT</i> ★	0.70 @ 150 A 0.82 @ 300 A	2500	175	357C	3-183
60	300	T _C = 120°C	<i>MBRP30060CT</i> ★	0.79 @ 150 A 0.89 @ 300 A	2500	175	357C	3-183
35	600	T _C = 100°C	<i>MBRP60035CTL</i> ★	0.57 @ 300 A	4000	150	357C	3-184
100	80	T _C = 125°C	<i>MBR240100V</i> ★	0.95 @ 40 A	600	150	SOT-227B Style 2	3-185
60	100	T _C = 125°C	<i>MBR25060V</i> ★	0.65 @ 50 A	800	150	SOT-227B Style 2	3-187
45	160	T _C = 125°C	<i>MBR28045V</i> ★	0.80 @ 80 A 1.0 @ 160 A	900	150	SOT-227B Style 2	3-188

(1) I_O is total device current capability.

All POWER TAP devices are being converted to the new, more rugged, POWER TAP II configuration beginning January 1994. Contact your Motorola representative for more details.

All SOT-227B devices have 2500 volts isolation between the heatsink and active elements.

★ New Product

Devices listed in bold, italic are Motorola preferred devices.

Ultrafast Rectifiers

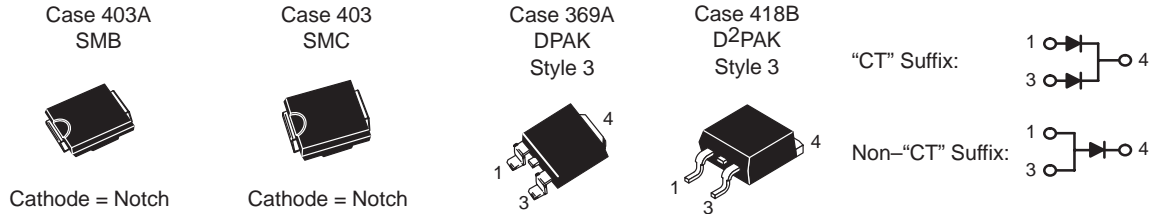


Table 11. Surface Mount Ultrafast Rectifiers

V _{RRM} (Volts)	I _O ⁽¹⁾ (Amperes)	I _O Rating Condition	Device	Max t _{rr} (ns)	Max V _F @ i _F T _C = 25°C (Volts)	I _{FSM} (Amperes)	T _J Max (°C)	Package	Page
200	1	T _L = 155°C	MURS120T3	35	0.875 @ 1.0 A	40	175	SMB	4-2
600	1	T _L = 150°C	MURS160T3	75	1.25 @ 1.0 A	35	175	SMB	4-2
200	3	T _L = 140°C	MURS320T3	35	0.875 @ 3.0 A	75	175	SMC	4-5
600	3	T _L = 130°C	MURS360T3	75	1.25 @ 3.0 A	75	175	SMC	4-5
200	3	T _L = 158°C	MURD320	35	0.95 @ 3.0 A	75	175	DPAK	4-8
200	6	T _L = 145°C	MURD620CT	35	1.0 @ 3.0 A	63	175	DPAK	4-11
400	8	T _L = 120°C	MURHB840CT ★	28	2.2 @ 4.0 A	100	175	D ² PAK	4-14
200	16	T _L = 150°C	MURB1620CT	35	0.975 @ 8.0 A	100	175	D ² PAK	4-17
600	16	T _L = 150°C	MURB1660CT	60	1.5 @ 8.0 A	100	175	D ² PAK	4-20

(1) I_O is total device current capability.

★ New Product

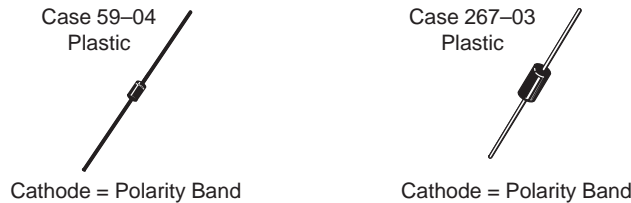


Table 12. Axial Lead Ultrafast Rectifiers

V _{RRM} (Volts)	I _O (Amperes)	I _O Rating Condition	Device	Max t _{rr} (ns)	Max V _F @ i _F T _C = 25°C (Volts)	I _{FSM} (Amperes)	T _J Max (°C)	Case	Page
200	1	T _A = 130°C R _{θJA} = 50°C/W	MUR120	25	0.875 @ 1.0 A	35	175	59-04	4-23
400	1	T _A = 120°C R _{θJA} = 50°C/W	MUR140	50	1.25 @ 1.0 A	35	175	59-04	4-23
600	1	T _A = 120°C R _{θJA} = 50°C/W	MUR160	50	1.25 @ 1.0 A	35	175	59-04	4-23
1000	1	T _A = 95°C R _{θJA} = 50°C/W	MUR1100E	75	1.75 @ 1.0 A	35	175	59-04	4-27
200	4	T _A = 80°C R _{θJA} = 28°C/W	MUR420	25	0.875 @ 3.0 A	125	175	267-03	4-31
400	4	T _A = 40°C R _{θJA} = 28°C/W	MUR440	50	1.25 @ 3.0 A	70	175	267-03	—
600	4	T _A = 40°C R _{θJA} = 28°C/W	MUR460	50	1.25 @ 3.0 A	70	175	267-03	4-31
1000	4	T _A = 35°C R _{θJA} = 28°C/W	MUR4100E	75	1.75 @ 3.0 A	70	175	267-03	4-35

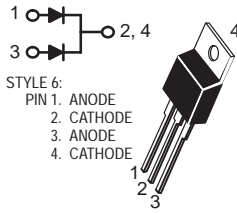
Devices listed in bold, italic are Motorola preferred devices.

Case 221B
(TO-220AC)



STYLE 1:
PIN 1. CATHODE
2. N/A
3. ANODE
4. CATHODE

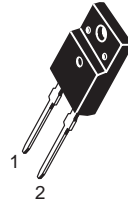
Case 221A-06
(TO-220AB)



STYLE 6:
PIN 1. ANODE
2. CATHODE
3. ANODE
4. CATHODE

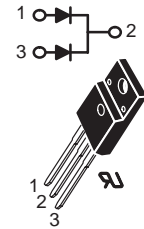
STYLE 7:
PIN 1. CATHODE
2. ANODE
3. CATHODE
4. ANODE

Case 221E





STYLE 1:
PIN 1. CATHODE
2. N/A
3. ANODE

Case 221D



STYLE 3:
PIN 1. ANODE
2. CATHODE
3. ANODE

Table 13. TO-220 Type Ultrafast Rectifiers

V _{RRM} (Volts)	I _O (Amperes)	I _O Rating Condition	Device	Max t _{rr} (ns)	Max V _F @ i _F T _C = 25°C (Volts)	I _{FSM} (Amperes)	T _J Max (°C)	Case	Page
200	6	T _C = 130°C	<i>MUR620CT</i>	35	0.975 @ 3.0 A	75	175	221A-06	4-39
400	8	T _C = 120°C	<i>MURH840CT</i>	28	2.0 @ 4.0 A	100	175	221A-06	4-41
600	8	T _C = 120°C	<i>MURH860CT</i>	35	2.8 @ 4.0 A	100	175	221A-06	4-44
200	16	T _C = 150°C	<i>MUR1620CT</i>	35	0.975 @ 8.0 A	100	175	221A-06	4-46
200	16	T _C = 160°C	<i>MUR1620CTR</i>	85	1.2 @ 8.0 A	100	175	221A-06	4-51
400	16	T _C = 150°C	<i>MUR1640CT</i>	60	1.30 @ 8.0 A	100	175	221A-06	4-46
600	16	T _C = 150°C	<i>MUR1660CT</i>	60	1.5 @ 8.0 A	100	175	221A-06	4-46
1500	5	T _C = 125°C	<i>MUR5150E</i>	175	2.4 @ 5.0 A	100	125	221B	4-54
200	8	T _C = 150°C	<i>MUR820</i>	35	0.975 @ 8.0 A	100	175	221B	4-56
400	8	T _C = 150°C	<i>MUR840</i> ★	50	1.30 @ 8.0 A	100	175	221B	4-56
600	8	T _C = 150°C	<i>MUR860</i> ★	50	1.50 @ 8.0 A	100	175	221B	4-56
800	8	T _C = 175°C	<i>MUR880E</i>	75	1.80 @ 8.0 A	100	175	221B	—
1000	8	T _C = 150°C	<i>MUR8100E</i>	75	1.80 @ 8.0 A	100	175	221B	4-61
1200	10	T _C = 125°C	<i>MUR10120E</i>	175	2.2 @ 6.5 A	100	125	221B	4-65
1500	10	T _C = 125°C	<i>MUR10150E</i>	175	2.4 @ 6.5 A	100	125	221B	4-68
200	15	T _C = 150°C	<i>MUR1520</i>	35	1.05 @ 15 A	200	175	221B	4-71
400	15	T _C = 150°C	<i>MUR1540</i>	60	1.25 @ 15 A	150	175	221B	4-71
600	15	T _C = 145°C	<i>MUR1560</i>	60	1.50 @ 15 A	150	175	221B	4-71
200	8	T _C = 150°C	<i>MURF820</i> ★	25	0.975 @ 8.0 A	100	150	ISOLATED 221E	4-76
200	16	T _C = 150°C	 <i>MURF1620CT</i> ★	25	0.975 @ 8.0 A	100	150	ISOLATED 221D	4-79
600	16	T _C = 150°C	 <i>MURF1660CT</i> ★	50	1.50 @ 8.0 A	100	150	ISOLATED 221D	4-82

 Indicates UL Recognized — File #E69369

★ New Product

Devices listed in bold, italic are Motorola preferred devices.

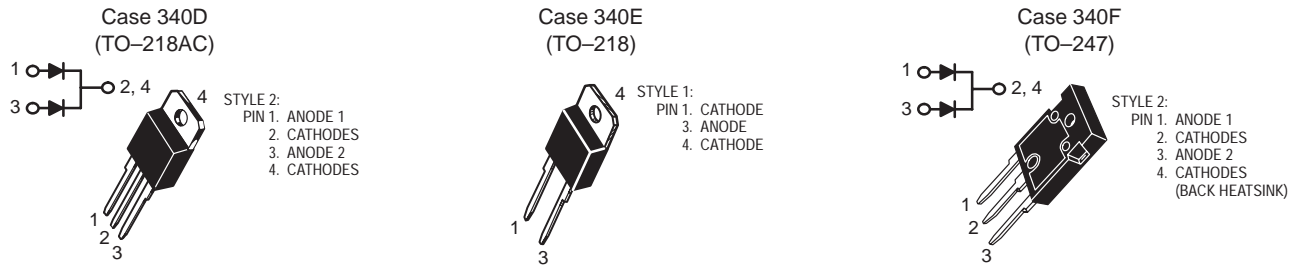


Table 14. TO-218 Types and TO-247 Ultrafast Rectifiers

V _{RRM} (Volts)	I _O (Amperes)	I _O Rating Condition	Device	Max t _{rr} (ns)	Max V _F @ i _F T _C = 25°C (Volts)	I _{FSM} (Amperes)	T _J Max (°C)	Case	Page
200	30	T _C = 145°C	<i>MUR3020WT</i>	35	1.05 @ 15 A	150	175	340F	4-85
400	30	T _C = 145°C	<i>MUR3040WT</i>	60	1.25 @ 15 A	150	175	340F	4-85
600	30	T _C = 145°C	<i>MUR3060WT</i>	60	1.70 @ 15 A	150	175	340F	4-85
200	30	T _C = 150°C	<i>MUR3020PT</i>	35	1.12 @ 15 A	200	175	340D	4-90
400	30	T _C = 150°C	<i>MUR3040PT</i>	60	1.12 @ 15 A	150	175	340D	4-90
600	30	T _C = 145°C	<i>MUR3060PT</i>	60	1.20 @ 15 A	150	175	340D	4-90
400	30	T _C = 70°C	<i>MUR3040</i> ★	100	1.5 @ 30 A	300	175	340E	4-95
800	30	T _C = 70°C	<i>MUR3080</i> ★	110	1.90 @ 30 A	300	175	340E	4-97
400	60	T _C = 70°C	<i>MUR6040</i>	100	1.50 @ 60 A	600	175	340E	4-98

★ New Product

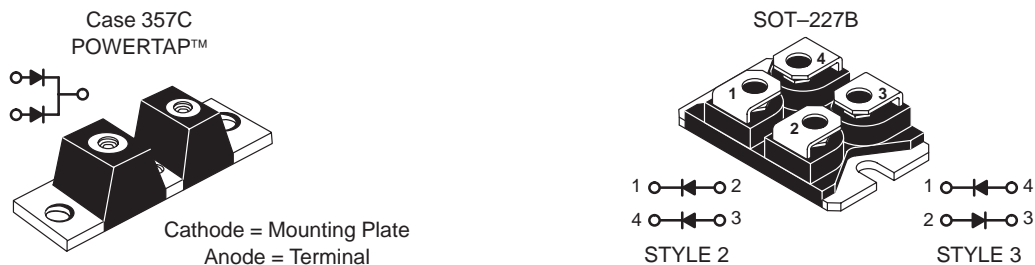


Table 15. POWEREAP II and SOT-227B Ultrafast Rectifiers

V _{RRM} (Volts)	I _O (1) (Amperes)	I _O Rating Condition	Device	Max t _{rr} (ns)	Max V _F @ i _F T _C = 25°C (Volts)	I _{FSM} (Amperes)	T _J Max (°C)	Case	Page
400	60	T _C = 60°C	<i>BYT230PIV-400M</i> ★ Ⓜ	100	1.5 @ 30 A	200	150	SOT-227B Style 3	4-100
1000	60	T _C = 50°C	<i>BYT230PIV-1000M</i> ★ Ⓜ	165	1.9 @ 30 A	200	150	SOT-227B Style 3	4-104
400	120	T _C = 80°C	<i>BYT261PIV-400M</i> ★ Ⓜ	100	1.5 @ 60 A	600	150	SOT-227B Style 2	4-108
1000	120	T _C = 60°C	<i>BYT261PIV-1000M</i> ★ Ⓜ	170	1.9 @ 60 A	400	150	SOT-227B Style 2	4-112
200	200	T _C = 130°C	<i>MURP20020CT</i> ★	50	1.00 @ 100 A	800	175	357C	4-116
400	200	T _C = 100°C	<i>MURP20040CT</i> ★	50	1.30 @ 100 A	800	175	357C	4-116

(1) I_O is total device current capability.

All POWEREAP devices are being converted to the new, more rugged, POWEREAP II configuration beginning January 1994. Contact your Motorola representative for more details.

All SOT-227B devices have 2500 volts isolation between the heatsink and active elements.

Ⓜ Indicates UL Recognized — File #E69369

★ New Product

Devices listed in bold, italic are Motorola preferred devices.

Fast Recovery Rectifiers/General-Purpose Rectifiers

Axial lead Fast Recovery Rectifiers having maximum switching times of 200 ns and low cost general purpose rectifiers are listed in the table below.

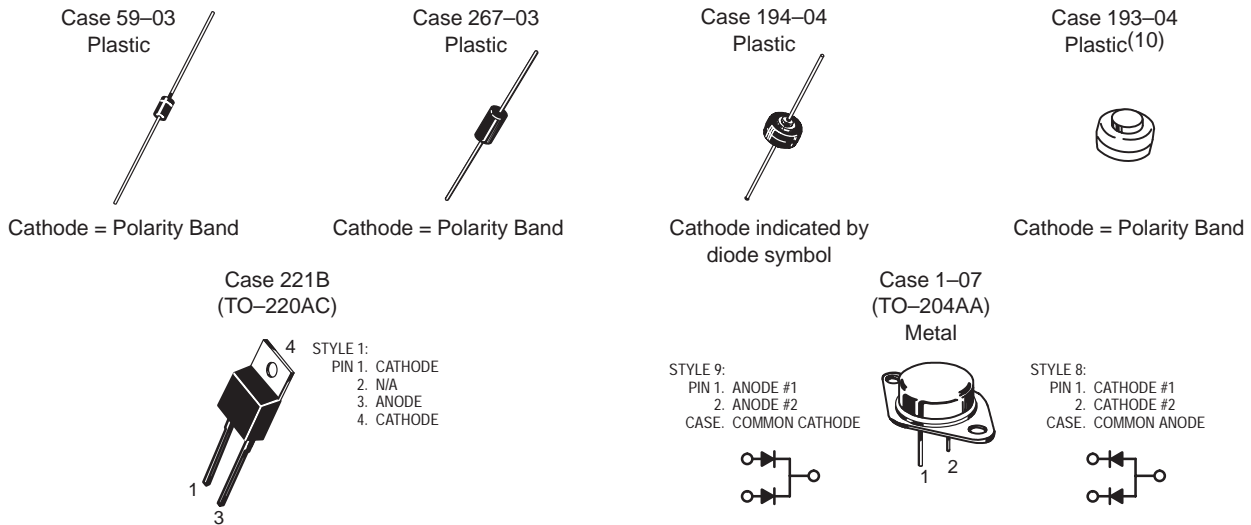


Table 16. Fast Recovery Rectifiers/General Purpose Rectifiers

V _{RRM} (Volts)	I _O (Amperes)	I _O Rating Condition	Device	Max V _F @ I _F T _J = 25°C (Volts)	Max t _{rr} (ns)	I _{FSM} (Amperes)	T _J Max (°C)	Case	Page
400	1	T _A = 75°C	1N4004	1.1 @ 1.0 A	—	30	150	59-03 ⁽³⁾	5-2
1000	1	T _A = 75°C	1N4007	1.1 @ 1.0 A	—	30	150	59-03 ⁽³⁾	5-2
200	1	T _A = 75°C	1N4935	1.2 @ 3.14 A T _J = 125°C	200	30	150	59-03 ⁽³⁾	5-3
600	1	T _A = 75°C	1N4937	1.2 @ 3.14 A T _J = 125°C	200	30	150	59-03 ⁽³⁾	5-3
400	3	T _L = 105°C	1N5404	1.2 @ 9.4 A	—	200	150	267-03	5-5
600	3	T _L = 105°C	1N5406	1.2 @ 9.4 A	—	200	150	267-03	5-5
200	3	T _A = 80°C ⁽⁸⁾	MR852	1.25 @ 3.0 A	200	100	150	267-03	5-6
600	3	T _A = 80°C ⁽⁸⁾	MR856	1.25 @ 3.0 A	200	100	150	267-03	5-6
400	6	T _A = 60°C R _{θJA} = 25°C/W	MR754	1.25 @ 100 A	—	400	175	194-04	5-8
1000	6	T _A = 60°C R _{θJA} = 25°C/W	MR760	1.25 @ 100 A	—	400	175	194-04	5-8
400	25	T _C = 150°C	MR2504	1.18 @ 78.5 A	—	400	175	193-04	5-12
1000	25	T _C = 150°C	MR2510	1.18 @ 78.5 A	—	400	175	193-04	5-12
100	30	T _C = 125°C	MR4422CTR	1.2 @ 15 A	—	400	150	1-07 Style 8	5-18
100	30	T _C = 125°C	MR4422CT	1.2 @ 15 A	—	400	150	1-07 Style 9	5-18
20	35	T _C = 150°C	MR2535L⁽¹¹⁾	1.1 @ 100 A	—	400	175	194-04	5-19

(3) Package Size: 0.120" max diameter by 0.260" length.
 (8) Must be derated for reverse power dissipation. See data sheet.
 (10) Request data sheet for mounting information.
 (11) Overvoltage Transient Suppressor: 24–32 volts avalanche voltage.

Devices listed in bold, italic are Motorola preferred devices.

Section 3

Schottky Data Sheets

Surface Mount Schottky Power Rectifier

Plastic SOD-123 Package

MBR0520LT1
MBR0520LT3

Motorola Preferred Devices

**SCHOTTKY BARRIER
RECTIFIER
0.5 AMPERES
20 VOLTS**



**CASE 425-04, Style 1
SOD-123**

The Schottky Power Rectifier employs the Schottky Barrier principle with a barrier metal that produces optimal forward voltage drop–reverse current tradeoff. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system. This package provides an alternative to the leadless 34 MELF style package. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Very Low Forward Voltage (0.38 V Max @ 0.5 A, 25°C)
- 125°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Package Designed for Optimal Automated Board Assembly

Mechanical Characteristics

- Reel Options: MBR0520LT1 = 3,000 per 7" reel/8 mm tape.
MBR0520LT3 = 10,000 per 13" reel/8 mm tape.
- Device Marking: B2
- Polarity Designator: Cathode Band
- Weight: 11.7 mg (approximately)
- Case: Epoxy, Molded
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	20	Volts
Average Rectified Forward Current (Rated V_R) $T_L = 90^\circ\text{C}$	$I_{F(AV)}$	0.5	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	5.5	Amps
Storage Temperature	T_{stg}	-65 to +125	°C
Operating Junction Temperature	T_J	-65 to +125	°C
Voltage Rate of Change (Rated V_R)	dv/dt	1000	V/ μs

THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Ambient (1)	$R_{\theta JA}$	340	°C/W
Thermal Resistance — Junction to Lead	$R_{\theta JL}$	150	°C/W

ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (2) ($i_F = 0.1$ Amps) ($i_F = 0.5$ Amps)	V_F	$T_J = 25^\circ\text{C}$	$T_J = 100^\circ\text{C}$	Volts
		0.300 0.385	0.220 0.330	
Maximum Instantaneous Reverse Current (2) ($V_R = 10$ V) (Rated dc Voltage = 20 V)	I_R	$T_J = 25^\circ\text{C}$	$T_J = 100^\circ\text{C}$	mA
		75 μA 250 μA	5 mA 8 mA	

(1) FR-4 or FR-5 = 3.5 x 1.5 inches using the Motorola minimum recommended footprint.

(2) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2\%$.

Preferred devices are Motorola recommended choices for future use and best overall value.

MBR0520LT1

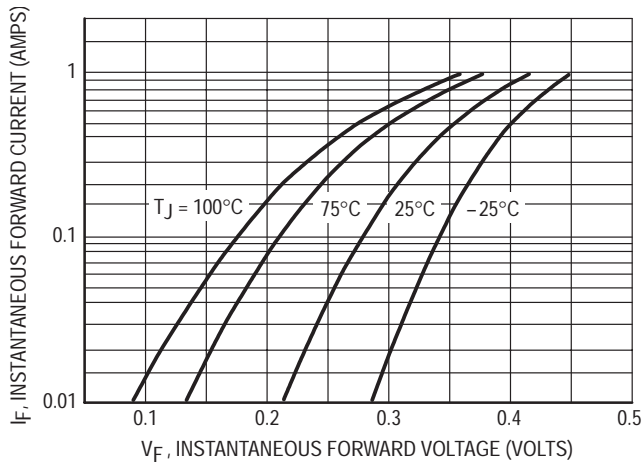


Figure 1. Typical Forward Voltage

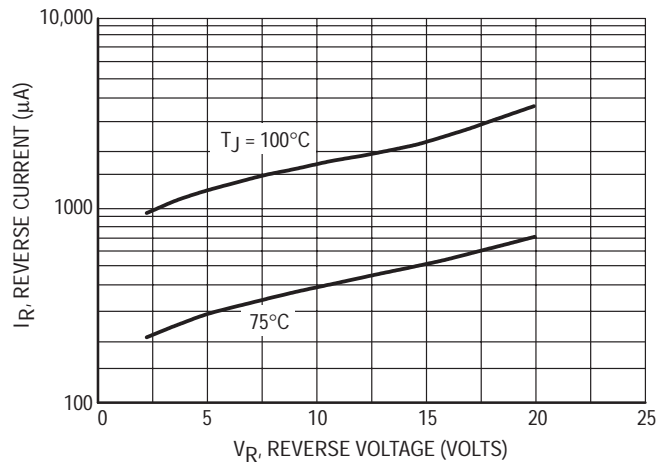


Figure 2. Typical Reverse Current

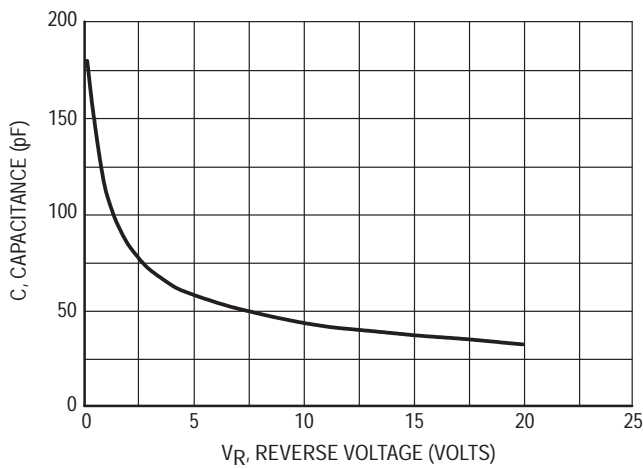


Figure 3. Typical Capacitance

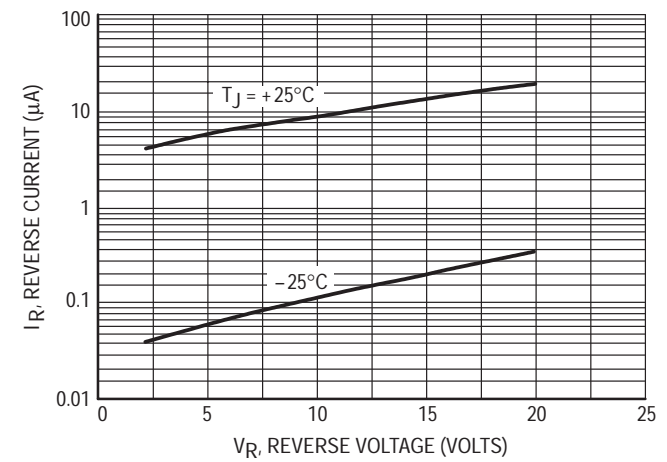


Figure 4. Typical Reverse Current

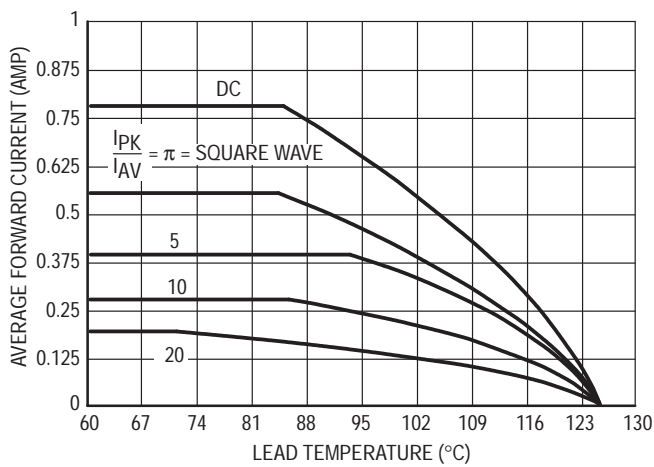


Figure 5. Current Derating (Lead)

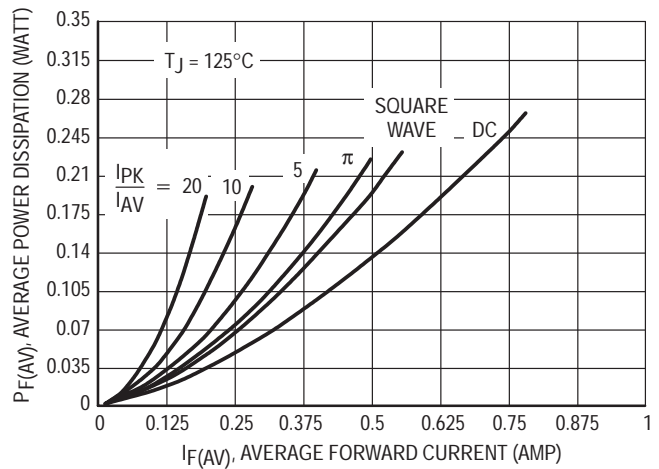


Figure 6. Power Dissipation

Surface Mount Schottky Power Rectifier

Plastic SOD-123 Package

MBR0530T1
MBR0530T3

Motorola Preferred Devices

**SCHOTTKY BARRIER
RECTIFIER
0.5 AMPERES
30 VOLTS**



**CASE 425-04
SOD-123**

... using the Schottky Barrier principle with a large area metal-to-silicon power diode. Ideally suited for low voltage, high frequency rectification or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system. This package also provides an easy to work with alternative to leadless 34 package style. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Low Forward Voltage
- 125°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Package Designed for Optimal Automated Board Assembly

Mechanical Characteristics

- Reel Options: MBR0530T1 = 3,000 per 7" reel/8 mm tape
MBR0530T3 = 10,000 per 13" reel/8 mm tape
- Device Marking: B3
- Polarity Designator: Cathode Band
- Weight: 11.7 mg (approximately)
- Case: Epoxy, Molded
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	30	Volts
Average Rectified Forward Current (Rated V_R) $T_L = 100^\circ\text{C}$	$I_{F(AV)}$	0.5	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	5.5	Amps
Storage Temperature	T_{stg}	-65 to +125	°C
Operating Junction Temperature	T_J	-65 to +125	°C
Voltage Rate of Change (Rated V_R)	dv/dt	1000	V/ μs

THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Ambient (1)	$R_{\theta JA}$	340	°C/W
Thermal Resistance — Junction to Lead (1)	$R_{\theta JL}$	150	°C/W

ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (2) ($i_F = 0.1$ Amps, $T_J = 25^\circ\text{C}$) ($i_F = 0.5$ Amps, $T_J = 25^\circ\text{C}$)	V_F	0.375 0.43	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_C = 25^\circ\text{C}$) ($V_R = 15$ V, $T_C = 25^\circ\text{C}$)	I_R	130 20	μA

(1) FR-4 or FR-5 = 3.5 x 1.5 inches using the Motorola minimum recommended footprint.

(2) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2\%$.

Preferred devices are Motorola recommended choices for future use and best overall value.

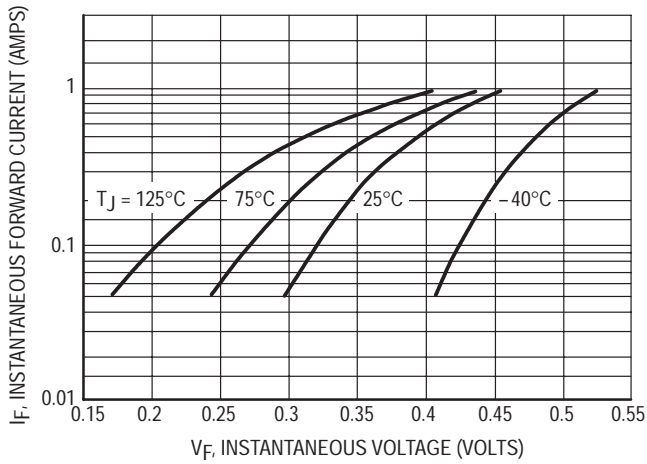


Figure 1. Typical Forward Voltage

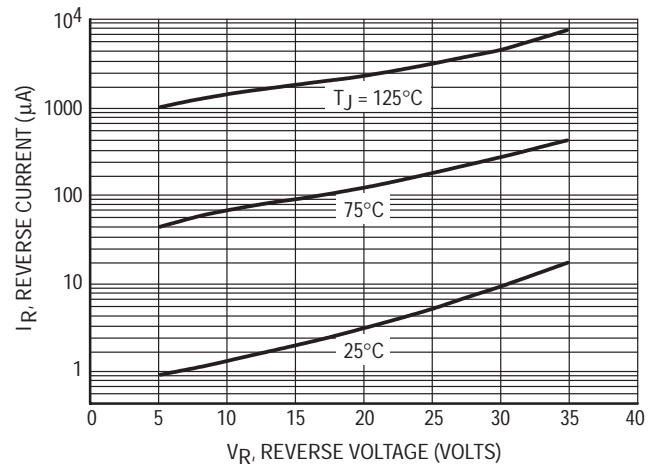


Figure 2. Typical Reverse Current

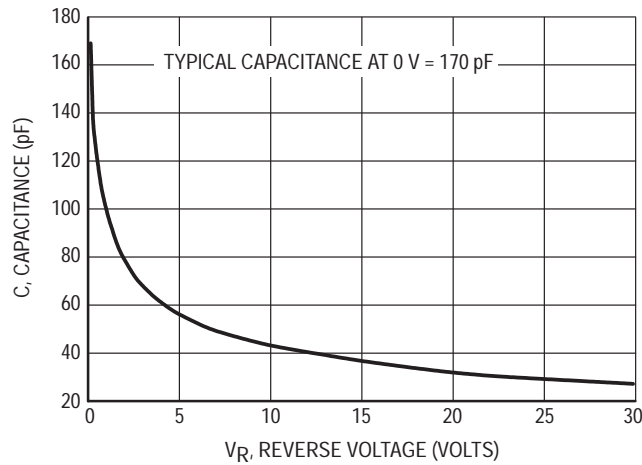


Figure 3. Typical Capacitance

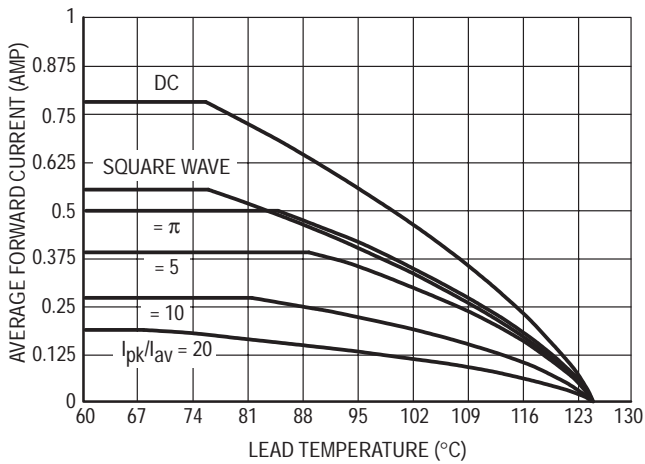


Figure 4. Current Derating (Lead)

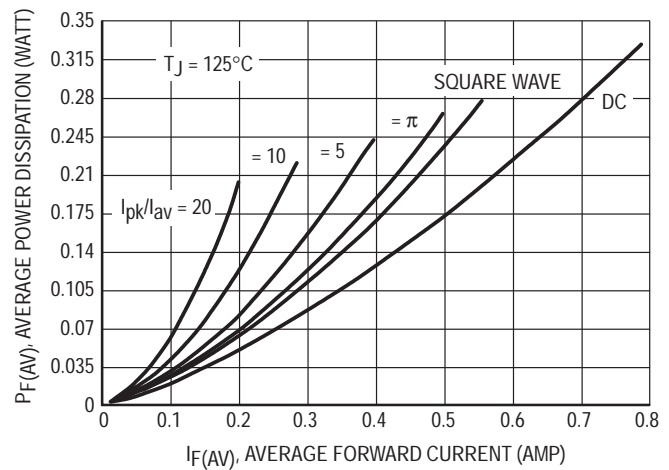


Figure 5. Power Dissipation

Advance Information
Surface Mount
Schottky Power Rectifier
SOD-123 Power Surface Mount Package

MBR0540T1

**SCHOTTKY BARRIER
RECTIFIER
0.5 AMPERES
40 VOLTS**



**CASE 425-04, Style 1
SOD-123**

The Schottky Power Rectifier employs the Schottky Barrier principle with a barrier metal that produces optimal forward voltage drop–reverse current tradeoff. Ideally suited for low voltage, high frequency rectification, or as a free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system. This package provides an alternative to the leadless 34 MELF style package. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Very Low Forward Voltage
- Epoxy Meets UL94, VO at 1/8"
- Package Designed for Optimal Automated Board Assembly

Mechanical Characteristics:

- Reel Options: 3,000 per 7 inch reel / 8 mm tape
- Reel Options: 10,000 per 13 inch reel / 8 mm tape
- Device Marking: B4
- Polarity Designator: Cathode Band
- Weight: 11.7 mg (approximately)
- Case: Epoxy Molded
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C max. for 10 Seconds

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	40	V
Average Rectified Forward Current (At Rated V_R , $T_C = 115^\circ\text{C}$)	I_O	0.5	A
Peak Repetitive Forward Current (At Rated V_R , Square Wave, 20 kHz, $T_C = 115^\circ\text{C}$)	I_{FRM}	1.0	A
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I_{FSM}	5.5	A
Storage / Operating Case Temperature	T_{stg} , T_C	-55 to 150	$^\circ\text{C}$
Operating Junction Temperature	T_J	-55 to 150	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R , $T_J = 25^\circ\text{C}$)	dv/dt	1,000	V/ μs

THERMAL CHARACTERISTICS

Thermal Resistance – Junction-to-Lead (2)	R_{tjl}	118	$^\circ\text{C/W}$
Thermal Resistance – Junction-to-Ambient (3)	R_{tja}	206	

ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ($I_F = 0.5\text{ A}$) ($I_F = 1\text{ A}$)	V_F	$T_J = 25^\circ\text{C}$	$T_J = 100^\circ\text{C}$	V
		0.51 0.62	0.46 0.61	
Maximum Instantaneous Reverse Current ($V_R = 40\text{ V}$) ($V_R = 20\text{ V}$)	I_R	$T_J = 25^\circ\text{C}$	$T_J = 100^\circ\text{C}$	μA
		20 10	5,000 13,000	

This document contains information on a new product. Specifications and information herein are subject to change without notice.

- (1) Pulse Test: Pulse Width $\leq 250\ \mu\text{s}$, Duty Cycle $\leq 2.0\%$.
- (2) Mounted with minimum recommended pad size, PC Board FR4.
- (3) 1 inch square pad size (1 X 0.5 inch for each lead) on FR4 board.

MBR0540T1

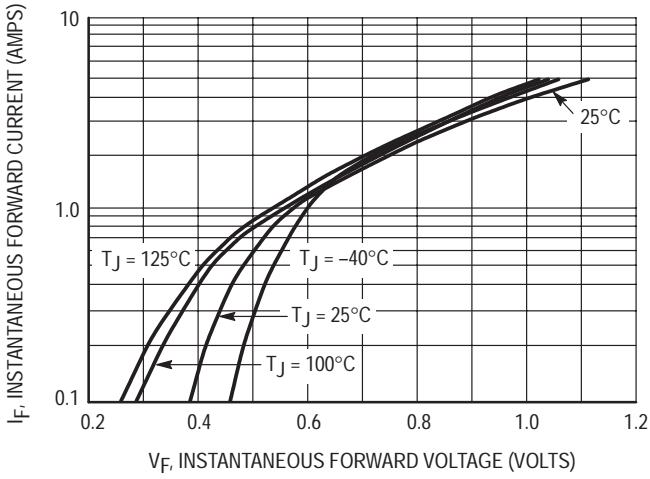


Figure 1. Typical Forward Voltage

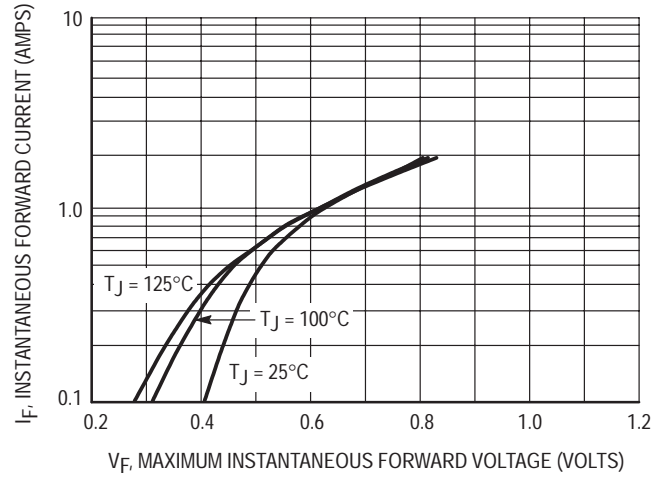


Figure 2. Maximum Forward Voltage

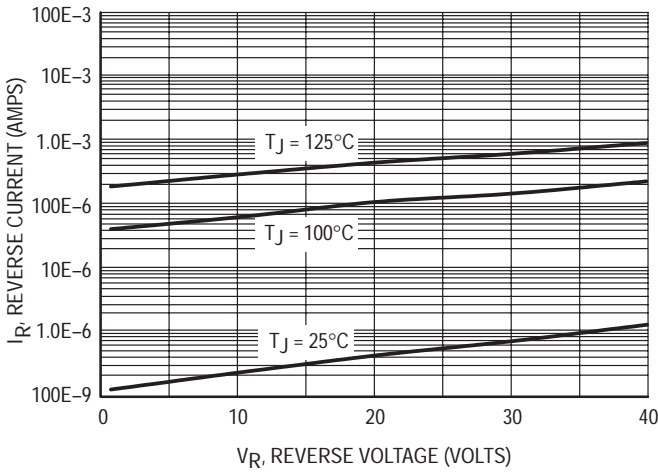


Figure 3. Typical Reverse Current

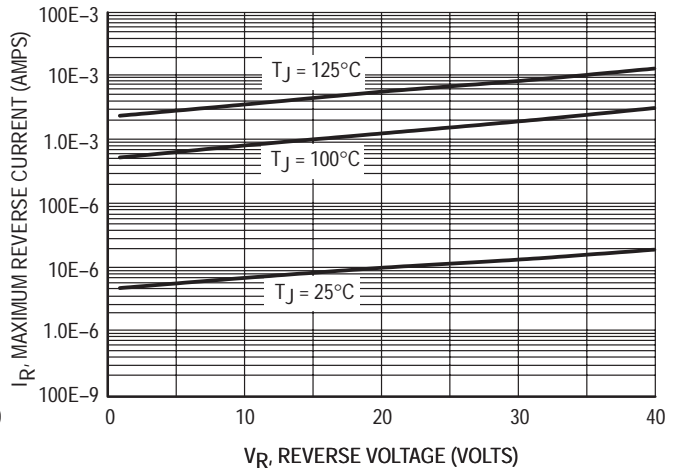


Figure 4. Maximum Reverse Current

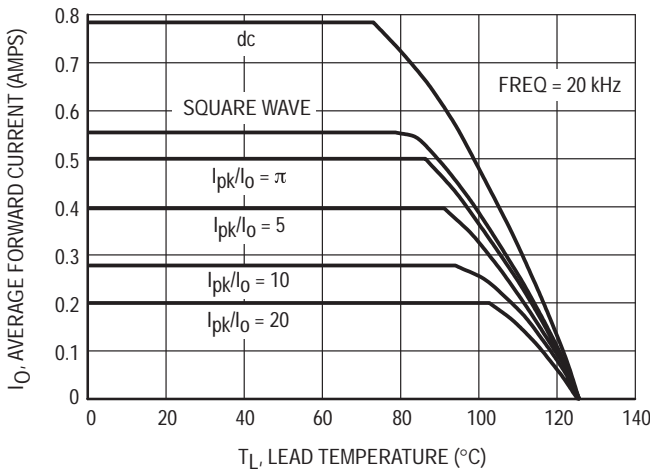


Figure 5. Current Derating

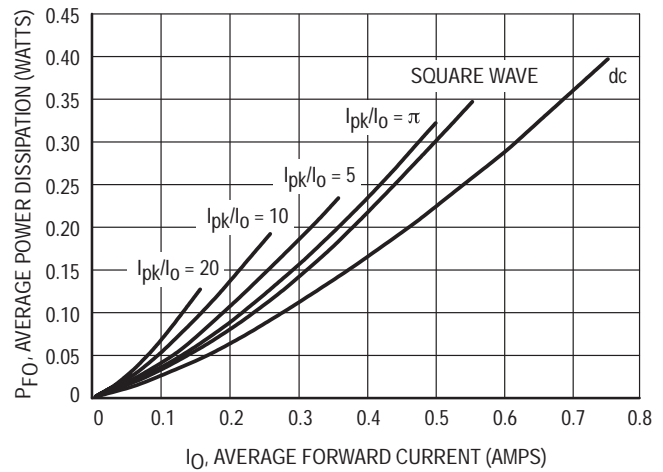


Figure 6. Forward Power Dissipation

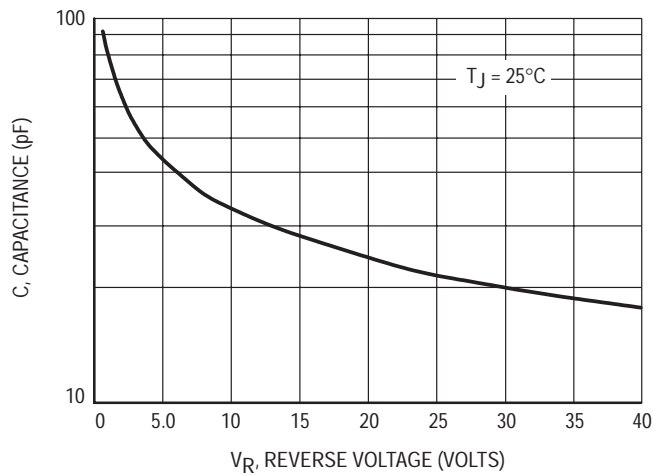


Figure 7. Capacitance

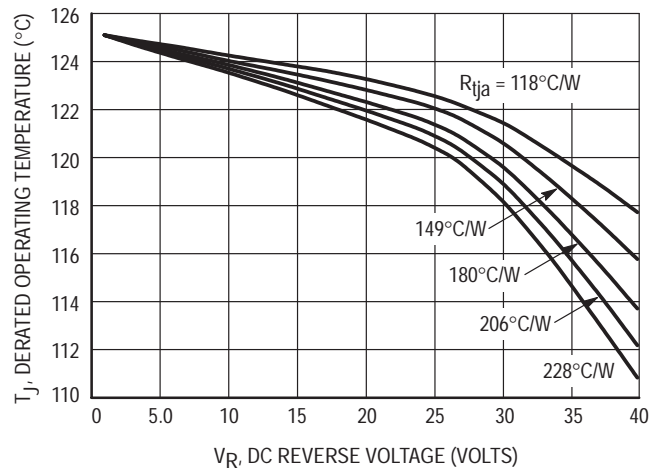


Figure 8. Typical Operating Temperature Derating*

* Reverse power dissipation and the possibility of thermal runaway must be considered when operating this device under any reverse voltage conditions. Calculations of T_J therefore must include forward and reverse power effects. The allowable operating T_J may be calculated from the equation:

$$T_J = T_{Jmax} - r(t)(P_f + P_r) \text{ where}$$

$r(t)$ = thermal impedance under given conditions,
 P_f = forward power dissipation, and
 P_r = reverse power dissipation

This graph displays the derated allowable T_J due to reverse bias under DC conditions only and is calculated as $T_J = T_{Jmax} - r(t)P_r$, where $r(t) = R_{thja}$. For other power applications further calculations must be performed.

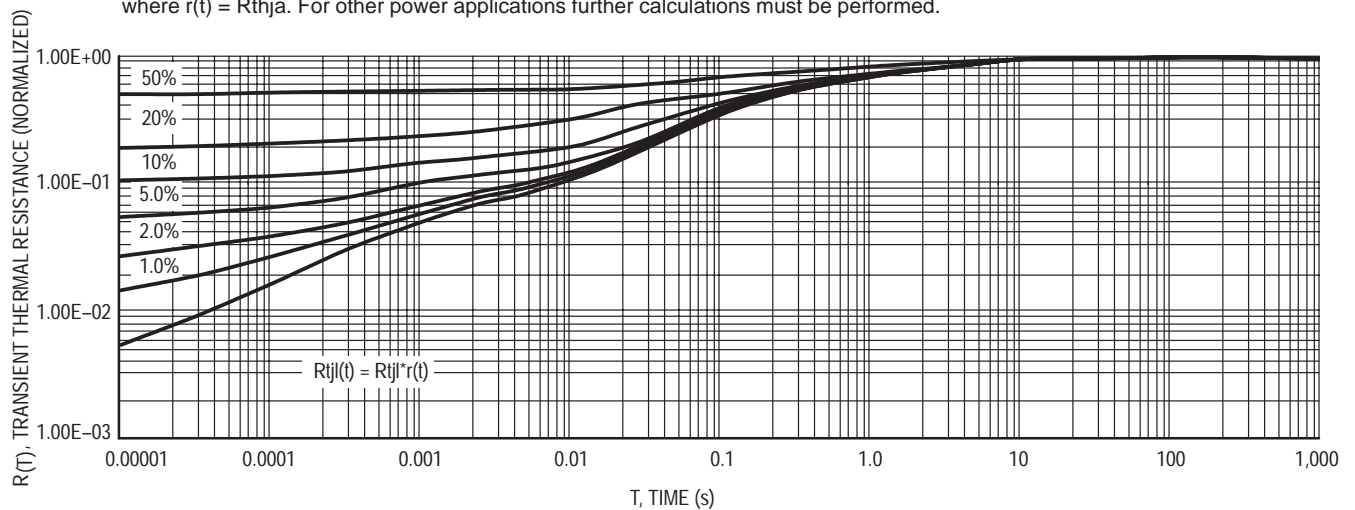


Figure 9. Thermal Response Junction to Lead

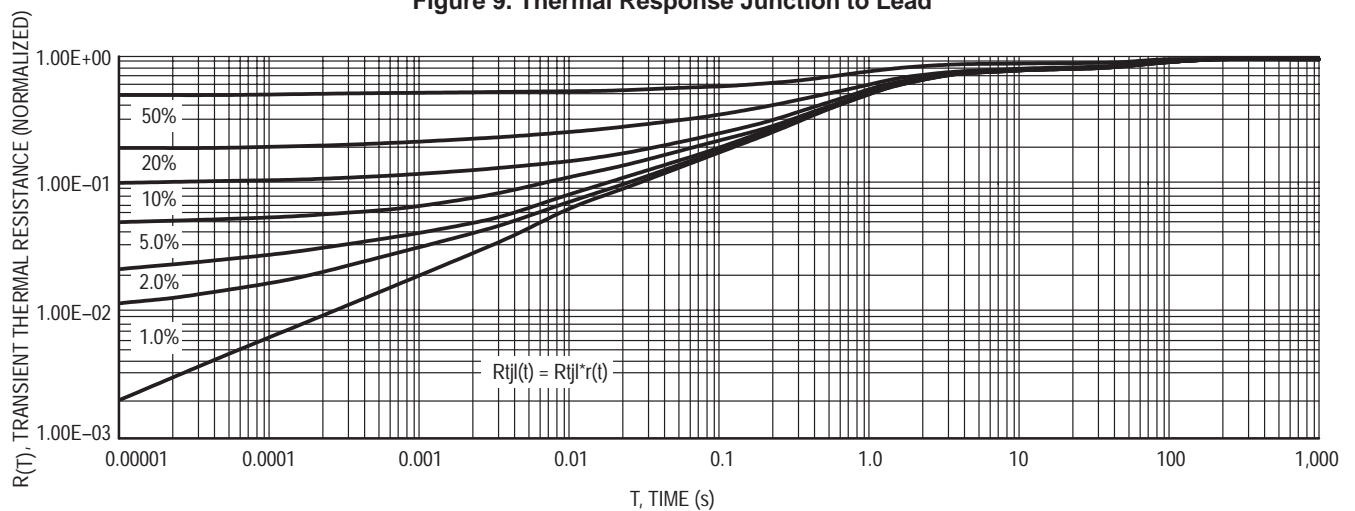


Figure 10. Thermal Response Junction to Ambient

Designer's™ Data Sheet
Schottky Power Rectifier
Surface Mount Power Package

... Employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes, in surface mount applications where compact size and weight are critical to the system.

- Very Low Forward Voltage Drop (0.395 Volts Max @ 1.0 A, T_J = 25°C)
- Small Compact Surface Mountable Package with J-Bend Leads
- Highly Stable Oxide Passivated Junction
- Guardring for Stress Protection

Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 95 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 2500 units per reel
- Polarity: Notch in Plastic Body Indicates Cathode Lead
- Marking: B130

MBS130LT3

Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIER
1.0 AMPERE
30 VOLTS**



CASE 403A-03

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	30	Volts
Average Rectified Forward Current T _L = 120°C T _L = 110°C	I _{F(AV)}	1.0 2.0	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I _{FSM}	40	Amps
Operating Junction Temperature	T _J	- 65 to +125	°C

THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Lead (T _L = 25°C)	R _{θJL}	12	°C/W
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ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) (i _F = 1.0 A, T _J = 25°C) (i _F = 2.0 A, T _J = 25°C)	V _F	0.395 0.445	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, T _J = 25°C) (Rated dc Voltage, T _J = 100°C)	I _R	1.0 10	mA

(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2%.

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

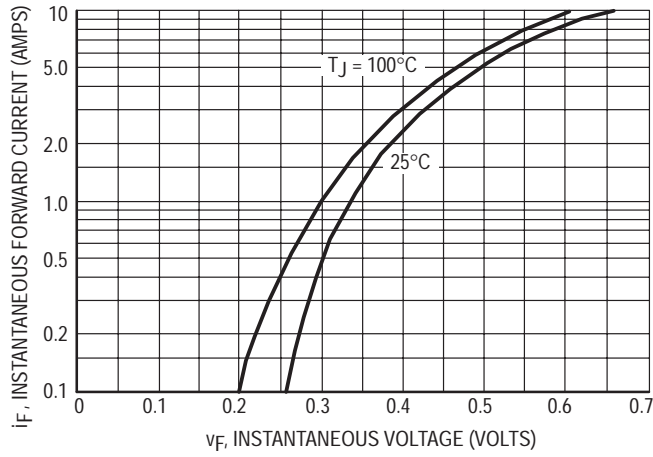


Figure 1. Typical Forward Voltage

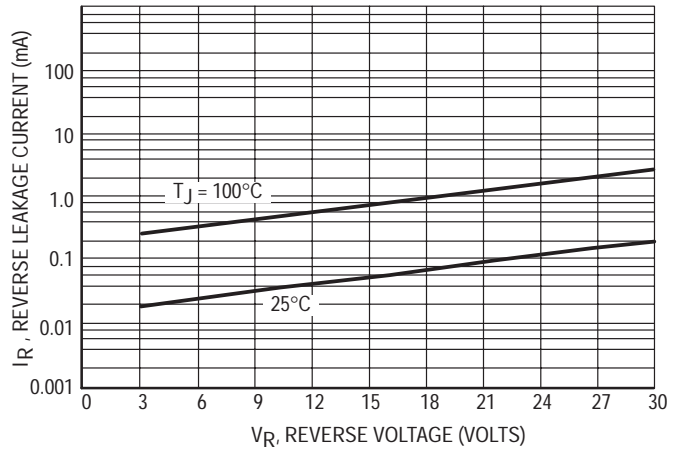


Figure 2. Typical Reverse Leakage Current

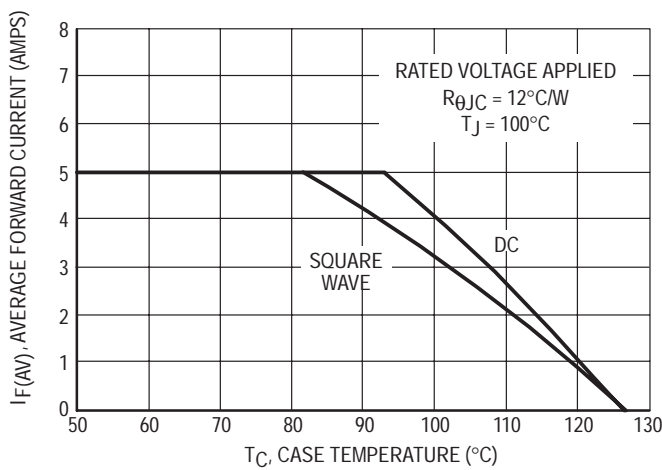


Figure 3. Current Derating (Case)

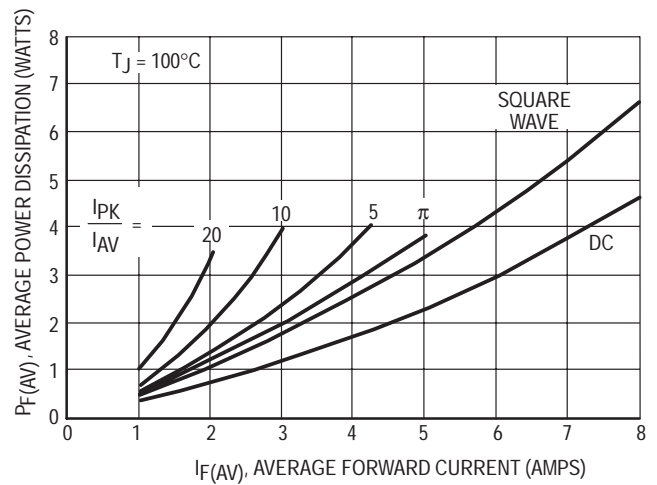


Figure 4. Typical Power Dissipation

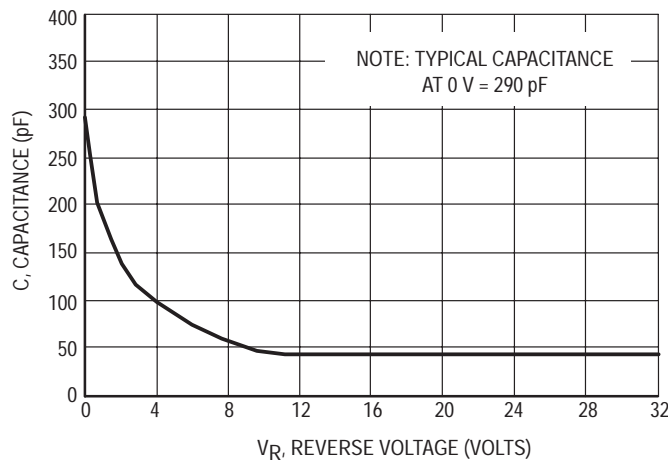


Figure 5. Typical Capacitance

Surface Mount Schottky Power Rectifier

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop (0.55 Volts Max @ 1.0 A, $T_J = 25^\circ\text{C}$)
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 95 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 2500 units per reel
- Polarity: Notch in Plastic Body Indicates Cathode Lead
- Marking: B140

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	40	Volts
Average Rectified Forward Current $T_L = 115^\circ\text{C}$	$I_{F(AV)}$	1.0	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	40	Amps
Operating Junction Temperature	T_J	- 65 to +125	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Lead ($T_L = 25^\circ\text{C}$)	$R_{\theta JL}$	12	$^\circ\text{C/W}$
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ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ($i_F = 1.0\text{ A}$, $T_J = 25^\circ\text{C}$)	V_F	0.6	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 25^\circ\text{C}$) (Rated dc Voltage, $T_J = 100^\circ\text{C}$)	i_R	1.0 10	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

MBRS140T3

Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIERS
1.0 AMPERE
40 VOLTS**



CASE 403A-03

Preferred devices are Motorola recommended choices for future use and best overall value.

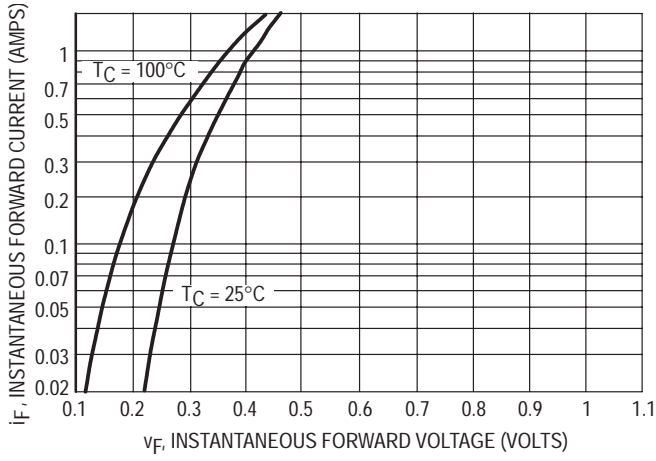


Figure 1. Typical Forward Voltage

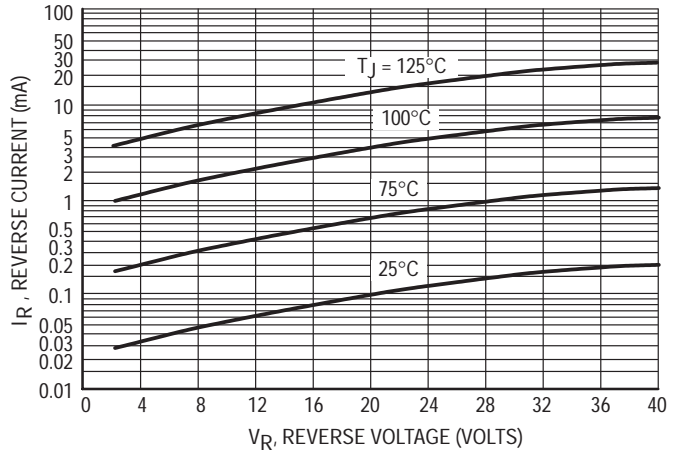


Figure 2. Typical Reverse Current

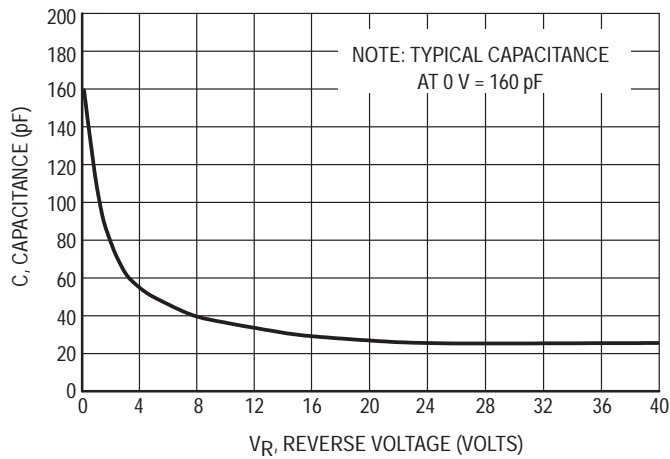


Figure 3. Typical Capacitance

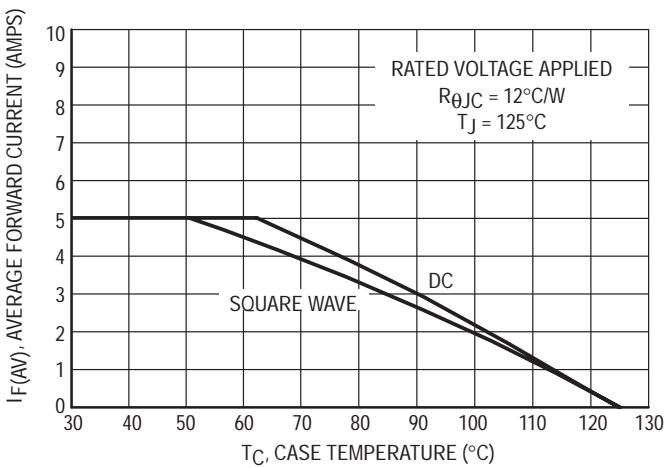


Figure 4. Current Derating (Case)

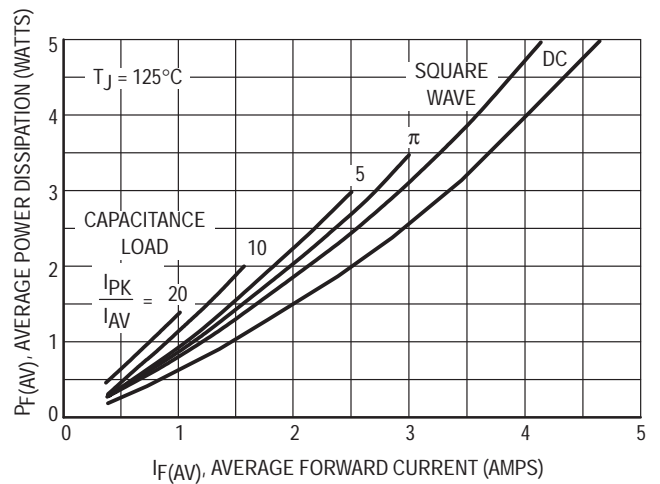


Figure 5. Power Dissipation

Designer's™ Data Sheet
Schottky Power Rectifier
Surface Mount Power Package

Schottky Power Rectifiers employ the use of the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes, in surface mount applications where compact size and weight are critical to the system. These state-of-the-art devices have the following features:

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- High Blocking Voltage — 100 Volts
- 150°C Operating Junction Temperature
- Guardring for Stress Protection

Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 95 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 2500 units per reel
- Polarity: Notch in Plastic Body Indicates Cathode Lead
- Marking: B110

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	100	Volts
Average Rectified Forward Current $T_L = 120^\circ\text{C}$ $T_L = 100^\circ\text{C}$	$I_{F(AV)}$	1.0 2.0	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	50	Amps
Operating Junction Temperature	T_J	- 65 to +150	°C
Voltage Rate of Change	dv/dt	10	V/ns

THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Lead ($T_L = 25^\circ\text{C}$)	$R_{\theta JL}$	22	°C/W
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ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ($I_F = 1.0\text{ A}$, $T_J = 25^\circ\text{C}$)	V_F	0.75	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 25^\circ\text{C}$) (Rated dc Voltage, $T_J = 100^\circ\text{C}$)	i_R	0.5 5.0	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

Preferred devices are Motorola recommended choices for future use and best overall value.

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

MBRS1100T3

Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIER
1.0 AMPERE
100 VOLTS**



CASE 403A-03

TYPICAL ELECTRICAL CHARACTERISTICS

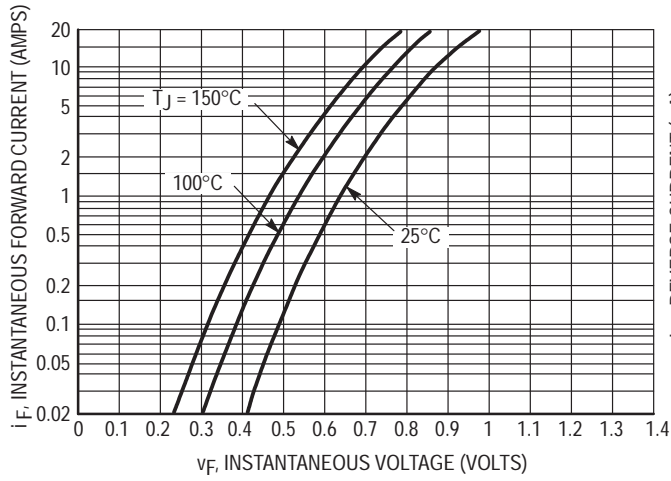


Figure 1. Typical Forward Voltage

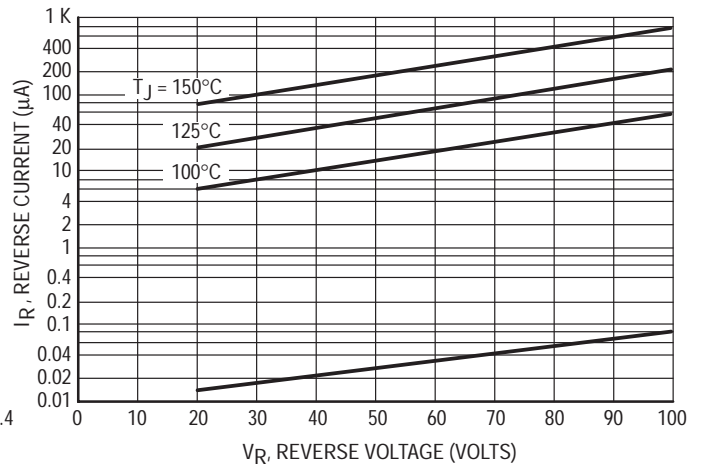


Figure 2. Typical Reverse Current

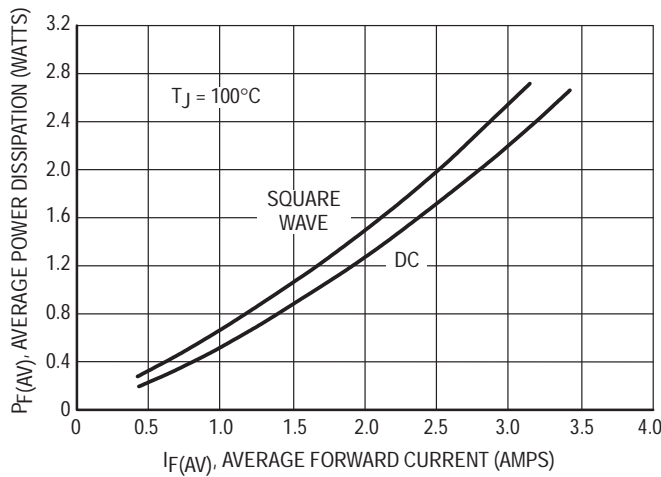


Figure 3. Power Dissipation

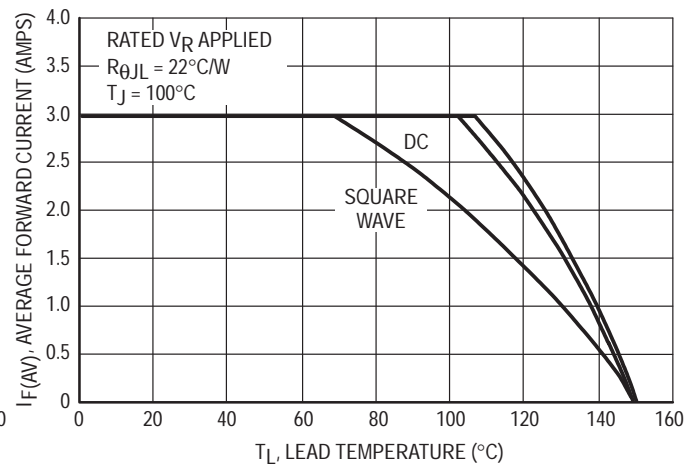


Figure 4. Current Derating, Lead

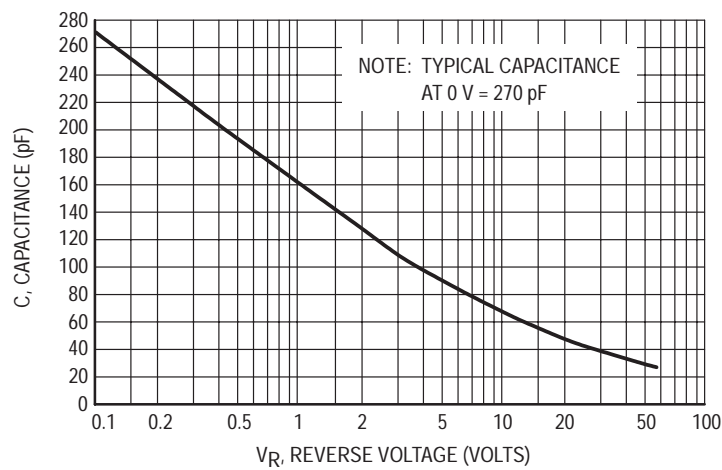


Figure 5. Typical Capacitance

Surface Mount Schottky Power Rectifier

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes, in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop (0.5 Volts Max @ 3.0 A, $T_J = 25^\circ\text{C}$)
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 217 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 16 mm Tape and Reel, 2500 units per reel
- Polarity: Notch in Plastic Body Indicates Cathode Lead
- Marking: B34, B36

MAXIMUM RATINGS

Rating	Symbol	MBRS340T3	MBRS360T3	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	40	60	Volts
Average Rectified Forward Current	$I_{F(AV)}$	3.0 @ $T_L = 100^\circ\text{C}$ 4.0 @ $T_L = 90^\circ\text{C}$		Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	80		Amps
Operating Junction Temperature	T_J	- 65 to +125		$^\circ\text{C}$

THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Lead	$R_{\theta JL}$	11	11	$^\circ\text{C/W}$
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ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ($i_F = 3.0\text{ A}$, $T_J = 25^\circ\text{C}$)	V_F	0.525	0.740	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 25^\circ\text{C}$) (Rated dc Voltage, $T_J = 100^\circ\text{C}$)	i_R	2.0 20	0.5 20	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

MBRS340T3
MBRS360T3

Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIERS**
3.0 AMPERES
40, 60 VOLTS



CASE 403-03

Preferred devices are Motorola recommended choices for future use and best overall value.

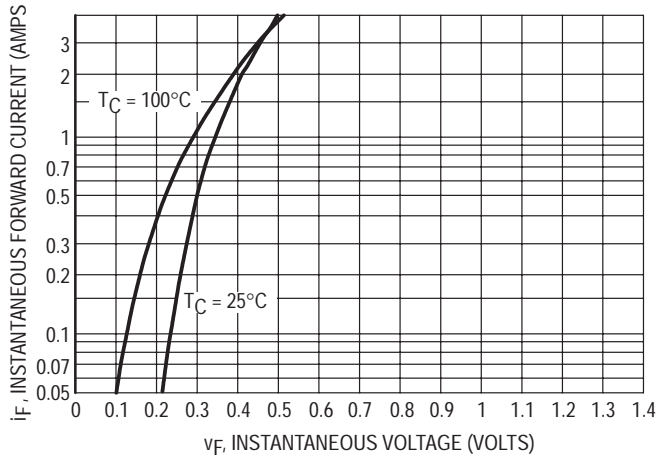


Figure 1. Typical Forward Voltage

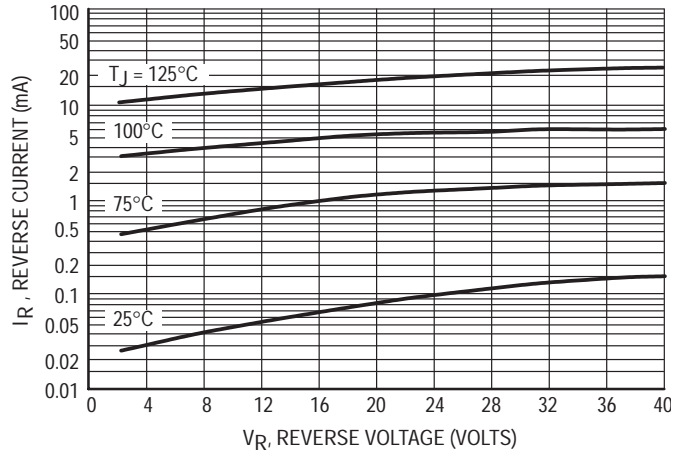


Figure 2. Typical Reverse Current

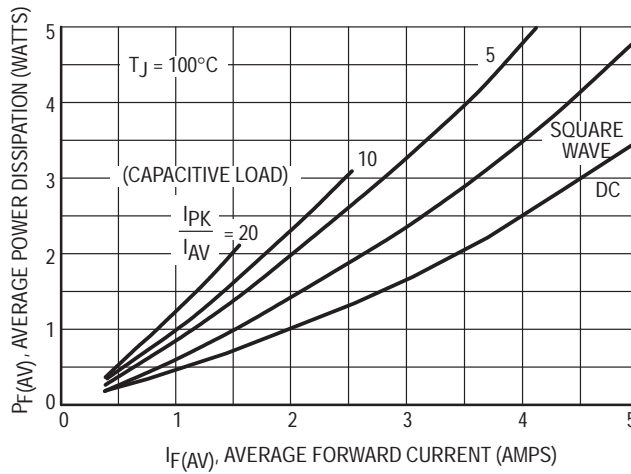


Figure 3. Power Dissipation

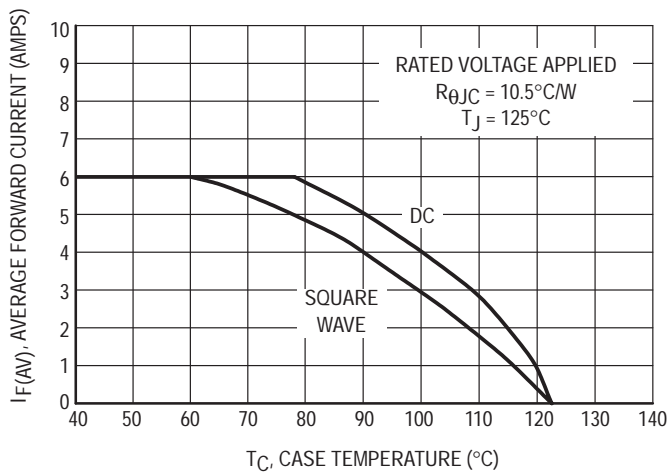


Figure 4. Current Derating (Case)

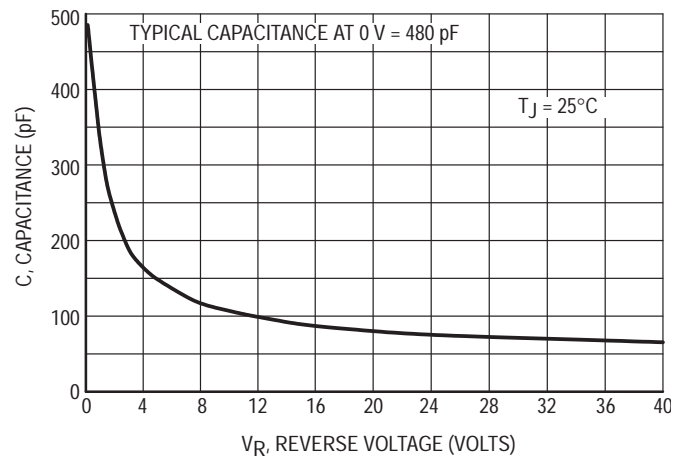


Figure 5. Typical Capacitance

SWITCHMODE™ Power Rectifiers

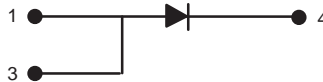
DPAK Surface Mount Package

... designed for use as output rectifiers, free wheeling, protection and steering diodes in switching power supplies, inverters and other inductive switching circuits. These state-of-the-art devices have the following features:

- Extremely Fast Switching
- Extremely Low Forward Drop
- Platinum Barrier with Avalanche Guardrings
- Guaranteed Reverse Avalanche

Mechanical Characteristics:

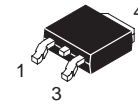
- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 75 units per plastic tube
- Available in 16 mm Tape and Reel, 2500 units per reel, by adding a "T4" suffix to the part number
- Marking: B320, B330, B340, B350, B360



MBRD320
MBRD330
MBRD340
MBRD350
MBRD360

MBRD320, MBRD340 and MBRD360 are
Motorola Preferred Devices

**SCHOTTKY BARRIER
RECTIFIERS**
3 AMPERES
20 TO 60 VOLTS



**CASE 369A-13
PLASTIC**

MAXIMUM RATINGS

Rating	Symbol	MBRD					Unit
		320	330	340	350	360	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	20	30	40	50	60	Volts
Average Rectified Forward Current ($T_C = +125^\circ\text{C}$, Rated V_R)	$I_{F(AV)}$	3					Amps
Peak Repetitive Forward Current, $T_C = +125^\circ\text{C}$ (Rated V_R , Square Wave, 20 kHz)	I_{FRM}	6					Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	75					Amps
Peak Repetitive Reverse Surge Current (2 μs , 1 kHz)	I_{RRM}	1					Amp
Operating Junction Temperature	T_J	-65 to +150					$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +175					$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10000					$\text{V}/\mu\text{s}$

THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	6	$^\circ\text{C}/\text{W}$
Maximum Thermal Resistance, Junction to Ambient (1)	$R_{\theta JA}$	80	$^\circ\text{C}/\text{W}$

(1) Rating applies when surface mounted on the minimum pad size recommended.

Preferred devices are Motorola recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (2) $i_F = 3$ Amps, $T_C = +25^\circ\text{C}$ $i_F = 3$ Amps, $T_C = +125^\circ\text{C}$ $i_F = 6$ Amps, $T_C = +25^\circ\text{C}$ $i_F = 6$ Amps, $T_C = +125^\circ\text{C}$	V_F	0.6 0.45 0.7 0.625	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_C = +25^\circ\text{C}$) (Rated dc Voltage, $T_C = +125^\circ\text{C}$)	i_R	0.2 20	mA

(2) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

TYPICAL CHARACTERISTICS

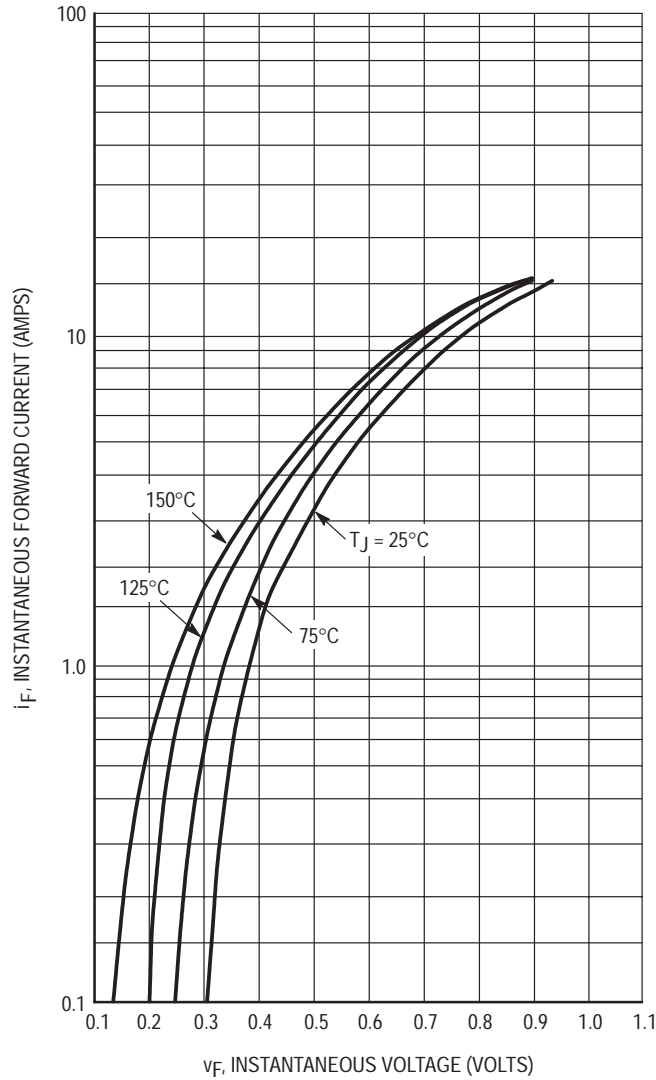
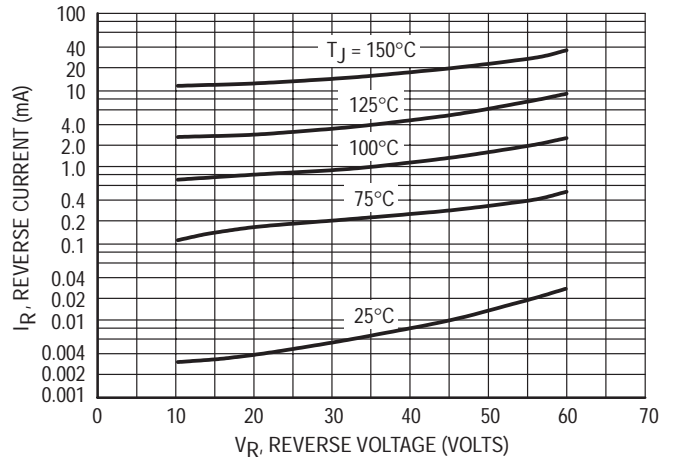


Figure 1. Typical Forward Voltage



*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these curves if V_R is sufficient below rated V_R .

Figure 2. Typical Reverse Current

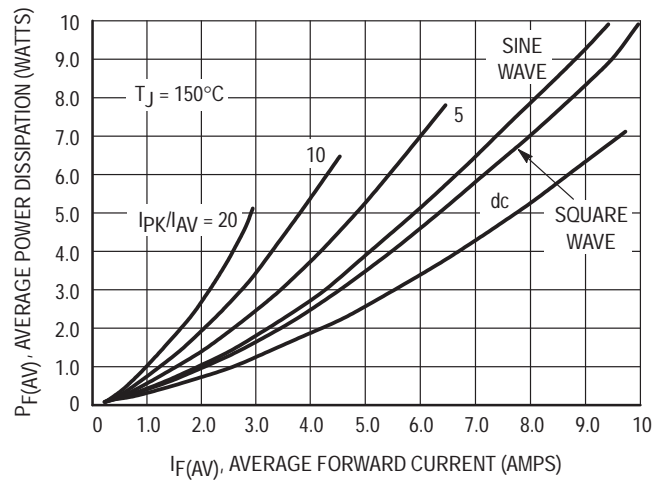


Figure 3. Average Power Dissipation

MBRD320 MBRD330 MBRD340 MBRD350 MBRD360

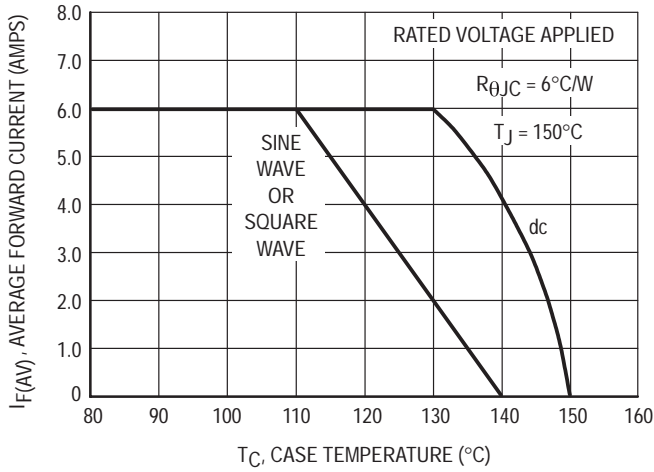


Figure 4. Current Derating, Case

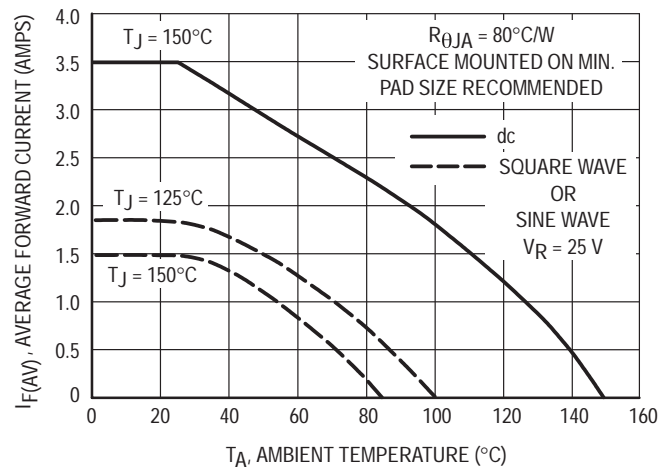


Figure 5. Current Derating, Ambient

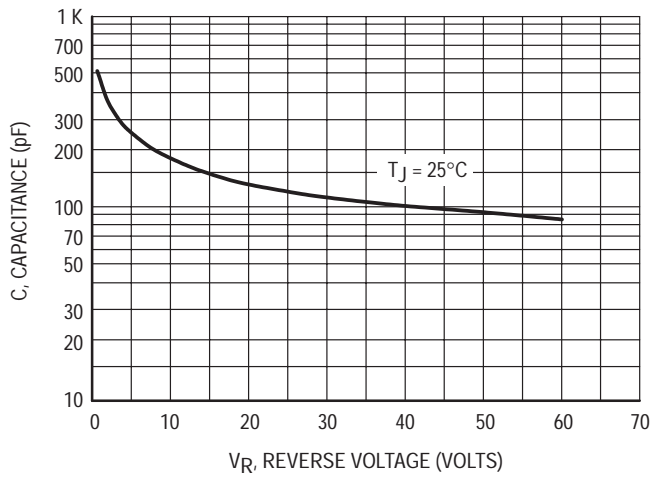


Figure 6. Typical Capacitance

SWITCHMODE™ Power Rectifiers

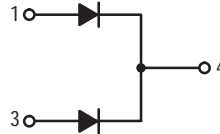
DKAK Surface Mount Package

... in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Extremely Fast Switching
- Extremely Low Forward Drop
- Platinum Barrier with Avalanche Guardrings
- Guaranteed Reverse Avalanche

Mechanical Characteristics:

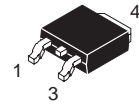
- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 75 units per plastic tube
- Available in 16 mm Tape and Reel, 2500 units per reel, by adding a "T4" suffix to the part number
- Marking: B620T, B630T, B640T, B650T, B660T



MBRD620CT
MBRD630CT
MBRD640CT
MBRD650CT
MBRD660CT

MBRD620CT, MBRD640CT and
MBRD660CT are
Motorola Preferred Devices

**SCHOTTKY BARRIER
RECTIFIERS
6 AMPERES
20 TO 60 VOLTS**



**CASE 369A-13
PLASTIC**

MAXIMUM RATINGS

Rating	Symbol	MBRD					Unit
		620CT	630CT	640CT	650CT	660CT	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	20	30	40	50	60	Volts
Average Rectified Forward Current $T_C = 130^\circ\text{C}$ (Rated V_R)	$I_{F(AV)}$	3 6					Amps
Peak Repetitive Forward Current, $T_C = 130^\circ\text{C}$ (Rated V_R , Square Wave, 20 kHz) Per Diode	I_{FRM}	6					Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	75					Amps
Peak Repetitive Reverse Surge Current (2 μs , 1 kHz)	I_{RRM}	1					Amp
Operating Junction Temperature	T_J	-65 to +150					$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +175					$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10000					$\text{V}/\mu\text{s}$

THERMAL CHARACTERISTICS PER DIODE

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	6	$^\circ\text{C}/\text{W}$
Maximum Thermal Resistance, Junction to Ambient (1)	$R_{\theta JA}$	80	$^\circ\text{C}/\text{W}$

(1) Rating applies when surface mounted on the minimum pad size recommended.

Preferred devices are Motorola recommended choices for future use and best overall value.

MBRD620CT MBRD630CT MBRD640CT MBRD650CT MBRD660CT

ELECTRICAL CHARACTERISTICS PER DIODE

Maximum Instantaneous Forward Voltage (2) $i_F = 3 \text{ Amps}, T_C = 25^\circ\text{C}$ $i_F = 3 \text{ Amps}, T_C = 125^\circ\text{C}$ $i_F = 6 \text{ Amps}, T_C = 25^\circ\text{C}$ $i_F = 6 \text{ Amps}, T_C = 125^\circ\text{C}$	V_F	0.7 0.65 0.9 0.85	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_C = 25^\circ\text{C}$) (Rated dc Voltage, $T_C = 125^\circ\text{C}$)	i_R	0.1 15	mA

(2) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

TYPICAL CHARACTERISTICS

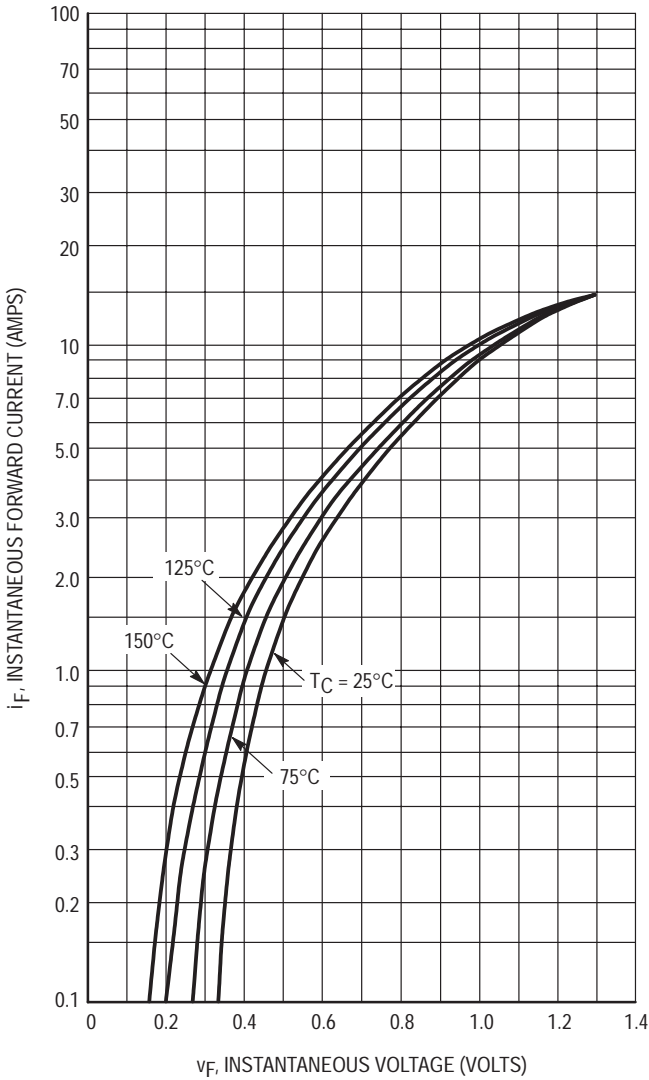
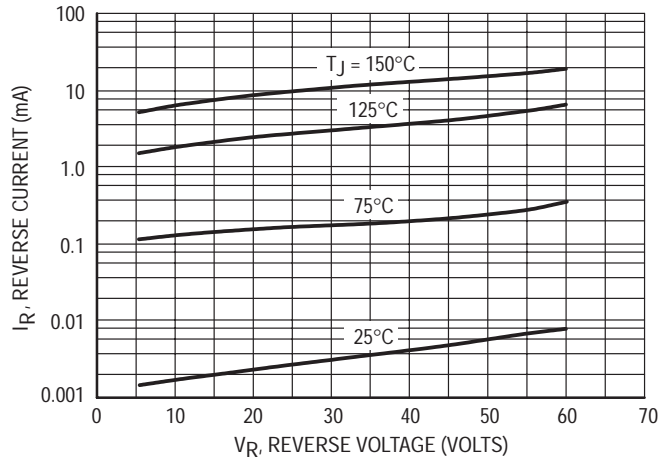


Figure 1. Typical Forward Voltage, Per Leg



*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these curves if V_R is sufficient below rated V_R .

Figure 2. Typical Reverse Current, * Per Leg

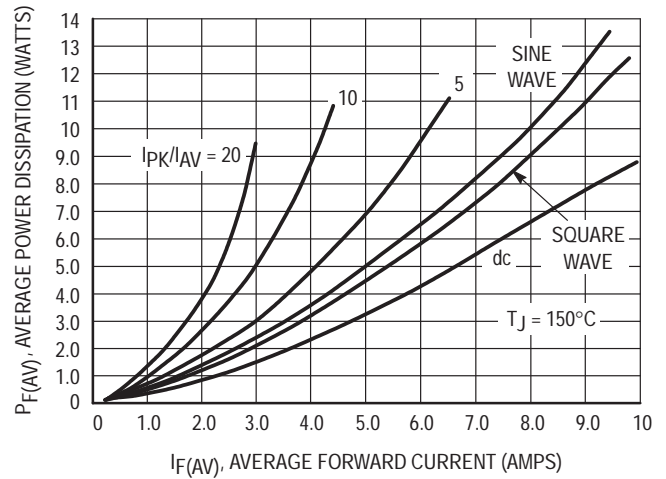


Figure 3. Average Power Dissipation, Per Leg

MBRD620CT MBRD630CT MBRD640CT MBRD650CT MBRD660CT

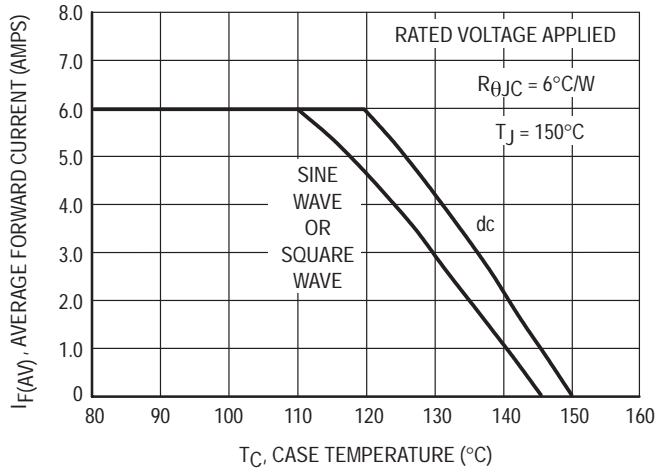


Figure 4. Current Derating, Case, Per Leg

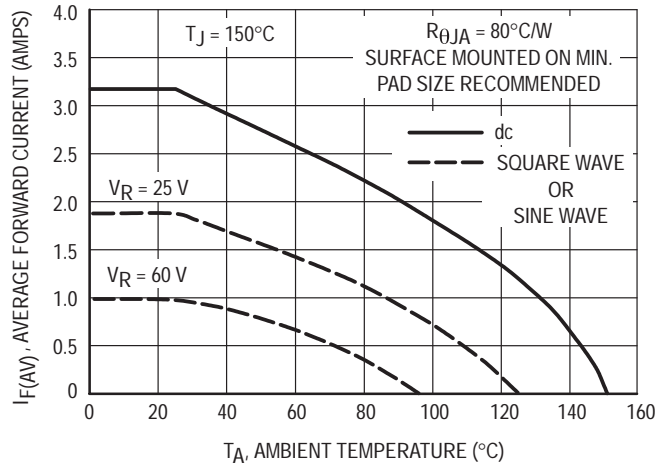


Figure 5. Current Derating, Ambient, Per Leg

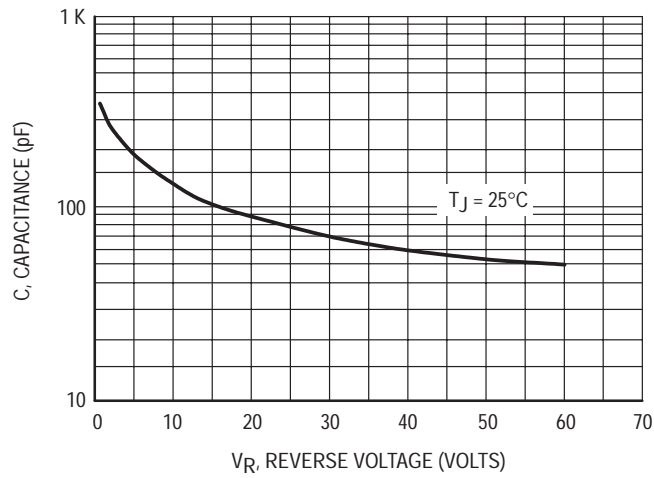


Figure 6. Typical Capacitance, Per Leg

SWITCHMODE™ Power Rectifier

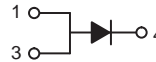
PAK Surface Mount Package

This SWITCHMODE power rectifier which uses the Schottky Barrier principle with a proprietary barrier metal, is designed for use as output rectifiers, free wheeling, protection and steering diodes in switching power supplies, inverters and other inductive switching circuits. This state of the art device has the following features:

- Low Forward Voltage
- 125°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Guaranteed Reverse Avalanche
- Compact Size
- Lead Formed for Surface Mount

Mechanical Characteristics

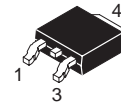
- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 75 units per plastic tube
- Available in 16 mm Tape and Reel, 2500 units per 13" reel, by adding a "T4" suffix to the part number
- Marking: B835L



MBRD835L

Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIER
8 AMPERES
35 VOLTS**



**CASE 369A-13
PAK PLASTIC, STYLE 3**

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	35	Volts
Average Rectified Forward Current (At Rated V_R) $T_C = +88^\circ\text{C}$	$I_{F(AV)}$	8	Amps
Peak Repetitive Forward Current (At Rated V_R , Square Wave, 20 kHz) $T_C = +80^\circ\text{C}$	I_{FRM}	16	Amps
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	75	Amps
Repetitive Avalanche Current (Current Decaying Linearly to Zero in 1 μs , Frequency Limited by T_{Jmax})	I_{AR}	2	Amps
Storage Temperature	T_{stg}	-65 to +150	$^\circ\text{C}$
Operating Junction Temperature	T_J	-65 to +125	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10,000	$\text{V}/\mu\text{s}$

THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Case	$R_{\theta JC}$	6	$^\circ\text{C}/\text{W}$
Thermal Resistance — Junction to Ambient ⁽¹⁾	$R_{\theta JA}$	80	$^\circ\text{C}/\text{W}$

ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage ⁽²⁾	$(I_F = 8 \text{ Amps}, T_C = +25^\circ\text{C})$ $(I_F = 8 \text{ Amps}, T_C = +125^\circ\text{C})$	V_F	0.51 0.41	Volts
Maximum Instantaneous Reverse Current ⁽²⁾	$(\text{Rated dc Voltage}, T_C = +25^\circ\text{C})$ $(\text{Rated dc Voltage}, T_C = +100^\circ\text{C})$	I_R	1.4 35	mA

(1) Rating applies when surface mounted on the minimum pad size recommended.

(2) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2\%$.

Preferred devices are Motorola recommended choices for future use and best overall value.

TYPICAL CHARACTERISTICS

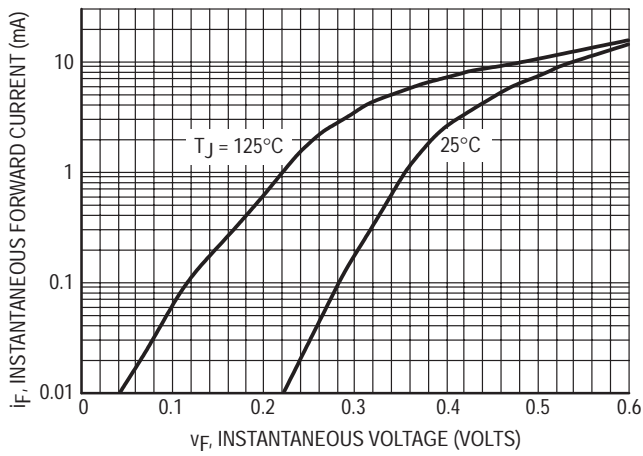


Figure 1. Maximum Forward Voltage

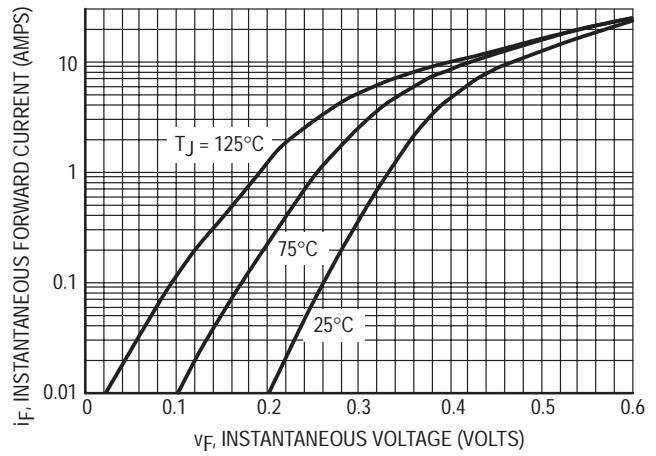


Figure 2. Typical Forward Voltage

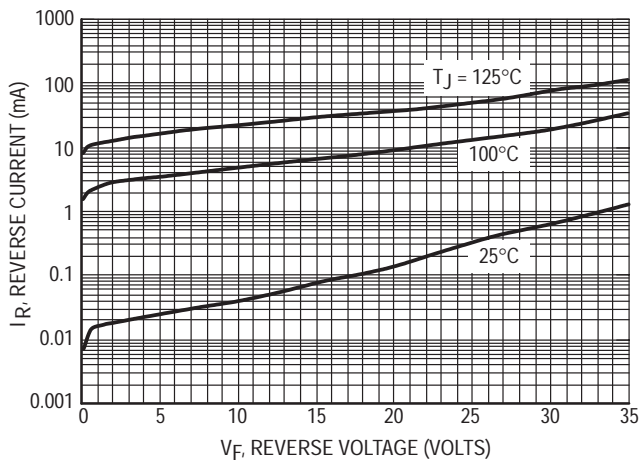


Figure 3. Maximum Reverse Current

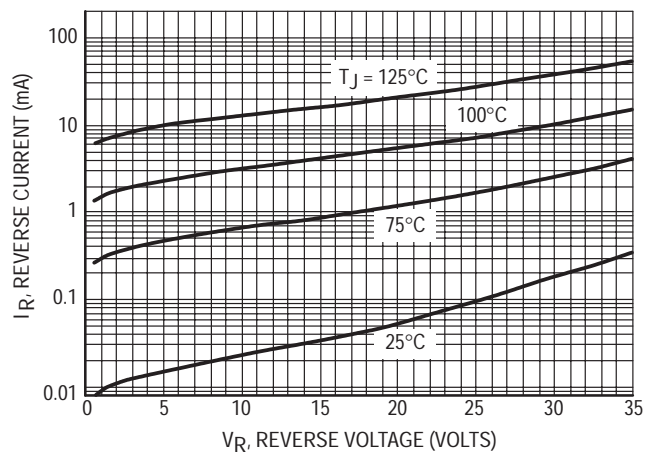


Figure 4. Typical Reverse Current

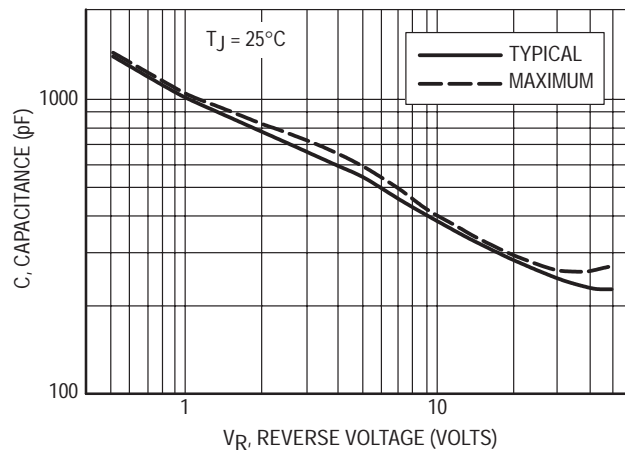


Figure 5. Maximum and Typical Capacitance

TYPICAL CHARACTERISTICS

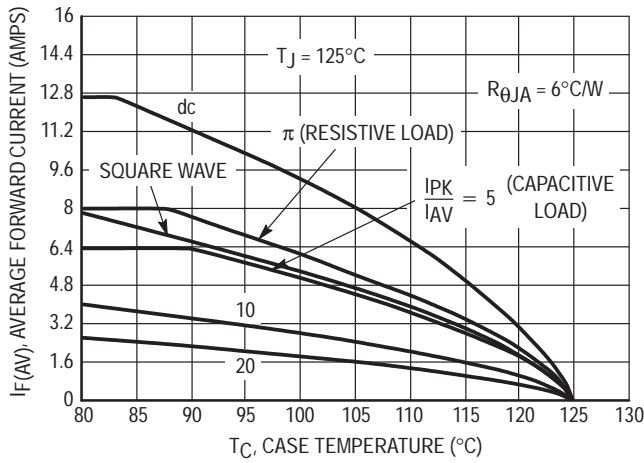


Figure 6. Current Derating, Infinite Heatsink

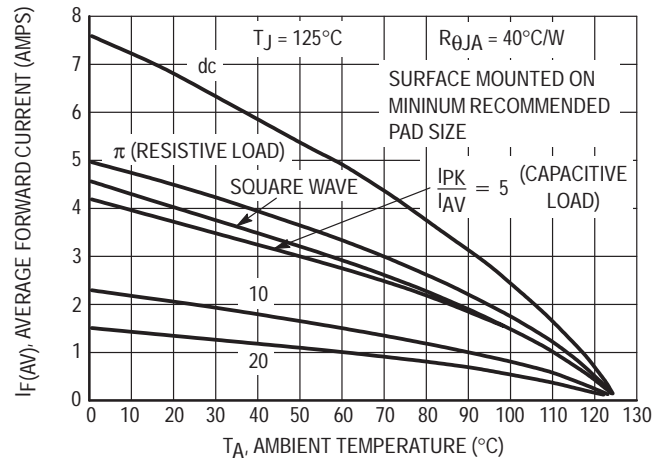


Figure 7. Current Derating

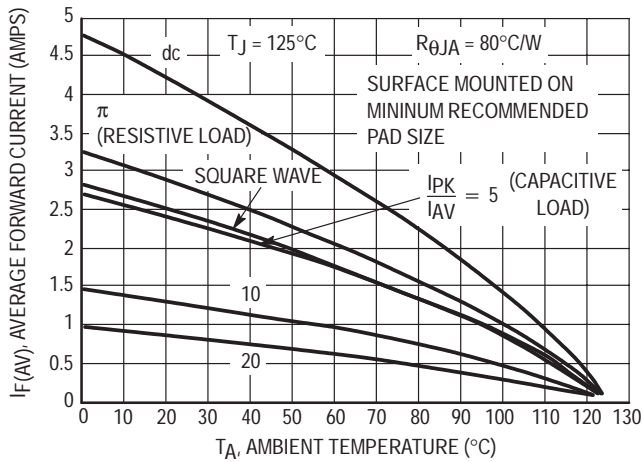


Figure 8. Current Derating, Free Air

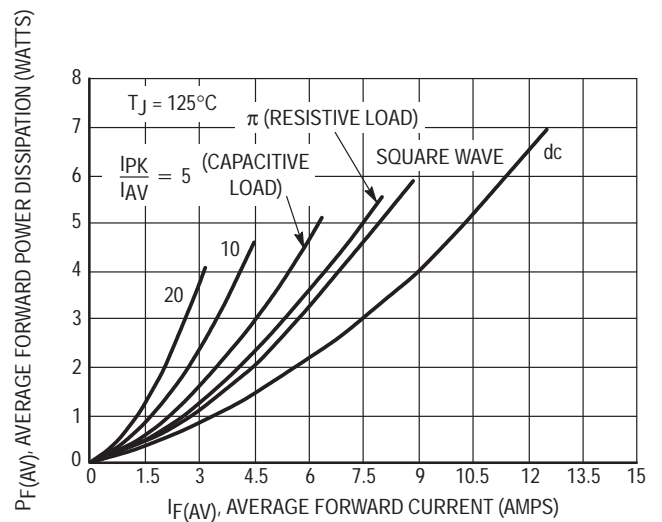


Figure 9. Forward Power Dissipation

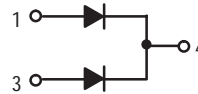
Designer's™ Data Sheet
SWITCHMODE™ Power Rectifier
D2PAK Surface Mount Power Package

The D2PAK Power Rectifier employs the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Center-Tap Configuration
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Guaranteed Reverse Avalanche
- Short Heat Sink Tab Manufactured — Not Sheared!
- Similar in Size to the Industry Standard TO-220 Package

Mechanical Characteristics

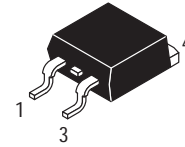
- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per 13" reel by adding a "T4" suffix to the part number
- Marking: B1545T



MBRB1545CT

Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIER
15 AMPERES
45 VOLTS**



**CASE 418B-02
D2PAK**

MAXIMUM RATINGS, PER LEG

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	45	Volts
Average Rectified Forward Current (Rated V_R) $T_C = 105^\circ\text{C}$ Total Device	$I_{F(AV)}$	7.5 15	Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz), $T_C = 105^\circ\text{C}$	I_{FRM}	15	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz)	I_{RRM}	1.0	Amp
Storage Temperature	T_{stg}	-65 to +175	$^\circ\text{C}$
Operating Junction Temperature	T_J	-65 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10000	$\text{V}/\mu\text{s}$

THERMAL CHARACTERISTICS, PER LEG

Thermal Resistance — Junction to Case	$R_{\theta JC}$	2.0	$^\circ\text{C}/\text{W}$
— Junction to Ambient (1)	$R_{\theta JA}$	50	

(1) When mounted using minimum recommended pad size on FR-4 board.

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS, PER LEG

Rating	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (2) ($i_F = 7.5$ Amps, $T_J = 125^\circ\text{C}$) ($i_F = 15$ Amps, $T_J = 125^\circ\text{C}$) ($i_F = 15$ Amps, $T_J = 25^\circ\text{C}$)	V_F	0.57 0.72 0.84	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_J = 125^\circ\text{C}$) (Rated dc Voltage, $T_J = 25^\circ\text{C}$)	i_R	15 0.1	mA

(2) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

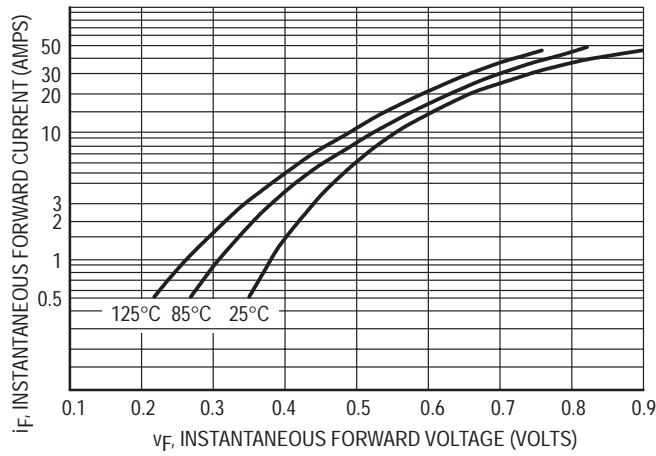


Figure 1. Typical Forward Voltage, Per Leg

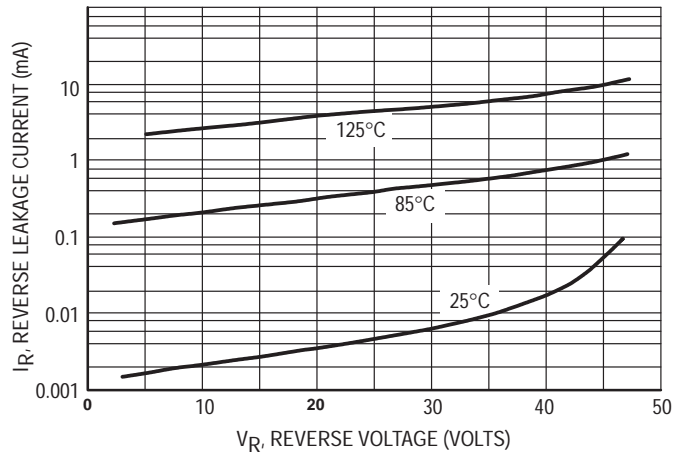


Figure 2. Typical Reverse Current, Per Leg

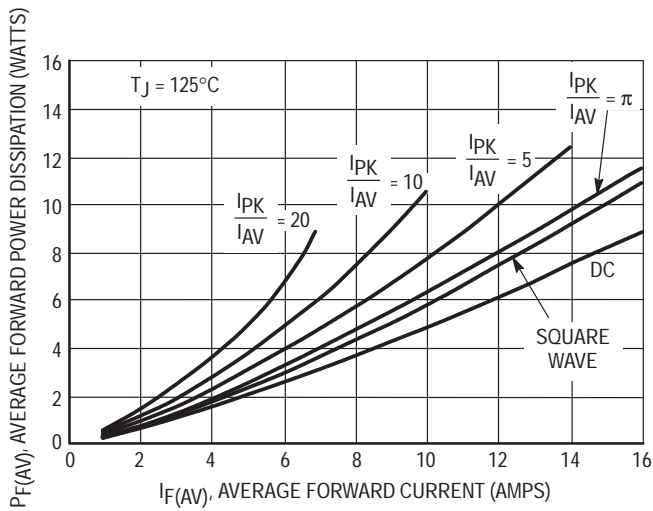


Figure 3. Typical Forward Power Dissipation

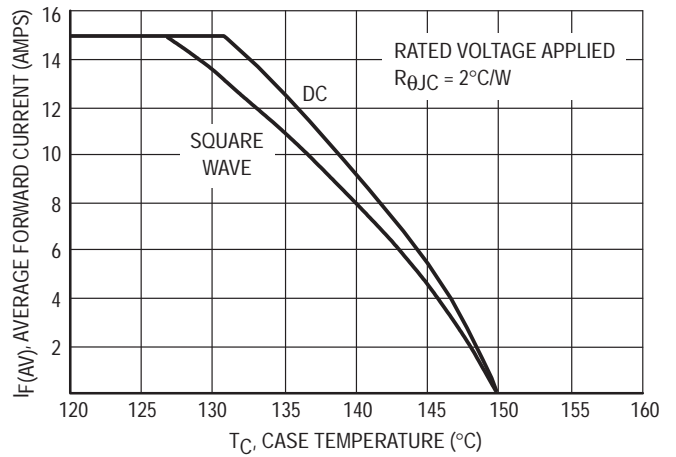


Figure 4. Current Derating, Case

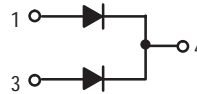
Designer's™ Data Sheet
SWITCHMODE™ Power Rectifier
D2PAK Surface Mount Power Package

Employs the use of the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Package Designed for Power Surface Mount Applications
- Center-Tap Configuration
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, V_O at 1/8"
- Guaranteed Reverse Avalanche
- Short Heat Sink Tab Manufactured — Not Sheared!
- Similar in Size to Industry Standard TO-220 Package

Mechanical Characteristics

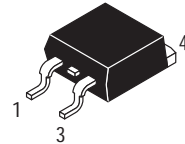
- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per 13" reel by adding a "T4" suffix to the part number
- Marking: B2060T



MBRB2060CT

Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIER
20 AMPERES
60 VOLTS**



CASE 418B-02

MAXIMUM RATINGS, PER LEG

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	60	Volts
Average Rectified Forward Current (Rated V _R) T _C = 110°C	I _{F(AV)}	10 20	Amps
Peak Repetitive Forward Current (Rated V _R , Square Wave, 20 kHz), T _C = 100°C	I _{FRM}	20	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I _{FSM}	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I _{RSM}	0.5	Amp
Storage Temperature	T _{stg}	-65 to +175	°C
Operating Junction Temperature	T _J	-65 to +150	°C
Voltage Rate of Change (Rated V _R)	dv/dt	10000	V/μs

THERMAL CHARACTERISTICS, PER LEG

Thermal Resistance — Junction to Case — Junction to Ambient (1)	R _{θJC} R _{θJA}	2.0 50	°C/W
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(1) See Chapter 7 for mounting conditions

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS, PER LEG

Rating	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (2) ($i_F = 20$ Amps, $T_J = 125^\circ\text{C}$) ($i_F = 20$ Amps, $T_J = 25^\circ\text{C}$)	V_F	0.85 0.95	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_J = 125^\circ\text{C}$) (Rated dc Voltage, $T_J = 25^\circ\text{C}$)	i_R	150 0.15	mA

(2) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

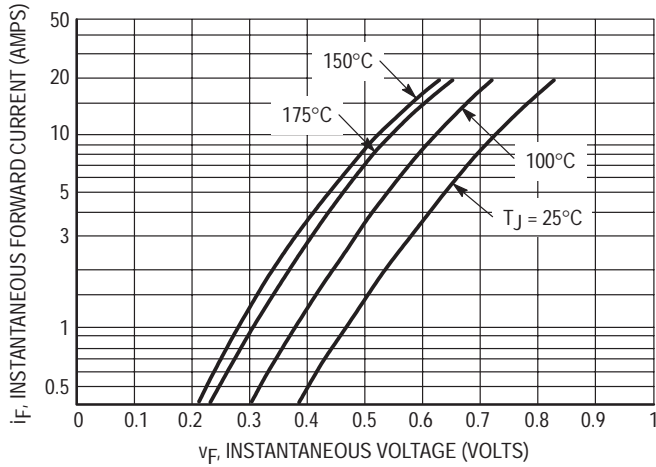


Figure 1. Typical Forward Voltage Per Diode

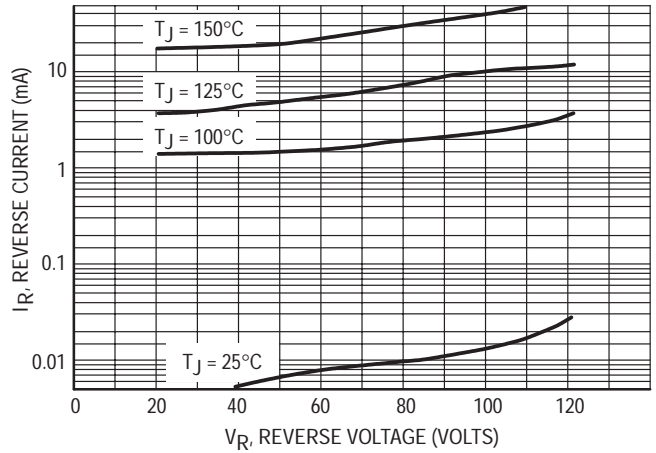


Figure 2. Typical Reverse Current Per Diode

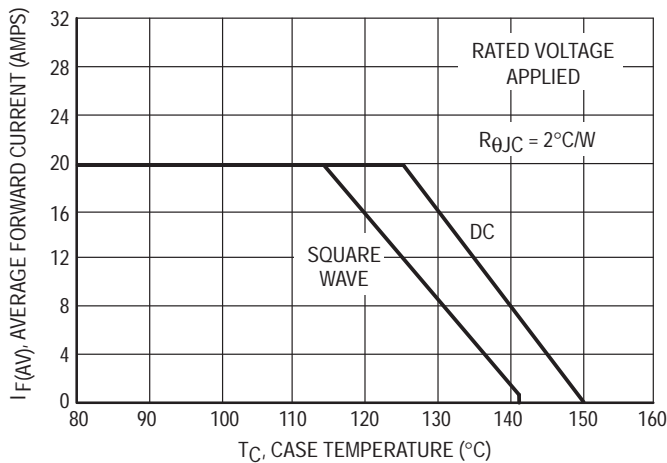


Figure 3. Typical Current Derating, Case, Per Leg

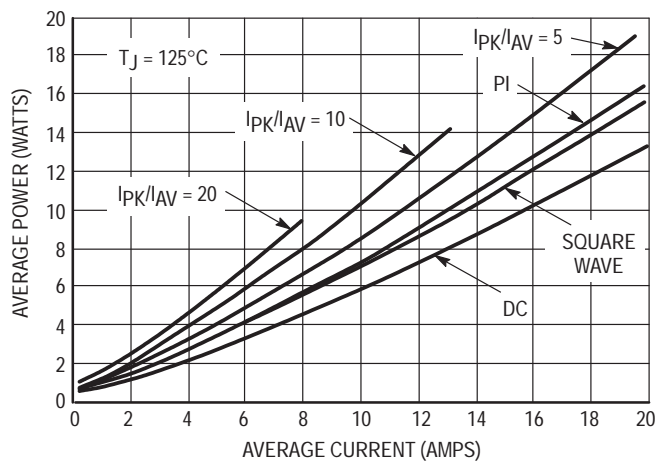


Figure 4. Average Power Dissipation and Average Current

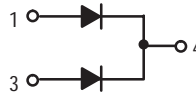
Designer's™ Data Sheet
SWITCHMODE™ Power Rectifier
D2PAK Surface Mount Power Package

The D2PAK Power Rectifier employs the use of the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Package Designed for Power Surface Mount Applications
- Center-Tap Configuration
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, V_O at 1/8"
- Guaranteed Reverse Avalanche
- Short Heat Sink Tab Manufactured — Not Sheared!
- Similar in Size to Industry Standard TO-220 Package

Mechanical Characteristics

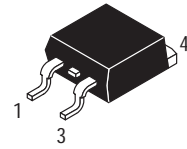
- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per 13" reel by adding a "T4" suffix to the part number
- Marking: B20100T



MBRB20100CT

Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIER
20 AMPERES
100 VOLTS**



**CASE 418B-02
D2PAK**

MAXIMUM RATINGS, PER LEG

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	100	Volts
Average Rectified Forward Current (Rated V_R) $T_C = 110^\circ\text{C}$ Total Device	$I_{F(AV)}$	10 20	Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz), $T_C = 100^\circ\text{C}$	I_{FRM}	20	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz)	I_{RRM}	0.5	Amp
Storage Temperature	T_{stg}	-65 to +175	$^\circ\text{C}$
Operating Junction Temperature	T_J	-65 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10000	$\text{V}/\mu\text{s}$

THERMAL CHARACTERISTICS, PER LEG

Thermal Resistance — Junction to Case — Junction to Ambient (1)	$R_{\theta JC}$ $R_{\theta JA}$	2.0 50	$^\circ\text{C}/\text{W}$
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(1) See Chapter 7 for mounting conditions

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS, PER LEG

Rating	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (2) ($i_F = 10$ Amp, $T_C = 125^\circ\text{C}$) ($i_F = 10$ Amp, $T_C = 25^\circ\text{C}$) ($i_F = 20$ Amp, $T_C = 125^\circ\text{C}$) ($i_F = 20$ Amp, $T_C = 25^\circ\text{C}$)	v_F	0.75 0.85 0.85 0.95	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_J = 125^\circ\text{C}$) (Rated dc Voltage, $T_J = 25^\circ\text{C}$)	i_R	6.0 0.1	mA

(2) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

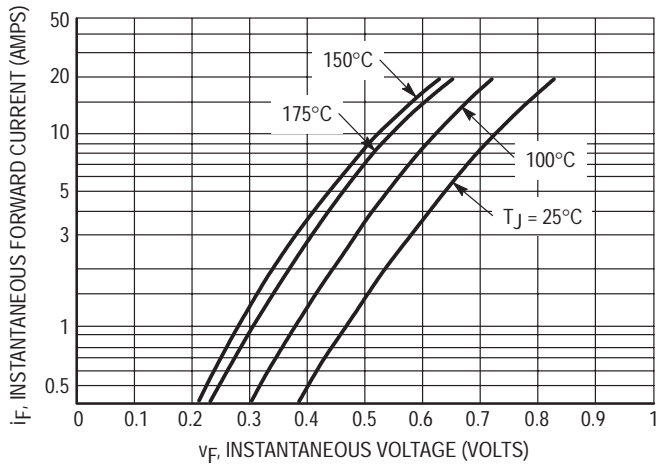


Figure 1. Typical Forward Voltage Per Diode

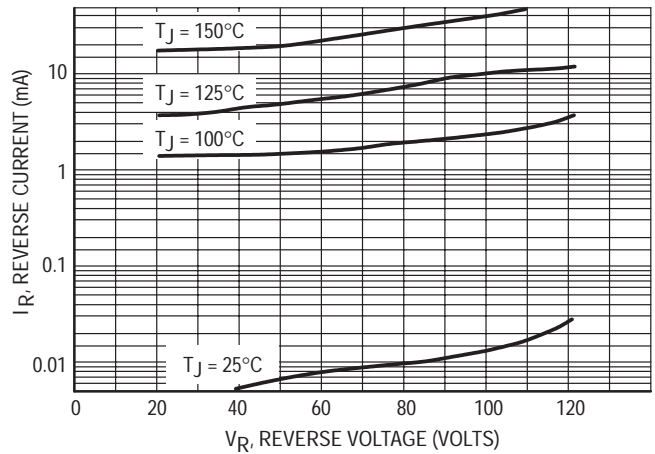


Figure 2. Typical Reverse Current Per Diode

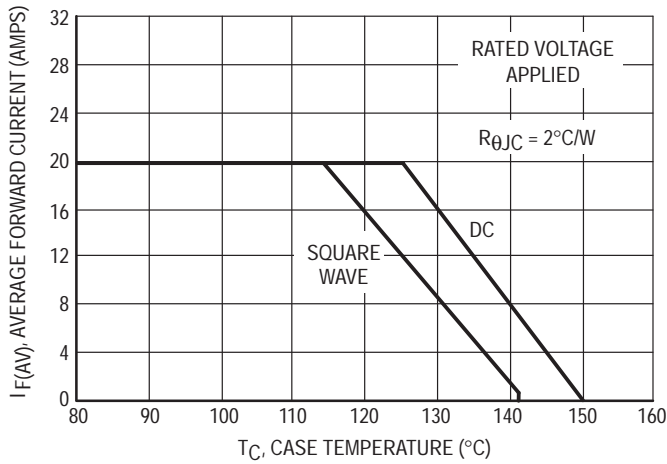


Figure 3. Typical Current Derating, Case, Per Leg

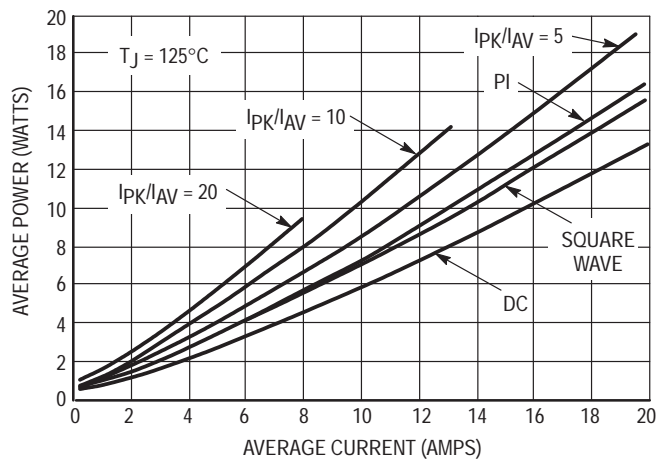


Figure 4. Average Power Dissipation and Average Current

SWITCHMODE™ Power

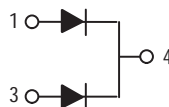
Dual Schottky Rectifier

... using Schottky Barrier technology with a platinum barrier metal. This state-of-the-art device is designed for use in high frequency switching power supplies and converters with up to 48 volt outputs. They block up to 200 volts and offer improved Schottky performance at frequencies from 250 kHz to 5.0 MHz.

- **200 Volt Blocking Voltage**
- Low Forward Voltage Drop
- Guardring for Stress Protection and High dv/dt Capability (10,000 V/μs)
- Dual Diode Construction — Terminals 1 and 3 Must be Connected for Parallel Operation at Full Rating

Mechanical Characteristics

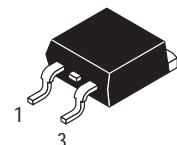
- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per 13" reel by adding a "T4" suffix to the part number
- Marking: B20200



MBRB2020CT

Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIER
20 AMPERES
200 VOLTS**



CASE 418B-02

MAXIMUM RATINGS (PER LEG)

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	200	Volts
Average Rectified Forward Current (Rated V_R) $T_C = 125^\circ\text{C}$	$I_F(AV)$	10 20	Amps Per Leg Per Package
Peak Repetitive Forward Current, Per Leg (Rated V_R , Square Wave, 20 kHz) $T_C = 90^\circ\text{C}$	I_{FRM}	20	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I_{RRM}	1.0	Amp
Operating Junction Temperature	T_J	-65 to +150	°C
Storage Temperature	T_{stg}	-65 to +175	°C
Voltage Rate of Change (Rated V_R)	dv/dt	10,000	V/μs

THERMAL CHARACTERISTICS (PER LEG)

Thermal Resistance — Junction to Case	$R_{\theta JC}$	2.0	°C/W
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ELECTRICAL CHARACTERISTICS (PER LEG)

Maximum Instantaneous Forward Voltage (1) ($I_F = 10$ Amps, $T_C = 25^\circ\text{C}$) ($I_F = 10$ Amps, $T_C = 125^\circ\text{C}$) ($I_F = 20$ Amps, $T_C = 25^\circ\text{C}$) ($I_F = 20$ Amps, $T_C = 125^\circ\text{C}$)	V_F	0.9 0.8 1.0 0.9	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 25^\circ\text{C}$) (Rated dc Voltage, $T_C = 125^\circ\text{C}$)	I_R	1.0 50	mA

DYNAMIC CHARACTERISTICS (PER LEG)

Capacitance ($V_R = -5.0$ V, $T_C = 25^\circ\text{C}$, Frequency = 1.0 MHz)	C_T	500	pF
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(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤2.0%.

Preferred devices are Motorola recommended choices for future use and best overall value.

MBRB20200CT

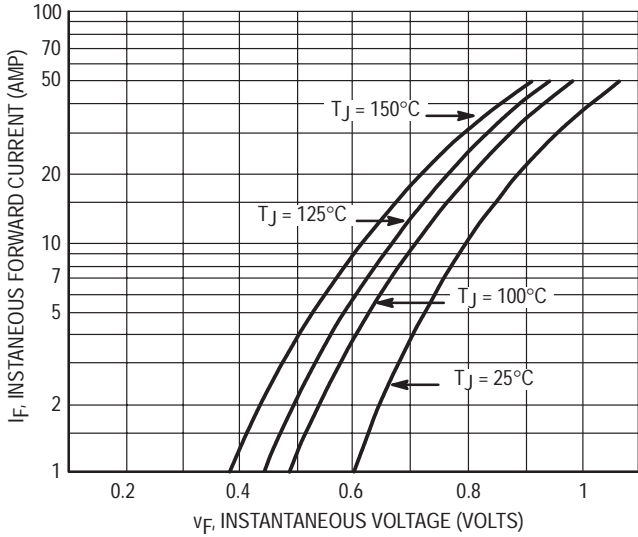


Figure 1. Typical Forward Voltage (Per Leg)

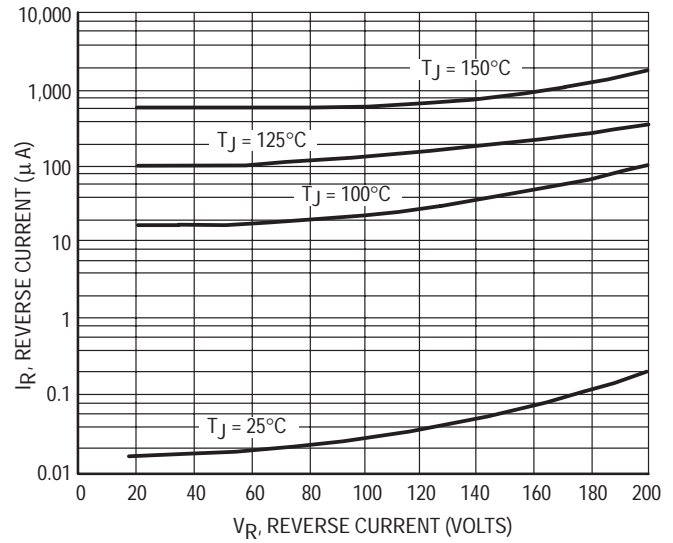


Figure 2. Typical Reverse Current (Per Leg)

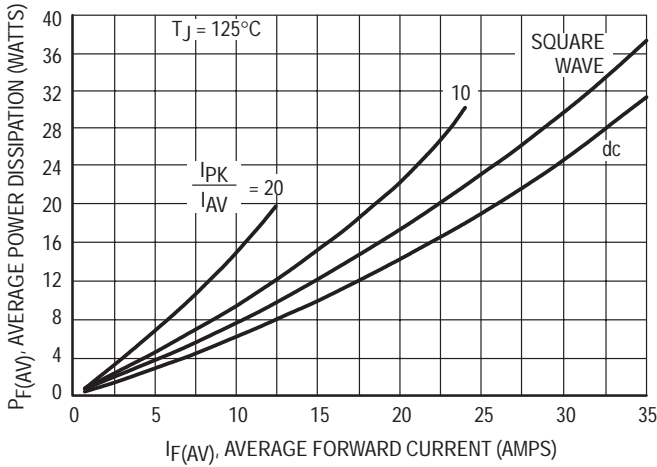


Figure 3. Forward Power Dissipation

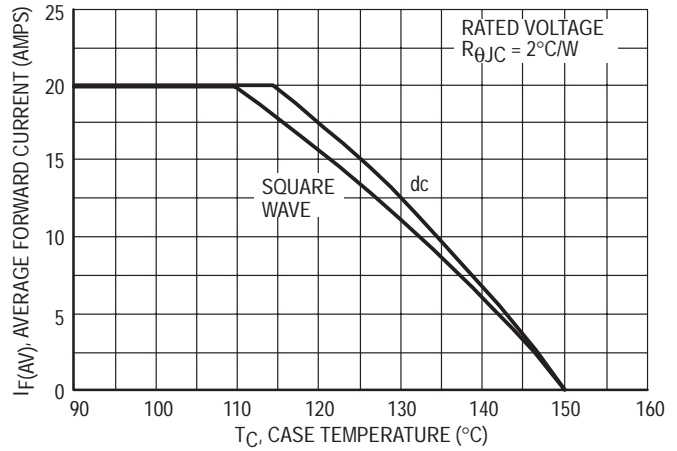


Figure 4. Current Derating, Case

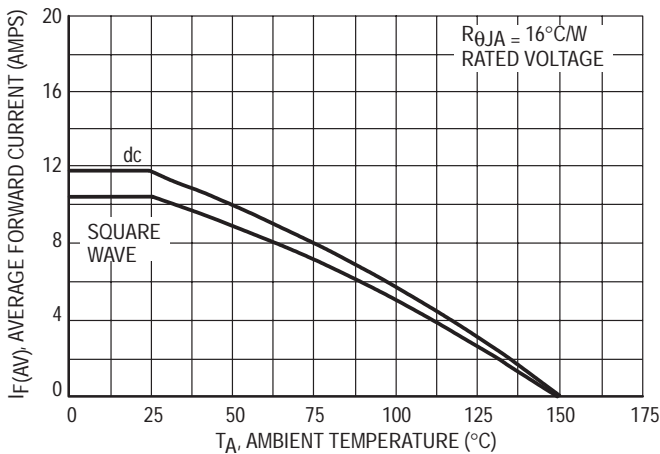


Figure 5. Current Derating, Ambient

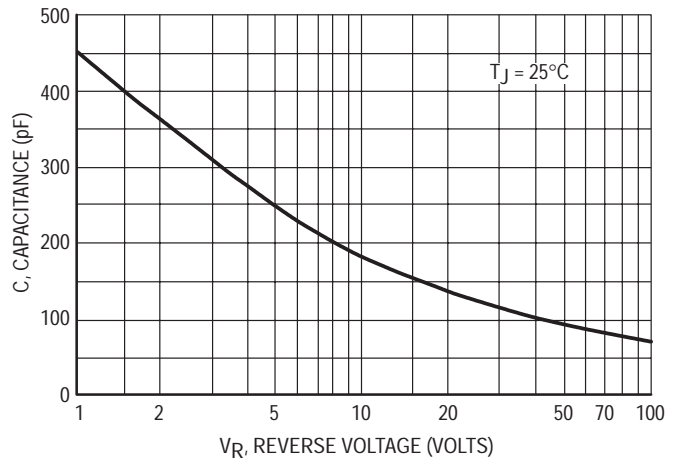


Figure 6. Typical Capacitance (Per Leg)

Designer's™ Data Sheet
SWITCHMODE™ Power Rectifier
OR'ing Function Diode
D2PAK Surface Mount Power Package

MBRB2515L

Motorola Preferred Device

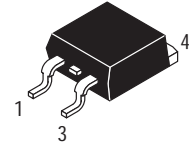
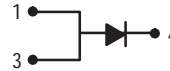
**SCHOTTKY BARRIER
RECTIFIER
25 AMPERES
15 VOLTS**

The D2PAK Power Rectifier employs the Schottky Barrier principle in a large metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use in low voltage, high frequency switching power supplies, free wheeling diodes, and polarity protection diodes. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Low Forward Voltage
- 100°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Guaranteed Reverse Avalanche
- Short Heat Sink Tab Manufactured — Not Sheared!
- Similar in Size to the Industry Standard TO-220 Package

Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per 13" reel by adding a "T4" suffix to the part number
- Marking: B2515L



**CASE 418B-02
D2PAK**

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	15	Volts
Average Rectified Forward Current (Rated V_R) $T_C = 90^\circ\text{C}$	$I_{F(AV)}$	25	Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz) $T_C = 100^\circ\text{C}$	I_{FRM}	30	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150	Amps
Storage Temperature	T_{stg}	-65 to +150	°C
Operating Junction Temperature	T_J	100	°C
Voltage Rate of Change (Rated V_R)	dv/dt	10000	V/ μs

THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Case — Junction to Ambient (1)	$R_{\theta JC}$ $R_{\theta JA}$	1.0 50	°C/W
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(1) When mounted using minimum recommended pad size on FR-4 board.

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

MBRB2515L

ELECTRICAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (2) ($I_F = 19$ Amps, $T_J = 70^\circ\text{C}$) ($I_F = 25$ Amps, $T_J = 70^\circ\text{C}$) ($I_F = 25$ Amps, $T_J = 25^\circ\text{C}$)	V_F	0.28 0.42 0.45	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_J = 70^\circ\text{C}$) (Rated dc Voltage, $T_J = 25^\circ\text{C}$)	I_R	200 15	mA

(2) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$

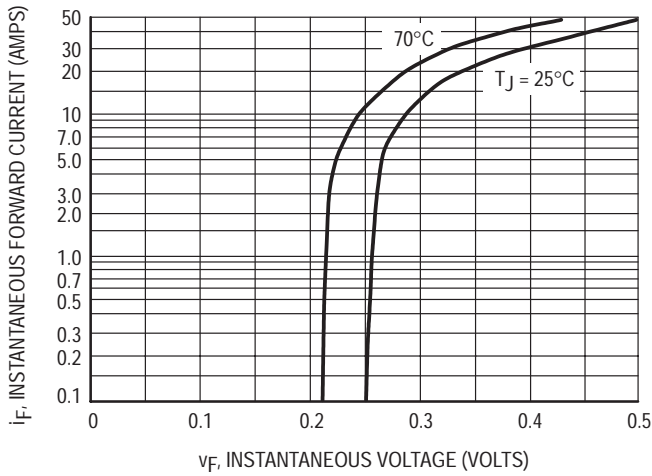


Figure 1. Typical Forward Voltage

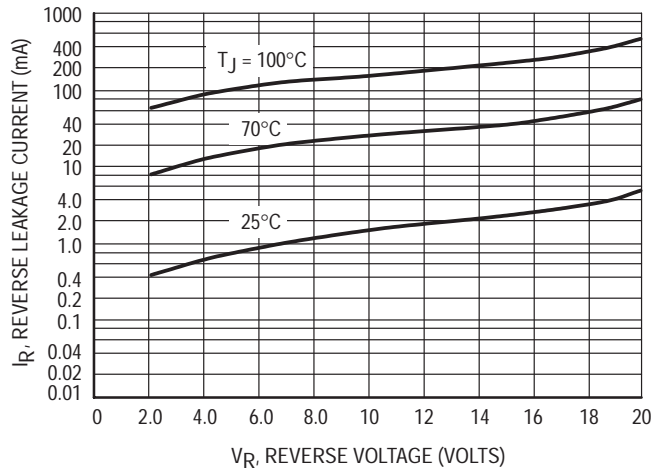


Figure 2. Typical Reverse Leakage Current

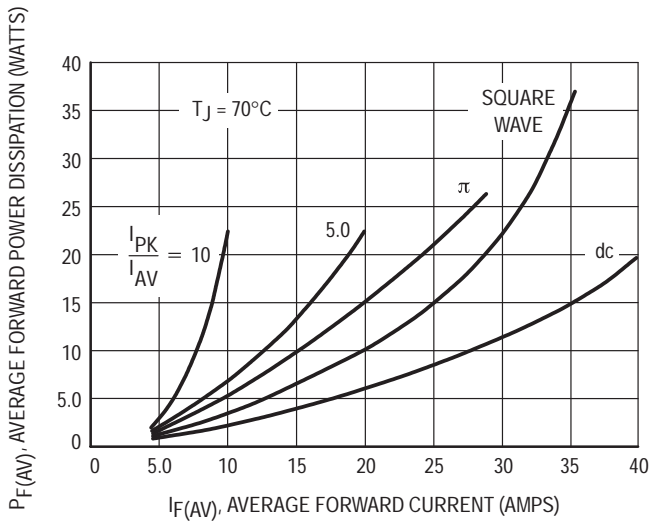


Figure 3. Typical Forward Power Dissipation

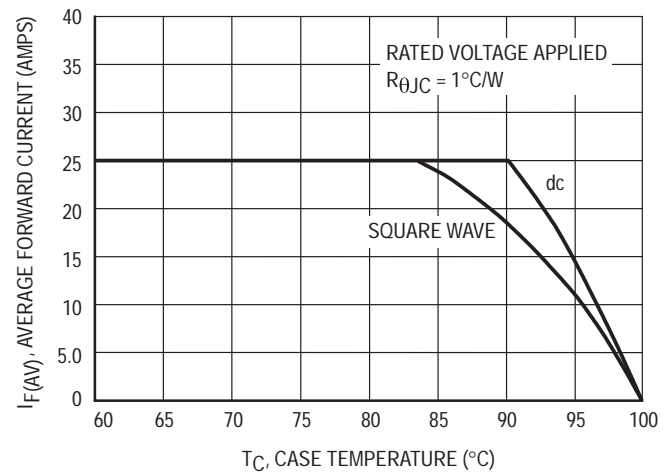
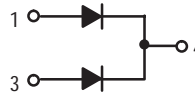


Figure 4. Current Derating, Case

Designer's™ Data Sheet
SWITCHMODE™ Power Rectifier
D²PAK Surface Mount Power Package

The D²PAK Power Rectifier employs the Schottky Barrier principle in a large metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use in low voltage, high frequency switching power supplies, free wheeling diodes, and polarity protection diodes. These state-of-the-art devices have the following features:

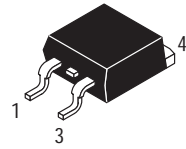
- Center-Tap Configuration
- Guardring for Stress Protection
- Low Forward Voltage
- 125°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Guaranteed Reverse Avalanche
- Short Heat Sink Tab Manufactured — Not Sheared!
- Similar in Size to the Industry Standard TO-220 Package



MBRB2535CTL

Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIER
25 AMPERES
35 VOLTS**



**CASE 418B-02
D²PAK**

Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per 13" reel by adding a "T4" suffix to the part number
- Marking: B2535L

MAXIMUM RATINGS (PER LEG)

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	35	Volts
Average Rectified Forward Current (Rated V_R) $T_C = 110^\circ\text{C}$	$I_{F(AV)}$	12.5	Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz), $T_C = 90^\circ\text{C}$	I_{FRM}	25	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz)	I_{RRM}	1.0	Amp
Storage Temperature	T_{stg}	-65 to +150	$^\circ\text{C}$
Operating Junction Temperature	T_J	-65 to +125	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10,000	V/ μs

THERMAL CHARACTERISTICS (PER LEG)

Thermal Resistance — Junction to Case	$R_{\theta JC}$	2.0	$^\circ\text{C/W}$
— Junction to Ambient (1)	$R_{\theta JA}$	50	

(1) When mounted using minimum recommended pad size on FR-4 board.

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

MBRB2535CTL

ELECTRICAL CHARACTERISTICS (PER LEG)

Rating	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (2)	V _F	(i _F = 25 Amps, T _J = 25°C)	0.55
		(i _F = 12.5 Amps, T _J = 125°C)	0.41
		(i _F = 12.5 Amps, T _J = 25°C)	0.47
Maximum Instantaneous Reverse Current (2)	i _R	(Rated dc Voltage, T _J = 125°C)	500
		(Rated dc Voltage, T _J = 25°C)	10

(2) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

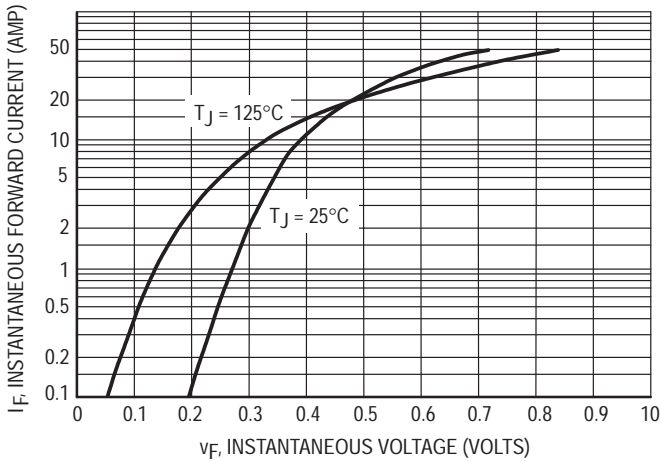


Figure 1. Typical Forward Voltage, Per Leg

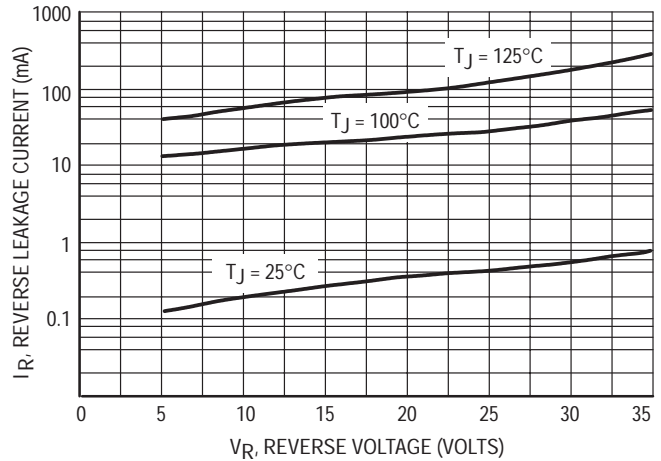


Figure 2. Typical Reverse Current, Per Leg

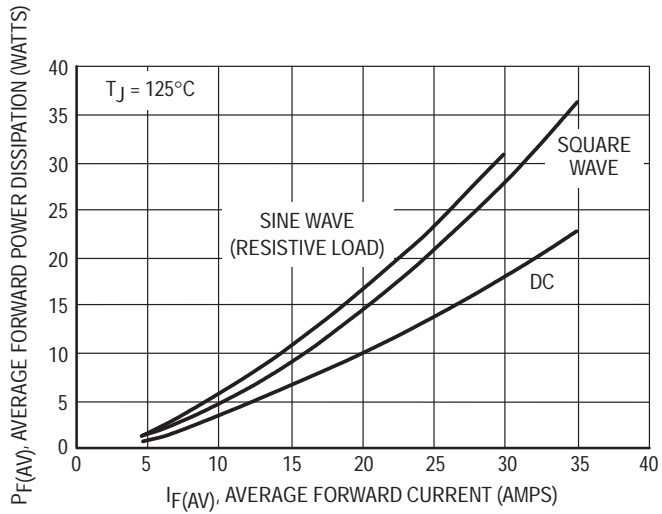


Figure 3. Typical Forward Power Dissipation

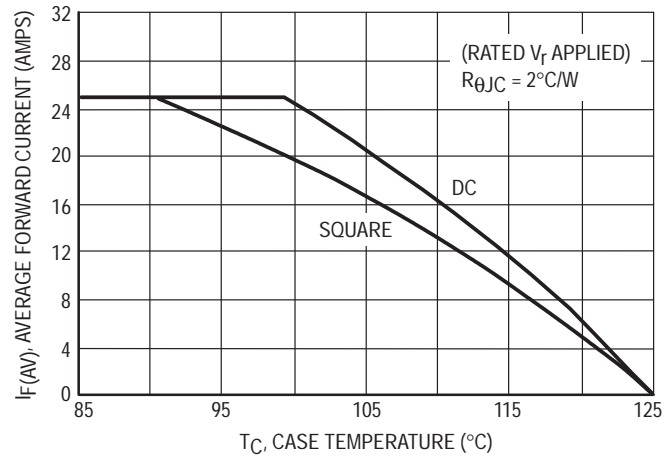


Figure 4. Current Derating, Case

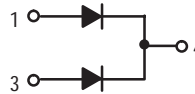
Designer's™ Data Sheet
SWITCHMODE™ Power Rectifier
D²PAK Surface Mount Power Package

The D²PAK Power Rectifier employs the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Center-Tap Configuration
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Guaranteed Reverse Avalanche
- Short Heat Sink Tab Manufactured — Not Sheared!
- Similar in Size to the Industry Standard TO-220 Package

Mechanical Characteristics

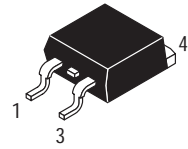
- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per 13" reel by adding a "T4" suffix to the part number
- Marking: B2545T



MBRB2545CT

Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIER
30 AMPERES
45 VOLTS**



**CASE 418B-02
D²PAK**

MAXIMUM RATINGS (PER LEG)

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	45	Volts
Average Rectified Forward Current (Rated V_R) $T_C = 130^\circ\text{C}$	$I_{F(AV)}$	15 30	Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz), $T_C = 130^\circ\text{C}$	I_{FRM}	30	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz)	I_{RRM}	1.0	Amp
Storage Temperature	T_{stg}	-65 to +175	$^\circ\text{C}$
Operating Junction Temperature	T_J	-65 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10000	$\text{V}/\mu\text{s}$

THERMAL CHARACTERISTICS (PER LEG)

Thermal Resistance — Junction to Case	$R_{\theta JC}$	1.5	$^\circ\text{C}/\text{W}$
— Junction to Ambient (1)	$R_{\theta JA}$	50	

(1) When mounted using minimum recommended pad size on FR-4 board.

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

MBRB2545CT

ELECTRICAL CHARACTERISTICS (PER LEG)

Rating	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (2) ($i_F = 30$ Amps, $T_J = 125^\circ\text{C}$) ($i_F = 30$ Amps, $T_J = 25^\circ\text{C}$)	v_F	0.73 0.82	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_J = 125^\circ\text{C}$) (Rated dc Voltage, $T_J = 25^\circ\text{C}$)	i_R	40 0.2	mA

(2) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

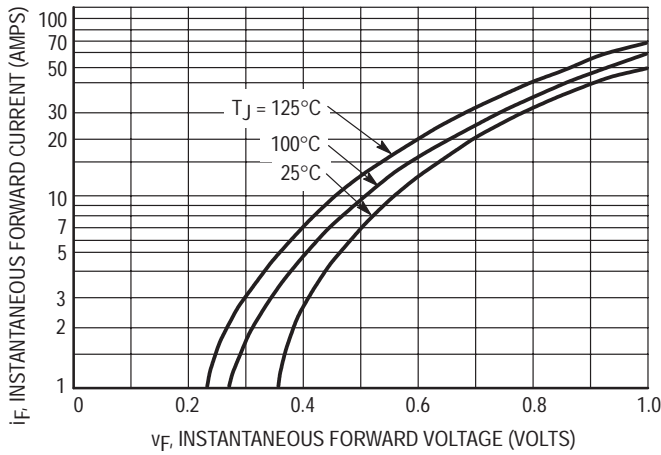


Figure 5. Typical Forward Voltage, Per Leg

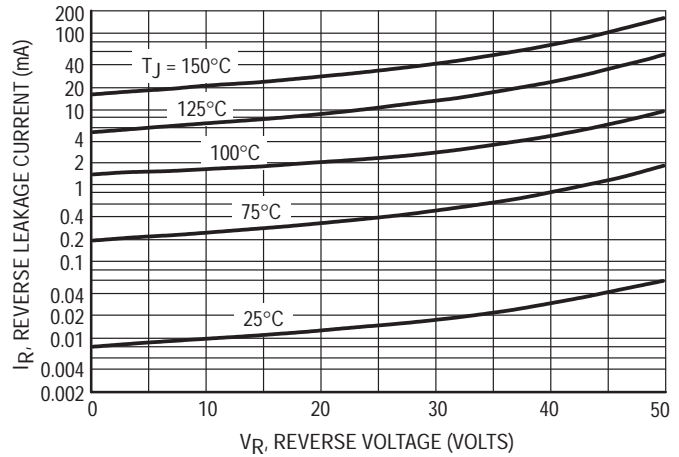


Figure 6. Typical Reverse Current, Per Leg

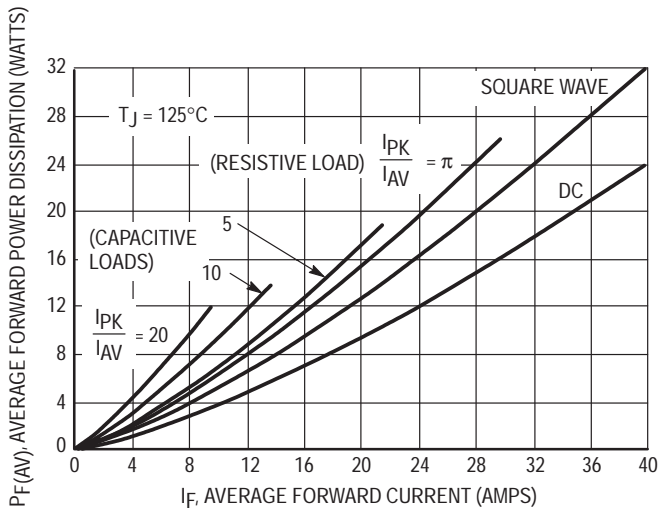


Figure 7. Typical Forward Power Dissipation

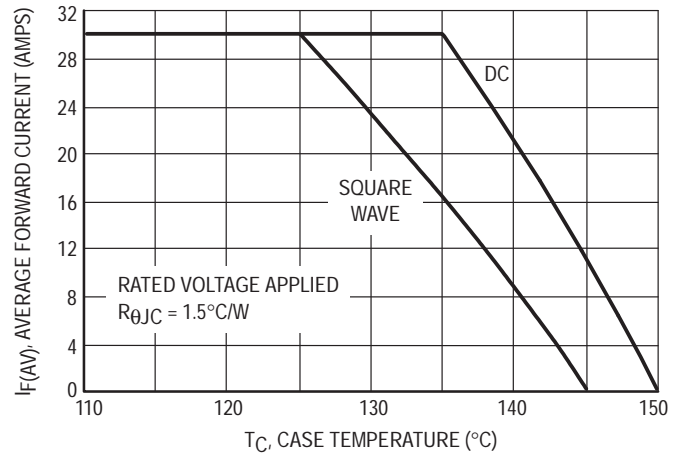


Figure 8. Current Derating, Case

Axial Lead Rectifiers

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features chrome barrier metal, epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Extremely Low v_f
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency

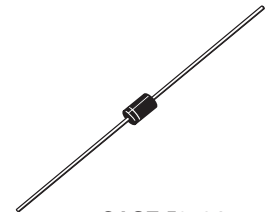
Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 1000 per bag.
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: 1N5817, 1N5818, 1N5819

1N5817
1N5818
1N5819

1N5817 and 1N5819 are
Motorola Preferred Devices

**SCHOTTKY BARRIER
RECTIFIERS
1 AMPERE
20, 30 and 40 VOLTS**



CASE 59-04

MAXIMUM RATINGS

Rating	Symbol	1N5817	1N5818	1N5819	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	20	30	40	V
Non-Repetitive Peak Reverse Voltage	V_{RSM}	24	36	48	V
RMS Reverse Voltage	$V_{R(RMS)}$	14	21	28	V
Average Rectified Forward Current (2) ($V_{R(equiv)} \leq 0.2 V_{R(dc)}$, $T_L = 90^\circ\text{C}$, $R_{\theta JA} = 80^\circ\text{C/W}$, P.C. Board Mounting, see Note 2, $T_A = 55^\circ\text{C}$)	I_O	1.0			A
Ambient Temperature (Rated $V_R(dc)$, $P_{F(AV)} = 0$, $R_{\theta JA} = 80^\circ\text{C/W}$)	T_A	85	80	75	°C
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, half-wave, single phase 60 Hz, $T_L = 70^\circ\text{C}$)	I_{FSM}	25 (for one cycle)			A
Operating and Storage Junction Temperature Range (Reverse Voltage applied)	T_J, T_{stg}	-65 to +125			°C
Peak Operating Junction Temperature (Forward Current applied)	$T_{J(pk)}$	150			°C

THERMAL CHARACTERISTICS (2)

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	80	°C/W

ELECTRICAL CHARACTERISTICS ($T_L = 25^\circ\text{C}$ unless otherwise noted) (2)

Characteristic	Symbol	1N5817	1N5818	1N5819	Unit
Maximum Instantaneous Forward Voltage (1) ($i_F = 0.1 \text{ A}$) ($i_F = 1.0 \text{ A}$) ($i_F = 3.0 \text{ A}$)	v_F	0.32 0.45 0.75	0.33 0.55 0.875	0.34 0.6 0.9	V
Maximum Instantaneous Reverse Current @ Rated dc Voltage (1) ($T_L = 25^\circ\text{C}$) ($T_L = 100^\circ\text{C}$)	I_R	1.0 10	1.0 10	1.0 10	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle = 2.0%.

(2) Lead Temperature reference is cathode lead 1/32" from case.

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 3

1N5817 1N5818 1N5819

NOTE 1 — DETERMINING MAXIMUM RATINGS

Reverse power dissipation and the possibility of thermal runaway must be considered when operating this rectifier at reverse voltages above $0.1 V_{RWM}$. Proper derating may be accomplished by use of equation (1).

$$T_{A(max)} = T_{J(max)} - R_{\theta JA} P_{F(AV)} - R_{\theta JA} P_{R(AV)} \quad (1)$$

where $T_{A(max)}$ = Maximum allowable ambient temperature

$T_{J(max)}$ = Maximum allowable junction temperature (125°C or the temperature at which thermal runaway occurs, whichever is lowest)

$P_{F(AV)}$ = Average forward power dissipation

$P_{R(AV)}$ = Average reverse power dissipation

$R_{\theta JA}$ = Junction-to-ambient thermal resistance

Figures 1, 2, and 3 permit easier use of equation (1) by taking reverse power dissipation and thermal runaway into consideration. The figures solve for a reference temperature as determined by equation (2).

$$T_R = T_{J(max)} - R_{\theta JA} P_{R(AV)} \quad (2)$$

Substituting equation (2) into equation (1) yields:

$$T_{A(max)} = T_R - R_{\theta JA} P_{F(AV)} \quad (3)$$

Inspection of equations (2) and (3) reveals that T_R is the ambient temperature at which thermal runaway occurs or where $T_J = 125^\circ\text{C}$, when forward power is zero. The transition from one boundary condition to the other is evident on the curves of Figures 1, 2, and 3 as a difference in the rate of change of the slope in the vicinity of 115°C . The data of Figures 1, 2, and 3 is based upon dc conditions. For use in common rectifier circuits, Table 1 indicates suggested factors for an equivalent dc voltage to use for conservative design, that is:

$$V_{R(equiv)} = V_{in(PK)} \times F \quad (4)$$

The factor F is derived by considering the properties of the various recifier circuits and the reverse characteristics of Schottky diodes.

EXAMPLE: Find $T_{A(max)}$ for 1N5818 operated in a 12-volt dc supply using a bridge circuit with capacitive filter such that $I_{DC} = 0.4 \text{ A}$ ($I_{F(AV)} = 0.5 \text{ A}$), $I_{(FM)}/I_{(AV)} = 10$, Input Voltage = 10 V_(rms), $R_{\theta JA} = 80^\circ\text{C/W}$.

Step 1. Find $V_{R(equiv)}$. Read $F = 0.65$ from Table 1, $\therefore V_{R(equiv)} = (1.41)(10)(0.65) = 9.2 \text{ V}$.

Step 2. Find T_R from Figure 2. Read $T_R = 109^\circ\text{C}$ @ $V_R = 9.2 \text{ V}$ and $R_{\theta JA} = 80^\circ\text{C/W}$.

Step 3. Find $P_{F(AV)}$ from Figure 4. **Read $P_{F(AV)} = 0.5 \text{ W}$

$$\text{@ } \frac{I_{(FM)}}{I_{(AV)}} = 10 \text{ and } I_{F(AV)} = 0.5 \text{ A.}$$

Step 4. Find $T_{A(max)}$ from equation (3).

$$T_{A(max)} = 109 - (80)(0.5) = 69^\circ\text{C}.$$

**Values given are for the 1N5818. Power is slightly lower for the 1N5817 because of its lower forward voltage, and higher for the 1N5819.

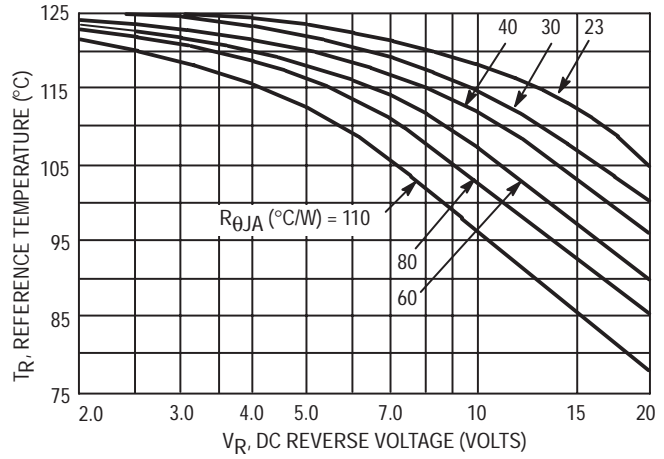


Figure 1. Maximum Reference Temperature 1N5817

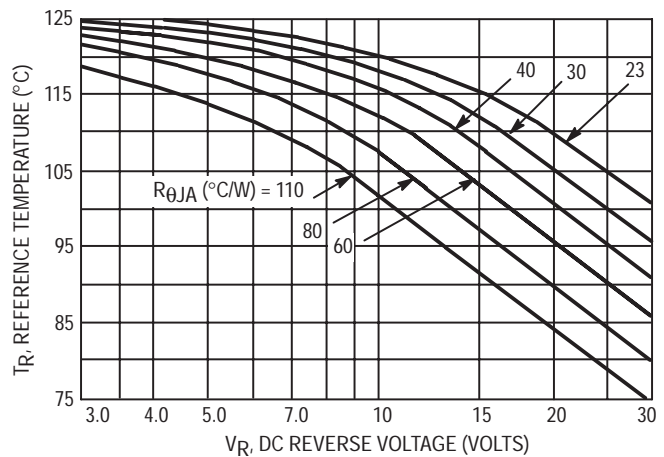


Figure 2. Maximum Reference Temperature 1N5818

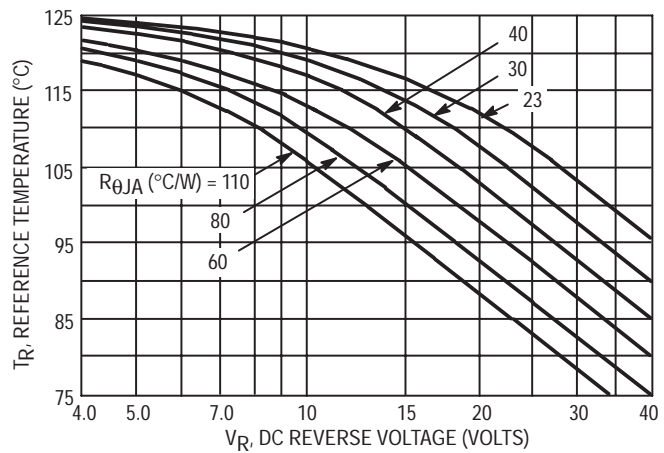


Figure 3. Maximum Reference Temperature 1N5819

Table 1. Values for Factor F

Circuit	Half Wave		Full Wave, Bridge		Full Wave, Center Tapped* †	
	Resistive	Capacitive*	Resistive	Capacitive	Resistive	Capacitive
Sine Wave	0.5	1.3	0.5	0.65	1.0	1.3
Square Wave	0.75	1.5	0.75	0.75	1.5	1.5

*Note that $V_{R(PK)} = 2.0 V_{in(PK)}$.

† Use line to center tap voltage for V_{in} .

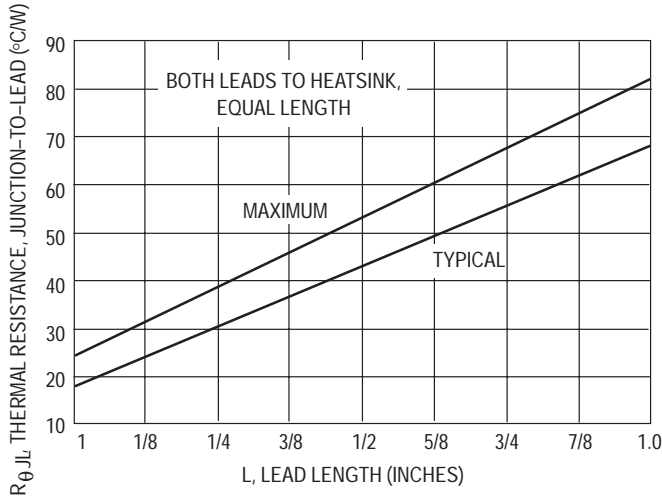


Figure 4. Steady-State Thermal Resistance

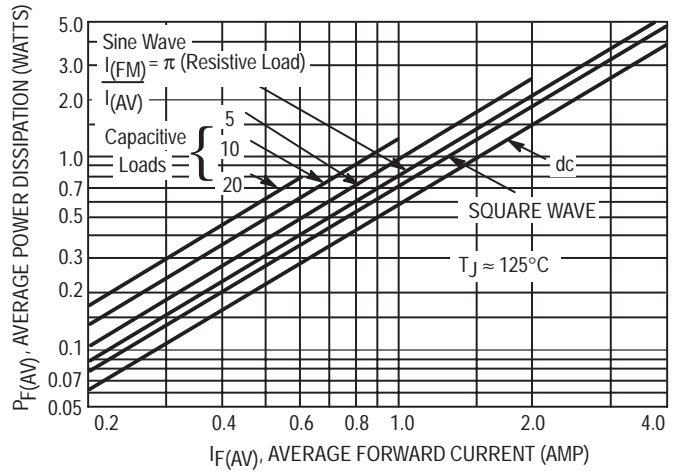


Figure 5. Forward Power Dissipation
1N5817-19

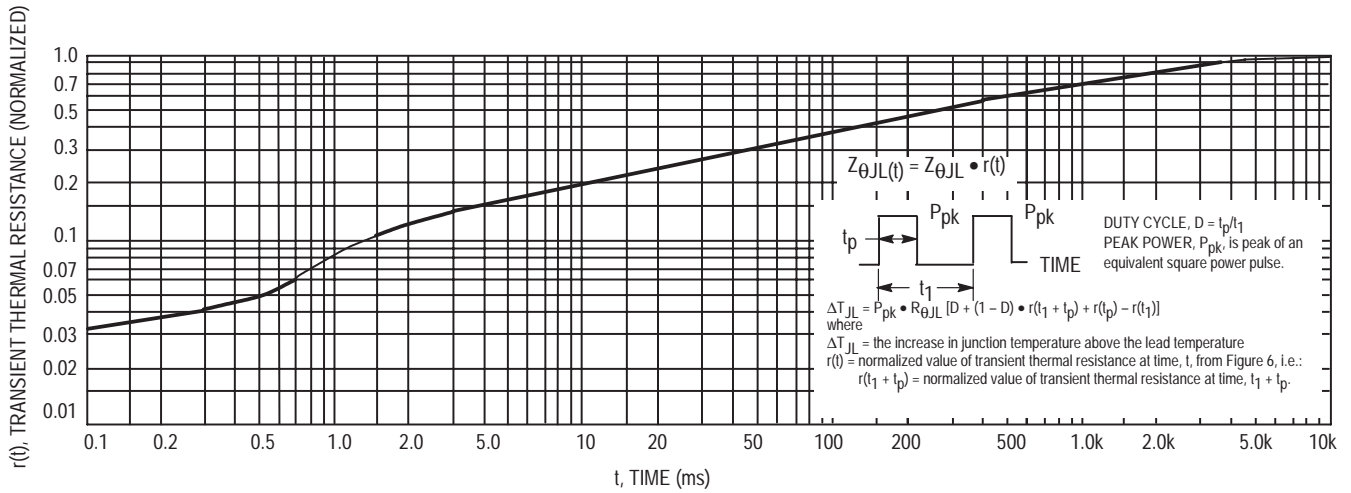


Figure 6. Thermal Response

NOTE 2 — MOUNTING DATA

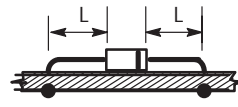
Data shown for thermal resistance junction-to-ambient ($R_{\theta JA}$) for the mountings shown is to be used as typical guideline values for preliminary engineering, or in case the tie point temperature cannot be measured.

TYPICAL VALUES FOR $R_{\theta JA}$ IN STILL AIR

Mounting Method	Lead Length, L (in)				$R_{\theta JA}$
	1/8	1/4	1/2	3/4	
1	52	65	72	85	$^{\circ}\text{C}/\text{W}$
2	67	80	87	100	$^{\circ}\text{C}/\text{W}$
3	50				$^{\circ}\text{C}/\text{W}$

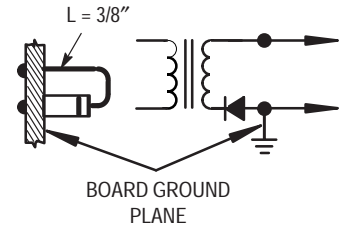
Mounting Method 1

P.C. Board with 1-1/2" x 1-1/2" copper surface.

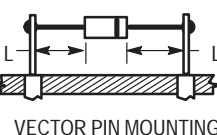


Mounting Method 3

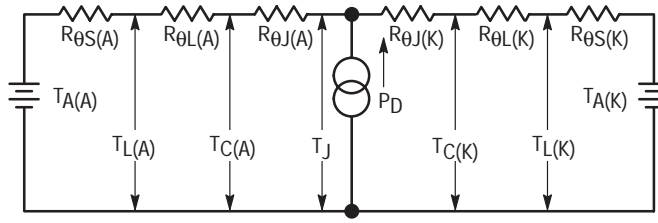
P.C. Board with 1-1/2" x 1-1/2" copper surface.



Mounting Method 2



NOTE 3 — THERMAL CIRCUIT MODEL
(For heat conduction through the leads)



Use of the above model permits junction to lead thermal resistance for any mounting configuration to be found. For a given total lead length, lowest values occur when one side of the rectifier is brought as close as possible to the heatsink. Terms in the model signify:

- T_A = Ambient Temperature T_C = Case Temperature
- T_L = Lead Temperature T_J = Junction Temperature
- $R_{\theta S}$ = Thermal Resistance, Heatsink to Ambient
- $R_{\theta L}$ = Thermal Resistance, Lead to Heatsink
- $R_{\theta J}$ = Thermal Resistance, Junction to Case
- P_D = Power Dissipation

(Subscripts A and K refer to anode and cathode sides, respectively.)
Values for thermal resistance components are:
 $R_{\theta L}$ = 100°C/W/in typically and 120°C/W/in maximum
 $R_{\theta J}$ = 36°C/W typically and 46°C/W maximum.

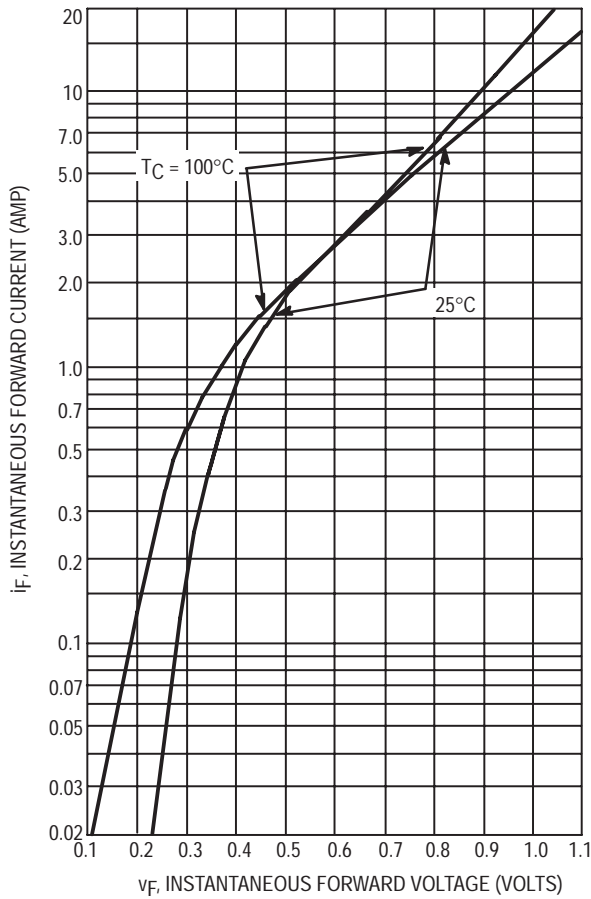


Figure 7. Typical Forward Voltage

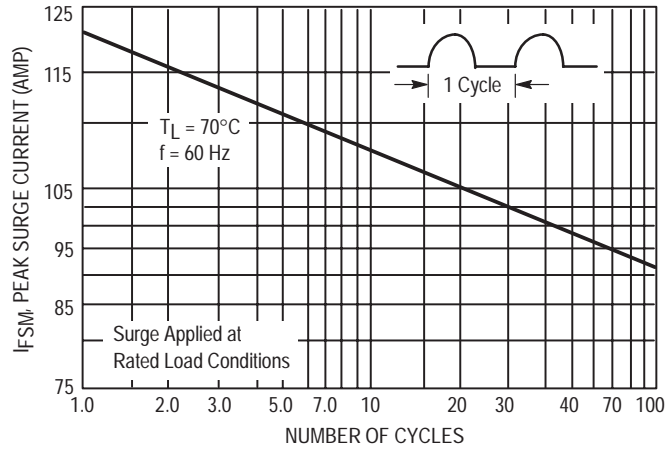


Figure 8. Maximum Non-Repetitive Surge Current

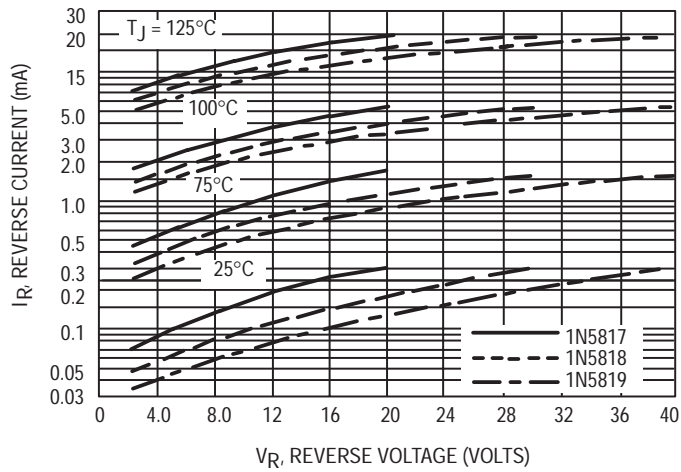


Figure 9. Typical Reverse Current

NOTE 4 — HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 10.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 percent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss: it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

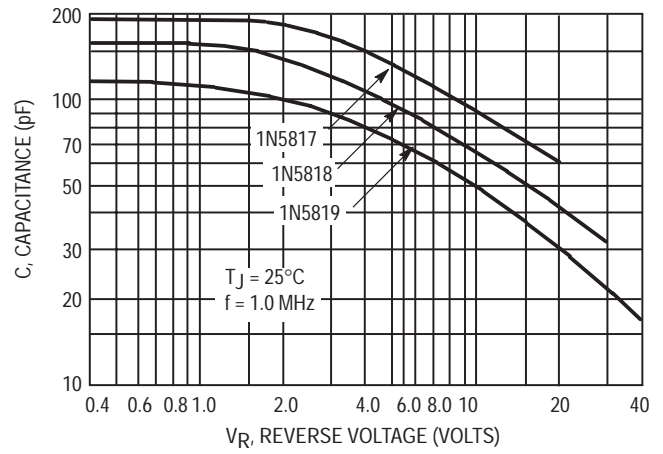


Figure 10. Typical Capacitance

Axial Lead Rectifiers

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Low Reverse Current
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency
- Highly Stable Oxide Passivated Junction

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 1000 per bag
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: B150, B160

MBR150
MBR160

MBR160 is a
Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIERS**
1 AMPERE
50, 60 VOLTS



MAXIMUM RATINGS

Rating	Symbol	MBR150	MBR160	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	50	60	Volts
RMS Reverse Voltage	$V_{R(RMS)}$	35	42	Volts
Average Rectified Forward Current (2) ($V_R(\text{equiv}) \leq 0.2 V_R(\text{dc})$, $T_L = 90^\circ\text{C}$, $R_{\theta JA} = 80^\circ\text{C/W}$, P.C. Board Mounting, see Note 3, $T_A = 55^\circ\text{C}$)	I_O	1		Amp
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz, $T_L = 70^\circ\text{C}$)	I_{FSM}	25 (for one cycle)		Amps
Operating and Storage Junction Temperature Range (Reverse Voltage applied)	T_J, T_{stg}	- 65 to +150		$^\circ\text{C}$
Peak Operating Junction Temperature (Forward Current applied)	$T_{J(pk)}$	150		$^\circ\text{C}$

THERMAL CHARACTERISTICS (Notes 3 and 4)

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	80	$^\circ\text{C/W}$

ELECTRICAL CHARACTERISTICS ($T_L = 25^\circ\text{C}$ unless otherwise noted) (2)

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (1) ($i_F = 0.1 \text{ A}$) ($i_F = 1 \text{ A}$) ($i_F = 3 \text{ A}$)	V_F	0.550 0.750 1.000	Volt
Maximum Instantaneous Reverse Current @ Rated dc Voltage (1) ($T_L = 25^\circ\text{C}$) ($T_L = 100^\circ\text{C}$)	i_R	0.5 5	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.
(2) Lead Temperature reference is cathode lead 1/32" from case.

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

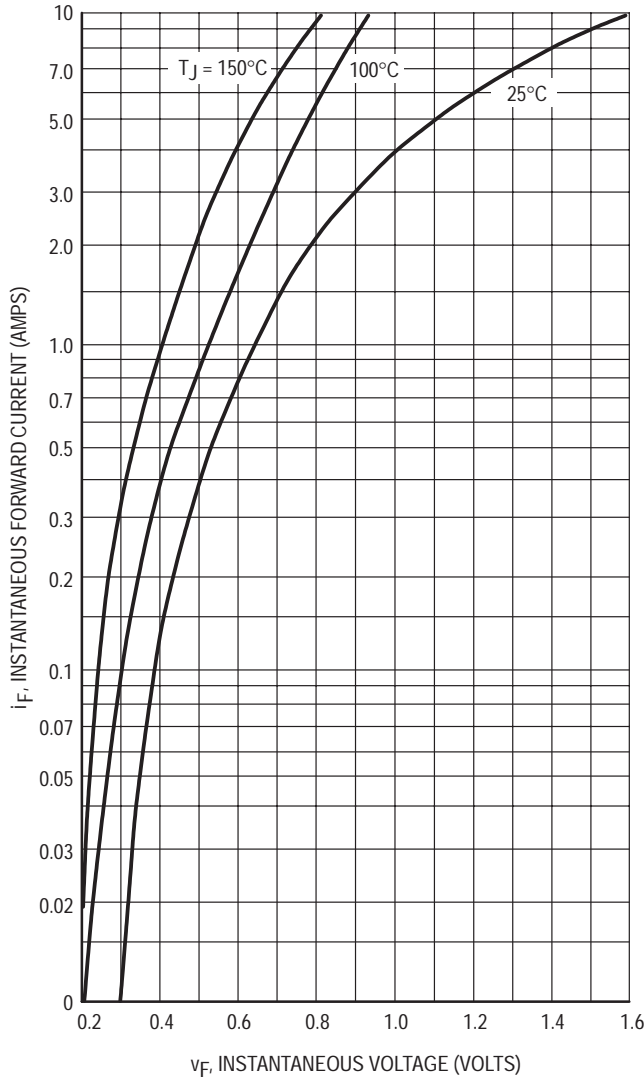


Figure 1. Typical Forward Voltage

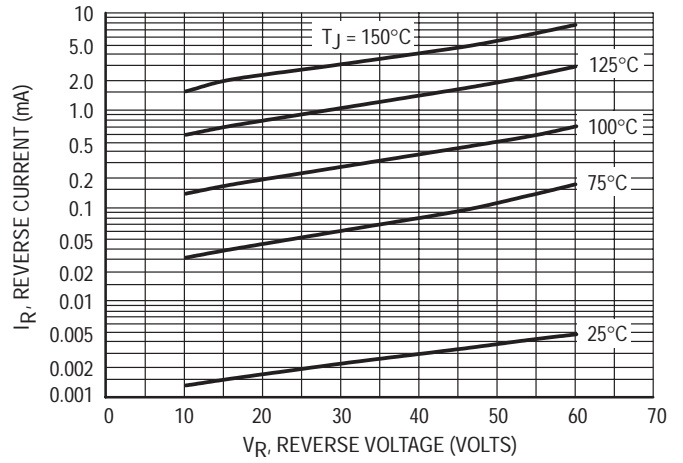


Figure 2. Typical Reverse Current*

*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V_R is sufficiently below rated V_R .

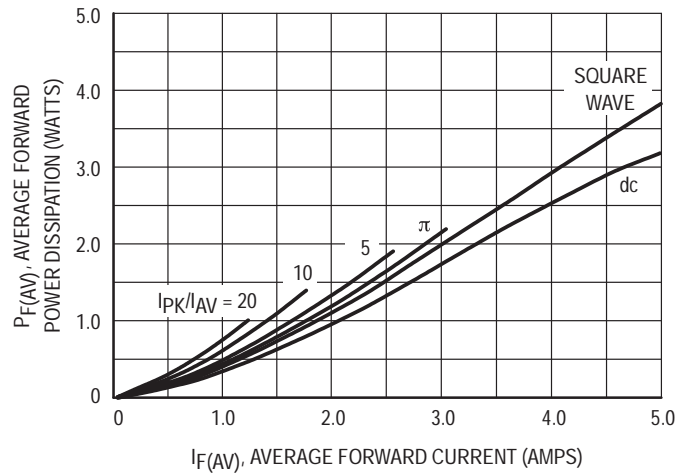


Figure 3. Forward Power Dissipation

THERMAL CHARACTERISTICS

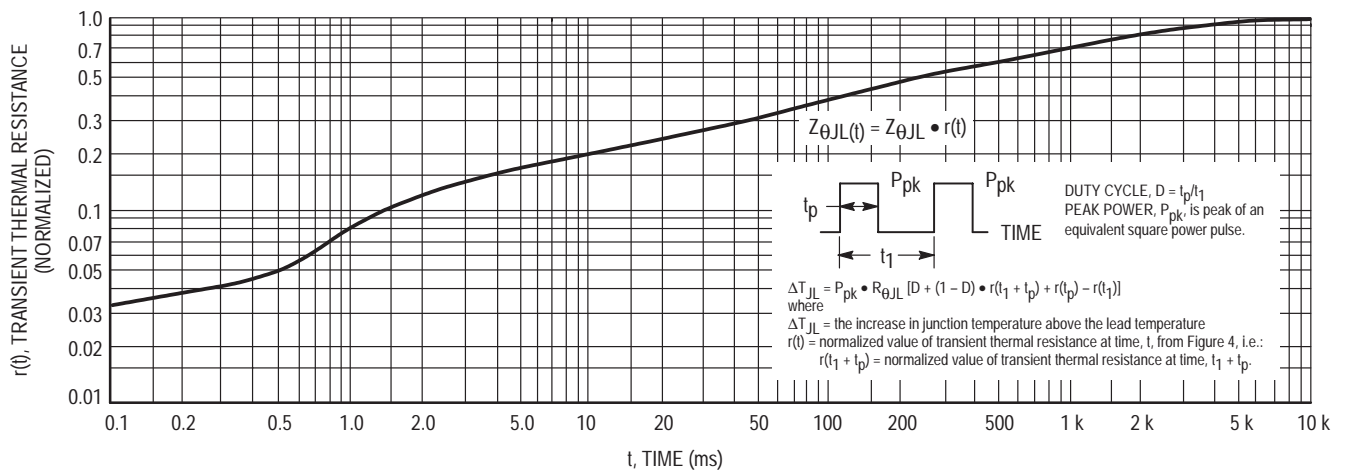


Figure 4. Thermal Response

MBR150 MBR160

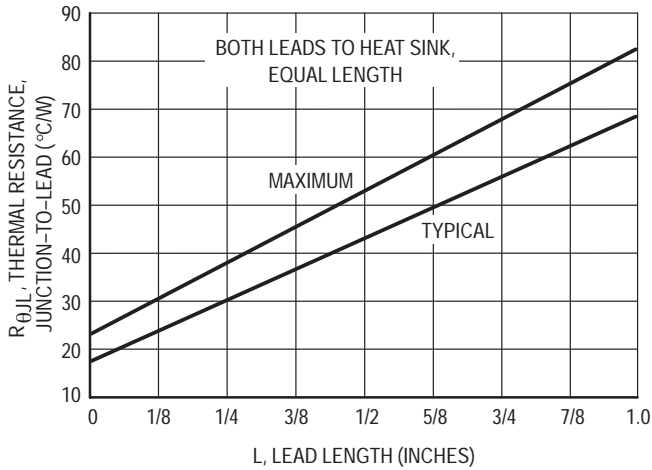


Figure 5. Steady-State Thermal Resistance

NOTE 3 — MOUNTING DATA:

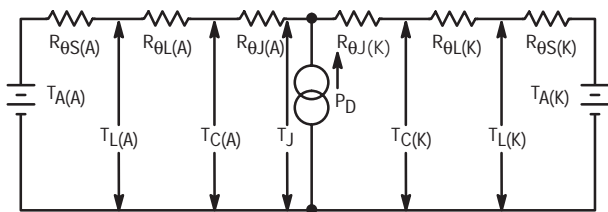
Data shown for thermal resistance junction-to-ambient ($R_{\theta JA}$) for the mounting shown is to be used as a typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

Typical Values for $R_{\theta JA}$ in Still Air

Mounting Method	Lead Length, L (in)				$R_{\theta JA}$
	1/8	1/4	1/2	3/4	
1	52	65	72	85	°C/W
2	67	80	87	100	°C/W
3	—	50			°C/W

NOTE 4 — THERMAL CIRCUIT MODEL:

(For heat conduction through the leads)



Use of the above model permits junction to lead thermal resistance for any mounting configuration to be found. For a given total lead length, lowest values occur when one side of the rectifier is brought as close as possible to the heat sink. Terms in the model signify:

T_A = Ambient Temperature T_C = Case Temperature
 T_L = Lead Temperature T_J = Junction Temperature
 $R_{\theta S}$ = Thermal Resistance, Heat Sink to Ambient
 $R_{\theta L}$ = Thermal Resistance, Lead to Heat Sink
 $R_{\theta J}$ = Thermal Resistance, Junction to Case
 P_D = Power Dissipation

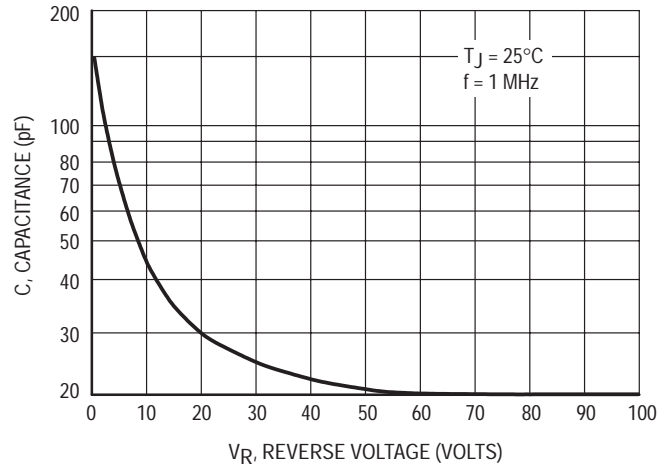
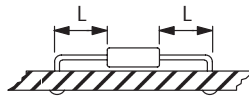


Figure 6. Typical Capacitance

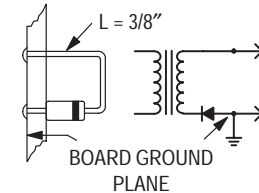
Mounting Method 1

P.C. Board with 1-1/2" x 1-1/2" copper surface.

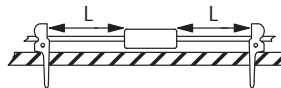


Mounting Method 3

P.C. Board with 1-1/2" x 1-1/2" copper surface.



Mounting Method 2



VECTOR PIN MOUNTING

(Subscripts A and K refer to anode and cathode sides, respectively.) Values for thermal resistance components are: $R_{\theta L} = 100^\circ\text{C/W/in}$ typically and 120°C/W/in maximum. $R_{\theta J} = 36^\circ\text{C/W}$ typically and 46°C/W maximum.

NOTE 5 — HIGH FREQUENCY OPERATION:

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 6.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 percent at 2 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss: it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

Axial Lead Rectifiers

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Low Reverse Current
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency
- Highly Stable Oxide Passivated Junction
- Guard-Ring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- High Surge Capacity

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 1000 per bag
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: B170, B180, B190, B1100

MAXIMUM RATINGS

Rating	Symbol	MBR170	MBR180	MBR190	MBR1100	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	70	80	90	100	Volts
Average Rectified Forward Current ($V_{R(equiv)} \leq 0.2 V_R(dc)$, $R_{\theta JA} = 50^\circ C/W$, P.C. Board Mounting, see Note 1, $T_A = 120^\circ C$)	I_O	1				Amp
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, half-wave, single phase, 60 Hz)	I_{FSM}	50				Amps
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-65 to +150				°C
Voltage Rate of Change (Rated V_R)	dv/dt	10				V/ns

THERMAL CHARACTERISTICS (See Note 2)

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	See Note 1	°C/W

ELECTRICAL CHARACTERISTICS ($T_L = 25^\circ C$ unless otherwise noted)

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (1) ($i_F = 1 A, T_L = 25^\circ C$) ($i_F = 1 A, T_L = 100^\circ C$)	V_F	0.79 0.69	Volt
Maximum Instantaneous Reverse Current @ Rated dc Voltage (1) ($T_L = 25^\circ C$) ($T_L = 100^\circ C$)	i_R	0.5 5	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

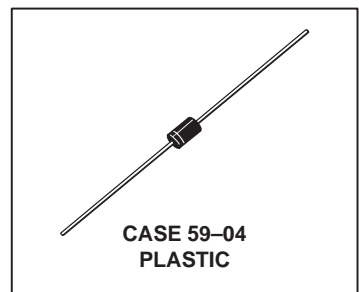
Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

MBR170
MBR180
MBR190
MBR1100

MBR1100 is a
Motorola Preferred Device

SCHOTTKY BARRIER
RECTIFIERS
1 AMPERE
70, 80, 90, 100 VOLTS



MBR170 MBR180 MBR190 MBR1100

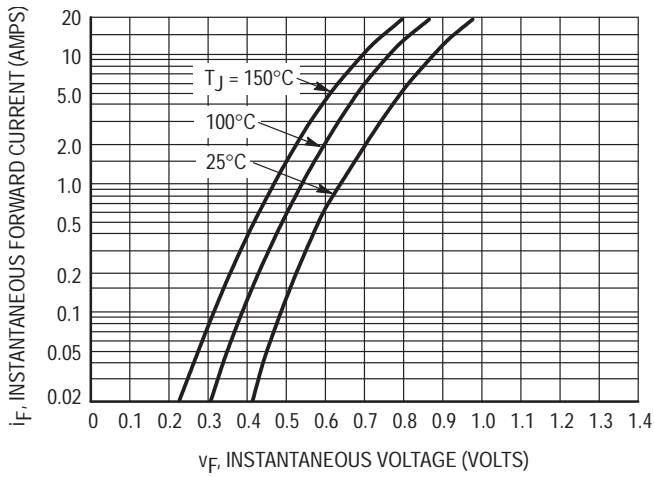


Figure 1. Typical Forward Voltage

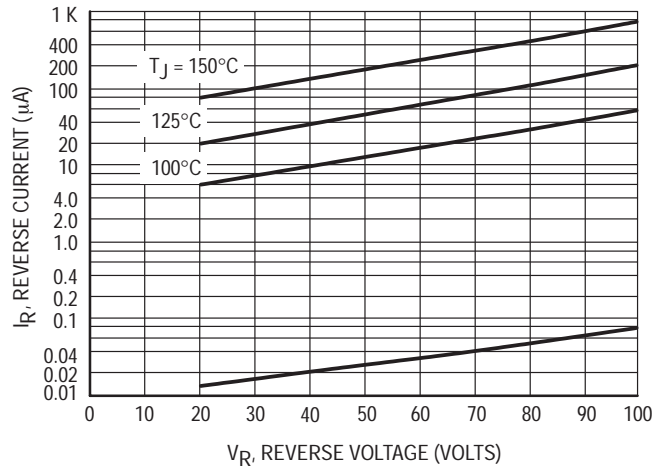
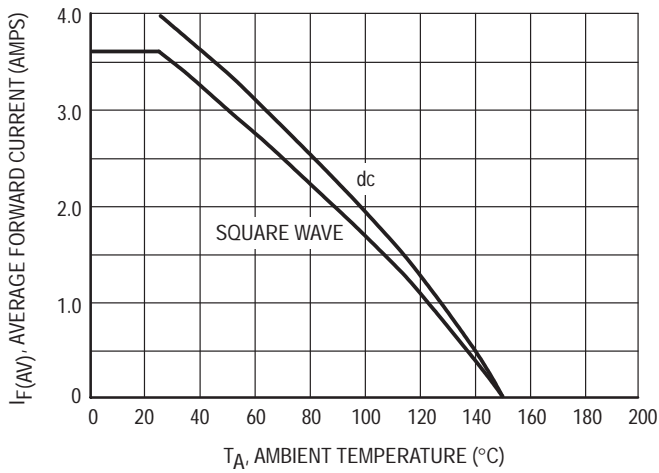


Figure 2. Typical Reverse Current*

*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V_R is sufficiently below rated V_R .



**Figure 3. Current Derating
(Mounting method 3 per note 1.)**

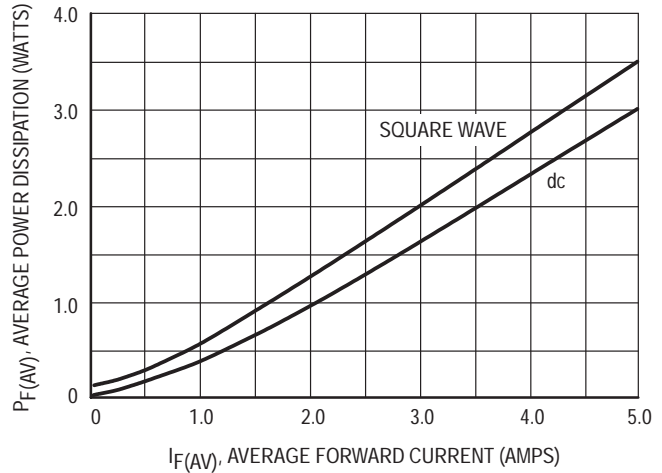


Figure 4. Power Dissipation

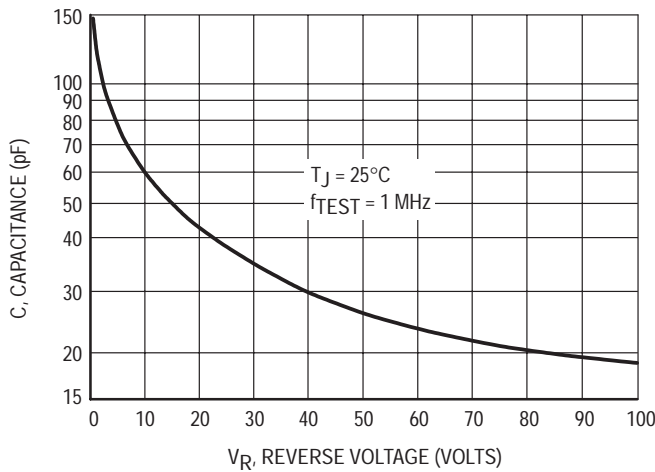


Figure 5. Typical Capacitance

NOTE 1 — MOUNTING DATA:

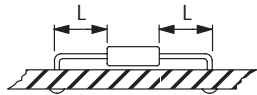
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Typical Values for $R_{\theta JA}$ in Still Air

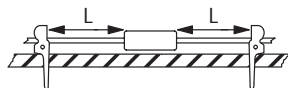
Mounting Method	Lead Length, L (in)				$R_{\theta JA}$
	1/8	1/4	1/2	3/4	
1	52	65	72	85	$^{\circ}\text{C}/\text{W}$
2	67	80	87	100	$^{\circ}\text{C}/\text{W}$
3	—	50			$^{\circ}\text{C}/\text{W}$

Mounting Method 1

P.C. Board with 1-1/2" x 1-1/2" copper surface.



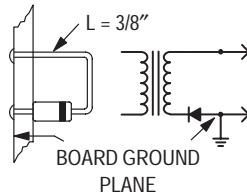
Mounting Method 2



VECTOR PIN MOUNTING

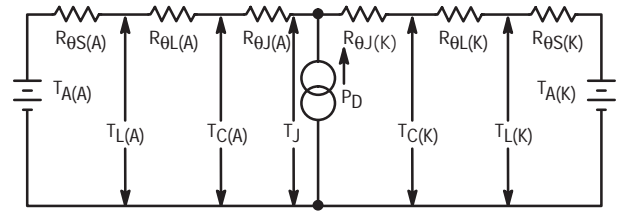
Mounting Method 3

P.C. Board with 1-1/2" x 1-1/2" copper surface.



NOTE 2 — THERMAL CIRCUIT MODEL:

(For heat conduction through the leads)



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(Subscripts A and K refer to anode and cathode sides, respectively.) Values for thermal resistance components are: $R_{\theta L} = 100^{\circ}\text{C}/\text{W}/\text{in}$ typically and $120^{\circ}\text{C}/\text{W}/\text{in}$ maximum. $R_{\theta J} = 36^{\circ}\text{C}/\text{W}$ typically and $46^{\circ}\text{C}/\text{W}$ maximum.

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Designer's™ Data Sheet

Axial Lead Rectifiers

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features chrome barrier metal, epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Extremely Low v_f
- Low Power Loss/High Efficiency
- Low Stored Charge, Majority Carrier Conduction

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 5,000 per bag
- Available Tape and Reeled, 1500 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode indicated by Polarity Band
- Marking: 1N5820, 1N5821, 1N5822

MAXIMUM RATINGS

Rating	Symbol	1N5820	1N5821	1N5822	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	20	30	40	V
Non-Repetitive Peak Reverse Voltage	V_{RSM}	24	36	48	V
RMS Reverse Voltage	$V_{R(RMS)}$	14	21	28	V
Average Rectified Forward Current (2) $V_{R(equiv)} \leq 0.2 V_{R(dc)}$, $T_L = 95^\circ C$ ($R_{\theta JA} = 28^\circ C/W$, P.C. Board Mounting, see Note 2)	I_O	← 3.0 →			A
Ambient Temperature Rated $V_{R(dc)}$, $P_{F(AV)} = 0$ $R_{\theta JA} = 28^\circ C/W$	T_A	90	85	80	°C
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, half wave, single phase 60 Hz, $T_L = 75^\circ C$)	I_{FSM}	← 80 (for one cycle) →			A
Operating and Storage Junction Temperature Range (Reverse Voltage applied)	T_J, T_{stg}	← -65 to +125 →			°C
Peak Operating Junction Temperature (Forward Current applied)	$T_{J(pk)}$	← 150 →			°C

*THERMAL CHARACTERISTICS (Note 2)

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	28	°C/W

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle = 2.0%.

(2) Lead Temperature reference is cathode lead 1/32" from case.

* Indicates JEDEC Registered Data for 1N5820-22.

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

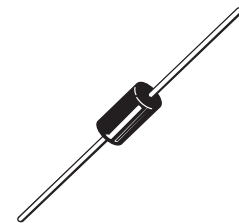
Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 2

1N5820
1N5821
1N5822

1N5820 and 1N5822 are
Motorola Preferred Devices

**SCHOTTKY BARRIER
RECTIFIERS**
3.0 AMPERES
20, 30, 40 VOLTS



CASE 267-03
PLASTIC

***ELECTRICAL CHARACTERISTICS** ($T_L = 25^\circ\text{C}$ unless otherwise noted) (2)

Characteristic	Symbol	1N5820	1N5821	1N5822	Unit
Maximum Instantaneous Forward Voltage (1) ($i_F = 1.0$ Amp) ($i_F = 3.0$ Amp) ($i_F = 9.4$ Amp)	V_F	0.370 0.475 0.850	0.380 0.500 0.900	0.390 0.525 0.950	V
Maximum Instantaneous Reverse Current @ Rated dc Voltage (1) $T_L = 25^\circ\text{C}$ $T_L = 100^\circ\text{C}$	i_R	2.0 20	2.0 20	2.0 20	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle = 2.0%.
 (2) Lead Temperature reference is cathode lead 1/32" from case.
 * Indicates JEDEC Registered Data for 1N5820–22.

NOTE 1 — DETERMINING MAXIMUM RATINGS

Reverse power dissipation and the possibility of thermal runaway must be considered when operating this rectifier at reverse voltages above 0.1 V_{RWM} . Proper derating may be accomplished by use of equation (1).

$$T_A(\text{max}) = T_J(\text{max}) - R_{\theta JA} P_{F(AV)} - R_{\theta JA} P_{R(AV)} \quad (1)$$

where $T_A(\text{max})$ = Maximum allowable ambient temperature
 $T_J(\text{max})$ = Maximum allowable junction temperature (125°C or the temperature at which thermal runaway occurs, whichever is lowest)
 $P_{F(AV)}$ = Average forward power dissipation
 $P_{R(AV)}$ = Average reverse power dissipation
 $R_{\theta JA}$ = Junction-to-ambient thermal resistance

Figures 1, 2, and 3 permit easier use of equation (1) by taking reverse power dissipation and thermal runaway into consideration. The figures solve for a reference temperature as determined by equation (2).

$$T_R = T_J(\text{max}) - R_{\theta JA} P_{R(AV)} \quad (2)$$

Substituting equation (2) into equation (1) yields:

$$T_A(\text{max}) = T_R - R_{\theta JA} P_{F(AV)} \quad (3)$$

Inspection of equations (2) and (3) reveals that T_R is the ambient temperature at which thermal runaway occurs or where $T_J = 125^\circ\text{C}$, when forward power is zero. The transition from one boundary condition to the other is evident on the curves of Figures 1, 2, and 3 as a difference in the rate of change of the slope in the vicinity of 115°C.

The data of Figures 1, 2, and 3 is based upon dc conditions. For use in common rectifier circuits, Table 1 indicates suggested factors for an equivalent dc voltage to use for conservative design, that is:

$$V_{R(\text{equiv})} = V_{(FM)} \times F \quad (4)$$

The factor F is derived by considering the properties of the various rectifier circuits and the reverse characteristics of Schottky diodes.

EXAMPLE: Find $T_A(\text{max})$ for 1N5821 operated in a 12-volt dc supply using a bridge circuit with capacitive filter such that $I_{DC} = 2.0$ A ($I_{F(AV)} = 1.0$ A), $I_{(FM)}/I_{(AV)} = 10$, Input Voltage = 10 V(rms), $R_{\theta JA} = 40^\circ\text{C/W}$.

Step 1. Find $V_{R(\text{equiv})}$. Read $F = 0.65$ from Table 1,
 $\therefore V_{R(\text{equiv})} = (1.41)(10)(0.65) = 9.2$ V.

Step 2. Find T_R from Figure 2. Read $T_R = 108^\circ\text{C}$
 @ $V_R = 9.2$ V and $R_{\theta JA} = 40^\circ\text{C/W}$.

Step 3. Find $P_{F(AV)}$ from Figure 6. **Read $P_{F(AV)} = 0.85$ W
 @ $\frac{I_{(FM)}}{I_{(AV)}} = 10$ and $I_{F(AV)} = 1.0$ A.

Step 4. Find $T_A(\text{max})$ from equation (3).
 $T_A(\text{max}) = 108 - (0.85)(40) = 74^\circ\text{C}$.

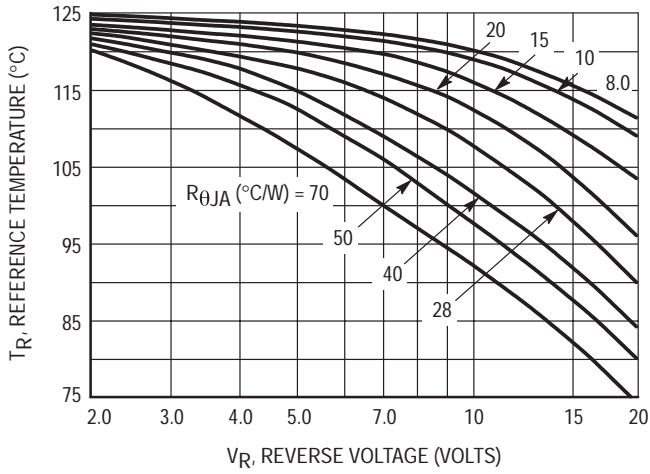
**Values given are for the 1N5821. Power is slightly lower for the 1N5820 because of its lower forward voltage, and higher for the 1N5822. Variations will be similar for the MBR-prefix devices, using $P_{F(AV)}$ from Figure 7.

Table 1. Values for Factor F

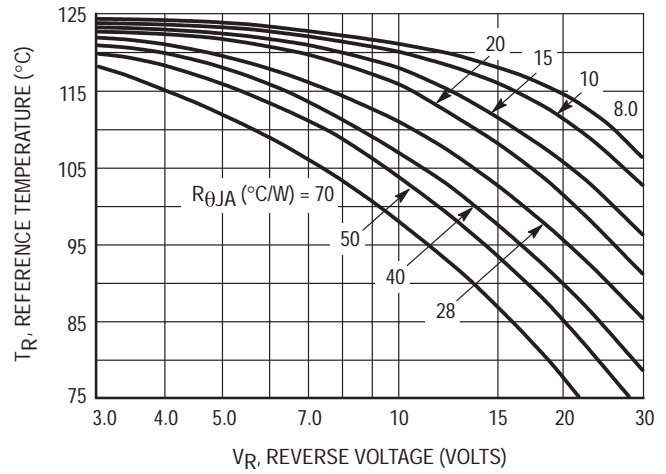
Circuit	Half Wave		Full Wave, Bridge		Full Wave, Center Tapped*†	
	Resistive	Capacitive*	Resistive	Capacitive	Resistive	Capacitive
Sine Wave	0.5	1.3	0.5	0.65	1.0	1.3
Square Wave	0.75	1.5	0.75	0.75	1.5	1.5

*Note that $V_{R(PK)} \approx 2.0 V_{in(PK)}$. †Use line to center tap voltage for V_{in} .

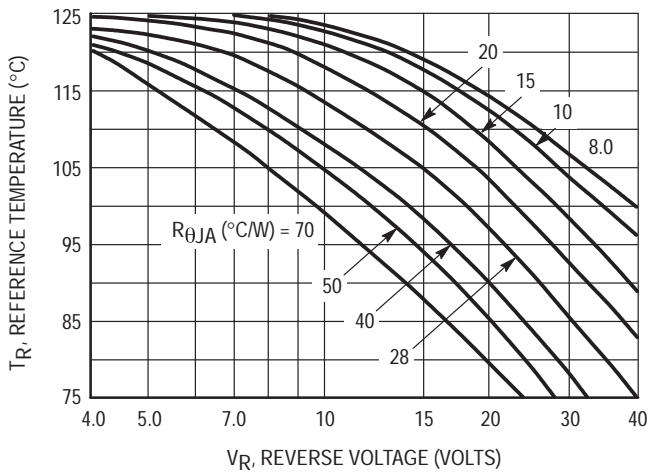
1N5820 1N5821 1N5822



**Figure 1. Maximum Reference Temperature
1N5820**



**Figure 2. Maximum Reference Temperature
1N5821**



**Figure 3. Maximum Reference Temperature
1N5822**

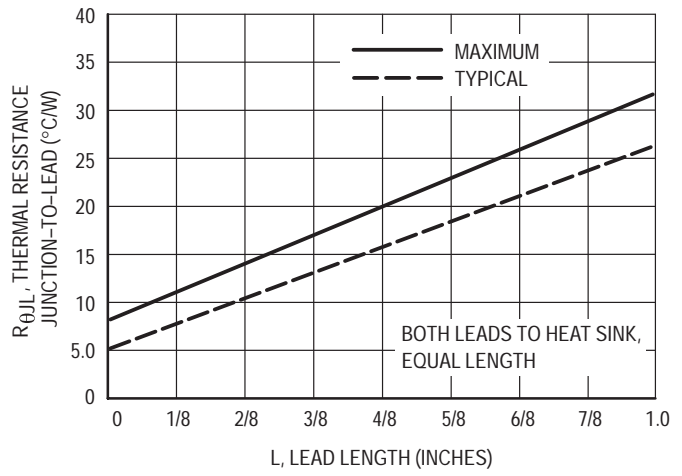


Figure 4. Steady-State Thermal Resistance

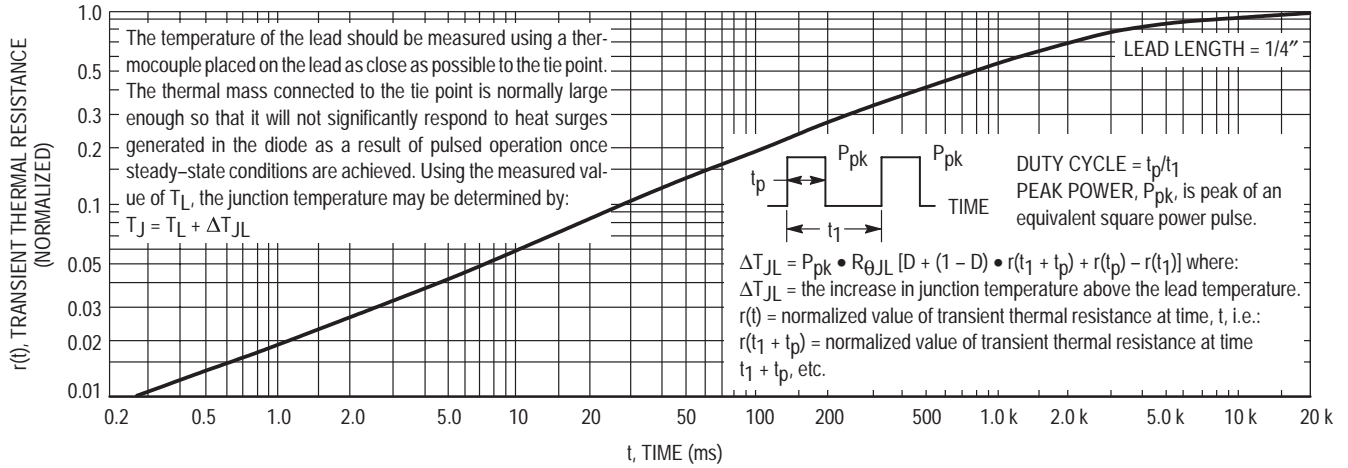


Figure 5. Thermal Response

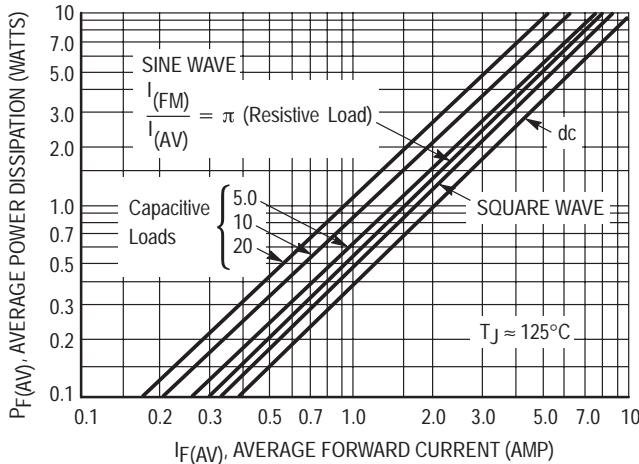
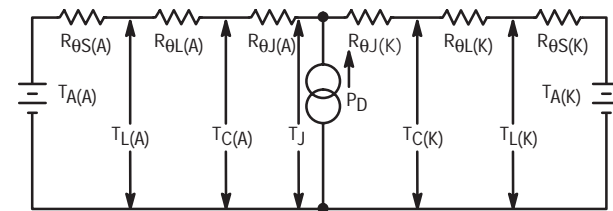


Figure 6. Forward Power Dissipation 1N5820-22

NOTE 3 — APPROXIMATE THERMAL CIRCUIT MODEL



Use of the above model permits junction to lead thermal resistance for any mounting configuration to be found. For a given total lead length, lowest values occur when one side of the rectifier is brought as close as possible to the heat sink. Terms in the model signify:

- T_A = Ambient Temperature
 - T_C = Case Temperature
 - T_L = Lead Temperature
 - T_J = Junction Temperature
 - $R_{\theta S}$ = Thermal Resistance, Heat Sink to Ambient
 - $R_{\theta L}$ = Thermal Resistance, Lead to Heat Sink
 - $R_{\theta J}$ = Thermal Resistance, Junction to Case
 - P_D = Total Power Dissipation = $P_F + P_R$
 - P_F = Forward Power Dissipation
 - P_R = Reverse Power Dissipation
- (Subscripts (A) and (K) refer to anode and cathode sides, respectively.) Values for thermal resistance components are:
 $R_{\theta L} = 42^\circ\text{C/W/in}$ typically and 48°C/W/in maximum
 $R_{\theta J} = 10^\circ\text{C/W}$ typically and 16°C/W maximum
 The maximum lead temperature may be found as follows:
 $T_L = T_{J(\text{max})} - \Delta T_{JL}$
 where $\Delta T_{JL} \approx R_{\theta JL} \cdot P_D$

NOTE 2 — MOUNTING DATA

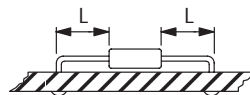
Data shown for thermal resistance junction-to-ambient ($R_{\theta JA}$) for the mountings shown is to be used as typical guideline values for preliminary engineering, or in case the tie point temperature cannot be measured.

TYPICAL VALUES FOR $R_{\theta JA}$ IN STILL AIR

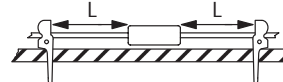
Mounting Method	Lead Length, L (in)				$R_{\theta JA}$
	1/8	1/4	1/2	3/4	
1	50	51	53	55	$^\circ\text{C/W}$
2	58	59	61	63	$^\circ\text{C/W}$
3	28				$^\circ\text{C/W}$

Mounting Method 1

P.C. Board where available copper surface is small.



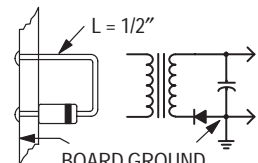
Mounting Method 2



VECTOR PUSH-IN TERMINALS T-28

Mounting Method 3

P.C. Board with 2-1/2" x 2-1/2" copper surface.



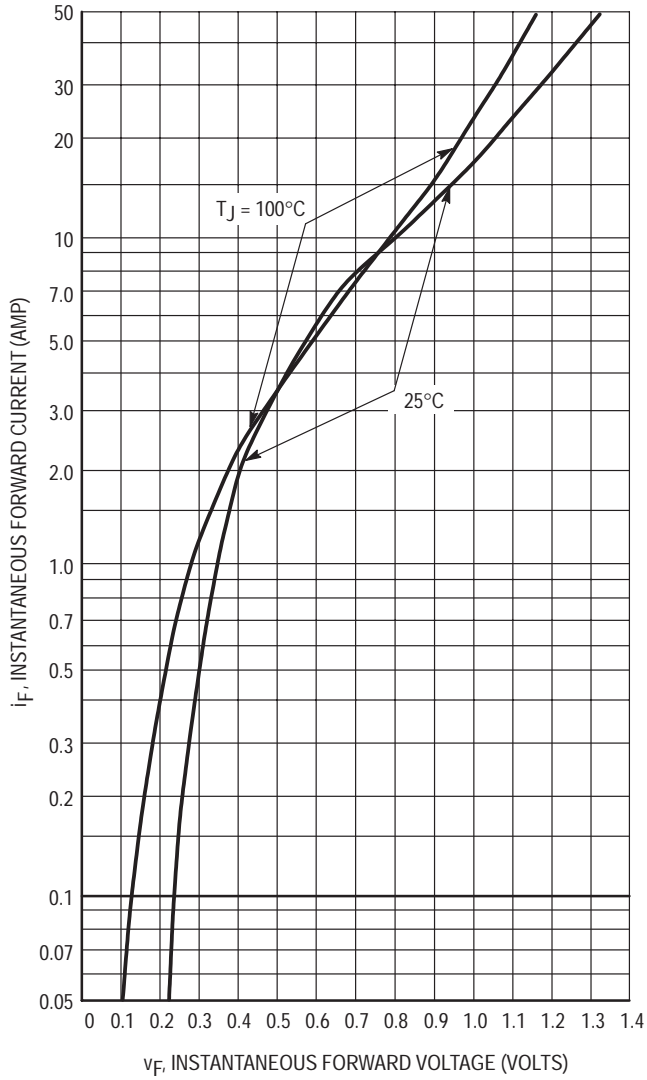


Figure 7. Typical Forward Voltage

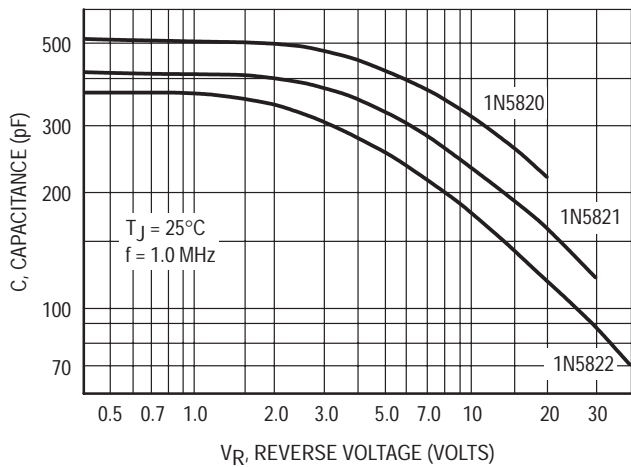


Figure 10. Typical Capacitance

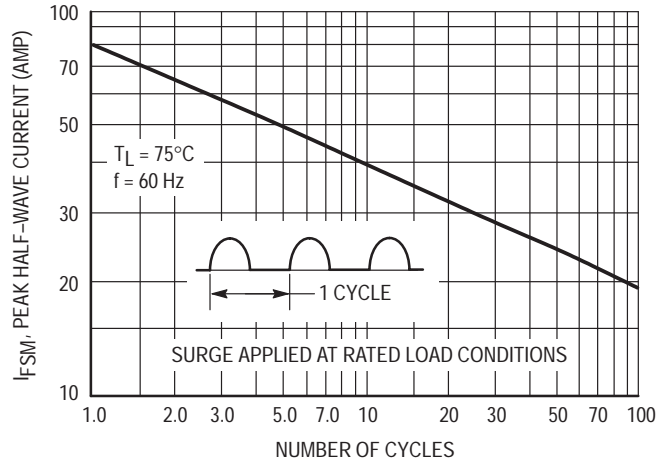


Figure 8. Maximum Non-Repetitive Surge Current

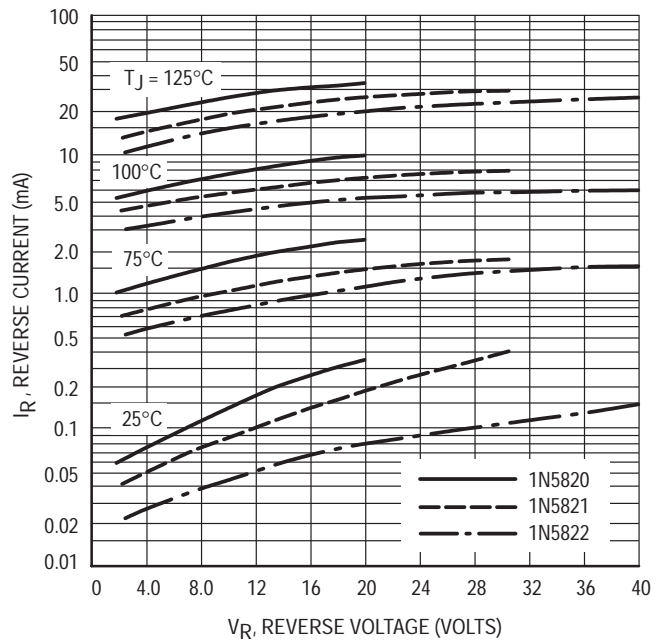


Figure 9. Typical Reverse Current

NOTE 4 — HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 11.)

Axial Lead Rectifiers

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Extremely Low v_f
- Low Power Loss/High Efficiency
- Highly Stable Oxide Passivated Junction
- Low Stored Charge, Majority Carrier Conduction

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 5,000 per bag
- Available Tape and Reeled, 1500 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode indicated by Polarity Band
- Marking: B320, B330, B340, B350, B360

MAXIMUM RATINGS

Rating	Symbol	MBR320	MBR330	MBR340	MBR350	MBR360	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	20	30	40	50	60	V
Average Rectified Forward Current, $T_A = 65^\circ\text{C}$ ($R_{\theta JA} = 28^\circ\text{C/W}$, P.C. Board Mounting, see Note 3)	I_O	3.0					A
Non-Repetitive Peak Surge Current (2) (Surge applied at rated load conditions, half wave, single phase 60 Hz, $T_L = 75^\circ\text{C}$)	I_{FSM}	80					A
Operating and Storage Junction Temperature Range (Reverse Voltage applied)	T_J, T_{stg}	-65 to 150°C					°C
Peak Operating Junction Temperature (Forward Current applied)	$T_{J(pk)}$	150					°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient (see Note 3, Mounting Method 3)	$R_{\theta JA}$	28	°C/W

ELECTRICAL CHARACTERISTICS ($T_L = 25^\circ\text{C}$ unless otherwise noted) (2)

Characteristic	Symbol	MBR320	MBR330	MBR340	MBR350	MBR360	Unit
Maximum Instantaneous Forward Voltage (1) ($i_F = 1.0$ Amp) ($i_F = 3.0$ Amp) ($i_F = 9.4$ Amp)	v_F	0.500 0.600 0.850			0.600 0.740 1.080		V
Maximum Instantaneous Reverse Current @ Rated dc Voltage (1) $T_L = 25^\circ\text{C}$ $T_L = 100^\circ\text{C}$	i_R	0.60 20					mA

- (1) Pulse Test: Pulse Width = 300 μs , Duty Cycle = 2.0%.
 (2) Lead Temperature reference is cathode lead 1/32" from case.

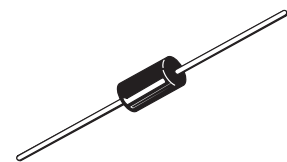
Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

MBR320
MBR330
MBR340
MBR350
MBR360

MBR340 and MBR360 are
Motorola Preferred Devices

**SCHOTTKY BARRIER
RECTIFIERS
3.0 AMPERES
20, 30, 40, 50, 60 VOLTS**



**CASE 267-03
PLASTIC**

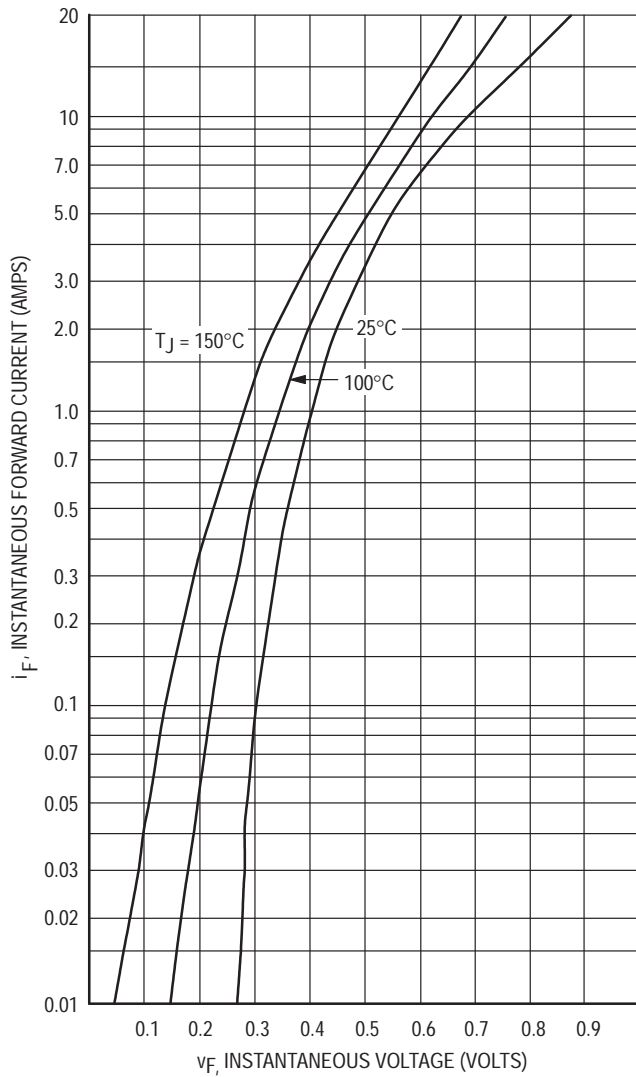


Figure 11. Typical Forward Voltage

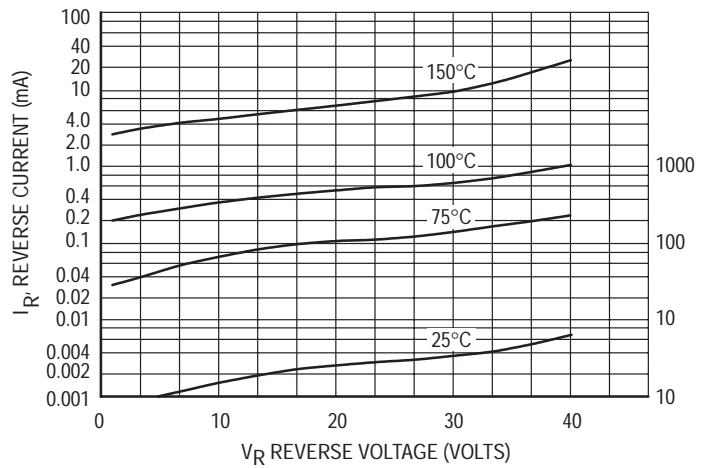


Figure 12. Typical Reverse Current*

*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V_R is sufficiently below rated V_R .

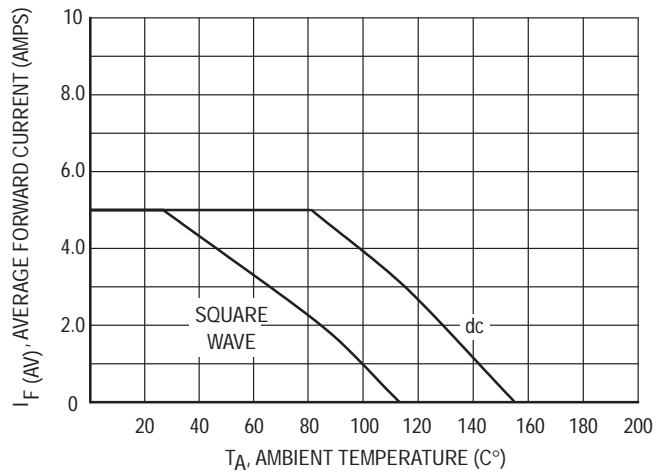


Figure 13. Current Derating
(Mounting method #3 per note 1)

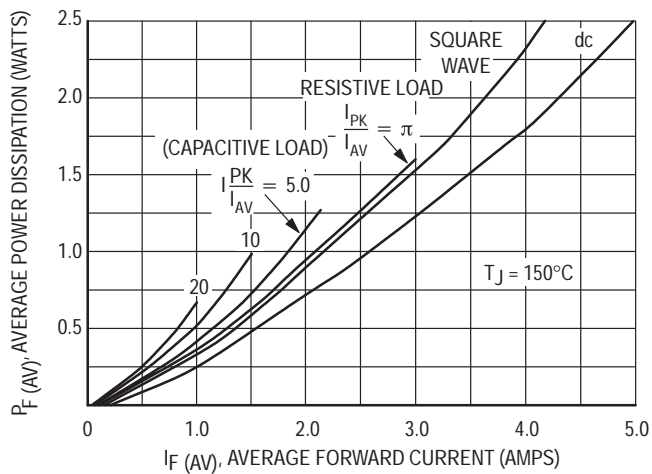


Figure 14. Power Dissipation

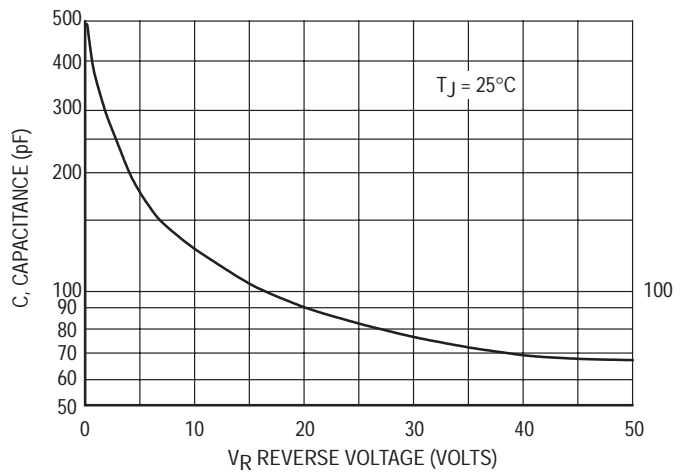


Figure 15. Typical Capacitance

MBR350 AND 360

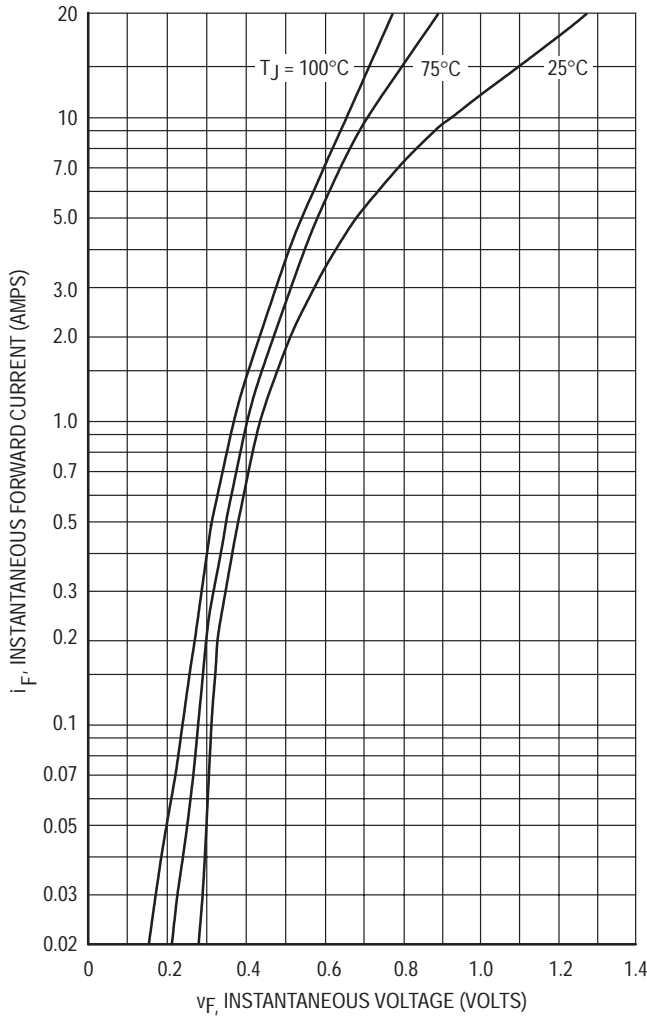


Figure 16. Typical Forward Voltage

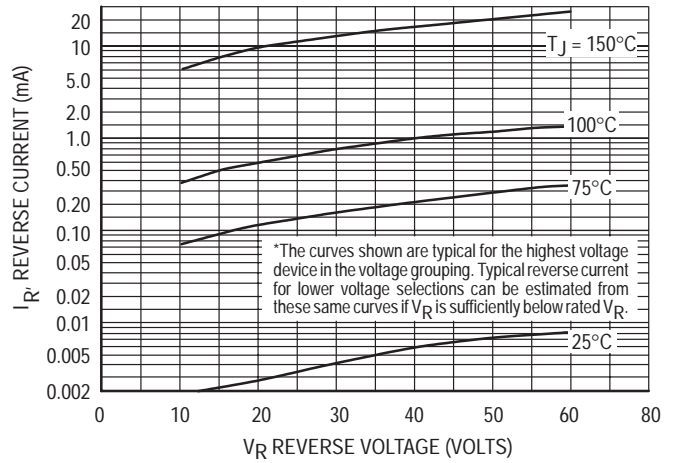


Figure 17. Typical Reverse Current*

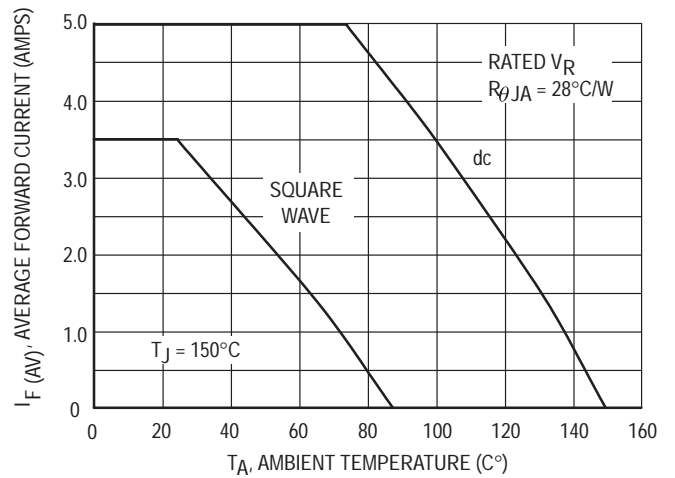


Figure 18. Current Derating Ambient (Mounting method #3 per note 1)

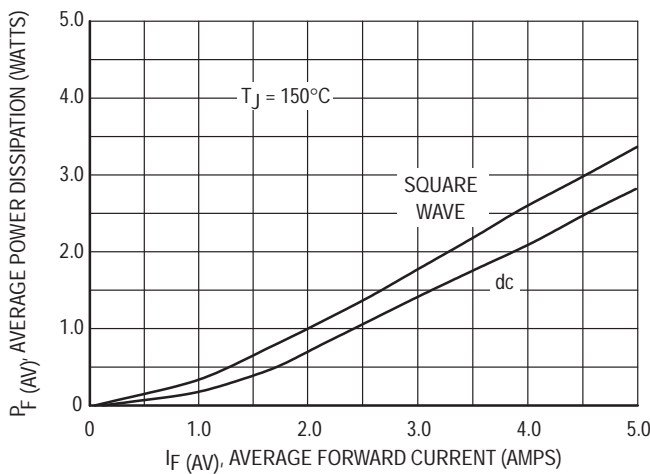


Figure 19. Power Dissipation

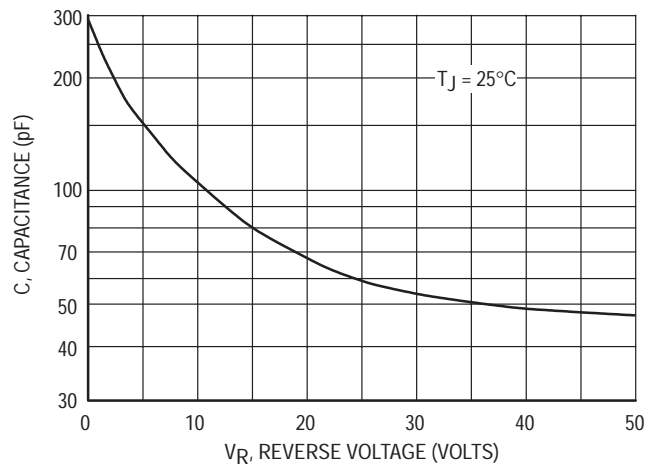


Figure 20. Typical Capacitance

MBR320 MBR330 MBR340 MBR350 MBR360

NOTE 1 — MOUNTING DATA

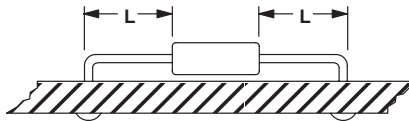
Data shown for thermal resistance junction-to-ambient ($R_{\theta JA}$) for the mountings shown is to be used as typical guideline values for preliminary engineering, or in case the tie point temperature cannot be measured.

TYPICAL VALUES FOR $R_{\theta JA}$ IN STILL AIR

Mounting Method	Lead Length, L (in)				$R_{\theta JA}$
	1/8	1/4	1/2	3/4	
1	50	51	53	55	$^{\circ}\text{C}/\text{W}$
2	58	59	61	63	$^{\circ}\text{C}/\text{W}$
3	28				$^{\circ}\text{C}/\text{W}$

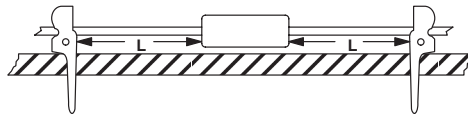
Mounting Method 1

P.C. Board where available copper surface is small.



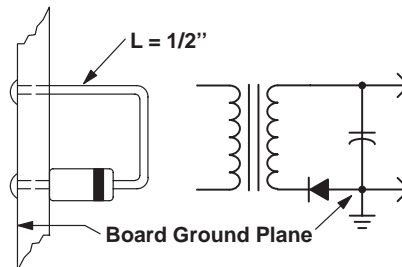
Mounting Method 2

Vector Push-In
Terminals T-28



Mounting Method 3

P.C. Board with
2-1/2" X 2-1/2"
copper surface.



Axial Lead Rectifiers

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Low Reverse Current
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency
- Highly Stable Oxide Passivated Junction
- Guard-Ring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- High Surge Capacity

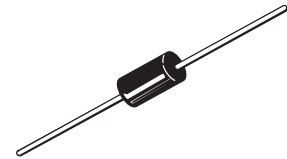
Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 5,000 per bag
- Available Tape and Reeled, 1500 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode indicated by Polarity Band
- Marking: B370, B380, B390, B3100

MBR370
MBR380
MBR390
MBR3100

MBR3100 is a
Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIERS**
3.0 AMPERES
70, 80, 90, 100 VOLTS



**CASE 267-03
PLASTIC**

MAXIMUM RATINGS

Rating	Symbol	MBR370	MBR380	MBR390	MBR3100	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	70	80	90	100	V
Average Rectified Forward Current, $T_A = 100^\circ\text{C}$ ($R_{\theta JA} = 28^\circ\text{C/W}$, P.C. Board Mounting, see Note 1)	I_O	3.0				A
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, half wave, single phase, 60 Hz)	I_{FSM}	150				A
Operating and Storage Junction Temperature Range (Reverse Voltage applied)	T_J, T_{stg}	-65 to +150				$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10				V/ns

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient (see Note 1, Mounting Method 3)	$R_{\theta JA}$	28	$^\circ\text{C/W}$

ELECTRICAL CHARACTERISTICS ($T_L = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage* ($i_F = 3$ Amps, $T_L = 25^\circ\text{C}$) ($i_F = 3$ Amps, $T_L = 100^\circ\text{C}$)	v_F	0.79 0.69	V
Maximum Instantaneous Reverse Current @ Rated dc Voltage* ($T_L = 25^\circ\text{C}$) ($T_L = 100^\circ\text{C}$)	i_R	0.6 20	mA

*Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

Preferred devices are Motorola recommended choices for future use and best overall value.

MBR370 MBR380 MBR390 MBR3100

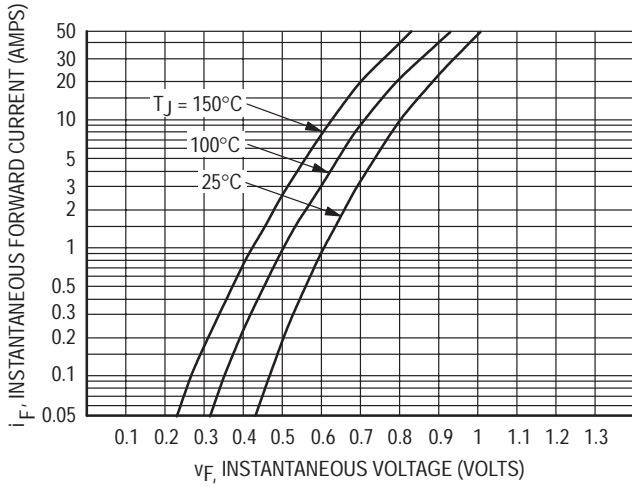


Figure 21. Typical Forward Voltage

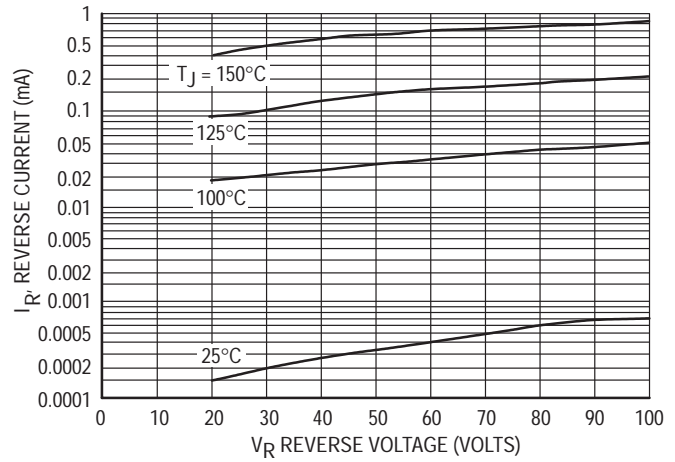
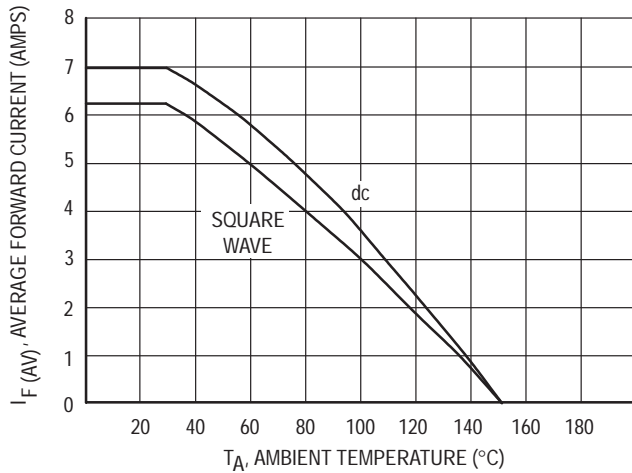


Figure 22. Typical Reverse Current*

*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these curves if V_R is sufficient below rated V_R .



**Figure 23. Current Derating
(Mounting method #3 per note 1)**

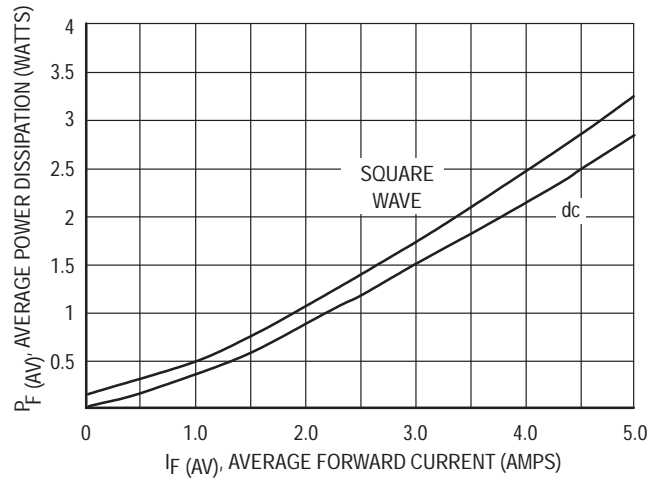


Figure 24. Power Dissipation

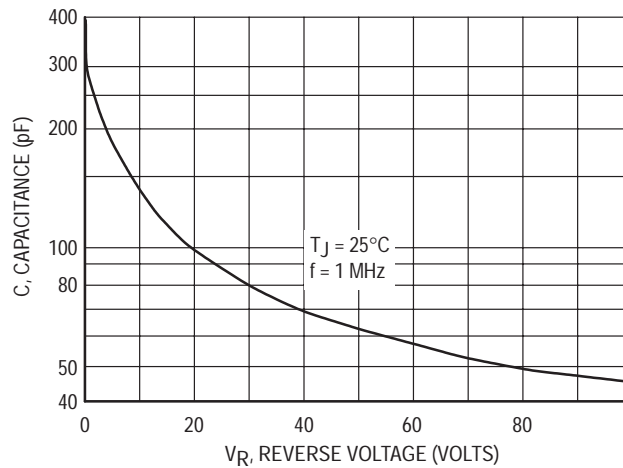


Figure 25. Typical Capacitance

NOTE 1 — MOUNTING DATA

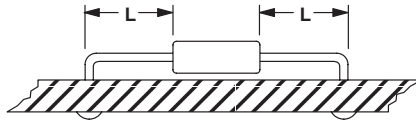
Data shown for thermal resistance junction-to-ambient ($R_{\theta JA}$) for the mountings shown is to be used as typical guideline values for preliminary engineering, or in case the tie point temperature cannot be measured.

TYPICAL VALUES FOR $R_{\theta JA}$ IN STILL AIR

Mounting Method	Lead Length, L (in)				$R_{\theta JA}$
	1/8	1/4	1/2	3/4	
1	50	51	53	55	$^{\circ}\text{C/W}$
2	58	59	61	63	$^{\circ}\text{C/W}$
3	28				$^{\circ}\text{C/W}$

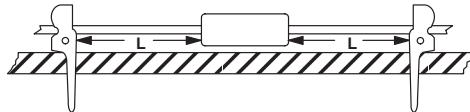
Mounting Method 1

P.C. Board where available copper surface is small.



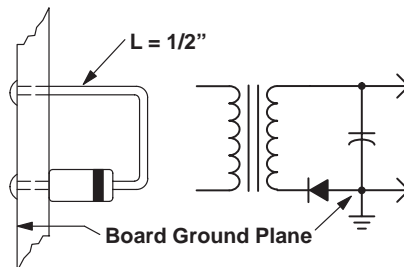
Mounting Method 2

Vector Push-In
Terminals T-28



Mounting Method 3

P.C. Board with
2-1/2" X 2-1/2"
copper surface.



Designer's™ Data Sheet

Power Rectifiers

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features chrome barrier metal, epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free-wheeling diodes, and polarity-protection diodes.

- Extremely Low v_f
- Low Power Loss/High Efficiency
- Low Stored Charge, Majority Carrier Conduction

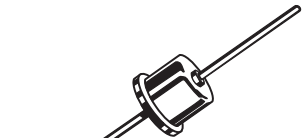
Mechanical Characteristics:

- Case: Welded steel, hermetically sealed
- Weight: 2.4 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Polarity: Cathode to Case
- Shipped 50 units per tray
- Marking: 1N5823, 1N5824, 1N5825

1N5823
1N5824
1N5825

1N5823 and 1N5825 are
Motorola Preferred Devices

**SCHOTTKY BARRIER
RECTIFIERS**
5.0 AMPERES
20, 30, 40 VOLTS



CASE 60-01
METAL

*MAXIMUM RATINGS

Rating	Symbol	1N5823	1N5824	1N5825	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	20	30	40	Volts
Non-Repetitive Peak Reverse Voltage	V_{RSM}	24	36	48	Volts
RMS Reverse Voltage	$V_{R(RMS)}$	14	21	28	Volts
Average Rectified Forward Current $V_{R(equiv)} \leq 0.2 V_{R(dc)}$, $T_C = 75^\circ C$ $V_{R(equiv)} \leq 0.2 V_{R(dc)}$, $T_L = 80^\circ C$ $R_{\theta JA} = 25^\circ C/W$, P.C. Board Mounting, See Note 3)	I_O				Amp
Ambient Temperature Rated $V_{R(dc)}$, $P_{F(AV)} = 0$ $R_{\theta JA} = 25^\circ C/W$	T_A	65	60	55	$^\circ C$
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase 60 Hz)	I_{FSM}	← 500 (for one cycle) →			Amp
Operating and Storage Junction Temperature Range (Reverse Voltage applied)	T_J, T_{stg}	← -65 to +125 →			$^\circ C$
Peak Operating Junction Temperature (Forward Current applied)	$T_{J(pk)}$	← 150 →			$^\circ C$

*THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.0	$^\circ C/W$

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle = 2.0%

* Indicates JEDEC Registered Data for 1N5823-1N5825

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

***ELECTRICAL CHARACTERISTICS** (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	1N5823	1N5824	1N5825	Unit
Maximum Instantaneous Forward Voltage (1) (i _F = 3.0 Amp) (i _F = 5.0 Amp) (i _F = 15.7 Amp)	V _F	0.330 0.360 0.470	0.340 0.370 0.490	0.350 0.380 0.520	Volts
Maximum Instantaneous Reverse Current @ Rated dc Voltage T _C = 25°C T _C = 100°C	i _R	10 100	10 125	10 150	mA

(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle = 2.0%
* Indicates JEDEC Registered Data for 1N5823–1N5825

NOTE 1 — DETERMINING MAXIMUM RATINGS

Reverse power dissipation and the possibility of thermal runaway must be considered when operating this rectifier at reverse voltages above 0.1 V_{RWM}. Proper derating may be accomplished by use of equation (1):

$$T_A(max) = T_J(max) - R_{\theta JA} P_{F(AV)} - R_{\theta JA} P_{R(AV)} \quad (1)$$

where T_A(max) = Maximum allowable ambient temperature
T_J(max) = Maximum allowable junction temperature
(125°C or the temperature at which thermal runaway occurs, whichever is lowest)
P_F(AV) = Average forward power dissipation
P_R(AV) = Average reverse power dissipation
R_{θJA} = Junction-to-ambient thermal resistance

Figures 1, 2, and 3 permit easier use of equation (1) by taking reverse power dissipation and thermal runaway into consideration. The figures solve for a reference temperature as determined by equation (2):

$$T_R = T_J(max) - R_{\theta JA} P_{R(AV)} \quad (2)$$

Substituting equation (2) into equation (1) yields:

$$T_A(max) = T_R - R_{\theta JA} P_{F(AV)} \quad (3)$$

Inspection of equations (2) and (3) reveals that T_R is the ambient temperature at which thermal runaway occurs or where T_J = 125°C, when forward power is zero. The transition from one boundary condition to the other is evident on the curves of Figures 1, 2, and 3 as a

difference in the rate of change of the slope in the vicinity of 115°C. The data of Figures 1, 2, and 3 is based upon dc conditions. For use in common rectifier circuits, Table 1 indicates suggested factors for an equivalent dc voltage to use for conservative design, i.e.:

$$V_{R(equiv)} = V_{IN(PK)} \times F \quad (4)$$

The factor F is derived by considering the properties of the various rectifier circuits and the reverse characteristics of Schottky diodes.

EXAMPLE: Find T_A(max) for 1N5825 operated in a 12-volt dc supply using a bridge circuit with capacitive filter such that I_{DC} = 10 A (I_F(AV) = 5 A), I_(PK)/I_(AV) = 10, Input Voltage = 10 V_(rms), R_{θJA} = 10°C/W.

Step 1. Find V_R(equiv). Read F = 0.65 from Table 1,
∴ V_R(equiv) = (1.41) (10) (0.65) = 9.2 V.

Step 2. Find T_R from Figure 3. Read T_R = 113°C
@ V_R = 9.2 V and R_{θJA} = 10°C/W.

Step 3. Find P_F(AV) from Figure 4. **Read P_F(AV) = 5.5 W
@ $\frac{I_{(PK)}}{I_{(AV)}} = 10$ and I_F(AV) = 5 A

Step 4. Find T_A(max) from equation (3).
T_A(max) = 113 · (10) (5.5) = 58°C.

**Values given are for the 1N5825. Power is slightly lower for the other units because of their lower forward voltage.

Table 1. Values for Factor F

Circuit	Half Wave		Full Wave, Bridge		Full Wave, Center Tapped*†	
	Resistive	Capacitive*	Resistive	Capacitive	Resistive	Capacitive
Sine Wave	0.5	1.3	0.5	0.65	1.0	1.3
Square Wave	0.75	1.5	0.75	0.75	1.5	1.5

*Note that V_R(PK) ≈ 2.0 V_{in}(PK). †Use line to center tap voltage for V_{in}.

1N5823 1N5824 1N5825

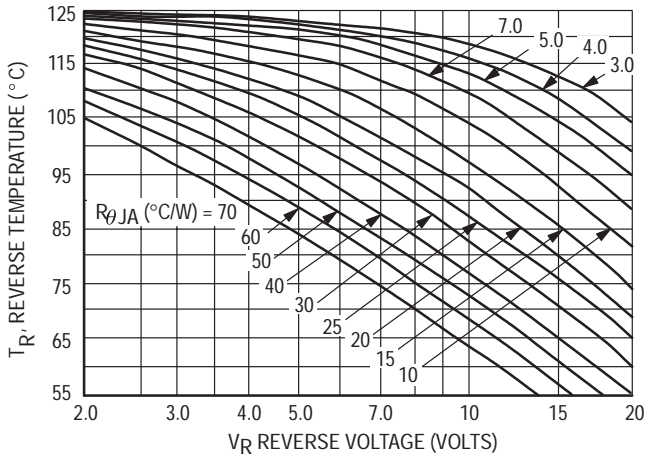


Figure 1. Maximum Reference Temperature – 1N5823

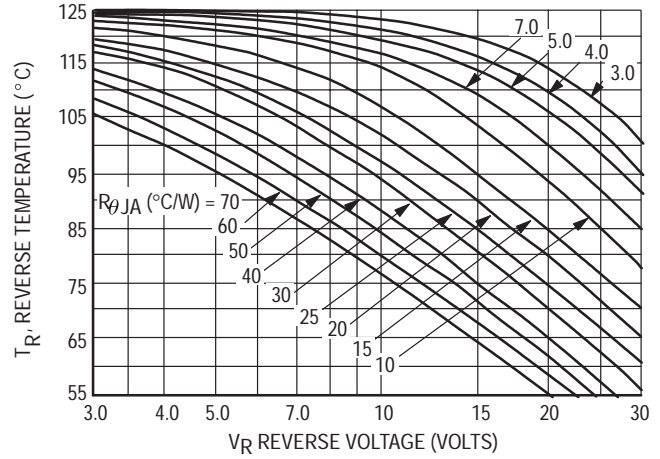
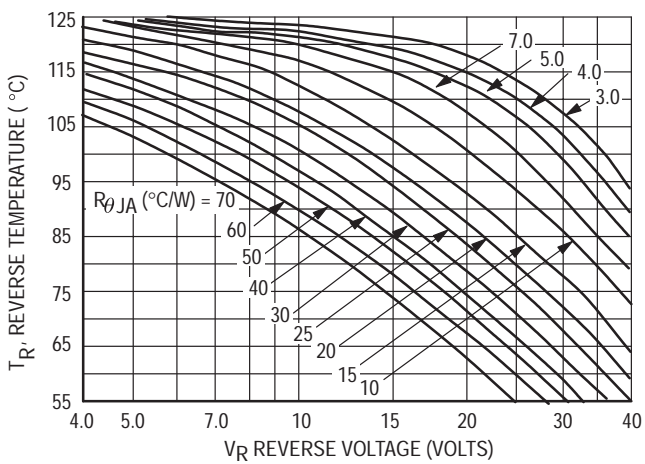


Figure 2. Maximum Reference Temperature – 1N5824



**Figure 3. Maximum Reference Temperature
1N5825 and MBR5825H, H1**

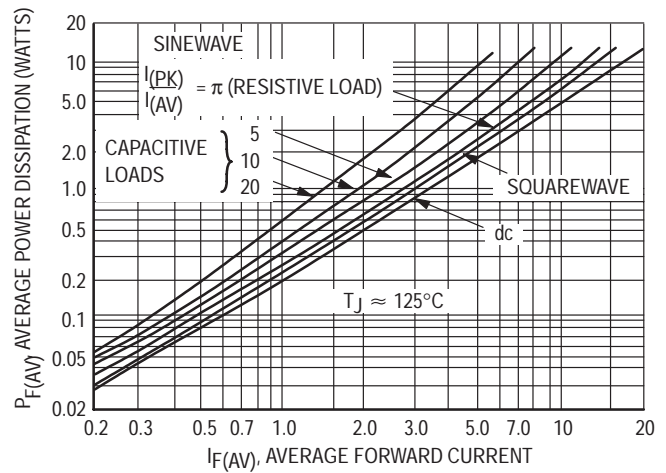


Figure 4. Forward Power Dissipation

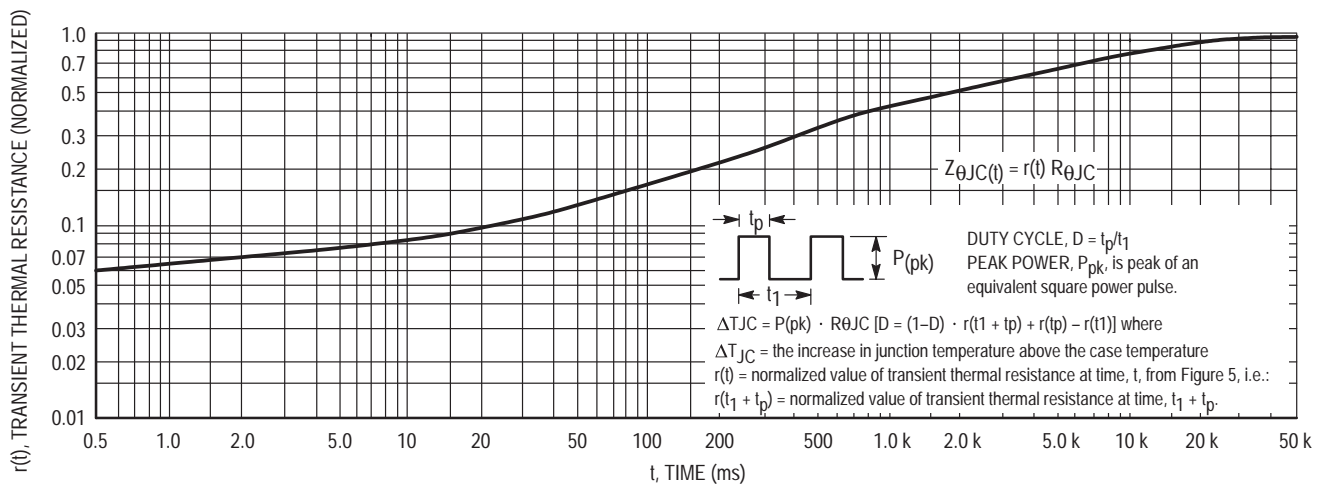
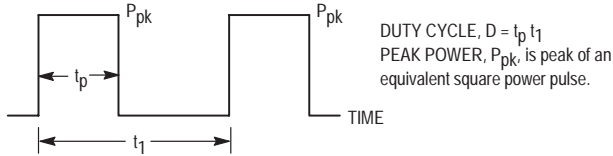


Figure 5. Thermal Response

NOTE 2 — FINDING JUNCTION TEMPERATURE



DUTY CYCLE, $D = t_p / t_1$
 PEAK POWER, P_{pk} is peak of an equivalent square power pulse.

To determine maximum junction temperature of the diode in a given situation, the following procedure is recommended:

The temperature of the case should be measured using a thermocouple placed on the case at the temperature reference point (see Note 3). The thermal mass connected to the case is normally large enough so that it will not significantly respond to heat surges generated in the diode as a result of pulsed operation once steady state conditions are achieved. Using the measured value of T_C , the junction temperature may be determined by:

$$T_J = T_C + T_{JC}$$

where T_{JC} is the increase in junction temperature above the case temperature, it may be determined by:

$$\Delta T_{JC} = P_{pk} \cdot R_{\theta JC} [D + (1 - D) \cdot r(t_1 + t_p) + r(t_p) r(t_1)]$$

where

$r(t)$ = normalized value of transient thermal resistance at time, t , from Figure 5, i.e.,

$r(t_1 + t_p)$ = normalized value of transient thermal resistance at time $t_1 + t_p$

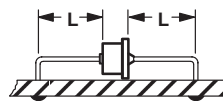
NOTE 3 — MOUNTING DATA

Data shown for thermal resistance junction-to-ambient ($R_{\theta JA}$) for the mountings shown is to be used as typical guideline values for preliminary engineering.

TYPICAL VALUES FOR $R_{\theta JA}$ IN STILL AIR

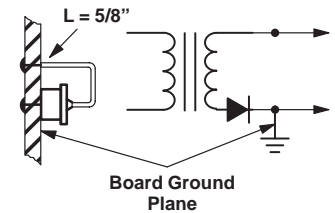
Mounting Method	Lead Length, L (in)		$R_{\theta JA}$
	1/4	1	
1	55	60	$^{\circ}\text{C}/\text{W}$
2	65	70	$^{\circ}\text{C}/\text{W}$
3	25		$^{\circ}\text{C}/\text{W}$

MOUNTING METHOD 1

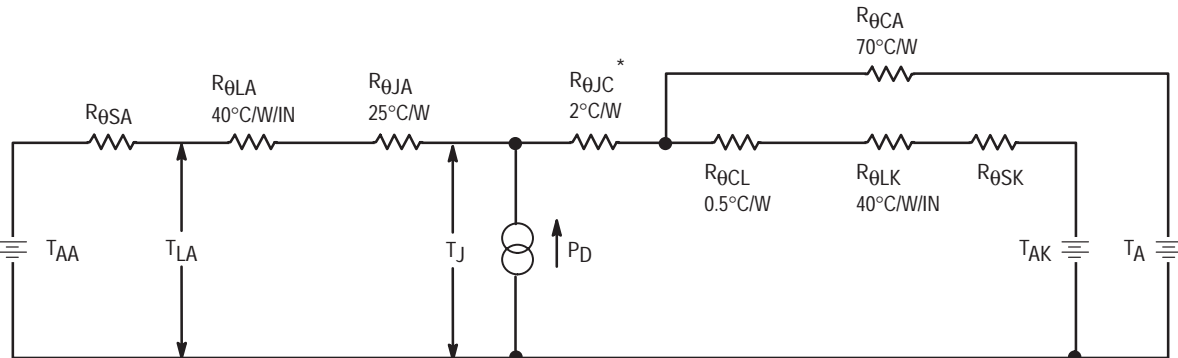
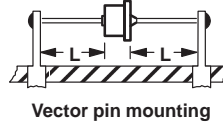


MOUNTING METHOD 3

P.C. Board with 2-1/2" x 2-1/2" copper surface



MOUNTING METHOD 2



Use of the above model permits calculation of average junction temperature for any mounting situation. Lowest values of thermal resistance will occur when the cathode lead is brought as close as possible to a heat dissipator; as heat conduction through the anode lead is small. Terms in the model are defined as follows:

*Case temperature reference is at cathode end.

TEMPERATURES

- T_A = Ambient
- T_{AA} = Anode Heat Sink Ambient
- T_{AK} = Cathode Heat Sink Ambient
- T_{LA} = Anode Lead
- T_{LK} = Cathode Lead
- T_J = Junction

THERMAL RESISTANCES

- $R_{\theta CA}$ = Case to Ambient
- $R_{\theta SA}$ = Anode Lead Heat Sink to Ambient
- $R_{\theta SK}$ = Cathode Lead Heat Sink to Ambient
- $R_{\theta LA}$ = Anode Lead
- $R_{\theta LK}$ = Cathode Lead
- $R_{\theta CL}$ = Case to Cathode Lead
- $R_{\theta JC}$ = Junction to Case
- $R_{\theta JA}$ = Junction to Anode Lead (S bend)

Figure 6. Approximate Thermal Circuit Model

1N5823 1N5824 1N5825

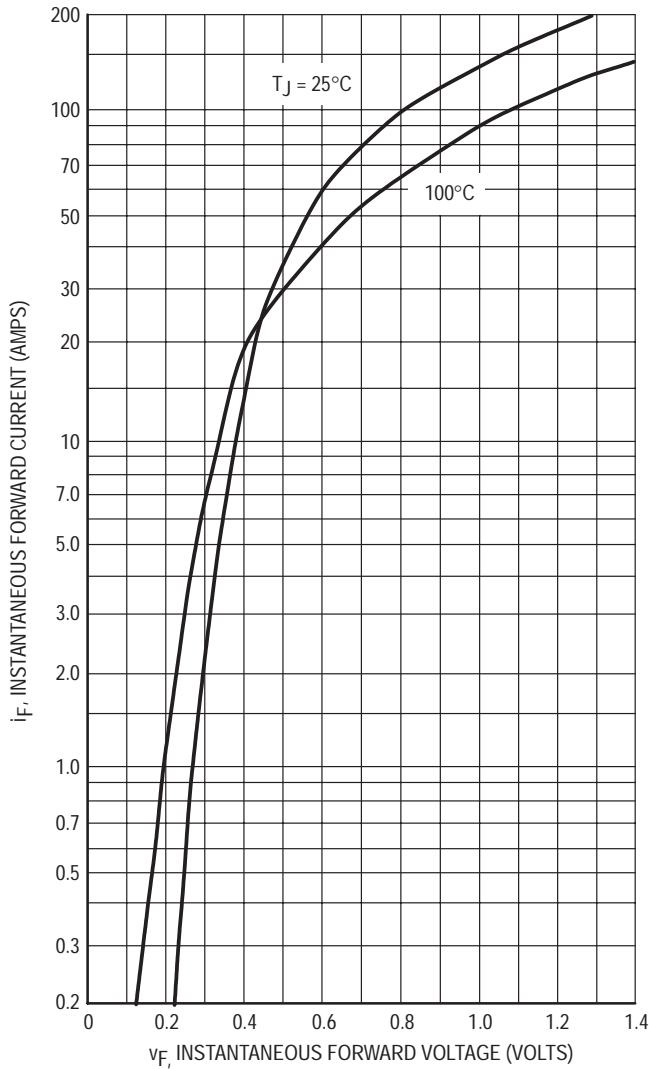


Figure 7. Typical Forward Voltage

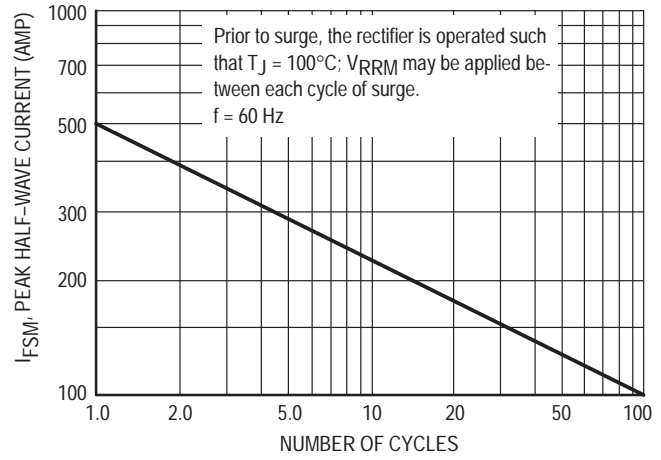


Figure 8. Maximum Surge Capability

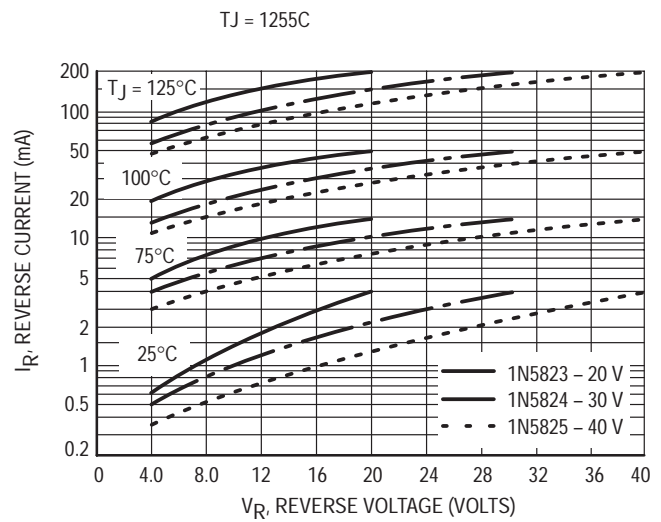


Figure 9. Typical Reverse Current

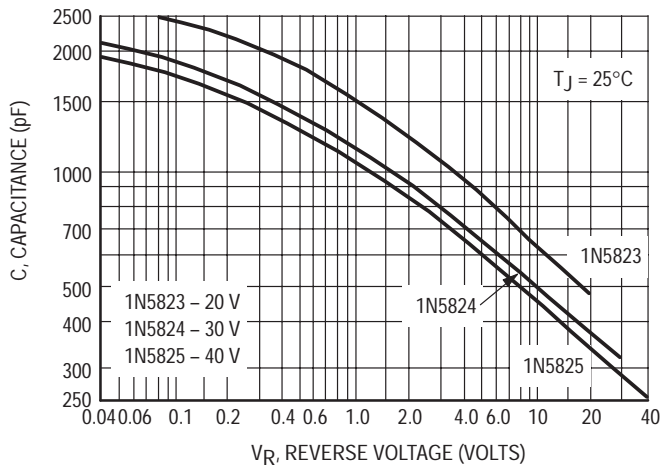


Figure 10. Capacitance

NOTE 4 — HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 10.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

SWITCHMODE™ Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Center-Tap Configuration
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche
- Epoxy Meets UL94, VO at 1/8"

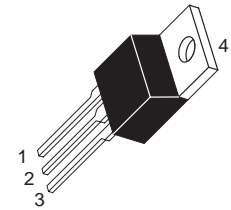
Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B1535, B1545

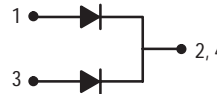
MBR1535CT
MBR1545CT

MBR1545CT is a
Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIERS
15 AMPERES
35 and 45 VOLTS**



**CASE 221A-06
TO-220AB
PLASTIC**



MAXIMUM RATINGS

Rating	Symbol	MBR1535CT	MBR1545CT	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	35	45	Volts
Average Rectified Forward Current $T_C = 105^\circ\text{C}$ (Rated V_R)	$I_F(AV)$ Per Diode Per Device	7.5 15	7.5 15	Amps
Peak Repetitive Forward Current, $T_C = 105^\circ\text{C}$ (Rated V_R , Square Wave, 20 kHz) Per Diode	I_{FRM}	15	15	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz)	I_{RRM}	1.0	1.0	Amp
Operating Junction Temperature	T_J	-65 to +150	-65 to +150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +175	-65 to +175	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	1000	1000	$\text{V}/\mu\text{s}$

THERMAL CHARACTERISTICS PER DIODE

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.0	3.0	$^\circ\text{C}/\text{W}$
Maximum Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	60	60	$^\circ\text{C}/\text{W}$

ELECTRICAL CHARACTERISTICS PER DIODE

Maximum Instantaneous Forward Voltage (1) ($i_F = 7.5$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 15$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 15$ Amps, $T_C = 25^\circ\text{C}$)	V_F	0.57 0.72 0.84	0.57 0.72 0.84	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$) (Rated dc Voltage, $T_C = 25^\circ\text{C}$)	i_R	15 0.1	15 0.1	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$

Preferred devices are Motorola recommended choices for future use and best overall value.

MBR1535CT MBR1545CT

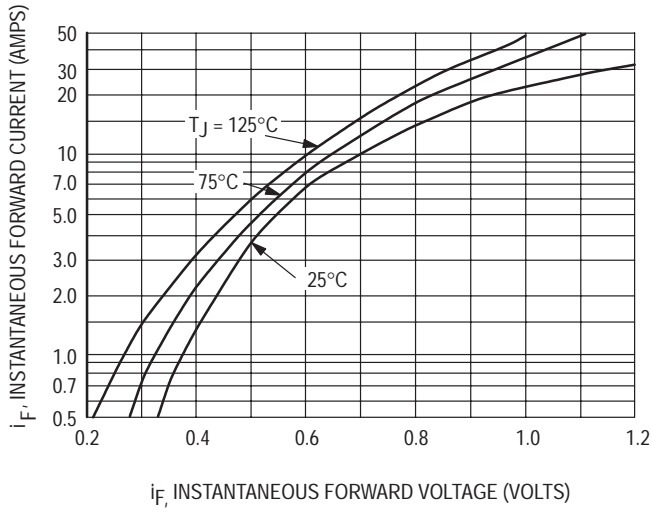


Figure 11. Typical Forward Voltage

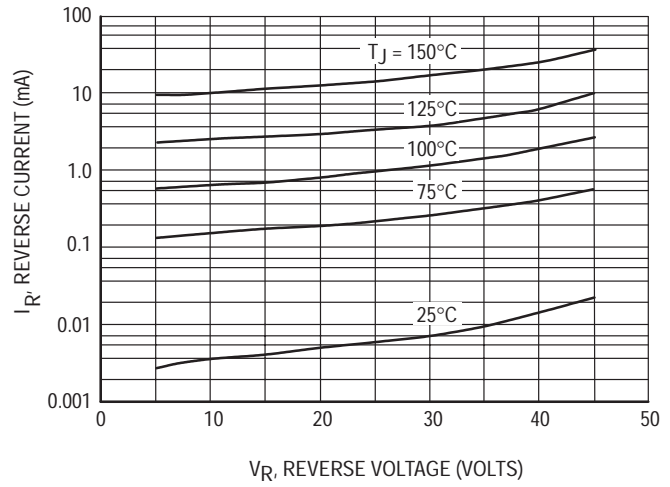


Figure 12. Typical Reverse Current

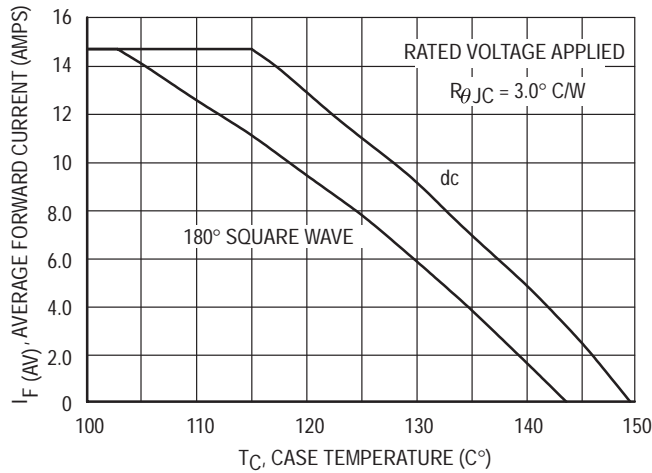


Figure 13. Current Derating, Case

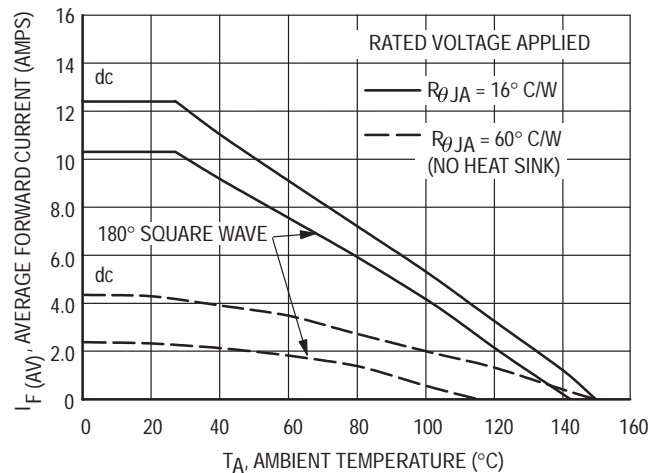


Figure 14. Current Derating, Ambient

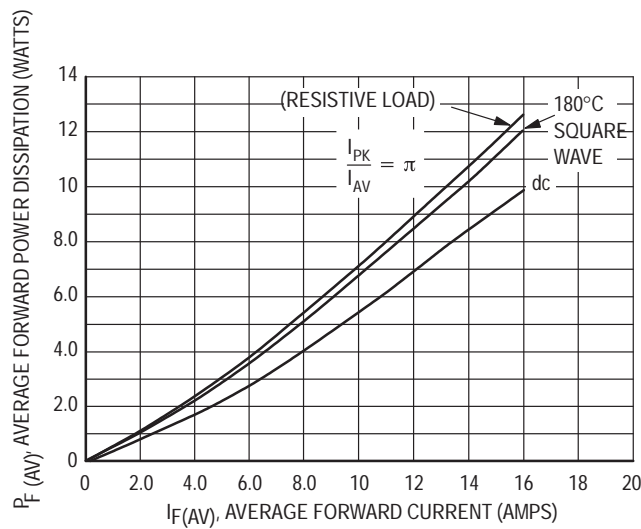


Figure 15. Power Dissipation

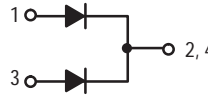
SWITCHMODE™ Dual Schottky Power Rectifiers

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use as rectifiers in very low-voltage, high-frequency switching power supplies, free wheeling diodes and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop (0.4 Max @ 10 A, T_C = 150°C)
- 150°C Operating Junction Temperature
- Matched Dual Die Construction (10 A per Leg or 20 A per Package)
- High Junction Temperature Capability
- High dv/dt Capability
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection
- Epoxy Meets UL94, VO at 1/8"

Mechanical Characteristics:

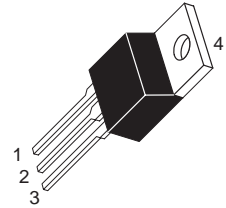
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B2015, B2030



MBR2015CTL
MBR2030CTL

MBR2030CTL is a
Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIERS
20 AMPERES
15 and 30 VOLTS**



**CASE 221A-06
TO-220AB**

MAXIMUM RATINGS (Per Leg)

Rating	Symbol	MBR2015CTL	MBR2030CTL	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	15	30	Volts
Average Rectified Forward Current	I _{F(AV)}	10		Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I _{FSM}	150		Amps
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I _{RSM}	1.0		Amp
Operating Junction Temperature	T _J	-65 to +150		°C
Storage Temperature	T _{stg}	-65 to +175		°C
Voltage Rate of Change (Rated V _R)	dv/dt	1000		V/μs

THERMAL CHARACTERISTICS (Per Leg)

Thermal Resistance, Junction to Case	R _{θJC}	2.0	°C/W
--------------------------------------	------------------	-----	------

ELECTRICAL CHARACTERISTICS (Per Leg)

Maximum Instantaneous Forward Voltage (1) (i _F = 10 Amps, T _C = 25°C) (i _F = 10 Amps, T _C = 150°C) (i _F = 20 Amps, T _C = 25°C) (i _F = 20 Amps, T _C = 150°C)	V _F	0.52 0.40 0.58 0.48	Volts
Maximum Instantaneous Reverse Current (1) (Rated DC Voltage, T _C = 25°C) (Rated DC Voltage, T _C = 100°C) (Rated DC Voltage, T _C = 125°C)	i _R	5.0 40 75	mA

(1) Pulse Test: Pulse Width = 5.0 ms, Duty Cycle ≤ 10%.

Preferred devices are Motorola recommended choices for future use and best overall value.

MBR2015CTL MBR2030CTL

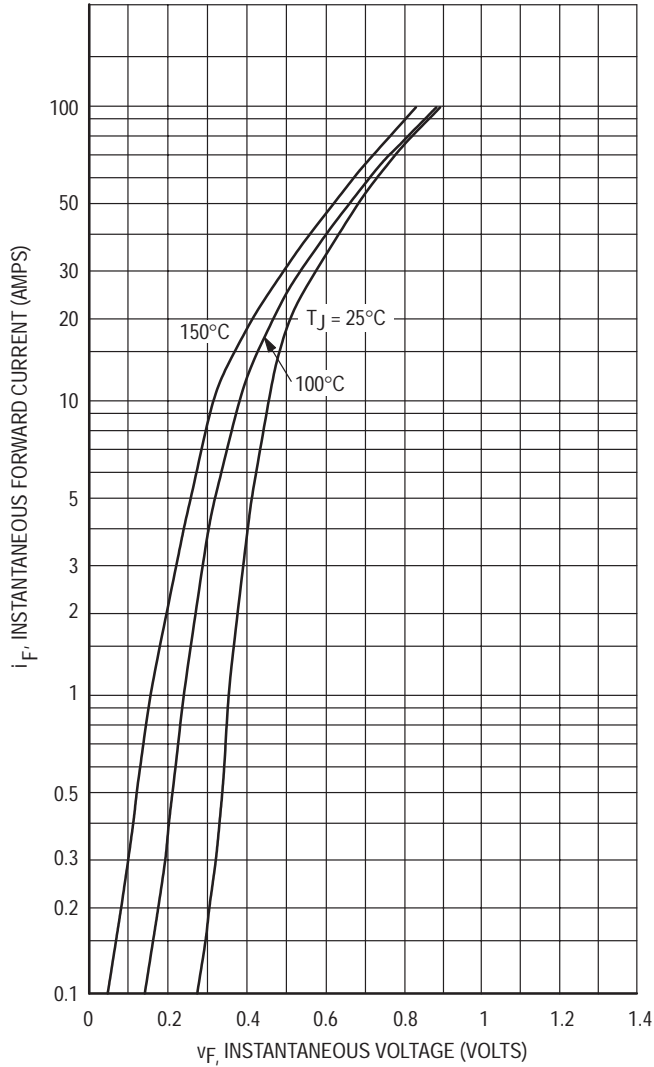


Figure 16. Typical Forward Voltage (Per Leg)

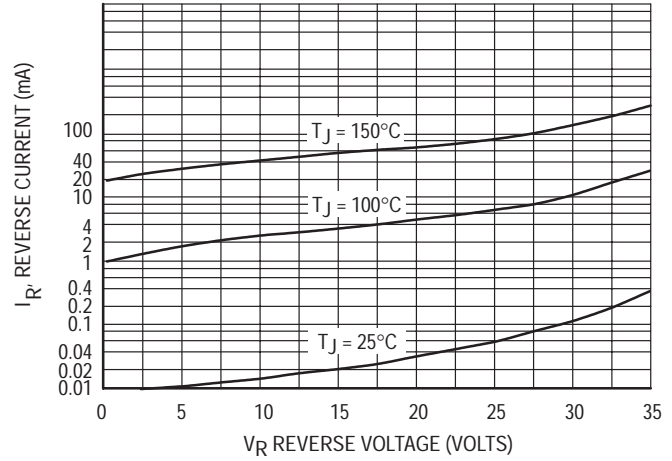


Figure 17. Typical Reverse Current (Per Leg)

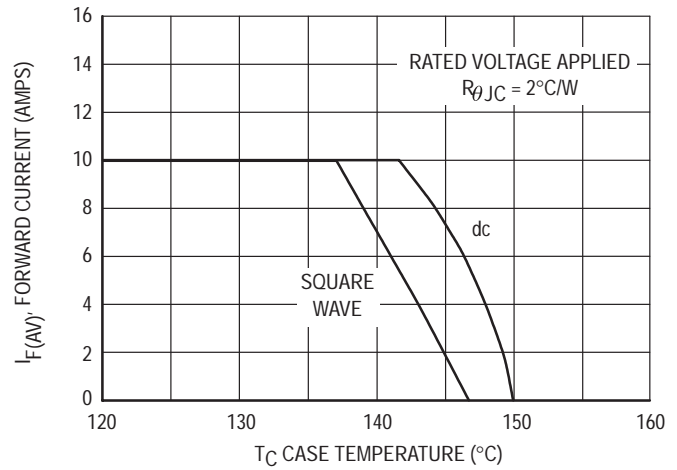


Figure 18. Current Derating, Case

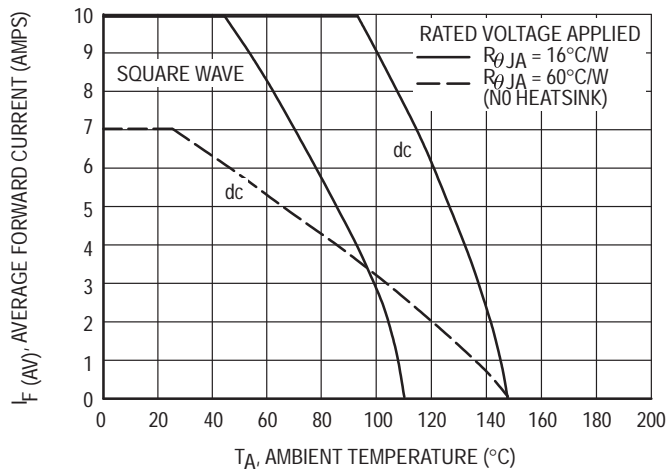


Figure 19. Current Derating, Ambient

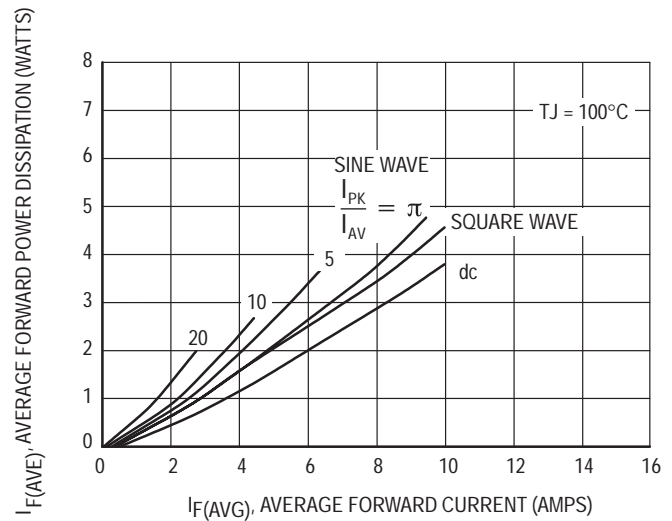


Figure 20. Forward Power Dissipation

HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 6.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 percent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

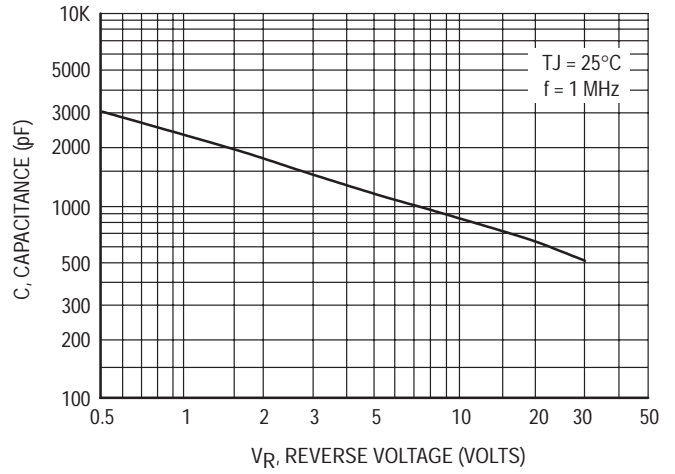


Figure 21. Typical Capacitance

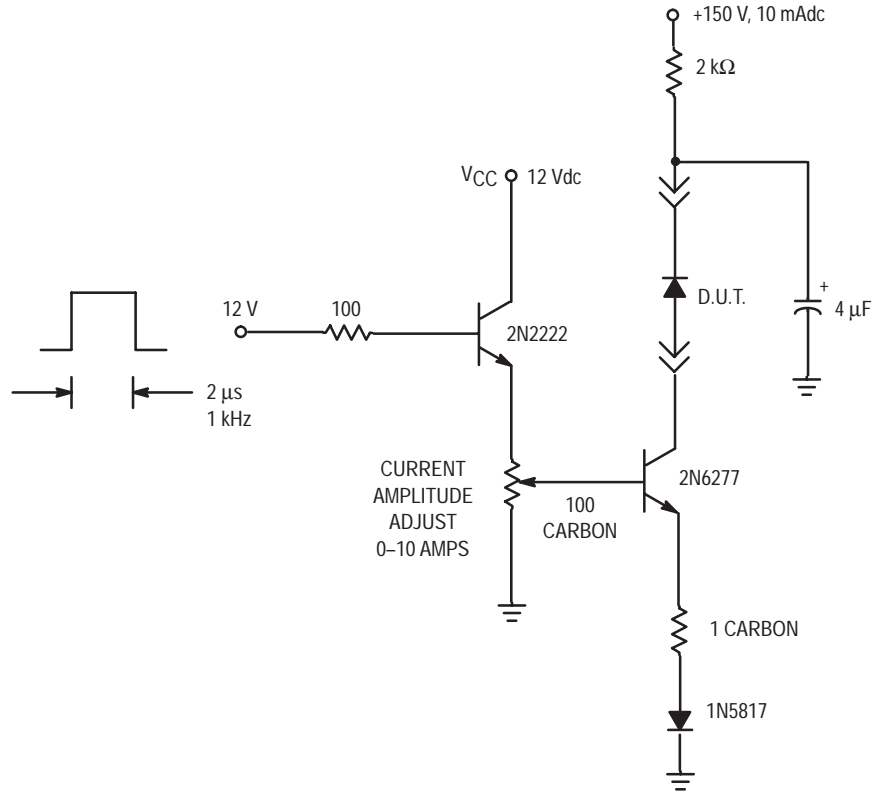


Figure 22. Test Circuit for dv/dt and Reverse Surge Current

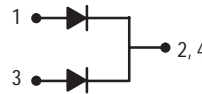
SWITCHMODE™ Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche
- Epoxy Meets UL94, VO at 1/8"

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B2035, B2045



MBR2035CT
MBR2045CT

MBR2045CT is a
Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIERS**
20 AMPERES
35 and 45 VOLTS

CASE 221A-06
TO-220AB
PLASTIC

MAXIMUM RATINGS

Rating	Symbol	MBR2035CT	MBR2045CT	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	35	45	Volts
Average Rectified Forward Current (Rated V_R) $T_C = 135^\circ\text{C}$	$I_{F(AV)}$	20	20	Amps
Peak Repetitive Forward Current Per Diode Leg (Rated V_R , Square Wave, 20 kHz) $T_C = 135^\circ\text{C}$	I_{FRM}	20	20	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz) See Figure 11	I_{RRM}	1.0	1.0	Amp
Operating Junction Temperature	T_J	-65 to +150	-65 to +150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +175	-65 to +175	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	1000	1000	V/ μs

THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	2.0	2.0	$^\circ\text{C/W}$
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ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ($i_F = 10$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 20$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 20$ Amps, $T_C = 25^\circ\text{C}$)	V_F	0.57 0.72 0.84	0.57 0.72 0.84	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$) (Rated dc Voltage, $T_C = 25^\circ\text{C}$)	i_R	15 0.1	15 0.1	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

Preferred devices are Motorola recommended choices for future use and best overall value.

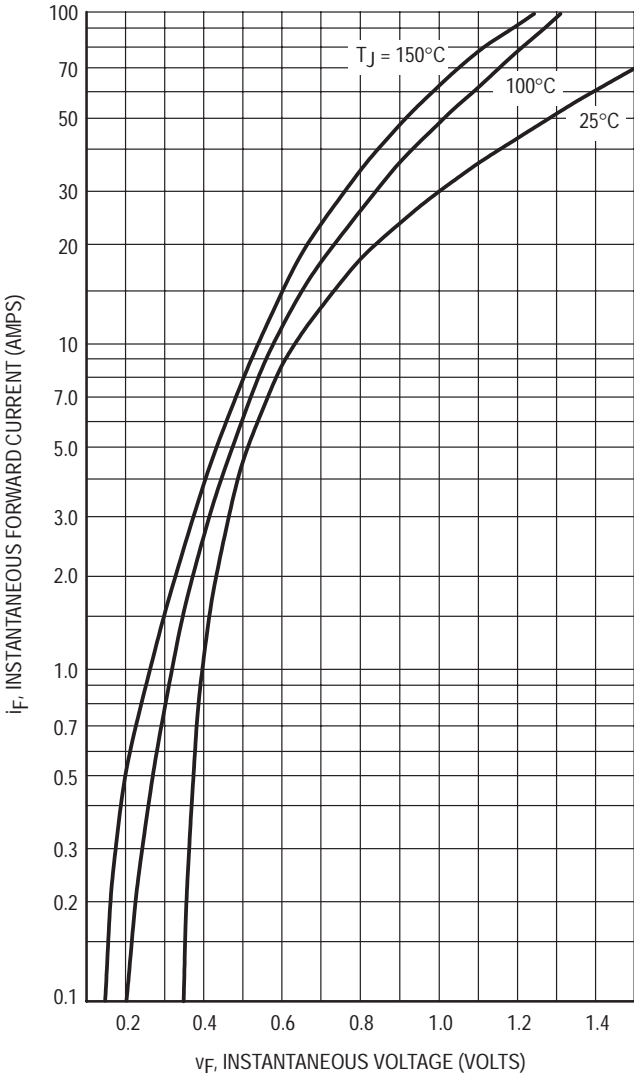


Figure 1. Maximum Forward Voltage

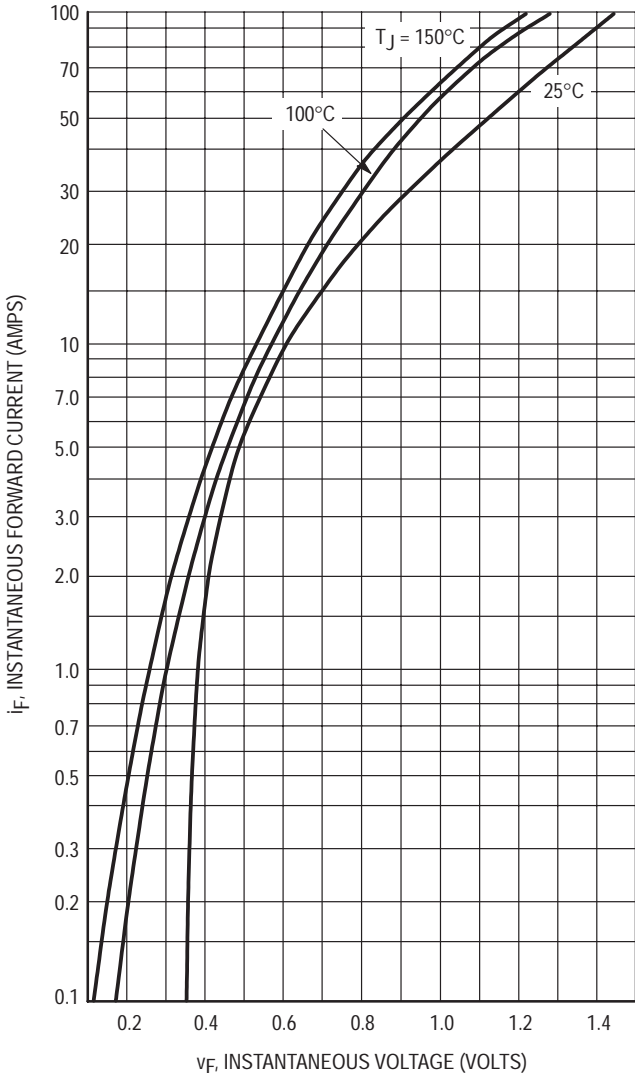


Figure 2. Typical Forward Voltage

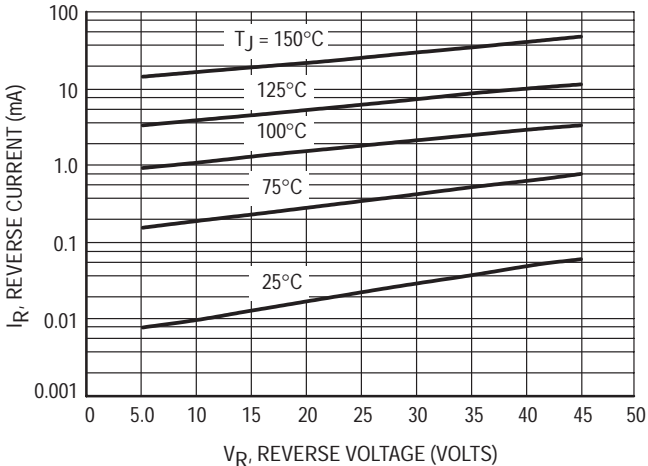


Figure 3. Maximum Reverse Current

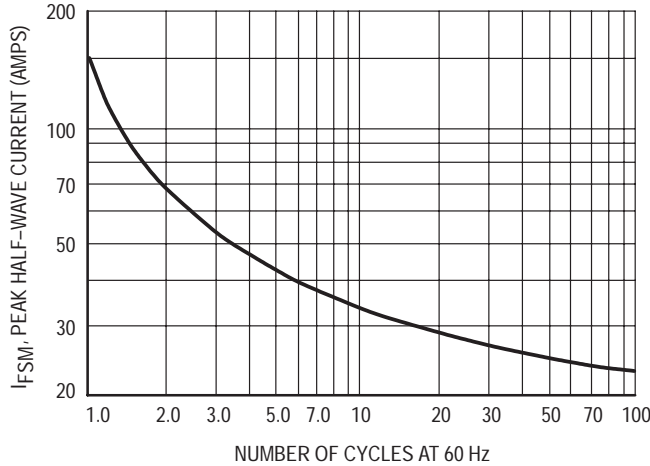


Figure 4. Maximum Surge Capability

MBR2035CT MBR2045CT

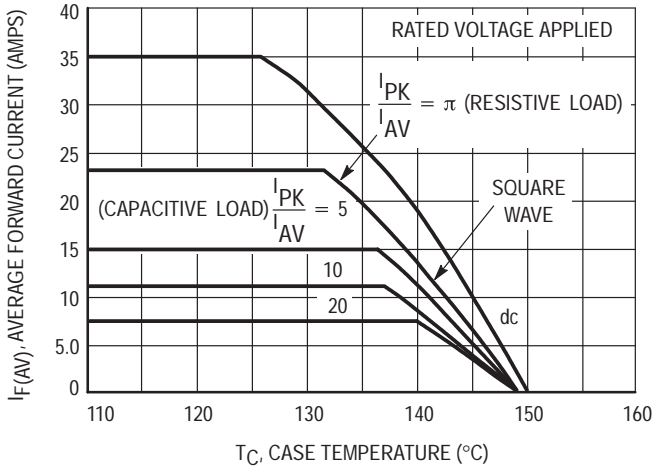


Figure 5. Current Derating, Infinite Heatsink

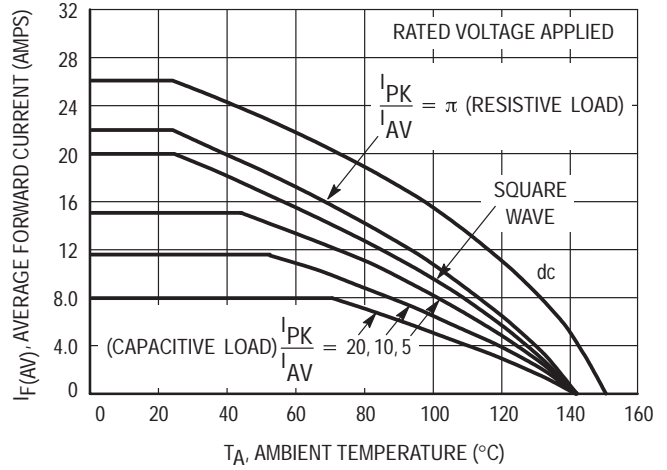


Figure 6. Current Derating, $R_{\theta JA} = 16^{\circ}\text{C/W}$

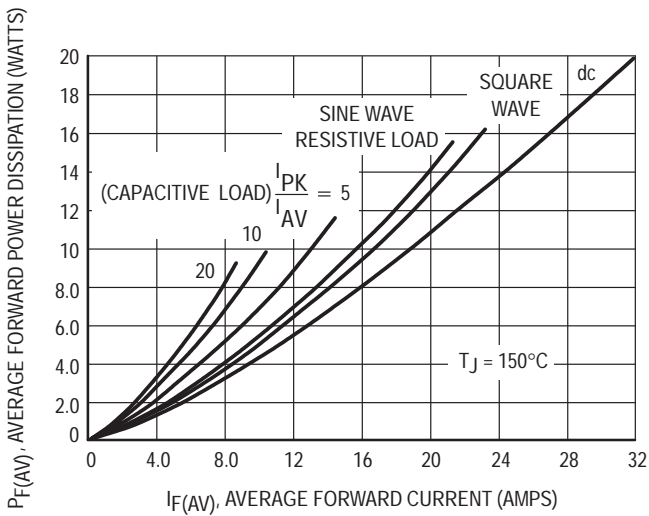


Figure 7. Forward Power Dissipation

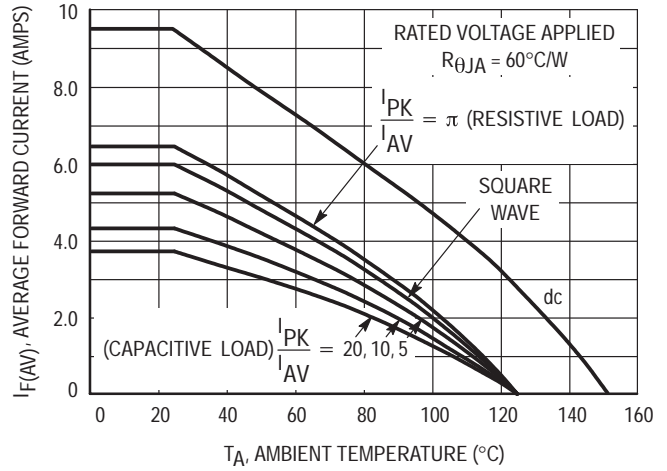


Figure 8. Current Derating, Free Air

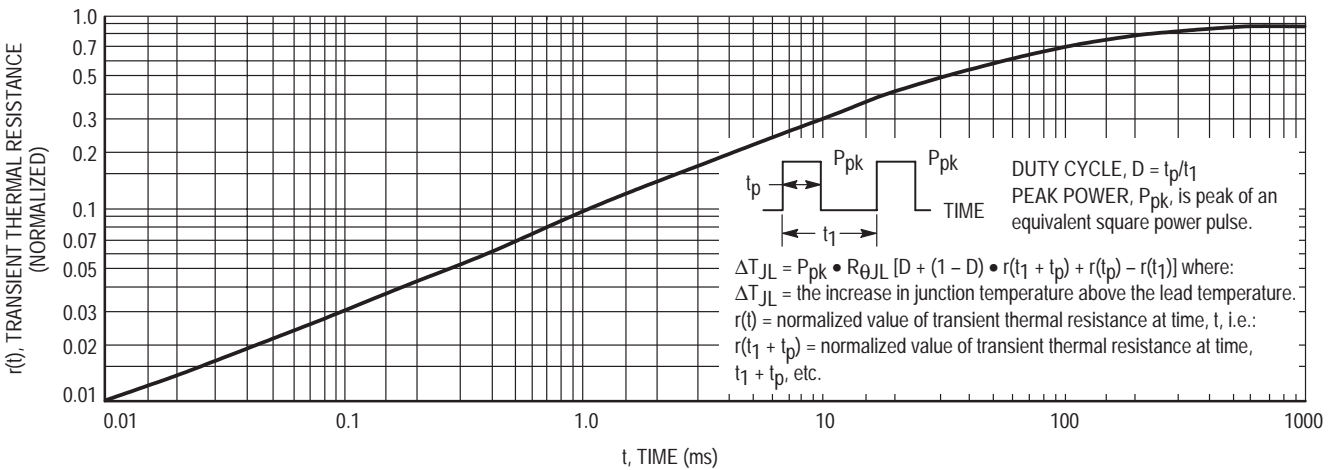


Figure 9. Thermal Response

HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 10.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 percent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

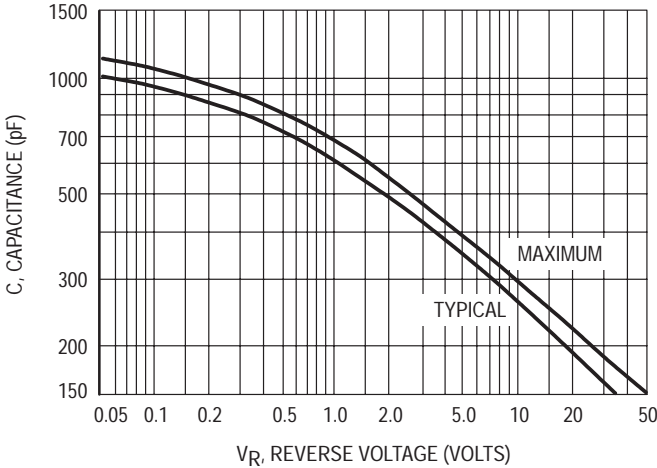


Figure 10. Capacitance

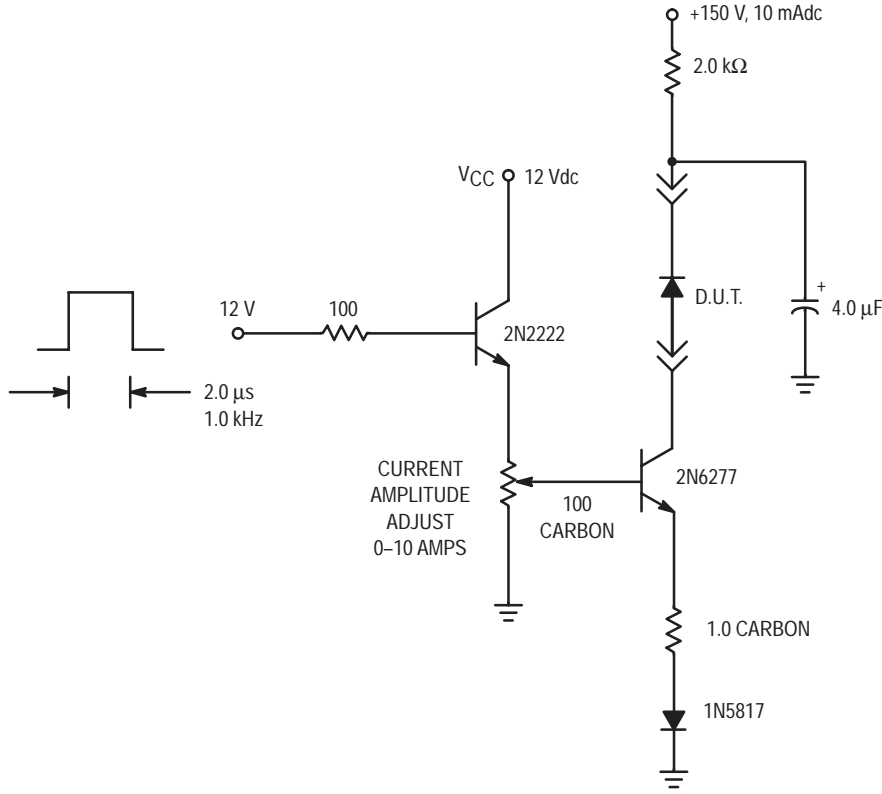


Figure 11. Test Circuit for dv/dt and Reverse Surge Current

SWITCHMODE™ Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- 20 Amps Total (10 Amps Per Diode Leg)
- Guard-Ring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche
- Epoxy Meets UL94, VO at 1/8"
- Low Power Loss/High Efficiency
- High Surge Capacity
- Low Stored Charge Majority Carrier Conduction

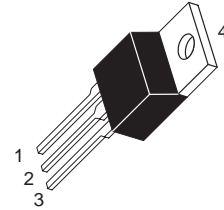
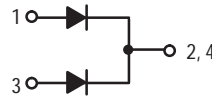
Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B2060, B2070, B2080, B2090, B20100

MBR2060CT
MBR2070CT
MBR2080CT
MBR2090CT
MBR20100CT

MBR2060CT and MBR20100CT
are Motorola Preferred Devices

**SCHOTTKY BARRIER
RECTIFIERS**
20 AMPERES
60–100 VOLTS



CASE 221A-06
TO-220AB
PLASTIC

MAXIMUM RATINGS PER DIODE LEG

Rating	Symbol	MBR					Unit
		2060CT	2070CT	2080CT	2090CT	20100CT	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	60	70	80	90	100	Volts
Average Rectified Forward Current (Rated V_R) $T_C = 133^\circ\text{C}$	$I_{F(AV)}$	10					Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz) $T_C = 133^\circ\text{C}$	I_{FRM}	20					Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150					Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz)	I_{RRM}	0.5					Amp
Operating Junction Temperature	T_J	-65 to +150					$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +175					$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10,000					$\text{V}/\mu\text{s}$

THERMAL CHARACTERISTICS

Maximum Thermal Resistance — Junction to Case — Junction to Ambient	$R_{\theta JC}$ $R_{\theta JA}$	2.0 60	$^\circ\text{C}/\text{W}$
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Preferred devices are Motorola recommended choices for future use and best overall value.

MBR2060CT MBR2070CT MBR2080CT MBR2090CT MBR20100CT

ELECTRICAL CHARACTERISTICS PER DIODE LEG

Rating	Symbol	MBR					Unit
		2060CT	2070CT	2080CT	2090CT	20100CT	
Maximum Instantaneous Forward Voltage (1) ($i_F = 10$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 10$ Amps, $T_C = 25^\circ\text{C}$) ($i_F = 20$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 20$ Amps, $T_C = 25^\circ\text{C}$)	v_F			0.75 0.85 0.85 0.95			Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$) (Rated dc Voltage, $T_C = 25^\circ\text{C}$)	i_R			6.0 0.1			mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

MBR2060CT MBR2070CT MBR2080CT MBR2090CT MBR20100CT

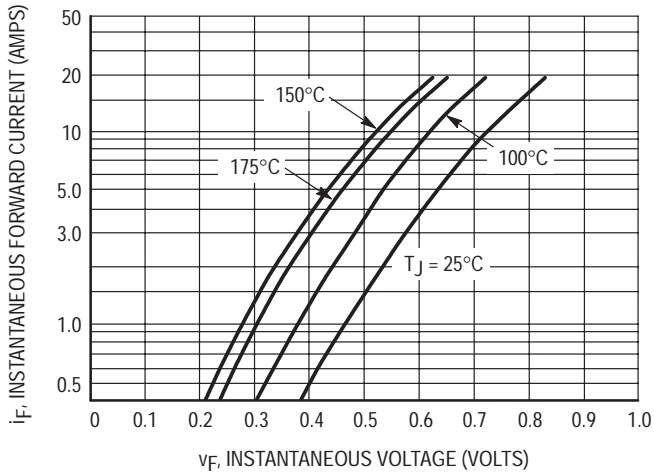


Figure 1. Typical Forward Voltage Per Diode

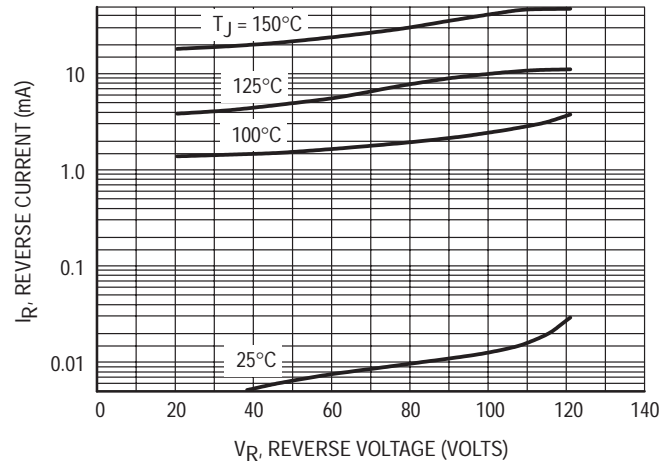


Figure 2. Typical Reverse Current Per Diode

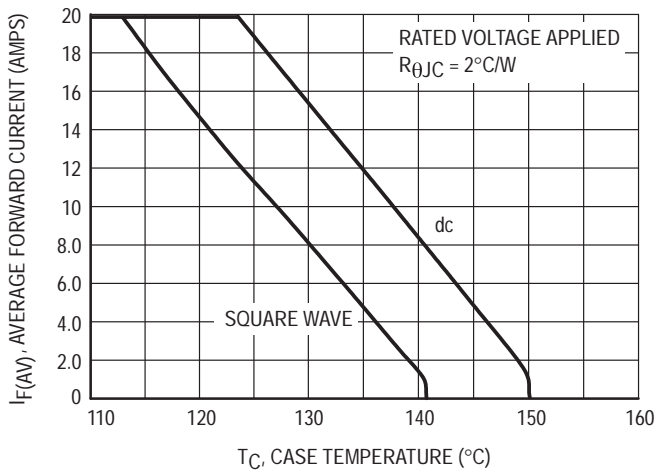


Figure 3. Current Derating, Case

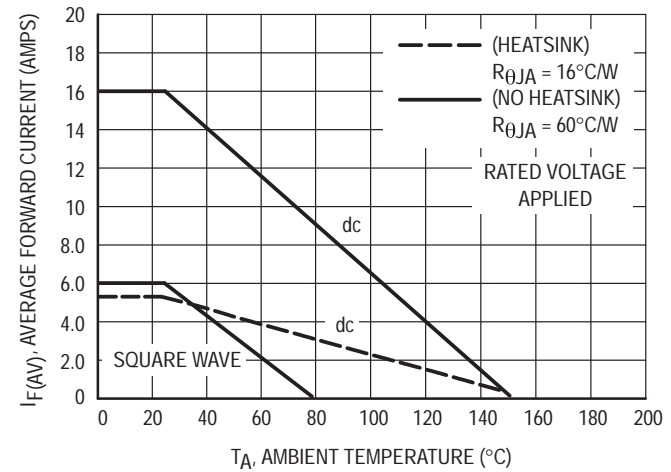


Figure 4. Current Derating, Ambient

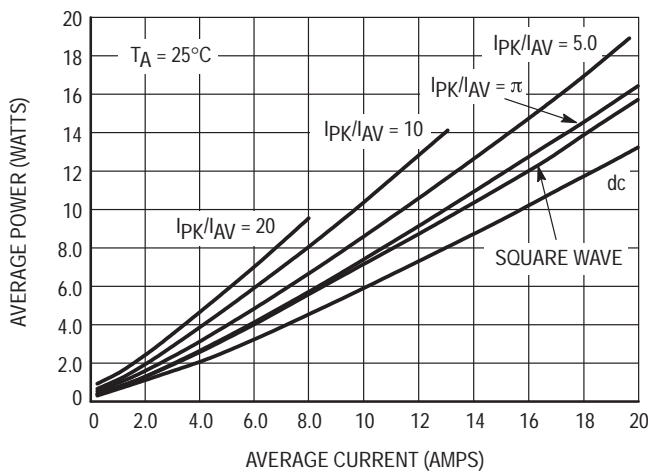


Figure 5. Average Power Dissipation and Average Current

SWITCHMODE™ Power

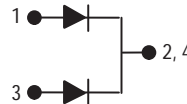
Dual Schottky Rectifier

... using Schottky Barrier technology with a platinum barrier metal. This state-of-the-art device is designed for use in high frequency switching power supplies and converters with up to 48 volt outputs. They block up to 200 volts and offer improved Schottky performance at frequencies from 250 kHz to 5.0 MHz.

- **200 Volt Blocking Voltage**
- Low Forward Voltage Drop
- Guardring for Stress Protection and High dv/dt Capability (10,000 V/μs)
- Dual Diode Construction — Terminals 1 and 3 Must be Connected for Parallel Operation at Full Rating

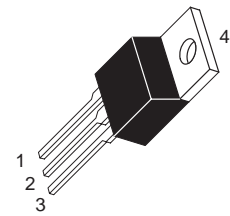
Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B20200



MBR2020CT

**SCHOTTKY BARRIER
RECTIFIER
20 AMPERES
200 VOLTS**



**CASE 221A-06
(TO-220AB)**

MAXIMUM RATINGS (PER LEG)

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	200	Volts
Average Rectified Forward Current (Rated V_R) $T_C = 125^\circ\text{C}$	$I_{F(AV)}$	10 20	Amps Per Leg Per Package
Peak Repetitive Forward Current, Per Leg (Rated V_R , Square Wave, 20 kHz) $T_C = 90^\circ\text{C}$	I_{FRM}	20	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I_{RRM}	1.0	Amp
Operating Junction Temperature	T_J	-65 to +150	°C
Storage Temperature	T_{stg}	-65 to +175	°C
Voltage Rate of Change (Rated V_R)	dv/dt	10,000	V/μs

THERMAL CHARACTERISTICS (PER LEG)

Thermal Resistance — Junction to Case	$R_{\theta JC}$	2.0	°C/W
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ELECTRICAL CHARACTERISTICS (PER LEG)

Maximum Instantaneous Forward Voltage (1)	($I_F = 10$ Amps, $T_C = 25^\circ\text{C}$) ($I_F = 10$ Amps, $T_C = 125^\circ\text{C}$) ($I_F = 20$ Amps, $T_C = 25^\circ\text{C}$) ($I_F = 20$ Amps, $T_C = 125^\circ\text{C}$)	V_F	0.9 0.8 1.0 0.9	Volts
Maximum Instantaneous Reverse Current (1)	(Rated dc Voltage, $T_C = 25^\circ\text{C}$) (Rated dc Voltage, $T_C = 125^\circ\text{C}$)	I_R	1.0 50	mA

DYNAMIC CHARACTERISTICS (PER LEG)

Capacitance ($V_R = -5.0$ V, $T_C = 25^\circ\text{C}$, Frequency = 1.0 MHz)	C_T	500	pF
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(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

MBR2020CT

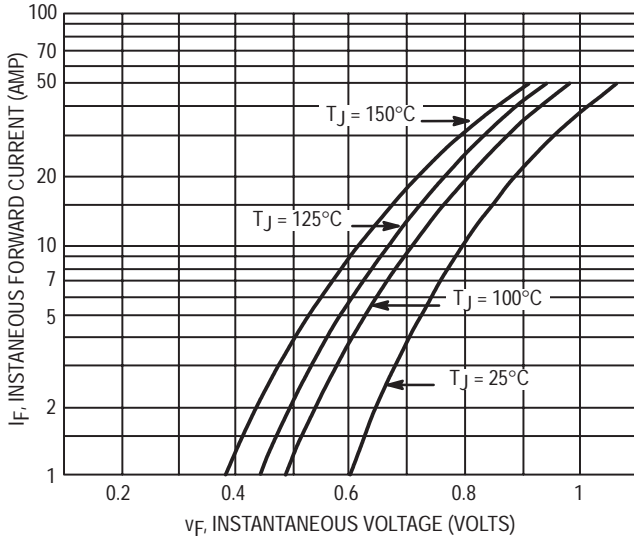


Figure 1. Typical Forward Voltage (Per Leg)

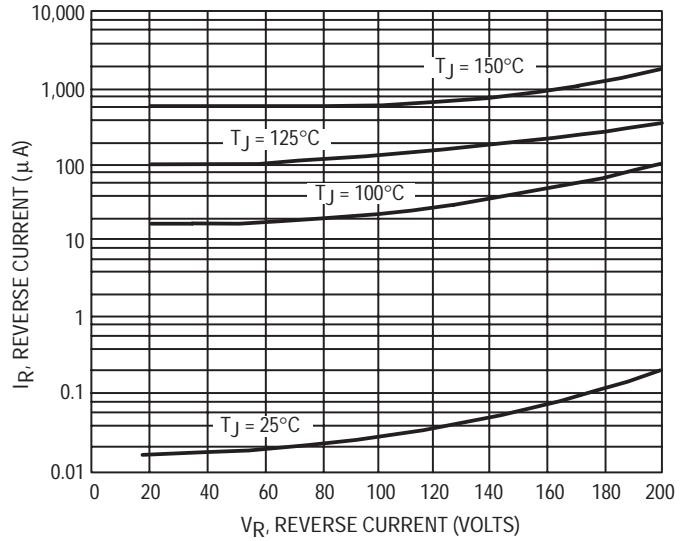


Figure 2. Typical Reverse Current (Per Leg)

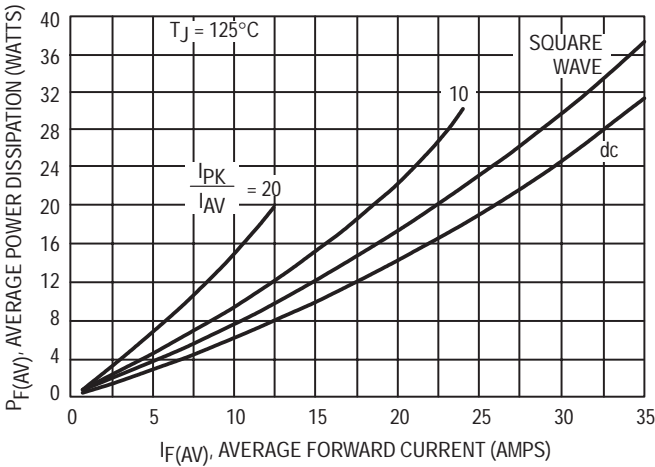


Figure 3. Forward Power Dissipation

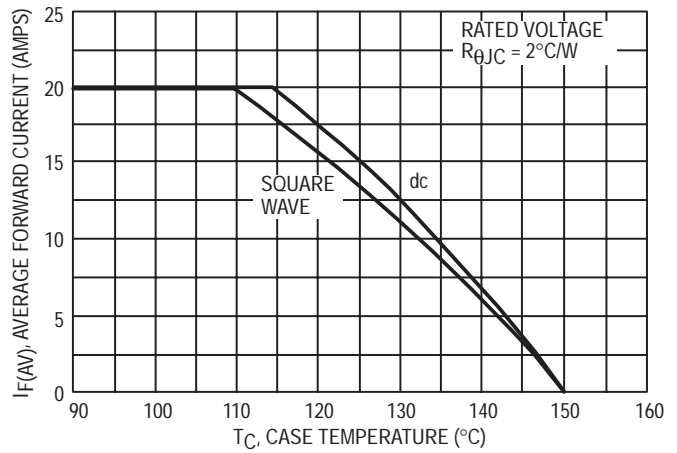


Figure 4. Current Derating, Case

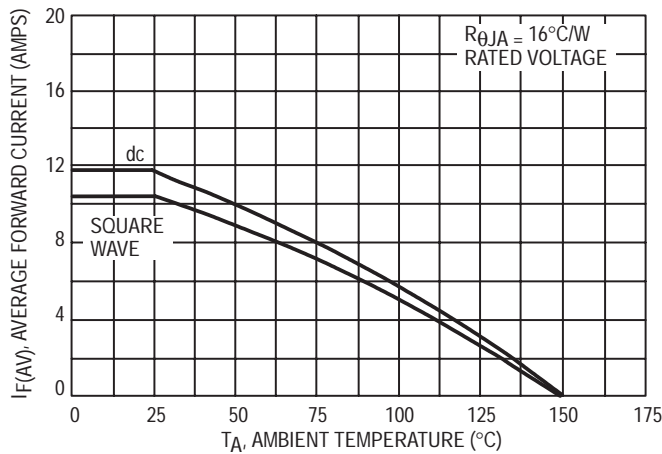


Figure 5. Current Derating, Ambient

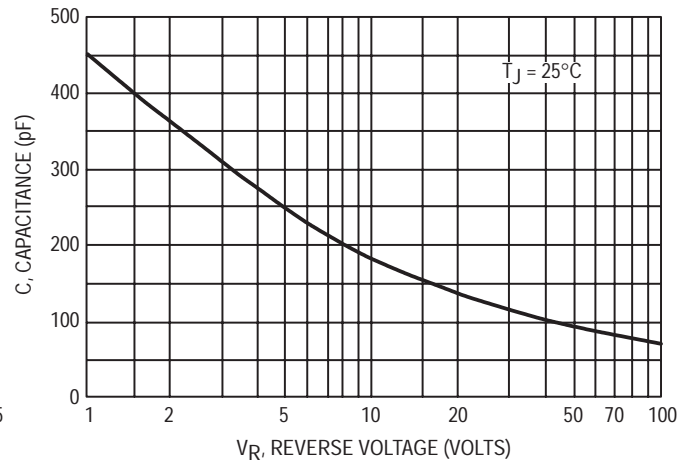


Figure 6. Typical Capacitance (Per Leg)

Advance Information

SWITCHMODE™ Power Rectifier

... employing the Schottky Barrier principle in a large metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use in low voltage, high frequency switching power supplies, low voltage converters, OR'ing diodes, and polarity protection devices.

- Very Low Forward Voltage (0.28 V Maximum @ 19 Amps, 70°C)
- Guardring for Stress Protection
- Highly Stable Oxide Passivated Junction (100°C Operating Junction Temperature)
- Epoxy Meets UL94, VO at 1/8"

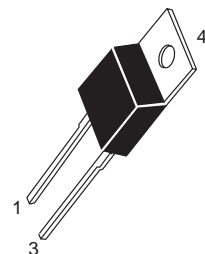
Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 Units Per Plastic Tube
- Marking: B2515L



MBR2515L

**SCHOTTKY BARRIER
RECTIFIER
25 AMPERES
15 VOLTS**



**CASE 221B-03, STYLE 1
(TO-220AC)**

MAXIMUM RATINGS (Per Leg)

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	15	Volts
Average Rectified Forward Current (Rated V_R) $T_C = 90^\circ\text{C}$	$I_{F(AV)}$	25	Amps
Peak Repetitive Forward Current, Per Leg (Rated V_R , Square Wave, 20 kHz) $T_C = 90^\circ\text{C}$	I_{FRM}	30	Amps
Non Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz)	I_{RRM}	1.0	Amps
Operating Junction Temperature	T_J	-65 to +100	$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +125	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Case	$R_{\theta JC}$	2.0	$^\circ\text{C/W}$
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ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ($I_F = 25$ Amps, $T_J = 25^\circ\text{C}$) ($I_F = 25$ Amps, $T_J = 70^\circ\text{C}$) ($I_F = 19$ Amps, $T_J = 70^\circ\text{C}$)	V_F	0.45 0.42 0.28	Volts
Maximum Instantaneous Reverse Current (1) (Rated DC Voltage, $T_J = 25^\circ\text{C}$) (Rated DC Voltage, $T_J = 70^\circ\text{C}$)	I_R	15 200	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

This document contains information on a new product. Specifications and information herein are subject to change without notice.

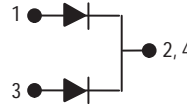
SWITCHMODE™ Power Rectifier

... employing the Schottky Barrier principle in a large metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use in low voltage, high frequency switching power supplies, free wheeling diodes, and polarity protection diodes.

- Very Low Forward Voltage (0.55 V Maximum @ 25 Amps)
- Matched Dual Die Construction (12.5 A per Leg or 25 A per Package)
- Guardring for Stress Protection
- Highly Stable Oxide Passivated Junction (125°C Operating Junction Temperature)
- Epoxy Meets UL94, VO at 1/8"

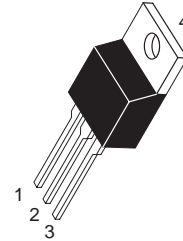
Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B2535L



MBR2535CTL

**SCHOTTKY BARRIER
RECTIFIER
25 AMPERES
35 VOLTS**



**CASE 221A-06
(TO-220AC)**

MAXIMUM RATINGS (PER LEG)

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}	35	Volts
Working Peak Reverse Voltage	V_{RWM}	35	
DC Blocking Voltage	V_R	35	
Average Rectified Forward Current (Rated V_R) $T_C = 110^\circ\text{C}$	$I_{F(AV)}$	12.5	Amps
Peak Repetitive Forward Current, Per Leg (Rated V_R , Square Wave, 20 kHz) $T_C = 95^\circ\text{C}$	I_{FRM}	25	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I_{FSM}	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz)	I_{RRM}	1.0	Amp
Operating Junction Temperature	T_J	-65 to +125	$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10,000	$\text{V}/\mu\text{s}$
Controlled Avalanche Energy	W_{aval}	20	mJ

THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Case	$R_{\theta JC}$	2.0	$^\circ\text{C}/\text{W}$
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ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ($I_F = 25$ Amps, $T_J = 25^\circ\text{C}$) ($I_F = 12.5$ Amps, $T_J = 25^\circ\text{C}$) ($I_F = 12.5$ Amps, $T_J = 125^\circ\text{C}$)	V_F	0.55 0.47 0.41	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 25^\circ\text{C}$) (Rated dc Voltage, $T_J = 125^\circ\text{C}$)	I_R	5.0 500	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

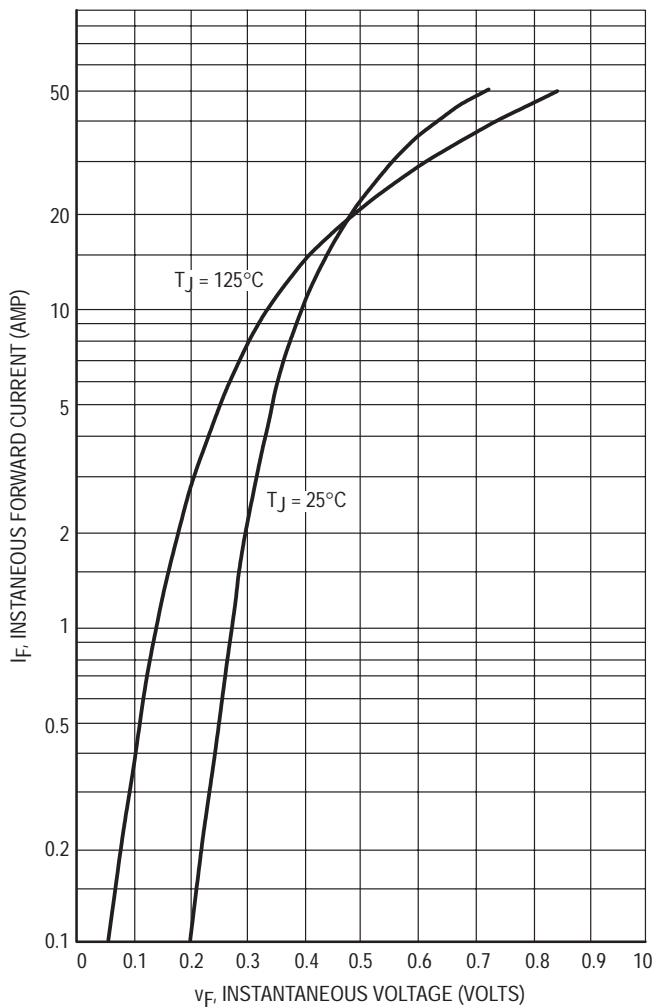


Figure 1. Typical Forward Voltage, Per Leg

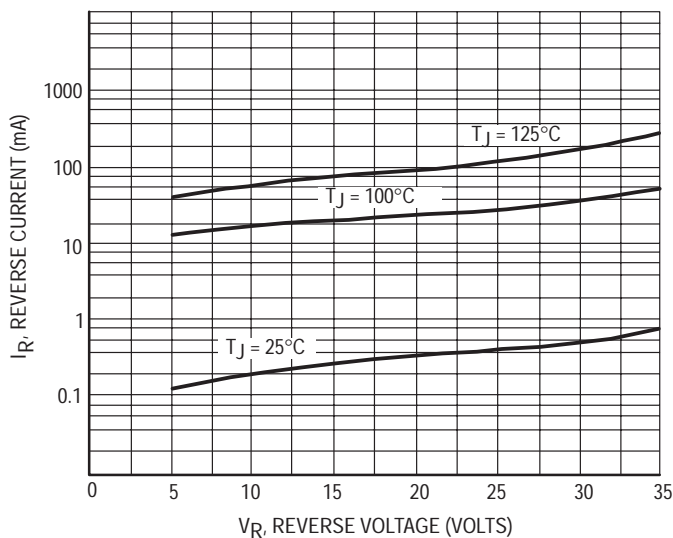


Figure 2. Typical Reverse Current, Per Leg

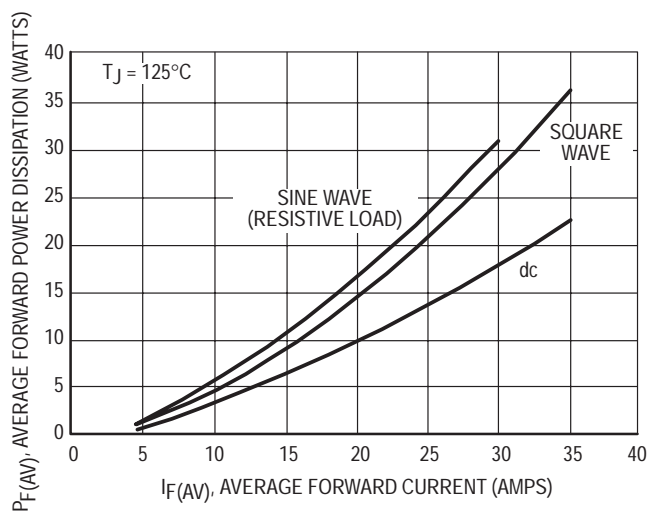


Figure 3. Forward Power Dissipation, Per Leg

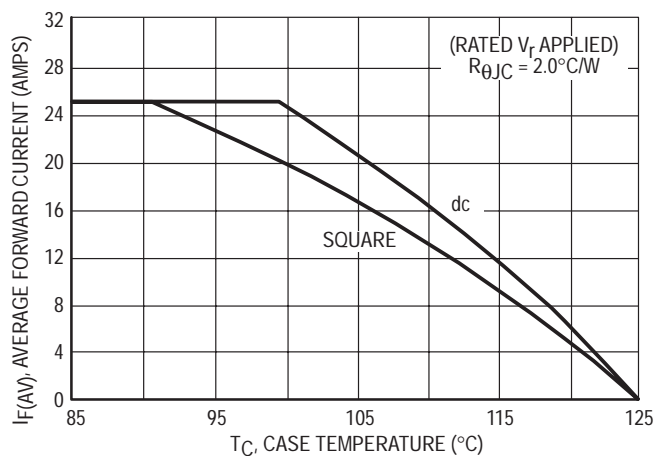


Figure 4. Current Derating

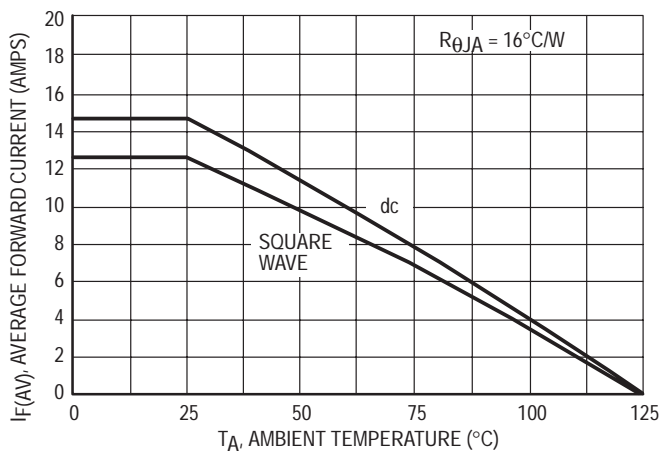


Figure 5. Current Derating Ambient, Per Leg

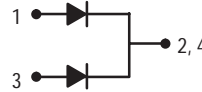
SWITCHMODE™ Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B2535, B2545



MBR2535CT
MBR2545CT

MBR2545CT is a
Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIERS**
30 AMPERES
35 and 45 VOLTS

CASE 221A-06
TO-220AB
PLASTIC

MAXIMUM RATINGS

Rating	Symbol	MBR2535CT	MBR2545CT	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	35	45	Volts
Average Rectified Forward Current (Rated V_R) $T_C = 130^\circ\text{C}$	$I_{F(AV)}$	30	30	Amps
Peak Repetitive Forward Current Per Diode Leg (Rated V_R , Square Wave, 20 kHz) $T_C = 130^\circ\text{C}$	I_{FRM}	30	30	Amps
Nonrepetitive Peak Surge Current per Diode Leg (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz)	I_{RRM}	1.0	1.0	Amp
Operating Junction Temperature	T_J	-65 to +150	-65 to +150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +175	-65 to +175	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	1000	1000	$\text{V}/\mu\text{s}$

THERMAL CHARACTERISTICS PER DIODE LEG

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.5	1.5	$^\circ\text{C}/\text{W}$
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ELECTRICAL CHARACTERISTICS PER DIODE LEG

Maximum Instantaneous Forward Voltage (1) ($i_F = 30$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 30$ Amps, $T_C = 25^\circ\text{C}$)	v_F	0.73 0.82	0.73 0.82	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$) (Rated dc Voltage, $T_C = 25^\circ\text{C}$)	i_R	40 0.2	40 0.2	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

Preferred devices are Motorola recommended choices for future use and best overall value.

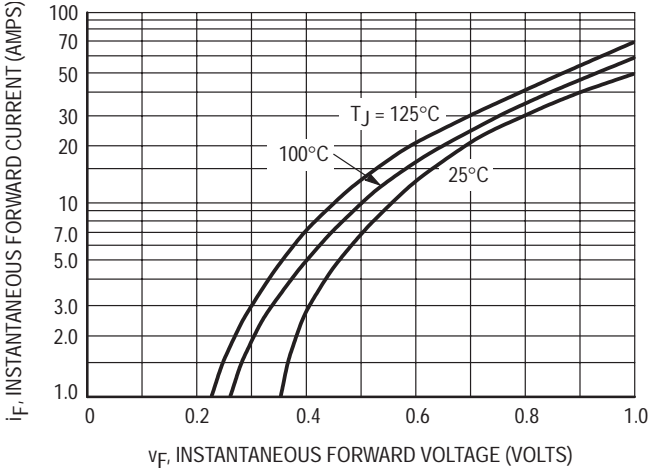


Figure 1. Typical Forward Voltage

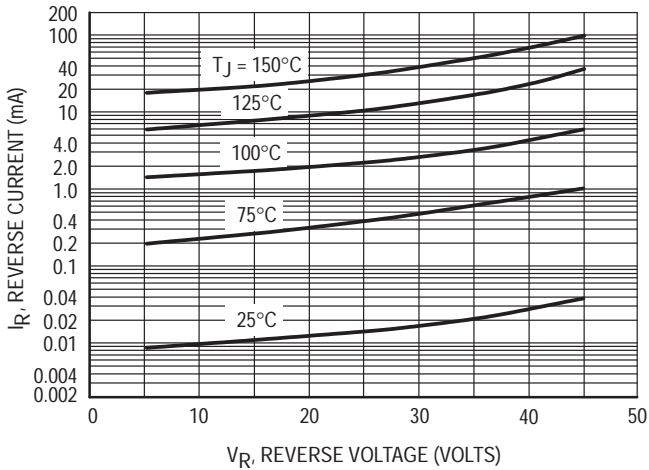


Figure 2. Typical Reverse Current

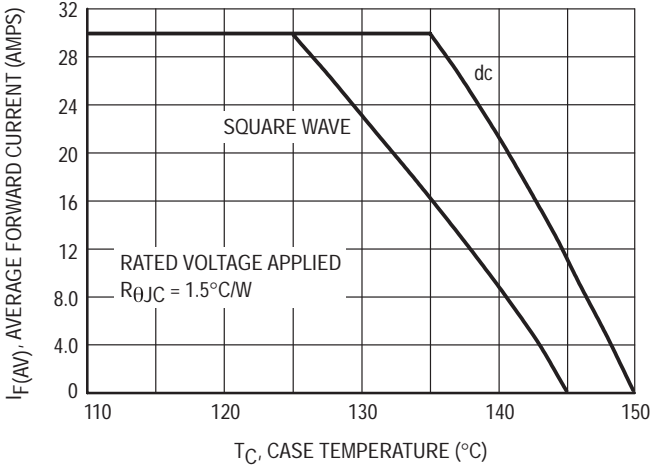


Figure 3. Current Derating, Case

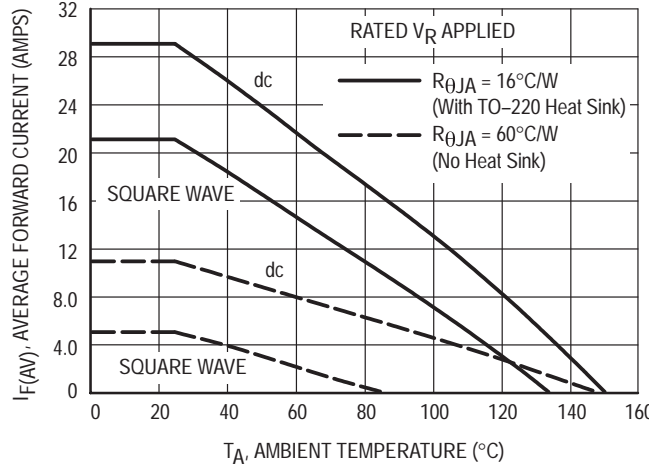


Figure 4. Current Derating, Ambient

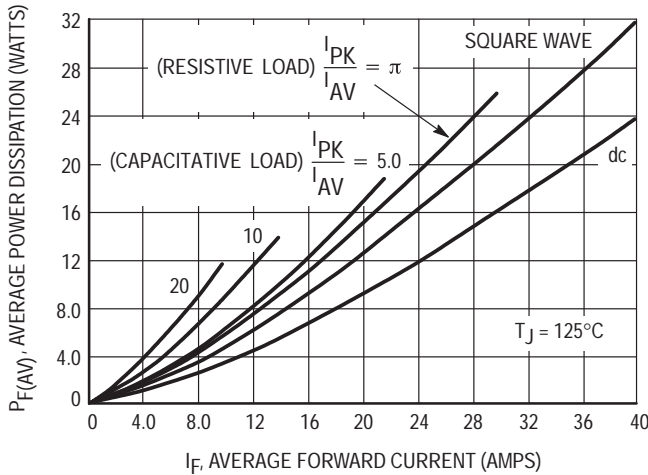


Figure 5. Forward Power Dissipation

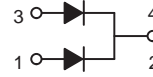
Advance Information
SWITCHMODE™ Power Rectifier

... using the Schottky Barrier principle with a platinum barrier metal. This state-of-the-art device has the following features:

- Dual Diode Construction — Terminals 1 and 3 May Be Connected for Parallel Operation at Full Rating
- 45 V Blocking Voltage
- Low Forward Voltage Drop
- Guardring for Stress Protection
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche

Mechanical Characteristics

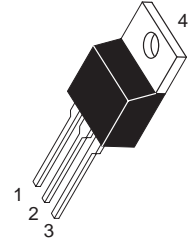
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 Units Per Plastic Tube
- Marking: B3045



MBR3045ST

Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIER
30 AMPERES
45 VOLTS**



**CASE 221A-06, STYLE 6
(TO-220AB)**

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	45	Volts
Average Rectified Current $T_C = 130^\circ\text{C}$	$I_{F(AV)}$	30 15	Amps
Peak Repetitive Forward Current, Per Diode (Square Wave, $V_R = 45\text{ V}$, 20 kHz)	I_{FRM}	30	Amps
Non Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150	Amps
Peak Repetitive Reverse Current, Per Diode (2.0 μs , 1.0 kHz)	I_{RRM}	2.0	Amps
Operating Junction Temperature	T_J	-65 to +150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +175	$^\circ\text{C}$
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dV/dt	10000	$\text{V}/\mu\text{s}$

THERMAL CHARACTERISTICS PER DIODE

Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.5	$^\circ\text{C}/\text{W}$
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ELECTRICAL CHARACTERISTICS PER DIODE

Instantaneous Forward Voltage (1)	$(I_F = 30\text{ Amp}, T_C = 25^\circ\text{C})$ $(I_F = 30\text{ Amp}, T_C = 125^\circ\text{C})$ $(I_F = 20\text{ Amp}, T_C = 125^\circ\text{C})$	V_F	0.76 0.72 0.60	Volts
Instantaneous Reverse Current (1)	$(V_R = 45\text{ Volts}, T_C = 25^\circ\text{C})$ $(V_R = 45\text{ Volts}, T_C = 125^\circ\text{C})$	I_R	0.2 40	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$

This document contains information on a new product. Specifications and information herein are subject to change without notice. Preferred devices are Motorola recommended choices for future use and best overall value.

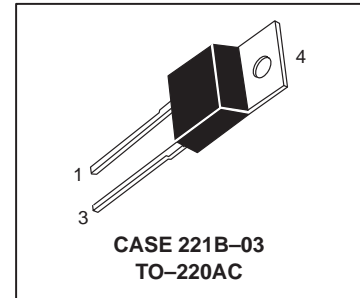
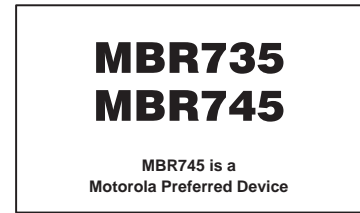
SWITCHMODE™ Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche
- Epoxy Meets UL94, VO at 1/8"

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B735, B745



MAXIMUM RATINGS

Rating	Symbol	MBR735	MBR745	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	35	45	Volts
Average Rectified Forward Current (Rated V_R) $T_C = 105^\circ\text{C}$	$I_{F(AV)}$	7.5	7.5	Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz) $T_C = 105^\circ\text{C}$	I_{FRM}	15	15	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz)	I_{RRM}	1.0	1.0	Amp
Operating Junction Temperature	T_J	-65 to +150	-65 to +150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +175	-65 to +175	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	1000	10000	$\text{V}/\mu\text{s}$

THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.0	3.0	$^\circ\text{C}/\text{W}$
Maximum Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	60	60	$^\circ\text{C}/\text{W}$

ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ($i_F = 7.5$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 15$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 15$ Amps, $T_C = 25^\circ\text{C}$)	V_F	0.57 0.72 0.84	0.57 0.72 0.84	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$) (Rated dc Voltage, $T_C = 25^\circ\text{C}$)	i_R	15 0.1	15 0.1	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

Preferred devices are Motorola recommended choices for future use and best overall value.

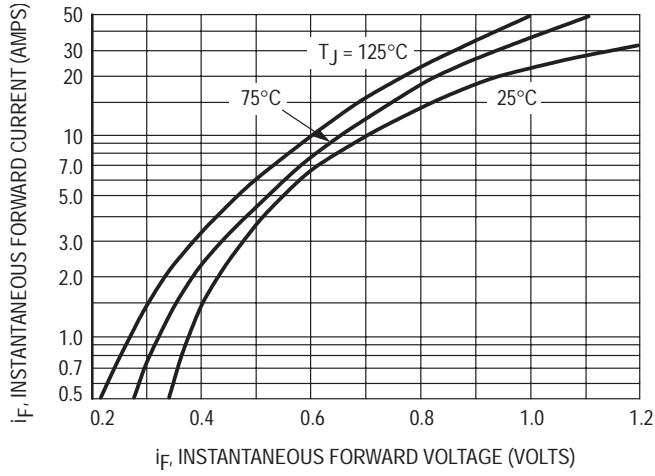


Figure 1. Typical Forward Voltage

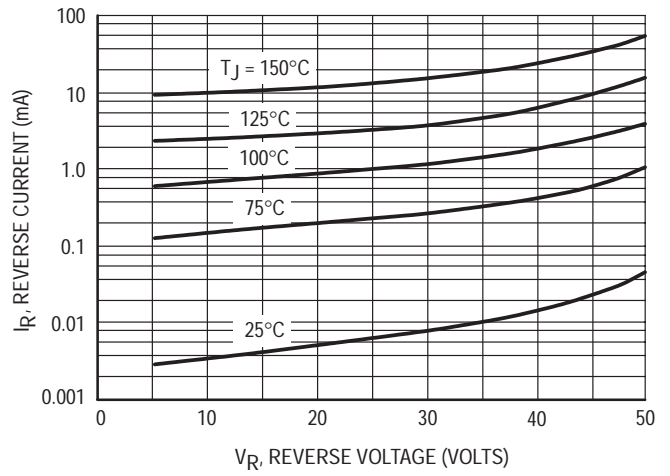


Figure 2. Typical Reverse Current

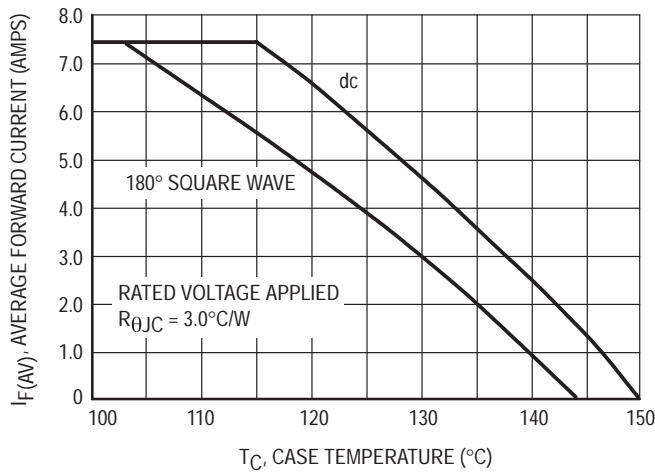


Figure 3. Current Derating, Case

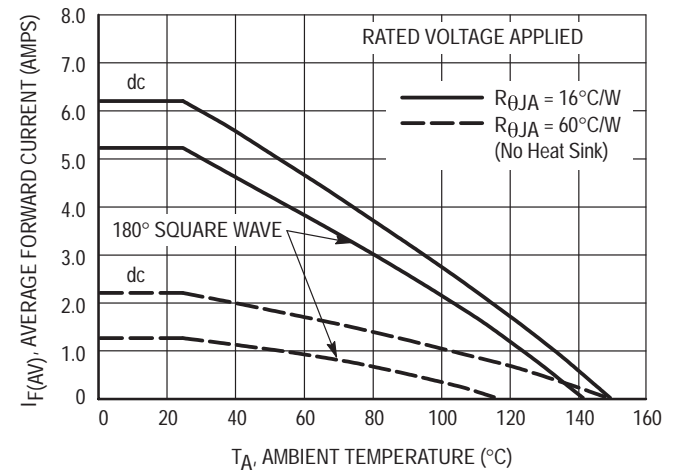


Figure 4. Current Derating, Ambient

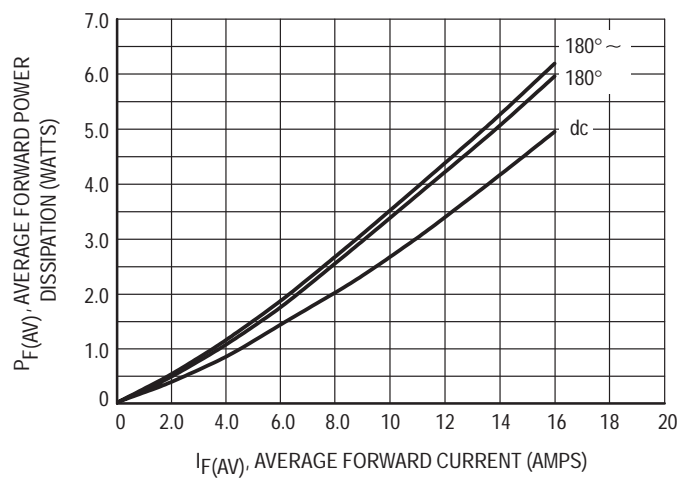


Figure 5. Power Dissipation

SWITCHMODE™ Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche
- Epoxy Meets UL94, VO at 1/8"

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B1035, B1045



MBR1035
MBR1045

MBR1045 is a
Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIERS**
10 AMPERES
20 to 45 VOLTS

CASE 221B-03
TO-220AC
PLASTIC

A photograph of the physical diode component. It is a small, rectangular, black plastic package with two leads extending from one side. The leads are labeled with the numbers 1, 3, and 4. The package is shown at an angle to highlight its three-dimensional shape.

MAXIMUM RATINGS

Rating	Symbol	MBR1035	MBR1045	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	35	45	Volts
Average Rectified Forward Current (Rated V_R) $T_C = 135^\circ\text{C}$	$I_{F(AV)}$	10	10	Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz) $T_C = 135^\circ\text{C}$	I_{FRM}	20	20	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz) See Figure 12	I_{RRM}	1.0	1.0	Amp
Operating Junction Temperature	T_J	-65 to +150	-65 to +150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +175	-65 to +175	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	1000	10000	V/ μs

THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	2.0	2.0	$^\circ\text{C/W}$
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ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ($i_F = 10$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 20$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 20$ Amps, $T_C = 25^\circ\text{C}$)	V_F	0.57 0.72 0.84	0.57 0.72 0.84	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$) (Rated dc Voltage, $T_C = 25^\circ\text{C}$)	i_R	15 0.1	15 0.1	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

Preferred devices are Motorola recommended choices for future use and best overall value.

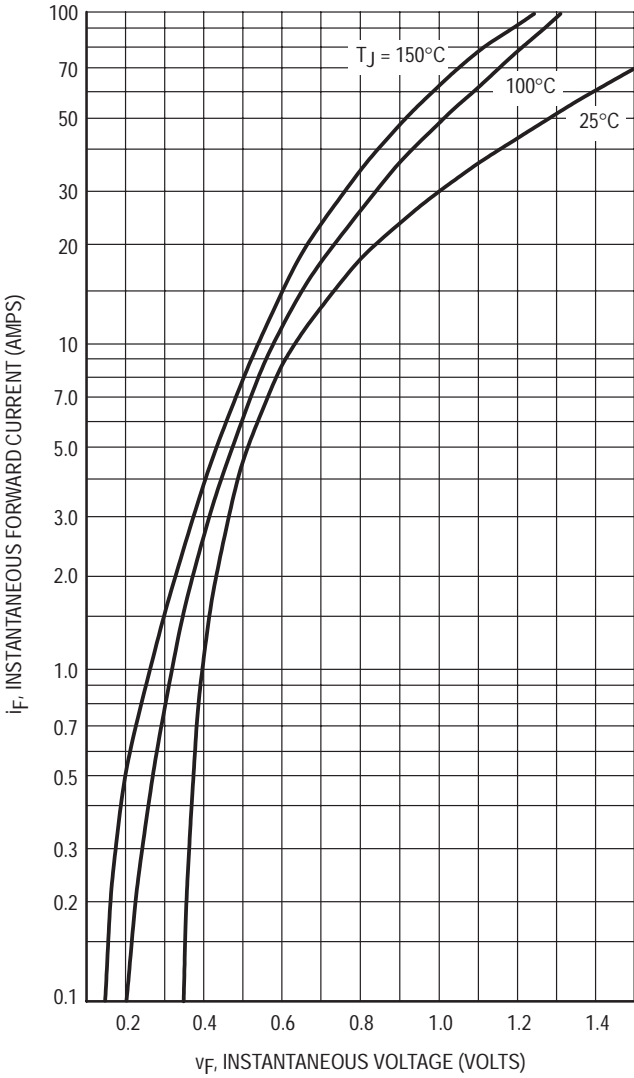


Figure 1. Maximum Forward Voltage

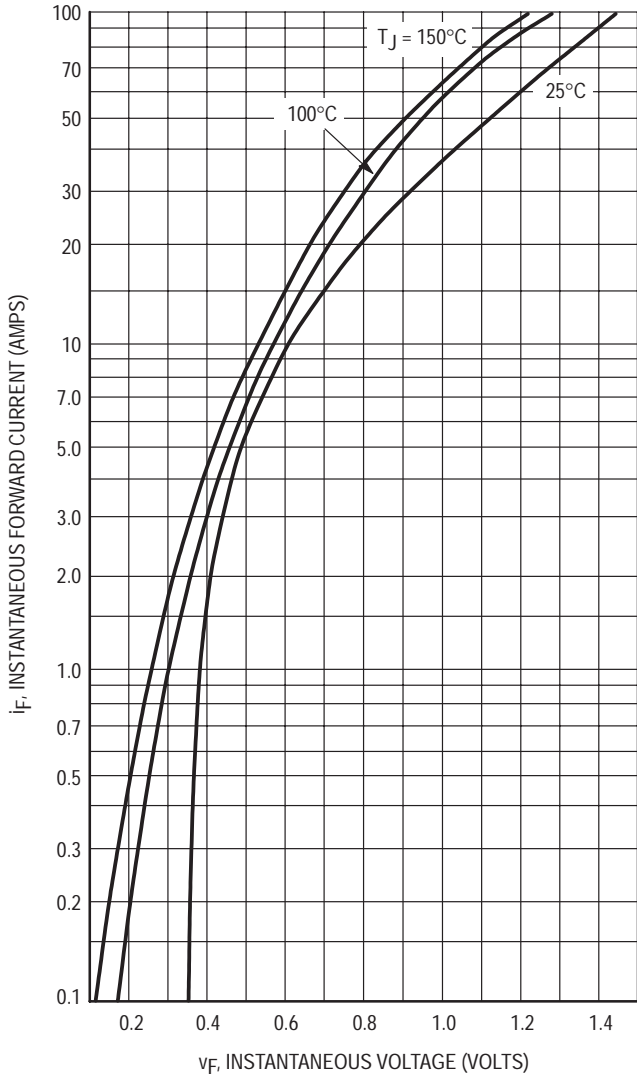


Figure 2. Typical Forward Voltage

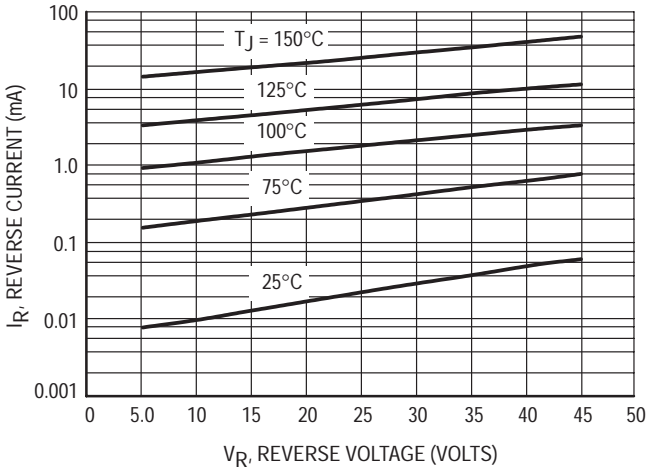


Figure 3. Maximum Reverse Current

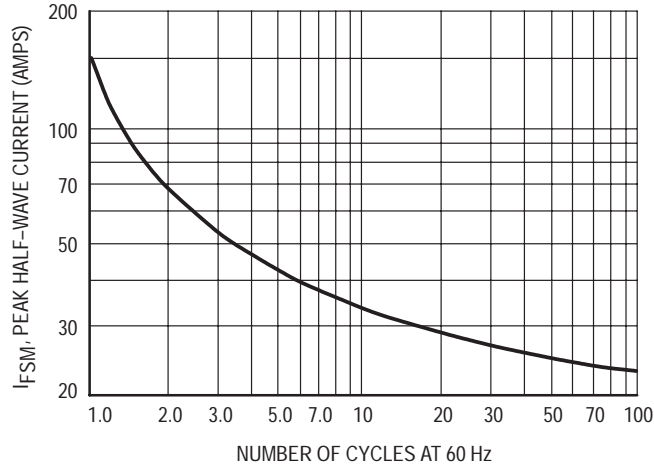


Figure 4. Maximum Surge Capability

MBR1035 MBR1045

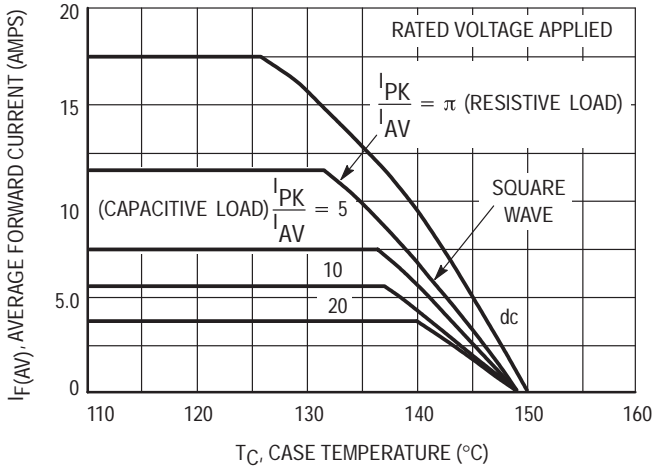


Figure 5. Current Derating, Infinite Heatsink

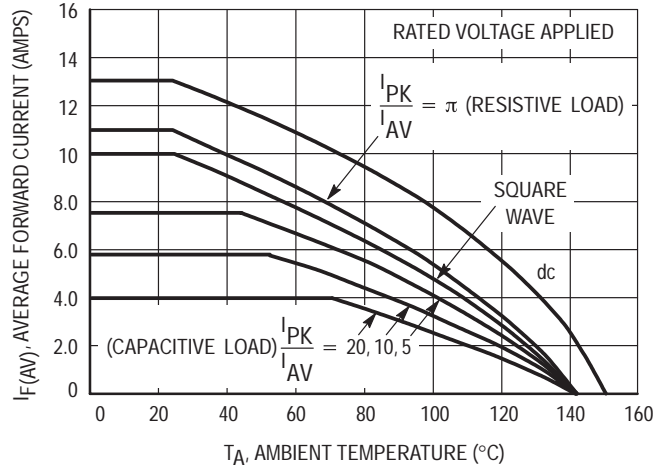


Figure 6. Current Derating, $R_{\theta JA} = 16^{\circ}\text{C/W}$

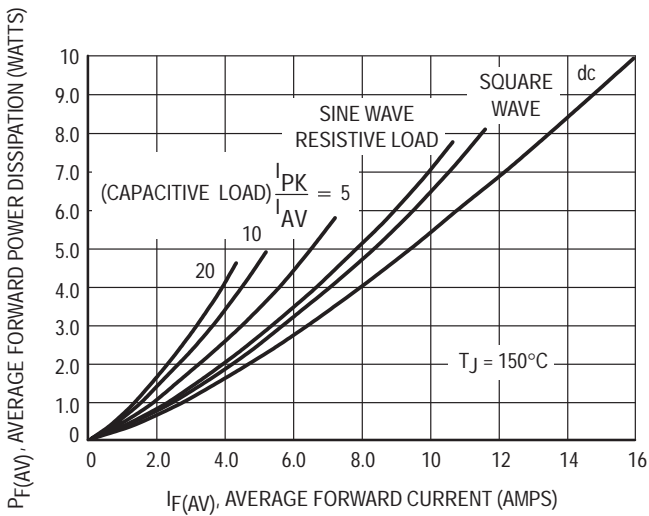


Figure 7. Forward Power Dissipation

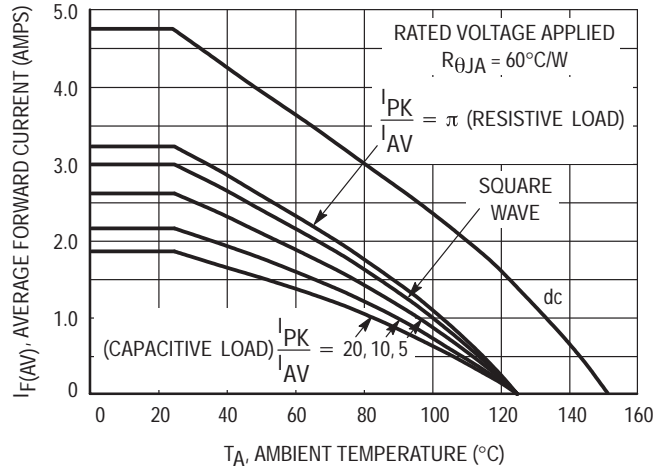


Figure 8. Current Derating, Free Air

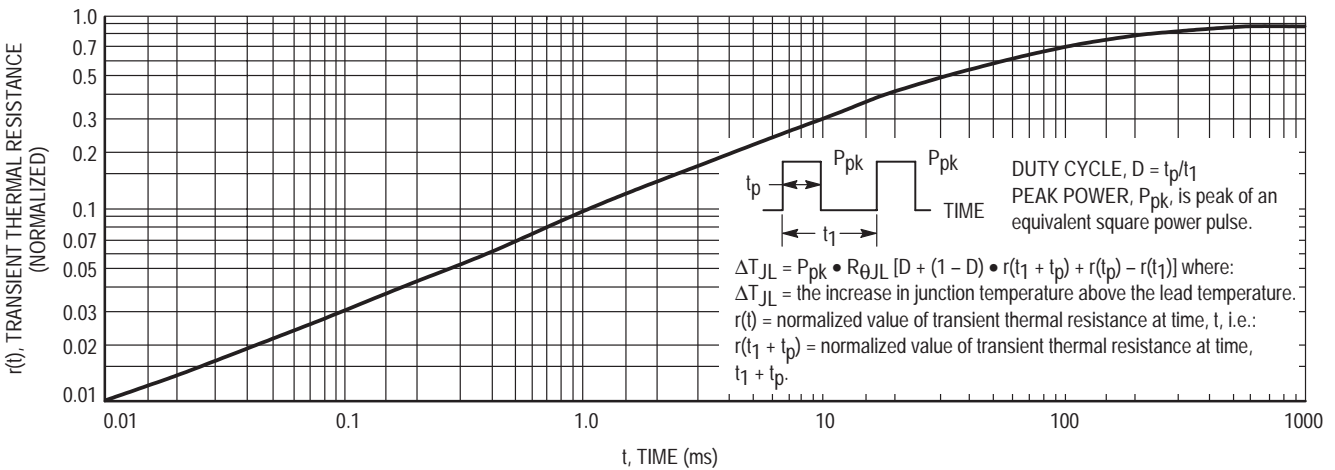


Figure 9. Thermal Response

HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 10.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 percent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

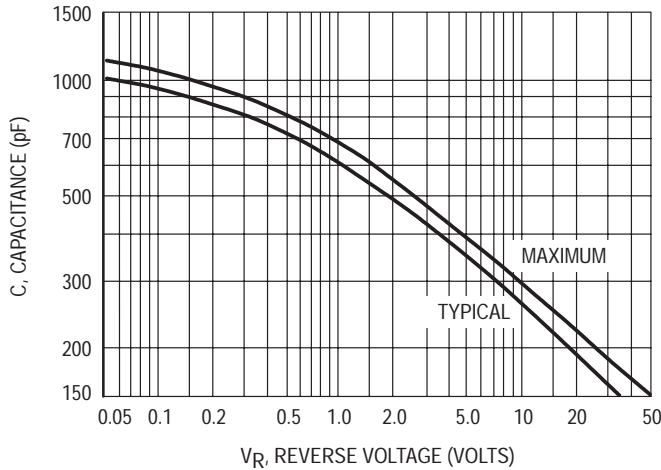


Figure 10. Capacitance

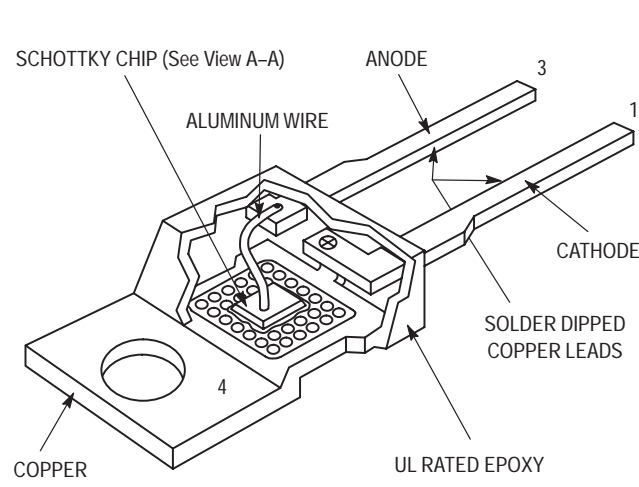
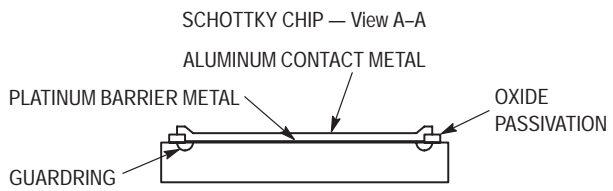


Figure 11. Schottky Rectifier



Motorola builds quality and reliability into its Schottky Rectifiers. First is the chip, which has an interface metal between the barrier metal and aluminum-contact metal to eliminate any possible interaction between the two. The indicated guardring prevents dv/dt problems, so snubbers are not mandatory. The guardring also operates like a zener to absorb over-voltage transients.

Second is the package. The Schottky chip is bonded to the copper heat sink using a specially formulated solder. This gives the unit the capability of passing 10,000 operating thermal-fatigue cycles having a ΔT_J of 100°C. The epoxy molding compound is rated per UL 94, V0 @ 1/8". Wire bonds are 100% tested in assembly as they are made.

Third is the electrical testing, which includes 100% dv/dt at 1600 V/ μ s and reverse avalanche as part of device characterization.

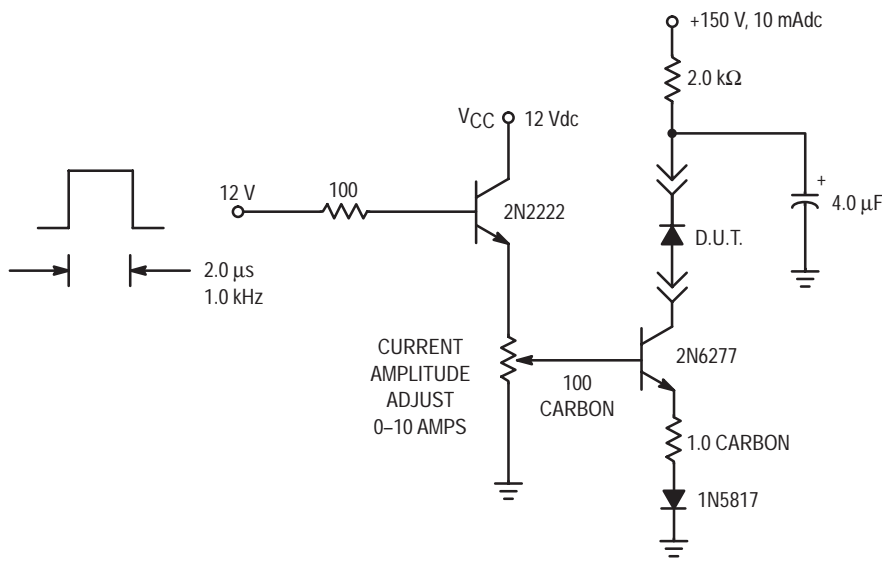


Figure 12. Test Circuit for dv/dt and Reverse Surge Current

SWITCHMODE™ Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Guard-Ring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche
- Epoxy Meets UL94, VO at 1/8"
- Low Power Loss/High Efficiency
- High Surge Capacity
- Low Stored Charge Majority Carrier Conduction

Mechanical Characteristics:

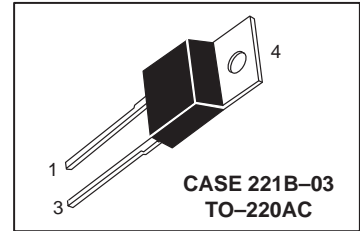
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B1060, B1070, B1080, B1090, B10100



MBR1060
MBR1070
MBR1080
MBR1090
MBR10100

MBR1060 and MBR10100 are
Motorola Preferred Devices

**SCHOTTKY BARRIER
RECTIFIERS
10 AMPERES
60 to 100 VOLTS**



MAXIMUM RATINGS

Rating	Symbol	MBR					Unit
		1060	1070	1080	1090	10100	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	60	70	80	90	100	Volts
Average Rectified Forward Current (Rated V_R) $T_C = 133^\circ\text{C}$	$I_{F(AV)}$	10					Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz) $T_C = 133^\circ\text{C}$	I_{FRM}	20					Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150					Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz)	I_{RRM}	0.5					Amp
Operating Junction Temperature	T_J	-65 to +150					$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +175					$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10,000					$\text{V}/\mu\text{s}$

THERMAL CHARACTERISTICS

Maximum Thermal Resistance — Junction to Case — Junction to Ambient	$R_{\theta JC}$ $R_{\theta JA}$	2.0 60	$^\circ\text{C}/\text{W}$
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ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ($i_F = 10$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 10$ Amps, $T_C = 25^\circ\text{C}$) ($i_F = 20$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 20$ Amps, $T_C = 25^\circ\text{C}$)	V_F	0.7 0.8 0.85 0.95	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$) (Rated dc Voltage, $T_C = 25^\circ\text{C}$)	i_R	6.0 0.10	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

Preferred devices are Motorola recommended choices for future use and best overall value.

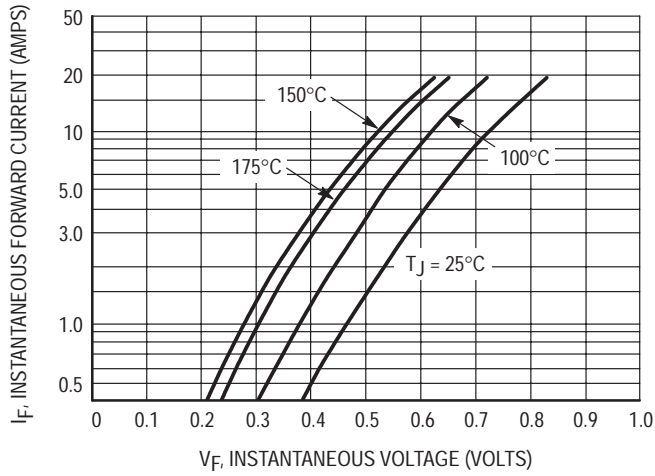


Figure 1. Typical Forward Voltage

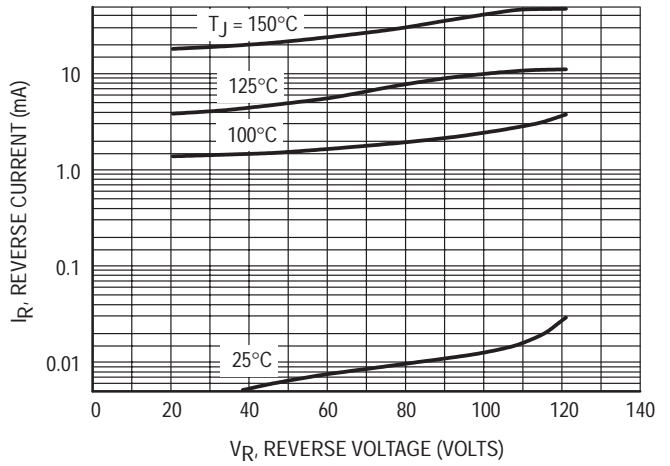


Figure 2. Typical Reverse Current

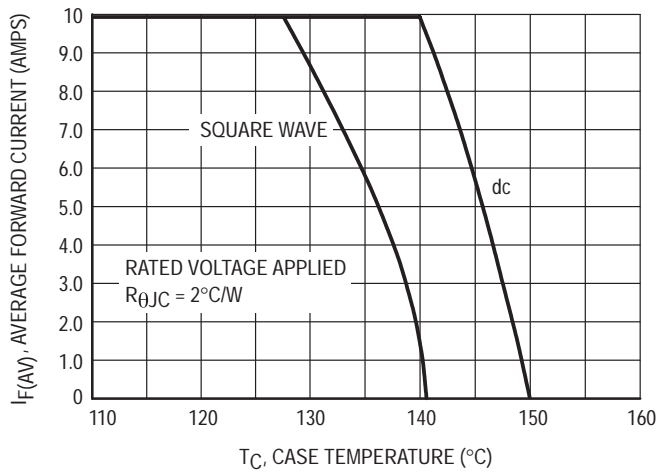


Figure 3. Current Derating, Case

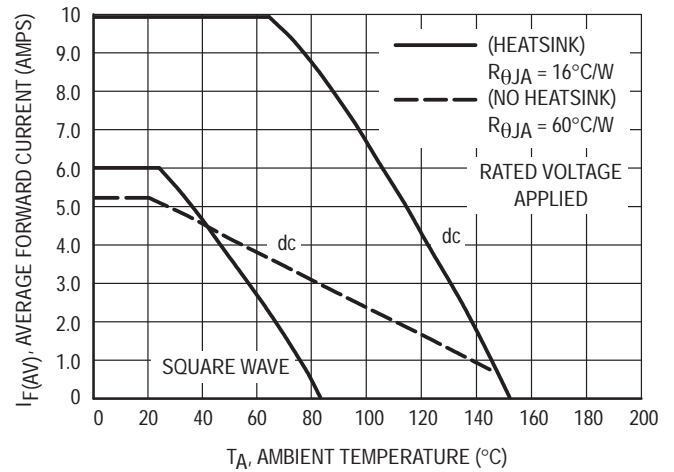


Figure 4. Current Derating, Ambient

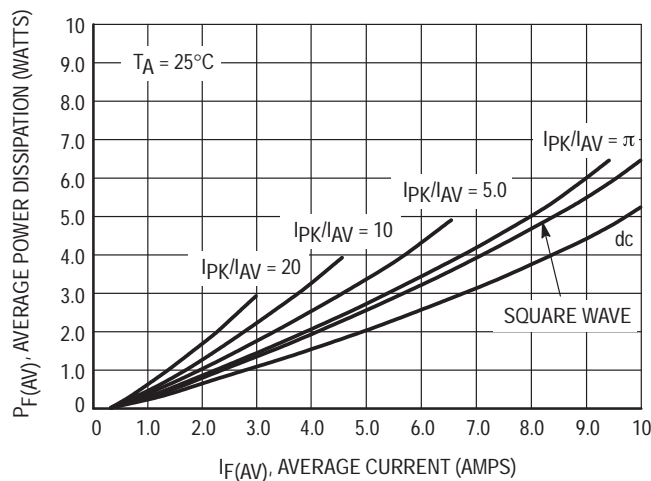


Figure 5. Forward Power Dissipation

SWITCHMODE™ Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche

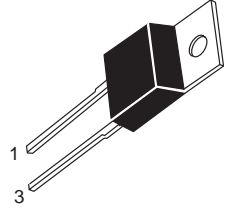
Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B1635, B1645

MBR1635
MBR1645

MBR1645 is a
Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIERS**
16 AMPERES
35 and 45 VOLTS



CASE 221B-03
TO-220AC



MAXIMUM RATINGS

Rating	Symbol	MBR1635	MBR1645	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	35	45	Volts
Average Rectified Forward Current (Rated V_R) $T_C = 125^\circ\text{C}$	$I_{F(AV)}$	16	16	Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz) $T_C = 125^\circ\text{C}$	I_{FRM}	32	32	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz)	I_{RRM}	1.0	1.0	Amp
Operating Junction Temperature	T_J	-65 to +150	-65 to +150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +175	-65 to +175	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	1000	10000	V/ μs

THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.5	1.5	$^\circ\text{C}/\text{W}$
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ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ($i_F = 16$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 16$ Amps, $T_C = 25^\circ\text{C}$)	v_F	0.57 0.63	0.57 0.63	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$) (Rated dc Voltage, $T_C = 25^\circ\text{C}$)	i_R	40 0.2	40 0.2	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

Preferred devices are Motorola recommended choices for future use and best overall value.

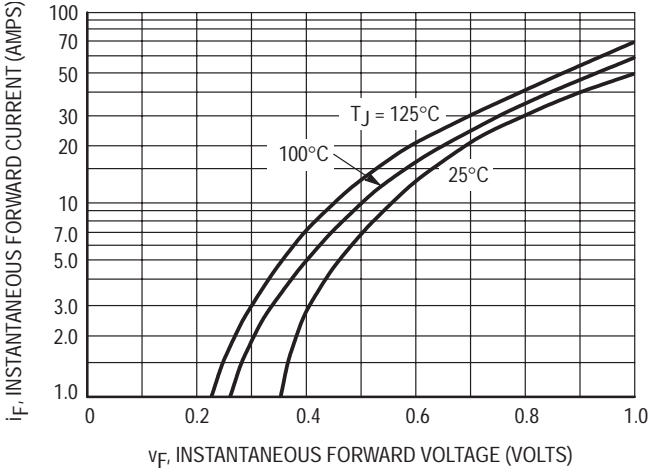


Figure 1. Typical Forward Voltage

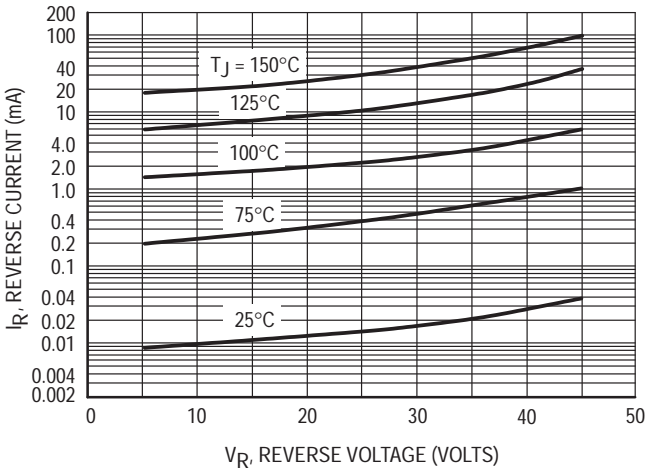


Figure 2. Typical Reverse Current

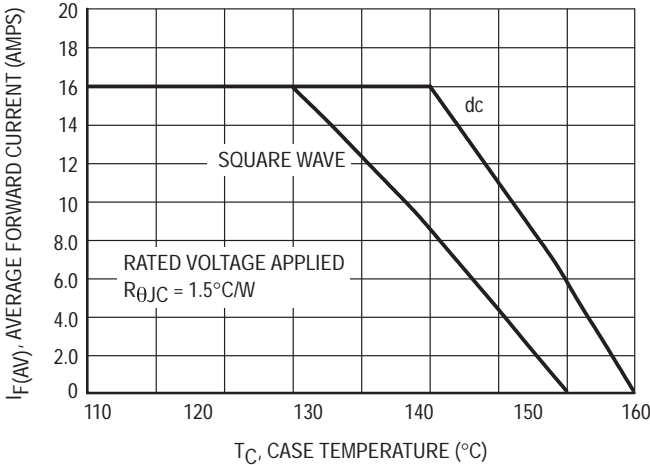


Figure 3. Current Derating, Case

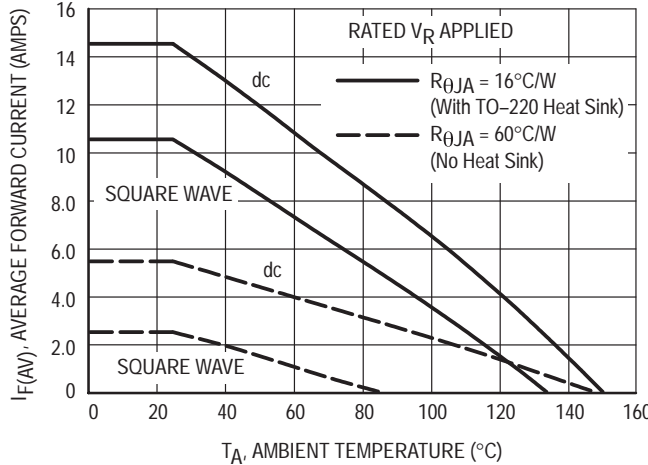


Figure 4. Current Derating, Ambient

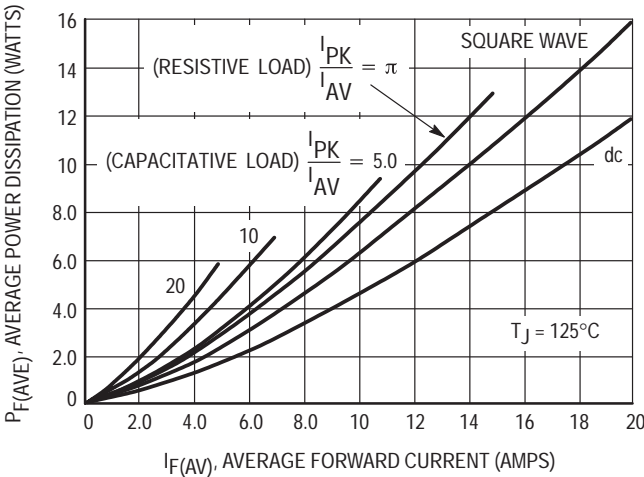


Figure 5. Forward Power Dissipation

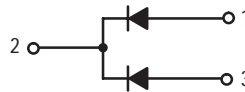
SWITCHMODE™ Schottky Power Rectifier

The SWITCHMODE Power Rectifier employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use as rectifiers in very low-voltage, high-frequency switching power supplies, free wheeling diodes and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Matched Dual Die Construction
- High Junction Temperature Capability
- High dv/dt Capability
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection
- Epoxy Meets UL94, VO at 1/8"
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369(1)

Mechanical Characteristics

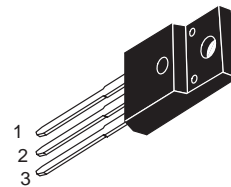
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B1545



MBRF1545CT

Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIER
15 AMPERES
45 VOLTS**



**CASE 221D-02
ISOLATED TO-220**

MAXIMUM RATINGS, PER LEG

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	45	Volts
Average Rectified Forward Current (Rated V_R), $T_C = 105^\circ\text{C}$ Total Device	$I_{F(AV)}$	7.5 15	Amps
Peak Repetitive Forward Current, $T_C = 105^\circ\text{C}$ (Rated V_R , Square Wave, 20 kHz) Per Diode	I_{FRM}	15	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz)	I_{RRM}	1.0	Amp
Operating Junction and Storage Temperature	T_J, T_{stg}	- 65 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10000	V/ μs
RMS Isolation Voltage (t = 1 second, R.H. \leq 30%, $T_A = 25^\circ\text{C}$) ⁽²⁾	Per Figure 3 Per Figure 4 ⁽¹⁾ Per Figure 5	V_{iso1} V_{iso2} V_{iso3}	4500 3500 1500 Volts

THERMAL CHARACTERISTICS, PER LEG

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	4.1	$^\circ\text{C}/\text{W}$
Lead Temperature for Soldering Purposes: 1/8" from Case for 5 seconds	T_L	260	$^\circ\text{C}$

(1) UL Recognized mounting method is per Figure 4.

(2) Proper strike and creepage distance must be provided.

Preferred devices are Motorola recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS, PER LEG

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (3) ($i_F = 15$ Amp, $T_C = 25^\circ\text{C}$) ($i_F = 15$ Amp, $T_C = 125^\circ\text{C}$) ($i_F = 7.5$ Amp, $T_C = 125^\circ\text{C}$)	v_F	0.84 0.72 0.57	Volts
Maximum Instantaneous Reverse Current (3) (Rated DC Voltage, $T_C = 25^\circ\text{C}$) (Rated DC Voltage, $T_C = 125^\circ\text{C}$)	i_R	0.1 15	mA

(3) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$

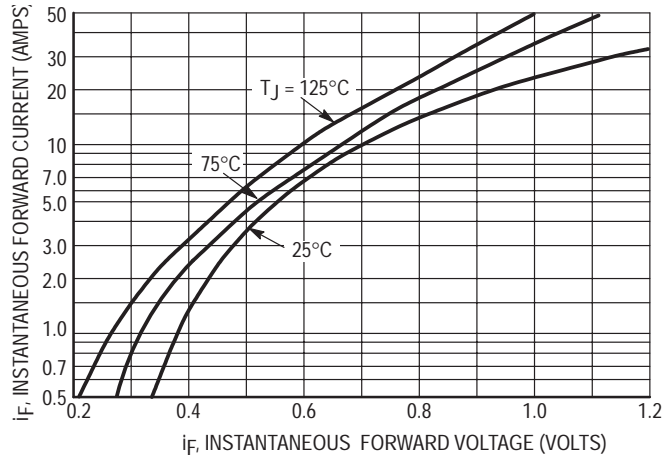


Figure 1. Typical Forward Voltage

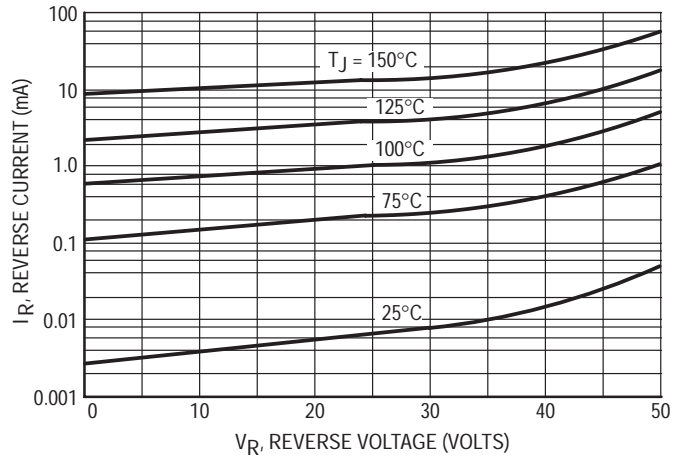


Figure 2. Typical Reverse Current

TEST CONDITIONS FOR ISOLATION TESTS*

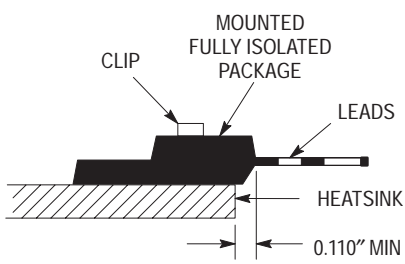


Figure 3. Clip Mounting Position for Isolation Test Number 1

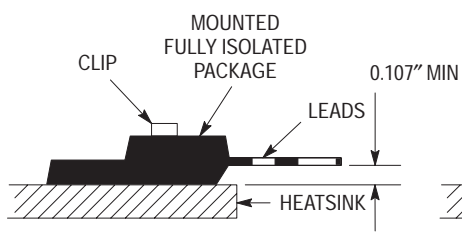


Figure 4. Clip Mounting Position for Isolation Test Number 2

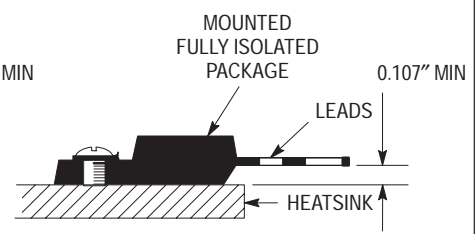
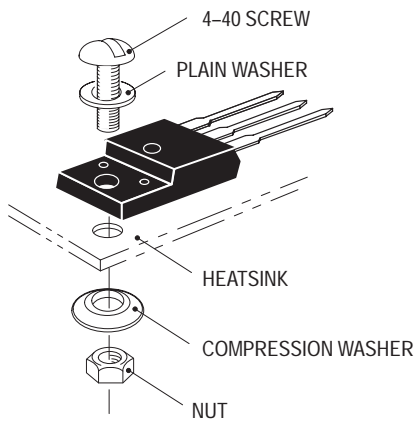


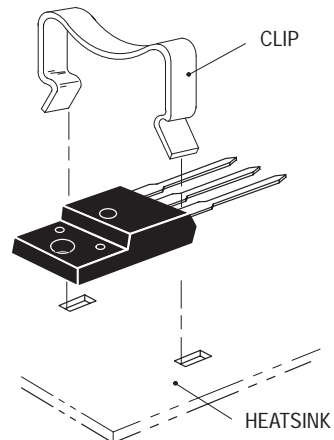
Figure 5. Screw Mounting Position for Isolation Test Number 3

* Measurement made between leads and heatsink with all leads shorted together.

MOUNTING INFORMATION**



6a. Screw-Mounted



6b. Clip-Mounted

Figure 6. Typical Mounting Techniques

Laboratory tests on a limited number of samples indicate, when using the screw and compression washer mounting technique, a screw torque of 6 to 8 in · lbs is sufficient to provide maximum power dissipation capability. The compression washer helps to maintain a constant pressure on the package over time and during large temperature excursions.

Destructive laboratory tests show that using a hex head 4-40 screw, without washers, and applying a torque in excess of 20 in · lbs will cause the plastic to crack around the mounting hole, resulting in a loss of isolation capability.

Additional tests on slotted 4-40 screws indicate that the screw slot fails between 15 to 20 in · lbs without adversely affecting the package. However, in order to positively ensure the package integrity of the fully isolated device, Motorola does not recommend exceeding 10 in · lbs of mounting torque under any mounting conditions.

**For more information about mounting power semiconductors see Application Note AN1040.

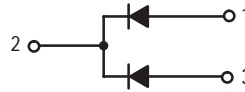
SWITCHMODE™ Schottky Power Rectifier

The SWITCHMODE Power Rectifier employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use as rectifiers in very low-voltage, high-frequency switching power supplies, free wheeling diodes and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Matched Dual Die Construction
- High Junction Temperature Capability
- High dv/dt Capability
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection
- Epoxy Meets UL94, VO at 1/8"
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369(1)

Mechanical Characteristics

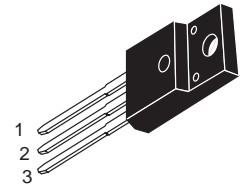
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B2045



MBRF2045CT

Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIER
20 AMPERES
45 VOLTS**



**CASE 221D-02
ISOLATED TO-220**

MAXIMUM RATINGS, PER LEG

Rating	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	45	Volts	
Average Rectified Forward Current (Rated V_R), $T_C = 135^\circ\text{C}$	$I_{F(AV)}$	10 20	Amps	
Peak Repetitive Forward Current Per Diode Leg (Rated V_R , Square Wave, 20 kHz), $T_C = 135^\circ\text{C}$	I_{FRM}	20	Amps	
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150	Amps	
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz)	I_{RRM}	1.0	Amp	
Operating Junction and Storage Temperature	T_J, T_{stg}	-65 to +150	$^\circ\text{C}$	
Voltage Rate of Change (Rated V_R)	dv/dt	10000	V/ μs	
RMS Isolation Voltage ($t = 1$ second, R.H. $\leq 30\%$, $T_A = 25^\circ\text{C}$)(2)	Per Figure 5 Per Figure 6(1) Per Figure 7	V_{iso1} V_{iso2} V_{iso3}	4500 3500 1500	Volts

THERMAL CHARACTERISTICS, PER LEG

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	4.0	$^\circ\text{C/W}$
Lead Temperature for Soldering Purposes: 1/8" from Case for 5 seconds	T_L	260	$^\circ\text{C}$

(1) UL Recognized mounting method is per Figure 6.

(2) Proper strike and creepage distance must be provided.

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

MBRF2045CT

ELECTRICAL CHARACTERISTICS, PER LEG

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (3) ($i_F = 20$ Amp, $T_C = 25^\circ\text{C}$) ($i_F = 20$ Amp, $T_C = 125^\circ\text{C}$) ($i_F = 10$ Amp, $T_C = 125^\circ\text{C}$)	v_F	0.84 0.72 0.57	Volts
Maximum Instantaneous Reverse Current (3) (Rated DC Voltage, $T_C = 25^\circ\text{C}$) (Rated DC Voltage, $T_C = 125^\circ\text{C}$)	i_R	0.1 15	mA

(3) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$

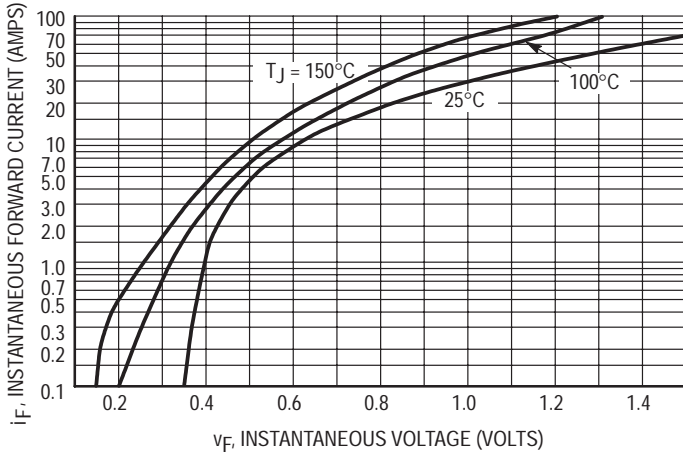


Figure 1. Maximum Forward Voltage

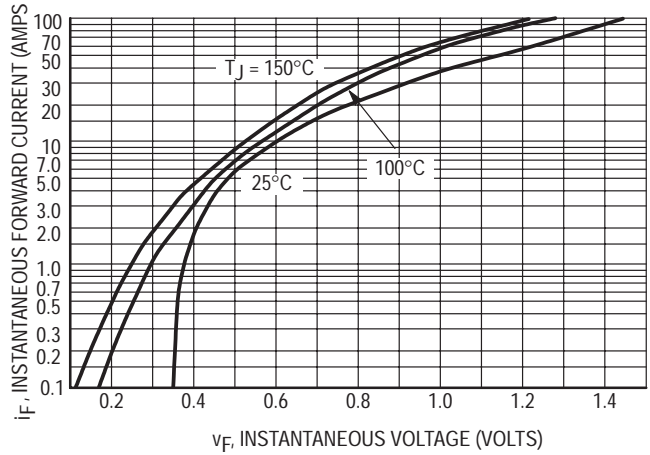


Figure 2. Typical Forward Voltage

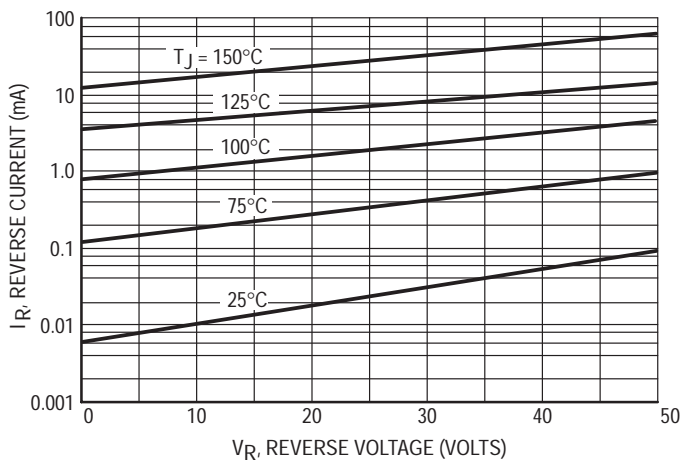


Figure 3. Maximum Reverse Current

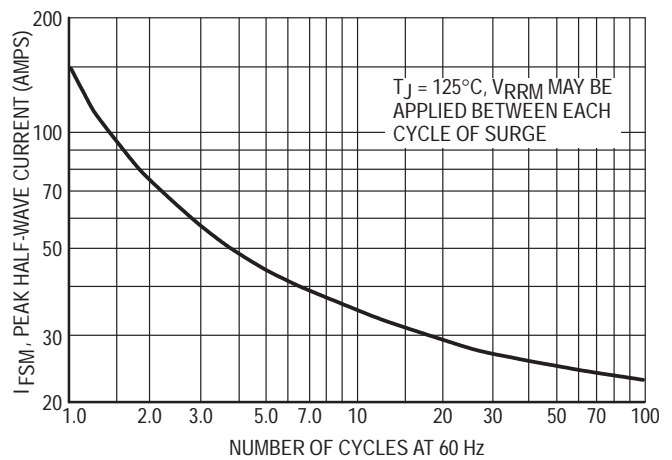
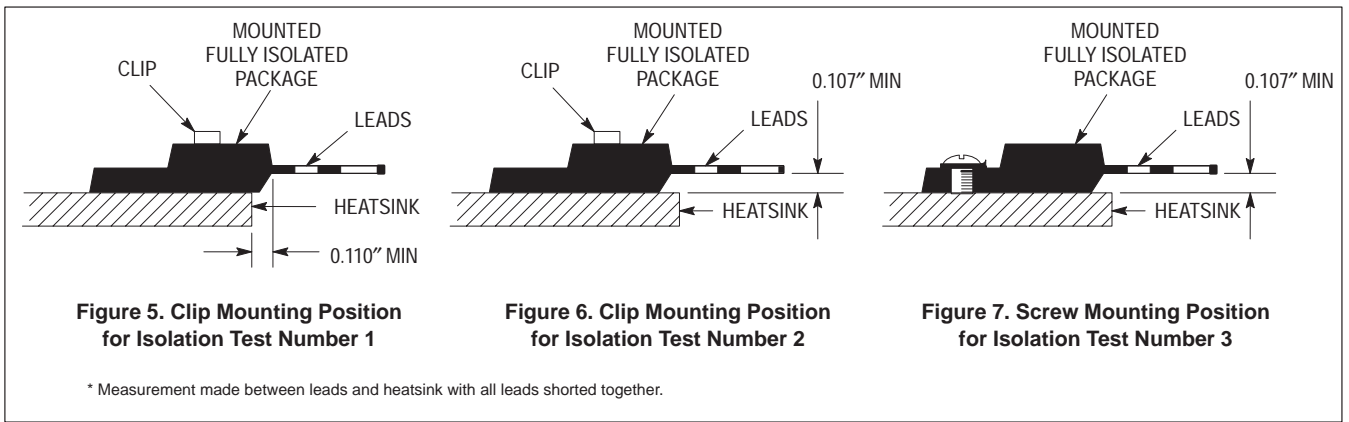
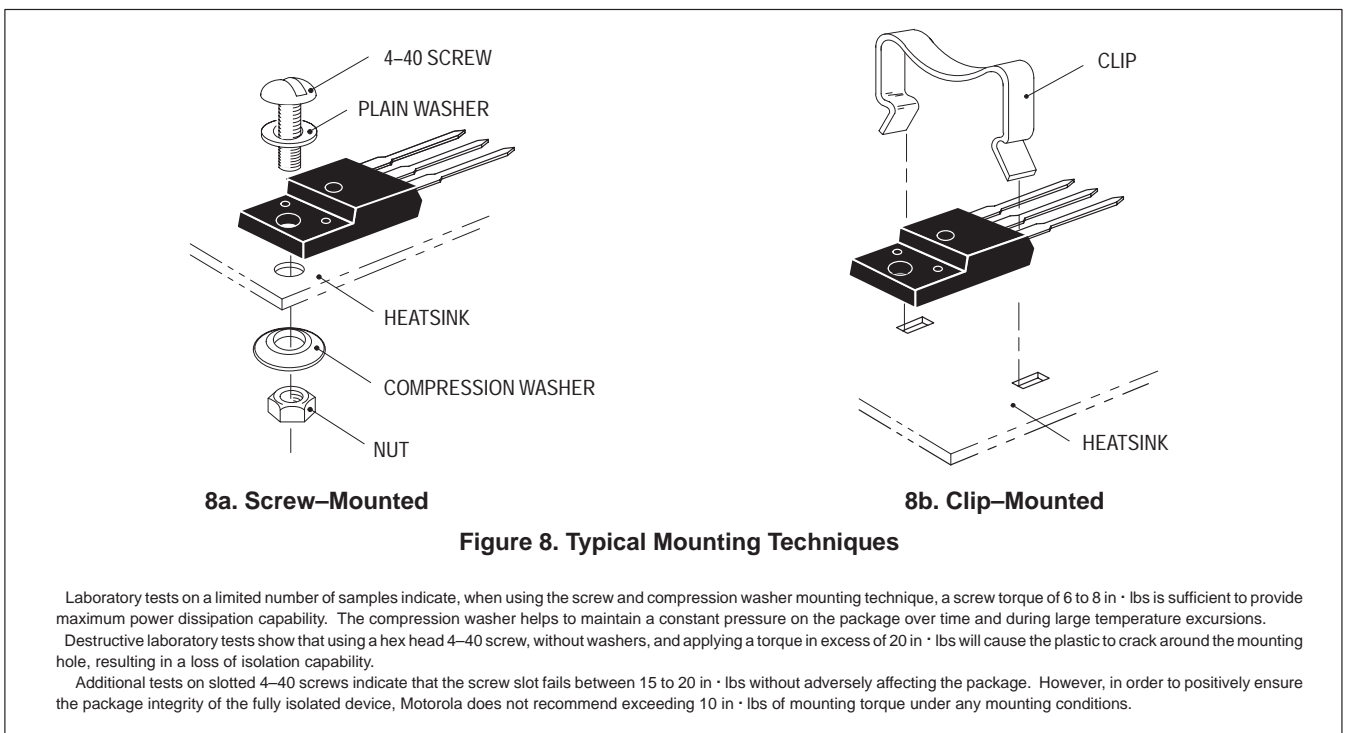


Figure 4. Maximum Surge Capability

TEST CONDITIONS FOR ISOLATION TESTS*



MOUNTING INFORMATION**



**For more information about mounting power semiconductors see Application Note AN1040.

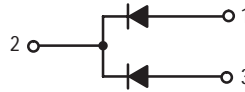
SWITCHMODE™ Schottky Power Rectifier

The SWITCHMODE Power Rectifier employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use as rectifiers in very low-voltage, high-frequency switching power supplies, free wheeling diodes and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Matched Dual Die Construction
- High Junction Temperature Capability
- High dv/dt Capability
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection
- Epoxy Meets UL94, V_O at 1/8"
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369(1)

Mechanical Characteristics

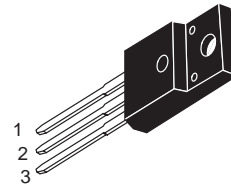
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B2060



MBRF2060CT

Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIER
20 AMPERES
60 VOLTS**



**CASE 221D-02
ISOLATED TO-220**

MAXIMUM RATINGS, PER LEG

Rating	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	60	Volts	
Average Rectified Forward Current (Rated V_R , $T_C = 133^\circ\text{C}$)	$I_{F(AV)}$	10 20	Amps	
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz), $T_C = 133^\circ\text{C}$	I_{FRM}	20	Amps	
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150	Amps	
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz)	I_{RRM}	0.5	Amp	
Operating Junction and Storage Temperature	T_J, T_{stg}	- 65 to +150	$^\circ\text{C}$	
Voltage Rate of Change (Rated V_R)	dv/dt	10000	V/ μs	
RMS Isolation Voltage (t = 1.0 second, R.H. \leq 30%, $T_A = 25^\circ\text{C}$) ⁽²⁾	Per Figure 3 Per Figure 4(1) Per Figure 5	V_{iso1} V_{iso2} V_{iso3}	4500 3500 1500	Volts

THERMAL CHARACTERISTICS, PER LEG

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	4.0	$^\circ\text{C}/\text{W}$
Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	T_L	260	$^\circ\text{C}$

(1) UL Recognized mounting method is per Figure 4.

(2) Proper strike and creepage distance must be provided.

Preferred devices are Motorola recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS, PER LEG

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (3) ($i_F = 10$ Amp, $T_C = 25^\circ\text{C}$) ($i_F = 10$ Amp, $T_C = 125^\circ\text{C}$) ($i_F = 20$ Amp, $T_C = 25^\circ\text{C}$) ($i_F = 20$ Amp, $T_C = 125^\circ\text{C}$)	v_F	0.85 0.75 0.95 0.85	Volts
Maximum Instantaneous Reverse Current (3) (Rated DC Voltage, $T_C = 25^\circ\text{C}$) (Rated DC Voltage, $T_C = 125^\circ\text{C}$)	i_R	0.15 150	mA

(3) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$

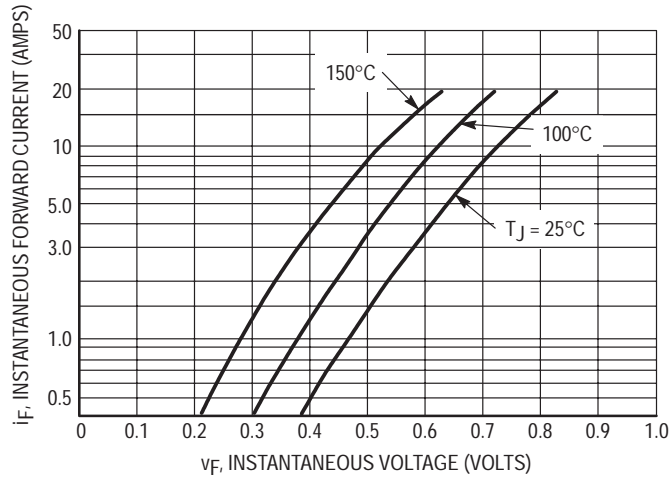


Figure 1. Typical Forward Voltage Per Diode

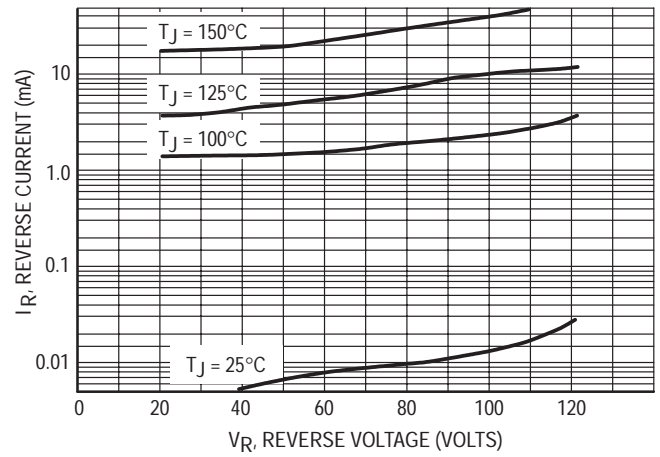


Figure 2. Typical Reverse Current Per Diode

TEST CONDITIONS FOR ISOLATION TESTS*

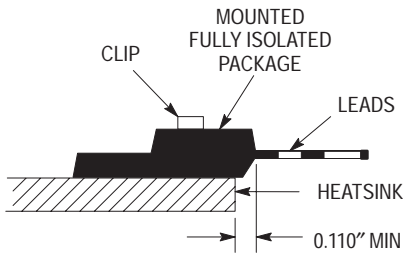


Figure 3. Clip Mounting Position for Isolation Test Number 1

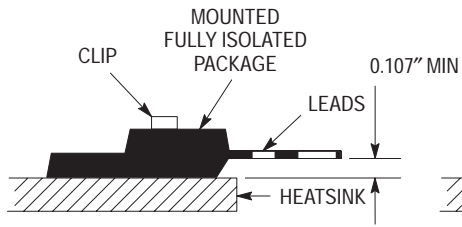


Figure 4. Clip Mounting Position for Isolation Test Number 2

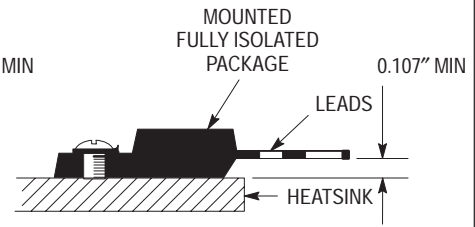
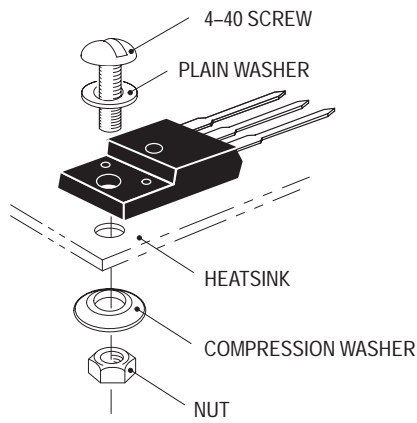


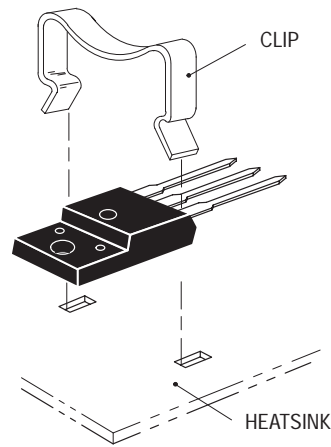
Figure 5. Screw Mounting Position for Isolation Test Number 3

* Measurement made between leads and heatsink with all leads shorted together.

MOUNTING INFORMATION**



6a. Screw-Mounted



6b. Clip-Mounted

Figure 6. Typical Mounting Techniques

Laboratory tests on a limited number of samples indicate, when using the screw and compression washer mounting technique, a screw torque of 6 to 8 in · lbs is sufficient to provide maximum power dissipation capability. The compression washer helps to maintain a constant pressure on the package over time and during large temperature excursions.

Destructive laboratory tests show that using a hex head 4-40 screw, without washers, and applying a torque in excess of 20 in · lbs will cause the plastic to crack around the mounting hole, resulting in a loss of isolation capability.

Additional tests on slotted 4-40 screws indicate that the screw slot fails between 15 to 20 in · lbs without adversely affecting the package. However, in order to positively ensure the package integrity of the fully isolated device, Motorola does not recommend exceeding 10 in · lbs of mounting torque under any mounting conditions.

**For more information about mounting power semiconductors see Application Note AN1040.

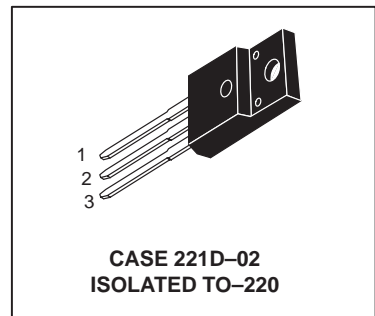
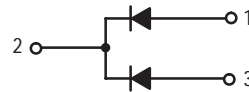
SWITCHMODE™ Schottky Power Rectifier

The SWITCHMODE Power Rectifier employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use as rectifiers in very low-voltage, high-frequency switching power supplies, free wheeling diodes and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Matched Dual Die Construction
- High Junction Temperature Capability
- High dv/dt Capability
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection
- Epoxy Meets UL94, V_O at 1/8"
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369(1)

Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B20100



MAXIMUM RATINGS, PER LEG

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	100	Volts
Average Rectified Forward Current (Rated V_R), $T_C = 133^\circ\text{C}$	$I_{F(AV)}$	10 20	Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz), $T_C = 133^\circ\text{C}$	I_{FRM}	20	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz)	I_{RRM}	0.5	Amp
Operating Junction and Storage Temperature	T_J, T_{stg}	-65 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10000	V/ μs
RMS Isolation Voltage (t = 1.0 second, R.H. \leq 30%, $T_A = 25^\circ\text{C}$)(2)	V_{iso1} V_{iso2} V_{iso3}	4500 3500 1500	Volts

THERMAL CHARACTERISTICS, PER LEG

Maximum Thermal Resistance — Junction to Case	$R_{\theta JC}$	3.5	$^\circ\text{C/W}$
Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	T_L	260	$^\circ\text{C}$

(1) UL Recognized mounting method is per Figure 4.
(2) Proper strike and creepage distance must be provided.

Preferred devices are Motorola recommended choices for future use and best overall value.

MBRF20100CT

ELECTRICAL CHARACTERISTICS, PER LEG

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (3) ($i_F = 10$ Amp, $T_C = 25^\circ\text{C}$) ($i_F = 10$ Amp, $T_C = 125^\circ\text{C}$) ($i_F = 20$ Amp, $T_C = 25^\circ\text{C}$) ($i_F = 20$ Amp, $T_C = 125^\circ\text{C}$)	v_F	0.85 0.75 0.95 0.85	Volts
Maximum Instantaneous Reverse Current (3) (Rated DC Voltage, $T_C = 25^\circ\text{C}$) (Rated DC Voltage, $T_C = 125^\circ\text{C}$)	i_R	0.15 150	mA

(3) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$

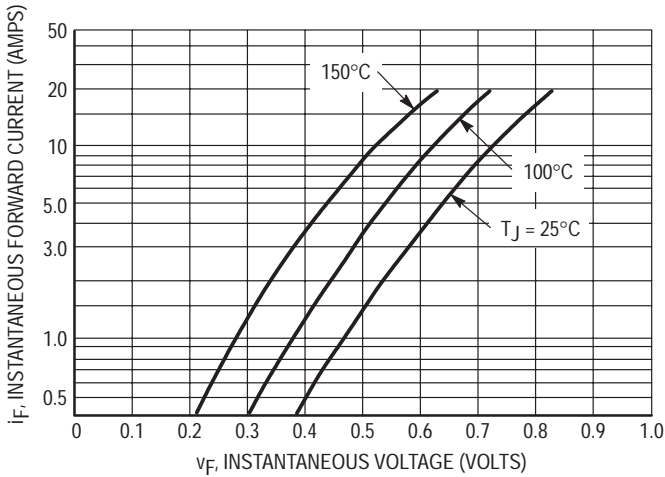


Figure 1. Typical Forward Voltage Per Diode

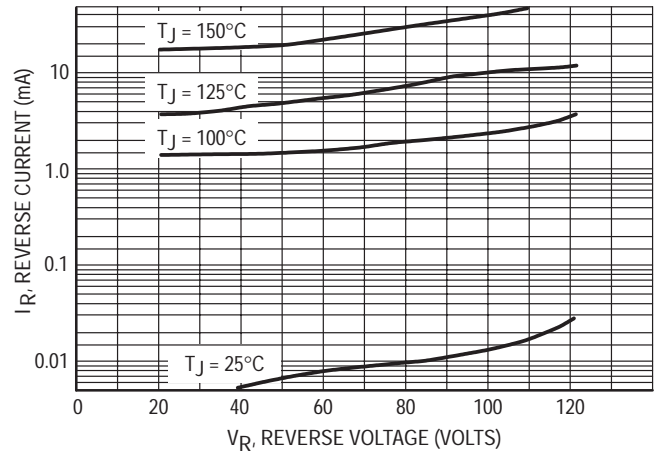
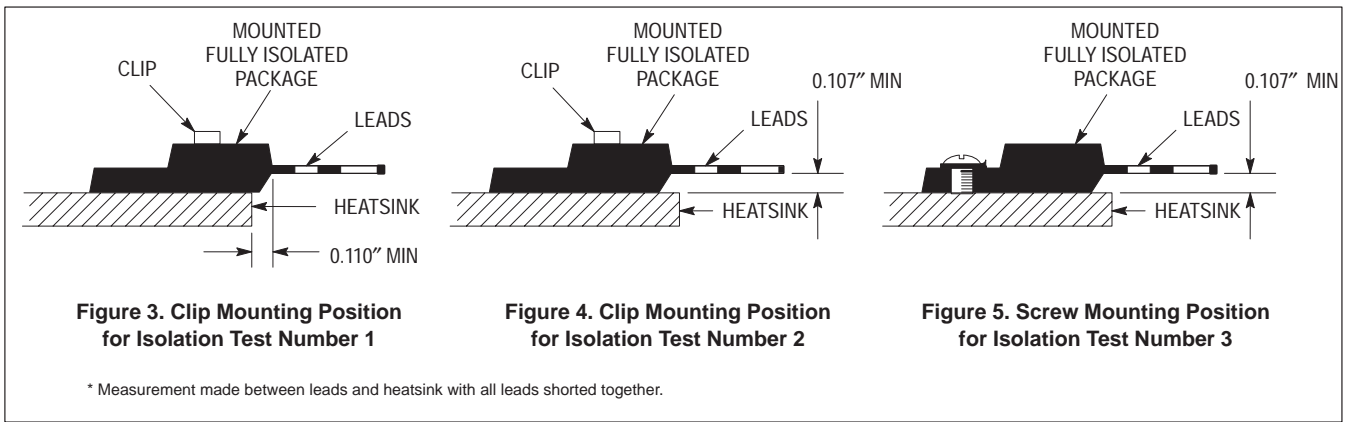
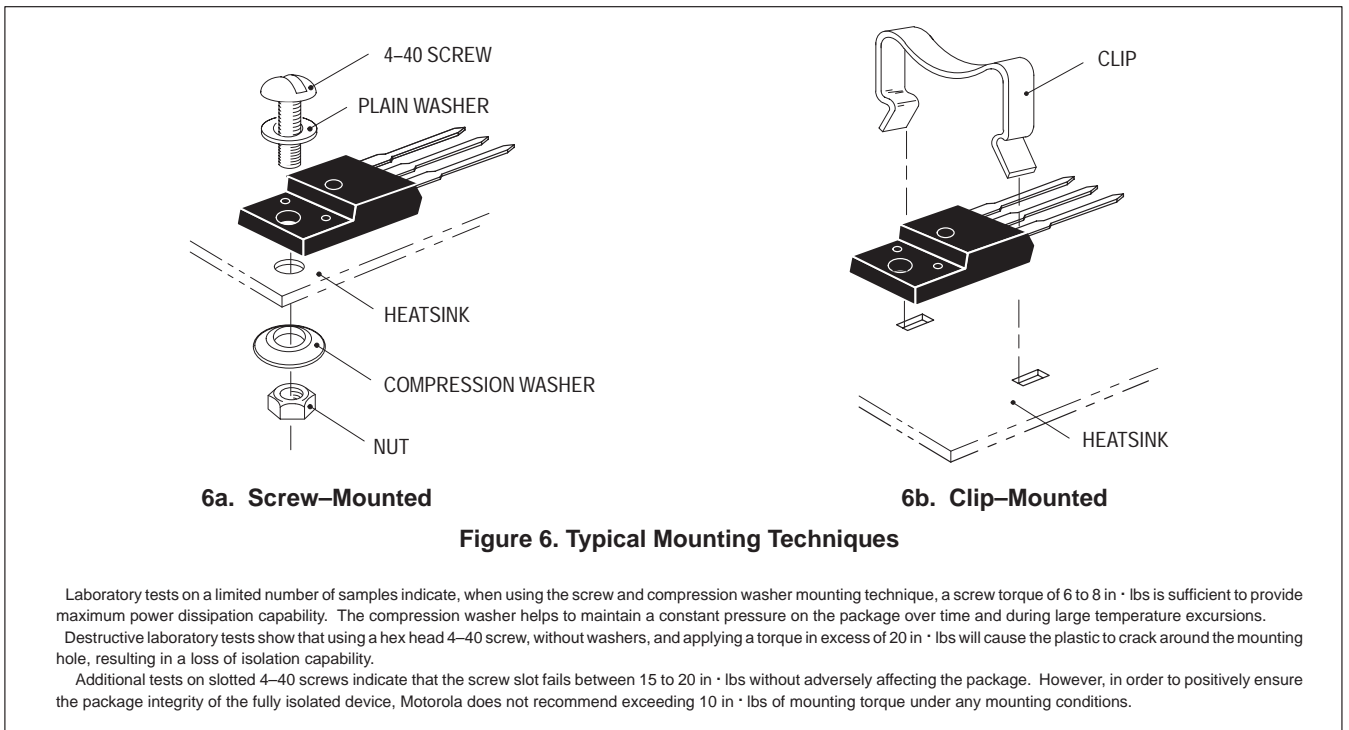


Figure 2. Typical Reverse Current Per Diode

TEST CONDITIONS FOR ISOLATION TESTS*



MOUNTING INFORMATION**



**For more information about mounting power semiconductors see Application Note AN1040.

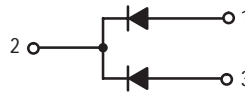
SWITCHMODE™ Schottky Power Rectifier

The SWITCHMODE Power Rectifier employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use as rectifiers in very low-voltage, high-frequency switching power supplies, free wheeling diodes and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Matched Dual Die Construction
- High Junction Temperature Capability
- High dv/dt Capability
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection
- Epoxy Meets UL94, V₀ at 1/8"
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369

Mechanical Characteristics

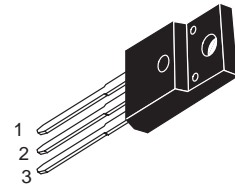
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B20200



MBRF20200CT

Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIER
20 AMPERES
150 and 200 VOLTS**



**CASE 221D-02
ISOLATED TO-220**

MAXIMUM RATINGS, PER LEG

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	200	Volts
Average Rectified Forward Current (Rated V_R) $T_C = 125^\circ\text{C}$	$I_{F(AV)}$	10 20	Amps
Peak Repetitive Forward Current, Per Leg (Rated V_R , Square Wave, 20 kHz) $T_C = 90^\circ\text{C}$	I_{FRM}	20	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz)	I_{RRM}	1.0	Amp
Operating Junction Temperature and Storage Temperature	T_J, T_{stg}	-65 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10,000	V/ μs

THERMAL CHARACTERISTICS, PER LEG

Thermal Resistance — Junction to Case	$R_{\theta JC}$	3.5	$^\circ\text{C/W}$
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Preferred devices are Motorola recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS, PER LEG

Rating	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (1) ($i_F = 10$ Amp, $T_C = 25^\circ\text{C}$) ($i_F = 10$ Amp, $T_C = 125^\circ\text{C}$) ($i_F = 20$ Amp, $T_C = 25^\circ\text{C}$) ($i_F = 20$ Amp, $T_C = 125^\circ\text{C}$)	v_F	0.9 0.8 1.0 0.9	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 25^\circ\text{C}$) (Rated dc Voltage, $T_C = 125^\circ\text{C}$)	i_R	1.0 50	mA

DYNAMIC CHARACTERISTICS, PER LEG

Capacitance ($V_R = -5.0$ V, $T_C = 25^\circ\text{C}$, Freq. = 1.0 MHz)	C_T	500	pF
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(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$

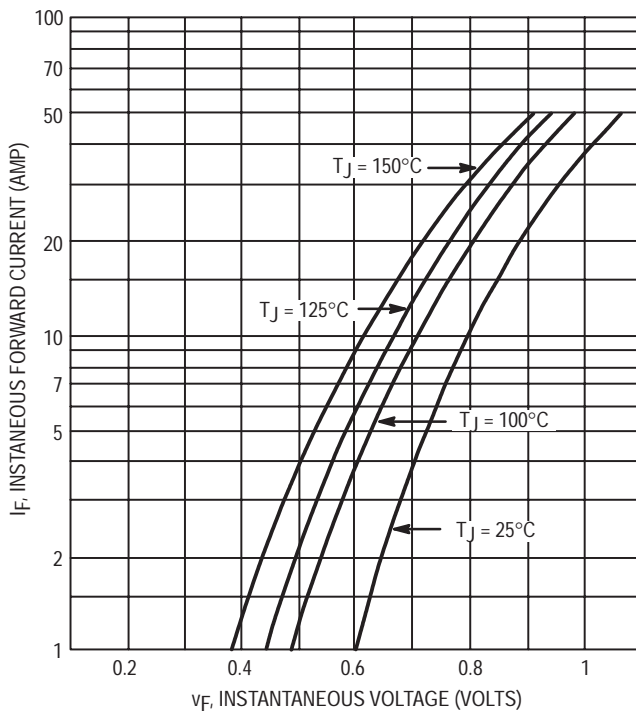


Figure 1. Typical Forward Voltage (Per Leg)

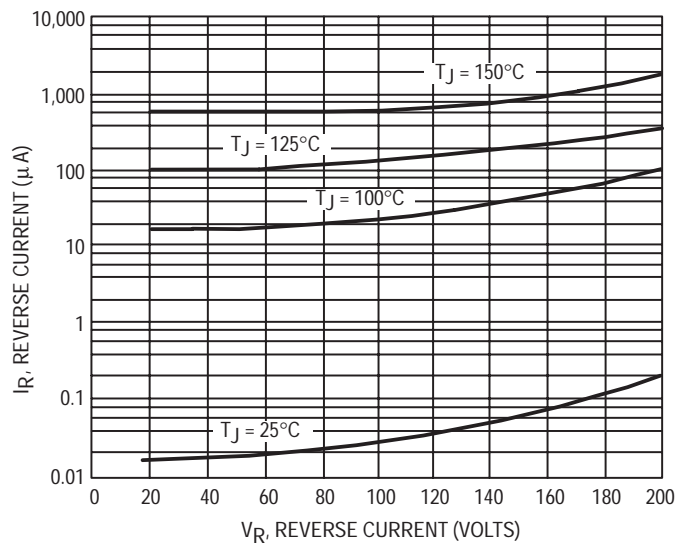
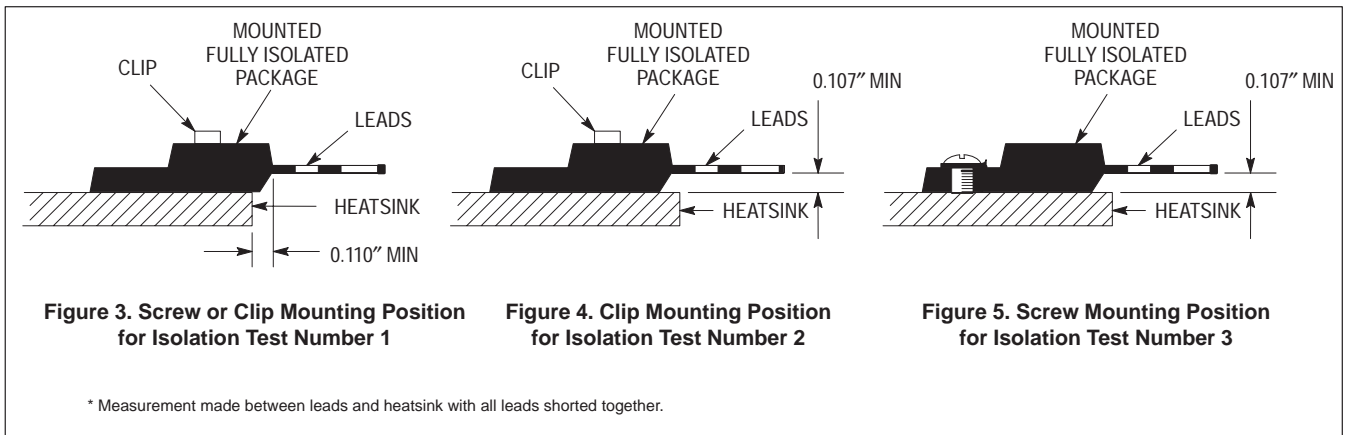
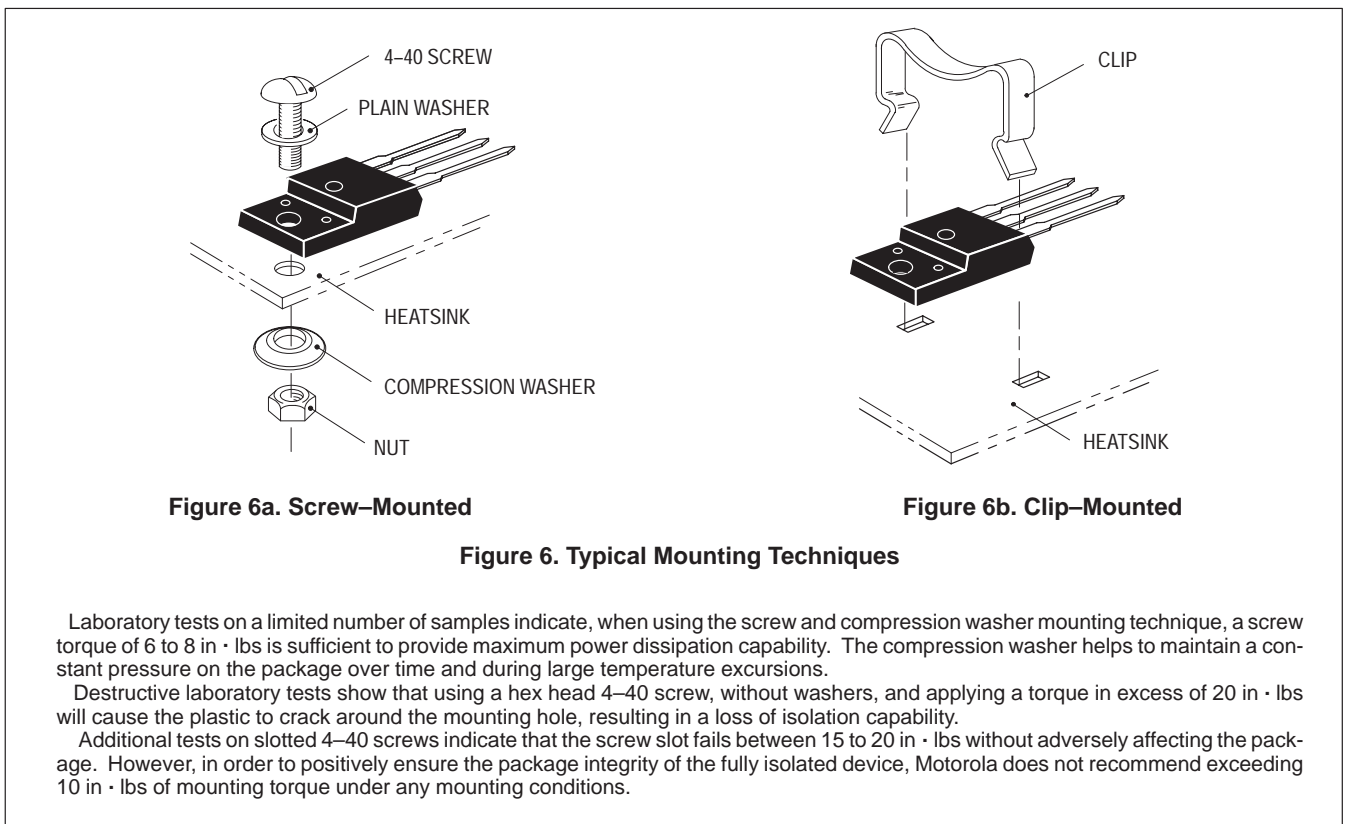


Figure 2. Typical Reverse Current (Per Leg)

TEST CONDITIONS FOR ISOLATION TESTS*



MOUNTING INFORMATION**



**For more information about mounting power semiconductors see Application Note AN1040.

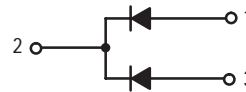
SWITCHMODE™ Schottky Power Rectifier

The SWITCHMODE Power Rectifier employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use as rectifiers in very low-voltage, high-frequency switching power supplies, free wheeling diodes and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Matched Dual Die Construction
- High Junction Temperature Capability
- High dv/dt Capability
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection
- Epoxy Meets UL94, V_O at 1/8"
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369(1)

Mechanical Characteristics

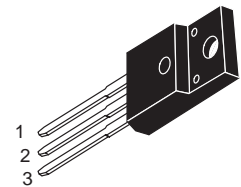
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B2545



MBRF2545CT

Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIER
25 AMPERES
45 VOLTS**



**CASE 221D-02
ISOLATED TO-220**

MAXIMUM RATINGS, PER LEG

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	45	Volts
Average Rectified Forward Current (Rated V_R), $T_C = 125^\circ\text{C}$ Total Device	$I_{F(AV)}$	12.5 25	Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz), $T_C = 125^\circ\text{C}$	I_{FRM}	25	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz)	I_{RRM}	1.0	Amp
Operating Junction and Storage Temperature	T_J, T_{stg}	-65 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10000	V/ μs
RMS Isolation Voltage (t = 1.0 second, R.H. \leq 30%, $T_A = 25^\circ\text{C}$)(2)	Per Figure 3 Per Figure 4(1) Per Figure 5 V_{iso1} V_{iso2} V_{iso3}	4500 3500 1500	Volts

THERMAL CHARACTERISTICS, PER LEG

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.5	$^\circ\text{C}/\text{W}$
Maximum Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	T_L	260	$^\circ\text{C}$

(1) UL Recognized mounting method is per Figure 4.

(2) Proper strike and creepage distance must be provided.

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

MBRF2545CT

ELECTRICAL CHARACTERISTICS, PER LEG

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (3) ($i_F = 12.5$ Amps, $T_C = 25^\circ\text{C}$) ($i_F = 12.5$ Amps, $T_C = 125^\circ\text{C}$)	v_F	0.7 0.62	Volts
Maximum Instantaneous Reverse Current (3) (Rated DC Voltage, $T_C = 25^\circ\text{C}$) (Rated DC Voltage, $T_C = 125^\circ\text{C}$)	i_R	0.2 40	mA

(3) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$

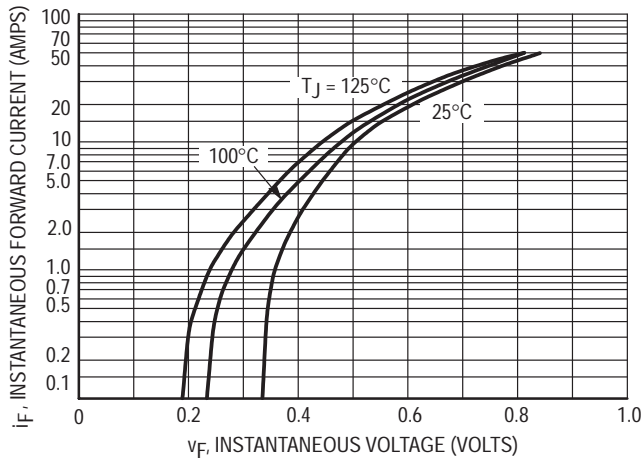


Figure 1. Typical Forward Voltage, Per Leg

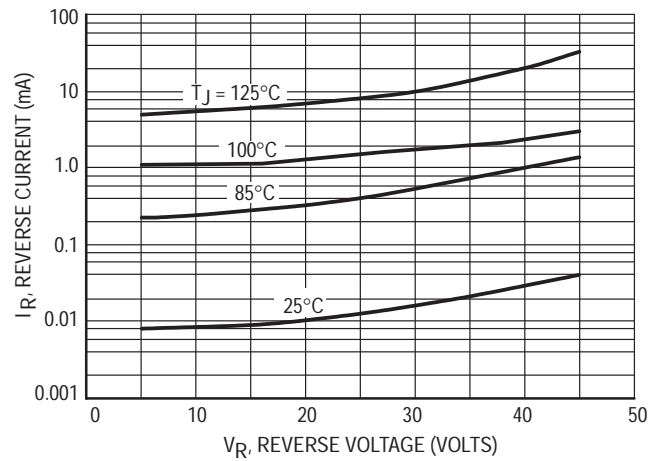
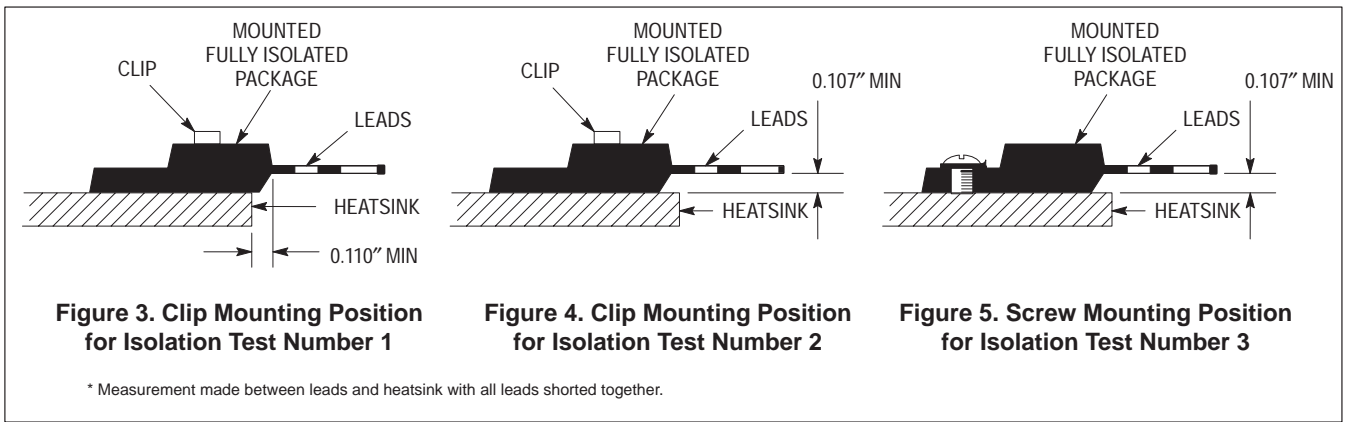
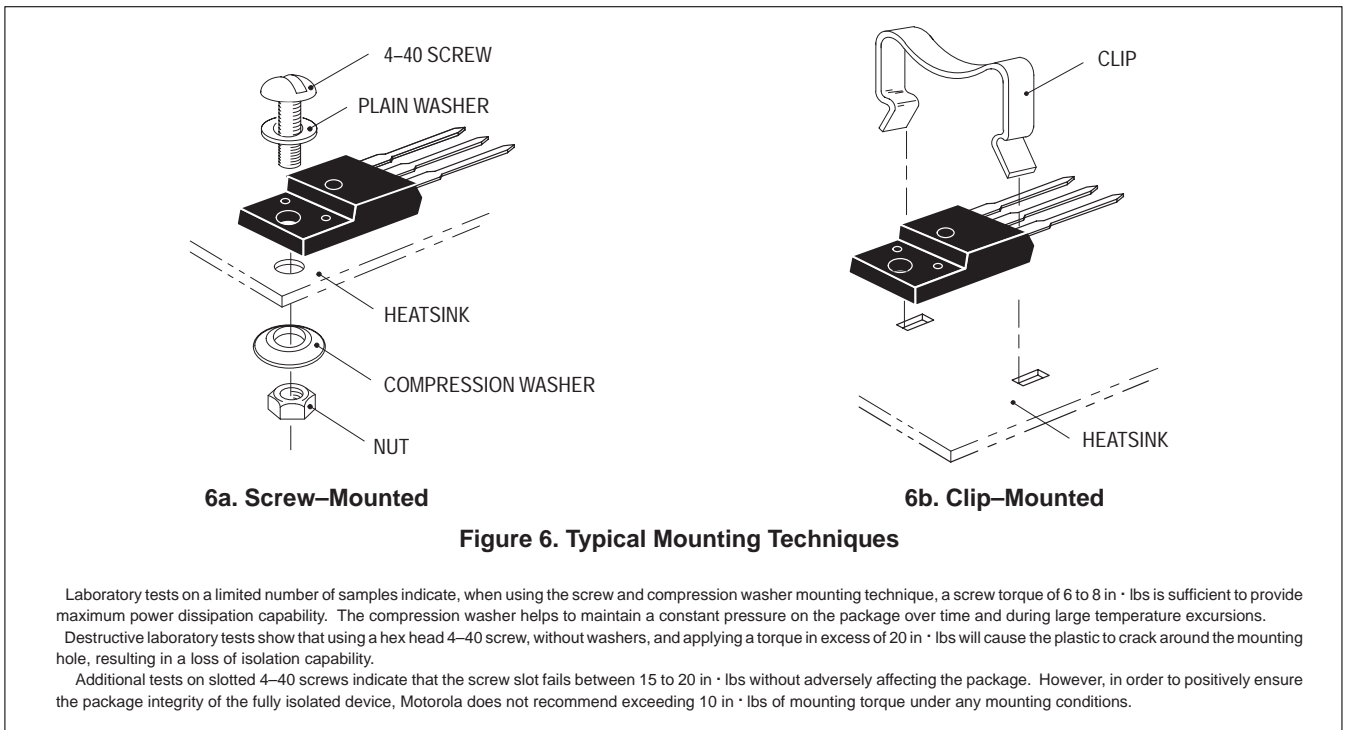


Figure 2. Typical Reverse Current, Per Leg

TEST CONDITIONS FOR ISOLATION TESTS*



MOUNTING INFORMATION**



**For more information about mounting power semiconductors see Application Note AN1040.

SWITCHMODE™ Schottky Power Rectifier

The SWITCHMODE Power Rectifier employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use as rectifiers in very low-voltage, high-frequency switching power supplies, free wheeling diodes and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- High Junction Temperature Capability
- High dv/dt Capability
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection
- Epoxy Meets UL94, VO at 1/8"
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369(1)

Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B745

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	45	Volts
Average Rectified Forward Current (Rated V_R), $T_C = 105^\circ\text{C}$	$I_{F(AV)}$	7.5	Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz), $T_C = 105^\circ\text{C}$	I_{FRM}	15	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz)	I_{RRM}	1.0	Amp
Operating Junction and Storage Temperature	T_J, T_{stg}	- 65 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10000	V/ μs
RMS Isolation Voltage (t = 1 second, R.H. \leq 30%, $T_A = 25^\circ\text{C}$)(2)	Per Figure 3 Per Figure 4(1) Per Figure 5	V_{iso1} 4500 V_{iso2} 3500 V_{iso3} 1500	Volts

THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	4.2	$^\circ\text{C}/\text{W}$
Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	T_L	260	$^\circ\text{C}$

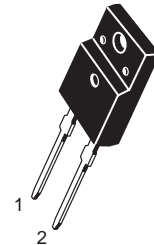
- (1) UL Recognized mounting method is per Figure 4.
(2) Proper strike and creepage distance must be provided.

Preferred devices are Motorola recommended choices for future use and best overall value.

MBRF745

Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIER
7.5 AMPERES
45 VOLTS**



**CASE 221E-01
ISOLATED TO-220**

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (3) ($i_F = 15$ Amp, $T_C = 25^\circ\text{C}$) ($i_F = 15$ Amp, $T_C = 125^\circ\text{C}$) ($i_F = 7.5$ Amp, $T_C = 125^\circ\text{C}$)	v_F	0.84 0.72 0.57	Volts
Maximum Instantaneous Reverse Current (3) (Rated DC Voltage, $T_C = 25^\circ\text{C}$) (Rated DC Voltage, $T_C = 125^\circ\text{C}$)	i_R	0.1 15	mA

(3) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$

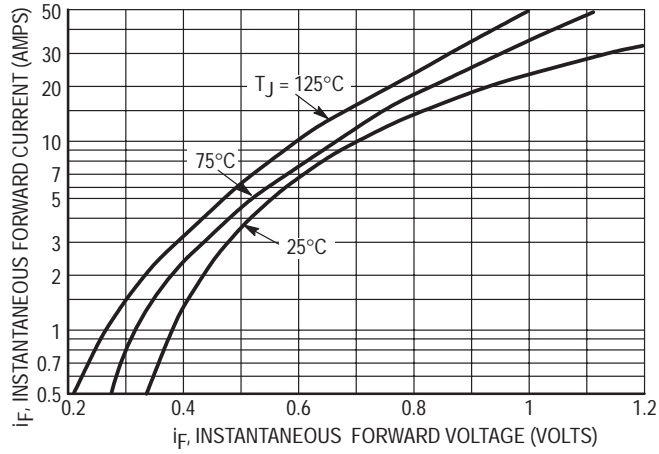


Figure 1. Typical Forward Voltage

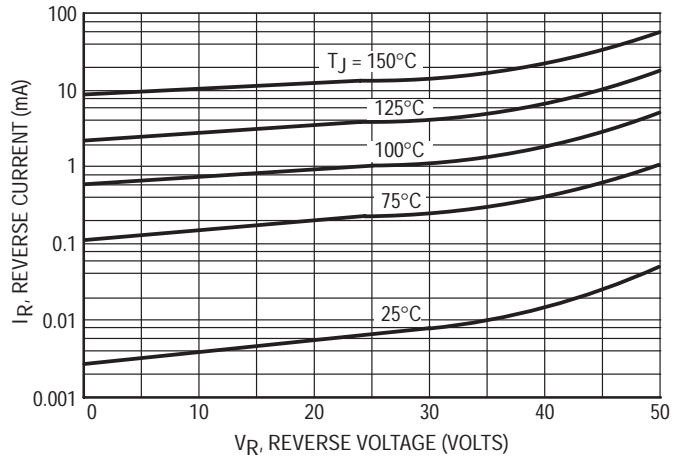


Figure 2. Typical Reverse Current

TEST CONDITIONS FOR ISOLATION TESTS*

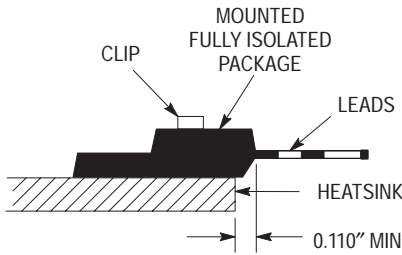


Figure 3. Clip Mounting Position for Isolation Test Number 1

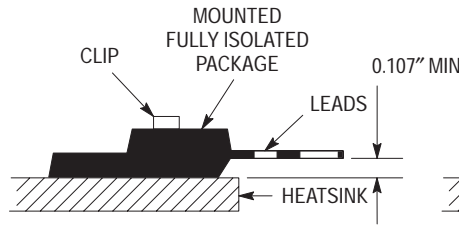


Figure 4. Clip Mounting Position for Isolation Test Number 2

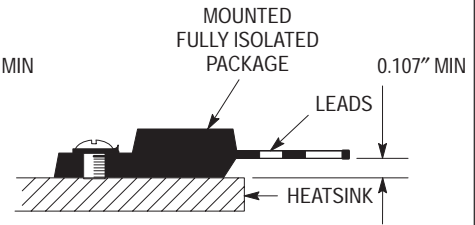
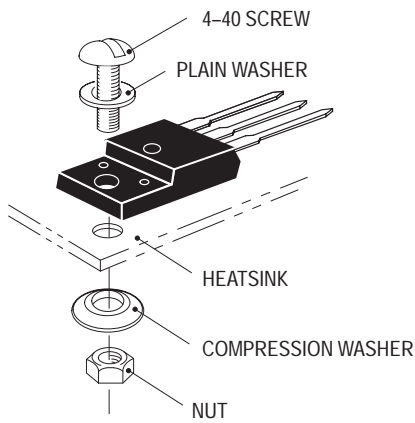


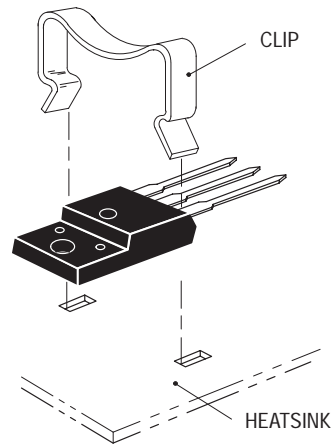
Figure 5. Screw Mounting Position for Isolation Test Number 3

* Measurement made between leads and heatsink with all leads shorted together.

MOUNTING INFORMATION**



6a. Screw-Mounted



6b. Clip-Mounted

Figure 6. Typical Mounting Techniques

Laboratory tests on a limited number of samples indicate, when using the screw and compression washer mounting technique, a screw torque of 6 to 8 in · lbs is sufficient to provide maximum power dissipation capability. The compression washer helps to maintain a constant pressure on the package over time and during large temperature excursions.

Destructive laboratory tests show that using a hex head 4-40 screw, without washers, and applying a torque in excess of 20 in · lbs will cause the plastic to crack around the mounting hole, resulting in a loss of isolation capability.

Additional tests on slotted 4-40 screws indicate that the screw slot fails between 15 to 20 in · lbs without adversely affecting the package. However, in order to positively ensure the package integrity of the fully isolated device, Motorola does not recommend exceeding 10 in · lbs of mounting torque under any mounting conditions.

**For more information about mounting power semiconductors see Application Note AN1040.

SWITCHMODE™ Schottky Power Rectifier

The SWITCHMODE Power Rectifier employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use as rectifiers in very low-voltage, high-frequency switching power supplies, free wheeling diodes and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- High Junction Temperature Capability
- High dv/dt Capability
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection
- Epoxy Meets UL94, VO at 1/8"
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369(1)

Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B1045

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	45	Volts
Average Rectified Forward Current (Rated V_R), $T_C = 135^\circ\text{C}$	$I_{F(AV)}$	10	Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz), $T_C = 135^\circ\text{C}$	I_{FRM}	20	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz) Figure 6	I_{RRM}	1.0	Amp
Operating Junction and Storage Temperature	T_J, T_{stg}	- 65 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10000	V/ μs
RMS Isolation Voltage (t = 1 second, R.H. \leq 30%, $T_A = 25^\circ\text{C}$)(2)	Per Figure 8 Per Figure 9(1) Per Figure 10	V_{iso1} V_{iso2} V_{iso3}	4500 3500 1500 Volts

THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	4.0	$^\circ\text{C}/\text{W}$
Lead Temperature for Soldering Purposes: 1/8" from Case for 5 seconds	T_L	260	$^\circ\text{C}$

- (1) UL Recognized mounting method is per Figure 9.
(2) Proper strike and creepage distance must be provided.

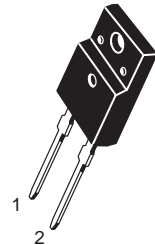
Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

MBRF1045

Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIER
10 AMPERES
45 VOLTS**



**CASE 221E-01
ISOLATED TO-220**

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (3) ($i_F = 20$ Amp, $T_C = 25^\circ\text{C}$) ($i_F = 20$ Amp, $T_C = 125^\circ\text{C}$) ($i_F = 10$ Amp, $T_C = 125^\circ\text{C}$)	v_F	0.84 0.72 0.57	Volts
Maximum Instantaneous Reverse Current (3) (Rated DC Voltage, $T_C = 25^\circ\text{C}$) (Rated DC Voltage, $T_C = 125^\circ\text{C}$)	i_R	0.1 15	mA

(3) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$

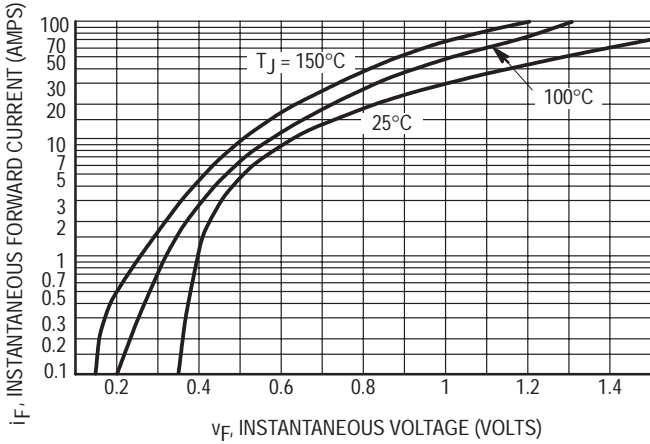


Figure 1. Maximum Forward Voltage

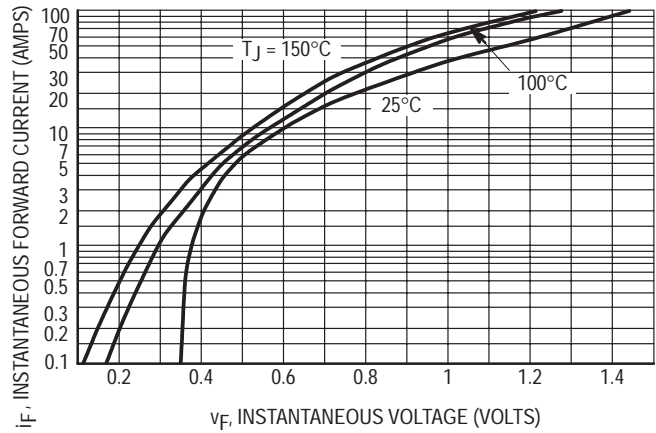


Figure 2. Typical Forward Voltage

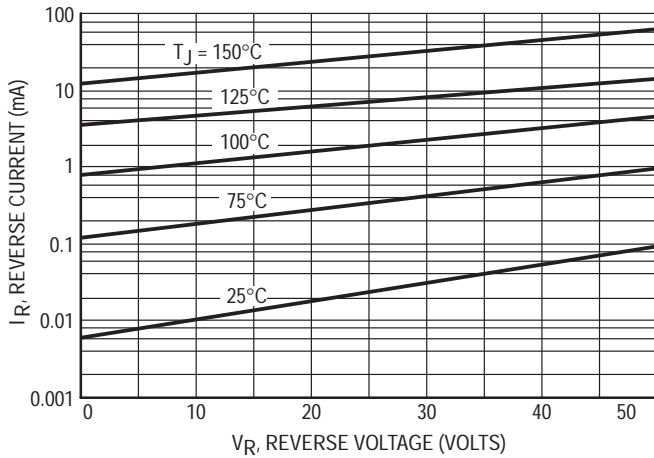


Figure 3. Maximum Reverse Current

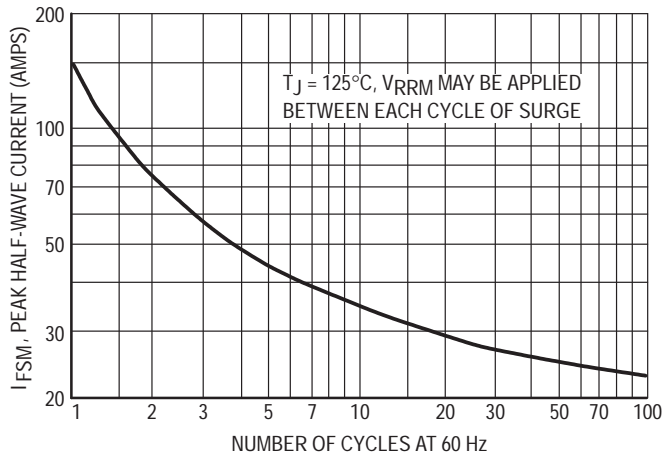


Figure 4. Maximum Surge Capability

HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 5.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 percent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

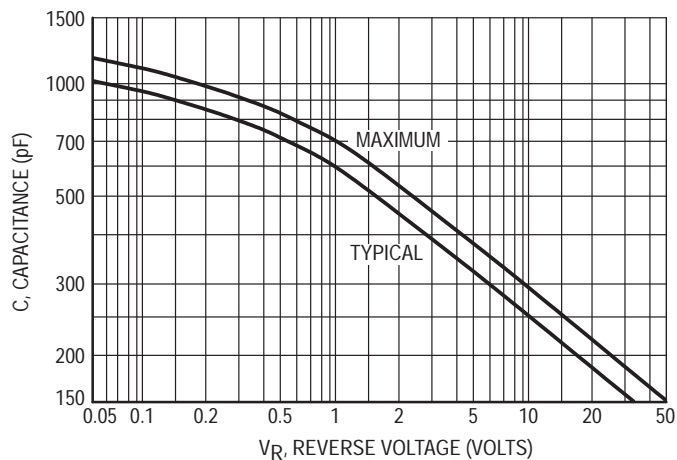


Figure 5. Capacitance

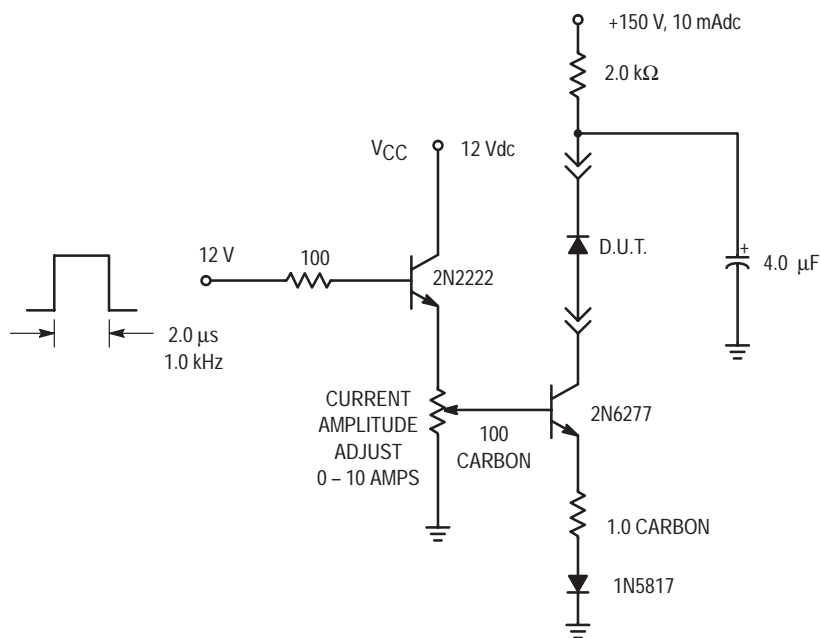


Figure 6. Test Circuit for dv/dt and Reverse Surge Current

TEST CONDITIONS FOR ISOLATION TESTS*

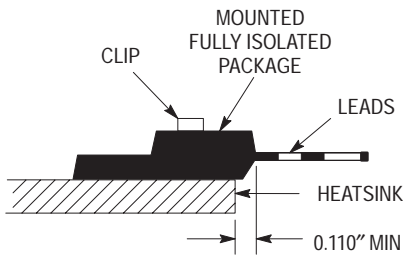


Figure 7. Clip Mounting Position for Isolation Test Number 1

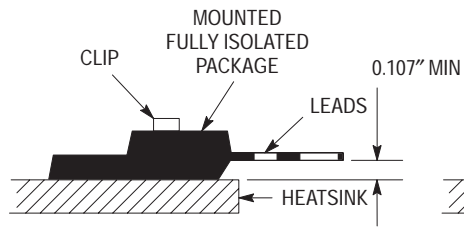


Figure 8. Clip Mounting Position for Isolation Test Number 2

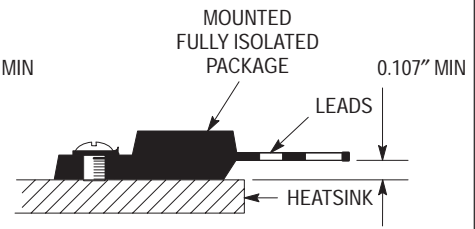
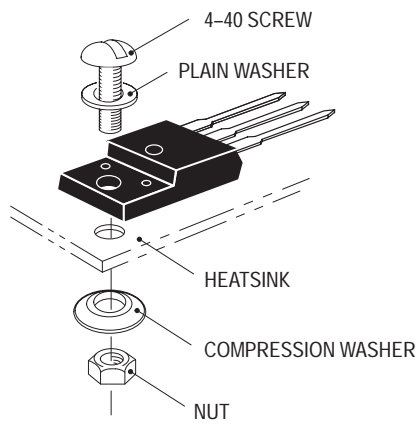


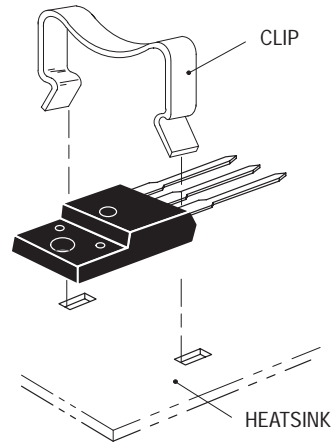
Figure 9. Screw Mounting Position for Isolation Test Number 3

* Measurement made between leads and heatsink with all leads shorted together.

MOUNTING INFORMATION**



10a. Screw-Mounted



10b. Clip-Mounted

Figure 10. Typical Mounting Techniques

Laboratory tests on a limited number of samples indicate, when using the screw and compression washer mounting technique, a screw torque of 6 to 8 in · lbs is sufficient to provide maximum power dissipation capability. The compression washer helps to maintain a constant pressure on the package over time and during large temperature excursions.

Destructive laboratory tests show that using a hex head 4-40 screw, without washers, and applying a torque in excess of 20 in · lbs will cause the plastic to crack around the mounting hole, resulting in a loss of isolation capability.

Additional tests on slotted 4-40 screws indicate that the screw slot fails between 15 to 20 in · lbs without adversely affecting the package. However, in order to positively ensure the package integrity of the fully isolated device, Motorola does not recommend exceeding 10 in · lbs of mounting torque under any mounting conditions.

**For more information about mounting power semiconductors see Application Note AN1040.

SWITCHMODE™ Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Dual Diode Construction — Terminals 1 and 3 may be Connected for Parallel Operation at Full Rating
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche

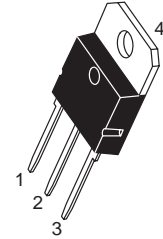
Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 units per plastic tube
- Marking: B3035, B3045

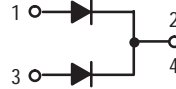
MBR3035PT
MBR3045PT

MBR3045PT is a
Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIERS
30 AMPERES
35 to 45 VOLTS**



CASE 340D-02



MAXIMUM RATINGS

Rating	Symbol	Maximum	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	MBR3035PT MBR3045PT V_{RRM} V_{RWM} V_R	35 45	Volts
Average Rectified Forward Current (Rated V_R) $T_C = 105^\circ\text{C}$	Per Device Per Diode $I_{F(AV)}$	30 15	Amps
Peak Repetitive Forward Current, Per Diode (Rated V_R , Square Wave, 20 kHz)	I_{FRM}	30	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	200	Amps
Peak Repetitive Reverse Current, Per Diode (2.0 μs , 1.0 kHz) See Figure 6	I_{RRM}	2.0	Amps
Operating Junction Temperature	T_J	-65 to +150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +175	$^\circ\text{C}$
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10000	V/ μs

THERMAL CHARACTERISTICS PER DIODE

Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.4	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	40	$^\circ\text{C}/\text{W}$

ELECTRICAL CHARACTERISTICS PER DIODE

Instantaneous Forward Voltage (1) ($i_F = 20$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 30$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 30$ Amps, $T_C = 25^\circ\text{C}$)	V_F	0.60 0.72 0.76	Volts
Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$) (Rated dc Voltage, $T_C = 25^\circ\text{C}$)	i_R	100 1.0	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

Preferred devices are Motorola recommended choices for future use and best overall value.

MBR3035PT MBR3045PT

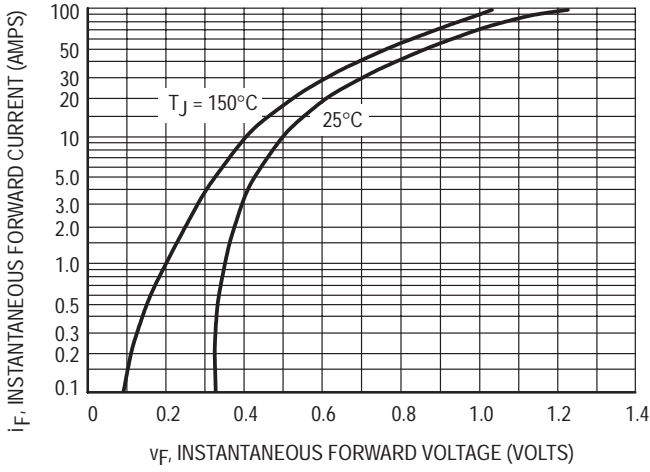


Figure 1. Typical Forward Voltage

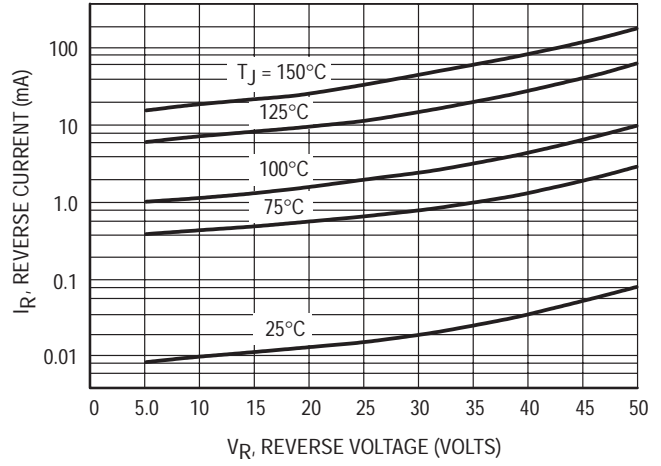


Figure 2. Typical Reverse Current

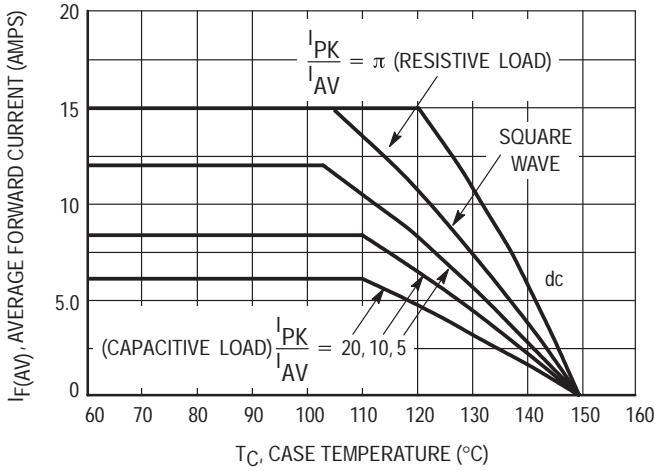


Figure 3. Current Derating (Per Leg)

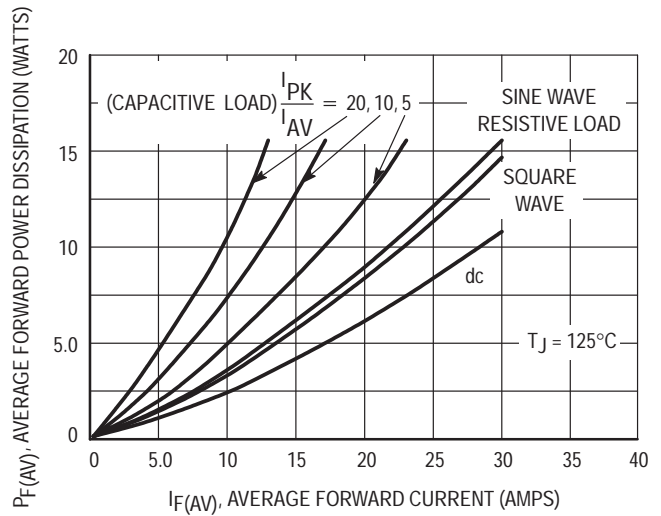


Figure 4. Forward Power Dissipation (Per Leg)

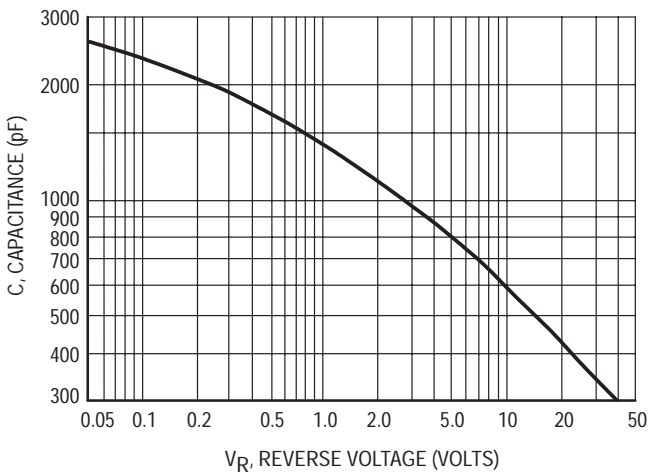


Figure 5. Capacitance

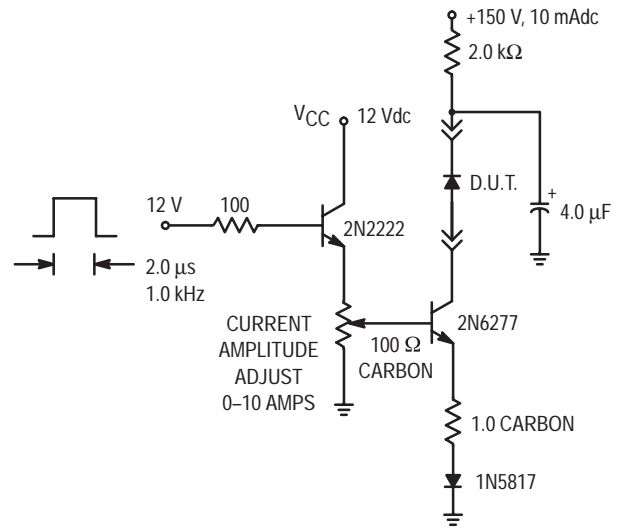


Figure 6. Test Circuit for Repetitive Reverse Current

Advance Information

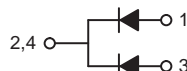
SWITCHMODE™ Power Rectifier

The SWITCHMODE power rectifier employs the use of the Schottky Barrier principle with a Platinum barrier metal. This state-of-the-art device has the following features:

- Dual Diode Construction — Terminals 1 and 3 May Be Connected for Parallel Operation at Full Rating
- 45 Volt Blocking Voltage
- Low Forward Voltage Drop
- Guardring for Stress Protection and High dv/dt Capability (> 10 V/ns)
- Guaranteed Reverse Avalanche
- 150°C Operating Junction Temperature

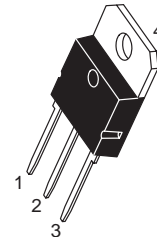
Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 Units Per Plastic Tube
- Marking: B4045



MBR4045PT

**SCHOTTKY BARRIER
RECTIFIER
40 AMPERES
45 VOLTS**



CASE 340D-02

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	45	Volt
Average Rectified Forward Current — Per Diode (Rated V_R) @ $T_C = 125^\circ\text{C}$ — Per Device	$I_{F(AV)}$	20 40	Amp
Peak Repetitive Forward Current, Per Diode (Rated V_R , Square Wave, 20 kHz) @ $T_C = 90^\circ\text{C}$	I_{FRM}	40	Amp
Non Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	400	Amp
Peak Repetitive Reverse Current (2.0 μs , 1.0 kHz)	I_{RRM}	2.0	Amp
Operating Junction Temperature	T_J	-65 to +150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +175	$^\circ\text{C}$
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175	$^\circ\text{C}$
Voltage Rate of Change	dv/dt	10,000	V/ μs

THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Case	$R_{\theta JC}$	1.4	$^\circ\text{C/W}$
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This document contains information on a new product. Specifications and information herein are subject to change without notice.

MBR4045PT

ELECTRICAL CHARACTERISTICS

Rating	Symbol	Max	Unit
Instantaneous Forward Voltage (1) @ $I_F = 20$ Amps, $T_C = 25^\circ\text{C}$ @ $I_F = 20$ Amps, $T_C = 125^\circ\text{C}$ @ $I_F = 40$ Amps, $T_C = 25^\circ\text{C}$ @ $I_F = 40$ Amps, $T_C = 125^\circ\text{C}$	V_F	0.70 0.60 0.80 0.75	Volts
Instantaneous Reverse Current (1) @ Rated DC Voltage, $T_C = 25^\circ\text{C}$ @ Rated DC Voltage, $T_C = 100^\circ\text{C}$	I_R	1.0 50	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$

TYPICAL ELECTRICAL CHARACTERISTICS

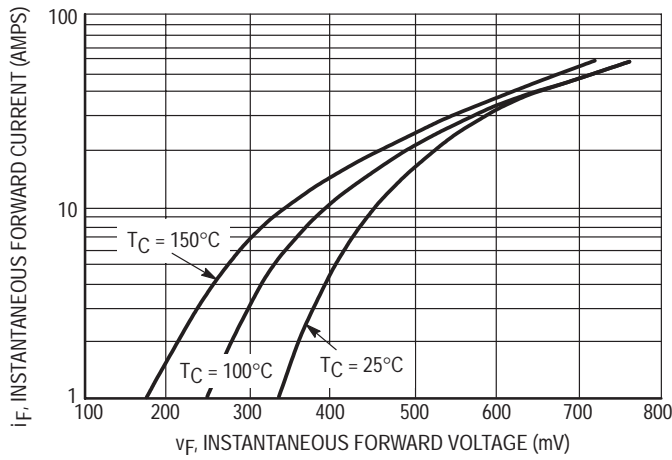


Figure 1. Typical Forward Voltage

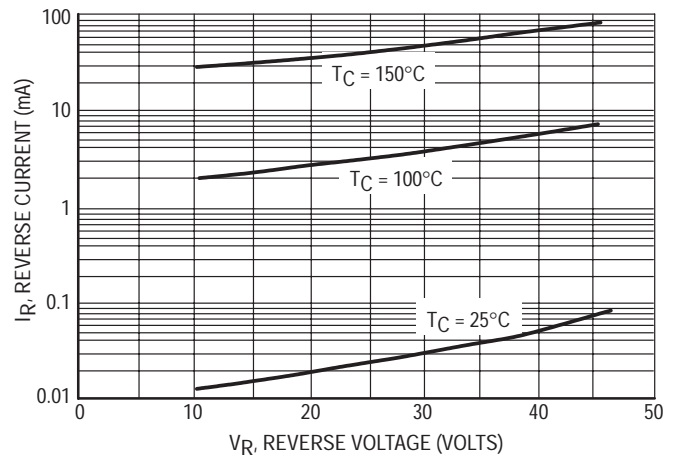


Figure 2. Typical Reverse Current

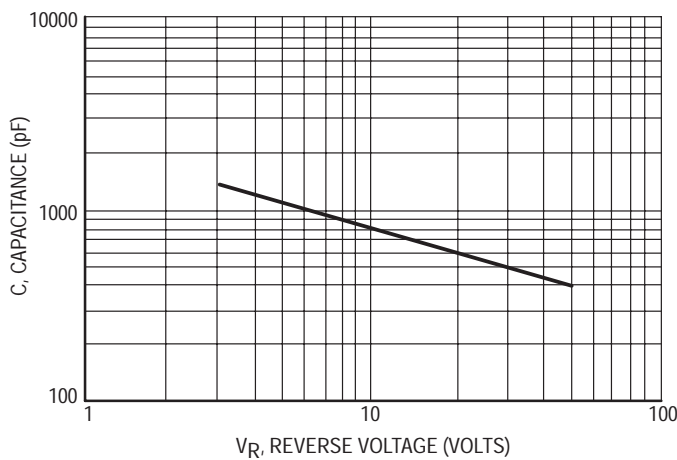


Figure 3. Typical Capacitance Per Leg

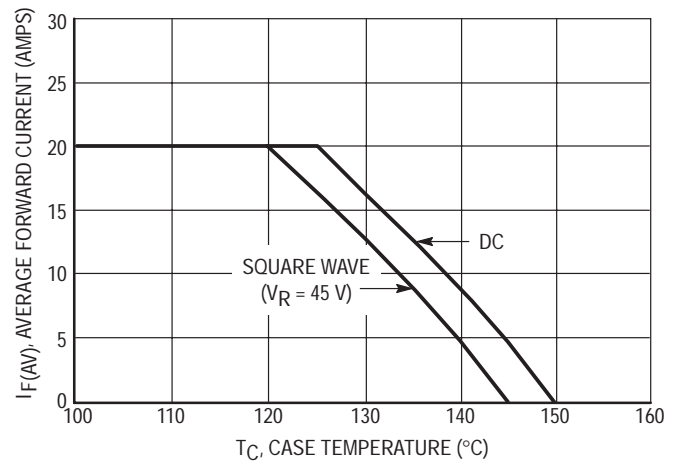


Figure 4. Current Derating Per Leg

Advance Information

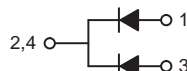
SWITCHMODE™ Power Rectifier

The SWITCHMODE power rectifier employs the use of the Schottky Barrier principle with a Platinum barrier metal. This state-of-the-art device has the following features:

- Dual Diode Construction — Terminals 1 and 3 May Be Connected for Parallel Operation at Full Rating
- 45 Volt Blocking Voltage
- Low Forward Voltage Drop
- Guardring for Stress Protection and High dv/dt Capability (> 10 V/ns)
- Guaranteed Reverse Avalanche
- 150°C Operating Junction Temperature

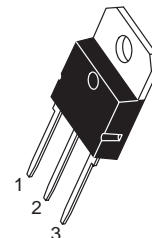
Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 Units Per Plastic Tube
- Marking: B6045



MBR6045PT

**SCHOTTKY BARRIER
RECTIFIER
60 AMPERES
45 VOLTS**



CASE 340D-02

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	45	Volt
Average Rectified Forward Current — Per Diode (Rated V_R) @ $T_C = 125^\circ\text{C}$ — Per Device	$I_{F(AV)}$	30 60	Amp
Peak Repetitive Forward Current, Per Diode (Rated V_R , Square Wave, 20 kHz) @ $T_C = 90^\circ\text{C}$	I_{FRM}	60	Amp
Non Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	500	Amp
Peak Repetitive Reverse Current (2.0 μs , 1.0 kHz)	I_{RRM}	2.0	Amp
Operating Junction Temperature	T_J	-65 to +150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +175	$^\circ\text{C}$
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175	$^\circ\text{C}$
Voltage Rate of Change	dv/dt	10,000	V/ μs

THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Case	$R_{\theta JC}$	1.0	$^\circ\text{C/W}$
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This document contains information on a new product. Specifications and information herein are subject to change without notice.

MBR6045PT

ELECTRICAL CHARACTERISTICS

Rating	Symbol	Max	Unit
Instantaneous Forward Voltage (1) @ $I_F = 30$ Amps, $T_C = 25^\circ\text{C}$ @ $I_F = 30$ Amps, $T_C = 125^\circ\text{C}$ @ $I_F = 60$ Amps, $T_C = 25^\circ\text{C}$	V_F	0.62 0.55 0.75	Volts
Instantaneous Reverse Current (1) @ Rated DC Voltage, $T_C = 25^\circ\text{C}$ @ Rated DC Voltage, $T_C = 100^\circ\text{C}$	I_R	1.0 50	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$

TYPICAL ELECTRICAL CHARACTERISTICS

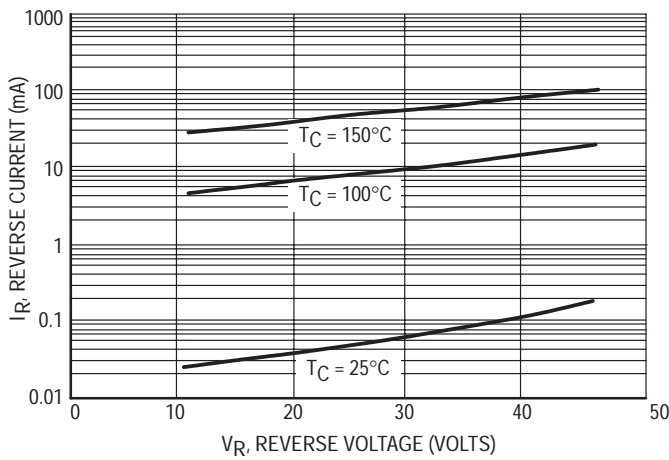


Figure 1. Typical Reverse Current

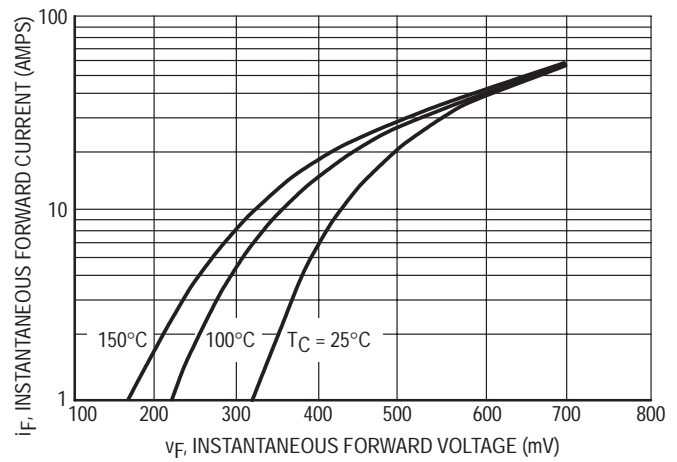


Figure 2. Typical Forward Voltage

Advance Information

SWITCHMODE™ Power Rectifier

The SWITCHMODE power rectifier employs the use of the Schottky Barrier principle with a Platinum barrier metal. This state-of-the-art device has the following features:

- Very Low Forward Voltage Drop (Max 0.58 V @ 100°C)
- Guardring for Stress Protection and High dv/dt Capability (> 10 V/ns)
- Guaranteed Reverse Avalanche
- 150°C Operating Junction Temperature
- Specially Designed for SWITCHMODE Power Supplies with Operating Frequency up to 300 kHz

Mechanical Characteristics

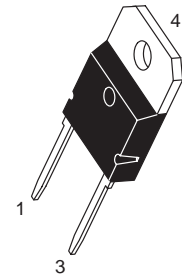
- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 Units Per Plastic Tube
- Marking: B5025L



MBR5025L

Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIER
LOW v_F
40 AMPERES
45 VOLTS**



CASE 340E-02

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	25	Volt
Average Rectified Forward Current $T_C = 125^\circ\text{C}$	$I_{F(AV)}$	50	Amp
Peak Repetitive Forward Current, Per Diode (Rated V_R , Square Wave, 20 kHz) @ $T_C = 90^\circ\text{C}$	I_{FRM}	150	Amp
Non Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	300	Amp
Peak Repetitive Reverse Current (2.0 μs , 1.0 kHz)	I_{RRM}	2.0	Amp
Operating Junction Temperature	T_J	-65 to +150	°C
Storage Temperature	T_{stg}	-65 to +175	°C
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175	°C
Voltage Rate of Change	dv/dt	10,000	V/ μs

THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Case	$R_{\theta JC}$	0.75	°C/W
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This document contains information on a new product. Specifications and information herein are subject to change without notice.

Preferred devices are Motorola recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS

Rating	Symbol	Max	Unit
Instantaneous Forward Voltage (1) @ $I_F = 50$ Amps, $T_C = 25^\circ\text{C}$ @ $I_F = 50$ Amps, $T_C = 125^\circ\text{C}$ @ $I_F = 30$ Amps, $T_C = 25^\circ\text{C}$	V_F	0.62 0.58 0.54	Volts
Instantaneous Reverse Current (1) @ Rated DC Voltage, $T_C = 25^\circ\text{C}$ @ Rated DC Voltage, $T_C = 100^\circ\text{C}$	I_R	0.5 60	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$

TYPICAL ELECTRICAL CHARACTERISTICS

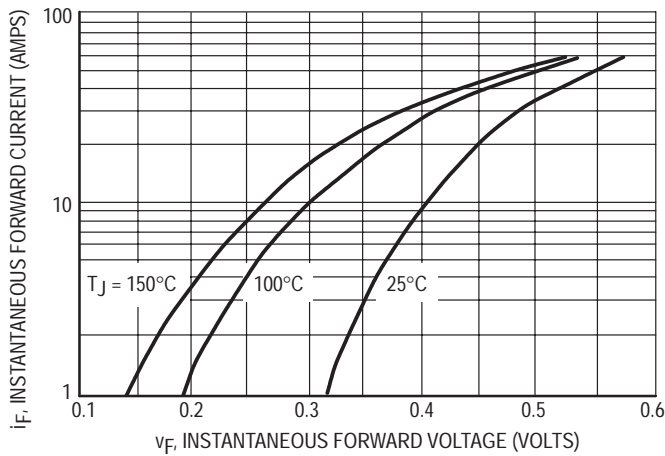


Figure 1. Typical Forward Voltage

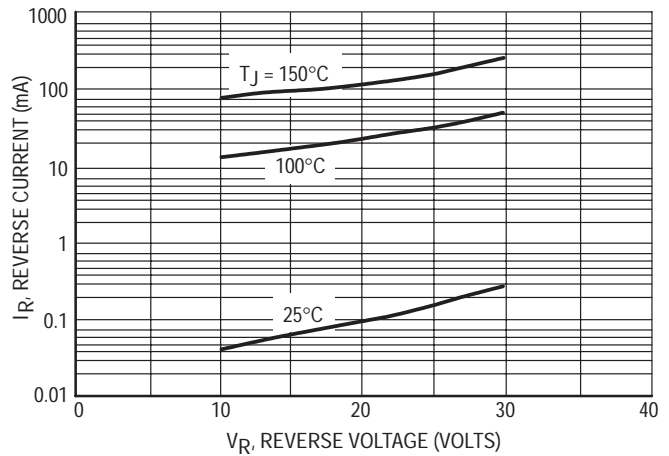


Figure 2. Typical Reverse Current

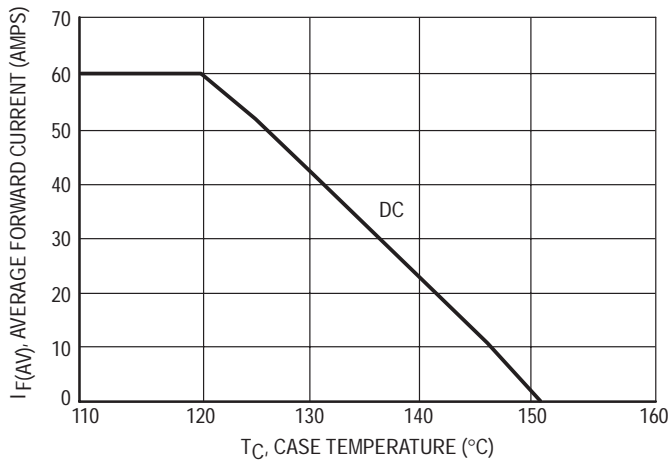


Figure 3. Current Derating, Case

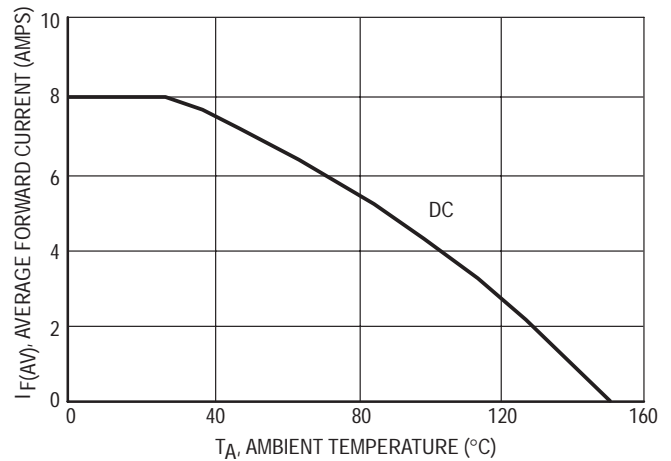


Figure 4. Current Derating, Ambient

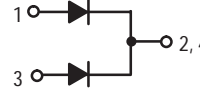
SWITCHMODE™ Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Dual Diode Construction — Terminals 1 and 3 may be Connected for Parallel Operation at Full Rating
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche
- Popular TO-247 Package

Mechanical Characteristics:

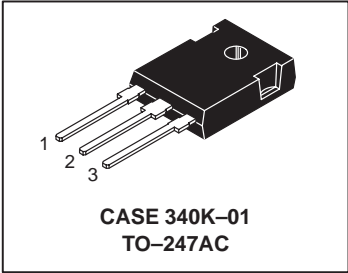
- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 units per plastic tube
- Marking: B3035, B3045



MBR3035WT
MBR3045WT

MBR3045WT is a
Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIERS**
30 AMPERES
35-45 VOLTS



MAXIMUM RATINGS

Rating	Symbol	MBR		Unit
		3035WT	3045WT	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	35	45	Volts
Average Rectified Forward Current (Rated V_R) $T_C = 105^\circ\text{C}$	$I_{F(AV)}$	30 15		Amps
Peak Repetitive Forward Current, Per Diode (Rated V_R , Square Wave, 20 kHz)	I_{FRM}	30		Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	200		Amps
Peak Repetitive Reverse Current, Per Diode (2.0 μs , 1.0 kHz) See Figure 6	I_{RRM}	2.0		Amps
Operating Junction Temperature	T_J	-65 to +150		$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +175		$^\circ\text{C}$
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175		$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10000		$\text{V}/\mu\text{s}$

THERMAL CHARACTERISTICS (Per Diode)

Thermal Resistance — Junction to Case	$R_{\theta JC}$	1.4	$^\circ\text{C}/\text{W}$
— Junction to Ambient	$R_{\theta JA}$	40	

ELECTRICAL CHARACTERISTICS (Per Diode)

Instantaneous Forward Voltage (1) ($i_F = 20$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 30$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 30$ Amps, $T_C = 25^\circ\text{C}$)	V_F	0.6 0.72 0.76	Volts
Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$) (Rated dc Voltage, $T_C = 25^\circ\text{C}$)	i_R	100 1.0	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

Preferred devices are Motorola recommended choices for future use and best overall value.

MBR3035WT MBR3045WT

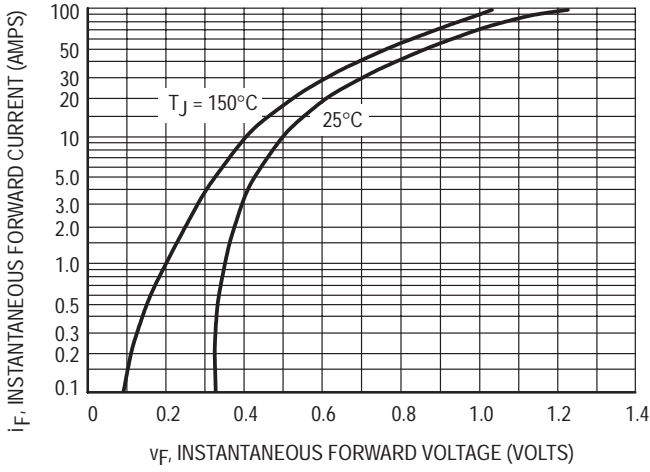


Figure 1. Typical Forward Voltage

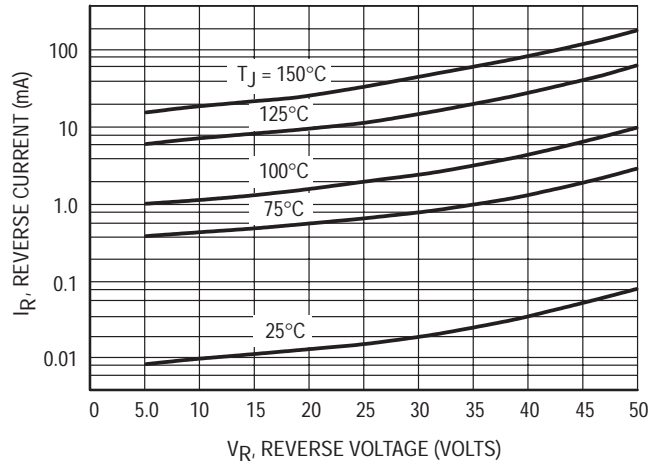


Figure 2. Typical Reverse Current

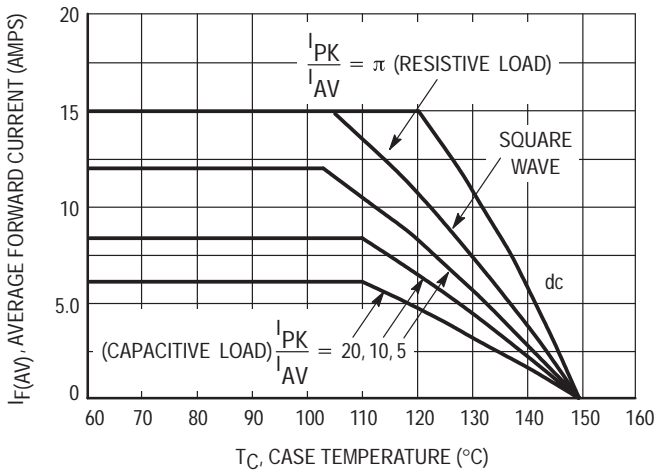


Figure 3. Current Derating (Per Leg)

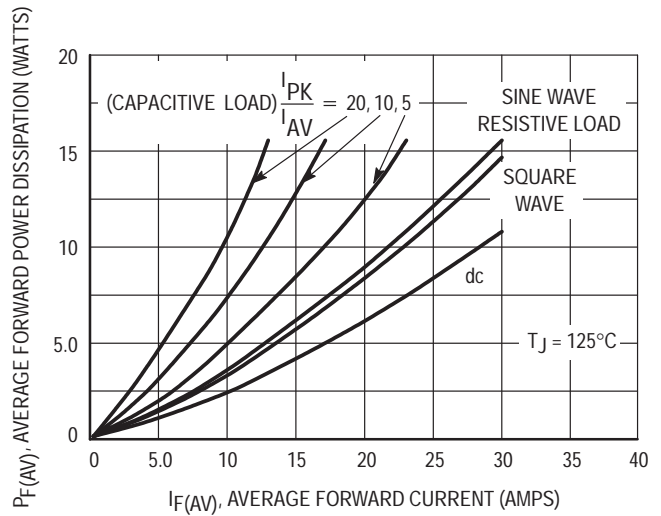


Figure 4. Forward Power Dissipation (Per Leg)

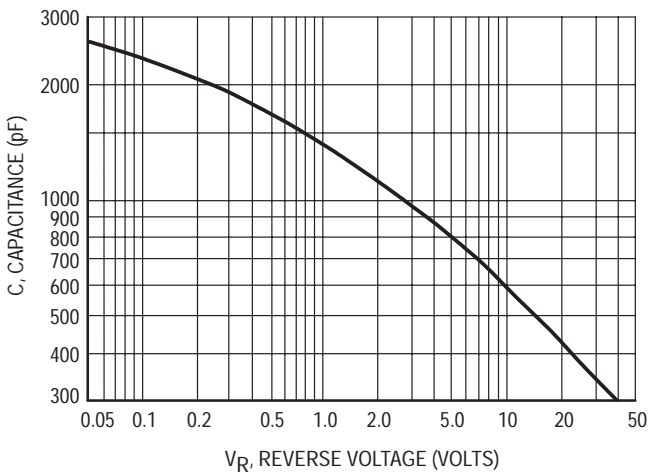


Figure 5. Capacitance

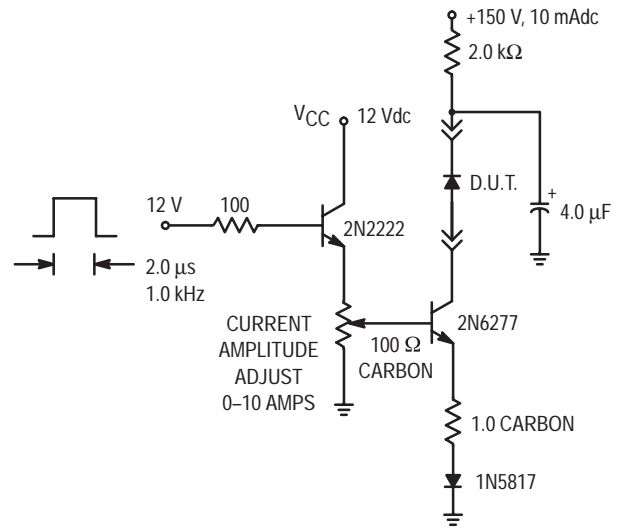


Figure 6. Test Circuit for Repetitive Reverse Current

Advance Information

SWITCHMODE™
Schottky Power Rectifier

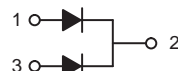
TO247 Power Package

... employing the Schottky Barrier principle in a large area metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Guardring for Over-Voltage Protection
- Low Forward Voltage Drop
- Monolithic Dual Die Construction. May Be Paralleled for High Current Output.
- Full Electrical Isolation without Additional Hardware

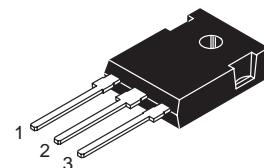
Mechanical Characteristics:

- Case: Molded Epoxy
- Epoxy Meets UL94, V₀ at 1/8"
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 30 Units Per Plastic Tube
- Marking: B4015L



MBR4015LWT

**SCHOTTKY BARRIER
RECTIFIER
40 AMPERES
15 VOLTS**



**CASE 340K-01, Style 2
TO-247**

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	15	V
Average Rectified Forward Current (At Rated V_R , $T_C = 95^\circ\text{C}$)	I_O	20 40	A
Peak Repetitive Forward Current (At Rated V_R , Square Wave, 20 kHz, $T_C = 95^\circ\text{C}$)	I_{FRM}	40	A
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	120	A
Storage / Operating Case Temperature	T_{stg}, T_C	-55 to +100	°C
Operating Junction Temperature	T_J	-55 to +100	°C
Voltage Rate of Change (Rated V_R , $T_J = 25^\circ\text{C}$)	dv/dt	10,000	V/ μs

THERMAL CHARACTERISTICS

Thermal Resistance — Junction-to-Case	Per Leg	$R_{\theta JC}$	0.57	°C/W
— Junction-to-Ambient	Per Leg	$R_{\theta JA}$	55	

This document contains information on a new product. Specifications and information herein are subject to change without notice.

MBR4015LWT

ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1), See Figure 2 ($I_F = 20\text{ A}$) ($I_F = 40\text{ A}$)	Per Leg	V_F	$T_J = 25^\circ\text{C}$	$T_J = 100^\circ\text{C}$	V
			0.42 0.50	0.36 0.48	
Maximum Instantaneous Reverse Current, See Figure 4 ($V_R = 15\text{ V}$) ($V_R = 7.5\text{ V}$)	Per Leg	I_R	$T_J = 25^\circ\text{C}$	$T_J = 100^\circ\text{C}$	mA
			5.0 2.7	530 370	

(1) Pulse Test: Pulse Width $\leq 250\ \mu\text{s}$, Duty Cycle $\leq 2\%$.

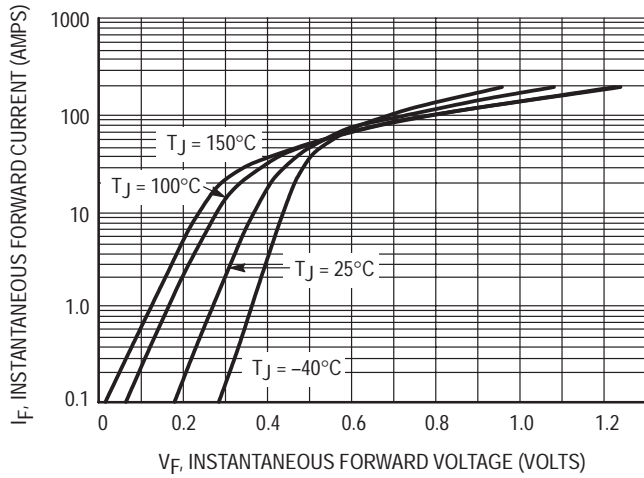


Figure 1. Typical Forward Voltage Per Leg

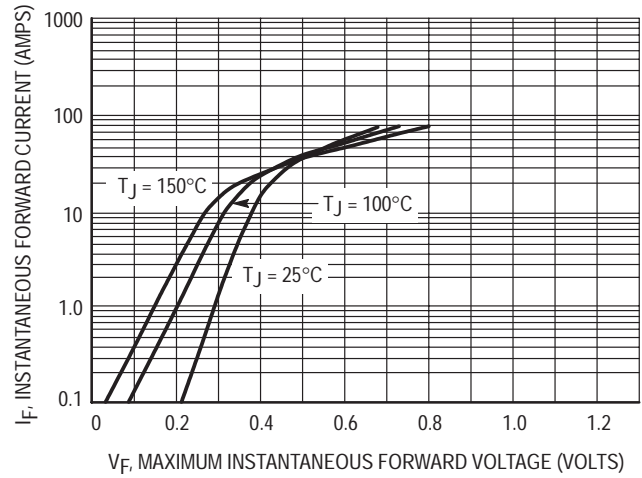


Figure 2. Maximum Forward Voltage Per Leg

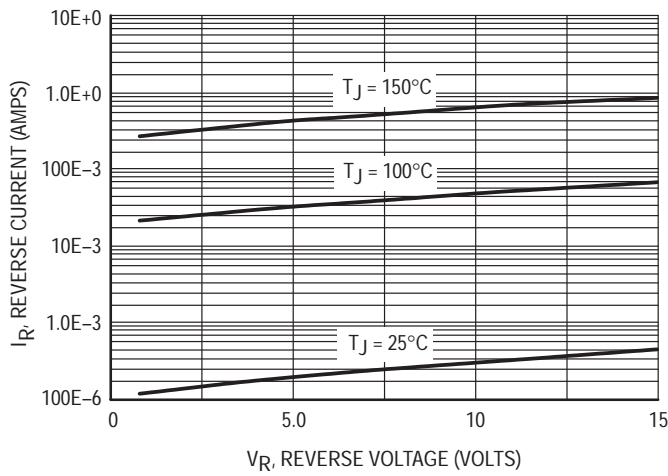


Figure 3. Typical Reverse Current Per Leg

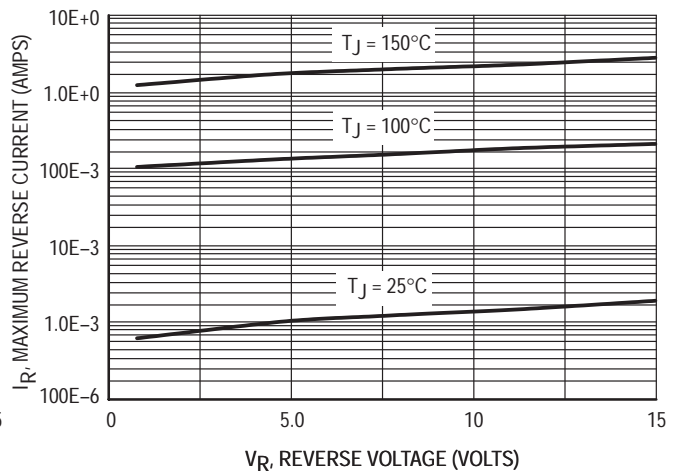


Figure 4. Maximum Reverse Current Per Leg

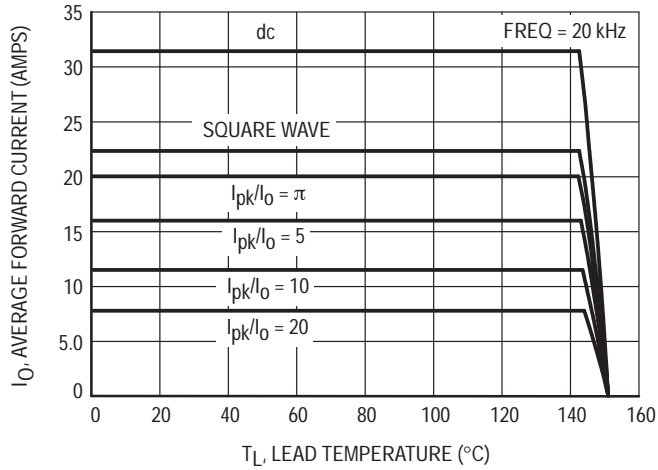


Figure 5. Current Derating Per Leg

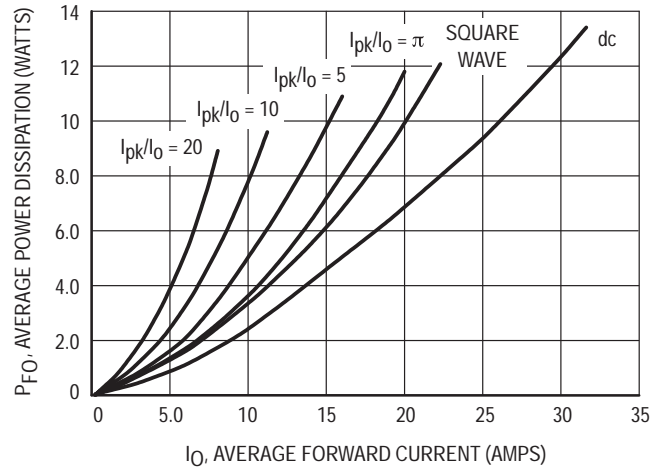


Figure 6. Forward Power Dissipation Per Leg

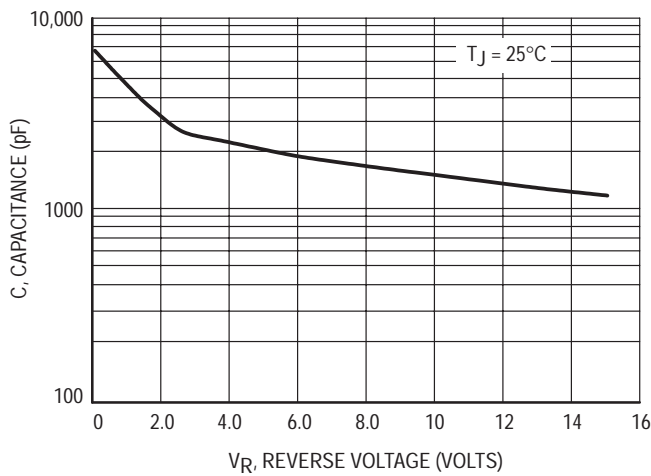


Figure 7. Capacitance Per Leg

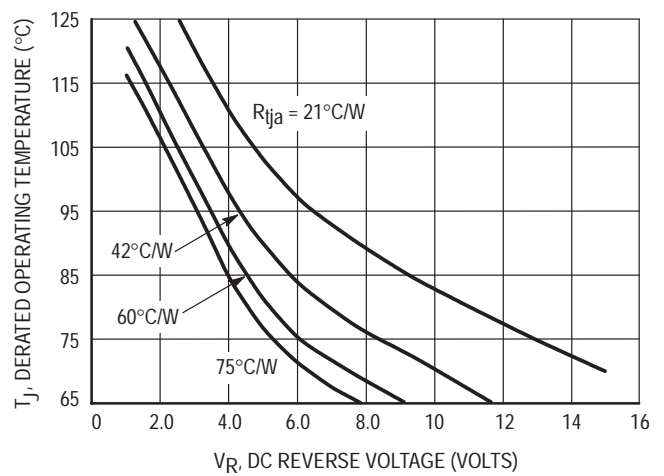


Figure 8. Typical Operating Temperature Derating Per Leg*

* Reverse power dissipation and the possibility of thermal runaway must be considered when operating this device under any reverse voltage conditions. Calculations of T_J therefore must include forward and reverse power effects. The allowable operating T_J may be calculated from the equation:

$$T_J = T_{Jmax} - r(t)(P_f + P_r) \text{ where}$$

$r(t)$ = thermal impedance under given conditions,
 P_f = forward power dissipation, and
 P_r = reverse power dissipation

This graph displays the derated allowable T_J due to reverse bias under DC conditions only and is calculated as $T_J = T_{Jmax} - r(t)P_r$, where $r(t) = R_{thja}$. For other power applications further calculations must be performed.

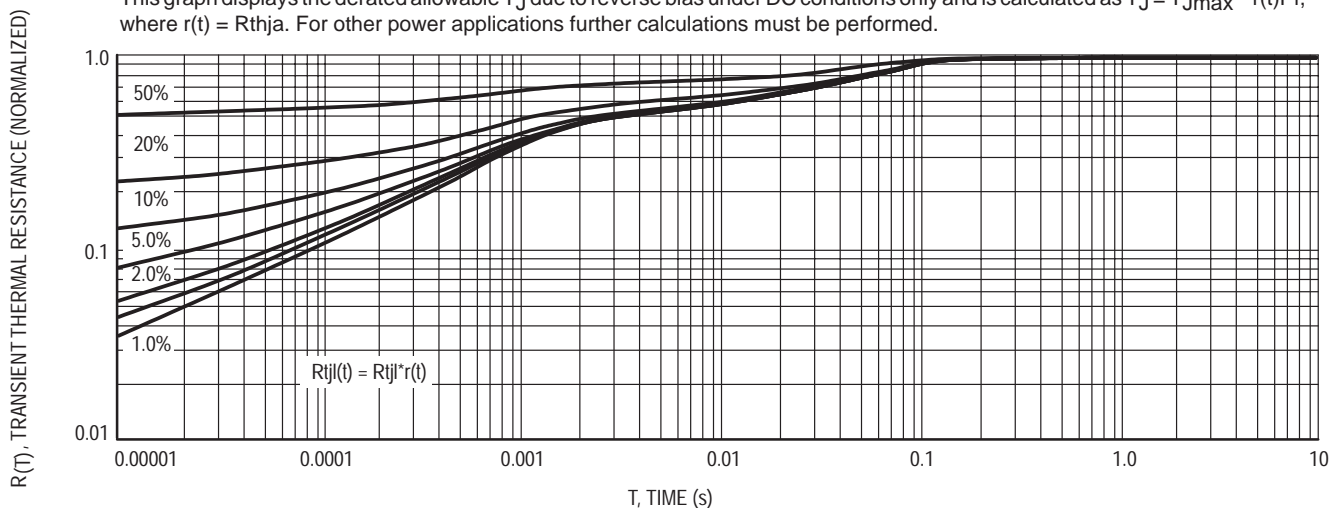


Figure 9. Thermal Response Junction to Lead (Per Leg)

MBR4015LWT

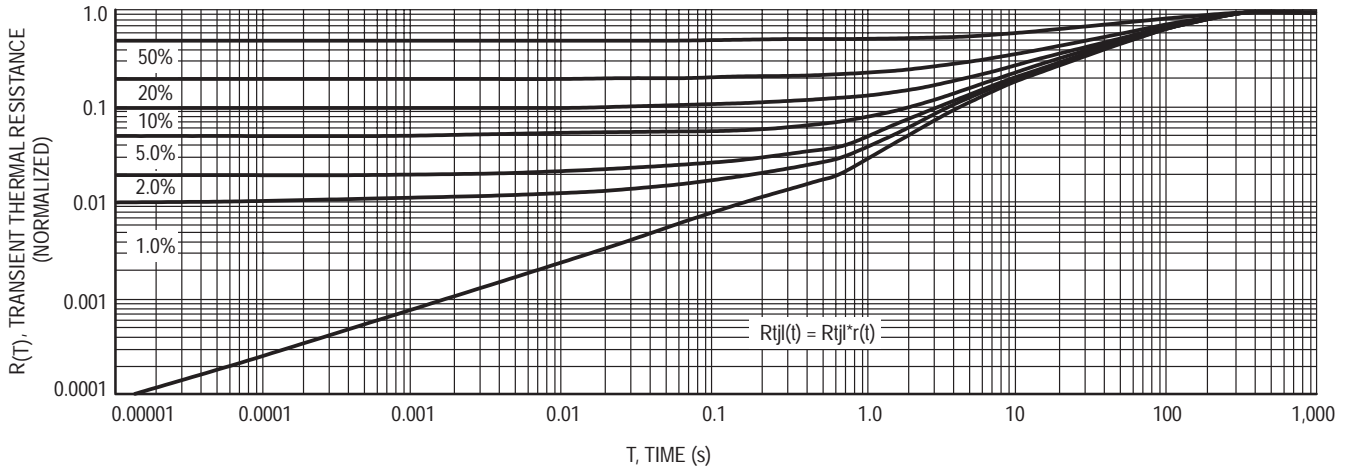


Figure 10. Thermal Response Junction to Ambient (Per Leg)

Advance Information

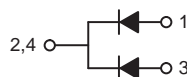
SWITCHMODE™ Power Rectifier

The SWITCHMODE power rectifier employs the use of the Schottky Barrier principle with a Platinum barrier metal. This state-of-the-art device has the following features:

- Dual Diode Construction — Terminals 1 and 3 May Be Connected for Parallel Operation at Full Rating
- 45 Volt Blocking Voltage
- Low Forward Voltage Drop
- Guardring for Stress Protection and High dv/dt Capability (> 10 V/ns)
- Guaranteed Reverse Avalanche
- 150°C Operating Junction Temperature

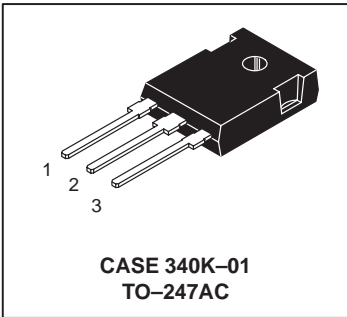
Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 Units Per Plastic Tube
- Marking: B4045



MBR4045WT

**SCHOTTKY BARRIER
RECTIFIER
40 AMPERES
45 VOLTS**



MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	45	Volt
Average Rectified Forward Current — Per Diode (Rated V_R) @ $T_C = 125^\circ\text{C}$ — Per Device	$I_{F(AV)}$	20 40	Amp
Peak Repetitive Forward Current, Per Diode (Rated V_R , Square Wave, 20 kHz) @ $T_C = 90^\circ\text{C}$	I_{FRM}	40	Amp
Non Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	400	Amp
Peak Repetitive Reverse Current (2.0 μs , 1.0 kHz)	I_{RRM}	2.0	Amp
Operating Junction Temperature	T_J	-65 to +150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +175	$^\circ\text{C}$
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175	$^\circ\text{C}$
Voltage Rate of Change	dv/dt	10,000	V/ μs

THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Case	$R_{\theta JC}$	1.4	$^\circ\text{C}/\text{W}$
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This document contains information on a new product. Specifications and information herein are subject to change without notice.

MBR4045WT

ELECTRICAL CHARACTERISTICS

Rating	Symbol	Max	Unit
Instantaneous Forward Voltage (1) @ $I_F = 20$ Amps, $T_C = 25^\circ\text{C}$ @ $I_F = 20$ Amps, $T_C = 125^\circ\text{C}$ @ $I_F = 40$ Amps, $T_C = 25^\circ\text{C}$ @ $I_F = 40$ Amps, $T_C = 125^\circ\text{C}$	V_F	0.70 0.60 0.80 0.75	Volts
Instantaneous Reverse Current (1) @ Rated DC Voltage, $T_C = 25^\circ\text{C}$ @ Rated DC Voltage, $T_C = 100^\circ\text{C}$	I_R	1.0 50	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle < 2.0%

TYPICAL ELECTRICAL CHARACTERISTICS

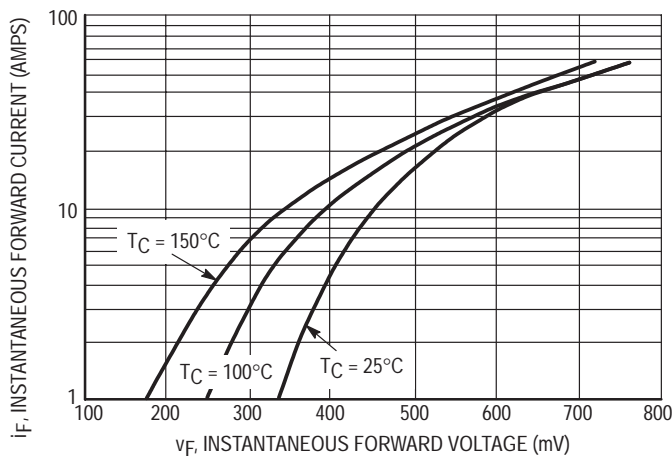


Figure 1. Typical Forward Voltage

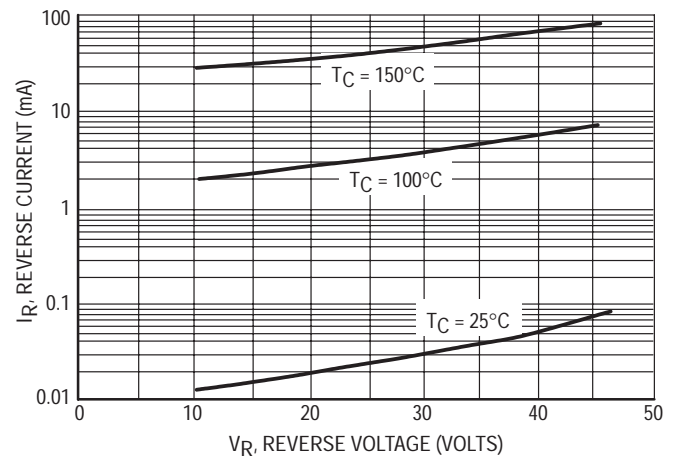


Figure 2. Typical Reverse Current

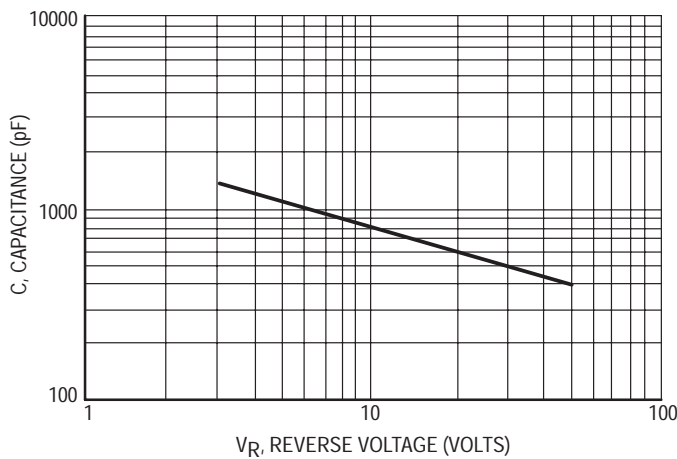


Figure 3. Typical Capacitance Per Leg

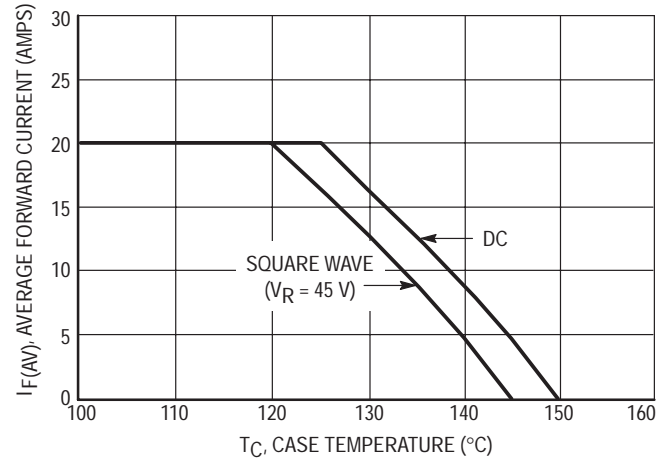


Figure 4. Current Derating Per Leg

Advance Information

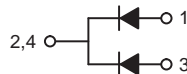
SWITCHMODE™ Power Rectifier

The SWITCHMODE power rectifier employs the use of the Schottky Barrier principle with a Platinum barrier metal. This state-of-the-art device has the following features:

- Dual Diode Construction — Terminals 1 and 3 May Be Connected for Parallel Operation at Full Rating
- 45 Volt Blocking Voltage
- Low Forward Voltage Drop
- Guardring for Stress Protection and High dv/dt Capability (> 10 V/ns)
- Guaranteed Reverse Avalanche
- 150°C Operating Junction Temperature

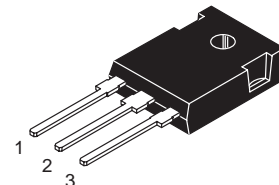
Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 Units Per Plastic Tube
- Marking: B6045



MBR6045WT

**SCHOTTKY BARRIER
RECTIFIER
60 AMPERES
45 VOLTS**



**CASE 340K-01
TO-247AC**

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	45	Volt
Average Rectified Forward Current — Per Diode (Rated V_R) @ $T_C = 125^\circ\text{C}$ — Per Device	$I_{F(AV)}$	30 60	Amp
Peak Repetitive Forward Current, Per Diode (Rated V_R , Square Wave, 20 kHz) @ $T_C = 90^\circ\text{C}$	I_{FRM}	60	Amp
Non Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	500	Amp
Peak Repetitive Reverse Current (2.0 μs , 1.0 kHz)	I_{RRM}	2.0	Amp
Operating Junction Temperature	T_J	-65 to +150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +175	$^\circ\text{C}$
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175	$^\circ\text{C}$
Voltage Rate of Change	dv/dt	10,000	V/ μs

THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Case	$R_{\theta JC}$	1.0	$^\circ\text{C}/\text{W}$
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This document contains information on a new product. Specifications and information herein are subject to change without notice.

MBR6045WT

ELECTRICAL CHARACTERISTICS

Rating	Symbol	Max	Unit
Instantaneous Forward Voltage (1) @ $I_F = 30$ Amps, $T_C = 25^\circ\text{C}$ @ $I_F = 30$ Amps, $T_C = 125^\circ\text{C}$ @ $I_F = 60$ Amps, $T_C = 25^\circ\text{C}$	V_F	0.62 0.55 0.75	Volts
Instantaneous Reverse Current (1) @ Rated DC Voltage, $T_C = 25^\circ\text{C}$ @ Rated DC Voltage, $T_C = 100^\circ\text{C}$	I_R	1.0 50	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle < 2.0%

TYPICAL ELECTRICAL CHARACTERISTICS

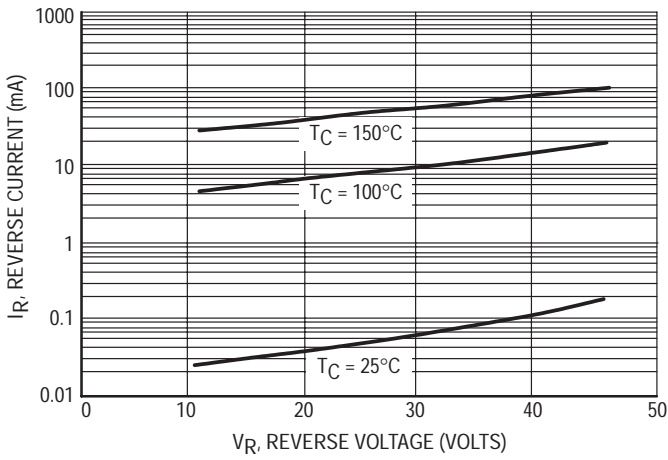


Figure 1. Typical Reverse Current

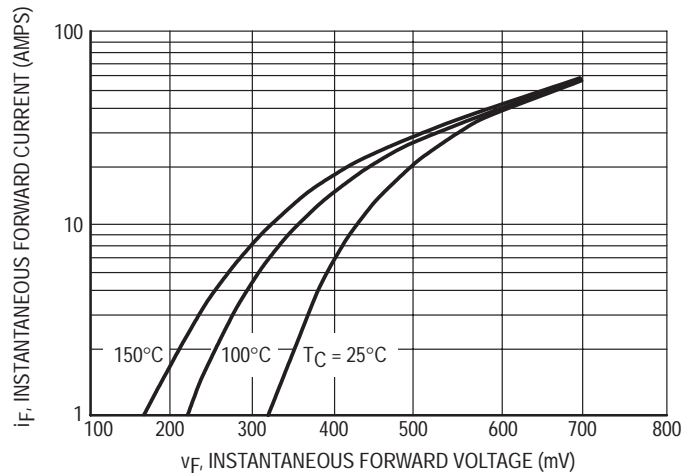


Figure 2. Typical Forward Voltage

Designer's™ Data Sheet

Power Rectifiers

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features chrome barrier metal, epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free-wheeling diodes, and polarity-protection diodes.

- Extremely Low v_f
- Low Power Loss/High Efficiency
- Low Stored Charge, Majority Carrier Conduction
- High Surge Capacity

Mechanical Characteristics:

- Case: Welded steel, hermetically sealed
- Weight: 45.6 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Solder Heat: The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.
- Stud Torque: 15 lb-in max
- Shipped 25 units per rail
- Marking: 1N5826, 1N5827, 1N5828

1N5826
1N5827
1N5828

1N5826 and 1N5828 are
Motorola Preferred Devices

**SCHOTTKY BARRIER
RECTIFIERS**
15 AMPERES
20, 30, 40 VOLTS



CASE 56-03
DO-203AA
METAL

MAXIMUM RATINGS

Rating	Symbol	1N5826	1N5827	1N5828	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	20	30	40	Volts
Non-Repetitive Peak Reverse Voltage	V_{RSM}	24	36	48	Volts
Average Rectified Forward Current $V_{R(equiv)} \leq 0.2 V_{R(dc)}$, $T_C = 85^\circ C$	I_O	← 15 →			Amp
Ambient Temperature Rated $V_R(dc)$, PF(AV) = 0, $R_{\theta JA} = 5.0^\circ C/W$	T_A	95	90	85	$^\circ C$
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I_{FSM}	← 500 (for one cycle) →			Amp
Operating and Storage Junction Temperature Range (Reverse Voltage applied)	T_J , T_{stg}	← -65 to +125 →			$^\circ C$
Peak Operating Junction Temperature (Forward Current applied)	$T_{J(pk)}$	← 150 →			$^\circ C$

*THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	2.5	$^\circ C/W$

* Indicates JEDEC Registered Data

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle = 2.0%.

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

1N5826 1N5827 1N5828

*ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	1N5826	1N5827	1N5828	Unit
Maximum Instantaneous Forward Voltage (1) ($i_F = 8.0$ Amps) ($i_F = 15$ Amps) ($i_F = 47.1$ Amps)	V_F	0.380 0.440 0.670	0.400 0.470 0.770	0.420 0.500 0.870	Volts
Maximum Instantaneous Reverse Current @ Rated dc Voltage (1) $T_C = 100^\circ\text{C}$	i_R	10 75	10 75	10 75	mA

* Indicates JEDEC Registered Data

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle = 2.0%.

NOTE 1 — DETERMINING MAXIMUM RATINGS

Reverse power dissipation and the possibility of thermal runaway must be considered when operating this rectifier at reverse voltages above $0.2 V_{RWM}$. Proper derating may be accomplished by use of equation (1):

$$T_{A(max)} = T_J(max) - R_{\theta JA} P_{F(AV)} - R_{\theta JA} P_{R(AV)} \quad (1)$$

where $T_{A(max)}$ = Maximum allowable ambient temperature

$T_J(max)$ = Maximum allowable junction temperature
(125°C or the temperature at which thermal runaway occurs, whichever is lowest)

$P_{F(AV)}$ = Average forward power dissipation

$P_{R(AV)}$ = Average reverse power dissipation

$R_{\theta JA}$ = Junction-to-ambient thermal resistance

Figures 1, 2, and 3 permit easier use of equation (1) by taking reverse power dissipation and thermal runaway into consideration. The figures solve for a reference temperature as determined by equation (2):

$$T_R = T_J(max) - R_{\theta JA} P_{R(AV)} \quad (2)$$

Substituting equation (2) into equation (1) yields:

$$T_{A(max)} = T_R - R_{\theta JA} P_{F(AV)} \quad (3)$$

Inspection of equations (2) and (3) reveals that T_R is the ambient temperature at which thermal runaway occurs or where $T_J = 125^\circ\text{C}$, when forward power is zero. The transition from one boundary condition to the other is evident on the curves of Figures 1, 2, and 3 as a

difference in the rate of change of the slope in the vicinity of 115°C . The data of Figures 1, 2, and 3 is based upon dc conditions. For use in common rectifier circuits, Table 1 indicates suggested factors for an equivalent dc voltage to use for conservative design, i.e.:

$$V_{R(equiv)} = V_{in(PK)} \times F \quad (4)$$

The Factor F is derived by considering the properties of the various rectifier circuits and the reverse characteristics of Schottky diodes.

EXAMPLE: Find $T_{A(max)}$ for 1N5828 operated in a 12-volt dc supply using a bridge circuit with capacitive filter such that $I_{DC} = 10$ A ($I_{F(AV)} = 5$ A), $I_{(PK)}/I_{(AV)} = 20$, Input Voltage = 10 V(rms), $R_{\theta JA} = 5^\circ\text{C/W}$.

Step 1. Find $V_{R(equiv)}$. Read $F = 0.65$ from Table 1,
 $\therefore V_{R(equiv)} = (1.41)(10)(0.65) = 9.18$ V.

Step 2. Find T_R from Figure 3. Read $T_R = 121^\circ\text{C}$
@ $V_R = 9.18$ V and $R_{\theta JA} = 5^\circ\text{C/W}$.

Step 3. Find $P_{F(AV)}$ from Figure 4. **Read $P_{F(AV)} = 10$ W

$$\text{@ } \frac{I_{(PK)}}{I_{(AV)}} = 20 \text{ and } I_{F(AV)} = 5 \text{ A}$$

Step 4. Find $T_{A(max)}$ from equation (3).
 $T_{A(max)} = 121 - (5)(10) = 71^\circ\text{C}$.

**Values given are for the 1N5828. Power is slightly lower for the other units because of their lower forward voltage.

Table 1. Values for Factor F

Circuit	Half Wave		Full Wave, Bridge		Full Wave, Center Tapped*†	
	Resistive	Capacitive*	Resistive	Capacitive	Resistive	Capacitive
Sine Wave	0.5	1.3	0.5	0.65	1.0	1.3
Square Wave	0.75	1.5	0.75	0.75	1.5	1.5

*Note that $V_{R(PK)} \approx 2.0 V_{in(PK)}$. *†Use line to center tap voltage for V_{in} .

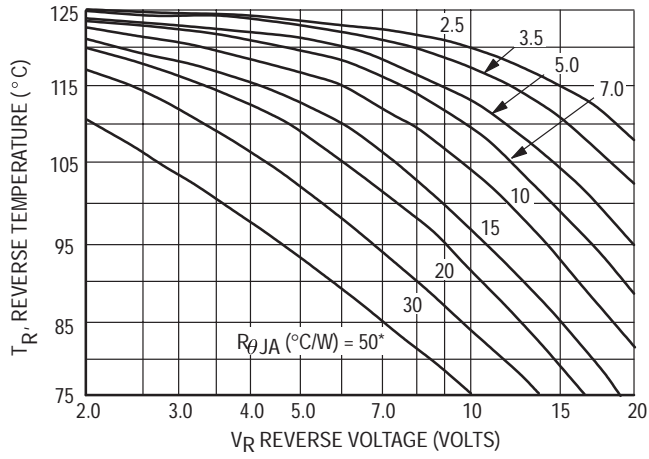


Figure 1. Maximum Reference Temperature – 1N5826

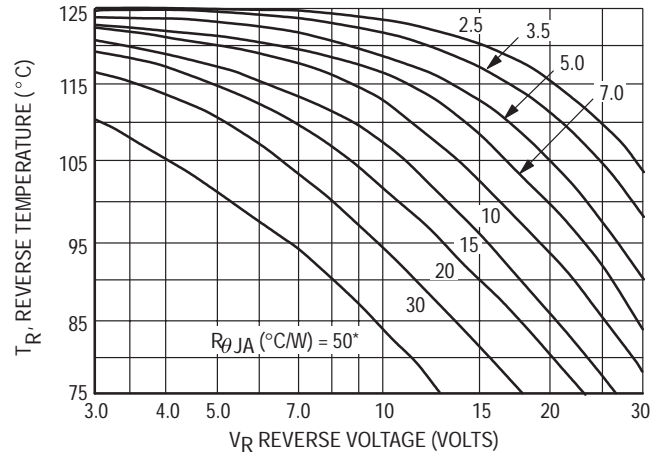


Figure 2. Maximum Reference Temperature – 1N5827

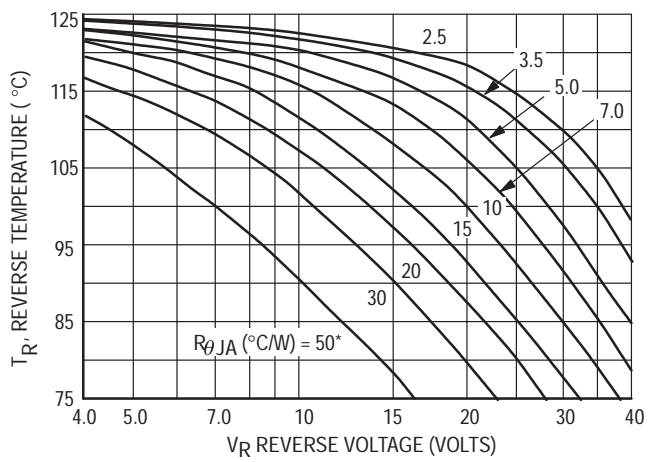


Figure 3. Maximum Reference Temperature – 1N5828

* NO EXTERNAL HEAT SINK

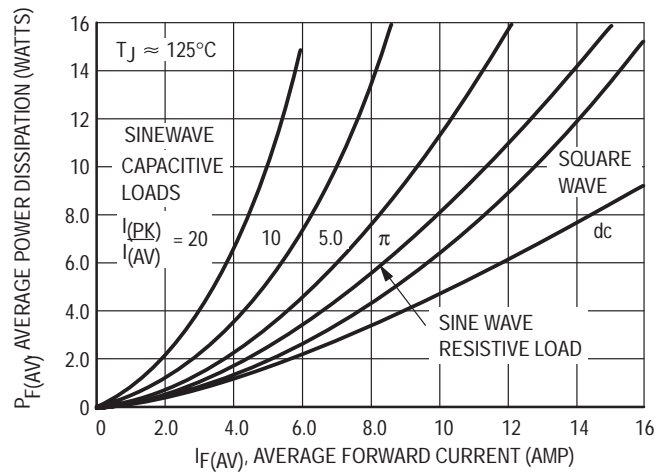


Figure 4. Forward Power Dissipation

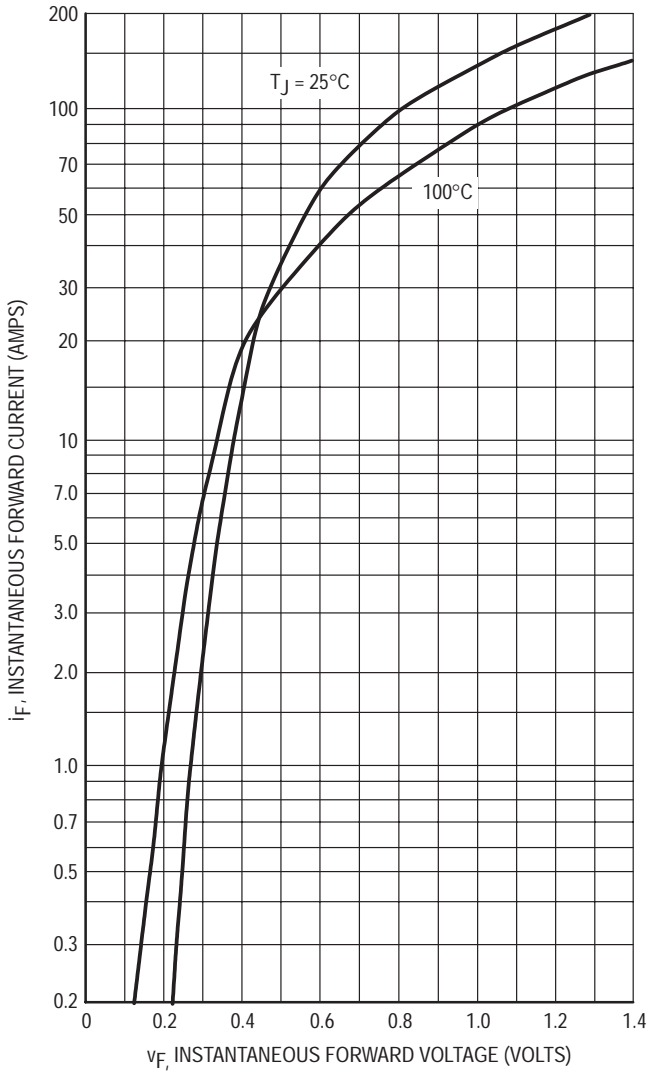


Figure 5. Typical Forward Voltage

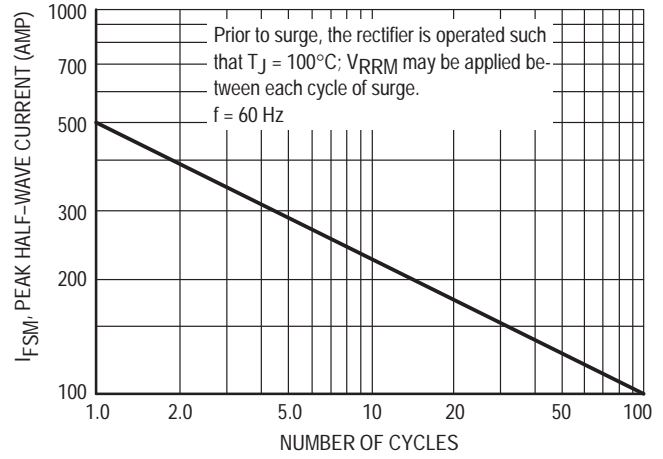


Figure 6. Maximum Surge Capability

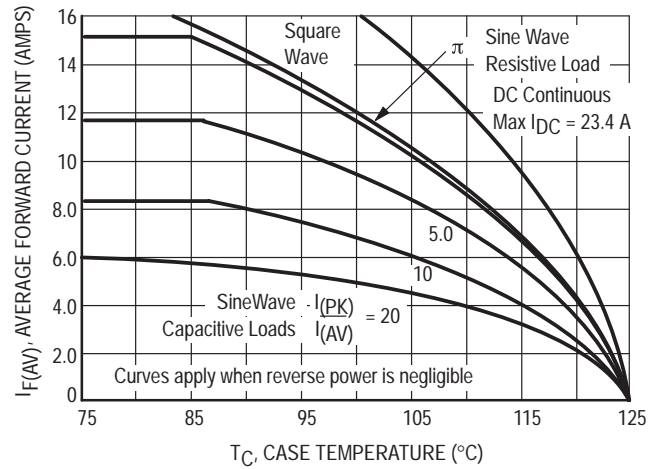


Figure 7. Current Derating

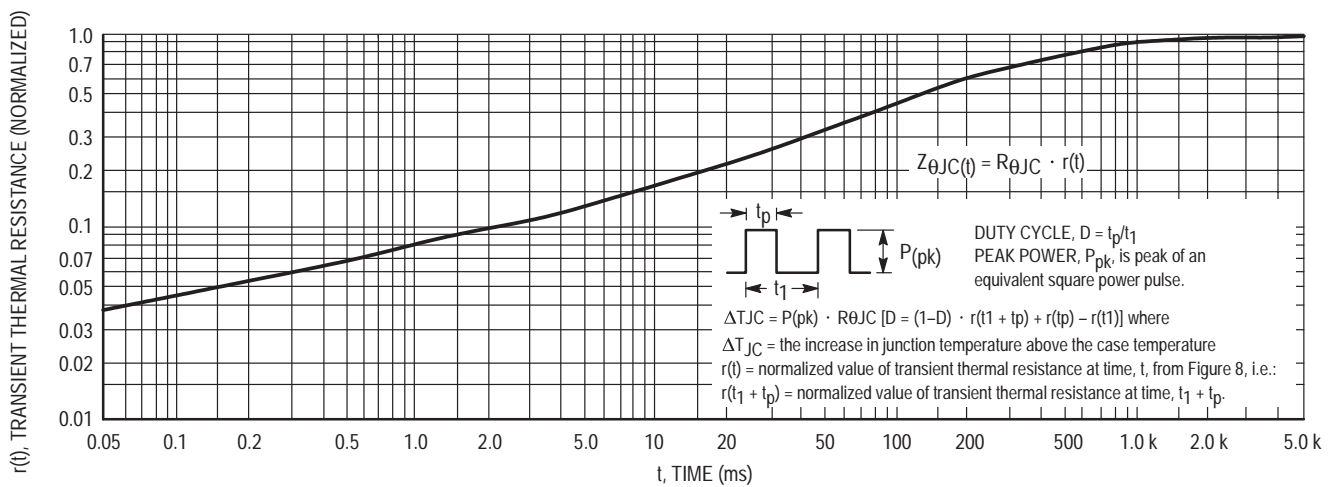


Figure 8. Thermal Response

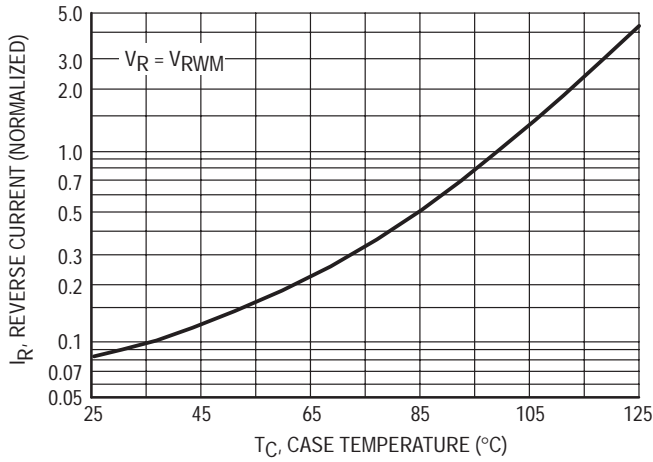


Figure 9. Normalized Reverse Current

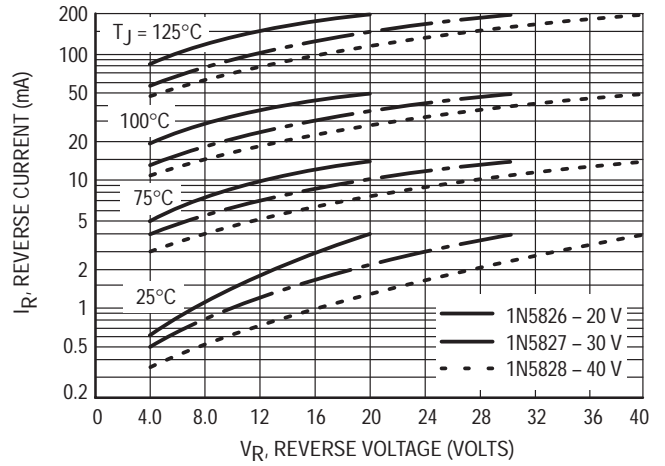


Figure 10. Typical Reverse Current

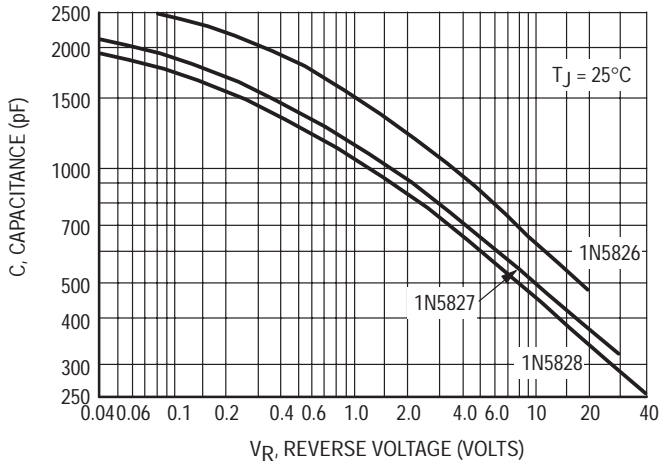


Figure 11. Capacitance

NOTE 2 — HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 11.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

Designer's™ Data Sheet

SWITCHMODE™ Power Rectifiers

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Extremely Low v_f
- Low Power Loss/High Efficiency
- Low Stored Charge, Majority Carrier Conduction
- High Surge Capacity

Mechanical Characteristics:

- Case: Welded steel, hermetically sealed
- Weight: 45.6 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Solder Heat: The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.
- Stud Torque: 15 lb-in max
- Shipped 25 units per rail
- Marking: 1N5829, 1N5830, 1N5831

1N5829
1N5830
1N5831

1N5831 is a
Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIERS**
25 AMPERES
20, 30, 40 VOLTS



CASE 56-03
DO-203AA
METAL

MAXIMUM RATINGS

Rating	Symbol	*1N5829	*1N5830	*1N5831	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	20	30	40	Volts
Non-Repetitive Peak Reverse Voltage	V_{RSM}	24	36	48	Volts
Average Rectified Forward Current $V_{R(equiv)} \leq 0.2 V_{R(dc)}$, $T_C = 85^\circ C$	I_O	25			Amps
Ambient Temperature Rated $V_{R(dc)}$, $PF(AV) = 0$, $R_{\theta JA} = 3.5^\circ C/W$	T_A	90	85	80	$^\circ C$
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I_{FSM}	800 (for one cycle)			Amps
Operating and Storage Junction Temperature Range (Reverse Voltage applied)	T_J, T_{stg}	-65 to +125			$^\circ C$
Peak Operating Junction Temperature (Forward Current applied)	$T_{J(pk)}$	150			$^\circ C$

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.75	$^\circ C/W$

* Indicates JEDEC Registered Data

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle = 2.0%.

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	*1N5829	*1N5830	*1N5831	Unit
Maximum Instantaneous Forward Voltage (1) (i _F = 10 Amps) (i _F = 25 Amps) (i _F = 78.5 Amps)	V _F	0.360 0.440 0.720	0.370 0.460 0.770	0.380 0.480 0.820	Volts
Maximum Instantaneous Reverse Current @ Rated dc Voltage (1) (T _C = 100°C)	i _R	20 150	20 150	20 150	mA

* Indicates JEDEC Registered Data

(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle = 2.0%.

NOTE 1 — DETERMINING MAXIMUM RATINGS

Reverse power dissipation and the possibility of thermal runaway must be considered when operating this rectifier at reverse voltages above 0.2 V_{RWM}. Proper derating may be accomplished by use of equation (1):

$$T_A(\max) = T_J(\max) - R_{\theta JA} P_{F(AV)} - R_{\theta JA} P_{R(AV)} \quad (1)$$

where T_A(max) = Maximum allowable ambient temperature

T_J(max) = Maximum allowable junction temperature
(125°C or the temperature at which thermal runaway occurs, whichever is lowest)

P_{F(AV)} = Average forward power dissipation

P_{R(AV)} = Average reverse power dissipation

R_{θJA} = Junction-to-ambient thermal resistance

Figures 1, 2, and 3 permit easier use of equation (1) by taking reverse power dissipation and thermal runaway into consideration. The figures solve for a reference temperature as determined by equation (2):

$$T_R = T_J(\max) - R_{\theta JA} P_{R(AV)} \quad (2)$$

Substituting equation (2) into equation (1) yields:

$$T_A(\max) = T_R - R_{\theta JA} P_{F(AV)} \quad (3)$$

Inspection of equations (2) and (3) reveals that T_R is the ambient temperature at which thermal runaway occurs or where T_J = 125°C, when forward power is zero. The transition from one boundary condition to the other is evident on the curves of Figures 1, 2, and 3 as a

difference in the rate of change of the slope in the vicinity of 115°C. The data of Figures 1, 2, and 3 is based upon dc conditions. For use in common rectifier circuits, Table 1 indicates suggested factors for an equivalent dc voltage to use for conservative design, i.e.:

$$V_{R(\text{equiv})} = V_{in(PK)} \times F \quad (4)$$

The Factor F is derived by considering the properties of the various rectifier circuits and the reverse characteristics of Schottky diodes.

EXAMPLE: Find T_A(max) for 1N5831 operated in a 12-volt dc supply using a bridge circuit with capacitive filter such that I_{DC} = 16 A (I_{F(AV)} = 8 A), I_(PK)/I_(AV) = 20, Input Voltage = 10 V_(rms), R_{θJA} = 5°C/W.

Step 1. Find V_{R(equiv)}. Read F = 0.65 from Table 1,
∴ V_{R(equiv)} = (1.41) (10) (0.65) = 9.18 V.

Step 2. Find T_R from Figure 3. Read T_R = 113°C
@ V_R = 9.18 V and R_{θJA} = 5°C/W.

Step 3. Find P_{F(AV)} from Figure 4. **Read P_{F(AV)} = 12.8 W
@ $\frac{I_{(PK)}}{I_{(AV)}} = 20$ and I_{F(AV)} = 8 A

Step 4. Find T_A(max) from equation (3).
T_A(max) = 113 · (5) (12.8) = 49°C.

**Values given are for the 1N5828. Power is slightly lower for the other units because of their lower forward voltage.

Table 1. Values for Factor F

Circuit Load	Half Wave		Full Wave, Bridge		Full Wave, Center Tapped††	
	Resistive	Capacitive†	Resistive	Capacitive	Resistive	Capacitive
Sine Wave	0.5	1.3	0.5	0.65	1.0	1.3
Square Wave	0.75	1.5	0.75	0.75	1.5	1.5

†Note that V_{R(PK)} ≈ 2.0 V_{in(PK)}. ††Use line to center tap voltage for V_{in}.

1N5829 1N5830 1N5831

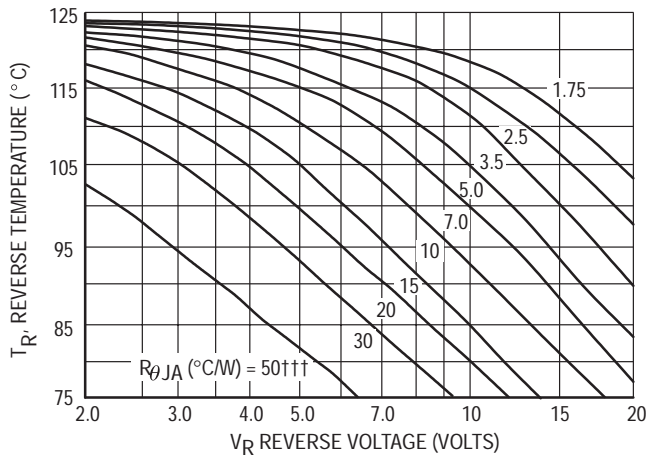


Figure 1. Maximum Reference Temperature – 1N5829

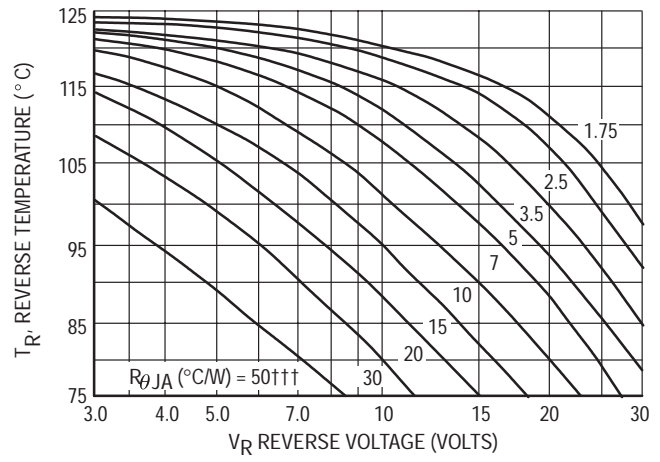


Figure 2. Maximum Reference Temperature – 1N5830

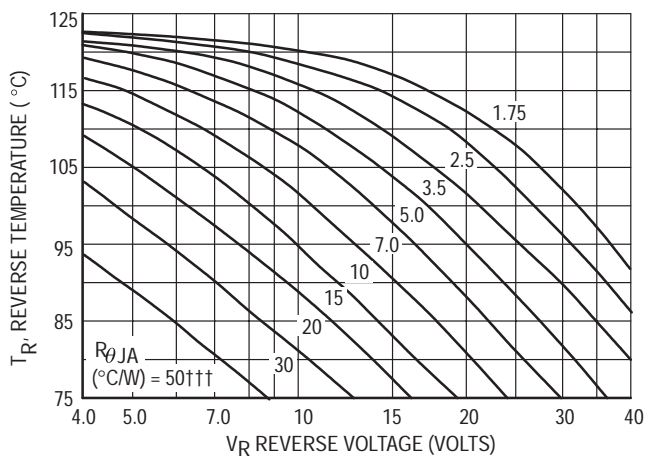


Figure 3. Maximum Reference Temperature – 1N5831

††† NO EXTERNAL HEAT SINK

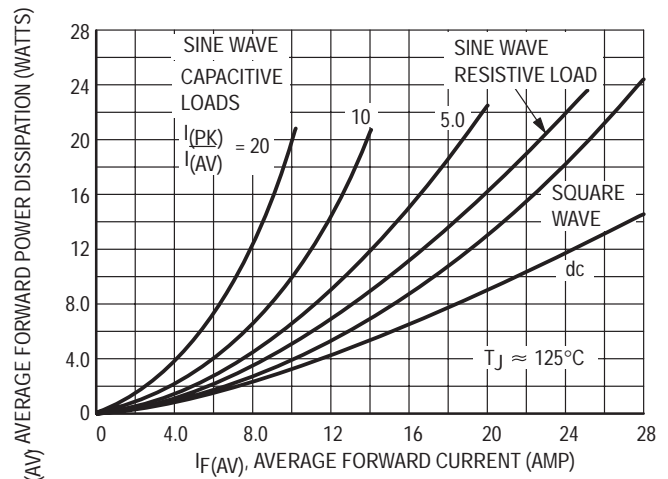


Figure 4. Forward Power Dissipation

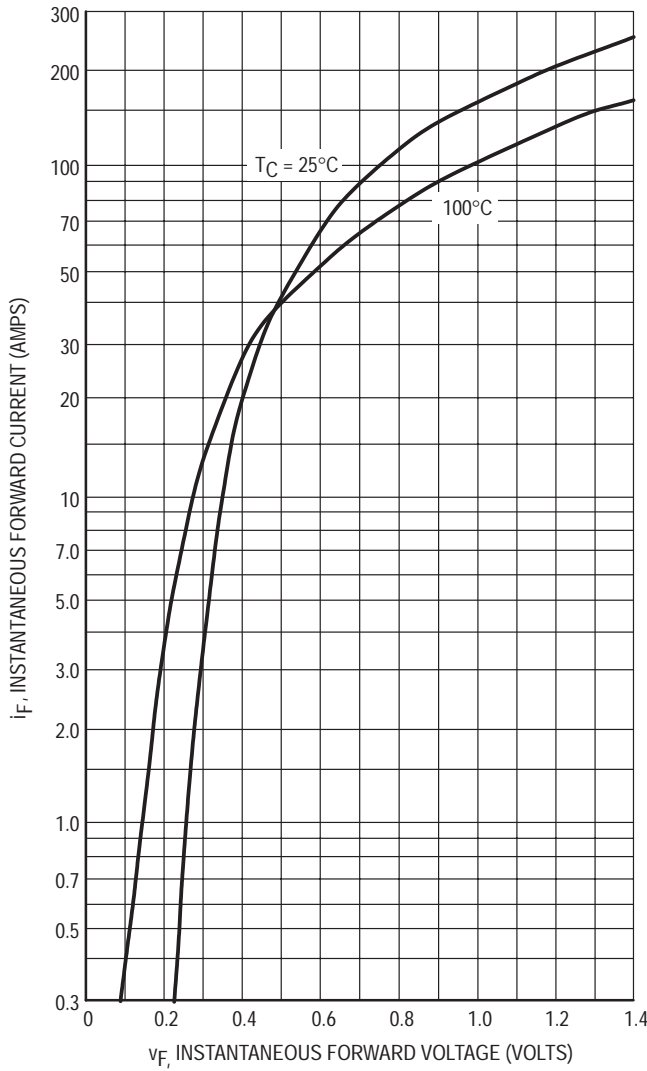


Figure 5. Typical Forward Voltage

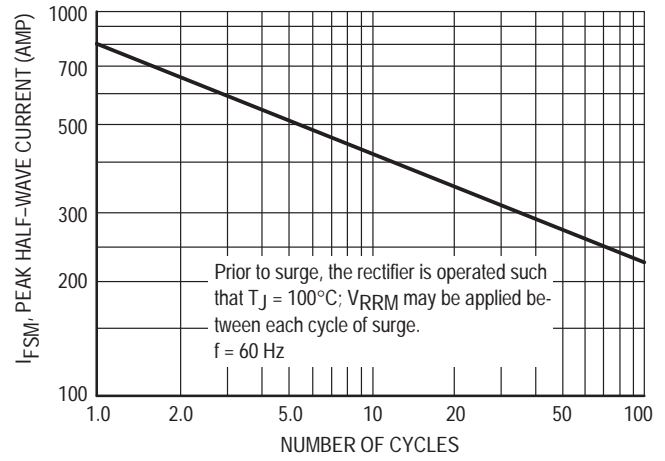


Figure 6. Maximum Surge Capability

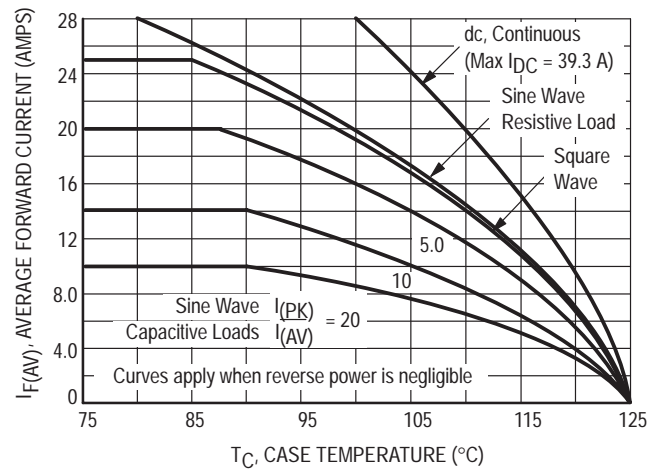


Figure 7. Current Derating

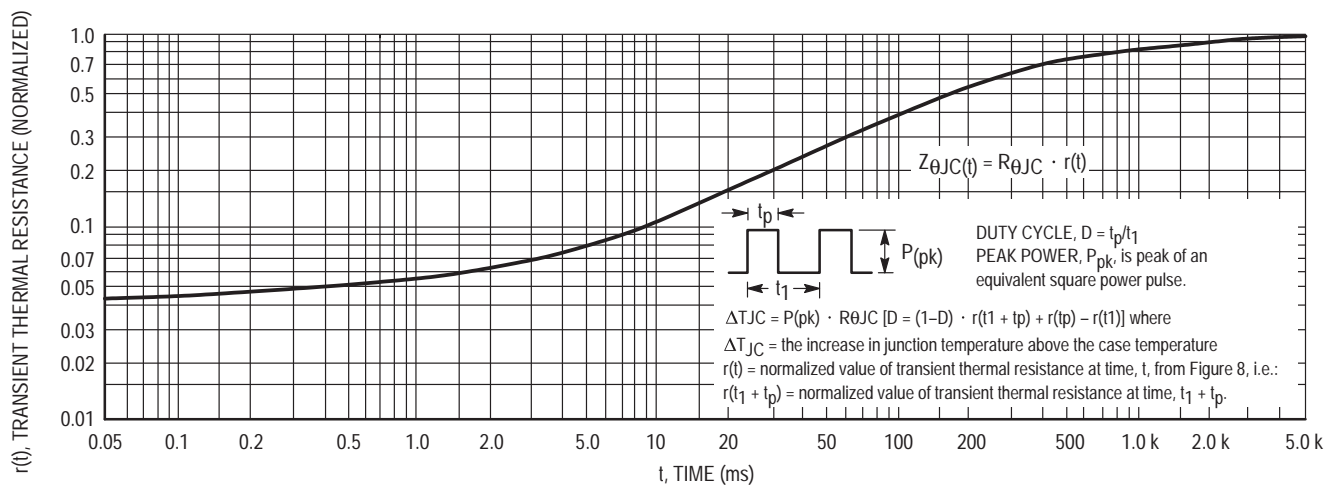


Figure 8. Thermal Response

1N5829 1N5830 1N5831

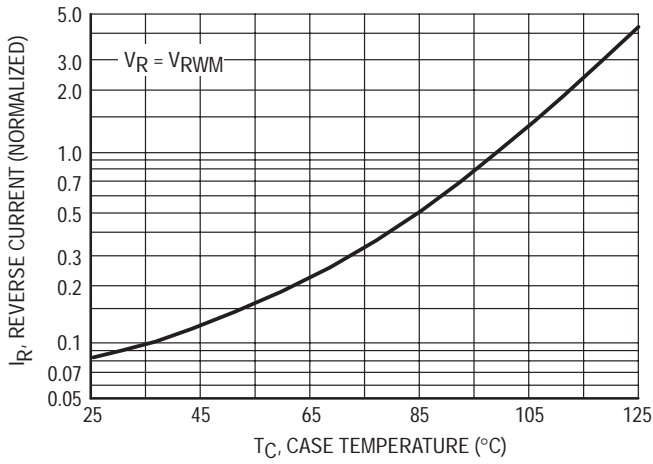


Figure 9. Normalized Reverse Current

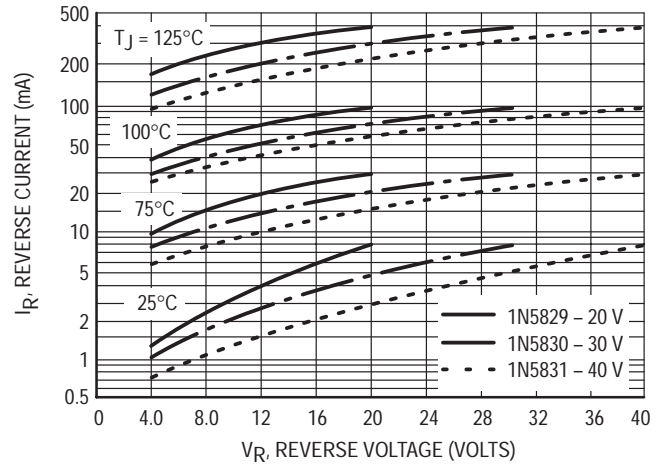


Figure 10. Typical Reverse Current

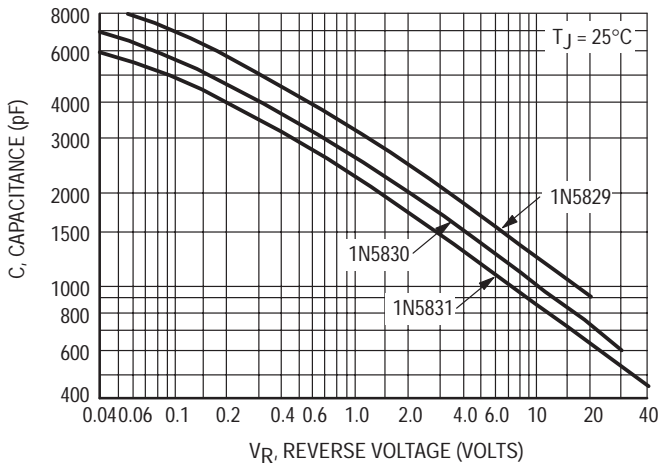


Figure 11. Capacitance

NOTE 2 — HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 11.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

SWITCHMODE™ Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature Capability
- Guaranteed Reverse Avalanche
- Mounting Torque: 15 in-lb max

Mechanical Characteristics:

- Case: Welded steel, hermetically sealed
- Weight: 45.6 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Solder Heat: The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.
- Stud Torque: 15 lb-in max
- Shipped 25 units per rail
- Marking: 1N6095, 1N6096, SD41

1N6095
1N6096
SD41

1N6096 and SD41 are
Motorola Preferred Devices

**SCHOTTKY BARRIER
RECTIFIERS**
25 and 30 AMPERES
30 to 45 VOLTS



CASE 56-03
DO-203AA
METAL

MAXIMUM RATINGS

Rating	Symbol	1N6095*	1N6096*	SD41	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	30	40	45 35 45	Volts
Average Rectified Forward Current (Rated V_R)	I_O	25 $T_C = 70^\circ C$	25 $T_C = 70^\circ C$	30 $T_C = 105^\circ C$	Amps
Case Temperature (Rated V_R)	T_C	105	105	—	°C
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I_{FSM}	400	400	600	Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz) See Figure 10. (1)	I_{RRM}	2.0	2.0	2.0	Amps
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-65 to +125	-65 to +125	-55 to +150°C	°C
Peak Operating Junction Temperature (Forward Current applied)	$T_{J(pk)}$	150	150	150	°C
Voltage Rate of Change (Rated V_R)	dv/dt	10000	10000	10000	V/ μs

THERMAL CHARACTERISTICS

Characteristic	Symbol	1N6095*	1N6096*	SD41	Unit
Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	←————— 2.0 —————→			°C/W

* Indicates JEDEC Registered Data
(1) Not JEDEC requirement, but a Motorola product capability.
(2) Pulse Test: Pulse Width = 300 μs , Duty Cycle \leq 2.0%.

Preferred devices are Motorola recommended choices for future use and best overall value.

1N6095 1N6096 SD41**ELECTRICAL CHARACTERISTICS**

Characteristic	Symbol	1N6095*	1N6096*	SD41	Unit
Maximum Instantaneous Forward Voltage (2) ($i_F = 30$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 78.5$ Amps, $T_C = 70^\circ\text{C}$)	V_F	— 0.86	— 0.86	0.55 —	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_C = 125^\circ\text{C}$)	i_R	250	250	125 @ $V_R = 35$ V	mA
Capacitance (100 kHz $\geq f \geq 1.0$ MHz)	C_t	6000 $V_R = 1.0$ V	6000 $V_R = 1.0$ V	2000 $V_R = 5.0$ V	pF

* Indicates JEDEC Registered Data

(1) Not JEDEC requirement, but a Motorola product capability.

(2) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

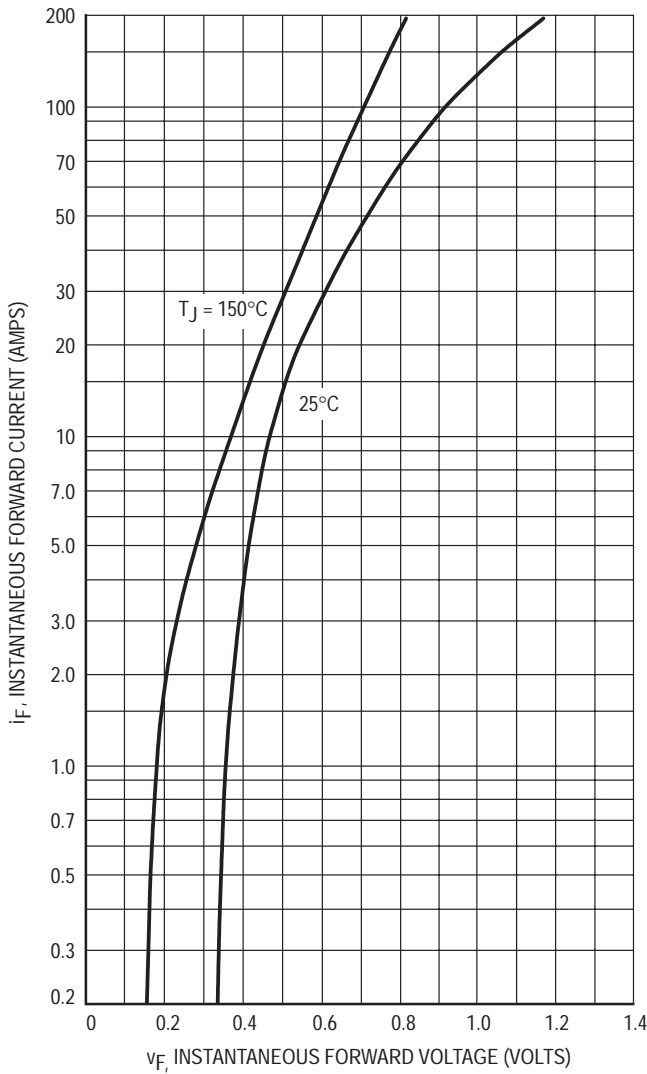


Figure 1. Typical Forward Voltage

HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 4.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

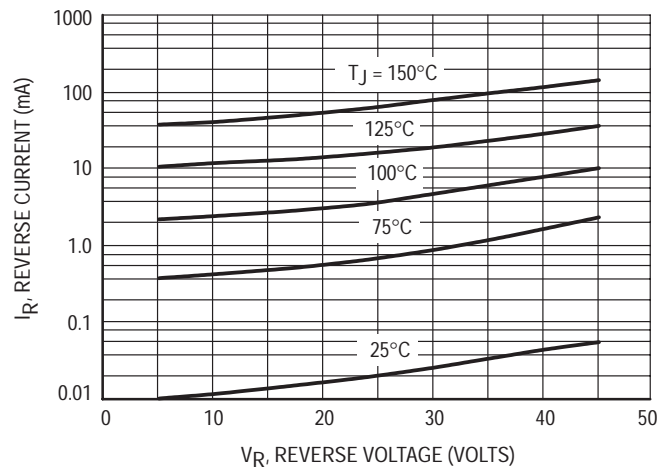


Figure 2. Typical Reverse Current

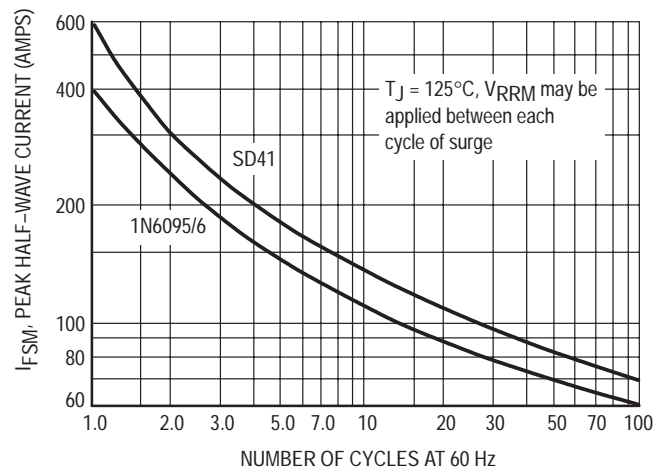


Figure 3. Maximum Surge Capability

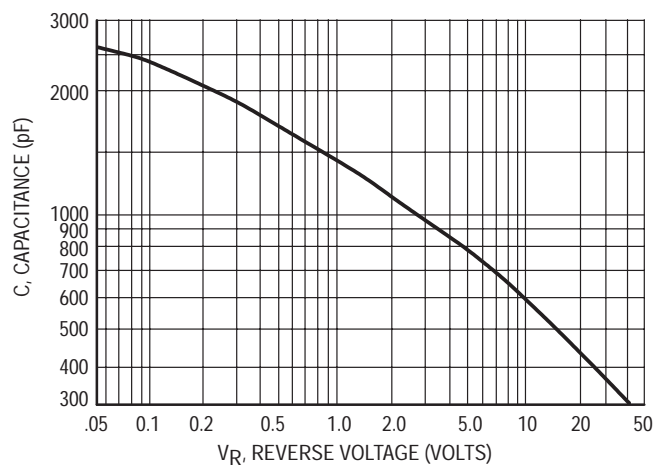


Figure 4. Capacitance

1N6095 1N6096 SD41

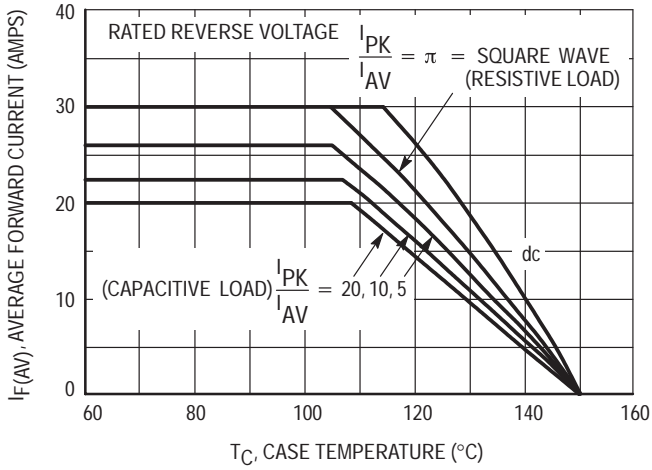


Figure 5. SD41 Current Derating

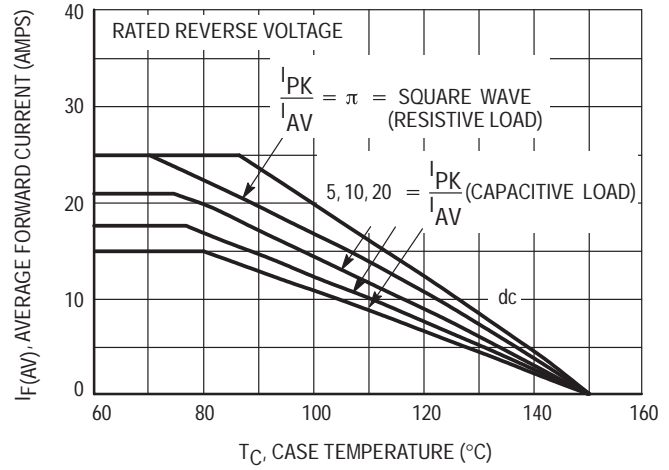


Figure 6. 1N6095/6 Current Derating

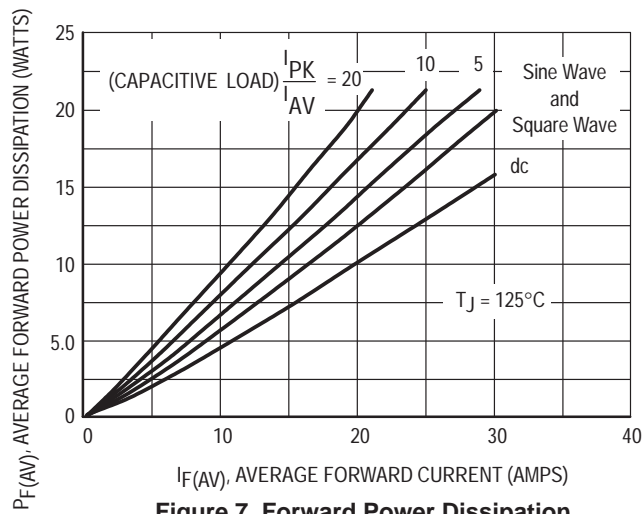


Figure 7. Forward Power Dissipation

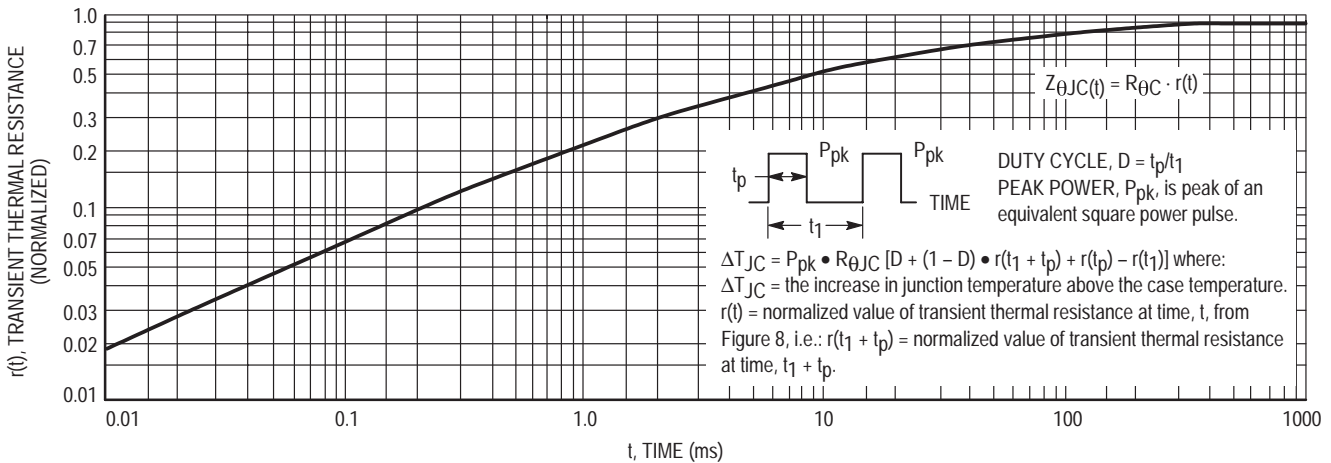


Figure 8. Thermal Response

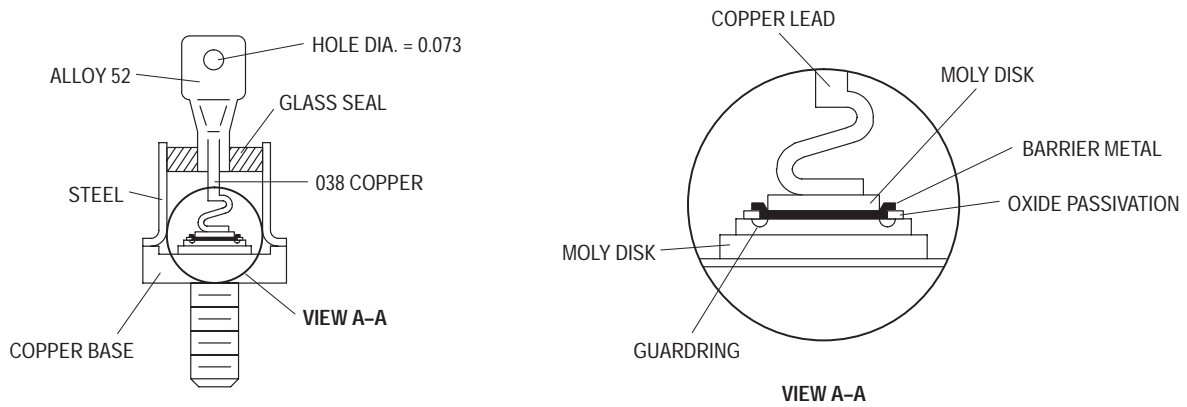


Figure 9. Schottky Rectifier

Motorola builds quality and reliability into its Schottky Rectifiers. First is the chip, which has an interface metal between the platinum-barrier metal and nickel-gold ohmic-contact metal to eliminate any possible interaction with the barrier. The indicated guarding prevents dv/dt problems, so snubbers are not required. The guarding also operates like a zener to absorb over-voltage transients. Second is the package. There are molybdenum disks which closely match the thermal coefficient of expansion of silicon on each side of the chip. The top copper lead is also stress relieved.

These two features give the unit the capability of passing stringent thermal fatigue tests for 5,000 cycles. The top copper lead provides a low resistance to current and therefore does not contribute to device heating; a heat sink should be used when attaching wires. Third is the redundant electrical testing. The device is tested before assembly in "sandwich" form, with the chip between the moly disks. It is tested again after assembly. As part of the final electrical test, devices are 100% tested for dv/dt at 1,600 V/μs and reverse avalanche.

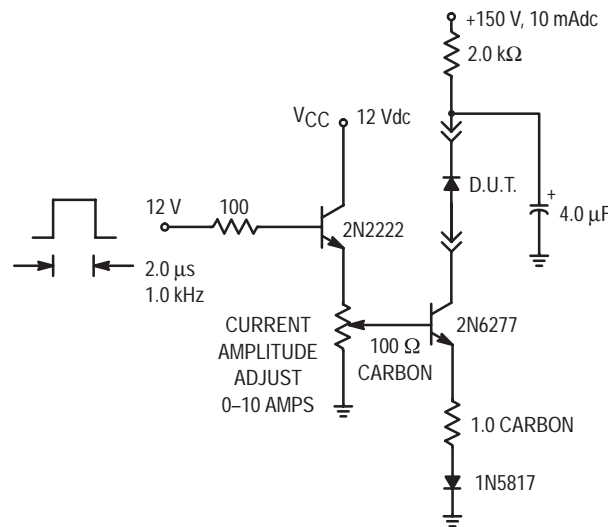


Figure 10. Test Circuit for dv/dt and Reverse Surge Current

SWITCHMODE™ Power Rectifiers

... using a platinum barrier metal in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free-wheeling diodes, and polarity-protection diodes.

- Guardring for dv/dt Stress Protection
- Guaranteed Reverse Surge Current/Avalanche
- 150°C Operating Junction Temperature
- Mounting Torque: 15 in-lb max


Mechanical Characteristics:

- Case: Welded steel, hermetically sealed
- Weight: 45.6 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Solder Heat: The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.
- Stud Torque: 15 lb-in max
- Shipped 25 units per rail
- Marking: B3520, B3535, B3545

MBR3520
MBR3535
MBR3545

MBR3545 is a
Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIERS**
35 AMPERES
20 to 45 VOLTS



CASE 56-03
DO-203AA
METAL

MAXIMUM RATINGS

Rating	Symbol	MBR3520	MBR3535	MBR3545	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	20	35	45	Volts
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz, $T_C = 110^\circ\text{C}$)	I_{FRM}	← 70 →			Amps
Average Rectified Forward Current (Rated V_R , $T_C = 110^\circ\text{C}$)	$I_{F(AV)}$	← 35 →			Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz) See Figure 8	I_{RRM}	← 2.0 →			Amps
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I_{FSM}	← 600 →			Amps
Operating Junction Temperature	T_J	← -65 to +150 →			$^\circ\text{C}$
Storage Temperature	T_{stg}	← -65 to +175 →			$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	← 10000 →			V/ μs

THERMAL CHARACTERISTICS

Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.3	1.5	$^\circ\text{C/W}$

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle = 2.0%.

Preferred devices are Motorola recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS PER DIODE

Characteristic	Symbol	Typ	Max	Unit
Instantaneous Forward Voltage (1) ($i_F = 35$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 35$ Amps, $T_C = 25^\circ\text{C}$) ($i_F = 70$ Amps, $T_C = 125^\circ\text{C}$)	v_F	0.49 0.55 0.60	0.55 0.63 0.69	Volts
Instantaneous Reverse Current (1) (Rated Voltage, $T_C = 125^\circ\text{C}$) (Rated Voltage, $T_C = 25^\circ\text{C}$)	i_R	60 0.1	100 0.3	mA
Capacitance ($V_R = 1.0$ Vdc, $100\text{ kHz} > f > 1.0\text{ MHz}$, $T_C = 25^\circ\text{C}$)	C_t	3000	3700	pF

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle = 2.0%.

MBR3520 MBR3535 MBR3545

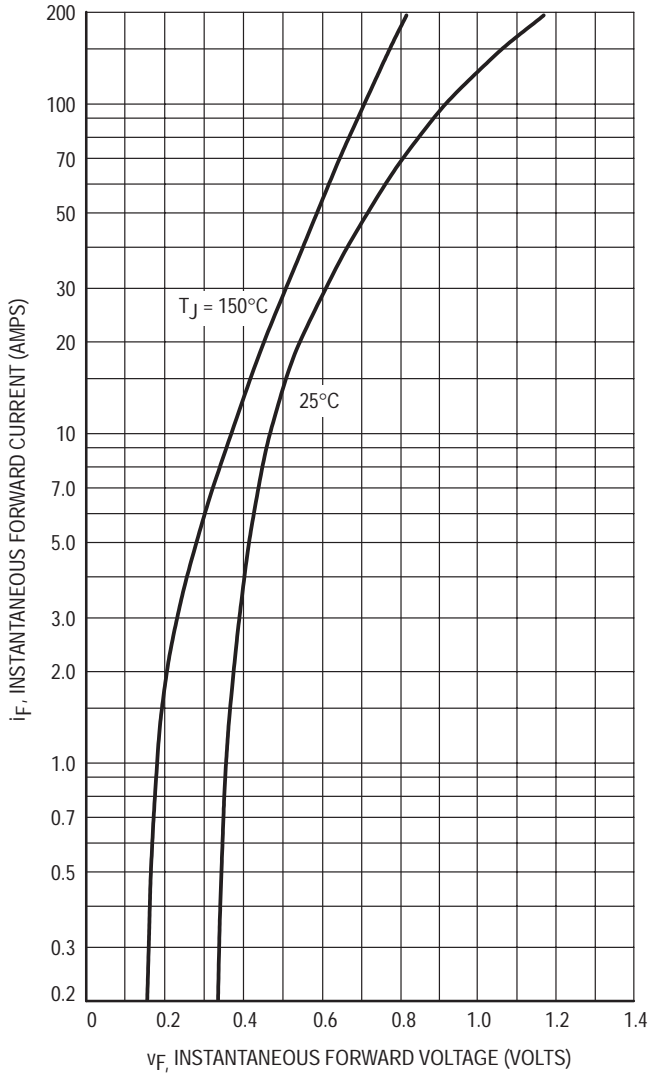


Figure 1. Maximum Forward Voltage

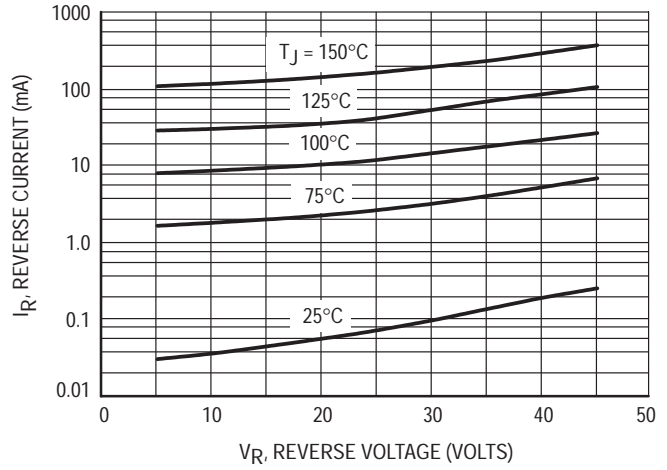


Figure 2. Maximum Reverse Current

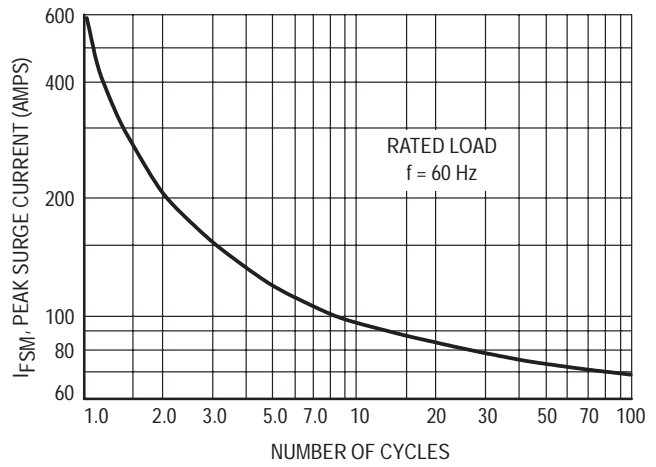


Figure 3. Maximum Surge Capability

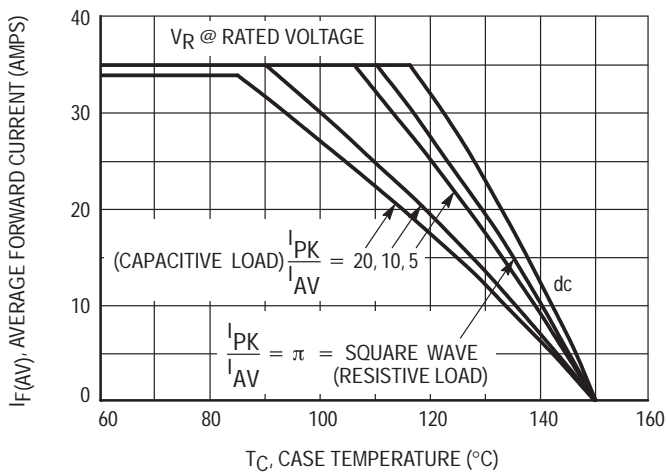


Figure 4. Current Derating

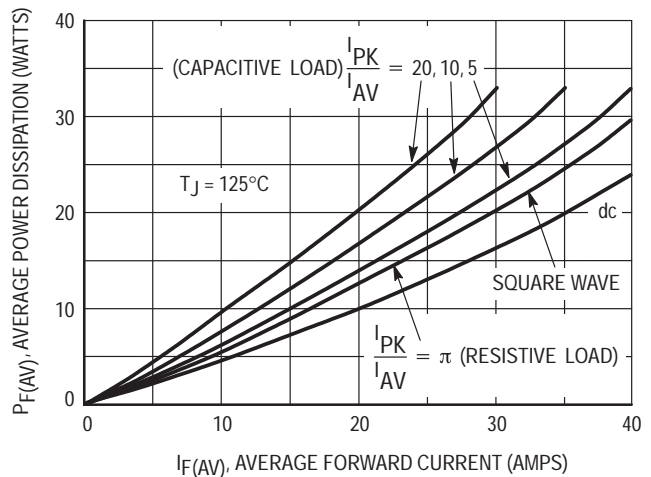


Figure 5. Power Dissipation

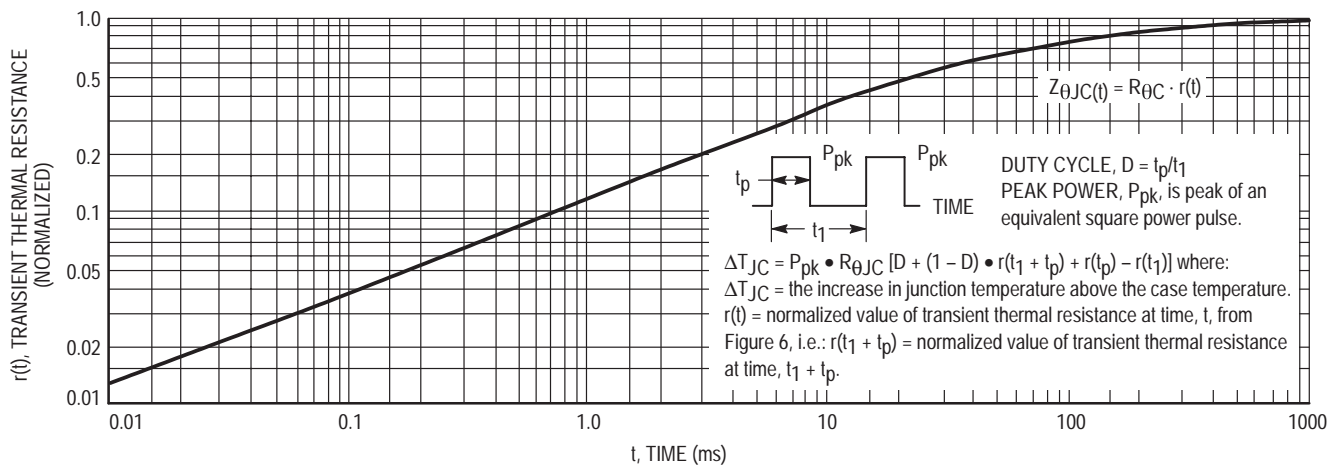


Figure 6. Thermal Response

HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 7.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

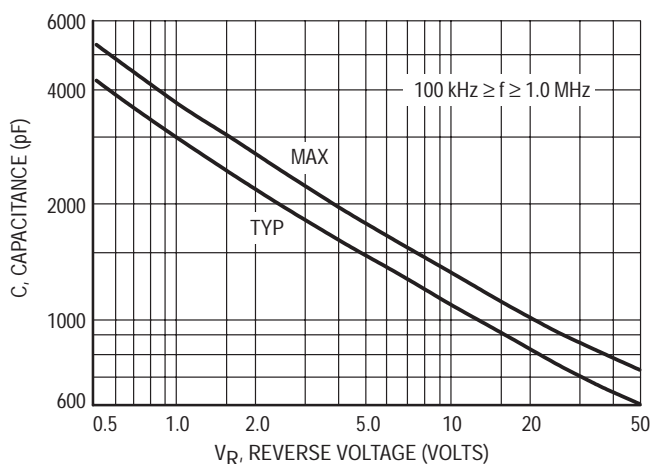


Figure 7. Capacitance

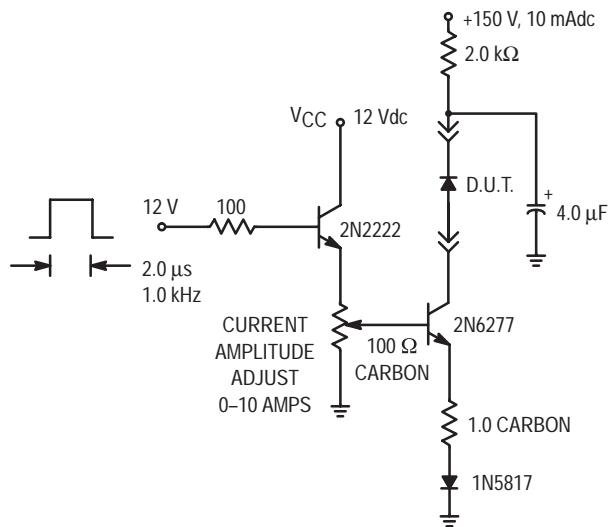


Figure 8. Test Circuit for dv/dt and Reverse Surge Current

MBR3520 MBR3535 MBR3545

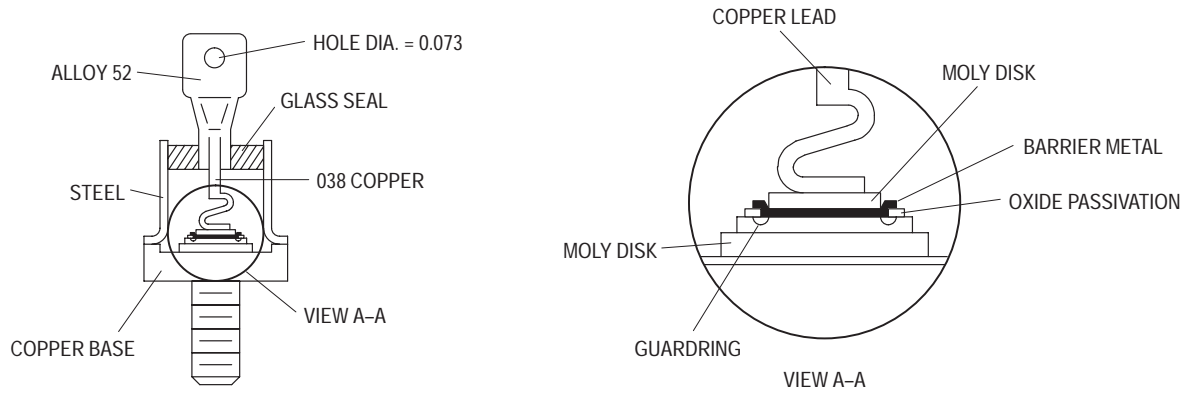


Figure 9. Schottky Rectifier

Motorola builds quality and reliability into its Schottky Rectifiers.

First is the chip, which has an interface metal between the platinum-barrier metal and nickel-gold ohmic-contact metal to eliminate any possible interaction with the barrier. The indicated guardring prevents dv/dt problems, so snubbers are not mandatory. The guardring also operates like a zener to absorb over-voltage transients.

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Designer's™ Data Sheet

SWITCHMODE™ Power Rectifiers

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features chrome barrier metal, epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Extremely Low v_f
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency
- High Surge Capacity

Mechanical Characteristics:

- Case: Welded steel, hermetically sealed
- Weight: 17 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Solder Heat: The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.
- Stud Torque: 25 lb-in max
- Shipped 25 units per rail
- Marking: 1N5832, 1N5833, 1N5834

1N5832
1N5833
1N5834

1N5832 and 1N5834 are
Motorola Preferred Devices

**SCHOTTKY BARRIER
RECTIFIERS**
40 AMPERES
20, 30, 40 VOLTS



CASE 257-01
DO-203AB
METAL

*MAXIMUM RATINGS

Rating	Symbol	1N5832	1N5833	1N5834	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWV} V_R	20	30	40	Volts
Non-Repetitive Peak Reverse Voltage	V_{RSM}	24	36	48	Volts
Average Rectified Forward Current $V_{R(equiv)} \leq 0.2 V_{R(dc)}$, $T_C = 75^\circ C$	I_O	← 40 →			Amps
Ambient Temperature Rated $V_{R(dc)}$, $PF(AV) = 0$, $R_{\theta JA} = 2.0^\circ C/W$	T_A	100	95	90	$^\circ C$
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I_{FSM}	← 800 (for one cycle) →			Amps
Operating and Storage Junction Temperature Range (Reverse Voltage applied)	T_J, T_{stg}	← -65 to +125 →			$^\circ C$
Peak Operating Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	← 150 →			$^\circ C$

*THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.0	$^\circ C/W$

* Indicates JEDEC Registered Data

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle = 2.0%.

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

1N5832 1N5833 1N5834

*ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	1N5832	1N5833	1N5834	Unit
Maximum Instantaneous Forward Voltage (1) ($i_F = 10$ Amps) ($i_F = 40$ Amps) ($i_F = 125$ Amps)	V_F	0.360 0.520 0.980	0.370 0.550 1.080	0.380 0.590 1.180	Volts
Maximum Instantaneous Reverse Current @ rated dc Voltage (1) $T_C = 100^\circ\text{C}$	i_R	20 150	20 150	20 150	mA

* Indicates JEDEC Registered Data

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle = 2.0%.

NOTE 1 — DETERMINING MAXIMUM RATINGS

Reverse power dissipation and the possibility of thermal runaway must be considered when operating this rectifier at reverse voltages above $0.2 V_{RWM}$. Proper derating may be accomplished by use of equation (1):

$$T_{A(max)} = T_J(max) - R_{\theta JA} P_{F(AV)} - R_{\theta JA} P_{R(AV)} \quad (1)$$

where $T_{A(max)}$ = Maximum allowable ambient temperature

$T_J(max)$ = Maximum allowable junction temperature
(125°C or the temperature at which thermal runaway occurs, whichever is lowest)

$P_{F(AV)}$ = Average forward power dissipation

$P_{R(AV)}$ = Average reverse power dissipation

$R_{\theta JA}$ = Junction-to-ambient thermal resistance

Figures 1, 2, and 3 permit easier use of equation (1) by taking reverse power dissipation and thermal runaway into consideration. The figures solve for a reference temperature as determined by equation (2):

$$T_R = T_J(max) - R_{\theta JA} P_{R(AV)} \quad (2)$$

Substituting equation (2) into equation (1) yields:

$$T_{A(max)} = T_R - R_{\theta JA} P_{F(AV)} \quad (3)$$

Inspection of equations (2) and (3) reveals that T_R is the ambient temperature at which thermal runaway occurs or where $T_J = 125^\circ\text{C}$, when forward power is zero. The transition from one boundary condition to the other is evident on the curves of Figures 1, 2, and 3 as a

difference in the rate of change of the slope in the vicinity of 115°C . The data of Figures 1, 2, and 3 is based upon dc conditions. For use in common rectifier circuits, Table 1 indicates suggested factors for an equivalent dc voltage to use for conservative design, i.e.:

$$V_{R(equiv)} = V_{in(PK)} \times F \quad (4)$$

The Factor F is derived by considering the properties of the various rectifier circuits and the reverse characteristics of Schottky diodes.

EXAMPLE: Find $T_{A(max)}$ for 1N5834 operated in a 12-volt dc supply using a bridge circuit with capacitive filter such that $I_{DC} = 30$ A ($I_{F(AV)} = 15$ A), $I_{(PK)}/I_{(AV)} = 10$, Input Voltage = 10 V(rms), $R_{\theta JA} = 3^\circ\text{C/W}$.

Step 1. Find $V_{R(equiv)}$. Read $F = 0.65$ from Table 1,
 $\therefore V_{R(equiv)} = (10)(1.41)(0.65) = 9.18$ V.

Step 2. Find T_R from Figure 3. Read $T_R = 118^\circ\text{C}$
@ $V_R = 9.18$ V and $R_{\theta JA} = 3^\circ\text{C/W}$.

Step 3. Find $P_{F(AV)}$ from Figure 4. †Read $P_{F(AV)} = 20$ W

$$\text{@ } \frac{I_{(PK)}}{I_{(AV)}} = 10 \text{ and } I_{F(AV)} = 15 \text{ A}$$

Step 4. Find $T_{A(max)}$ from equation (3).
 $T_{A(max)} = 118 - (3)(20) = 58^\circ\text{C}$.

†Values given are for the 1N5834. Power is slightly lower for the other units because of their lower forward voltage.

Table 1. Values for Factor F

Circuit Load	Half Wave		Full Wave, Bridge		Full Wave, Center Tapped (1), (2)	
	Resistive	Capacitive (1)	Resistive	Capacitive	Resistive	Capacitive
Sine Wave	0.5	1.3	0.5	0.65	1.0	1.3
Square Wave	0.75	1.5	0.75	0.75	1.5	1.5

(1) Note that $V_{R(PK)} \approx 2.0 V_{in(PK)}$.

(2) Use line to center tap voltage for V_{in} .

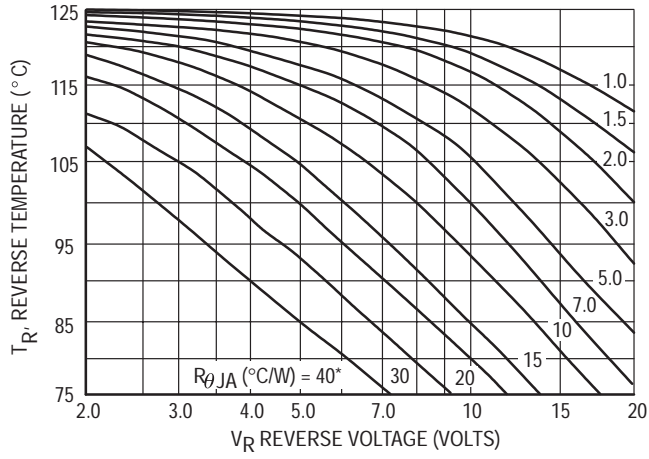


Figure 1. Maximum Reference Temperature – 1N5832

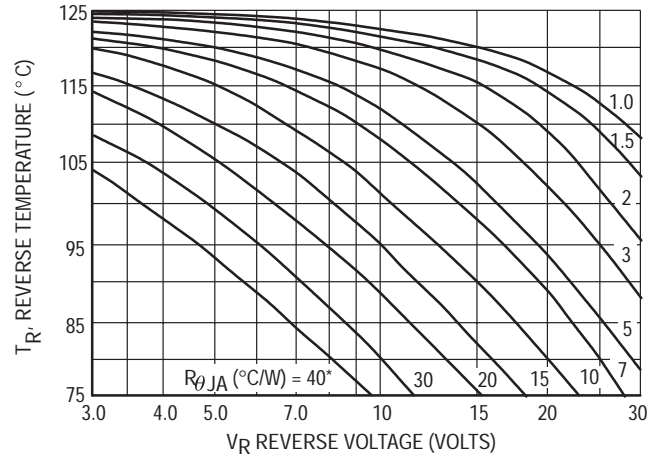


Figure 2. Maximum Reference Temperature – 1N5833

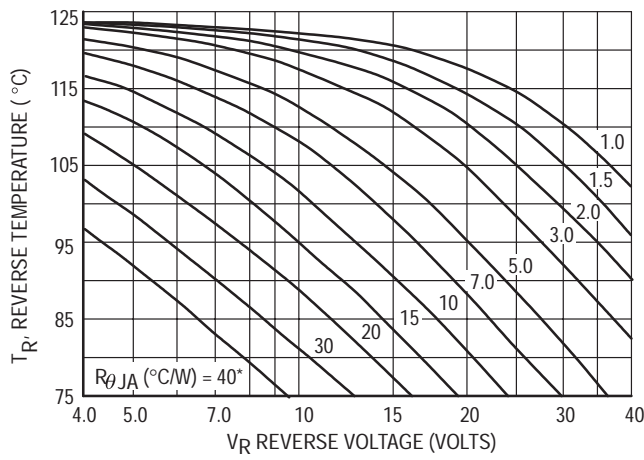


Figure 3. Maximum Reference Temperature – 1N5834

* NO EXTERNAL HEAT SINK

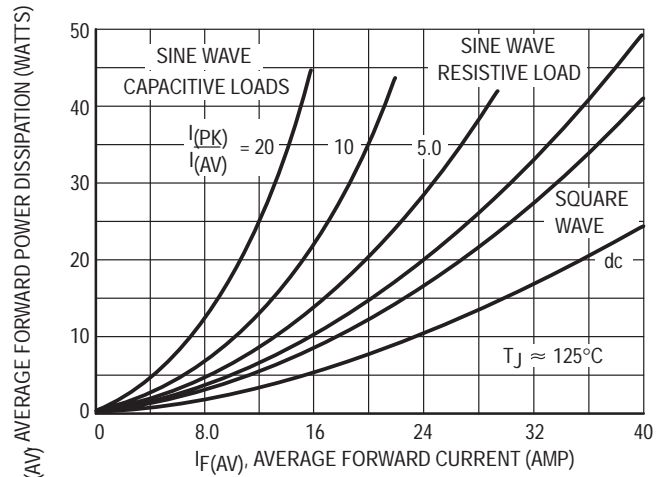


Figure 4. Forward Power Dissipation

1N5832 1N5833 1N5834

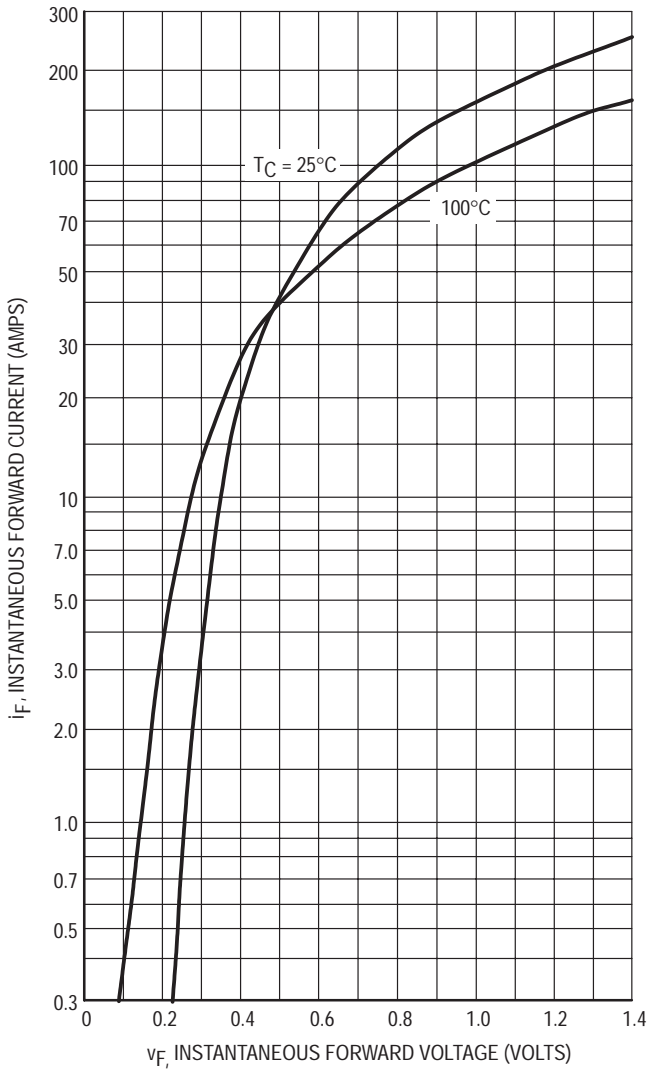


Figure 5. Typical Forward Voltage

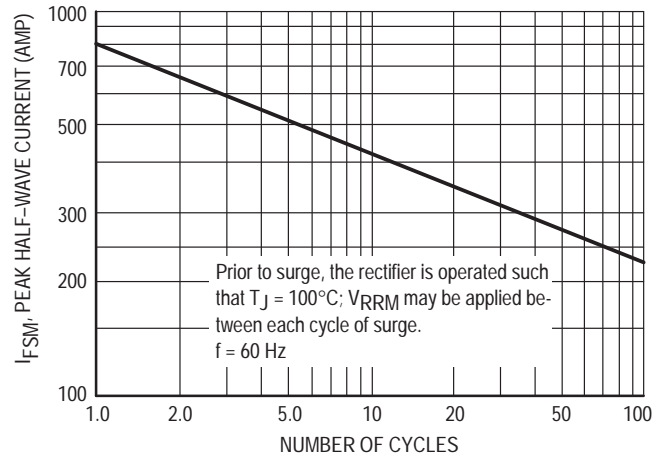


Figure 6. Maximum Surge Capability

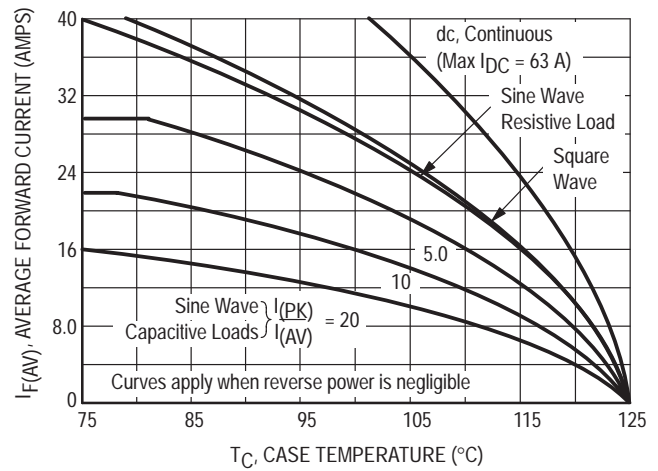


Figure 7. Current Derating

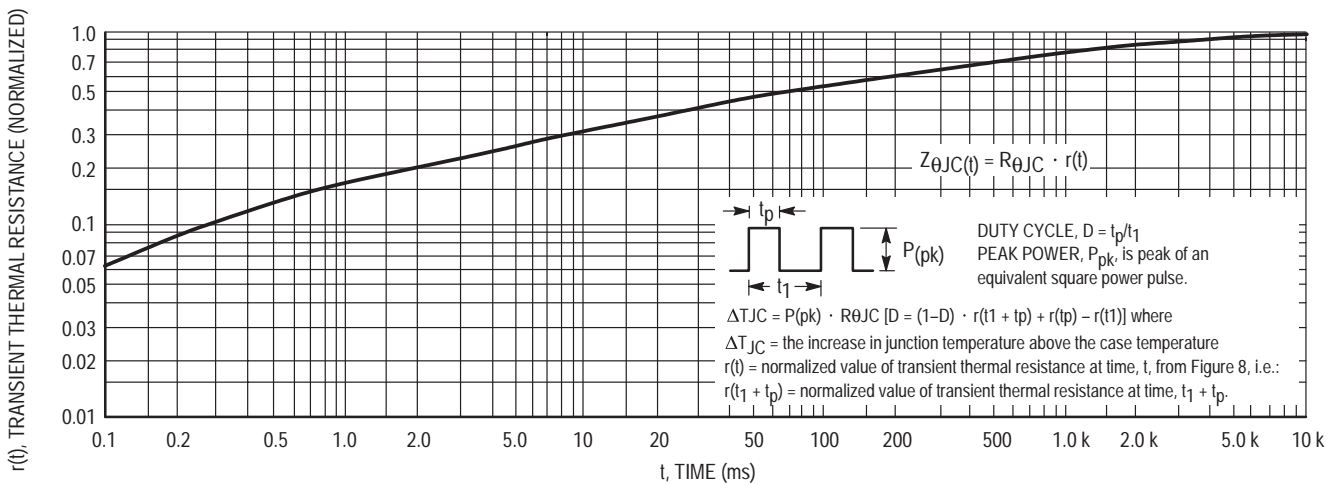


Figure 8. Thermal Response

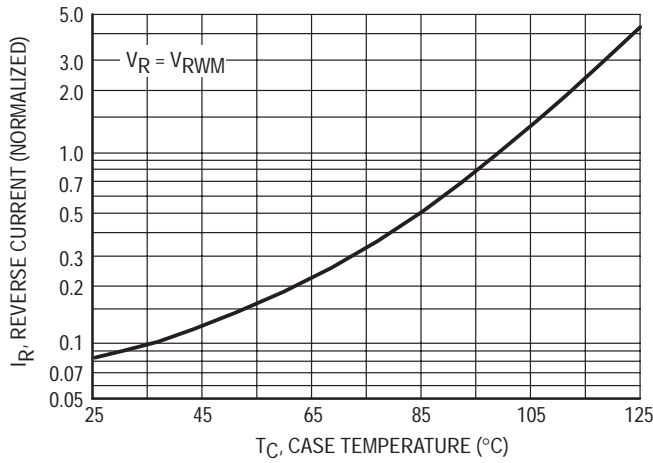


Figure 9. Normalized Reverse Current

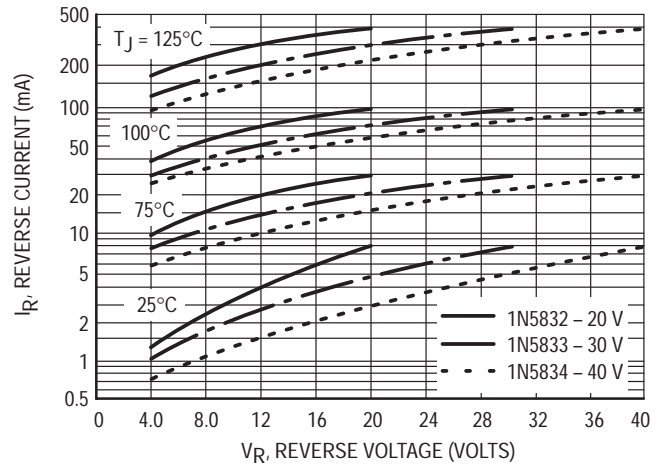


Figure 10. Typical Reverse Current

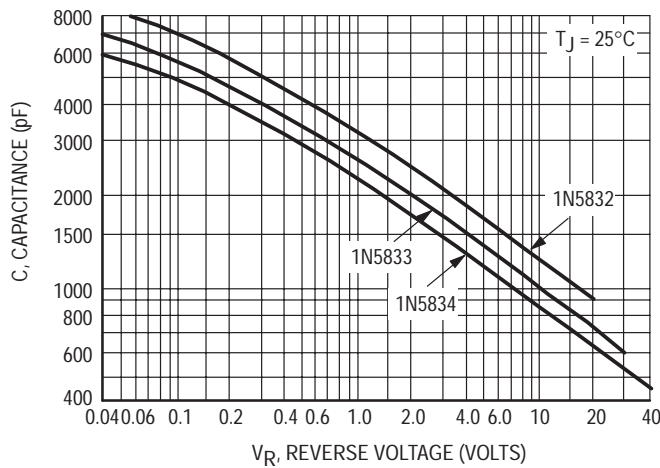


Figure 11. Capacitance

NOTE 2 — HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 11.)

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NOTE 3 — SOLDER HEAT

The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.

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- Guaranteed Reverse Avalanche
- Extremely Low v_f
- Low Stored Charge, Majority Carrier Conduction
- Guardring for Stress Protection
- Low Power Loss/High Efficiency
- 150°C Operating Junction Temperature Capability
- High Surge Capacity


Mechanical Characteristics:

- Case: Welded steel, hermetically sealed
- Weight: 17 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Solder Heat: The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.
- Stud Torque: 25 lb-in max
- Shipped 25 units per rail
- Marking: 1N6097, 1N6098, SD51

1N6097
1N6098
SD51

1N6098 and SD51 are
Motorola Preferred Devices

**SCHOTTKY BARRIER
RECTIFIERS**
60 AMPERES
20 to 45 VOLTS



CASE 257-01
DO-203AB
METAL

MAXIMUM RATINGS

Rating	Symbol	1N6097*	1N6098*	SD51	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	30	40	45 35 45	Volts
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz)	I_{FRM}	—	—	120 $T_C = 90^\circ\text{C}$	Amps
Average Rectified Forward Current (Rated V_R)	I_O	50 $T_C = 70^\circ\text{C}$	50 $T_C = 70^\circ\text{C}$	—	Amps
Case Temperature (Rated V_R)	T_C	115	115	—	°C
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I_{FSM}	← 800 →			Amps
Peak Repetitive Reverse Surge Current (2) (2.0 μs , 1.0 kHz) See Figure 10.	I_{RRM}	← 2.0 →			Amps
Operating Junction Temperature Range (Reverse Voltage applied)	T_J	-65 to +125	-65 to +125	-65 to +150	°C
Storage Temperature Range	T_{stg}	-65 to +125	-65 to +125	-65 to +165	°C
Voltage Rate of Change (Rated V_R)	dv/dt	10000	10000	10000	V/ μs

* Indicates JEDEC Registered Data

(1) Not a JEDEC requirement, but of Motorola product capability.

(2) Pulse Test: Pulse Width = 300 μs , Duty Cycle = 2.0%.

Preferred devices are Motorola recommended choices for future use and best overall value.

THERMAL CHARACTERISTICS

Characteristic	Symbol	1N6097*	1N6098*	SD51	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	← 1.0 →			°C/W

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	1N6097*	1N6098*	SD51	Unit
Maximum Instantaneous Forward Voltage (2) ($i_F = 157$ Amps, $T_C = 70^\circ\text{C}$) ($i_F = 60$ Amps) ($i_F = 60$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 120$ Amps, $T_C = 125^\circ\text{C}$)	V_F	0.86 — — —	0.86 — — —	— 0.70 0.60 0.84	Volts
Maximum Instantaneous Reverse Current (2) (Rated Voltage, $T_C = 125^\circ\text{C}$) (Rated Voltage, $T_C = 25^\circ\text{C}$)	i_R	250 —	250 —	200 50 @ $V_R = 35$ V	mA
DC Reverse Current (Rated Voltage, $T_C = 115^\circ\text{C}$)	i_R	250	250	—	mA
Maximum Capacitance (100 kHz $\leq f \leq 1.0$ MHz)	C_t	7000 $V_R = 1.0$ Vdc	7000 $V_R = 1.0$ Vdc	4000 $V_R = 5.0$ Vdc	pF

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1N6097 1N6098 SD51

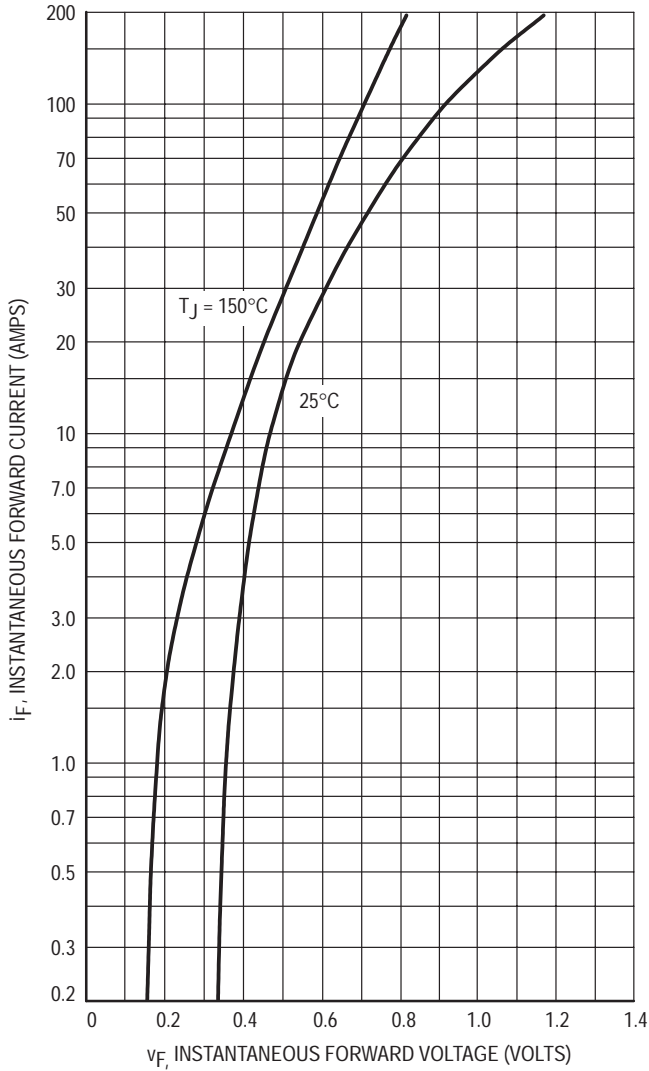


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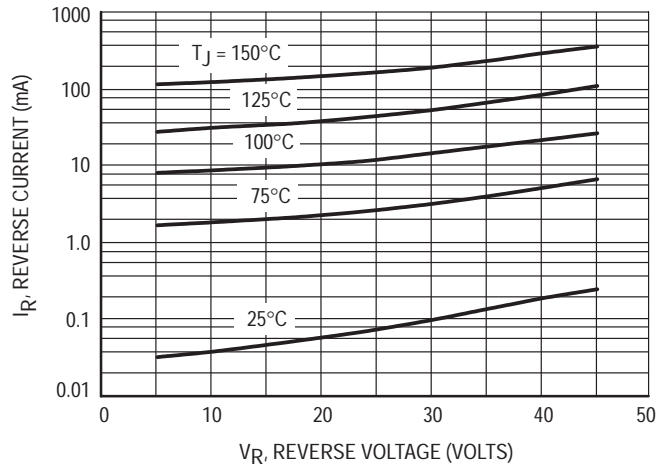


Figure 2. Typical Reverse Current

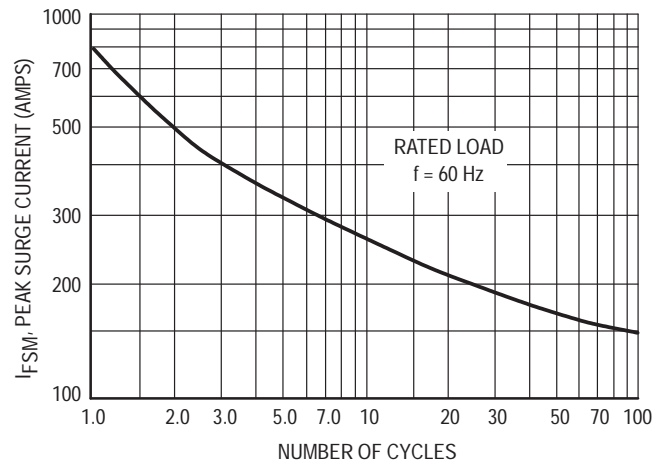


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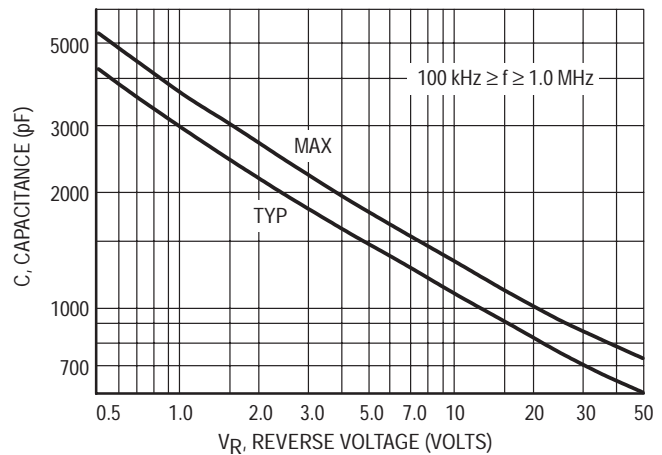


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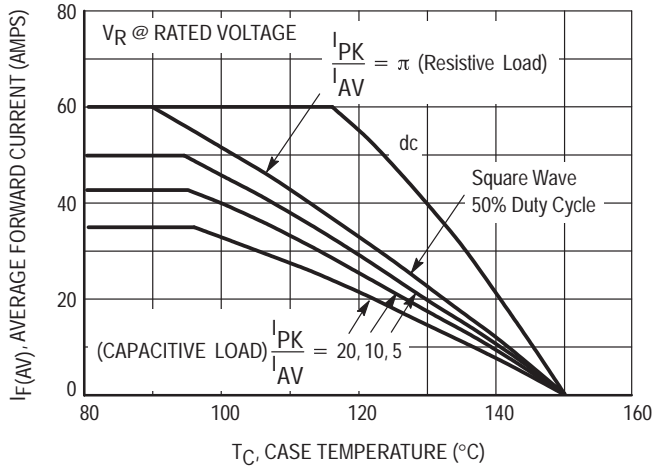


Figure 5. Current Derating (SD51)

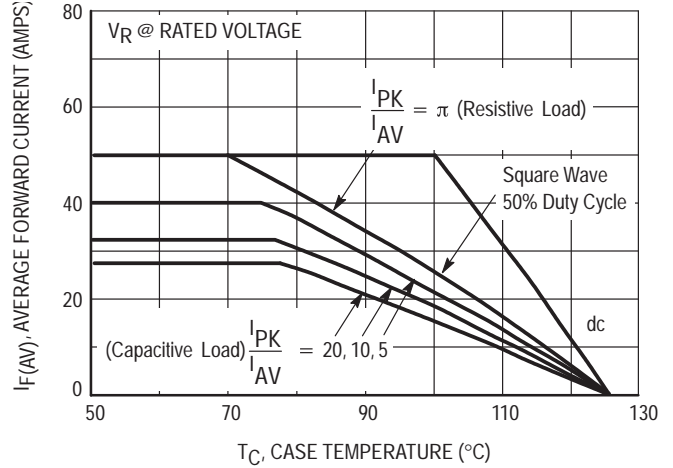


Figure 6. Current Derating (1N6097/1N6098)

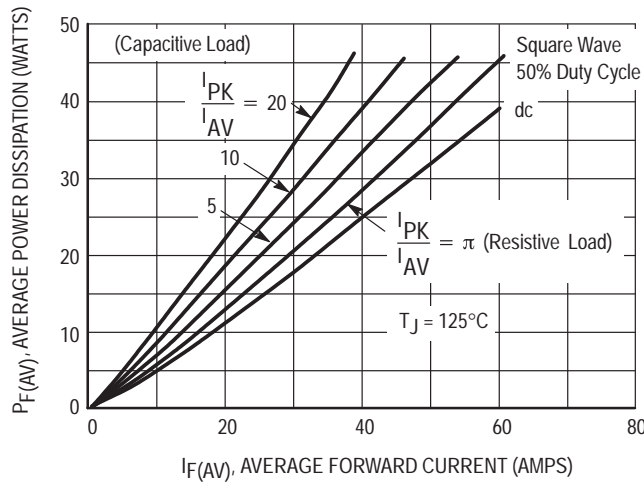
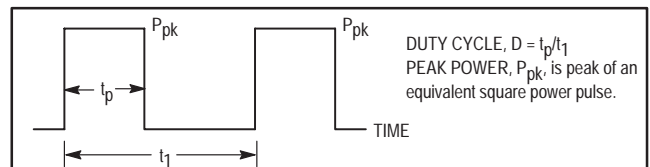


Figure 7. Power Dissipation

NOTE 2



To determine maximum junction temperature of the diode in a given situation, the following procedure is recommended:

The temperature of the case should be measured using a thermocouple placed on the case. The thermal mass connected to the case is normally large enough so that it will not significantly respond to heat surges generated in the diode as a result of pulsed operation once steady-state conditions are achieved. Using the measured value of T_C , the junction temperature may be determined by:

$$T_J = T_C + \Delta T_{JC}$$

where ΔT_{JC} is the increase in junction temperature above the case temperature, it may be determined by:

$$\Delta T_{JC} = P_{pk} \cdot R_{\theta JC} [D + (1 - D) \cdot r(t_1 + t_p) + r(t_p) - r(t_1)]$$

where $r(t)$ = normalized value of transient thermal resistance at time, t , from Figure 8, i.e.:

$r(t_1 + t_p)$ = normalized value of transient thermal resistance at time $t_1 + t_p$.

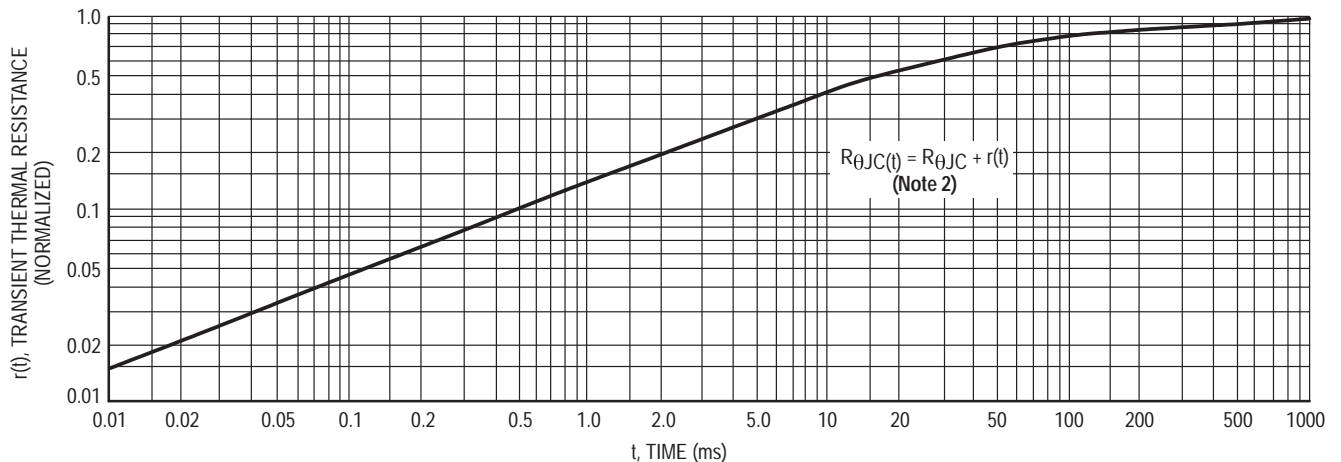


Figure 8. Thermal Response

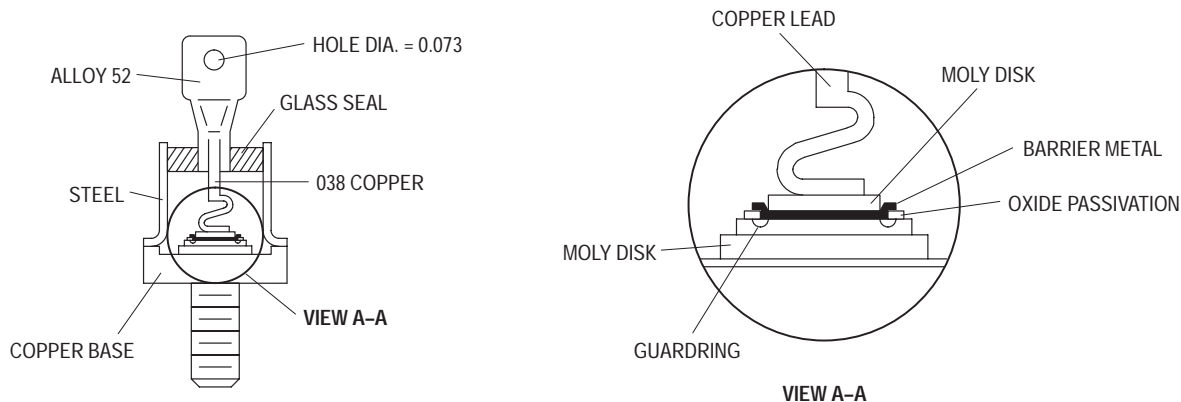


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feature which protects the die during assembly. These two features give the unit the capability of passing stringent thermal fatigue tests for 5,000 cycles. The top copper lead provides a low resistance to current and therefore does not contribute to device heating; a heat sink should be used when attaching wires.

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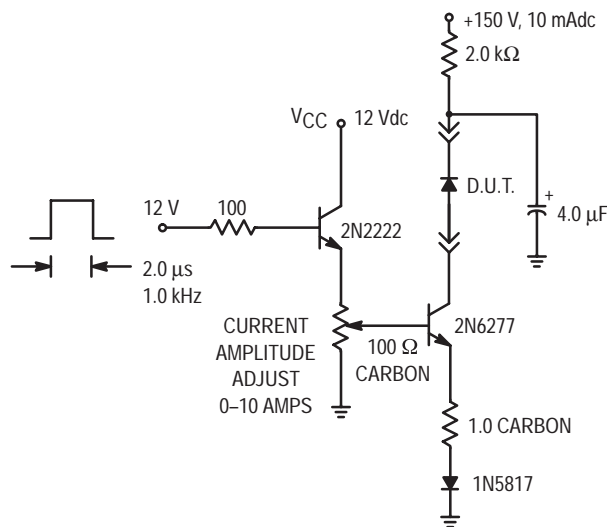


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- Guaranteed Reverse Avalanche
- Guardring for dv/dt Stress Protection
- 175°C Operating Junction Temperature
- Extremely Low Forward Voltage


Mechanical Characteristics:

- Case: Welded steel, hermetically sealed
- Weight: 17 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Solder Heat: The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.
- Stud Torque: 25 lb-in max
- Shipped 25 units per rail
- Marking: B6015L, B6020L, B6025L, B6030L

MBR6015L
MBR6020L
MBR6025L
MBR6030L

MBR6030L is a
Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIERS**
60 AMPERES
15 to 30 VOLTS



CASE 257-01
DO-203AB
METAL

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	MBR6015L MBR6020L MBR6025L MBR6030L	V _R RM V _R W V _R	15 20 25 30 Volts
Peak Repetitive Forward Current (Rated V _R , Square Wave, 20 kHz) T _C = 90°C	I _{FRM}	150	Amps
Average Rectified Forward Current (Rated V _R) T _C = 120°C	I _O	60	Amps
Peak Repetitive Reverse Surge Current (2 μs, 1 kHz) See Figure 7	I _{RRM}	2	Amps
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I _{FSM}	10000	Amps
Operating Junction Temperature	T _J	-65 to +150	°C
Storage Temperature Range	T _{stg}	-65 to +175	°C
Voltage Rate of Change (Rated V _R)	dv/dt	10000	V/μs

THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	R _{θJC}	0.8	°C/W
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(1) Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

Preferred devices are Motorola recommended choices for future use and best overall value.

MBR6015L MBR6020L MBR6025L MBR6030L**ELECTRICAL CHARACTERISTICS**

Characteristic	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (1) ($i_F = 30$ Amps, $T_C = 25^\circ\text{C}$) ($i_F = 60$ Amps, $T_C = 25^\circ\text{C}$) ($i_F = 30$ Amps, $T_C = 150^\circ\text{C}$) ($i_F = 60$ Amps, $T_C = 150^\circ\text{C}$)	v_F	0.42 0.48 0.30 0.38	Volts
Maximum Instantaneous Reverse Current (1) (Rated Voltage, $T_C = 25^\circ\text{C}$) (Rated Voltage, $T_C = 125^\circ\text{C}$)	i_R	50 280	mA
Capacitance ($V_R = 1$ Vdc, 100 kHz $\leq f \leq 1.0$ MHz)	C_t	6000	pF

(1) Pulse Test: Pulse Width ≤ 300 μs , Duty Cycle $\leq 2.0\%$.

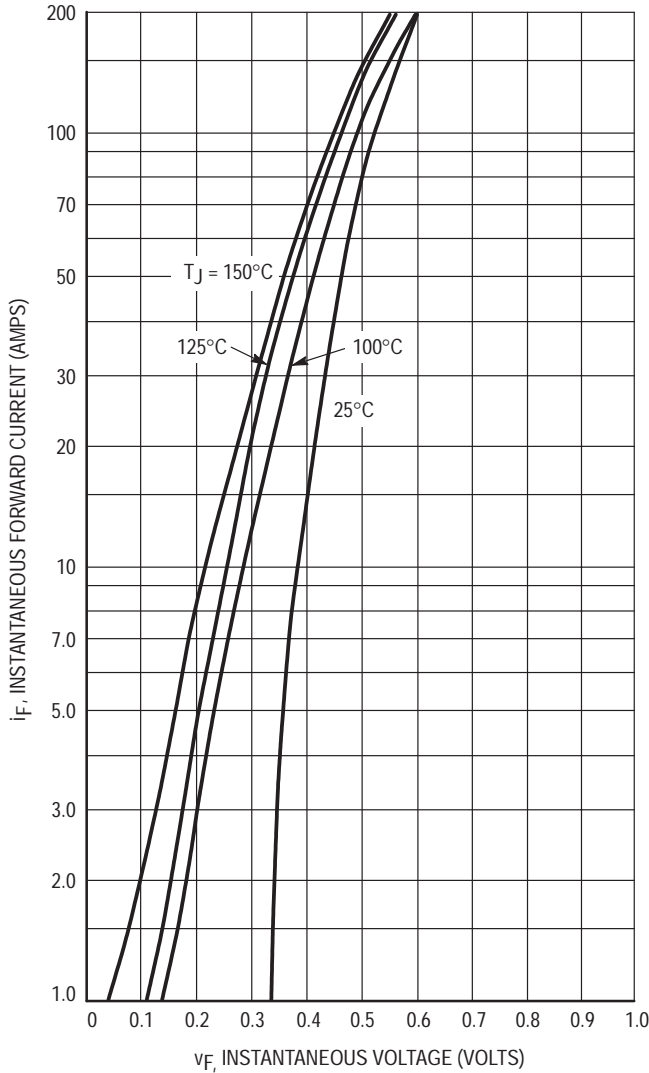


Figure 1. Typical Forward Voltage

NOTE 1 — HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 4.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 percent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

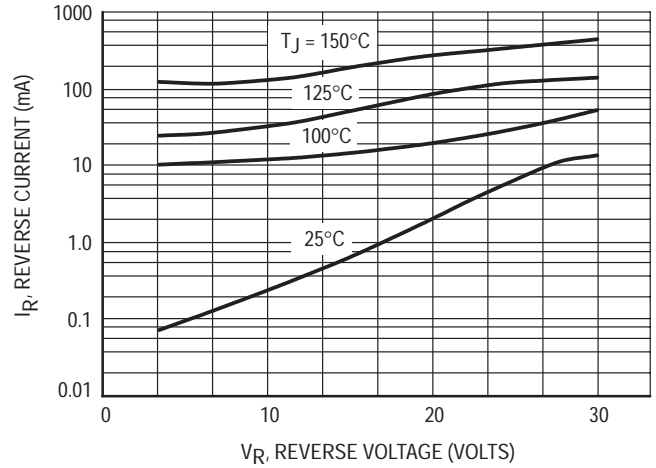


Figure 2. Typical Reverse Current*

* The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V_R is sufficiently below rated V_R .

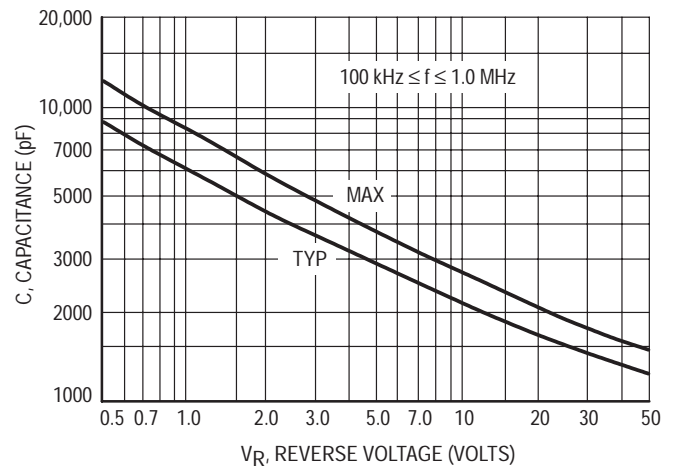


Figure 3. Capacitance

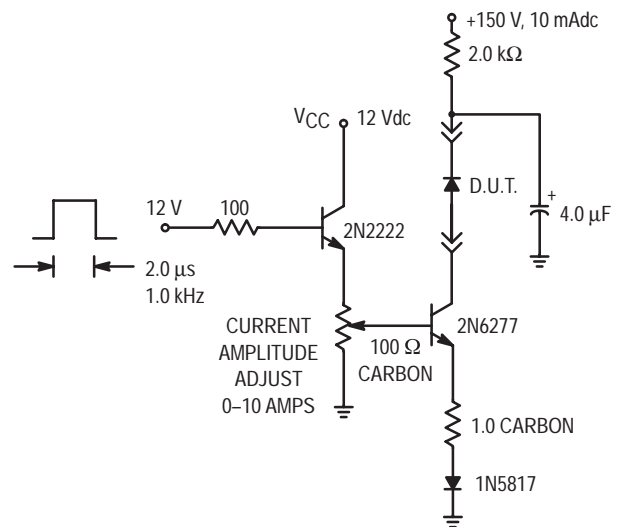


Figure 4. Test Circuit for dv/dt and Reverse Surge Current

MBR6015L MBR6020L MBR6025L MBR6030L

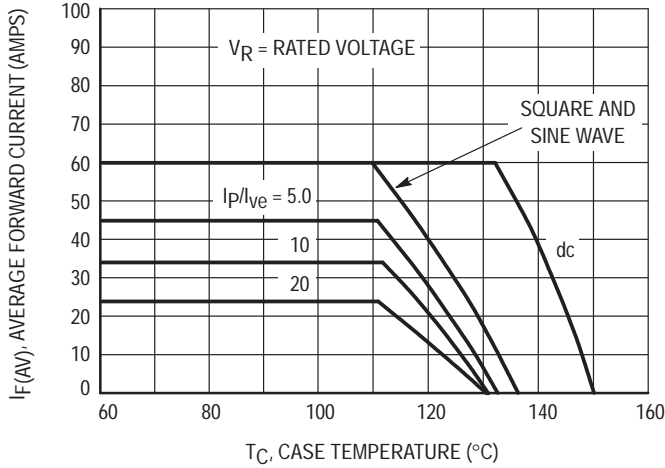


Figure 5. Forward Current Derating

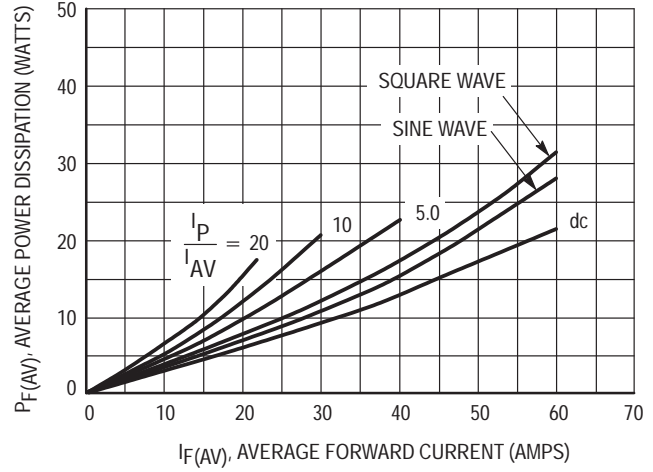
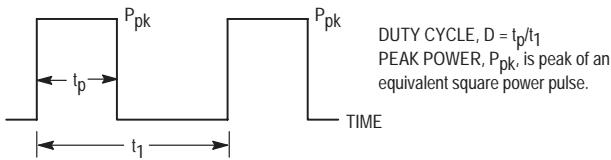


Figure 6. Power Dissipation

NOTE 2



To determine maximum junction temperature of the diode in a given situation, the following procedure is recommended:

The temperature of the case should be measured using a thermocouple placed on the case. The thermal mass connected to the case is normally large enough so that it will not significantly

respond to heat surges generated in the diode as a result of pulsed operation once steady-state conditions are achieved. Using the measured value of T_C , the junction temperature may be determined by:

$$T_J = T_C + \Delta T_{JC}$$

where ΔT_C is the increase in junction temperature above the case temperature, it may be determined by:

$\Delta T_{JC} = P_{pk} \cdot R_{\theta JC} [D + (1 - D) \cdot r(t_1 + t_p) + r(t_p) - r(t_1)]$ where $r(t)$ = normalized value of transient thermal resistance at time, t , from Figure 7, i.e.:

$r(t_1 - t_p)$ = normalized value of transient thermal resistance at time $t_1 + t_p$.

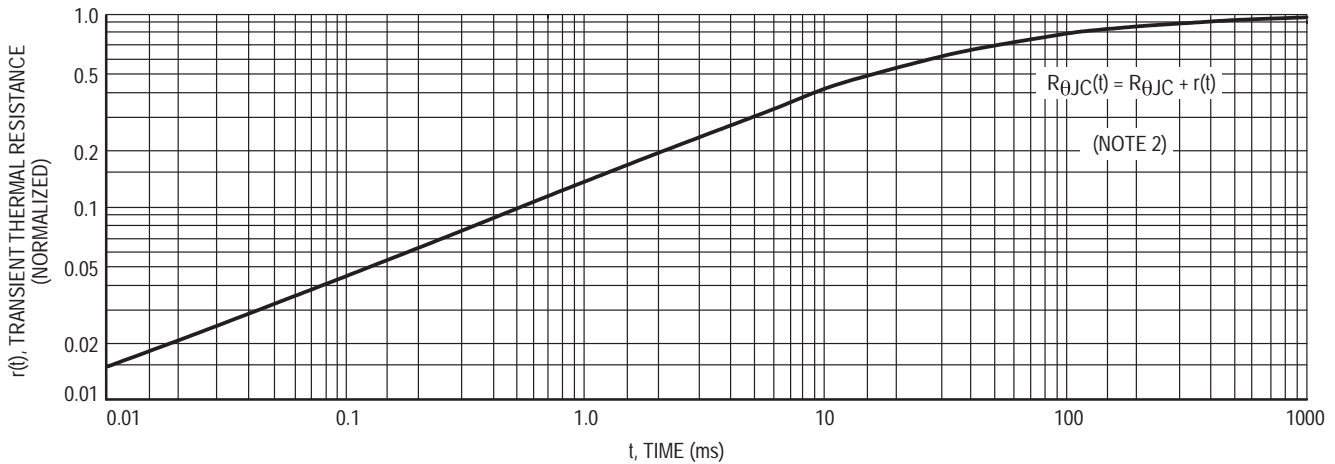


Figure 7. Thermal Response

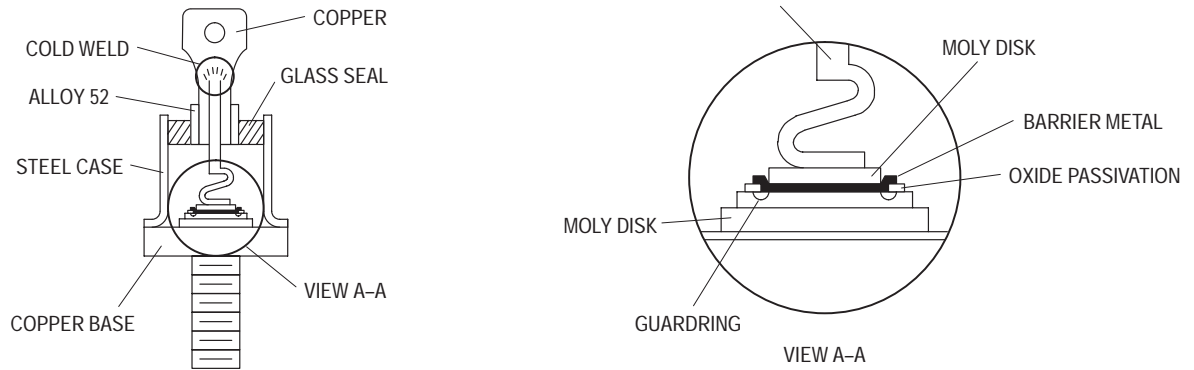


Figure 8. Schottky Rectifier

Motorola builds quality and reliability into its Schottky Rectifiers.

First is the chip, which has an interface metal between the platinum-barrier metal and nickel-gold ohmic-contact metal to eliminate any possible interaction with the barrier. The indicated guardring prevents dv/dt problems, so snubbers are not mandatory. The guardring also operates like a zener to absorb over-voltage transients.

Second is the package. There are molybdenum disks which closely match the thermal coefficient of expansion of silicon on each side of the chip. The top copper lead has a stress relief

feature which protects the die during assembly. These two features give the unit the capability of passing stringent thermal fatigue tests for 5,000 cycles. The top copper lead provides a low resistance to current and therefore does not contribute to device heating; a heat sink should be used when attaching wires.

Third is the redundant electrical testing. The device is tested before assembly in "sandwich" form, with the chip between the moly disks. It is tested again after assembly. As part of the final electrical test, devices are 100% tested for dv/dt at 1,600 V/ μ s and reverse avalanche.

SWITCHMODE™ Power Rectifiers

... using a platinum barrier metal in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free-wheeling diodes, and polarity-protection diodes.

- Guaranteed Reverse Avalanche
- Guardring for dv/dt Stress Protection
- 150°C Operating Junction Temperature
- Low Forward Voltage


Mechanical Characteristics:

- Case: Welded steel, hermetically sealed
- Weight: 17 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Solder Heat: The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.
- Stud Torque: 25 lb-in max
- Shipped 25 units per rail
- Marking: B6035, B6045

MBR6035
MBR6045

MBR6045 is a
Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIERS**
60 AMPERES
35 and 45 VOLTS



CASE 257-01
DO-203AB
METAL

MAXIMUM RATINGS

Rating	Symbol	MBR6035	MBR6045	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	35	45	Volts
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz) $T_C = 100^\circ\text{C}$	I_{FRM}	← 120 →		Amps
Average Rectified Forward Current (Rated V_R) $T_C = 100^\circ\text{C}$	I_O	← 60 →		Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz) See Figure 7.	I_{RRM}	← 2.0 →		Amps
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I_{FSM}	← 800 →		Amps
Operating Junction Temperature	T_J	← -65 to +150 →		$^\circ\text{C}$
Storage Temperature	T_{stg}	← -65 to +175 →		$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	← 10000 →		V/ μs

THERMAL CHARACTERISTICS

Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.85	1.0	$^\circ\text{C}/\text{W}$

Preferred devices are Motorola recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Typ	Max	Unit
Instantaneous Forward Voltage (1) ($i_F = 60$ Amps, $T_C = 25^\circ\text{C}$) ($i_F = 60$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 120$ Amps, $T_C = 125^\circ\text{C}$)	V_F	0.65 0.57 0.70	0.70 0.60 0.76	Volts
Instantaneous Reverse Current (1) (Rated Voltage, $T_C = 25^\circ\text{C}$) (Rated Voltage, $T_C = 125^\circ\text{C}$)	i_R	0.1 55	0.3 100	mA
Capacitance ($V_R = 1.0$ Vdc, 100 kHz \leq 1.0 MHz)	C_t	3000	3700	pF

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle = 2.0%.

MBR6035 MBR6045

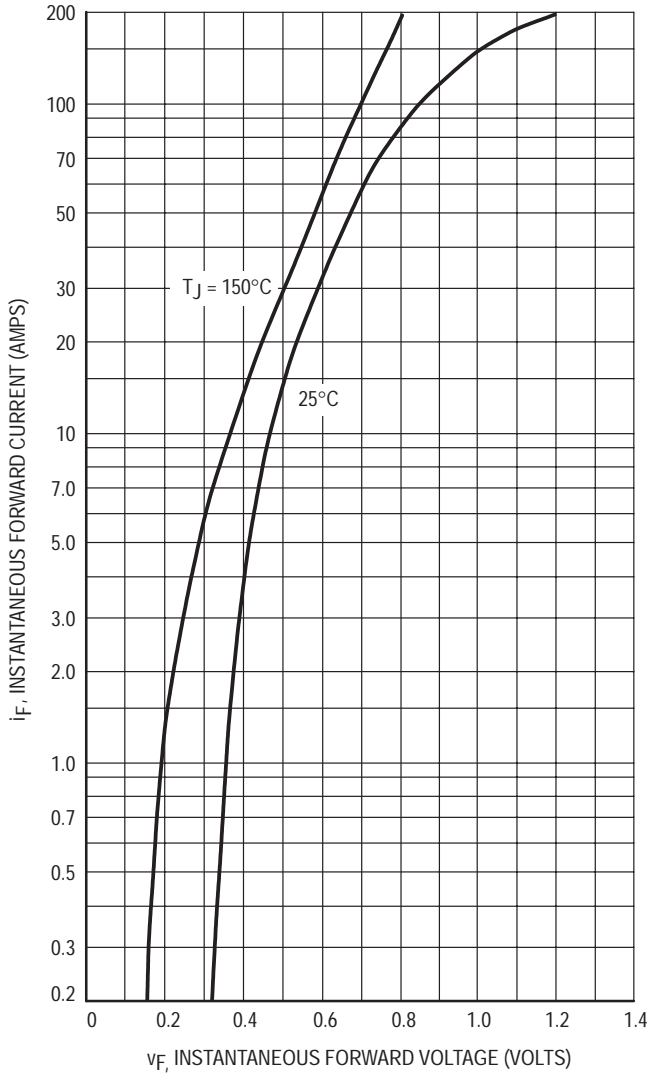


Figure 1. Typical Forward Voltage

NOTE 1 — HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 4.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

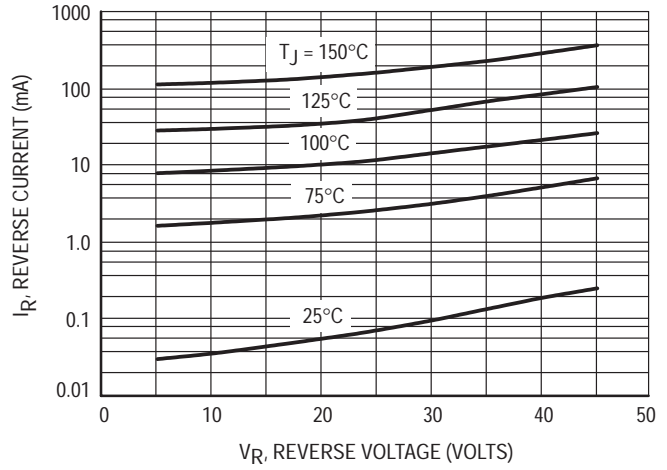


Figure 2. Typical Reverse Current

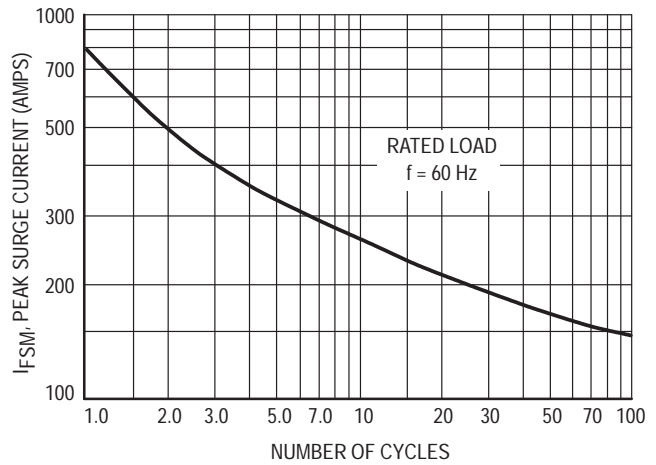


Figure 3. Maximum Surge Capability

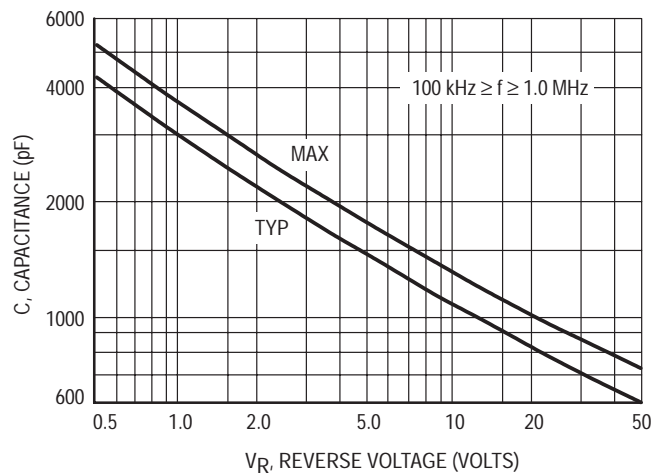


Figure 4. Capacitance

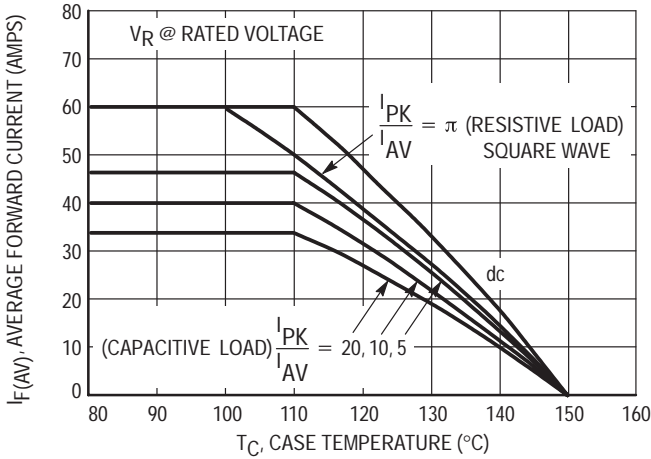


Figure 5. Forward Current Derating

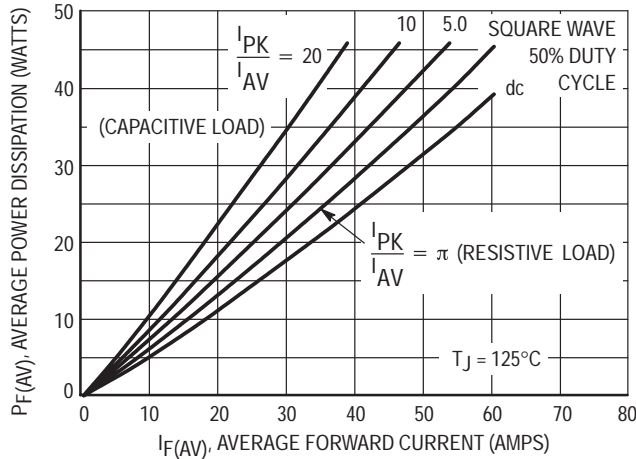


Figure 6. Power Dissipation

NOTE 2

DUTY CYCLE, $D = t_p/t_1$
 PEAK POWER, P_{pk} , is peak of an equivalent square power pulse.

TIME

To determine maximum junction temperature of the diode in a given situation, the following procedure is recommended:
 The temperature of the case should be measured using a thermocouple placed on the case. The thermal mass connected to the case is normally large enough so that it will not significantly respond to heat surges generated in the diode as a result of pulsed operation once steady-state conditions are achieved. Using the measured value of T_C , the junction temperature may be determined by:

$$T_J = T_C + \Delta T_{JC}$$

where ΔT_{JC} is the increase in junction temperature above the case temperature, it may be determined by:

$$\Delta T_{JC} = P_{pk} \cdot R_{\theta JC} [D + (1 - D) \cdot r(t_1 + t_p) + r(t_p) - r(t_1)]$$

where $r(t)$ = normalized value of transient thermal resistance at time, t , from Figure 8, i.e.:

$r(t_1 + t_p)$ = normalized value of transient thermal resistance at time $t_1 + t_p$.

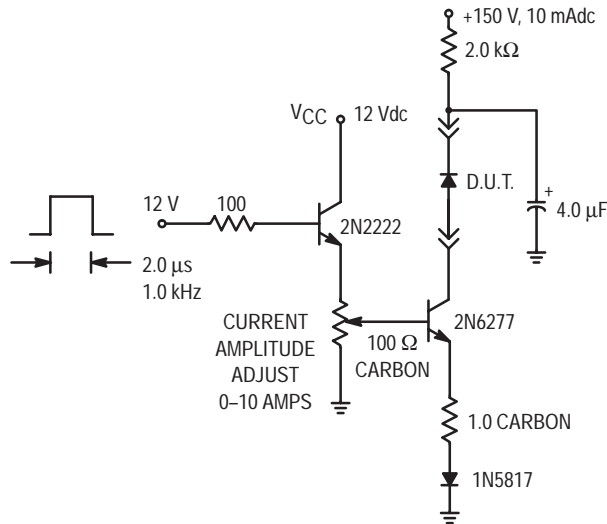


Figure 7. Test Circuit for dv/dt and Reverse Surge Current

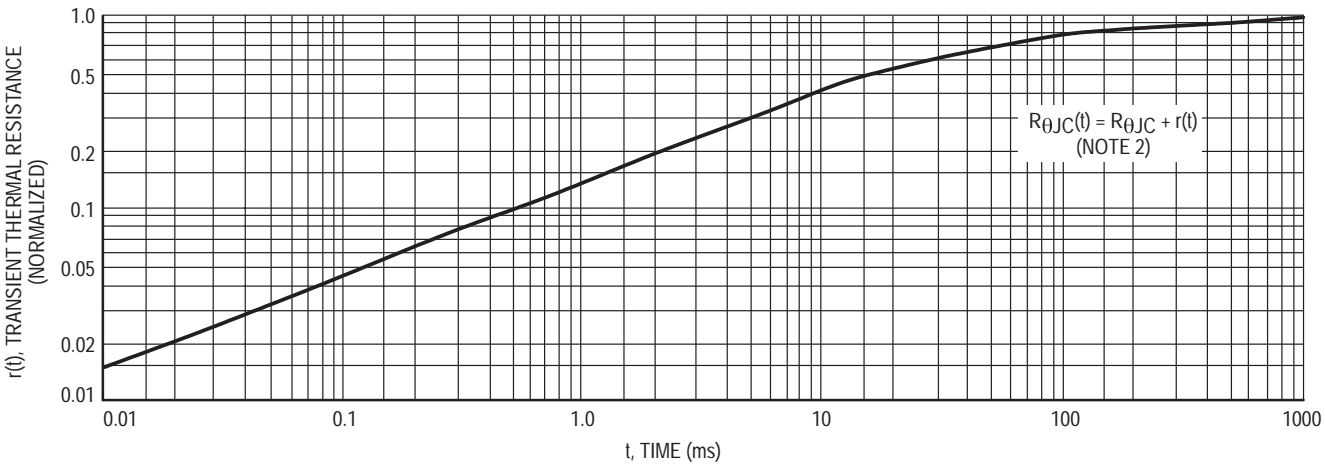


Figure 8. Thermal Response

MBR6035 MBR6045

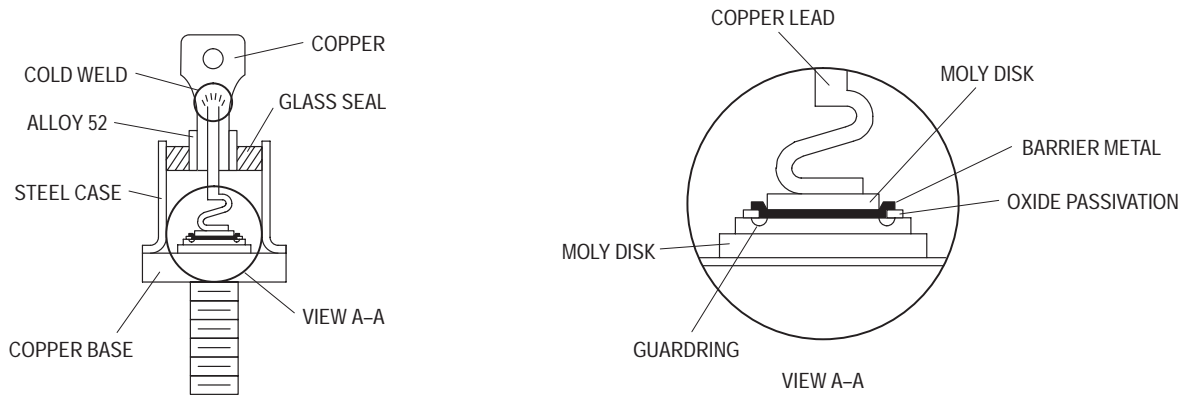


Figure 9. Schottky Rectifier

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Second is the package. There are molybdenum disks which closely match the thermal coefficient of expansion of silicon on each side of the chip. The top copper lead has a stress relief feature which protects the die during assembly.

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SWITCHMODE™ Power Rectifiers

... using a platinum barrier metal in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free-wheeling diodes, and polarity-protection diodes.

- Guaranteed Reverse Avalanche
- Guardring for dv/dt Stress Protection
- 175°C Operating Junction Temperature
- Low Forward Voltage


Mechanical Characteristics:

- Case: Welded steel, hermetically sealed
- Weight: 17 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Solder Heat: The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.
- Stud Torque: 25 lb-in max
- Shipped 25 units per rail
- Marking: B6535, B6545

MBR6535
MBR6545

MBR6545 is a
Motorola Preferred Device

HIGH TEMPERATURE
SCHOTTKY RECTIFIERS
65 AMPERES
35 and 45 VOLTS



CASE 257-01
DO-203AB
METAL

MAXIMUM RATINGS

Rating	Symbol	MBR6535	MBR6545	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	35	45	Volts
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz) $T_C = 120^\circ\text{C}$	I_{FRM}	130	130	Amps
Average Rectified Forward Current (Rated V_R) $T_C = 120^\circ\text{C}$	I_O	65	65	Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz) See Figure 7.	I_{RRM}	2.0	2.0	Amps
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I_{FSM}	800	800	Amps
Operating Junction Temperature and Storage Temperature	T_J, T_{stg}	-65 to +175	-65 to +175	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	1000	10000	V/ μs

THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.0	1.0	$^\circ\text{C}/\text{W}$
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Preferred devices are Motorola recommended choices for future use and best overall value.

MBR6535 MBR6545**ELECTRICAL CHARACTERISTICS**

Characteristic	Symbol	MBR6535	MBR6545	Unit
Maximum Instantaneous Forward Voltage (1) ($i_F = 65$ Amps, $T_C = 25^\circ\text{C}$) ($i_F = 65$ Amps, $T_C = 150^\circ\text{C}$) ($i_F = 130$ Amps, $T_C = 150^\circ\text{C}$)	v_F	0.78 0.62 0.73	0.78 0.62 0.73	Volts
Maximum Instantaneous Reverse Current (1) (Rated Voltage, $T_C = 25^\circ\text{C}$) (Rated Voltage, $T_C = 150^\circ\text{C}$)	i_R	0.07 125	0.07 125	mA
Capacitance ($V_R = 1.0$ Vdc, 100 kHz $\leq f \leq 1.0$ MHz)	C_t	3700	3700	pF

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

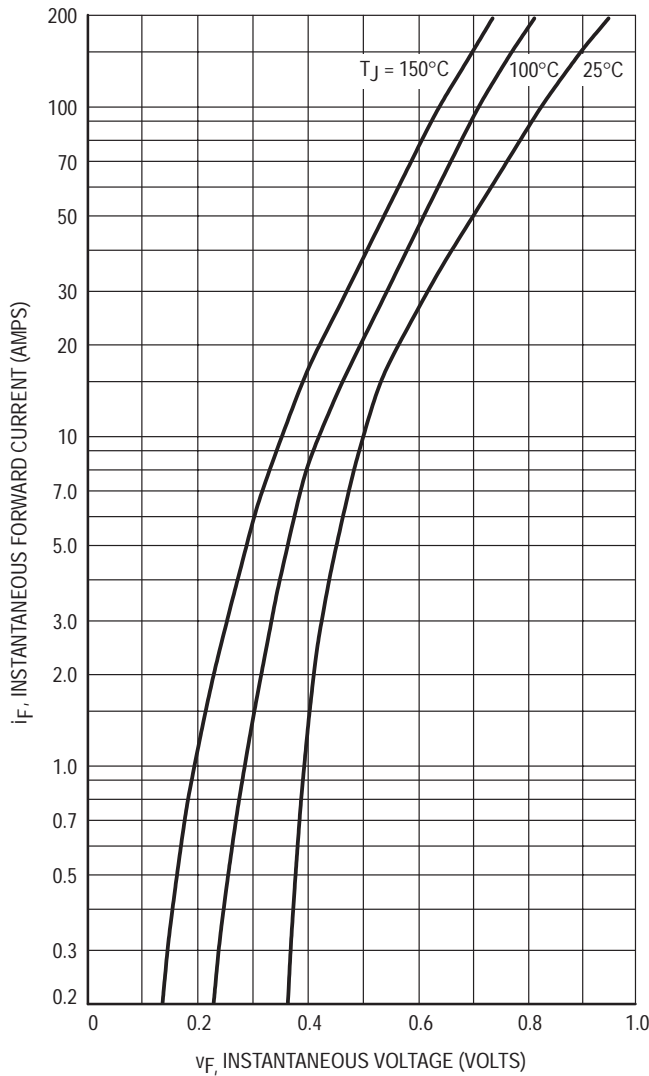


Figure 1. Typical Forward Voltage

NOTE 1 — HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 4.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

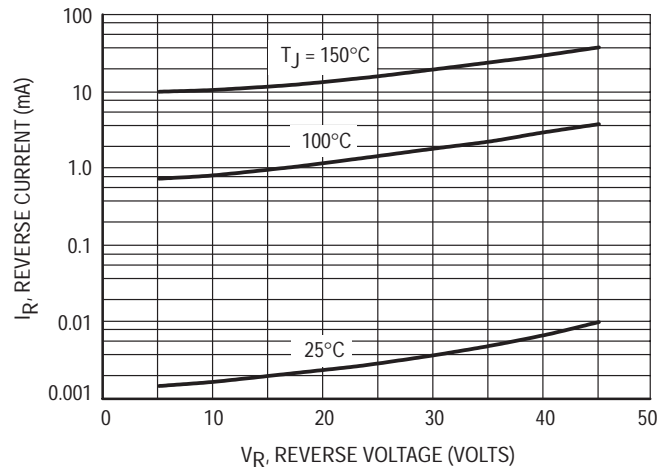


Figure 2. Typical Reverse Current

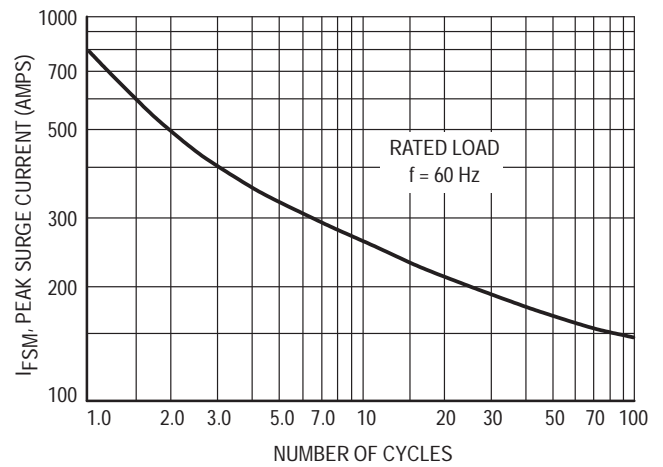


Figure 3. Maximum Surge Capability

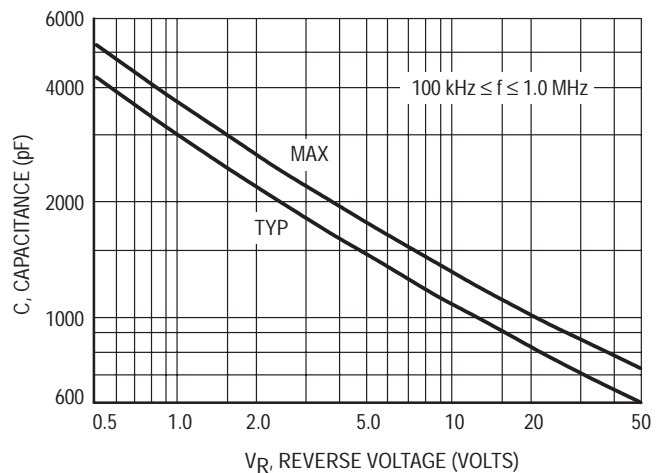


Figure 4. Capacitance

MBR6535 MBR6545

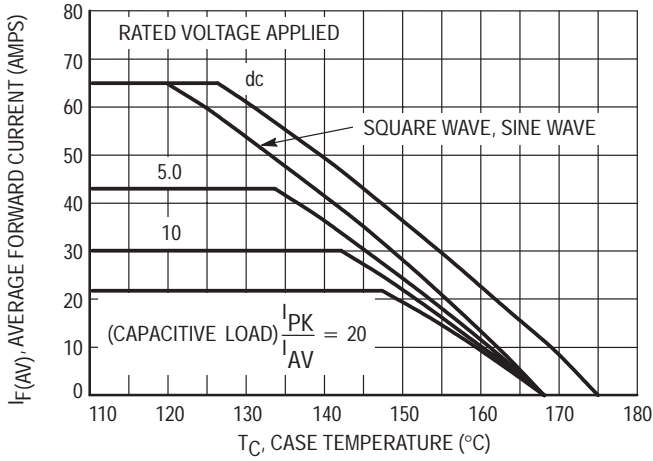


Figure 5. Forward Current Derating

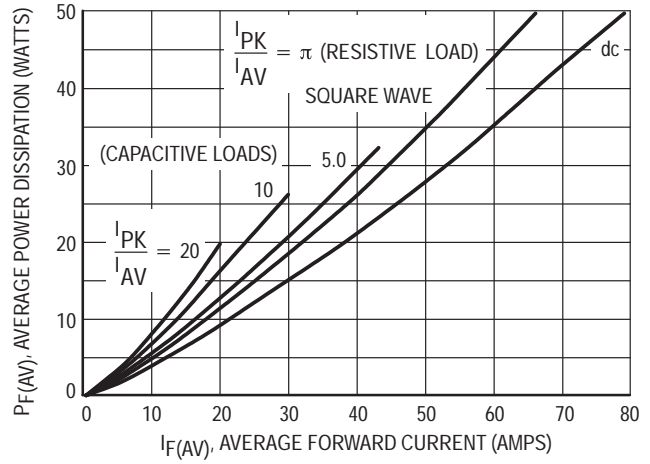


Figure 6. Power Dissipation

NOTE 2

DUTY CYCLE, $D = t_p/t_1$
 PEAK POWER, P_{pk} is peak of an equivalent square power pulse.

To determine maximum junction temperature of the diode in a given situation, the following procedure is recommended:
 The temperature of the case should be measured using a thermocouple placed on the case. The thermal mass connected to the case is normally large enough so that it will not significantly respond to heat surges generated in the diode as a result of pulsed operation once steady-state conditions are achieved. Using the measured value of T_C , the junction temperature may be determined by:

$$T_J = T_C + \Delta T_{JC}$$

where ΔT_{JC} is the increase in junction temperature above the case temperature, it may be determined by:
 $\Delta T_{JC} = P_{pk} \cdot R_{\theta JC} [D + (1 - D) \cdot r(t_1 + t_p) + r(t_p) - r(t_1)]$ where
 $r(t)$ = normalized value of transient thermal resistance at time, t , from Figure 8, i.e.:
 $r(t_1 + t_p)$ = normalized value of transient thermal resistance at time $t_1 + t_p$.

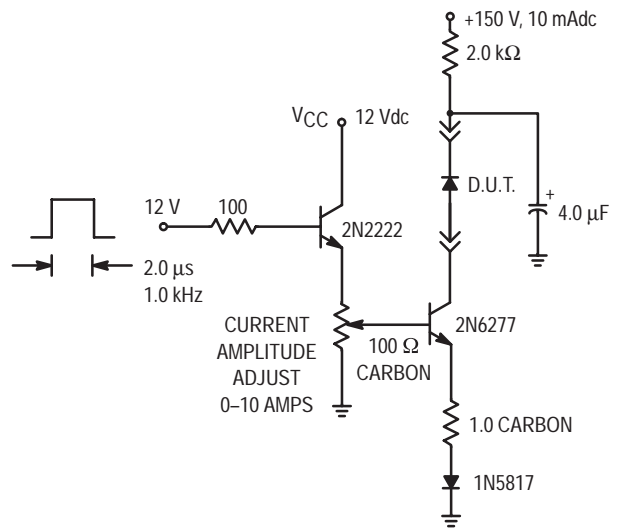


Figure 7. Test Circuit for dv/dt and Reverse Surge Current

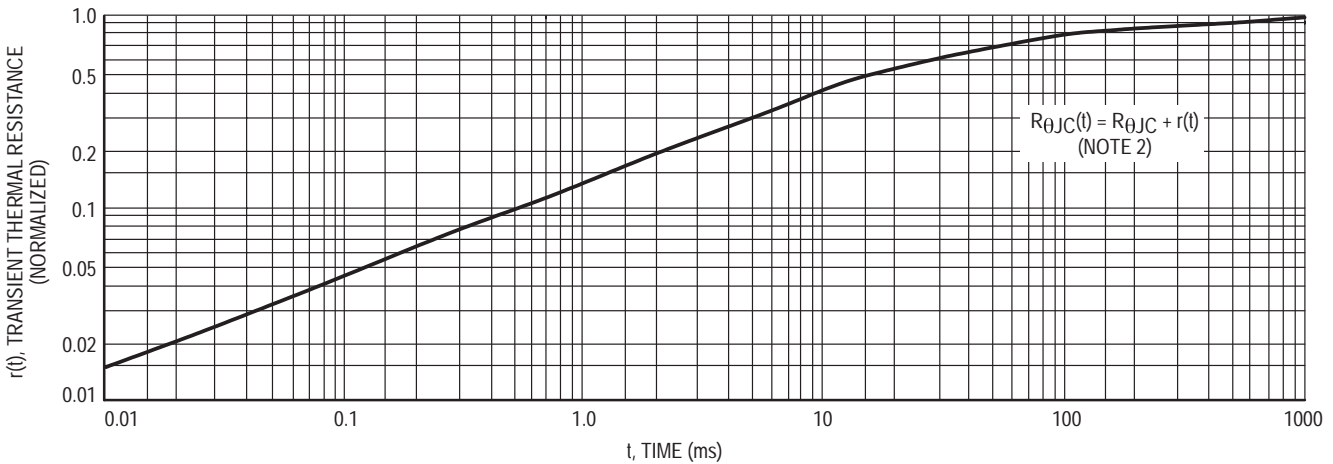


Figure 8. Thermal Response

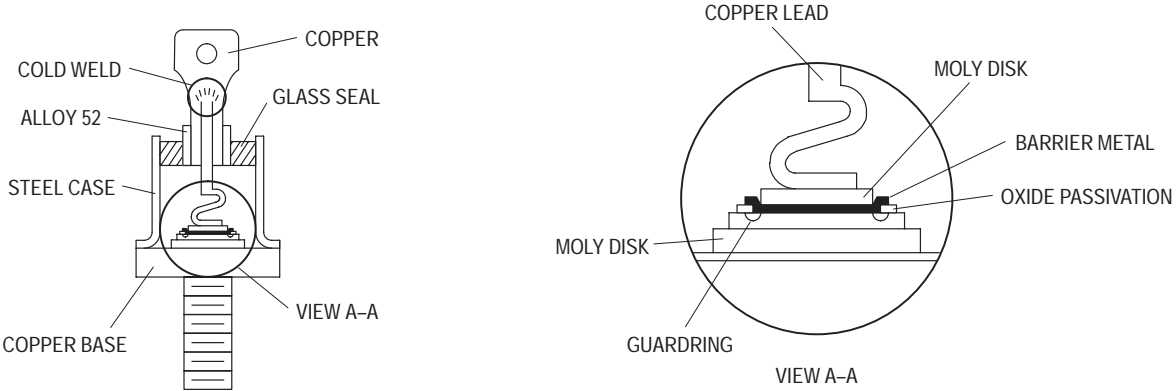


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feature which protects the die during assembly. These two features give the unit the capability of passing stringent thermal fatigue tests for 5,000 cycles. The top copper lead provides a low resistance to current and therefore does not contribute to device heating; a heat sink should be used when attaching wires. Third is the redundant electrical testing. The device is tested before assembly in "sandwich" form, with the chip between the moly disks. It is tested again after assembly. As part of the final electrical test, devices are 100% tested for dv/dt at 1,600 V/ μ s and reverse avalanche.

SWITCHMODE™ Power Rectifiers

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free-wheeling diodes, and polarity-protection diodes.

- Extremely Low v_f
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency
- High Surge Capacity


Mechanical Characteristics:

- Case: Welded steel, hermetically sealed
- Weight: 17 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Solder Heat: The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.
- Stud Torque: 25 lb-in max
- Shipped 25 units per rail
- Marking: B7535, B7545

MBR7535
MBR7545

MBR7545 is a
Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIERS**
75 AMPERES
35 and 45 VOLTS



CASE 257-01
DO-203AB
METAL

MAXIMUM RATINGS

Rating	Symbol	MBR7535	MBR7545	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	35	45	Volts
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz)	I_{FRM}	150 $T_C = 90^\circ C$		Amps
Average Rectified Forward Current (Rated V_R)	I_O	75 $T_C = 90^\circ C$		Amps
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I_{FSM}	1000		Amps
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-65 to +150		$^\circ C$
Peak Operating Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175		$^\circ C$
Voltage Rate of Change (Rated V_R)	dv/dt	10000		V/ μs

THERMAL CHARACTERISTICS

Characteristic	Symbol	MBR7535	MBR7545	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.8		$^\circ C/W$

Preferred devices are Motorola recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	MBR7535	MBR7545	Unit
Maximum Instantaneous Forward Voltage (1) ($i_F = 60$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 220$ Amps, $T_C = 125^\circ\text{C}$)	v_F	0.60 0.90		Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$)	i_R	150	250	mA
Capacitance ($V_R = 5.0$ Vdc, $100\text{ kHz} \leq f \leq 1.0\text{ MHz}$)	C_t	4000		pF

(1) Pulse Test: Pulse Width = $300\ \mu\text{s}$, Duty Cycle = 2.0%.

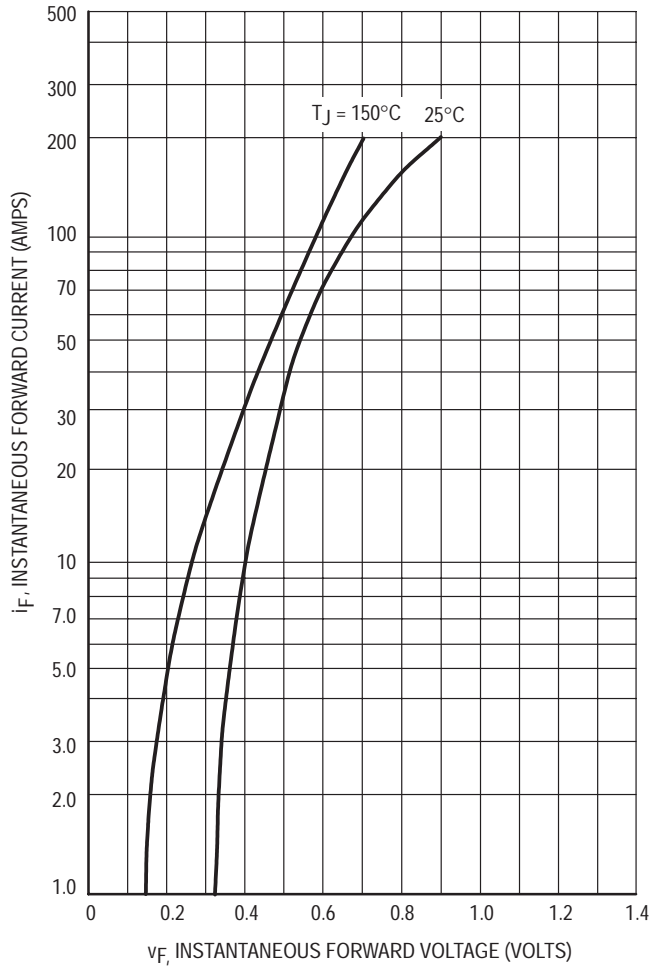


Figure 1. Typical Forward Voltage

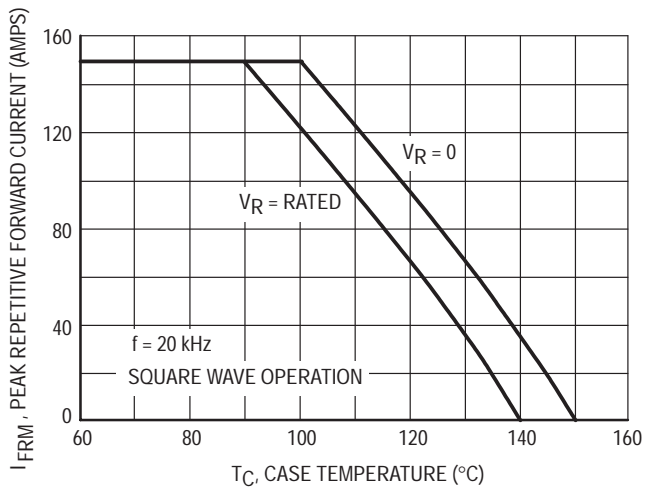


Figure 2. Current Derating

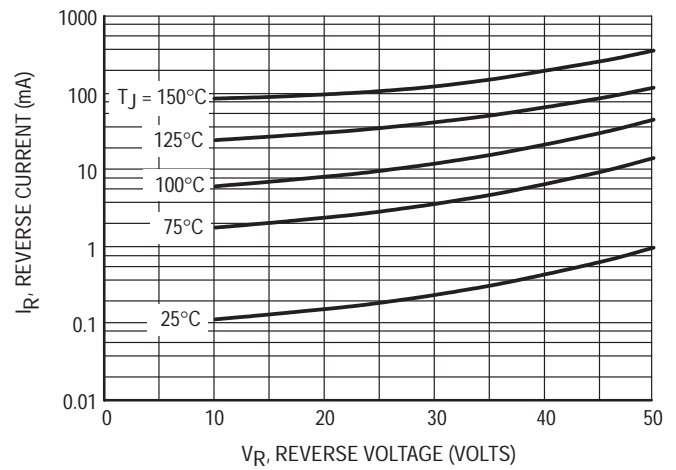


Figure 3. Typical Reverse Operation

SWITCHMODE™ Power Rectifiers

... using a platinum barrier metal in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free-wheeling diodes, and polarity-protection diodes.

- Guaranteed Reverse Avalanche
- Guardring for dv/dt Stress Protection
- 175°C Operating Junction Temperature
- Low Forward Voltage


Mechanical Characteristics:

- Case: Welded steel, hermetically sealed
- Weight: 17 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Solder Heat: The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.
- Stud Torque: 25 lb-in max
- Shipped 25 units per rail
- Marking: B8035, B8045

MBR8035
MBR8045

MBR8045 is a
Motorola Preferred Device

SCHOTTKY RECTIFIERS
80 AMPERES
35 and 45 VOLTS



CASE 257-01
DO-203AB
METAL

MAXIMUM RATINGS

Rating	Symbol	MBR8035	MBR8045	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	35	45	Volts
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz) $T_C = 120^\circ\text{C}$	I_{FRM}	160	160	Amps
Average Rectified Forward Current (Rated V_R) $T_C = 120^\circ\text{C}$	I_O	80	80	Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz) See Figure 7.	I_{RRM}	2.0	2.0	Amps
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I_{FSM}	1000	1000	Amps
Operating Junction Temperature and Storage Temperature	T_J, T_{stg}	-65 to +175	-65 to +175	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	1000	10000	V/ μs

THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.80	0.80	$^\circ\text{C/W}$
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Preferred devices are Motorola recommended choices for future use and best overall value.

MBR8035 MBR8045**ELECTRICAL CHARACTERISTICS**

Characteristic	Symbol	MBR8035	MBR8045	Unit
Maximum Instantaneous Forward Voltage (1) ($i_F = 80$ Amps, $T_C = 25^\circ\text{C}$) ($i_F = 80$ Amps, $T_C = 150^\circ\text{C}$) ($i_F = 160$ Amps, $T_C = 150^\circ\text{C}$)	v_F	0.72 0.59 0.67	0.72 0.59 0.67	Volts
Maximum Instantaneous Reverse Current (1) (Rated Voltage, $T_C = 25^\circ\text{C}$) (Rated Voltage, $T_C = 150^\circ\text{C}$)	i_R	1.0 150	1.0 150	mA
Capacitance ($V_R = 1.0$ Vdc, $100 \text{ kHz} \leq f \leq 1.0 \text{ MHz}$)	C_t	5000	5000	pF

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

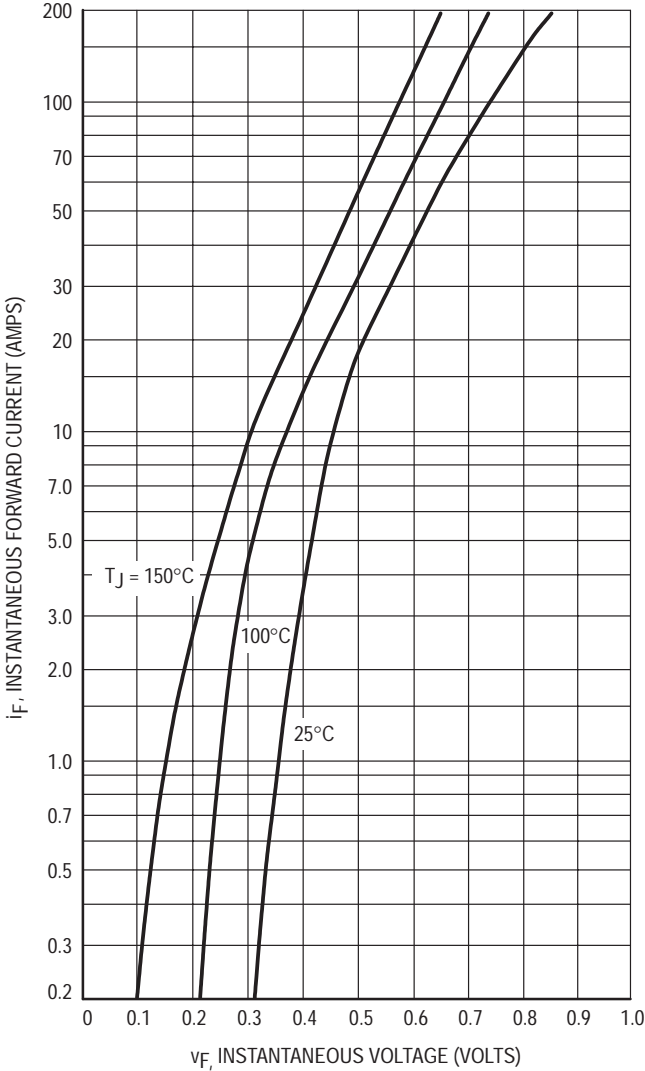


Figure 1. Typical Forward Voltage

NOTE 1 — HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 4.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

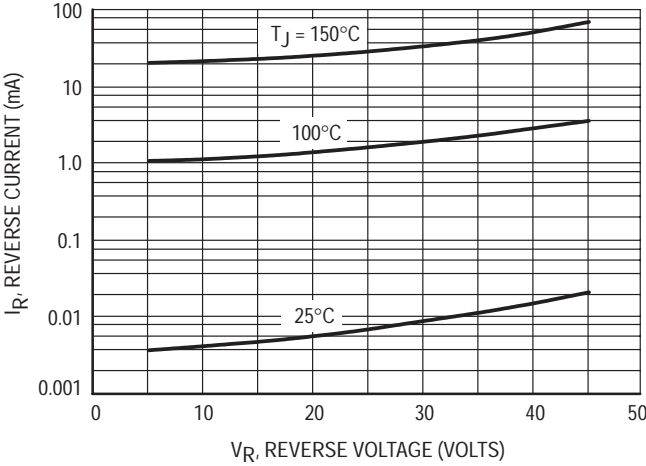


Figure 2. Typical Reverse Current

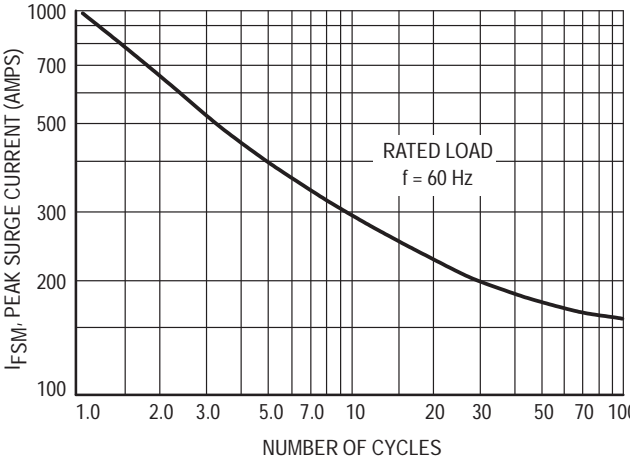


Figure 3. Maximum Surge Capability

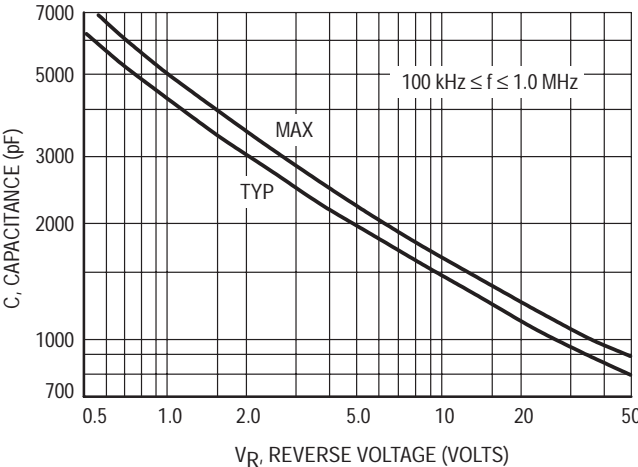


Figure 4. Capacitance

MBR8035 MBR8045

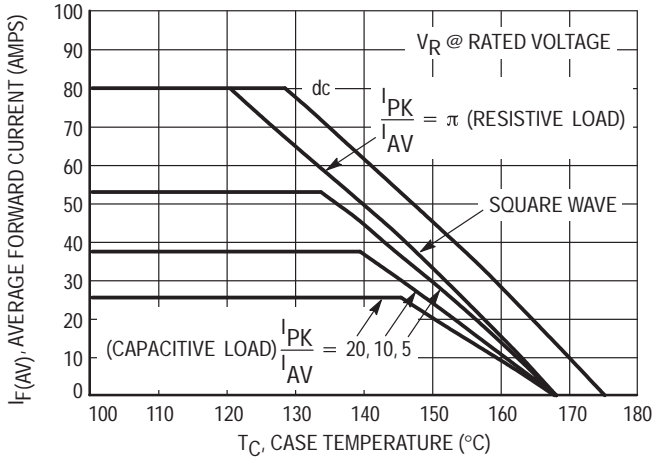


Figure 5. Forward Current Derating

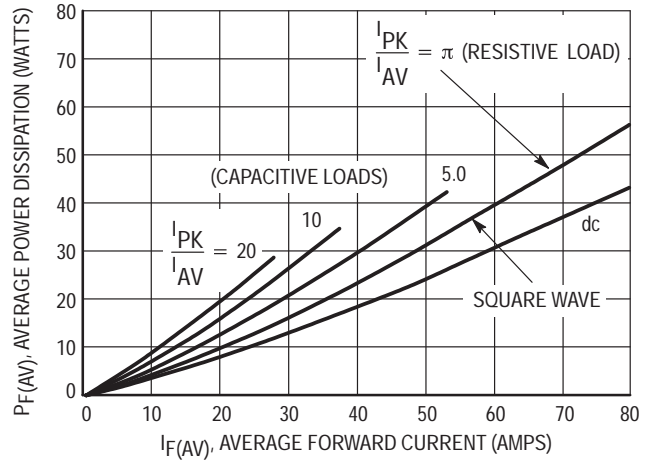


Figure 6. Power Dissipation

NOTE 2

DUTY CYCLE, $D = t_p/t_1$
 PEAK POWER, P_{pk} , is peak of an equivalent square power pulse.

To determine maximum junction temperature of the diode in a given situation, the following procedure is recommended:
 The temperature of the case should be measured using a thermocouple placed on the case. The thermal mass connected to the case is normally large enough so that it will not significantly respond to heat surges generated in the diode as a result of pulsed operation once steady-state conditions are achieved. Using the measured value of T_C , the junction temperature may be determined by:

$$T_J = T_C + \Delta T_{JC}$$

where ΔT_C is the increase in junction temperature above the case temperature, it may be determined by:
 $\Delta T_{JC} = P_{pk} \cdot R_{\theta JC} [D + (1 - D) \cdot r(t_1 + t_p) + r(t_p) - r(t_1)]$ where
 $r(t)$ = normalized value of transient thermal resistance at time, t , from Figure 8, i.e.:
 $r(t_1 + t_p)$ = normalized value of transient thermal resistance at time $t_1 + t_p$.

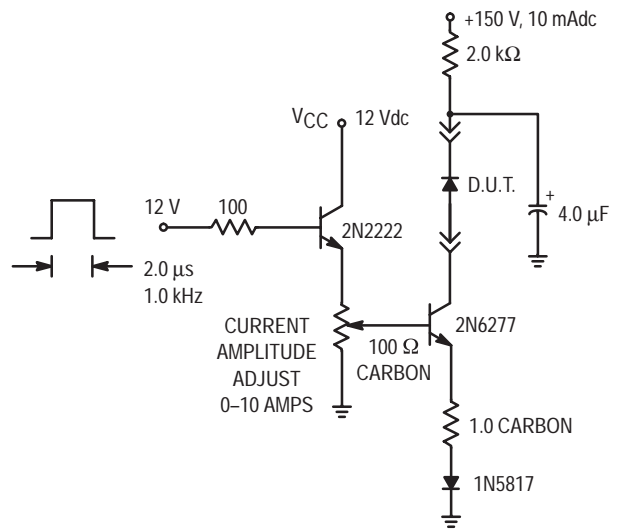


Figure 7. Test Circuit for dv/dt and Reverse Surge Current

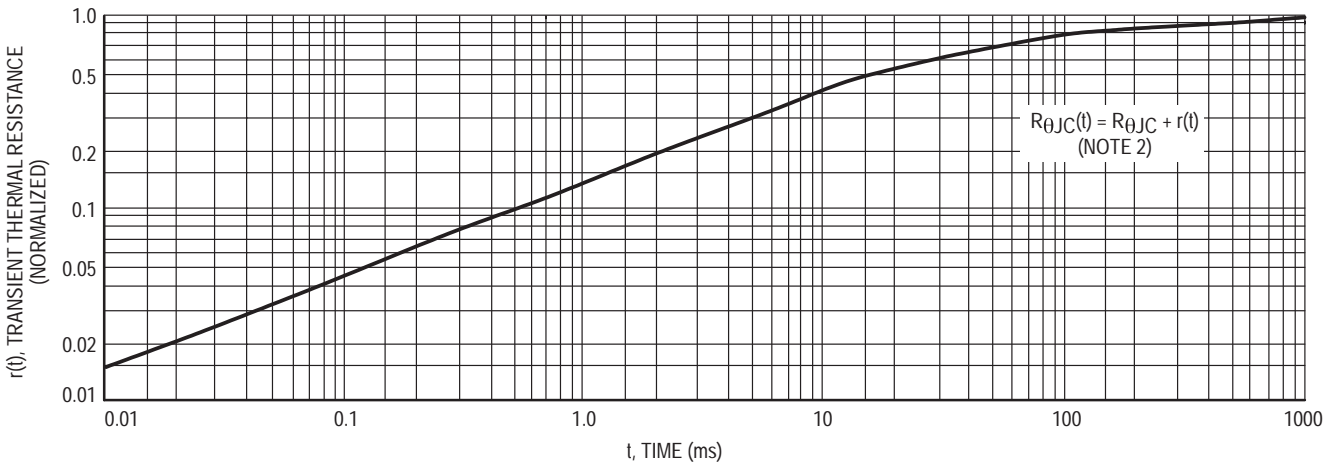


Figure 8. Thermal Response

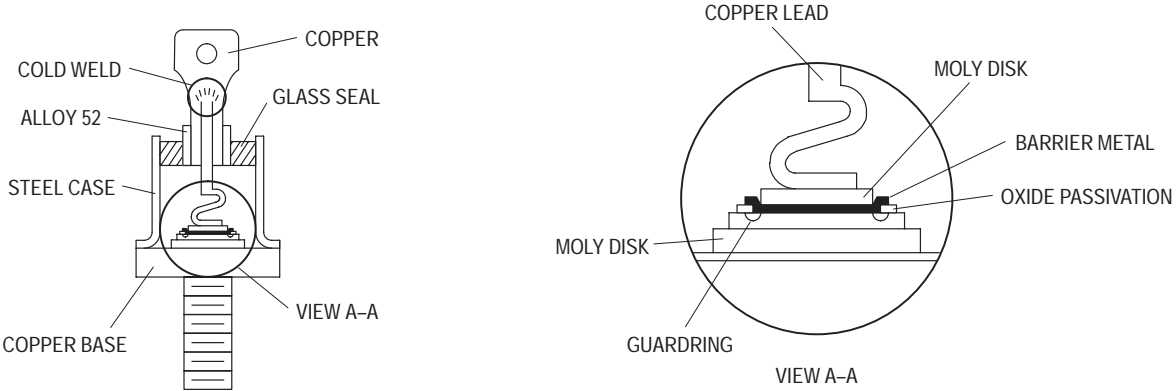


Figure 9. Schottky Rectifier

Motorola builds quality and reliability into its Schottky Rectifiers. First is the chip, which has an interface metal between the platinum-barrier metal and nickel-gold ohmic-contact metal to eliminate any possible interaction with the barrier. The indicated guardring prevents dv/dt problems, so snubbers are not mandatory. The guardring also operates like a zener to absorb over-voltage transients. Second is the package. There are molybdenum disks which closely match the thermal coefficient of expansion of silicon on each side of the chip. The top copper lead has a stress relief

feature which protects the die during assembly. These two features give the unit the capability of passing stringent thermal fatigue tests for 5,000 cycles. The top copper lead provides a low resistance to current and therefore does not contribute to device heating; a heat sink should be used when attaching wires. Third is the redundant electrical testing. The device is tested before assembly in "sandwich" form, with the chip between the moly disks. It is tested again after assembly. As part of the final electrical test, devices are 100% tested for dv/dt at 1,600 V/ μ s and reverse avalanche.

SWITCHMODE™ Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Dual Diode Construction
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche

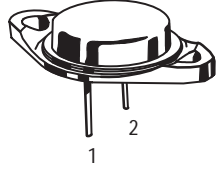
Mechanical Characteristics:

- Case: Copper slug header, welded steel can, hermetically sealed
- Weight: 18.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Stud Torque: 25 lb-in max
- Shipped 100 units per foam tray
- Marking: MBR3045CT, SD241

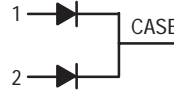
**MBR3045CT
SD241**

MBR3045CT and SD241 are
Motorola Preferred Devices

**SCHOTTKY BARRIER
RECTIFIERS
30 AMPERES
20 to 45 VOLTS**



CASE 11-03
TO-204AA
METAL



MAXIMUM RATINGS

Rating	Symbol	MBR3045CT	SD241	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	45	45	Volts
Average Rectified Forward Current (Rated V_R) $T_C = 105^\circ\text{C}$	I_O	30 15	30 15	Amps Per Device Per Diode
Peak Repetitive Forward Current, Per Diode (Rated V_R , Square Wave, 20 kHz)	I_{FRM}	30	30	Amps
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I_{FSM}	400	400	Amps
Peak Repetitive Reverse Surge Current, Per Diode (2.0 μs , 1.0 kHz) See Figure 8.	I_{RRM}	2.0	2.0	Amps
Operating Junction Temperature	T_J	-65 to +150	-65 to +150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +175	-65 to +175	$^\circ\text{C}$
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175	175	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10000	10000	V/ μs

THERMAL CHARACTERISTICS PER DIODE

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.4	1.4	$^\circ\text{C}/\text{W}$
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Preferred devices are Motorola recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS PER DIODE

Characteristic	Symbol	MBR3045CT	SD241	Unit
Maximum Instantaneous Forward Voltage (1) ($i_F = 10$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 20$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 30$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 30$ Amps, $T_C = 25^\circ\text{C}$)	v_F	— 0.60 0.72 0.76	0.47 0.60 — —	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$) (Rated dc Voltage, $T_C = 25^\circ\text{C}$)	i_R	60 1.0	100 $V_R = 35$ V	mA
Capacitance	C_t	2000	2000	pF

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

MBR3045CT SD241

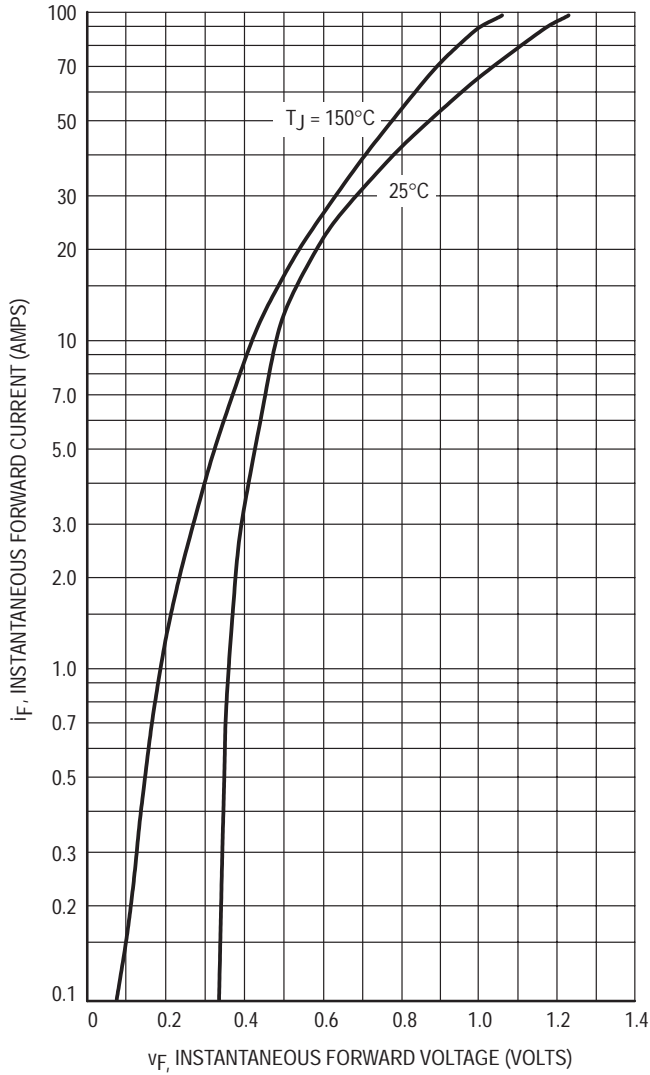


Figure 1. Typical Forward Voltage

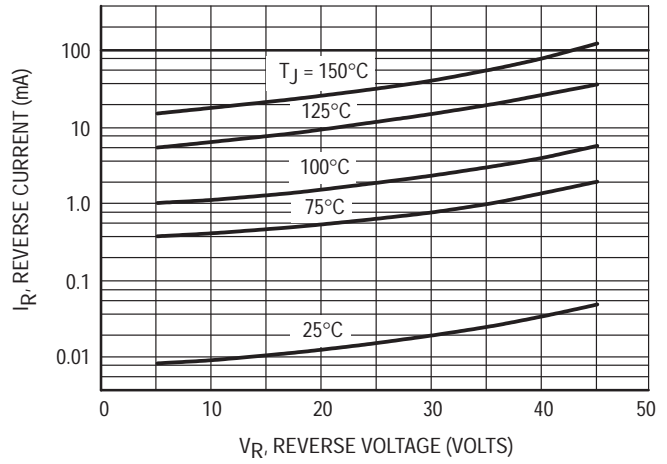


Figure 2. Typical Reverse Current

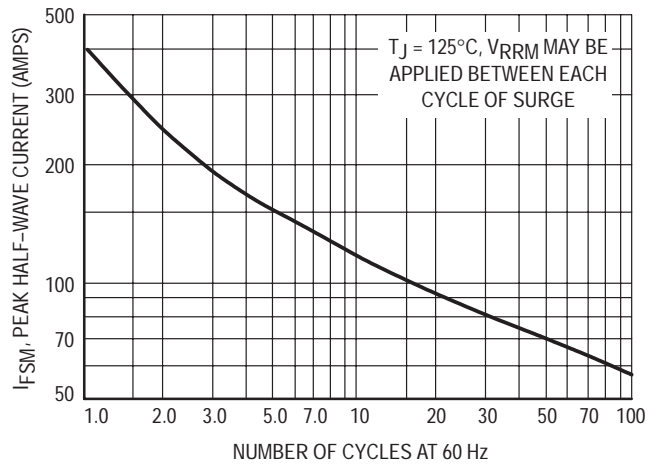


Figure 3. Maximum Surge Capability

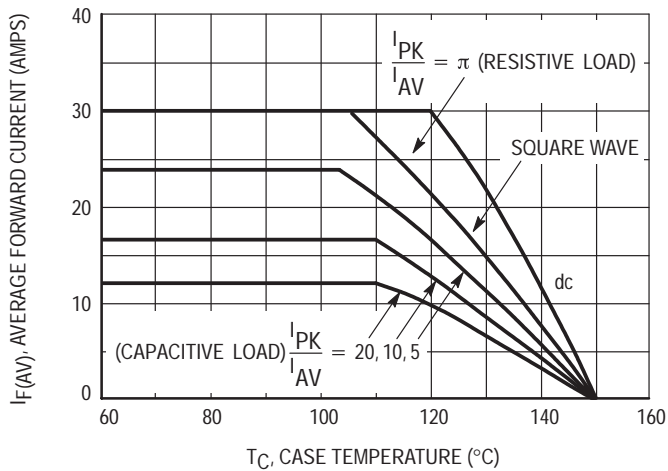


Figure 4. Current Derating

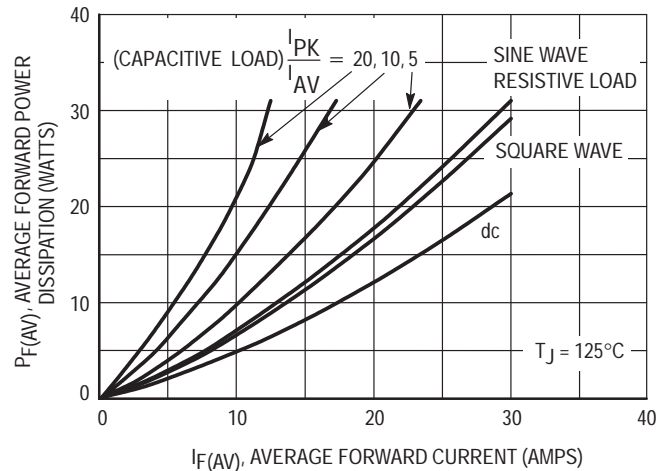


Figure 5. Forward Power Dissipation

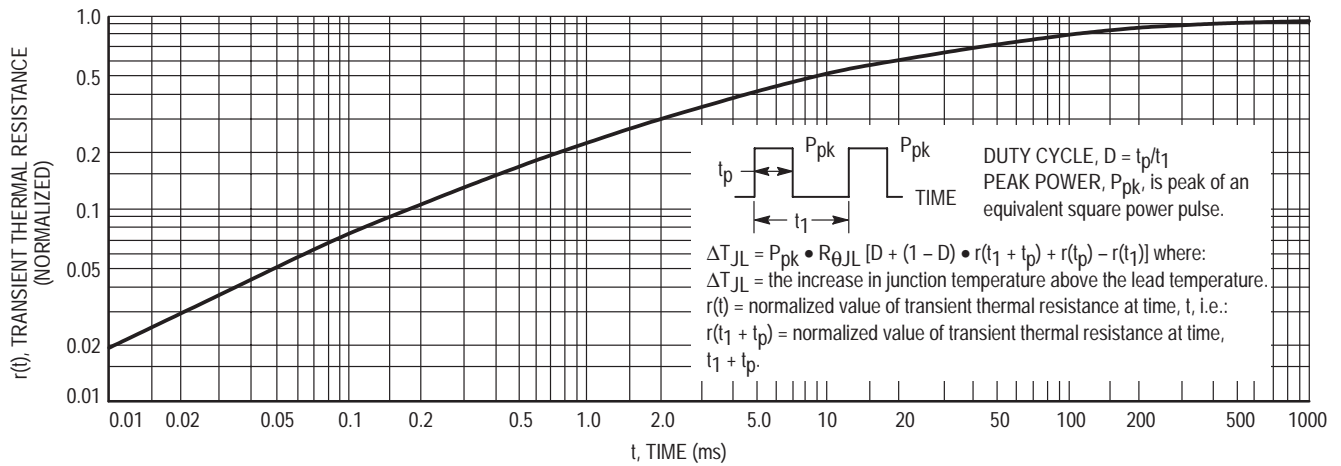


Figure 6. Thermal Response per Diode Leg

HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 7.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

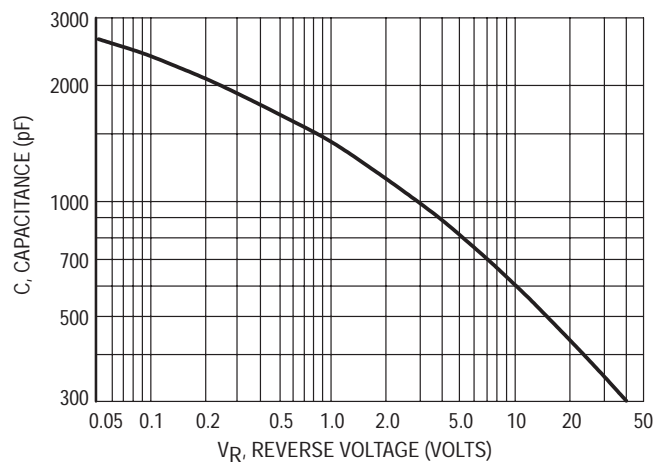


Figure 7. Capacitance

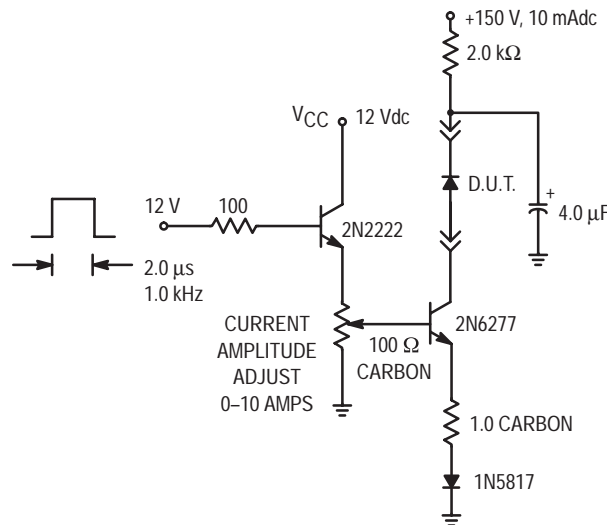


Figure 8. Test Circuit for Repetitive Reverse Current

Product Preview

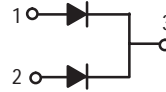
POWERTAP™ II
SWITCHMODE™ Power Rectifier

The SWITCHMODE Power Rectifier uses the Schottky Barrier principle with a platinum barrier metal. This state-of-the-art device has the following features:

- Dual Diode Construction — May Be Paralleled for Higher Current Output
- Guardring for Stress Protection
- Low Forward Voltage Drop
- 150°C Operating Junction Temperature
- Recyclable Epoxy
- Guaranteed Reverse Avalanche Energy Capability
- Improved Mechanical Ratings

Mechanical Characteristics

- Case: Epoxy, Molded with metal heatsink base
- Weight: 80 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Top Terminal Torque: 25–40 lb-in max
- Base Plate Torques: See procedure given in the Package Outline Section
- Shipped 25 units per foam
- Marking: B20030L



MBRP20030CTL
Motorola Preferred Device

LOW V_F
SCHOTTKY BARRIER
RECTIFIER
200 AMPERES
30 VOLTS

CASE 357C-03
POWERTAP II

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	30	Volts
Average Rectified Forward Current (At Rated V_R) $T_C = +125^\circ\text{C}$	$I_{F(AV)}$ Per Leg Per Device	100 200	Amps
Peak Repetitive Forward Current (At Rated V_R , Square Wave, 20 kHz) $T_C = +100^\circ\text{C}$	I_{FRM}	200	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	1500	Amps
Peak Repetitive Reverse Surge Current (2 μs , 1 kHz)	I_{RRM}	2	Amp
Storage Temperature	T_{stg}	-55 to +150	$^\circ\text{C}$
Operating Junction Temperature	T_J	-55 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10000	$\text{V}/\mu\text{s}$

THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Case	$R_{\theta JC}$	0.45	$^\circ\text{C}/\text{W}$
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ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (2) ($i_F = 200$ Amps, $T_C = +25^\circ\text{C}$) ($i_F = 200$ Amps, $T_C = +25^\circ\text{C}$)	V_F	0.52 0.60	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_C = +25^\circ\text{C}$)	I_R	5	mA

(1) Rating applies when surface mounted on the minimum pad size recommended.

(2) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2\%$.

This document contains information on a product under development. Motorola reserves the right to change or discontinue this product without notice.

Preferred devices are Motorola recommended choices for future use and best overall value.

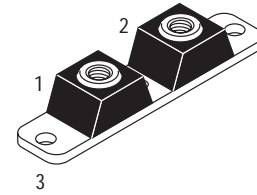
Preliminary Data Sheet

POWERTAP II
SWITCHMODE™ Power Rectifiers

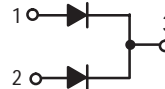
MBRP20045CT
MBRP20060CT

Motorola Preferred Devices

SCHOTTKY BARRIER
RECTIFIERS
200 AMPERES
45 to 60 VOLTS



CASE 357C-03
POWERTAP II



... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Dual Diode Construction — May Be Paralleled for Higher Current Output
- Guardring for Stress Protection
- Low Forward Voltage
- 175°C Operating Junction Temperature
- Guaranteed Reverse Avalanche

Mechanical Characteristics:

- Case: Epoxy, Molded with metal heatsink base
- Weight: 80 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Top Terminal Torque: 25–40 lb-in max
- Base Plate Torques: See procedure given in the Package Outline Section
- Shipped 25 units per foam
- Marking: B20045T, B20060T

MAXIMUM RATINGS

Rating	Symbol	MBRP20045CT	MBRP20060CT	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	45	60	Volts
Average Rectified Forward Current (Rated V_R) $T_C = 140^\circ\text{C}$ Per Device Per Leg	$I_{F(AV)}$	200 100	200 100	Amps
Peak Repetitive Forward Current, Per Leg (Rated V_R , Square Wave, 20 kHz), $T_C = 140^\circ\text{C}$	I_{FRM}	200	200	Amps
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	1500	1500	Amps
Peak Repetitive Reverse Current, Per Leg (2.0 μs , 1.0 kHz) See Figure 6.	I_{RRM}	2.0	2.0	Amps
Operating Junction Temperature	T_J	-55 to +175	-55 to +175	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55 to +150	-55 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10000	10000	$\text{V}/\mu\text{s}$

THERMAL CHARACTERISTICS PER LEG

Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.6	0.6	$^\circ\text{C}/\text{W}$
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ELECTRICAL CHARACTERISTICS PER LEG

Instantaneous Forward Voltage (1) ($i_F = 200$ Amps, $T_J = 25^\circ\text{C}$) ($i_F = 200$ Amps, $T_J = 25^\circ\text{C}$)	V_F	0.89 0.78	0.91 0.80	Volts
Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 125^\circ\text{C}$) (Rated dc Voltage, $T_J = 25^\circ\text{C}$)	i_R	50 0.5	50 0.5	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

This document contains information on a product under development. Motorola reserves the right to change or discontinue this product without notice.

Preferred devices are Motorola recommended choices for future use and best overall value.

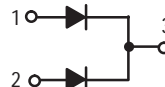
Preliminary Data Sheet
POWERTAP II
SWITCHMODE™ Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Dual Diode Construction — May Be Paralleled for Higher Current Output
- Guardring for Stress Protection
- Low Forward Voltage
- 175°C Operating Junction Temperature
- Guaranteed Reverse Avalanche

Mechanical Characteristics:

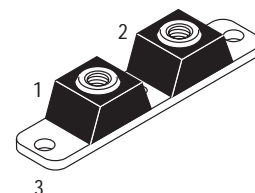
- Case: Epoxy, Molded with metal heatsink base
- Weight: 80 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Top Terminal Torque: 25–40 lb-in max
- Base Plate Torques: See procedure given in the Package Outline Section
- Shipped 25 units per foam
- Marking: B30045T, B30060T



MBRP30045CT
MBRP30060CT

Motorola Preferred Devices

**SCHOTTKY BARRIER
RECTIFIERS**
300 AMPERES
45 to 60 VOLTS



CASE 357C-03
POWERTAP II

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	45 60	Volts
Average Rectified Forward Current (Rated V_R) $T_C = 140^\circ\text{C}$	$I_{F(AV)}$	300 150	Amps
Peak Repetitive Forward Current, Per Leg (Rated V_R , Square Wave, 20 kHz), $T_C = 140^\circ\text{C}$	I_{FRM}	300	Amps
Non-Repetitive Peak Surge Current Per Leg (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	2500	Amps
Peak Repetitive Reverse Current, Per Leg (2.0 μs , 1.0 kHz) See Figure 6.	I_{RRM}	2.0	Amps
Operating Junction Temperature	T_J	-55 to +175	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10000	$\text{V}/\mu\text{s}$

THERMAL CHARACTERISTICS PER LEG

Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.45	$^\circ\text{C}/\text{W}$
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ELECTRICAL CHARACTERISTICS PER LEG

Instantaneous Forward Voltage (1) ($i_F = 150$ Amps, $T_J = 25^\circ\text{C}$) ($i_F = 300$ Amps, $T_J = 25^\circ\text{C}$) ($i_F = 150$ Amps, $T_J = 25^\circ\text{C}$) ($i_F = 300$ Amps, $T_J = 25^\circ\text{C}$)	V_F	0.70 0.82 0.79 0.89	Volts
Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 125^\circ\text{C}$) (Rated dc Voltage, $T_J = 25^\circ\text{C}$)	i_R	75 0.8	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

This document contains information on a product under development. Motorola reserves the right to change or discontinue this product without notice.

Preferred devices are Motorola recommended choices for future use and best overall value.

Product Preview

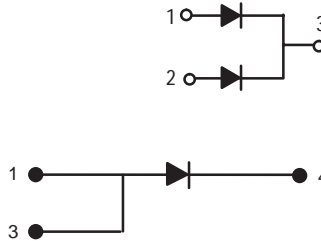
POWERTAP™ II
SWITCHMODE™ Power Rectifier

The SWITCHMODE Power Rectifier uses the Schottky Barrier principle with a platinum barrier metal. This state-of-the-art device has the following features:

- Dual Diode Construction — May Be Paralleled for Higher Current Output
- Guardring for Stress Protection
- Low Forward Voltage Drop
- 150°C Operating Junction Temperature
- Recyclable Epoxy
- Guaranteed Reverse Avalanche Energy Capability
- Improved Mechanical Ratings

Mechanical Characteristics

- Case: Epoxy, Molded with metal heatsink base
- Weight: 80 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Top Terminal Torque: 25–40 lb–in max
- Base Plate Torques: See procedure given in the Package Outline Section
- Shipped 25 units per foam
- Marking: B60035L



MBRP60035CTL

Motorola Preferred Device

LOW V_F
SCHOTTKY BARRIER
RECTIFIER
600 AMPERES
35 VOLTS

CASE 357C-03
POWERTAP II

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	35	Volts
Average Rectified Forward Current (At Rated V_R , $T_C = +100^\circ\text{C}$)	$I_F(AV)$	300 600	Amps Per Leg Per Device
Peak Repetitive Forward Current (At Rated V_R , Square Wave, 20 kHz) $T_C = +100^\circ\text{C}$	I_{FRM}	300	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	4000	Amps
Peak Repetitive Reverse Surge Current (2 μs , 1 kHz)	I_{RRM}	2	Amp
Storage Temperature	T_{stg}	-55 to +150	$^\circ\text{C}$
Operating Junction Temperature	T_J	-55 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10000	$\text{V}/\mu\text{s}$

THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Case	$R_{\theta JC}$	0.4	$^\circ\text{C}/\text{W}$
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ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (2) ($i_F = 300$ Amps, $T_C = +25^\circ\text{C}$) ($i_F = 300$ Amps, $T_C = +100^\circ\text{C}$)	V_F	0.57 0.50	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_C = +25^\circ\text{C}$) (Rated dc Voltage, $T_C = +100^\circ\text{C}$)	I_R	10 250	mA

(1) Rating applies when surface mounted on the minimum pad size recommended.

(2) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2\%$.


This document contains information on a product under development. Motorola reserves the right to change or discontinue this product without notice.

Preferred devices are Motorola recommended choices for future use and best overall value.

Advance Information
SWITCHMODE™ Schottky
Power Rectifier

MBR240100V

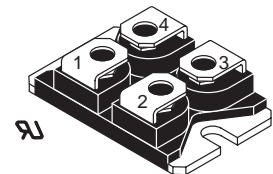
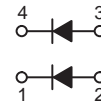
... using the Schottky Barrier principle with a platinum barrier metal. This state-of-the-art device has the following features:

- 100 V Blocking Voltage, Low Forward Voltage Drop
- Double Rectifier Diodes Construction: May Be Paralleled for Higher Current Output up to 80 Amp
- Guardring Construction Guarantees Stress Protection, High dV/dt Capability (10 kV/μs) and Reverse Avalanche
- Very Low Internal Parasitic Inductance (≤ 5.0 nH)
- Isolated Power Package (2500 Vac Insulation Rating)
- 175°C Operating Junction Temperature
-  — UL Recognized, File #E69369

Mechanical Characteristics

- Case: Molded epoxy with isolated metal base
- Weight: 28 g (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Shipped 10 units per plastic tube
- Marking: MBR240100V

**SCHOTTKY BARRIER
RECTIFIER
80 AMPERES
100 VOLTS**



SOT-227B, STYLE 2

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	100	Volts
Average Rectified Forward Current — Per Diode (Rated V_C) @ $T_C = 125^\circ\text{C}$ — Per Device	$I_{F(AV)}$	40 80	Amps
Peak Repetitive Forward Current, Per Diode (Rated V_R , Square Wave, 20 kHz) @ $T_C = 90^\circ\text{C}$	I_{FRM}	120	Amps
Non Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	600	Amps
Peak Repetitive Reverse Current (2.0 μs, 1.0 kHz)	I_{RRM}	2.0	Amps
Operating Junction Temperature	T_J	-65 to 150	°C
Storage Temperature	T_{stg}	-65 to 150	°C
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175	°C
Voltage Rate of Change	dV/dt	10000	V/μs
Package Insulation Rating (AC)	V_{isol}	2500	Volts

This document contains information on a new product. Specifications and information herein are subject to change without notice.

Rev 1

MBR240100V

THERMAL CHARACTERISTICS

Rating	Symbol	Max	Unit
Thermal Resistance, Junction to Case Per Diode Per Device	$R_{\theta JC}$	1.2 0.7	$^{\circ}C/W$

ELECTRICAL CHARACTERISTICS PER DIODE

Instantaneous Forward Voltage (1) @ $i_F = 40$ Amps, $T_C = 25^{\circ}C$ @ $i_F = 40$ Amps, $T_C = 100^{\circ}C$ @ $i_F = 80$ Amps, $T_C = 100^{\circ}C$	V_F	0.95 0.80 0.90	Volts
Instantaneous Reverse Current (1) @ Rated DC Voltage, $T_C = 25^{\circ}C$ @ Rated DC Voltage, $T_C = 100^{\circ}C$	i_R	0.1 20	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle < 2.0%

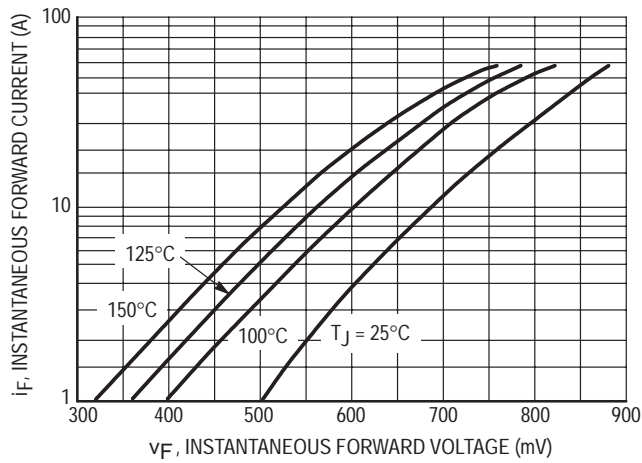


Figure 1. Typical Forward Voltage

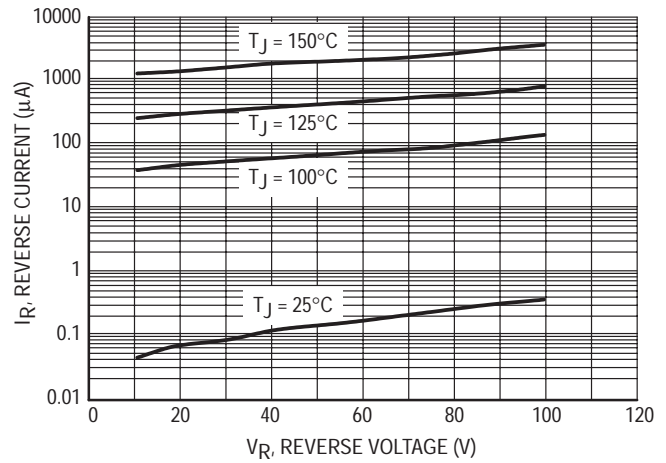



Figure 2. Typical Reverse Current

Advance Information
SWITCHMODE™ Schottky
Power Rectifier

... using the Schottky Barrier principle with a Platinum barrier metal. This state-of-the-art device has the following features:

- 60 V Blocking Voltage, Low Forward Voltage Drop
- Double Rectifier Diodes Construction: May Be Paralleled for Higher Current Output up to 100 Amp
- Guardring Construction Guarantees Stress Protection, High dV/dt Capability (10 kV/μs) and Reverse Avalanche
- Very Low Internal Parasitic Inductance (≤ 5.0 nH)
- Isolated Power Package (2500 Vac Insulation Rating)
- 150°C Operating Junction Temperature
-  — UL Recognized, File #E69369

Mechanical Characteristics

- Case: Molded epoxy with isolated metal base
- Weight: 28 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Shipped 10 units per plastic tube
- Marking: MBR25060V

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	60	Volts
Average Rectified Forward Current — Per Diode (Rated V_R) @ $T_C = 125^\circ\text{C}$ — Per Device	$I_{F(AV)}$	50 100	Amps
Peak Repetitive Forward Current, Per Diode (Rated V_R , Square Wave, 20 kHz) @ $T_C = 90^\circ\text{C}$	I_{FRM}	150	Amps
Non Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	800	Amps
Peak Repetitive Reverse Current (2.0 μs, 1.0 kHz)	I_{RRM}	2.0	Amps
Operating Junction Temperature	T_J	-65 to 150	°C
Storage Temperature	T_{stg}	-65 to 150	°C
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175	°C
Voltage Rate of Change	dV/dt	10000	V/μs
Package Insulation Rating (AC)	V_{isol}	2500	Volts

THERMAL CHARACTERISTICS

Thermal Resistance, Junction to Case	Per Diode Per Device	$R_{\theta JC}$	1.2 0.7	°C/W
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ELECTRICAL CHARACTERISTICS PER DIODE

Instantaneous Forward Voltage (1) @ $i_F = 50$ Amps, $T_C = 25^\circ\text{C}$ @ $i_F = 50$ Amps, $T_C = 100^\circ\text{C}$	v_F	0.65 0.60	Volts
Instantaneous Reverse Current (1) @ Rated DC Voltage, $T_C = 25^\circ\text{C}$ @ Rated DC Voltage, $T_C = 100^\circ\text{C}$	i_R	0.5 20	mA

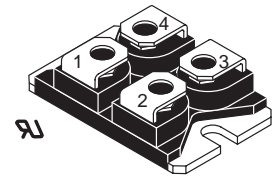
(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle < 2.0%

This document contains information on a new product. Specifications and information herein are subject to change without notice.

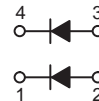
Rev 1

MBR25060V

**SCHOTTKY BARRIER
RECTIFIER
100 AMPERES
60 VOLTS**




SOT-227B, STYLE 2



Advance Information
SWITCHMODE™ Schottky
Power Rectifier

MBR28045V

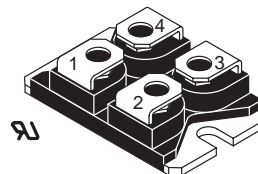
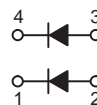
... using the Schottky Barrier principle with a platinum barrier metal. This state-of-the-art device has the following features:

- 45 V Blocking Voltage, Low Forward Voltage Drop
- Double Rectifier Diodes Construction: May Be Paralleled for Higher Current Output up to 160 Amp
- Guardring Construction Guarantees Stress Protection, High dV/dt Capability (10 kV/ μ s) and Reverse Avalanche
- Very Low Internal Parasitic Inductance (≤ 5.0 nH)
- Isolated Power Package (2500 Vac Insulation Rating)
- 175°C Operating Junction Temperature
-  — UL Recognized, File #E69369

**SCHOTTKY BARRIER
RECTIFIER
160 AMPERES
45 VOLTS**

Mechanical Characteristics

- Case: Molded epoxy with isolated metal base
- Weight: 28 g (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Shipped 10 units per plastic tube
- Marking: MBR28045V



SOT-227B, STYLE 2

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	45	Volts
Average Rectified Forward Current — Per Diode (Rated V_R) @ $T_C = 125^\circ\text{C}$ — Per Device	$I_{F(AV)}$	80 160	Amps
Peak Repetitive Forward Current, Per Diode (Rated V_R , Square Wave, 20 kHz) @ $T_C = 90^\circ\text{C}$	I_{FRM}	145	Amps
Non Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	900	Amps
Peak Repetitive Reverse Current (2.0 μ s, 1.0 kHz)	I_{RRM}	2.0	Amps
Operating Junction Temperature	T_J	-65 to 150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to 150	$^\circ\text{C}$
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175	$^\circ\text{C}$
Voltage Rate of Change	dV/dt	10000	V/ μ s
Package Insulation Rating (AC)	V_{isol}	2500	Volts

THERMAL CHARACTERISTICS

Thermal Resistance, Junction to Case	Per Diode Per Device	$R_{\theta JC}$	1.1 0.6	$^\circ\text{C/W}$
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This document contains information on a new product. Specifications and information herein are subject to change without notice.

Rev 1

MBR28045V

ELECTRICAL CHARACTERISTICS PER DIODE

Instantaneous Forward Voltage (1) @ $i_F = 80$ Amps, $T_C = 25^\circ\text{C}$ @ $i_F = 80$ Amps, $T_C = 150^\circ\text{C}$ @ $i_F = 160$ Amps, $T_C = 25^\circ\text{C}$	v_F	0.8 0.69 1.0	Volts
Instantaneous Reverse Current (1) @ Rated DC Voltage, $T_C = 25^\circ\text{C}$ @ Rated DC Voltage, $T_C = 100^\circ\text{C}$	i_R	1.0 80	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle < 2.0%

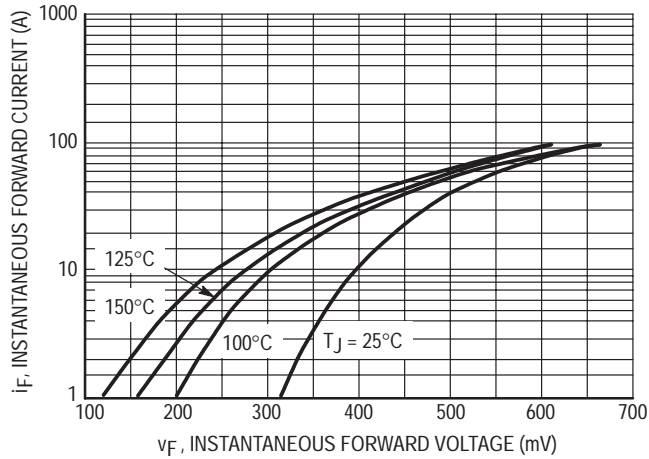


Figure 1. Typical Forward Voltage

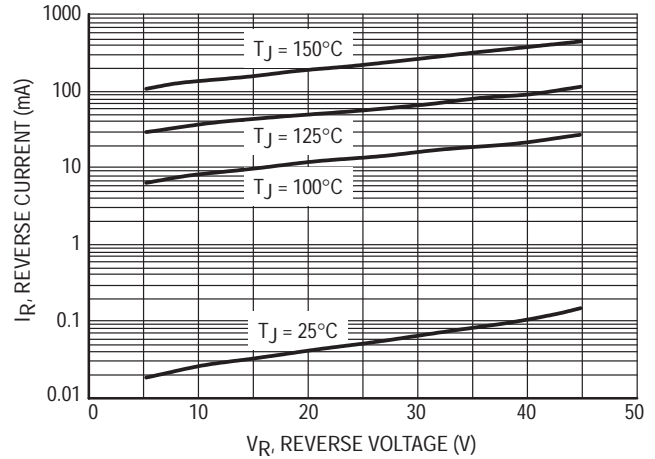


Figure 2. Typical Reverse Current

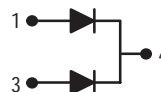
SWITCHMODE™ Power Rectifier

Using the Schottky Barrier principle with a proprietary barrier metal. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Maximum Die Size
- 150°C Operating Junction Temperature
- Short Heat Sink Tab Manufactured – Not Sheared

Mechanical Characteristics:

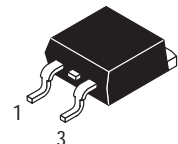
- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 Units per Plastic Tube
- Available in 24 mm Tape and Reel, 800 Units per 13" Reel by Adding a "T4" Suffix to the Part Number
- Marking: B3030



MBRB3030CT

Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIER
30 AMPERES
30 VOLTS**



**CASE 418B-02
D2PAK**

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	30	V
Average Rectified Forward Current (At Rated V_R) $T_C = +134^\circ\text{C}$	$I_{F(AV)}$	30 15	A Per Device Per Leg
Peak Repetitive Forward Current, Per Leg (At Rated V_R , Square Wave, 20 kHz) $T_C = +137^\circ\text{C}$	I_{FRM}	30	A
Nonrepetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I_{FSM}	200	A
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz)	I_{RRM}	2.0	A
Storage Temperature	T_{stg}	- 55 to +150	$^\circ\text{C}$
Operating Junction Temperature	T_J	- 55 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10000	V/ μs
Reverse Energy (Unclamped Inductive Surge) (Inductance = 3 mH, $T_C = 25^\circ\text{C}$)	W	100	mJ

THERMAL CHARACTERISTICS

Thermal Resistance – Junction to Case	$R_{\theta JC}$	1.0	$^\circ\text{C}/\text{W}$
Thermal Resistance – Junction to Ambient (1)	$R_{\theta JA}$	50	$^\circ\text{C}/\text{W}$

ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (2), per Leg ($I_F = 15\text{ A}$, $T_C = +25^\circ\text{C}$) ($I_F = 15\text{ A}$, $T_C = +150^\circ\text{C}$) ($I_F = 30\text{ A}$, $T_C = +25^\circ\text{C}$) ($I_F = 30\text{ A}$, $T_C = +150^\circ\text{C}$)	V_F	0.54 0.47 0.67 0.66	V
Maximum Instantaneous Reverse Current (2), per Leg (Rated DC Voltage, $T_C = +25^\circ\text{C}$) (Reverse Voltage = 10 V, $T_C = +150^\circ\text{C}$) (Rate DC Voltage, $T_C = +150^\circ\text{C}$)	I_R	0.6 46 145	mA

(1) When mounted using minimum recommended pad size on FR-4 board.

(2) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$

Preferred devices are Motorola recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS

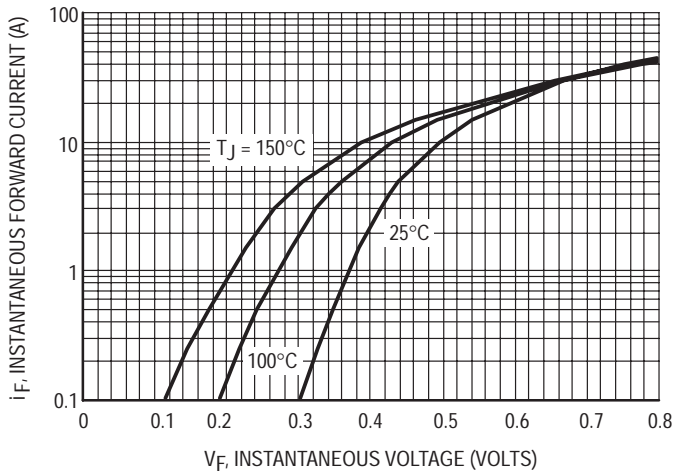


Figure 1. Maximum Forward Voltage, Per Leg

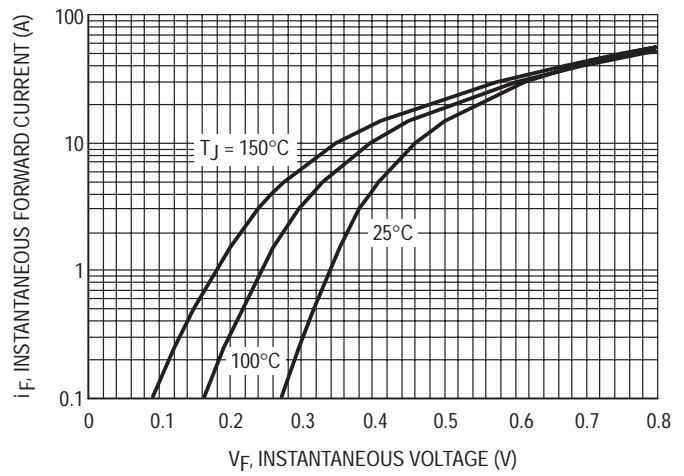


Figure 2. Typical Forward Voltage, Per Leg

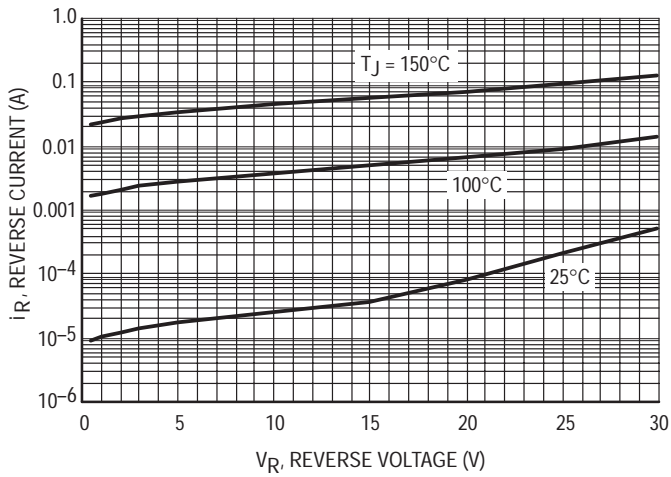


Figure 3. Maximum Reverse Current, Per Leg

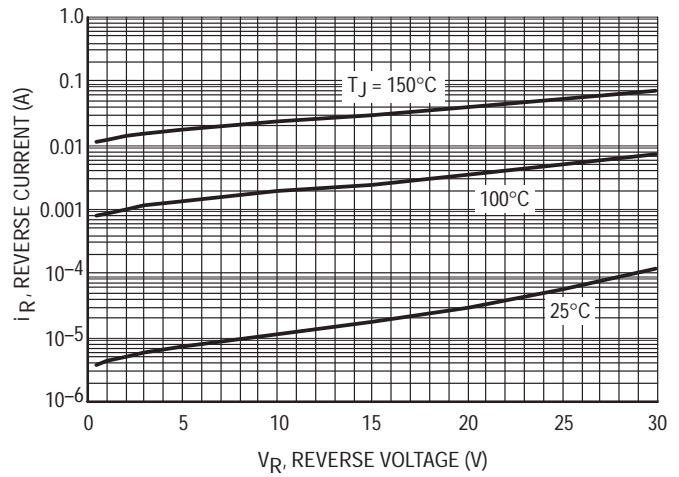


Figure 4. Typical Reverse Current, Per Leg

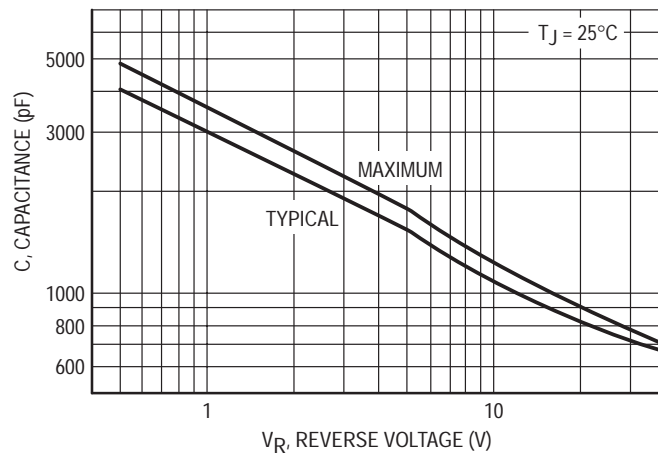


Figure 5. Capacitance

TYPICAL CHARACTERISTICS

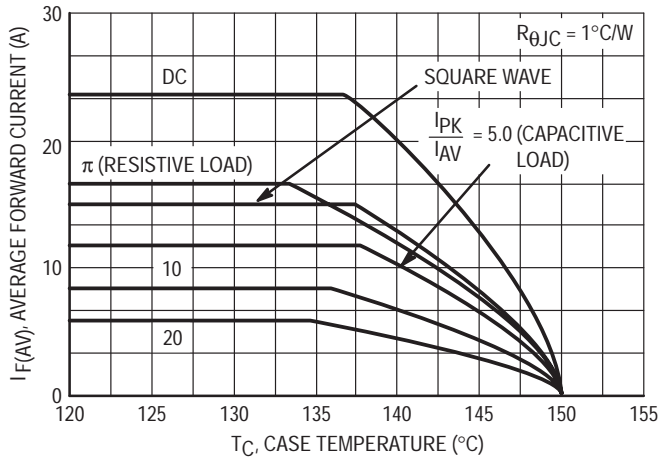


Figure 6. Current Derating, Infinite Heatsink

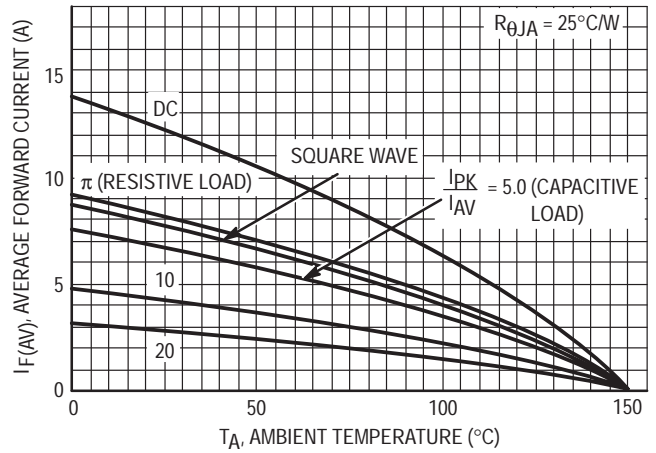


Figure 7. Current Derating

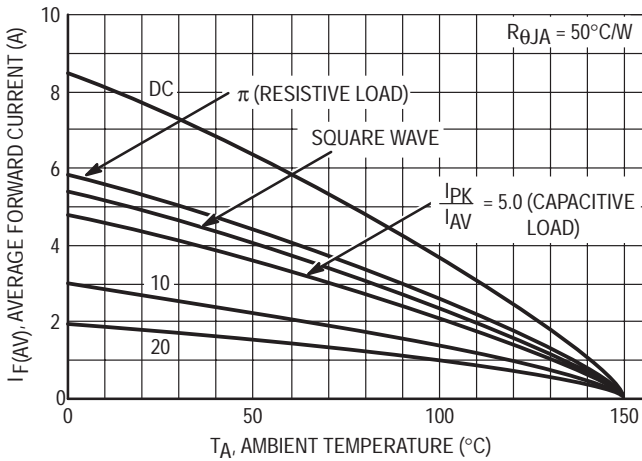


Figure 8. Current Derating, Free Air

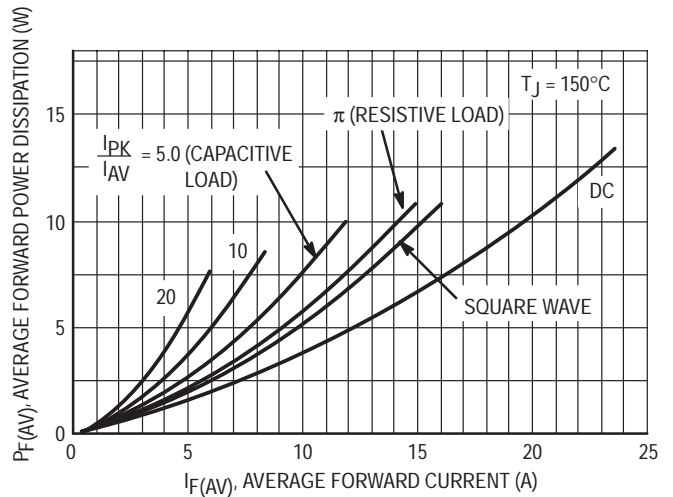


Figure 9. Forward Power Dissipation

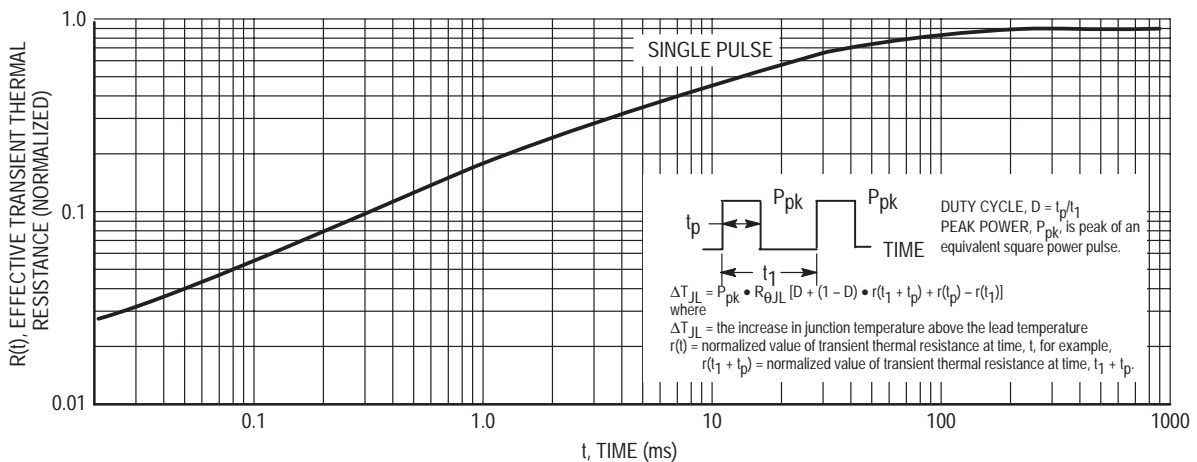


Figure 10. Thermal Response

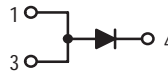
SWITCHMODE™ Power Rectifier

Using the Schottky Barrier principle with a proprietary barrier metal. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Maximum Die Size
- 150°C Operating Junction Temperature
- Short Heat Sink Tab Manufactured – Not Sheared

Mechanical Characteristics

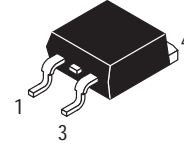
- Case: Epoxy, Molded
- Weight: 1.7 Grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads Readily Solderable
- Shipped 50 Units per Plastic Tube
- Available in 24 mm Tape and Reel, 800 Units per 13" Reel by Adding a "T4" Suffix to the Part Number
- Marking: B4030



MBRB4030

Motorola Preferred Device

**SCHOTTKY BARRIER
RECTIFIER
40 AMPERES
30 VOLTS**



**CASE 418B-02
D2PAK**

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	30	V
Average Rectified Forward Current (At Rated V_R) $T_C = +115^\circ\text{C}$ (1)	$I_F(\text{AV})$	40	A
Peak Repetitive Forward Current (At Rated V_R , Square Wave, 20 kHz) $T_C = +112^\circ\text{C}$	I_{FRM}	80	A
Nonrepetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I_{FSM}	300	A
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz)	I_{RRM}	2.0	A
Storage Temperature	T_{stg}	- 65 to +150	$^\circ\text{C}$
Operating Junction Temperature	T_J	- 65 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated V_R)	dv/dt	10,000	V/ μs
Reverse Energy (Unclamped Inductive Surge) (Inductance = 3 mH), $T_C = 25^\circ\text{C}$	W	600	mJ

THERMAL CHARACTERISTICS

Thermal Resistance – Junction to Case	$R_{\theta\text{JC}}$	1.0	$^\circ\text{C}/\text{W}$
Thermal Resistance – Junction to Ambient (2)	$R_{\theta\text{JA}}$	50	$^\circ\text{C}/\text{W}$

ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1 and 3), per Device ($I_F = 20\text{ A}$, $T_C = +25^\circ\text{C}$) ($I_F = 20\text{ A}$, $T_C = +150^\circ\text{C}$) ($I_F = 40\text{ A}$, $T_C = +25^\circ\text{C}$) ($I_F = 40\text{ A}$, $T_C = +150^\circ\text{C}$)	V_F	0.46 0.34 0.55 0.45	V
Maximum Instantaneous Reverse Current (3), per Device (Rated DC Voltage, $T_C = +25^\circ\text{C}$) (Rated DC Voltage, $T_C = +125^\circ\text{C}$)	I_R	0.35 150	mA

(1) Rating applies when pins 1 and 3 are connected.

(2) Rating applies when surface mounted on the minimum pad size recommended.

(3) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$

Preferred devices are Motorola recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS

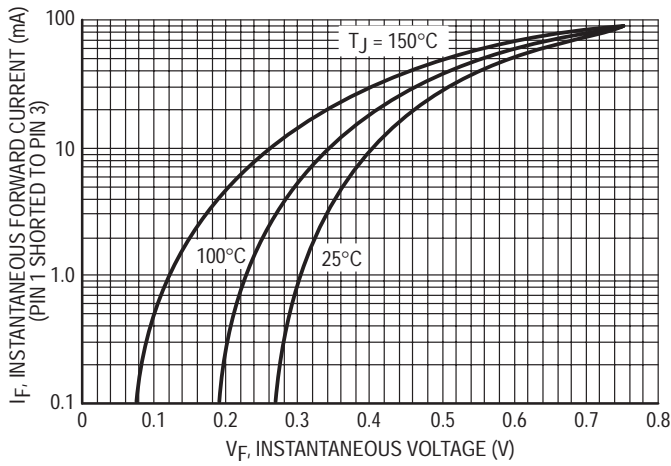


Figure 1. Maximum Forward Voltage

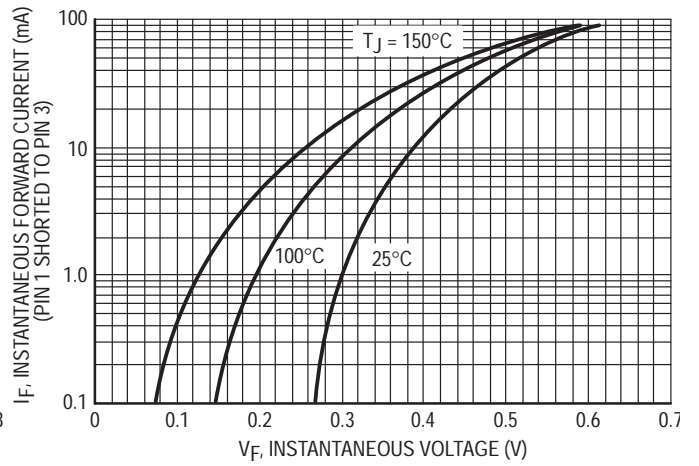


Figure 2. Typical Forward Voltage

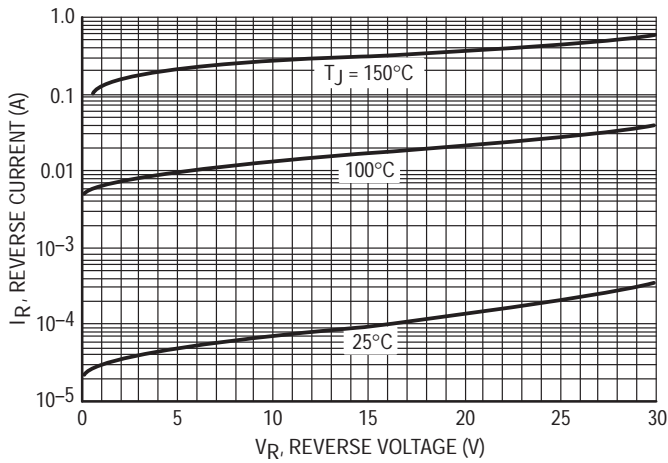


Figure 3. Maximum Reverse Current

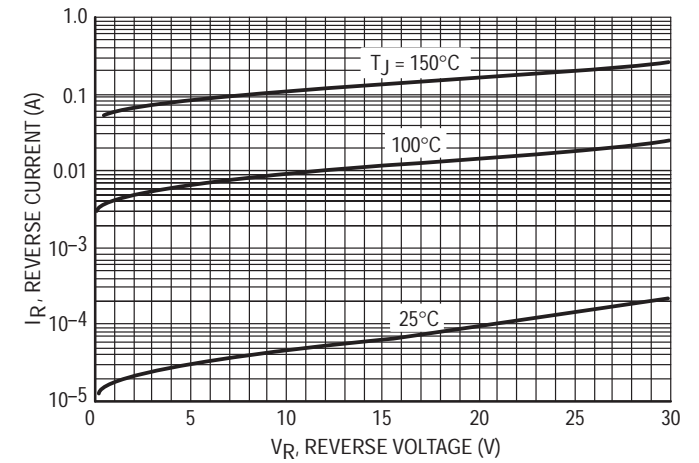


Figure 4. Typical Reverse Current

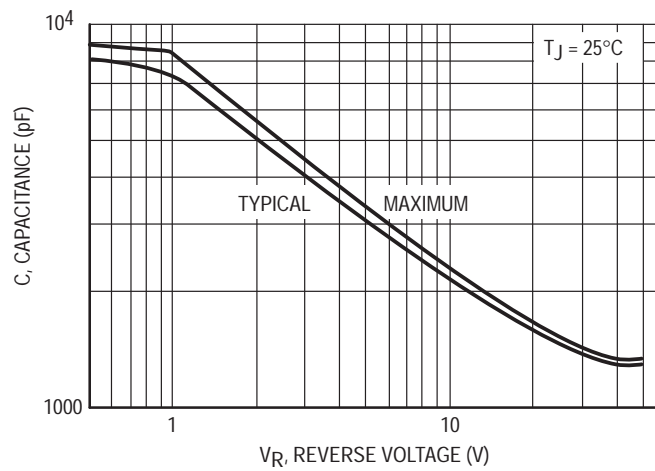


Figure 5. Maximum and Typical Capacitance

ELECTRICAL CHARACTERISTICS

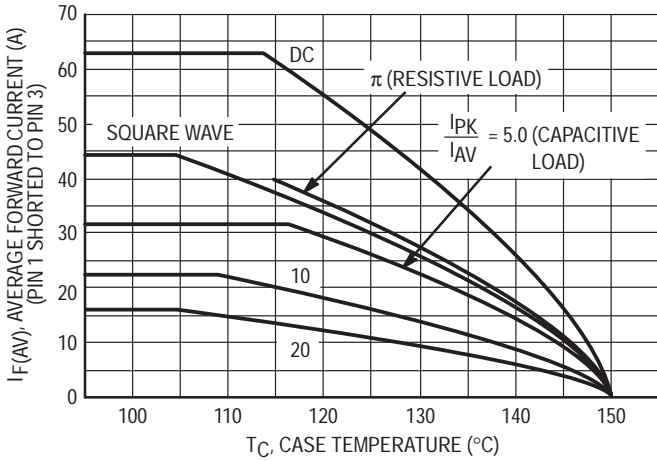


Figure 6. Current Derating, Infinite Heatsink

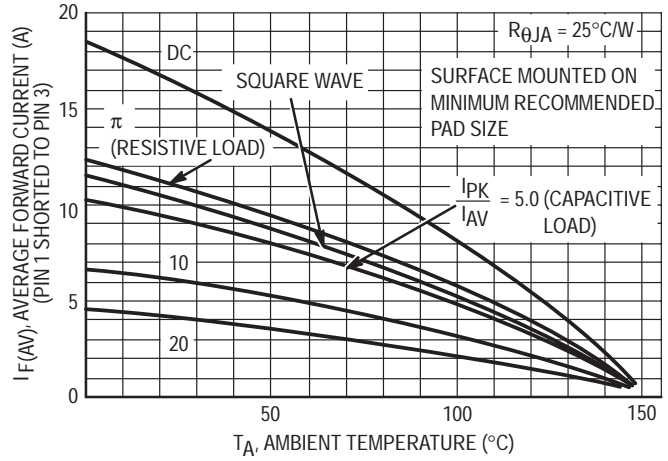


Figure 7. Current Derating

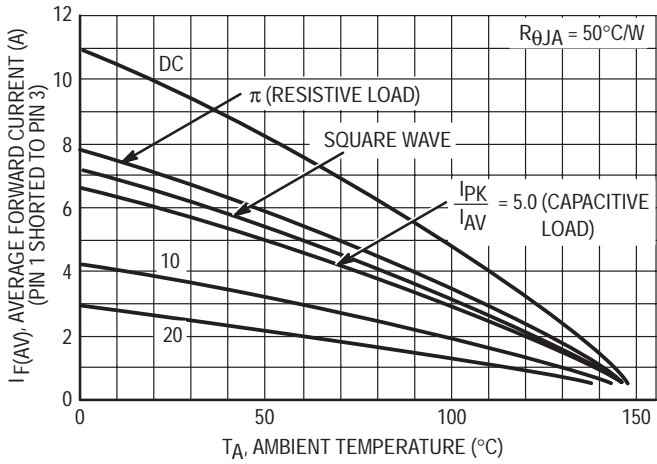


Figure 8. Current Derating, Free Air

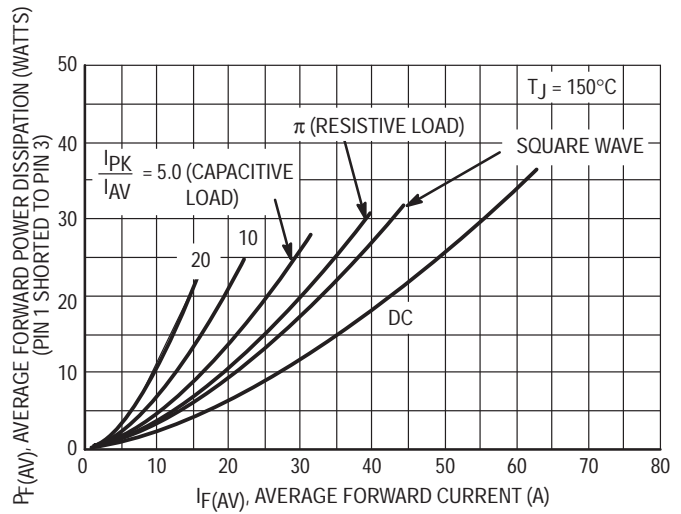


Figure 9. Forward Power Dissipation

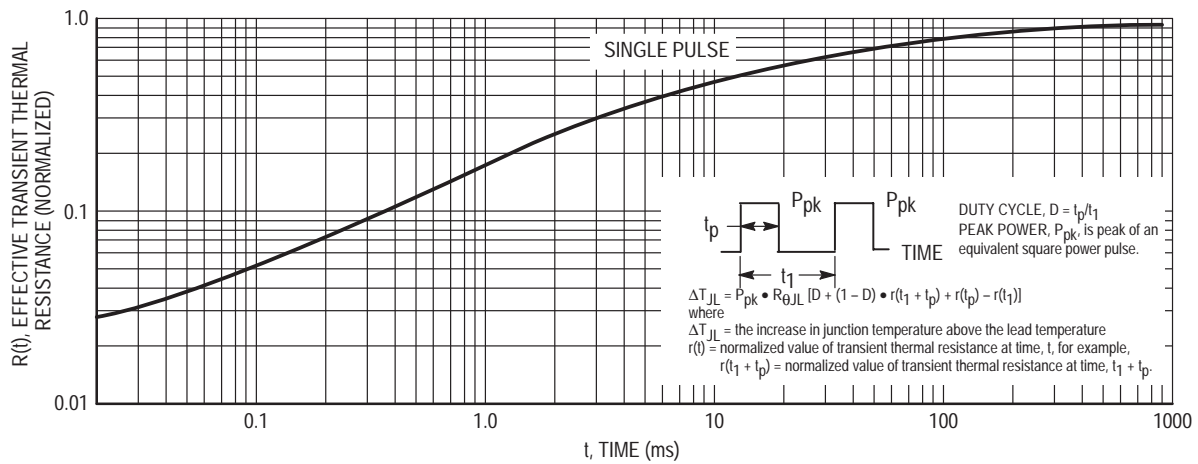


Figure 10. Thermal Response

Section 4

Ultrafast Data Sheets

Surface Mount Ultrafast Power Rectifiers

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (0.71 to 1.05 Volts Max @ 1.0 A, T_J = 150°C)

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 95 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 2500 units per reel
- Polarity: Notch in Plastic Body Indicates Cathode Lead
- Marking: U1D, U1J

MURS120T3
MURS160T3

Motorola Preferred Devices

ULTRAFAST RECTIFIERS
1.0 AMPERE
200-600 VOLTS



CASE 403A-03

MAXIMUM RATINGS

Rating	Symbol	MURS		Unit
		120T3	160T3	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _R RM V _R RWM V _R	200	600	Volts
Average Rectified Forward Current	I _F (AV)	1.0 @ T _L = 155°C 2.0 @ T _L = 145°C	1.0 @ T _L = 150°C 2.0 @ T _L = 125°C	Amps
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I _{FSM}	40	35	Amps
Operating Junction Temperature	T _J	-65 to +175		°C

THERMAL CHARACTERISTICS

Thermal Resistance, Junction to Lead (T _L = 25°C)	R _θ JL	13	°C/W
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ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) (i _F = 1.0 A, T _J = 25°C) (i _F = 1.0 A, T _J = 150°C)	V _F	0.875 0.71	1.25 1.05	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, T _J = 25°C) (Rated dc Voltage, T _J = 150°C)	i _R	2.0 50	5.0 150	μA
Maximum Reverse Recovery Time (i _F = 1.0 A, di/dt = 50 A/μs) (i _F = 0.5 A, i _R = 1.0 A, I _R to 0.25 A)	t _{rr}	35 25	75 50	ns
Maximum Forward Recovery Time (i _F = 1.0 A, di/dt = 100 A/μs, Rec. to 1.0 V)	t _{fr}	25	50	ns

(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 2

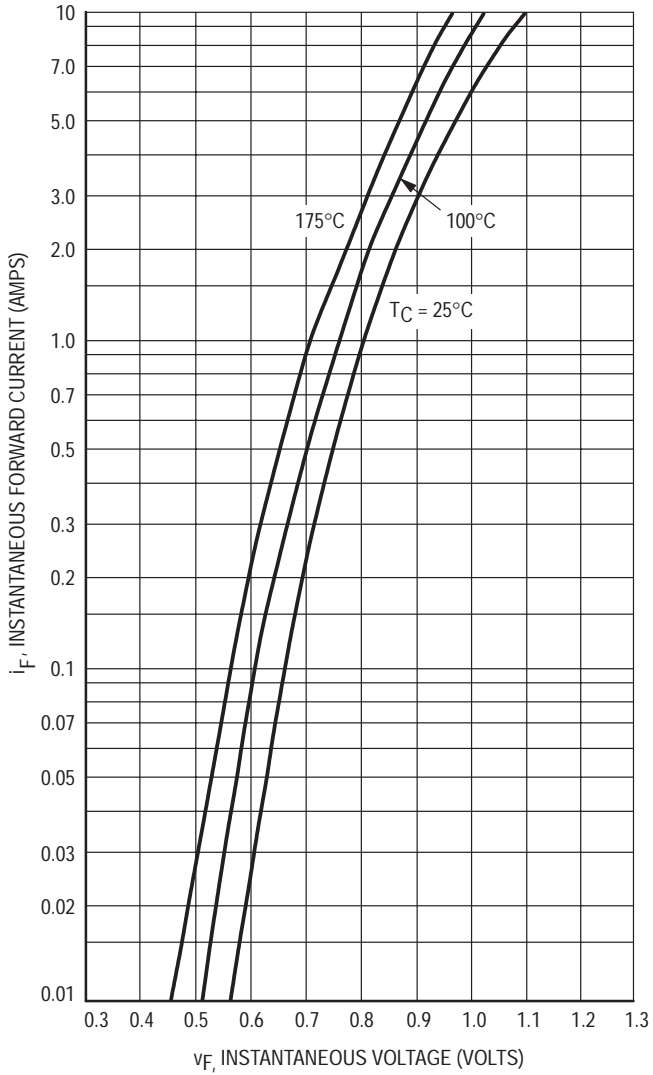


Figure 1. Typical Forward Voltage

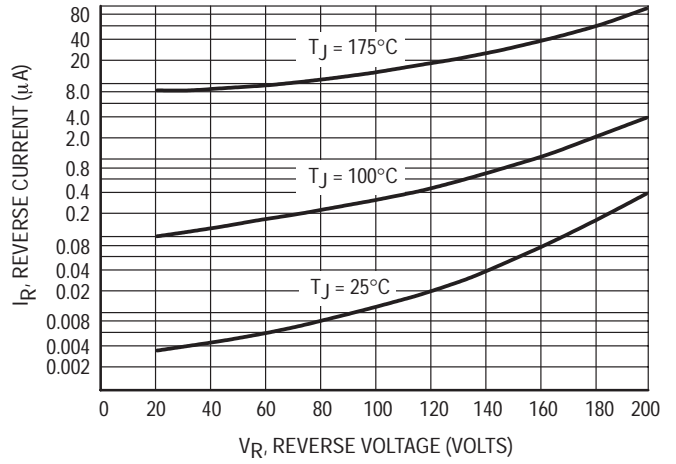


Figure 2. Typical Reverse Current*

* The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if applied V_R is sufficiently below rated V_R .

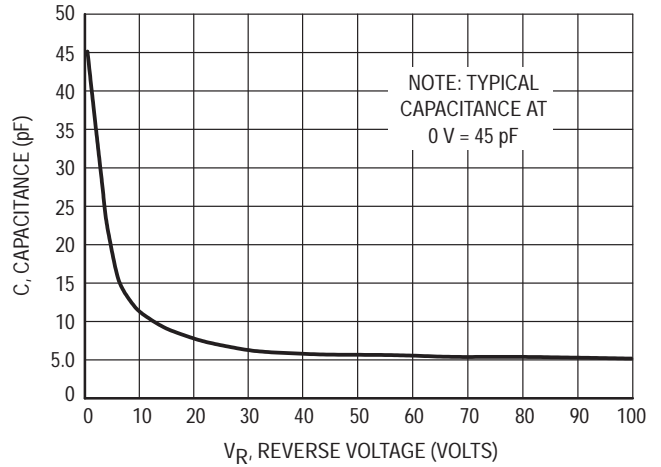


Figure 3. Typical Capacitance

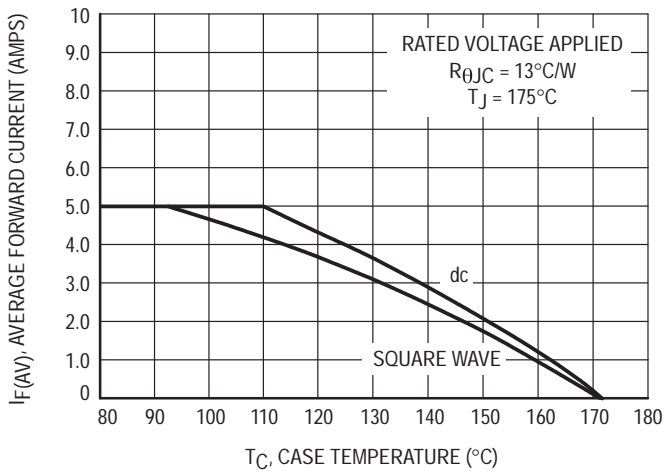


Figure 4. Current Derating, Case

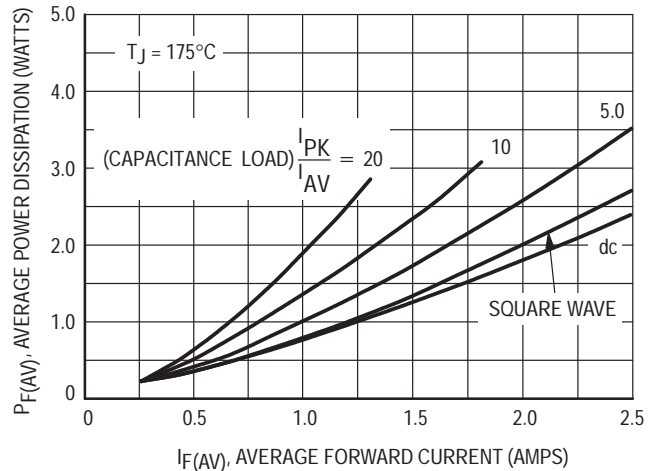


Figure 5. Power Dissipation

MURS120T3 MURS160T3

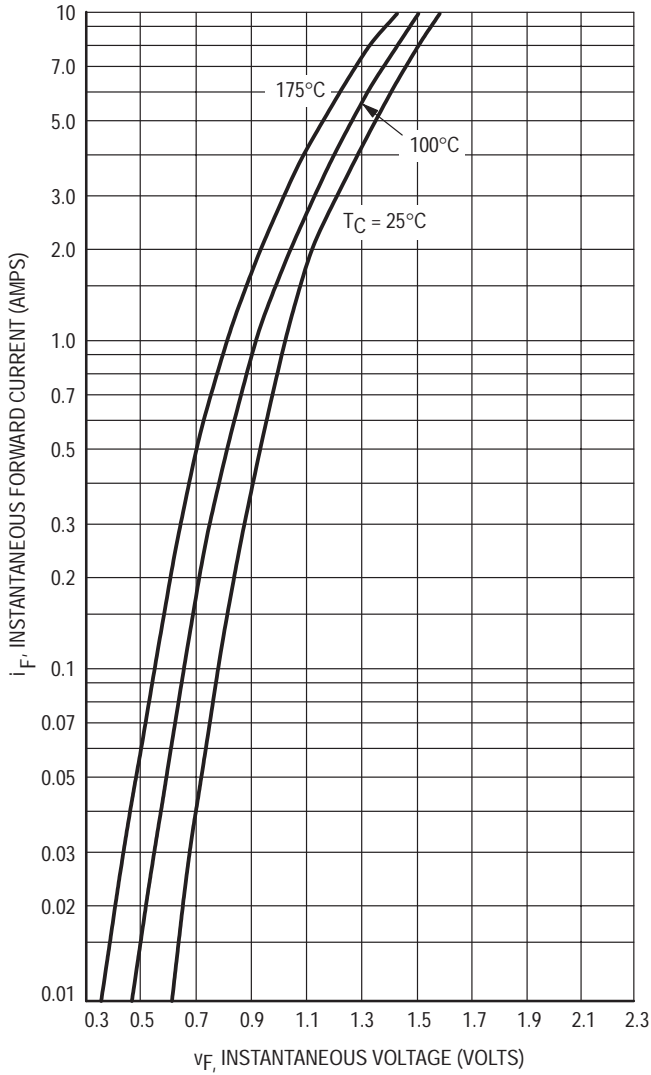


Figure 6. Typical Forward Voltage

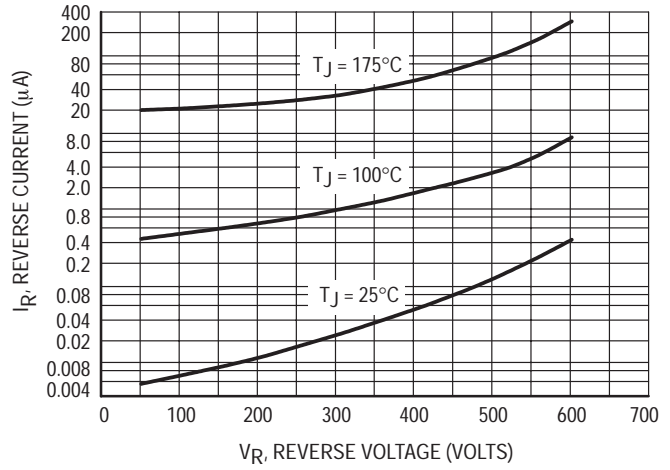


Figure 7. Typical Reverse Current*

* The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if applied V_R is sufficiently below rated V_R .

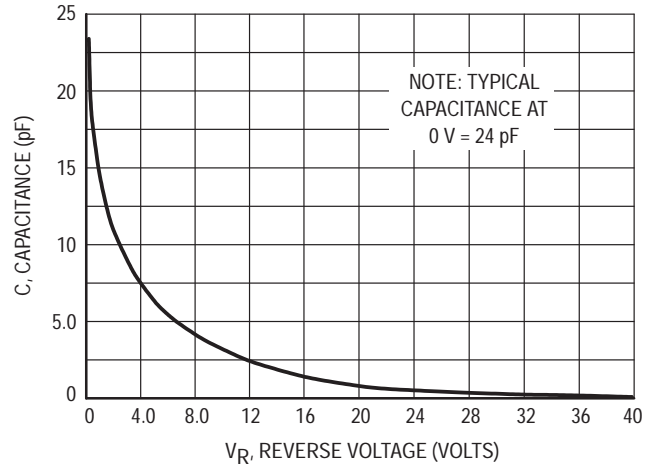


Figure 8. Typical Capacitance

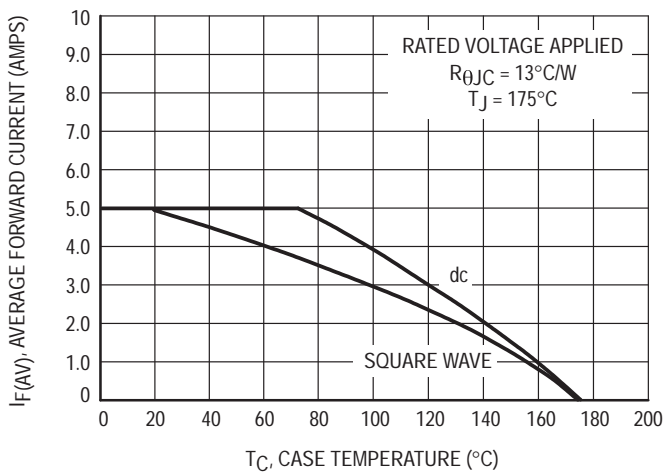


Figure 9. Current Derating, Case

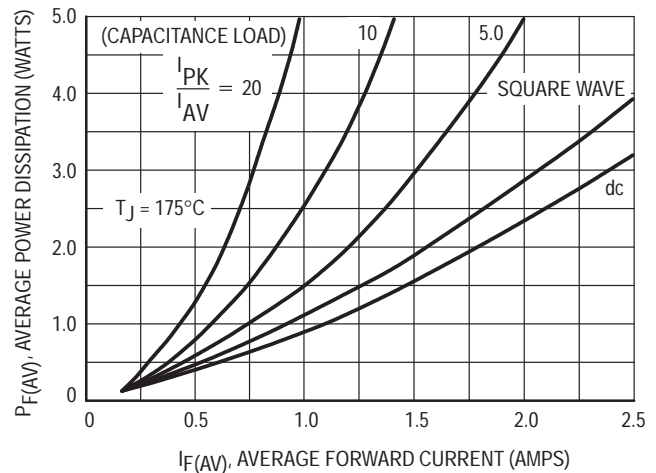


Figure 10. Power Dissipation

Surface Mount Ultrafast Power Rectifiers

... employing state-of-the-art epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes, in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Low Forward Voltage Drop (0.71 to 1.05 Volts Max @ 3.0 A, T_J = 150°C)

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 217 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 16 mm Tape and Reel, 2500 units per reel
- Polarity: Notch in Plastic Body Indicates Cathode Lead
- Marking: U3D, U3J

MURS320T3
MURS360T3

Motorola Preferred Devices

ULTRAFAST RECTIFIERS
3.0 AMPERES
200–600 VOLTS



CASE 403-03

MAXIMUM RATINGS

Rating	Symbol	MURS		Unit
		320T3	360T3	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	200	600	Volts
Average Rectified Forward Current	I _{F(AV)}	3.0 @ T _L = 140°C 4.0 @ T _L = 130°C	3.0 @ T _L = 130°C 4.0 @ T _L = 115°C	Amps
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I _{FSM}	75		Amps
Operating Junction Temperature	T _J	-65 to +175		°C

THERMAL CHARACTERISTICS

Thermal Resistance, Junction to Lead	R _{θJL}	11	°C/W
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ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) (i _F = 3.0 A, T _J = 25°C) (i _F = 4.0 A, T _J = 25°C) (i _F = 3.0 A, T _J = 150°C)	v _F	0.875 0.89 0.71	1.25 1.28 1.05	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, T _J = 25°C) (Rated dc Voltage, T _J = 150°C)	i _R	5.0 15	10 250	μA
Maximum Reverse Recovery Time (i _F = 1.0 A, di/dt = 50 A/μs) (i _F = 0.5 A, i _R = 1.0 A, I _{REC} to 0.25 A)	t _{rr}	35 25	75 50	ns
Maximum Forward Recovery Time (i _F = 1.0 A, di/dt = 100 A/μs, Recovery to 1.0 V)	t _{fr}	25	50	ns

(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 2

MURS320T3 MURS360T3

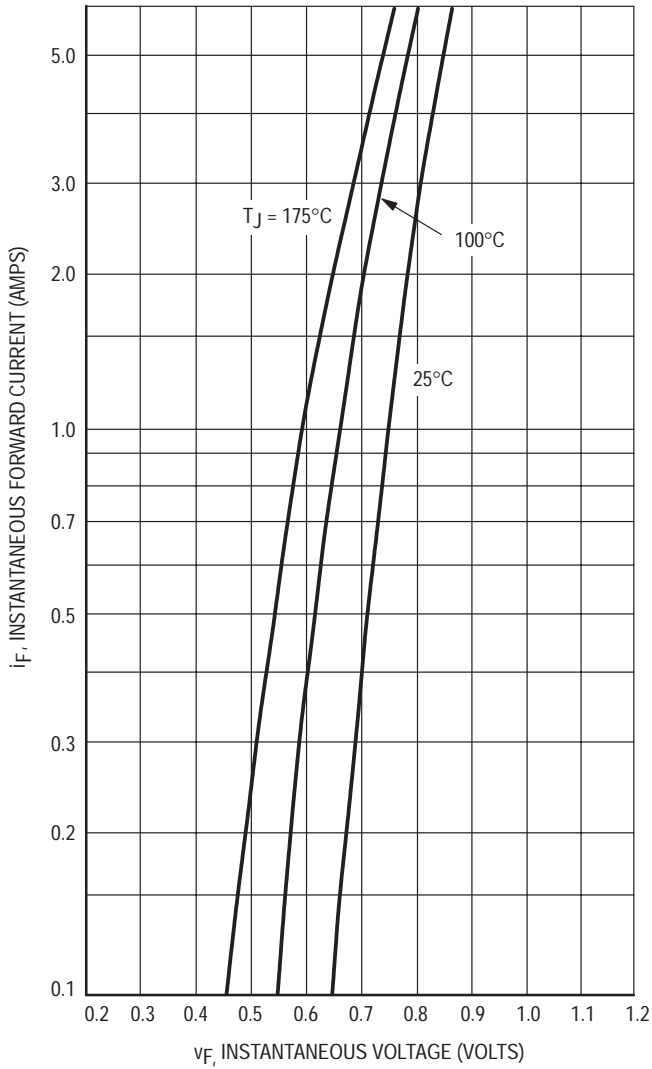


Figure 1. Typical Forward Voltage

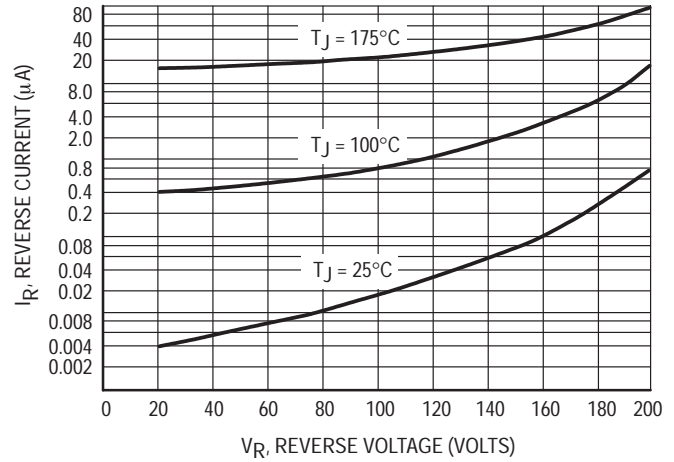


Figure 2. Typical Reverse Current*

* The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V_R is sufficiently below rated V_R .

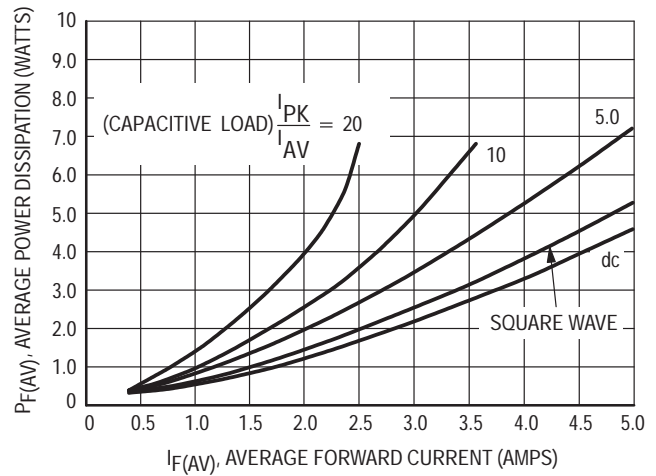


Figure 3. Power Dissipation

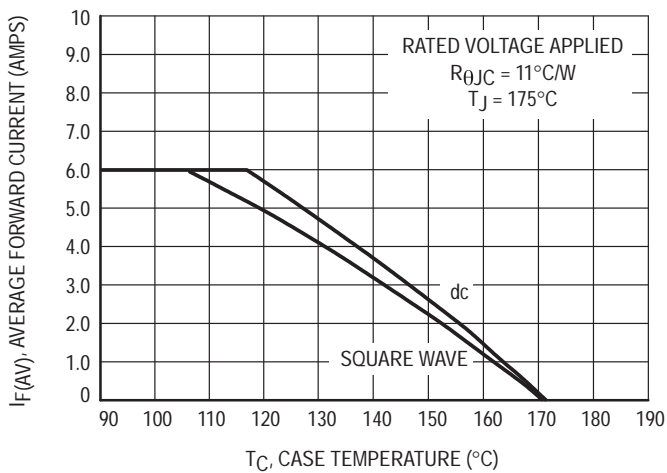


Figure 4. Current Derating, Case

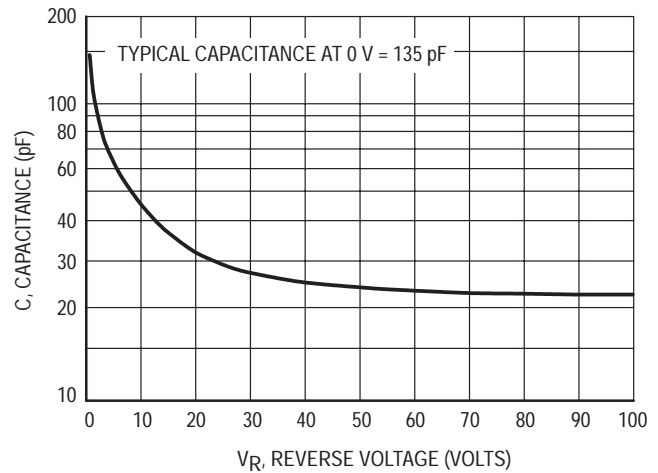


Figure 5. Typical Capacitance

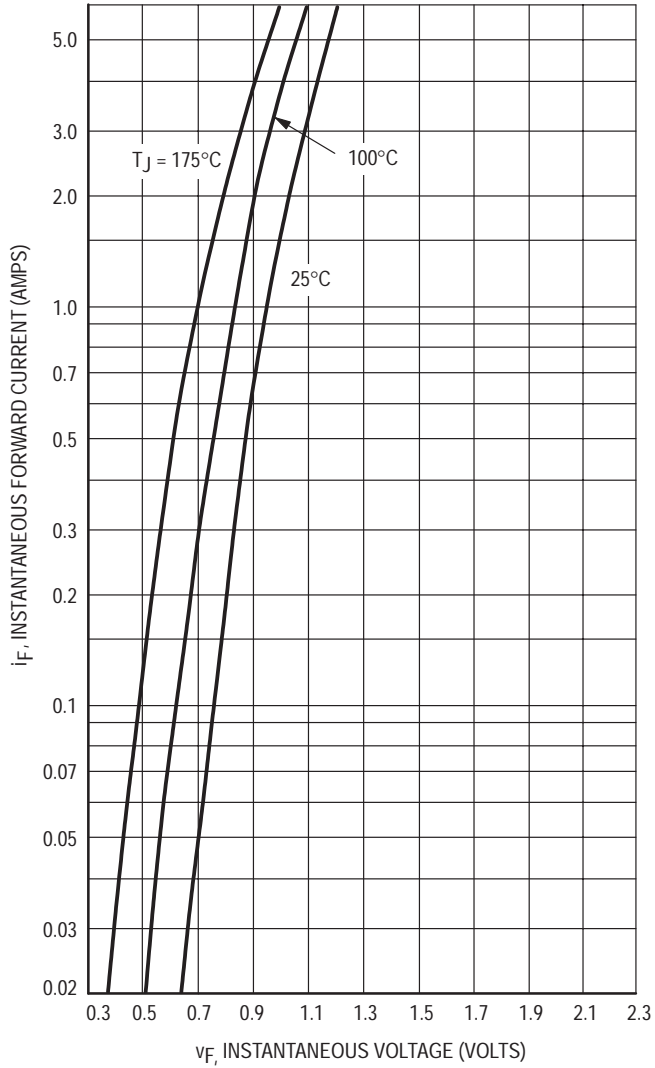


Figure 6. Typical Forward Voltage

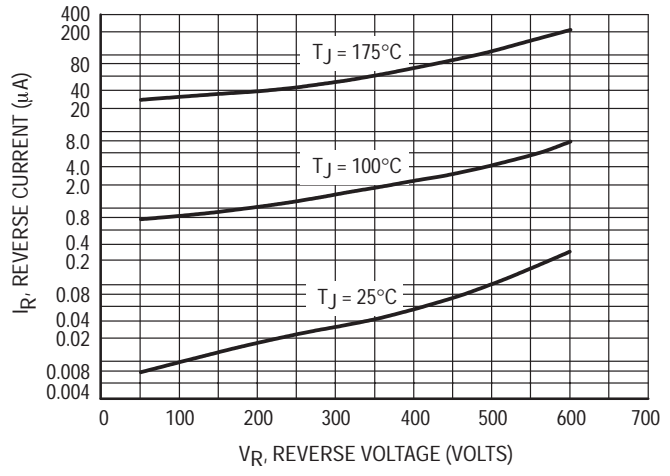


Figure 7. Typical Reverse Current*

* The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V_R is sufficiently below rated V_R .

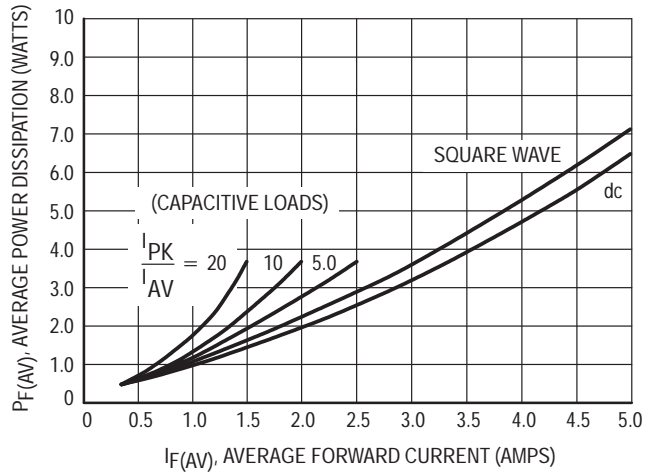


Figure 8. Power Dissipation

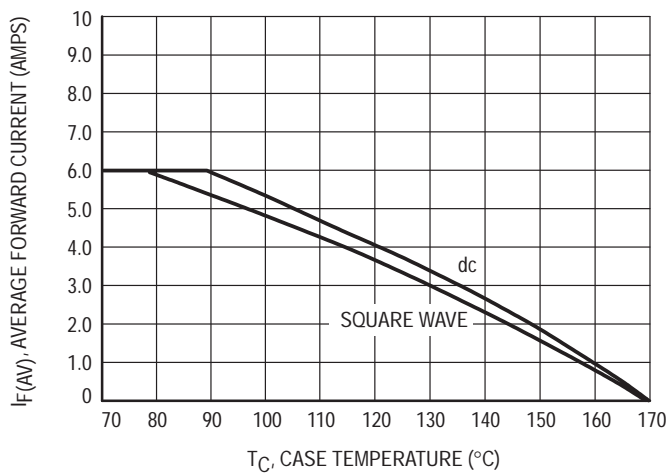


Figure 9. Current Derating, Case

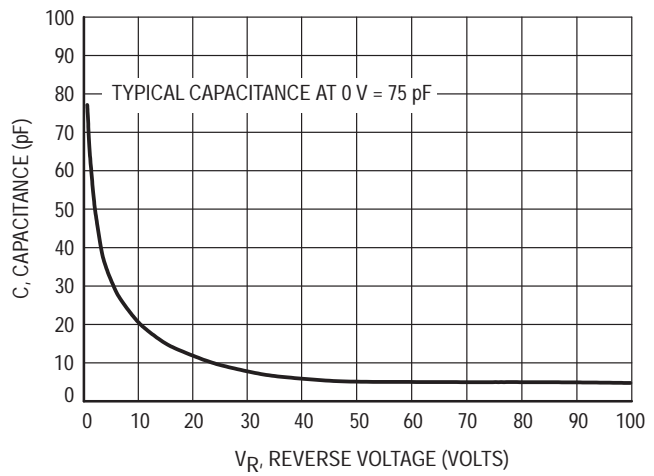


Figure 10. Typical Capacitance

SWITCHMODE™ Power Rectifiers

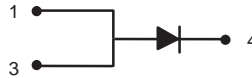
DPAK Surface Mount Package

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 Nanosecond Recovery Time
- Low Forward Voltage Drop
- Low Leakage

Mechanical Characteristics:

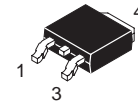
- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 75 units per plastic tube
- Available in 16 mm Tape and Reel, 2500 units per reel, by adding a "T4" suffix to the part number
- Marking: U320



MURD320

MURD320 is a
Motorola Preferred Device

ULTRAFAST RECTIFIERS
3 AMPERES
200 VOLTS



CASE 369A-13
DPAK

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	200	Volts
Average Rectified Forward Current ($T_C = 158^\circ\text{C}$, Rated V_R)	$I_{F(AV)}$	3	Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz, $T_C = 158^\circ\text{C}$)	I_{FRM}	6	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, 60 Hz)	I_{FSM}	75	Amps
Operating Junction and Storage Temperature	T_J, T_{stg}	-65 to +175	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Thermal Resistance, Junction to Case Junction to Ambient (1)	$R_{\theta JC}$ $R_{\theta JA}$	6 80	$^\circ\text{C/W}$
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ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage Drop (2) ($i_F = 3$ Amps, $T_J = 25^\circ\text{C}$) ($i_F = 3$ Amps, $T_J = 125^\circ\text{C}$)	v_F	0.95 0.75	Volts
Maximum Instantaneous Reverse Current (2) ($T_J = 25^\circ\text{C}$, Rated dc Voltage) ($T_J = 125^\circ\text{C}$, Rated dc Voltage)	i_R	5 500	μA
Maximum Reverse Recovery Time ($I_F = 1$ Amp, $di/dt = 50$ Amps/ μs , $V_R = 30$ V, $T_J = 25^\circ\text{C}$) ($I_F = 0.5$ Amp, $i_R = 1$ Amp, $I_{REC} = 0.25$ A, $V_R = 30$ V, $T_J = 25^\circ\text{C}$)	t_{rr}	35 25	ns

(1) Rating applies when surface mounted on the minimum pad sizes recommended.

(2) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

Preferred devices are Motorola recommended choices for future use and best overall value.

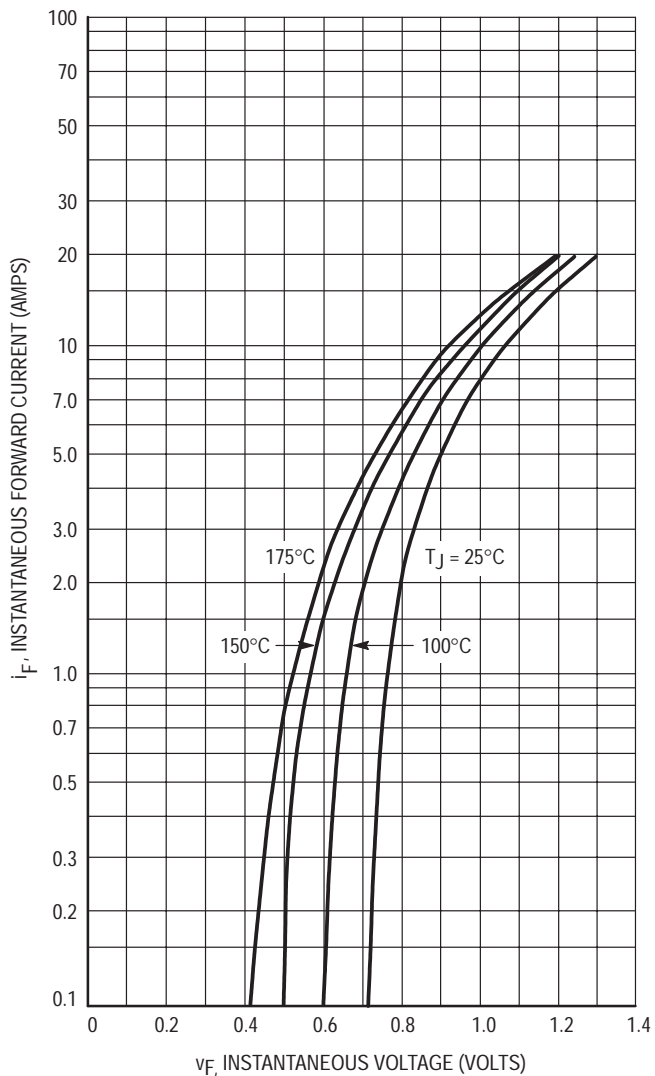


Figure 1. Typical Forward Voltage

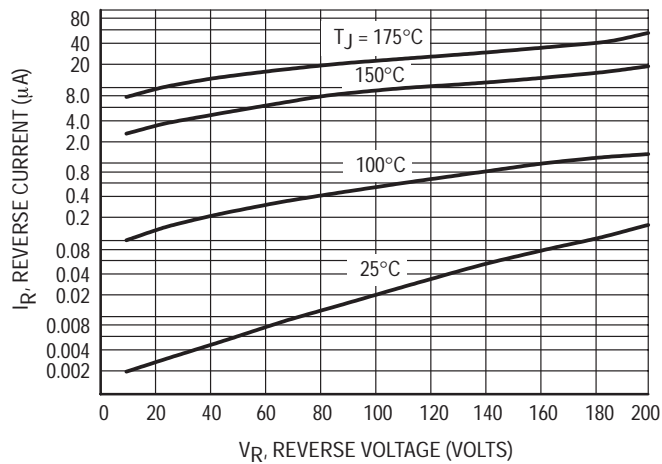


Figure 2. Typical Reverse Current*

* The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these curves if V_R is sufficiently below rated V_R .

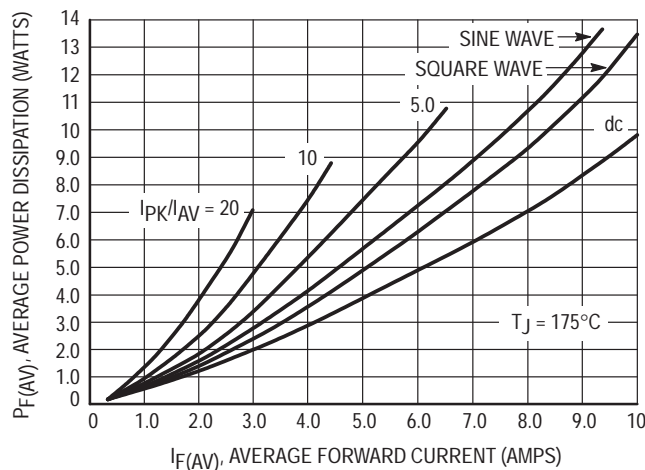


Figure 3. Average Power Dissipation

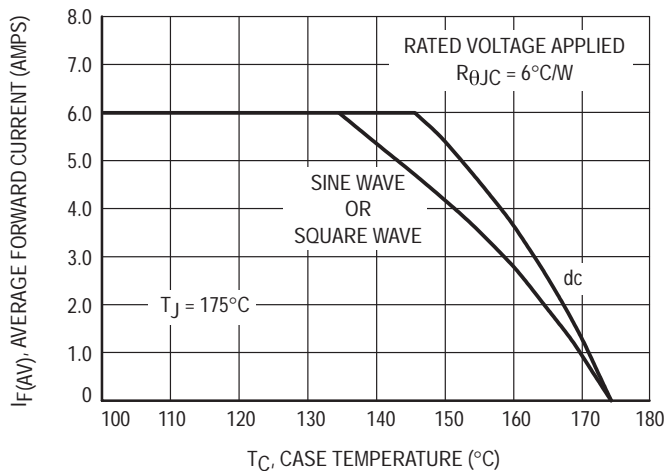


Figure 4. Current Derating, Case

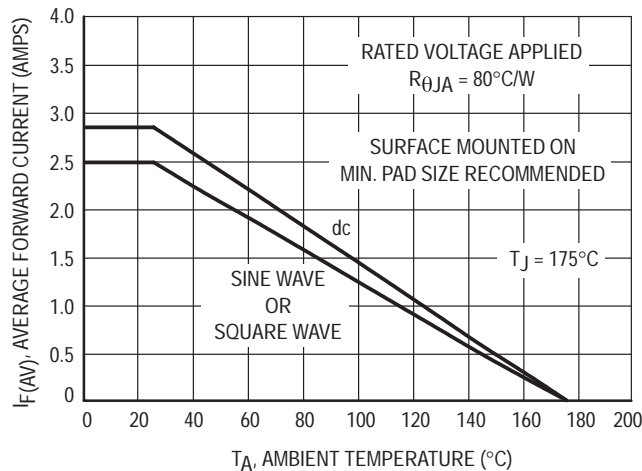


Figure 5. Current Derating, Ambient

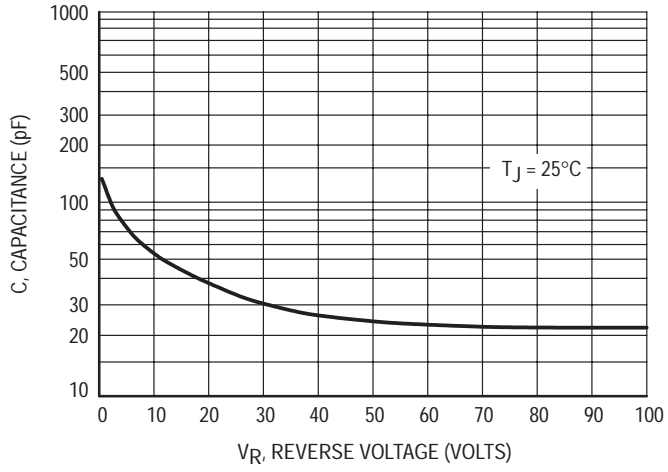


Figure 6. Typical Capacitance

SWITCHMODE™ Power Rectifiers

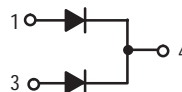
PAK Surface Mount Package

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 Nanosecond Recovery Time
- Low Forward Voltage Drop
- Low Leakage

Mechanical Characteristics:

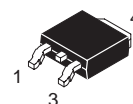
- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 75 units per plastic tube
- Available in 16 mm Tape and Reel, 2500 units per reel, by adding a "T4" suffix to the part number
- Marking: U620T



MURD620CT

MURD620CT is a
Motorola Preferred Device

ULTRAFAST RECTIFIERS
6 AMPERES
200 VOLTS



CASE 369A-13
PLASTIC

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	200	Volts
Average Rectified Forward Voltage ($T_C = 140^\circ\text{C}$, Rated V_R)	$I_F(AV)$	3 6	Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz, $T_C = 145^\circ\text{C}$)	I_F	6	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, 60 Hz)	I_{FSM}	50	Amps
Operating Junction and Storage Temperature	T_J, T_{stg}	-65 to +175	$^\circ\text{C}$

THERMAL CHARACTERISTICS PER DIODE

Thermal Resistance, Junction to Case Junction to Ambient (1)	$R_{\theta JC}$ $R_{\theta JA}$	9 80	$^\circ\text{C/W}$
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ELECTRICAL CHARACTERISTICS PER DIODE

Maximum Instantaneous Forward Voltage Drop (2) ($i_F = 3$ Amps, $T_C = 25^\circ\text{C}$) ($i_F = 3$ Amps, $T_C = 125^\circ\text{C}$) ($i_F = 6$ Amps, $T_C = 25^\circ\text{C}$) ($i_F = 6$ Amps, $T_C = 125^\circ\text{C}$)	v_F	1 0.96 1.2 1.13	Volts
Maximum Instantaneous Reverse Current (2) ($T_J = 25^\circ\text{C}$, Rated dc Voltage) ($T_J = 125^\circ\text{C}$, Rated dc Voltage)	i_R	5 250	μA
Maximum Reverse Recovery Time ($I_F = 1$ Amp, $di/dt = 50$ Amps/ μs , $V_R = 30$ V, $T_J = 25^\circ\text{C}$) ($I_F = 0.5$ Amp, $i_R = 1$ Amp, $I_{REC} = 0.25$ A, $V_R = 30$ V, $T_J = 25^\circ\text{C}$)	t_{rr}	35 25	ns

(1) Rating applies when surface mounted on the minimum pad sizes recommended.

(2) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

Preferred devices are Motorola recommended choices for future use and best overall value.

MURD620CT

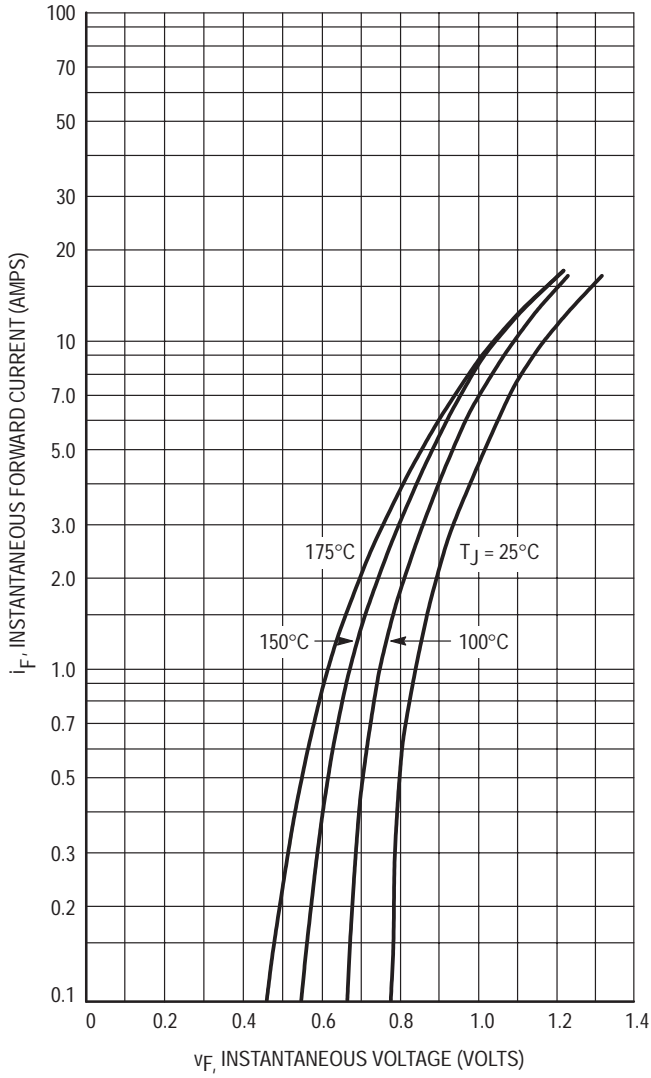


Figure 1. Typical Forward Voltage (Per Leg)

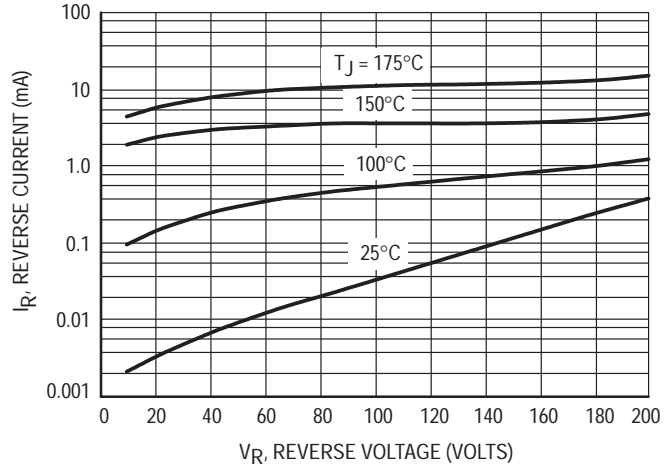


Figure 2. Typical Leakage Current* (Per Leg)

* The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these curves if V_R is sufficiently below rated V_R .

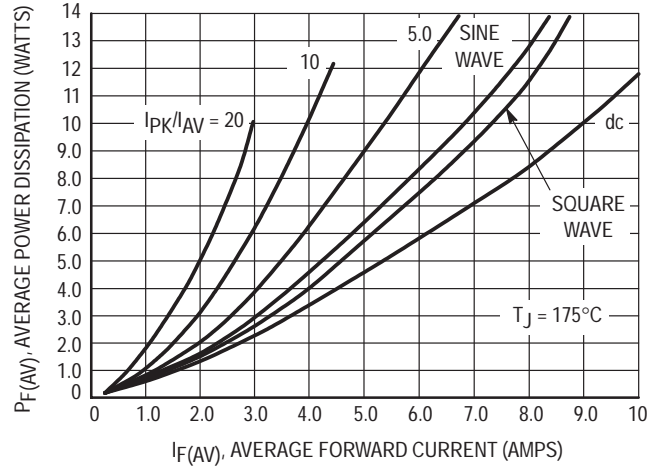


Figure 3. Average Power Dissipation (Per Leg)

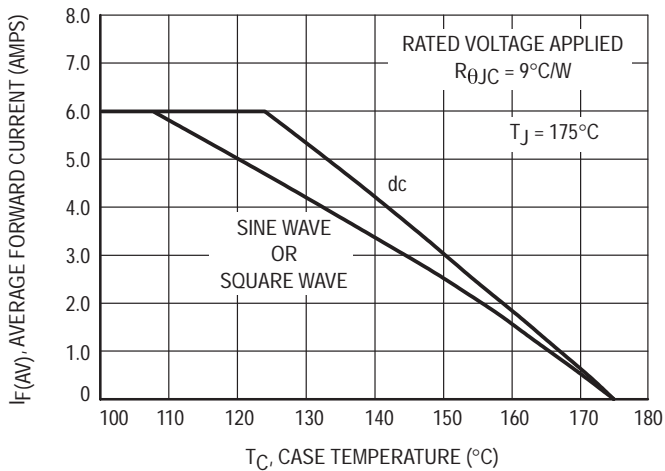


Figure 4. Current Derating, Case (Per Leg)

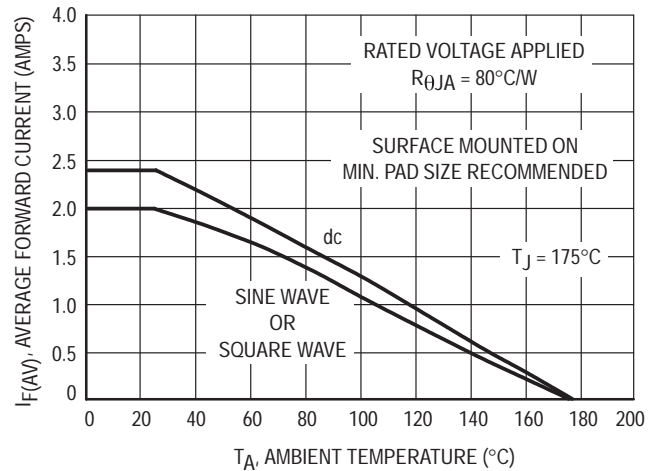


Figure 5. Current Derating, Ambient (Per Leg)

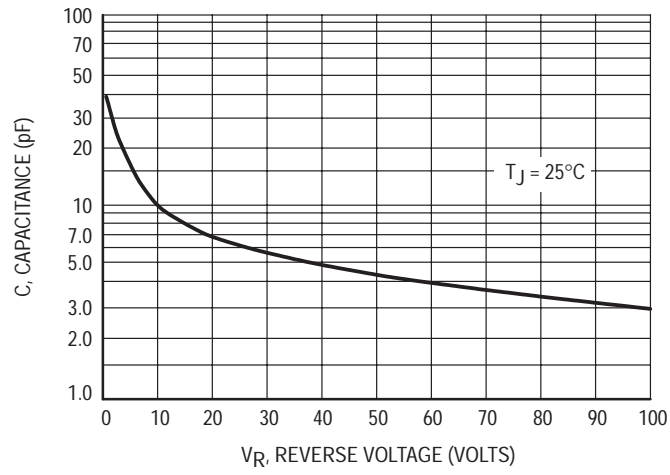
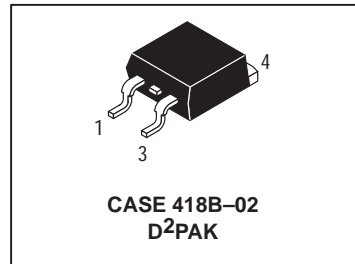
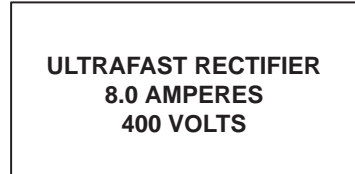


Figure 6. Typical Capacitance (Per Leg)

Designer's™ Data Sheet
SWITCHMODE™ Power Rectifier
D2PAK Power Surface Mount Package

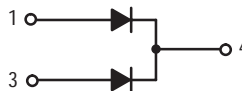


Designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Package Designed for Power Surface Mount Applications
- Ultrafast 28 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Epoxy Meets UL94, V_O @ 1/8"
- High Temperature Glass Passivated Junction
- High Voltage Capability
- Low Leakage Specified @ 150°C Case Temperature
- Short Heat Sink Tab Manufactured — Not Sheared!
- Similar in Size to Industry Standard TO-220 Package

Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per reel by adding a "T4" suffix to the part number
- Marking: UH840



MAXIMUM RATINGS, PER LEG

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	400	Volts
Average Rectified Forward Current (Rated V _R), T _C = 120°C	I _{F(AV)}	4.0 8.0	Amps
Peak Repetitive Forward Current (Rated V _R , Square Wave, 20 kHz), T _C = 120°C	I _{FM}	8	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I _{FSM}	100	Amps
Controlled Avalanche Energy	W _{AVAIL}	20	mJ
Operating Junction Temperature and Storage Temperature	T _J , T _{stg}	-65 to +175	°C

THERMAL CHARACTERISTICS, PER LEG

Maximum Thermal Resistance — Junction to Case — Junction to Ambient (1)	R _{θJC} R _{θJA}	3.0 50	°C/W
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(1) See Chapter 7 for mounting conditions

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS, PER LEG

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (2) ($i_F = 4.0$ Amps, $T_C = 150^\circ\text{C}$) ($i_F = 4.0$ Amps, $T_C = 25^\circ\text{C}$)	v_F	1.9 2.2	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_C = 150^\circ\text{C}$) (Rated dc Voltage, $T_C = 25^\circ\text{C}$)	i_R	500 10	μA
Maximum Reverse Recovery Time ($I_F = 1.0$ Amp, $di/dt = 50$ Amps/ μs)	t_{rr}	28	ns

(2) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$

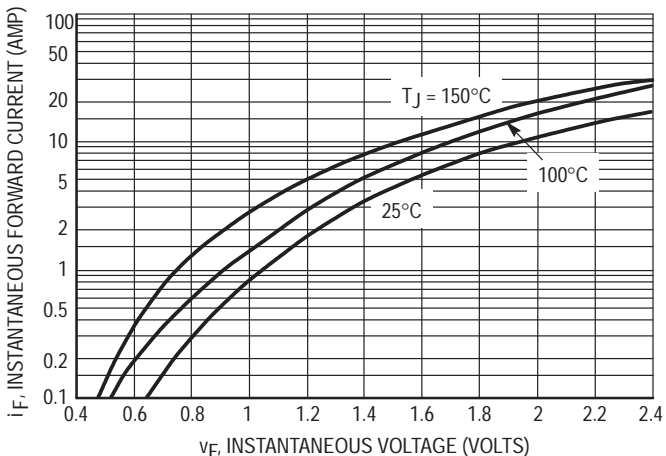


Figure 1. Typical Forward Voltage

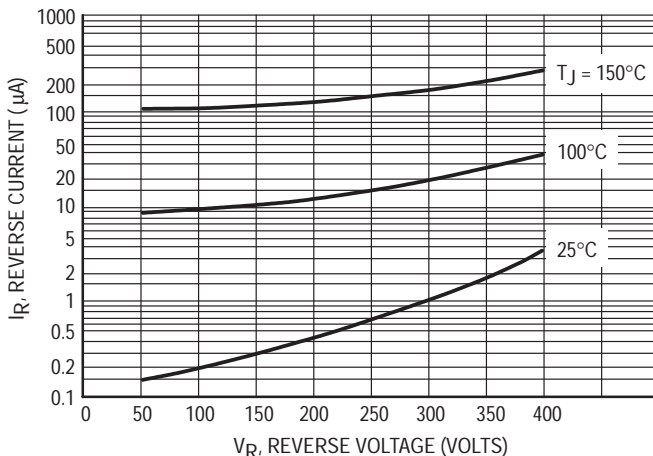


Figure 2. Typical Reverse Current, Per Leg

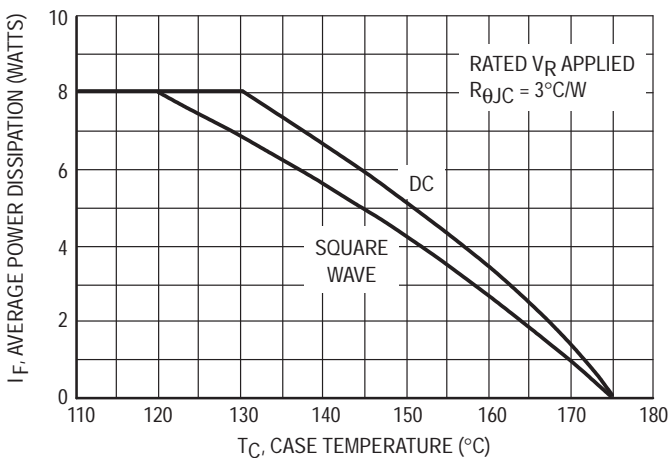


Figure 3. Current Derating, Case

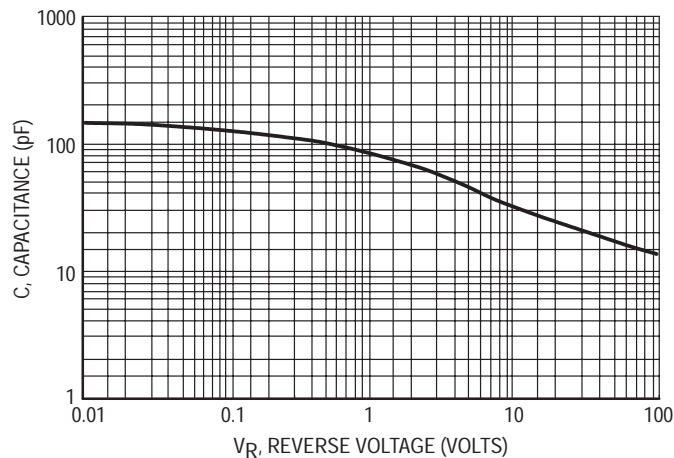


Figure 4. Typical Capacitance, Per Leg

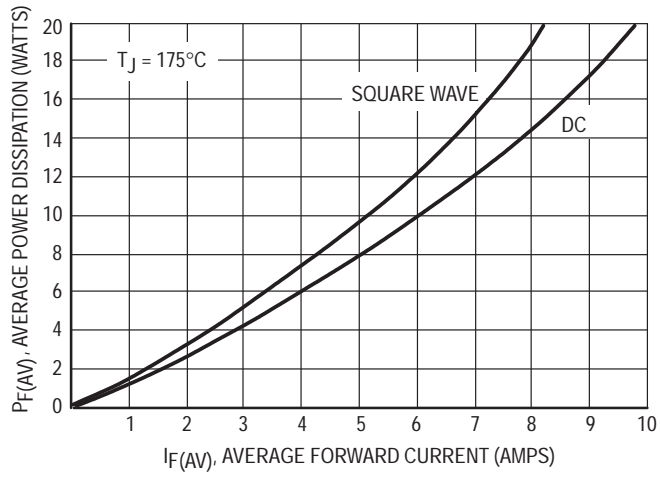


Figure 5. Forward Power Dissipation, Per Leg

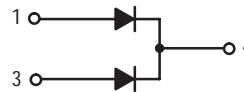
Designer's™ Data Sheet
SWITCHMODE™ Power Rectifier
D2PAK Power Surface Mount Package

Designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Package Designed for Power Surface Mount Applications
- Ultrafast 35 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Epoxy Meets UL94, V_O @ 1/8"
- High Temperature Glass Passivated Junction
- Low Leakage Specified @ 150°C Case Temperature
- Short Heat Sink Tab Manufactured — Not Sheared!
- Similar in Size to Industrial Standard TO-220 Package

Mechanical Characteristics

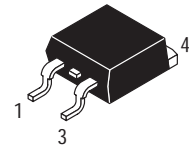
- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per reel by adding a "T4" suffix to the part number
- Marking: U1620T



MURB1620CT

Motorola Preferred Device

ULTRAFAST RECTIFIER
16 AMPERES
200 VOLTS



CASE 418B-02
D2PAK

MAXIMUM RATING, PER LEG

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	200	Volts
Average Rectified Forward Current Total Device, (Rated V_R), $T_C = 150^\circ\text{C}$	$I_{F(AV)}$	8 16	Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz), $T_C = 150^\circ\text{C}$	I_{FM}	16	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	100	Amps
Operating Junction and Storage Temperature	T_J, T_{stg}	- 65 to +175	$^\circ\text{C}$

THERMAL CHARACTERISTICS, PER LEG

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	3	$^\circ\text{C/W}$
Maximum Thermal Resistance, Junction to Ambient (1)	$R_{\theta JA}$	50	$^\circ\text{C/W}$
Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	T_L	260	$^\circ\text{C}$

(1) See Chapter 7 for mounting conditions

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

MURB1620CT

ELECTRICAL CHARACTERISTICS, PER LEG

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (2) ($i_F = 8$ Amp, $T_C = 150^\circ\text{C}$) ($i_F = 8$ Amp, $T_C = 25^\circ\text{C}$)	v_F	0.895 0.975	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_C = 150^\circ\text{C}$) (Rated dc Voltage, $T_C = 25^\circ\text{C}$)	i_R	250 5	μA
Maximum Reverse Recovery Time ($I_F = 1$ Amp, $di/dt = 50$ Amp/ μs) ($I_F = 0.5$ Amp, $i_R = 1$ Amp, $I_{REC} = 0.25$ Amp)	t_{rr}	35 25	ns

(2) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$

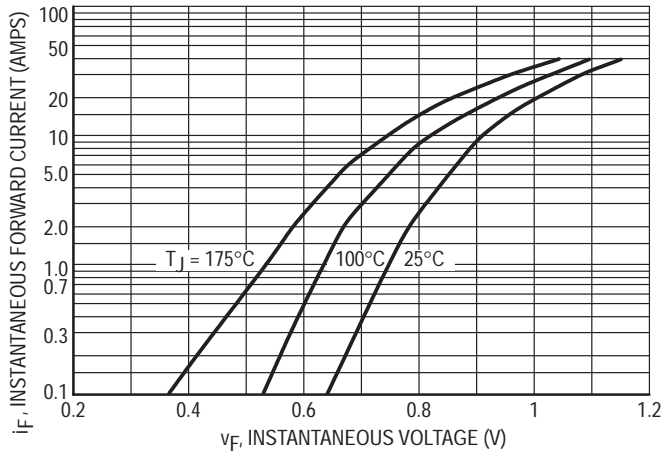


Figure 1. Typical Forward Voltage, Per Leg

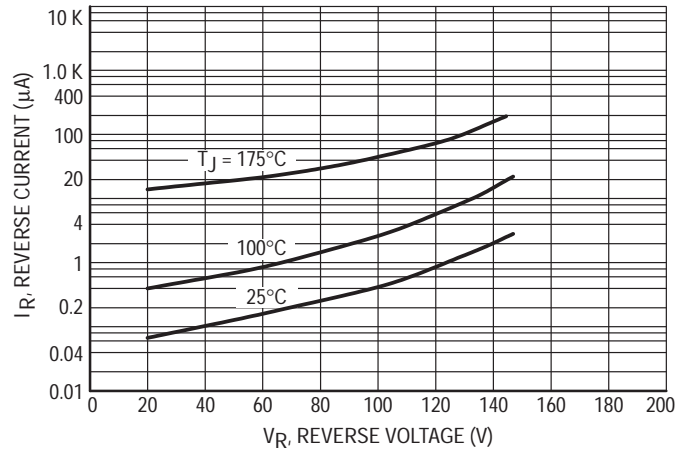


Figure 2. Typical Reverse Current, Per Leg*

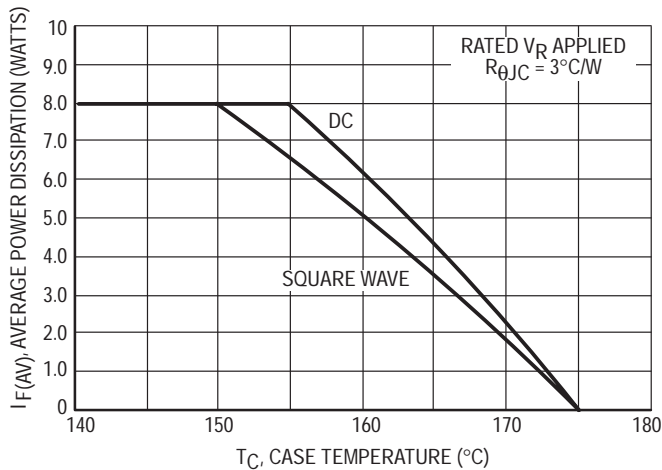


Figure 3. Current Derating Case, Per Leg

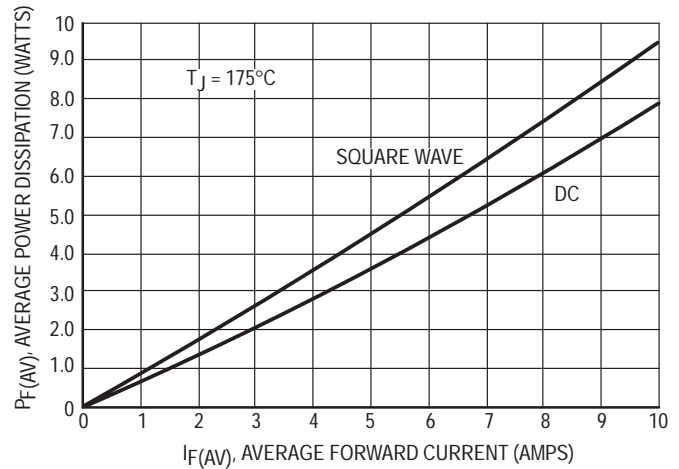


Figure 4. Power Dissipation, Per Leg

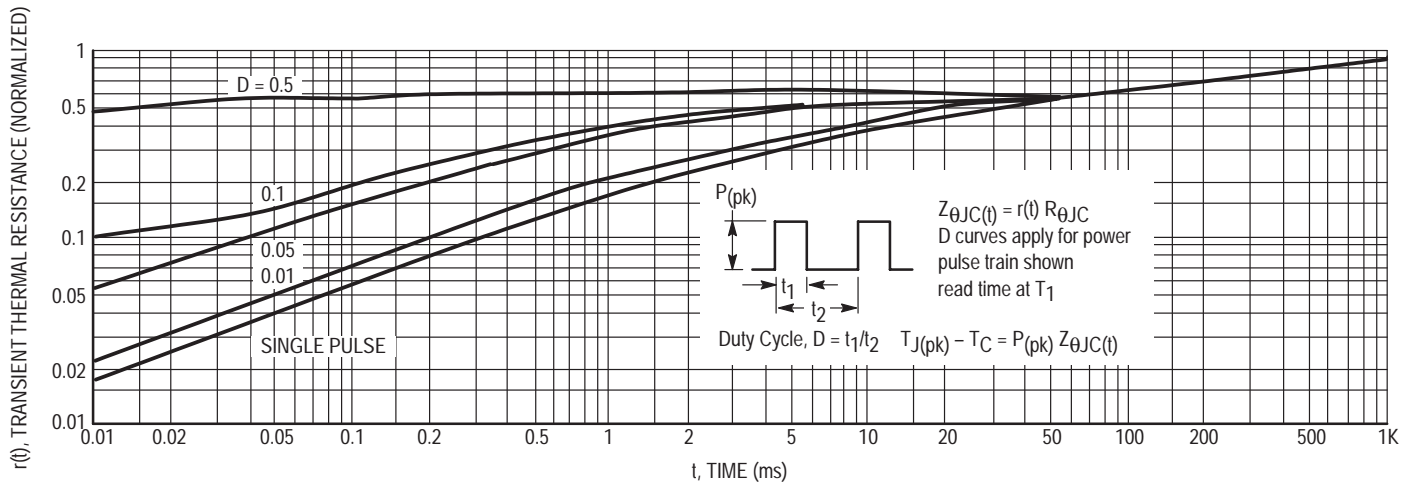


Figure 5. Thermal Response

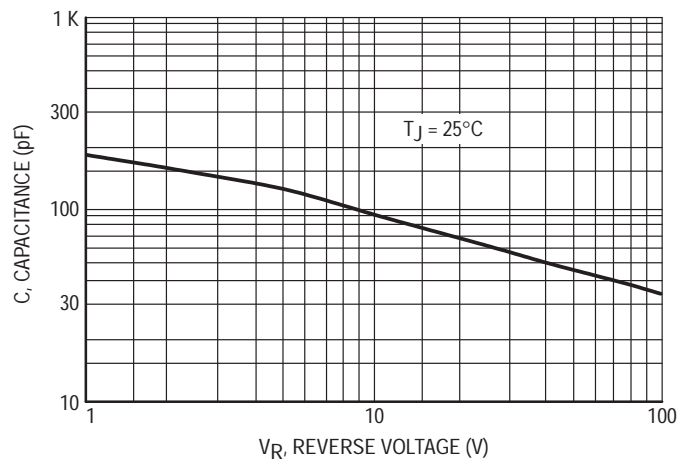


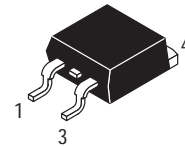
Figure 6. Typical Capacitance, Per Leg

Designer's™ Data Sheet
SWITCHMODE™ Power Rectifier
D2PAK Power Surface Mount Package

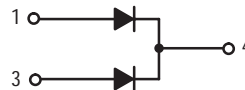
MURB1660CT

Motorola Preferred Device

ULTRAFAST RECTIFIER
16 AMPERES
600 VOLTS



CASE 418B-02
D2PAK



Designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Package Designed for Power Surface Mount Applications
- Ultrafast 60 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Epoxy Meets UL94, V_O @ 1/8"
- High Temperature Glass Passivated Junction
- High Voltage Capability to 600 V
- Low Leakage Specified @ 150°C Case Temperature
- Short Heat Sink Tab Manufactured – Not Sheared!
- Similar in Size to Industrial Standard TO-220 Package

Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per reel by adding a "T4" suffix to the part number
- Marking: U1660T

MAXIMUM RATING, PER LEG

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	600	Volts
Average Rectified Forward Current Total Device, (Rated V _R), T _C = 150°C	I _{F(AV)}	8 16	Amps
Peak Repetitive Forward Current (Rated V _R , Square Wave, 20 kHz), T _C = 150°C	I _{FM}	16	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I _{FSM}	100	Amps
Operating Junction and Storage Temperature	T _J , T _{stg}	- 65 to +175	°C

THERMAL CHARACTERISTICS, PER LEG

Maximum Thermal Resistance, Junction to Case	R _{θJC}	2	°C/W
Maximum Thermal Resistance, Junction to Ambient (1)	R _{θJA}	50	°C/W
Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	T _L	260	°C

(1) See Chapter 7 for mounting conditions

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS, PER LEG

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (2) ($i_F = 8 \text{ Amp}$, $T_C = 150^\circ\text{C}$) ($i_F = 8 \text{ Amp}$, $T_C = 25^\circ\text{C}$)	V_F	1.20 1.50	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_C = 150^\circ\text{C}$) (Rated dc Voltage, $T_C = 25^\circ\text{C}$)	i_R	500 10	μA
Maximum Reverse Recovery Time ($I_F = 1 \text{ Amp}$, $di/dt = 50 \text{ Amp}/\mu\text{s}$) ($I_F = 0.5 \text{ Amp}$, $i_R = 1 \text{ Amp}$, $I_{REC} = 0.25 \text{ Amp}$)	t_{rr}	60 50	ns

(2) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$

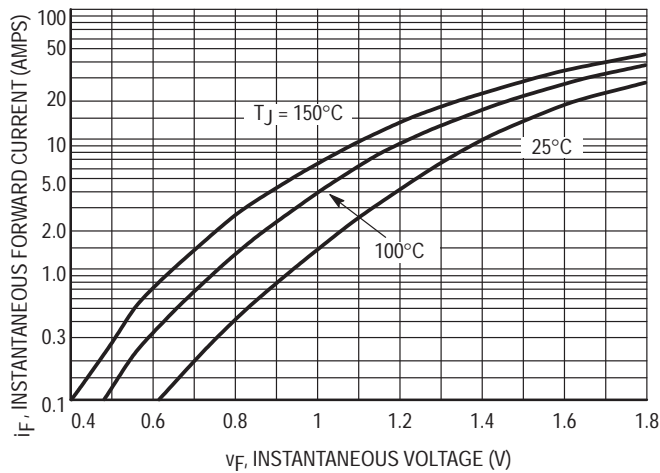


Figure 1. Typical Forward Voltage, Per Leg

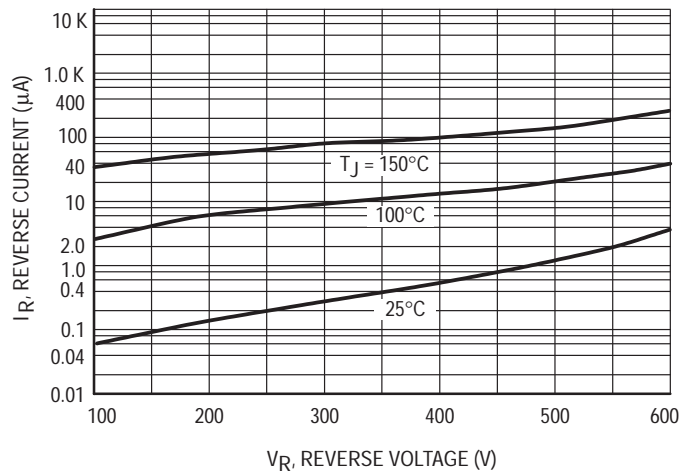


Figure 2. Typical Reverse Current, Per Leg

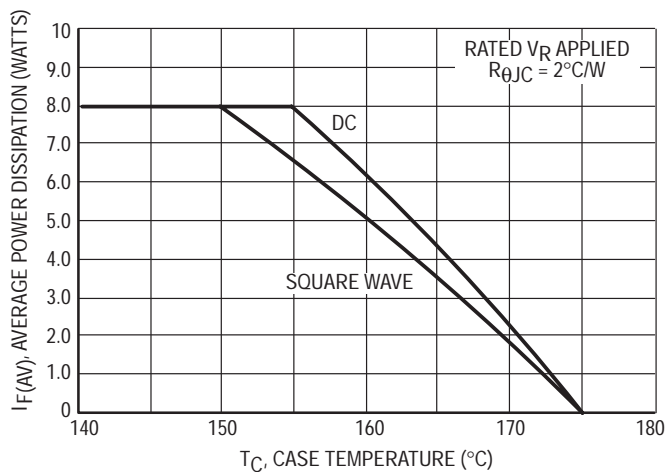


Figure 3. Current Derating, Case, Per Leg

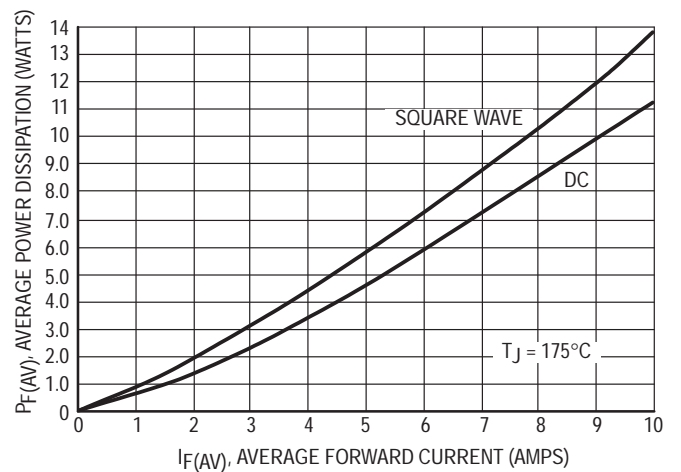


Figure 4. Power Dissipation, Per Leg

MURB1660CT

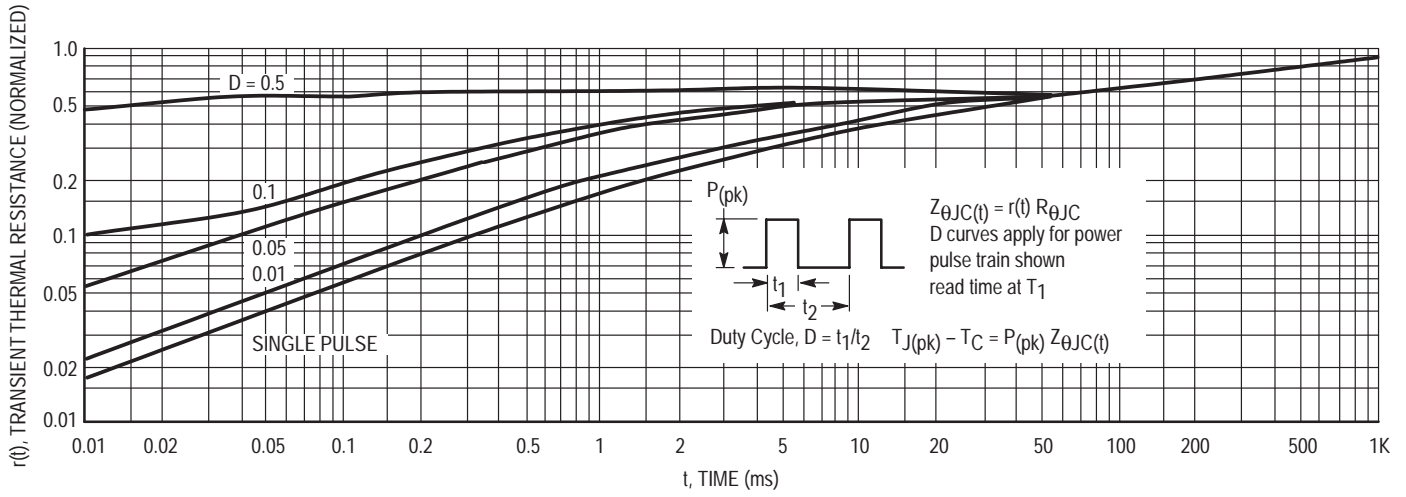


Figure 5. Thermal Response

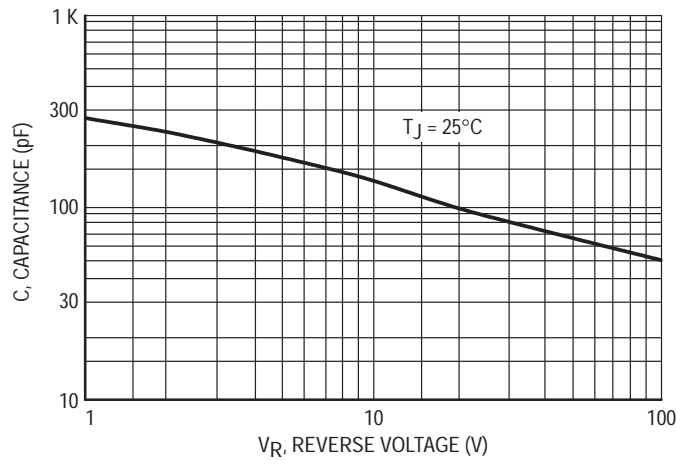


Figure 6. Typical Capacitance, Per Leg

SWITCHMODE™ Power Rectifiers

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 25, 50 and 75 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- Reverse Voltage to 600 Volts

Mechanical Characteristics:

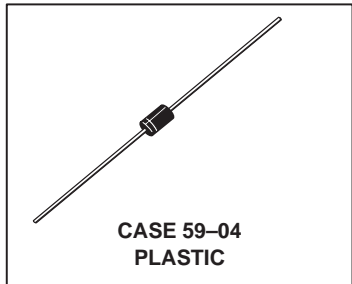
- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 1000 per bag
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: U120, U140, U160



MUR120
MUR140
MUR160

MUR120, MUR140 and MUR160 are
Motorola Preferred Devices

ULTRAFAST RECTIFIERS
1.0 AMPERE
200-400-600 VOLTS



MAXIMUM RATINGS

Rating	Symbol	MUR			Unit
		120	140	160	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	200	400	600	Volts
Average Rectified Forward Current (Square Wave Mounting Method #3 Per Note 1)	$I_{F(AV)}$	1.0 @ $T_A = 130^\circ\text{C}$	1.0 @ $T_A = 120^\circ\text{C}$		Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I_{FSM}	35			Amps
Operating Junction Temperature and Storage Temperature	T_J, T_{stg}	- 65 to +175			°C

THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	See Note 1	°C/W
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ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ($i_F = 1.0$ Amp, $T_J = 150^\circ\text{C}$) ($i_F = 1.0$ Amp, $T_J = 25^\circ\text{C}$)	V_F	0.710 0.875	1.05 1.25	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 150^\circ\text{C}$) (Rated dc Voltage, $T_J = 25^\circ\text{C}$)	i_R	50 2.0	150 5.0	μA
Maximum Reverse Recovery Time ($I_F = 1.0$ Amp, $di/dt = 50$ Amp/μs) ($I_F = 0.5$ Amp, $i_R = 1.0$ Amp, $I_{REC} = 0.25$ A)	t_{rr}	35 25	75 50	ns
Maximum Forward Recovery Time ($I_F = 1.0$ A, $di/dt = 100$ A/μs, I_{REC} to 1.0 V)	t_{fr}	25	50	ns

(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

Preferred devices are Motorola recommended choices for future use and best overall value.

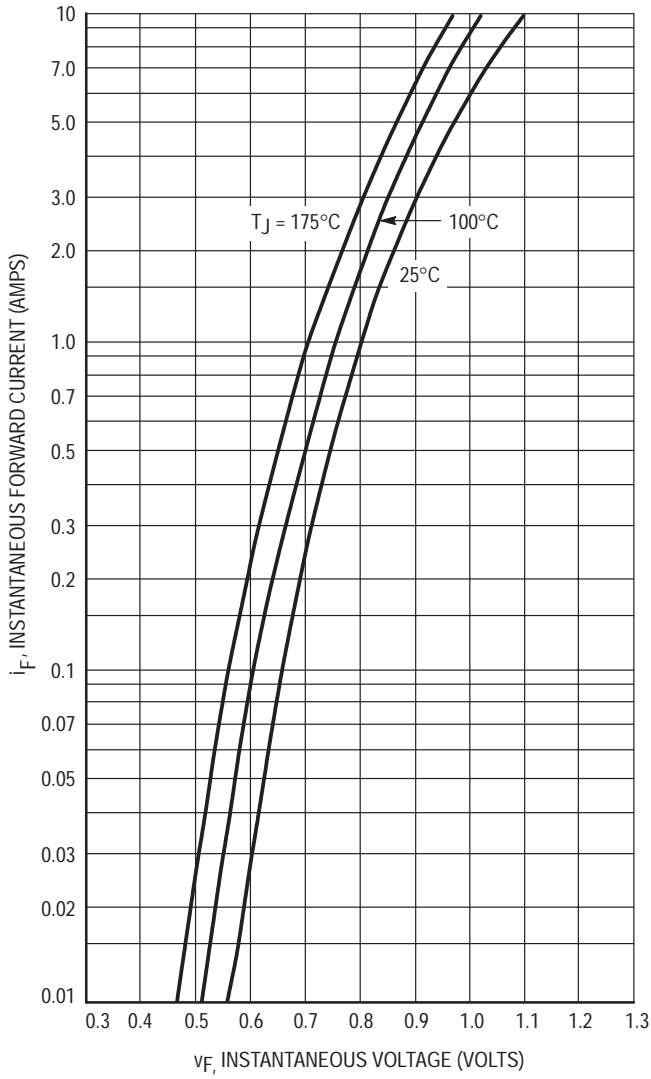


Figure 1. Typical Forward Voltage

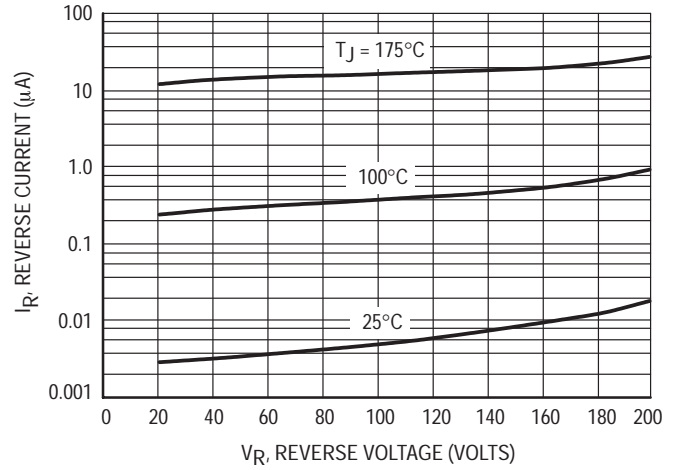


Figure 2. Typical Reverse Current*

* The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V_R is sufficiently below rated V_R .

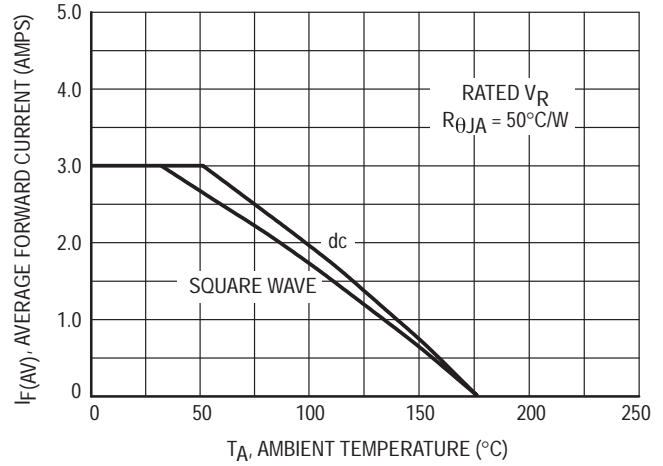


Figure 3. Current Derating (Mounting Method #3 Per Note 1)

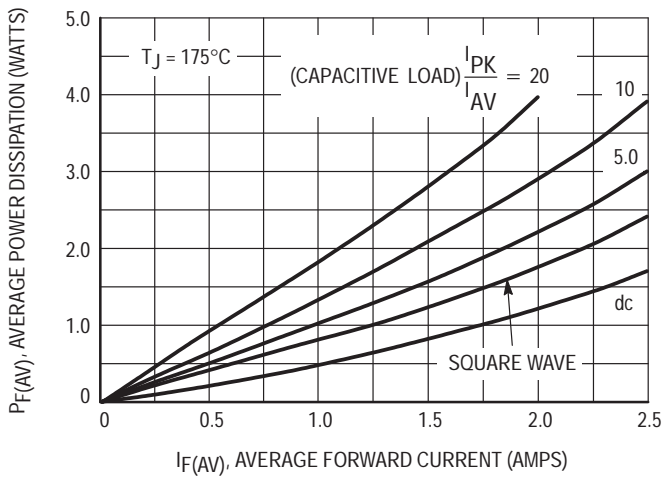


Figure 4. Power Dissipation

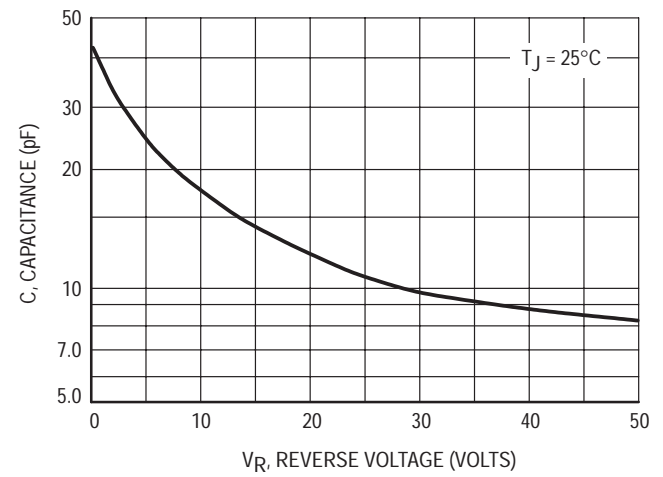


Figure 5. Typical Capacitance

MUR140, MUR160

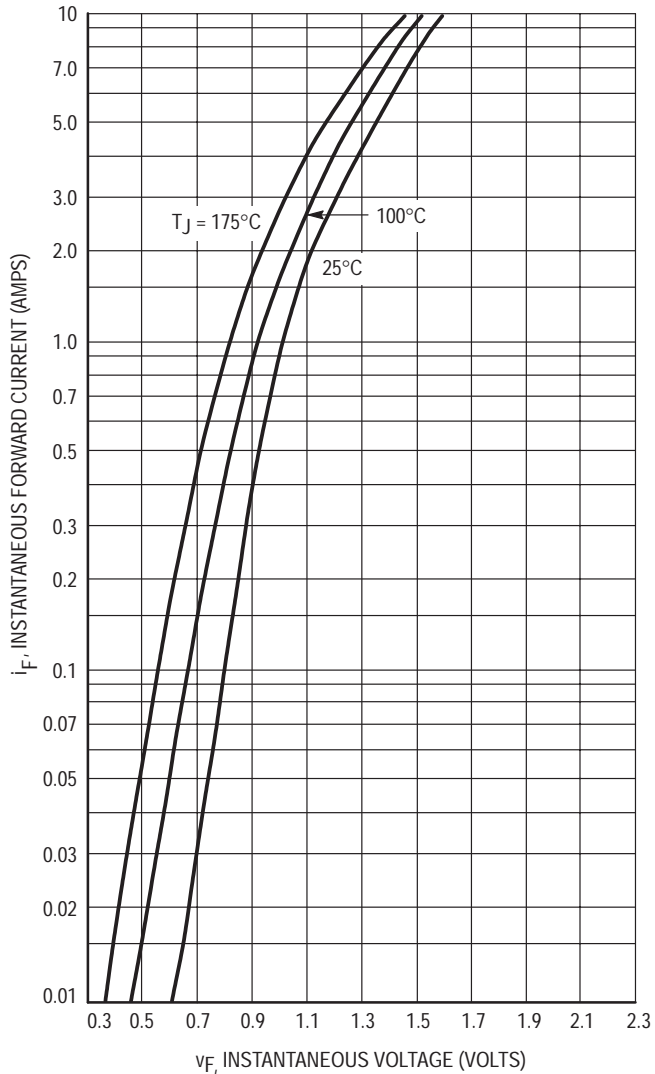


Figure 6. Typical Forward Voltage

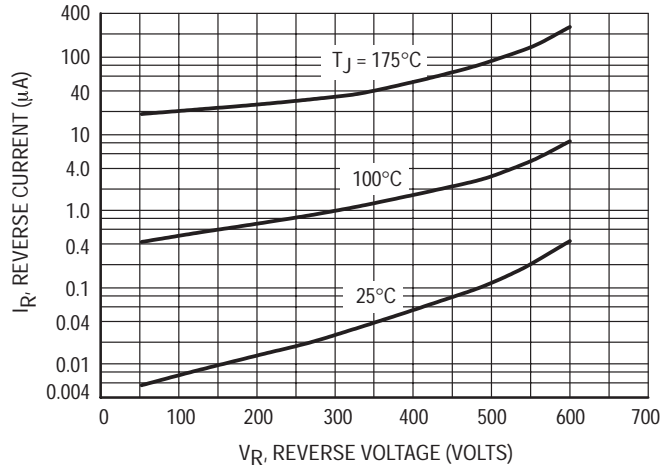


Figure 7. Typical Reverse Current*

* The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V_R is sufficiently below rated V_R .

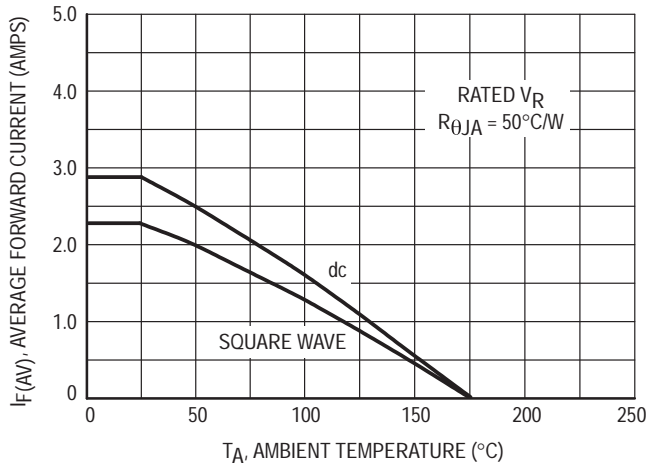


Figure 8. Current Derating (Mounting Method #3 Per Note 1)

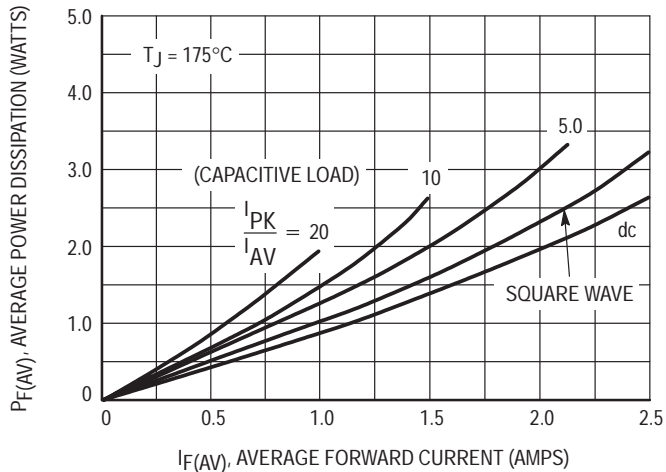


Figure 9. Power Dissipation

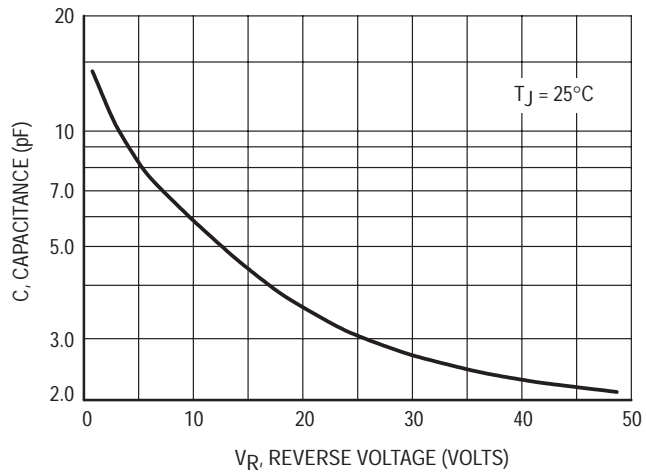


Figure 10. Typical Capacitance

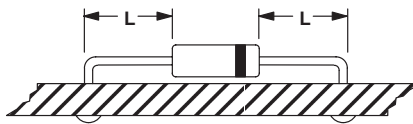
NOTE 1 — AMBIENT MOUNTING DATA

Data shown for thermal resistance junction to ambient ($R_{\theta JA}$) for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

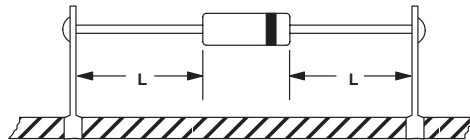
TYPICAL VALUES FOR $R_{\theta JA}$ IN STILL AIR

Mounting Method	$R_{\theta JA}$	Lead Length, L			Units
		1/8	1/4	1/2	
1		52	65	72	$^{\circ}\text{C}/\text{W}$
2		67	80	87	$^{\circ}\text{C}/\text{W}$
3		50			$^{\circ}\text{C}/\text{W}$

MOUNTING METHOD 1

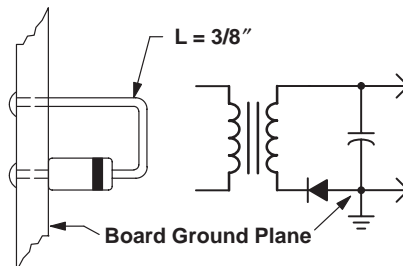


MOUNTING METHOD 2



Vector Pin Mounting

MOUNTING METHOD 3



P.C. Board with
1-1/2" X 1-1/2" Copper Surface

SWITCHMODE™ Power Rectifiers

Ultrafast “E” Series with High Reverse Energy Capability

. . . designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- 20 mJoules Avalanche Energy Guaranteed
- Excellent Protection Against Voltage Transients in Switching Inductive Load Circuits
- Ultrafast 75 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- Reverse Voltage to 1000 Volts

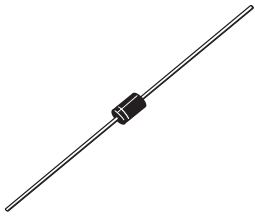
Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 1000 per bag
- Available Tape and Reeled, 5000 per reel, by adding a “RL” suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: U190E, U1100E

MUR190E
MUR1100E

MUR1100E is a
Motorola Preferred Device

**ULTRAFAST
RECTIFIERS
1.0 AMPERE
900–1000 VOLTS**



CASE 59-04



MAXIMUM RATINGS

Rating	Symbol	MUR		Unit
		190E	1100E	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	900	1000	Volts
Average Rectified Forward Current (Square Wave) (Mounting Method #3 Per Note 1)	$I_{F(AV)}$	1.0 @ $T_A = 95^\circ\text{C}$		Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I_{FSM}	35		Amps
Operating Junction Temperature and Storage Temperature	T_J, T_{stg}	-65 to +175		°C

THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	See Note 1	°C/W
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(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

Preferred devices are Motorola recommended choices for future use and best overall value.

MUR190E MUR1100E**ELECTRICAL CHARACTERISTICS**

Rating	Symbol	MUR		Unit
		190E	1100E	
Maximum Instantaneous Forward Voltage (1) ($i_F = 1.0$ Amp, $T_J = 150^\circ\text{C}$) ($i_F = 1.0$ Amp, $T_J = 25^\circ\text{C}$)	v_F	1.50 1.75		Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 100^\circ\text{C}$) (Rated dc Voltage, $T_J = 25^\circ\text{C}$)	i_R	600 10		μA
Maximum Reverse Recovery Time ($I_F = 1.0$ Amp, $di/dt = 50$ Amp/ μs) ($I_F = 0.5$ Amp, $i_R = 1.0$ Amp, $I_{REC} = 0.25$ Amp)	t_{rr}	100 75		ns
Maximum Forward Recovery Time ($I_F = 1.0$ Amp, $di/dt = 100$ Amp/ μs , Recovery to 1.0 V)	t_{fr}	75		ns
Controlled Avalanche Energy (See Test Circuit in Figure 6)	W_{AVAL}	10		mJ

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

ELECTRICAL CHARACTERISTICS

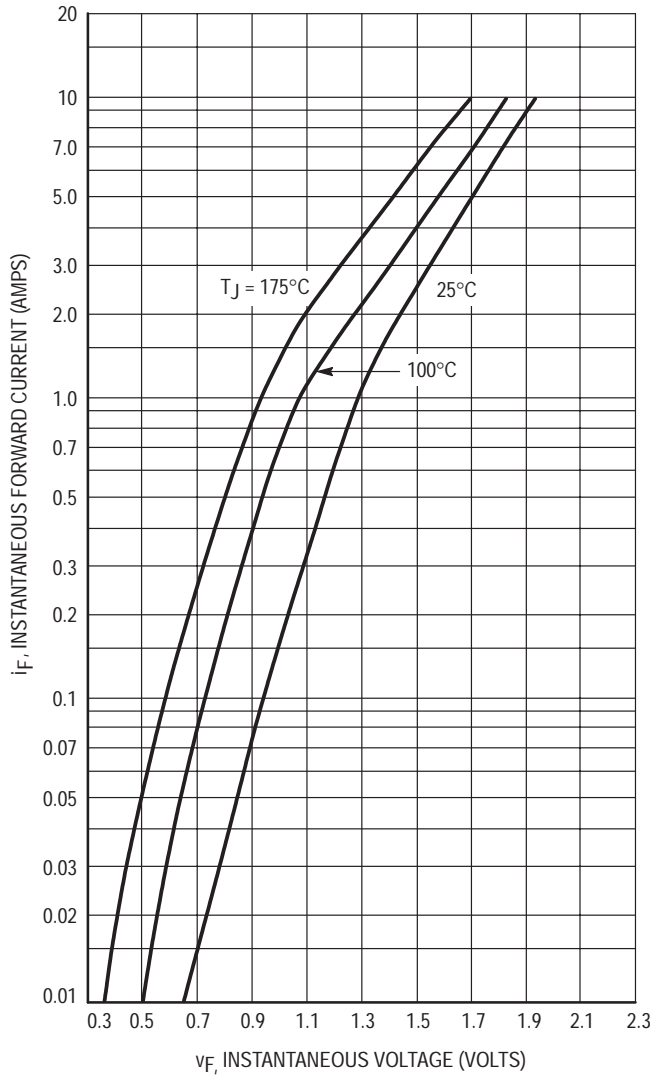


Figure 1. Typical Forward Voltage

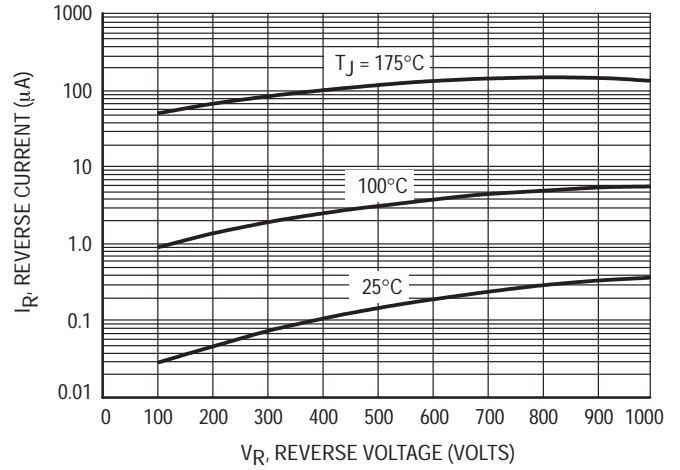


Figure 2. Typical Reverse Current*

* The curves shown are typical for the highest voltage device in the grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V_R is sufficiently below rated V_R .

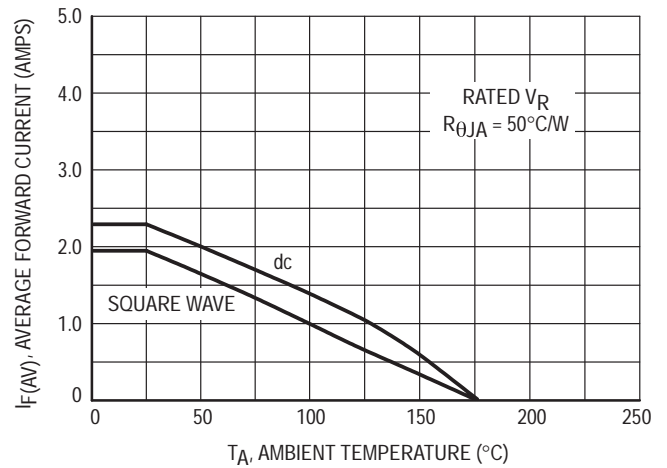


Figure 3. Current Derating
(Mounting Method #3 Per Note 1)

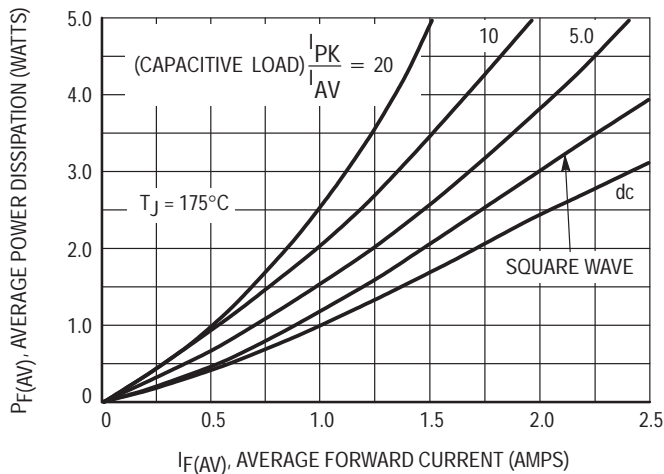


Figure 4. Power Dissipation

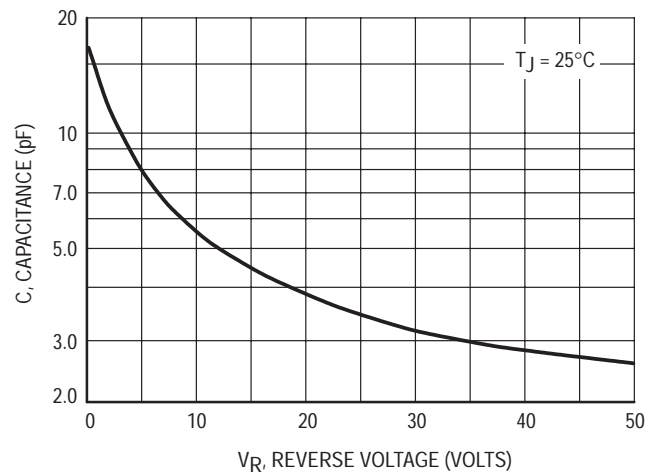


Figure 5. Typical Capacitance

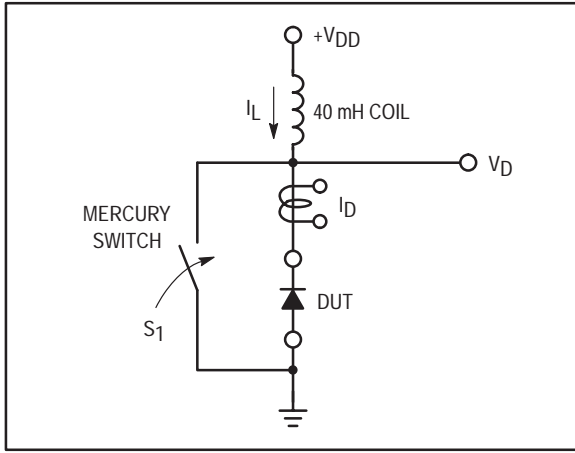


Figure 6. Test Circuit

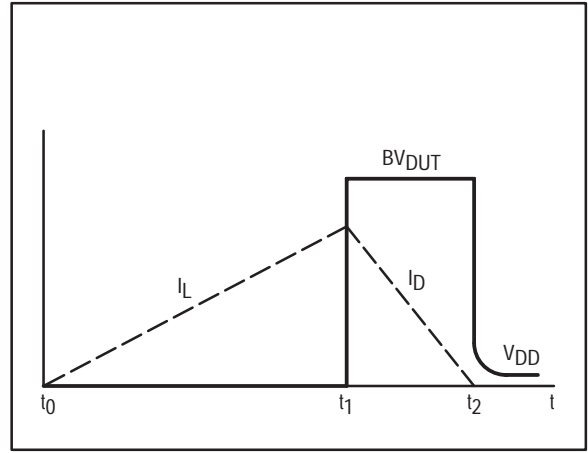


Figure 7. Current–Voltage Waveforms

The unclamped inductive switching circuit shown in Figure 6 was used to demonstrate the controlled avalanche capability of the new “E” series Ultrafast rectifiers. A mercury switch was used instead of an electronic switch to simulate a noisy environment when the switch was being opened.

When S₁ is closed at t₀ the current in the inductor I_L ramps up linearly; and energy is stored in the coil. At t₁ the switch is opened and the voltage across the diode under test begins to rise rapidly, due to di/dt effects, when this induced voltage reaches the breakdown voltage of the diode, it is clamped at BV_{DUT} and the diode begins to conduct the full load current which now starts to decay linearly through the diode, and goes to zero at t₂.

By solving the loop equation at the point in time when S₁ is opened; and calculating the energy that is transferred to the diode it can be shown that the total energy transferred is equal to the energy stored in the inductor plus a finite amount of energy from the V_{DD} power supply while the diode is in breakdown (from t₁ to t₂) minus any losses due to finite com-

ponent resistances. Assuming the component resistive elements are small Equation (1) approximates the total energy transferred to the diode. It can be seen from this equation that if the V_{DD} voltage is low compared to the breakdown voltage of the device, the amount of energy contributed by the supply during breakdown is small and the total energy can be assumed to be nearly equal to the energy stored in the coil during the time when S₁ was closed, Equation (2).

The oscilloscope picture in Figure 8, shows the information obtained for the MUR8100E (similar die construction as the MUR1100E Series) in this test circuit conducting a peak current of one ampere at a breakdown voltage of 1300 volts, and using Equation (2) the energy absorbed by the MUR8100E is approximately 20 mJoules.

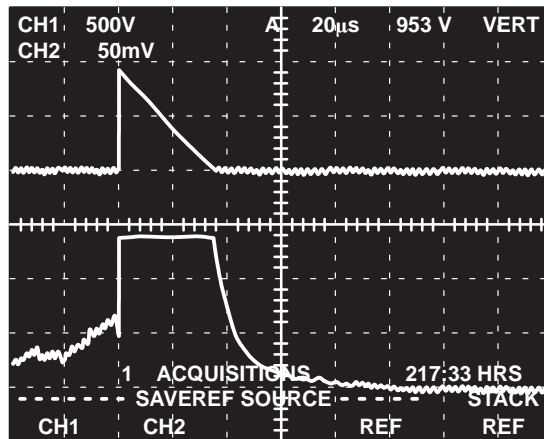
Although it is not recommended to design for this condition, the new “E” series provides added protection against those unforeseen transient viruses that can produce unexplained random failures in unfriendly environments.

EQUATION (1):

$$W_{\text{AVAL}} \approx \frac{1}{2} L I_L^2 \text{LPK} \left(\frac{BV_{\text{DUT}}}{BV_{\text{DUT}} - V_{\text{DD}}} \right)$$

EQUATION (2):

$$W_{\text{AVAL}} \approx \frac{1}{2} L I_L^2 \text{LPK}$$



CHANNEL 2:

I_L
0.5 AMPS/DIV.

CHANNEL 1:

V_{DUT}
500 VOLTS/DIV.

TIME BASE:
20 μs/DIV.

Figure 8. Current–Voltage Waveforms

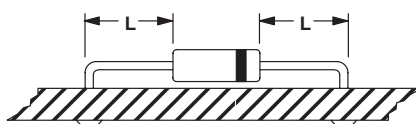
NOTE 1 — AMBIENT MOUNTING DATA

Data shown for thermal resistance junction to ambient ($R_{\theta JA}$) for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

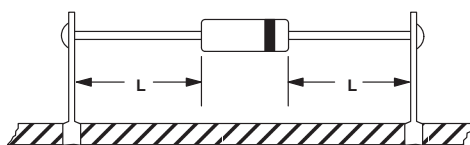
TYPICAL VALUES FOR $R_{\theta JA}$ IN STILL AIR

Mounting Method	$R_{\theta JA}$	Lead Length, L			Units
		1/8	1/4	1/2	
1		52	65	72	$^{\circ}\text{C/W}$
2		67	80	87	$^{\circ}\text{C/W}$
3		50			$^{\circ}\text{C/W}$

MOUNTING METHOD 1

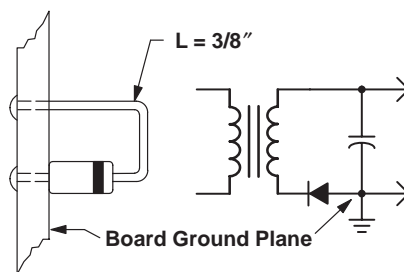


MOUNTING METHOD 2



Vector Pin Mounting

MOUNTING METHOD 3



**P.C. Board with
1-1/2" X 1-1/2" Copper Surface**

SWITCHMODE™ Power Rectifiers

. . . designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 25, 50 and 75 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- Reverse Voltage to 600 Volts

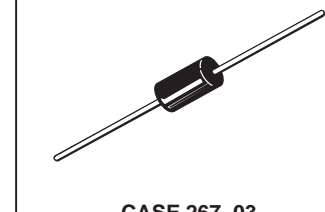
Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 5,000 per bag
- Available Tape and Reeled, 1500 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode indicated by Polarity Band
- Marking: U420, U460

MUR420
MUR460

MUR420 and MUR460 are
Motorola Preferred Devices

ULTRAFAST
RECTIFIERS
4.0 AMPERES
200-600 VOLTS



CASE 267-03
PLASTIC

MAXIMUM RATINGS

Rating	Symbol	MUR		Unit
		420	460	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	200	600	Volts
Average Rectified Forward Current (Square Wave) (Mounting Method #3 Per Note 1)	$I_{F(AV)}$	4.0 @ $T_A = 80^\circ\text{C}$	4.0 @ $T_A = 40^\circ\text{C}$	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, half wave, single phase, 60 Hz)	I_{FSM}	125	70	Amps
Operating Junction Temperature and Storage Temperature	T_J, T_{stg}	-65 to +175		°C

THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	See Note 1	°C/W
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ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ($i_F = 3.0$ Amps, $T_J = 150^\circ\text{C}$) ($i_F = 3.0$ Amps, $T_J = 25^\circ\text{C}$) ($i_F = 4.0$ Amps, $T_J = 25^\circ\text{C}$)	V_F	0.710 0.875 0.890	1.05 1.25 1.28	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 150^\circ\text{C}$) (Rated dc Voltage, $T_J = 25^\circ\text{C}$)	i_R	150 5.0	250 10	μA
Maximum Reverse Recovery Time ($I_F = 1.0$ Amp, $di/dt = 50$ Amp/ μs) ($I_F = 0.5$ Amp, $i_R = 1.0$ Amp, $I_{REC} = 0.25$ Amp)	t_{rr}	35 25	75 50	ns
Maximum Forward Recovery Time ($I_F = 1.0$ A, $di/dt = 100$ A/ μs , Recovery to 1.0 V)	t_{fr}	25	50	ns

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

Preferred devices are Motorola recommended choices for future use and best overall value.

MUR420

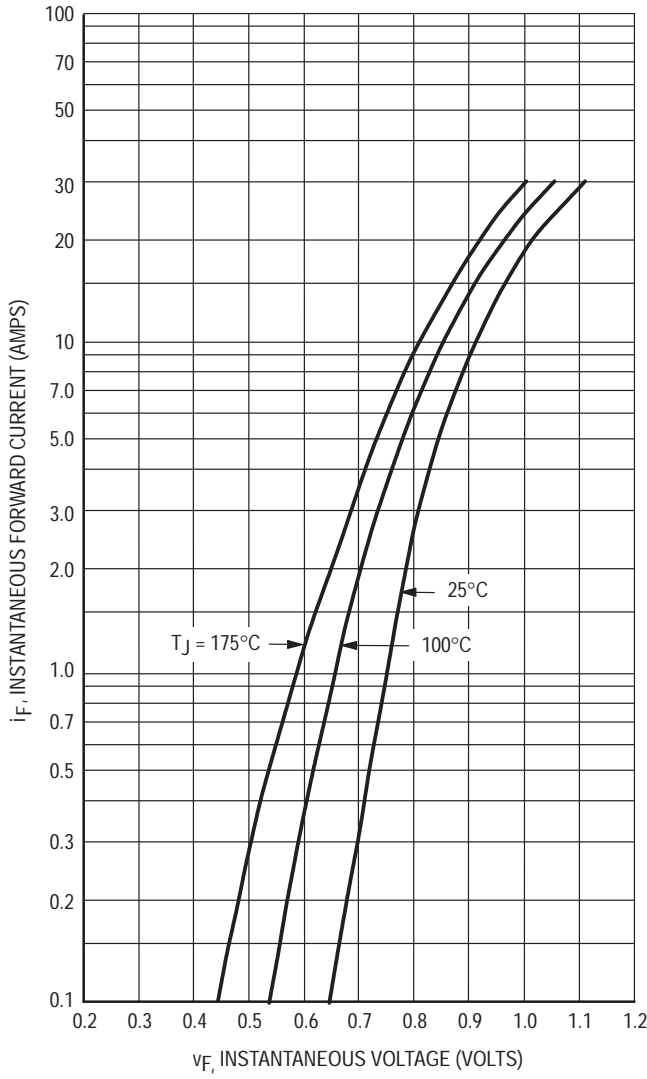


Figure 1. Typical Forward Voltage

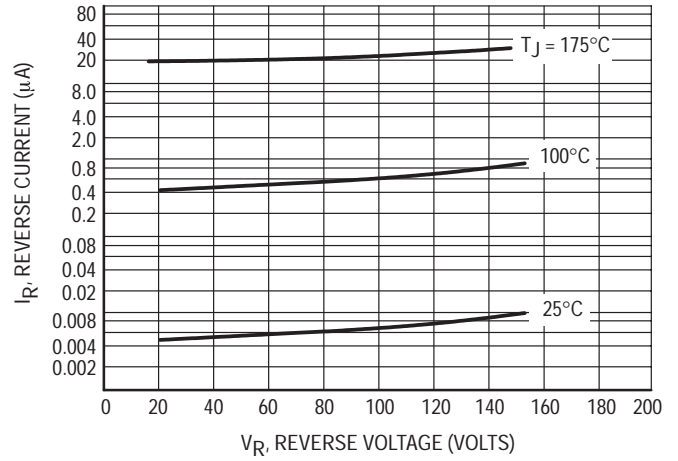


Figure 2. Typical Reverse Current

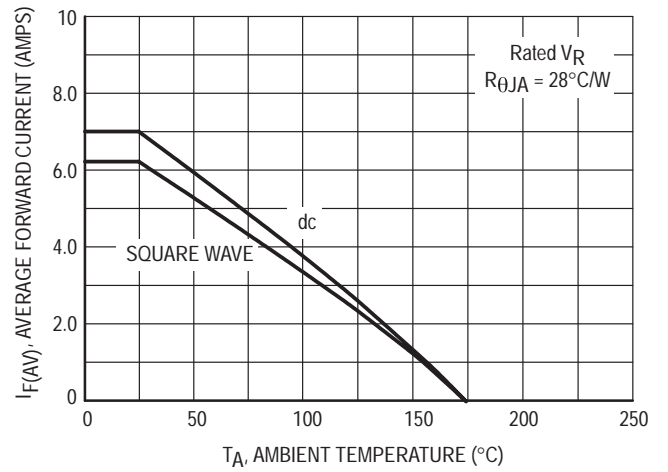


Figure 3. Current Derating
(Mounting Method #3 Per Note 1)

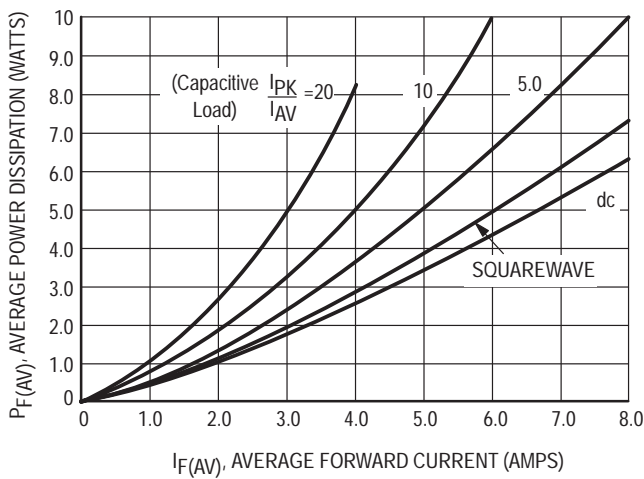


Figure 4. Power Dissipation

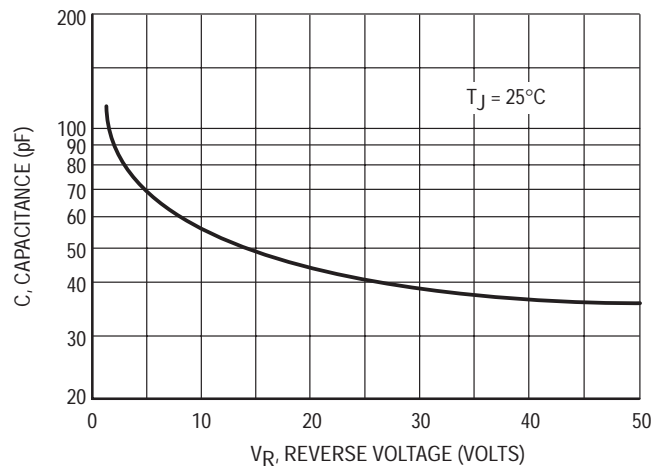


Figure 5. Typical Capacitance

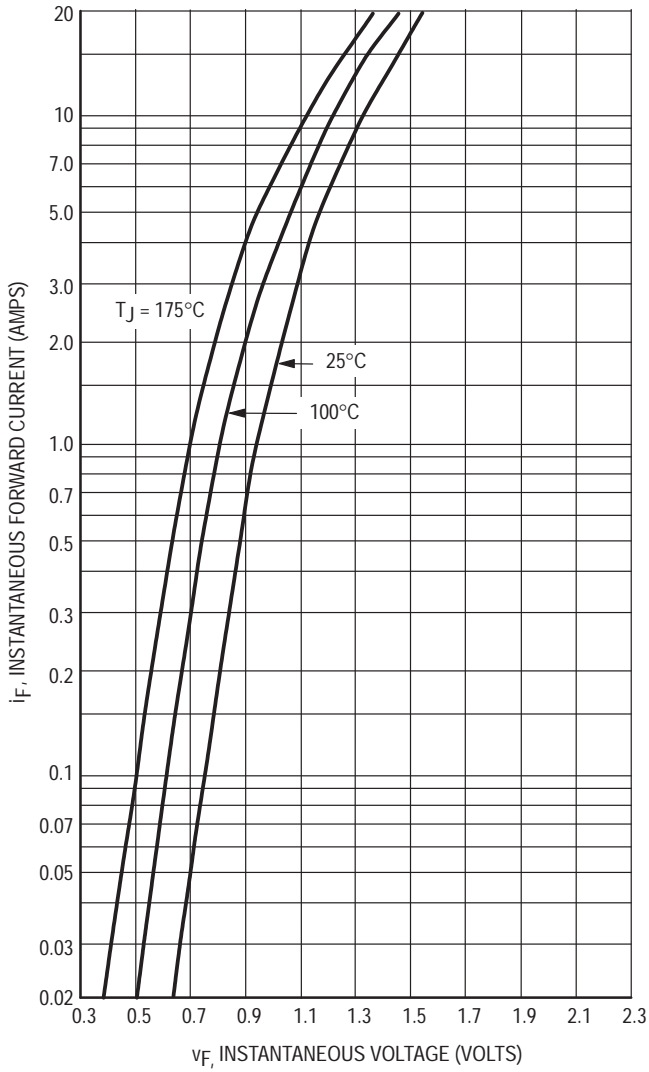


Figure 6. Typical Forward Voltage

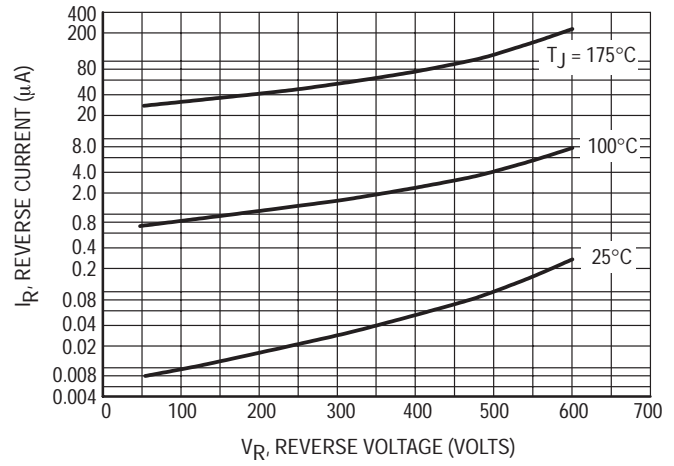


Figure 7. Typical Reverse Current

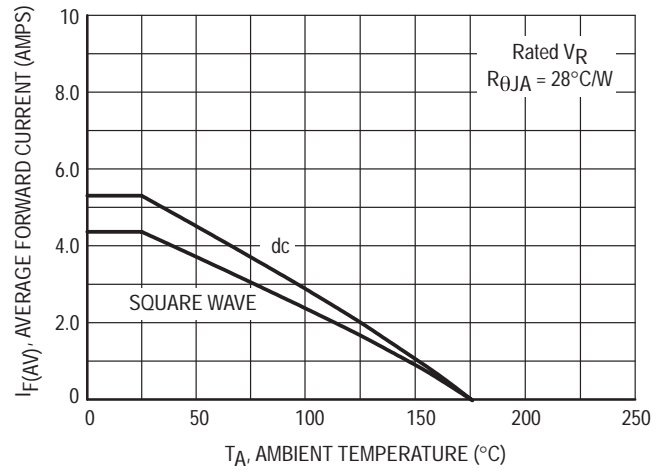


Figure 8. Current Derating
(Mounting Method #3 Per Note 1)

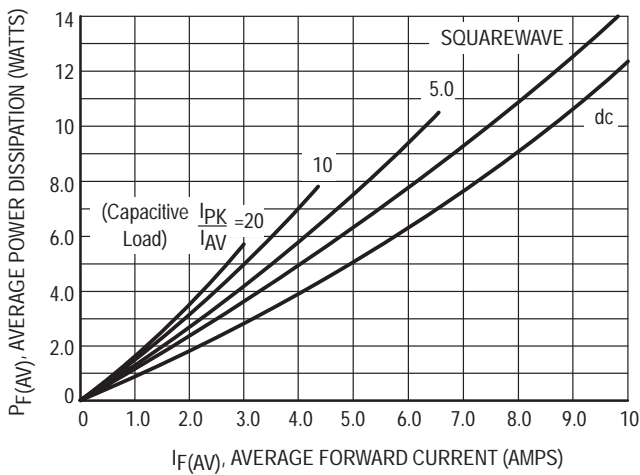


Figure 9. Power Dissipation

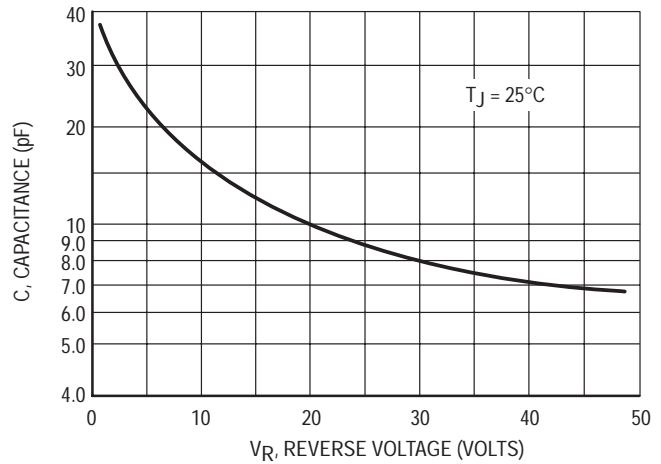


Figure 10. Typical Capacitance

NOTE 1 — AMBIENT MOUNTING DATA

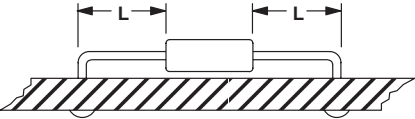
Data shown for thermal resistance junction-to-ambient ($R_{\theta JA}$) for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

TYPICAL VALUES FOR $R_{\theta JA}$ IN STILL AIR

Mounting Method	$R_{\theta JA}$	Lead Length, L (IN)				Units
		1/8	1/4	1/2	3/4	
1		50	51	53	55	°C/W
2		58	59	61	63	°C/W
3		28				°C/W

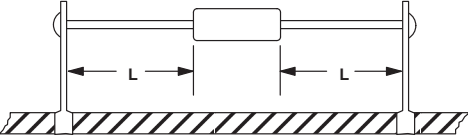
MOUNTING METHOD 1

P.C. Board Where Available Copper Surface area is small.



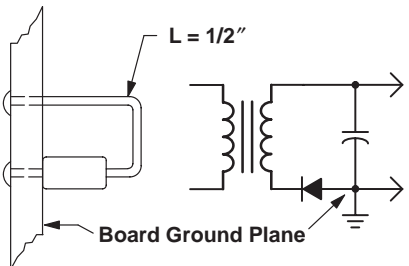
MOUNTING METHOD 2

Vector Push-In Terminals T-28



MOUNTING METHOD 3

P.C. Board with 1-1/2" x 1-1/2" Copper Surface



SWITCHMODE™ Power Rectifiers

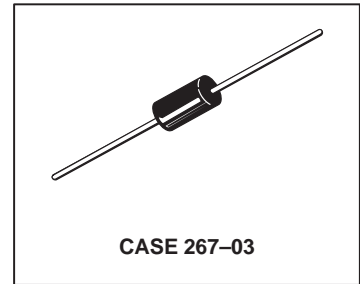
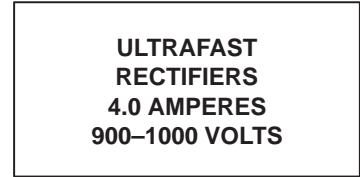
Ultrafast “E” Series with High Reverse Energy Capability

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- 20 mJ Avalanche Energy Guaranteed
- Excellent Protection Against Voltage Transients in Switching Inductive Load Circuits
- Ultrafast 75 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- Reverse Voltage to 1000 Volts

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 5,000 per bag
- Available Tape and Reeled, 1500 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode indicated by Polarity Band
- Marking: U490E, U4100E



MAXIMUM RATINGS

Rating	Symbol	MUR490E	MUR4100E	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	900	1000	Volts
Average Rectified Forward Current (Square Wave) (Mounting Method #3 Per Note 1)	$I_F(AV)$	4.0 @ $T_A = 35^\circ C$		Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, half wave, single phase, 60 Hz)	I_{FSM}	70		Amps
Operating Junction Temperature and Storage Temperature	T_J, T_{stg}	-65 to +175		°C

THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	See Note 1	°C/W
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(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle \leq 2.0%.

Preferred devices are Motorola recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ($i_F = 3.0$ Amps, $T_J = 150^\circ\text{C}$) ($i_F = 3.0$ Amps, $T_J = 25^\circ\text{C}$) ($i_F = 4.0$ Amps, $T_J = 25^\circ\text{C}$)	v_F	1.53 1.75 1.85	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 100^\circ\text{C}$) (Rated dc Voltage, $T_J = 25^\circ\text{C}$)	i_R	900 25	μA
Maximum Reverse Recovery Time ($I_F = 1.0$ Amp, $di/dt = 50$ Amp/ μs) ($I_F = 0.5$ Amp, $i_R = 1.0$ Amp, $I_{REC} = 0.25$ Amp)	t_{rr}	100 75	ns
Maximum Forward Recovery Time ($I_F = 1.0$ Amp, $di/dt = 100$ Amp/ μs , Recovery to 1.0 V)	t_{fr}	75	ns
Controlled Avalanche Energy (See Test Circuit in Figure 6)	W_{AVAIL}	20	mJ

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

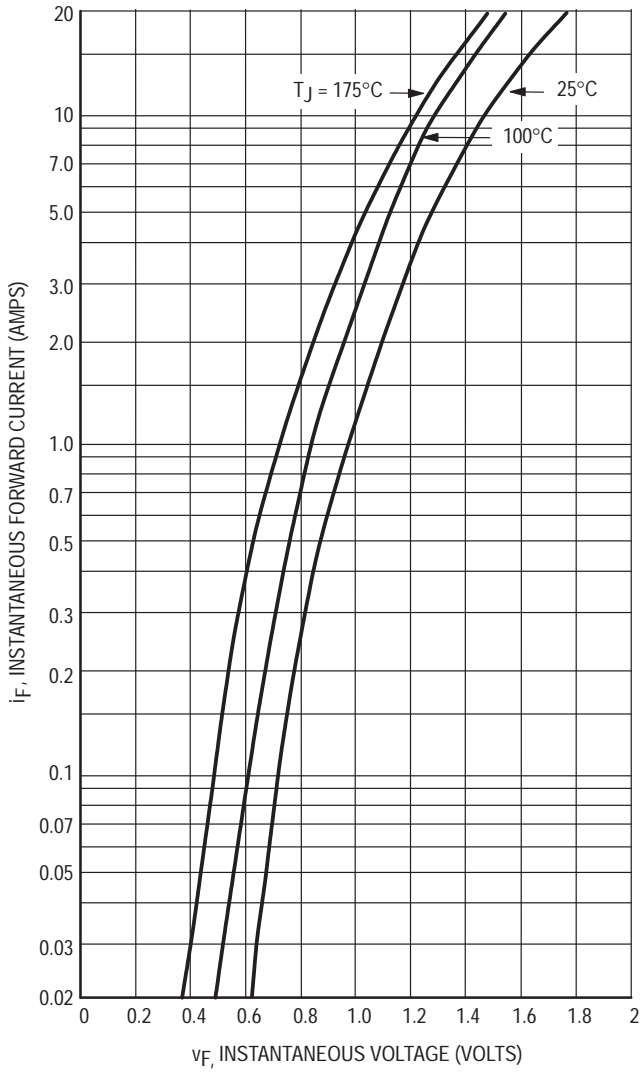


Figure 1. Typical Forward Voltage

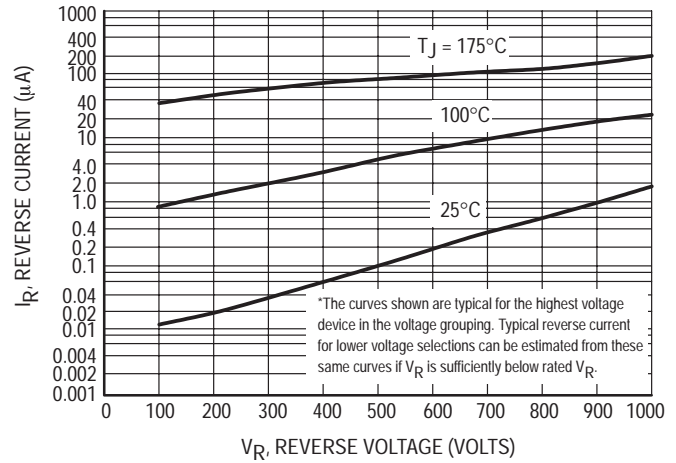


Figure 2. Typical Reverse Current*

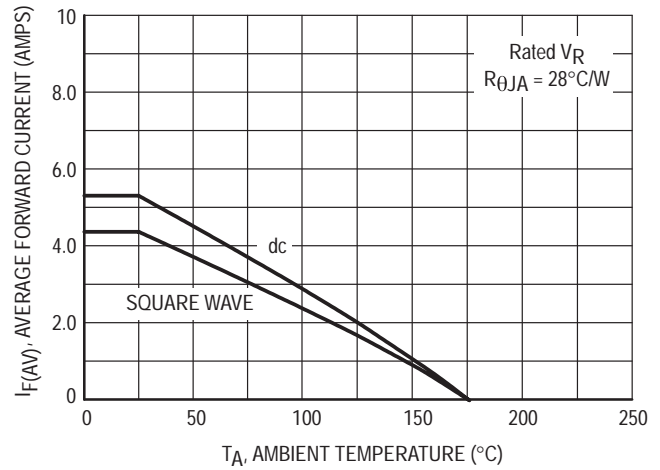


Figure 3. Current Derating (Mounting Method #3 Per Note 1)

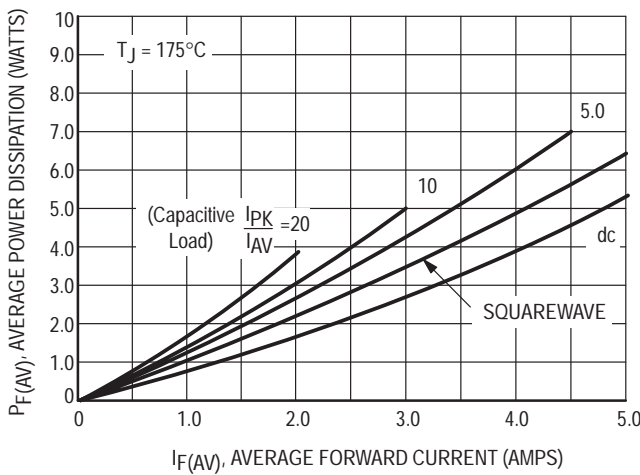


Figure 4. Power Dissipation

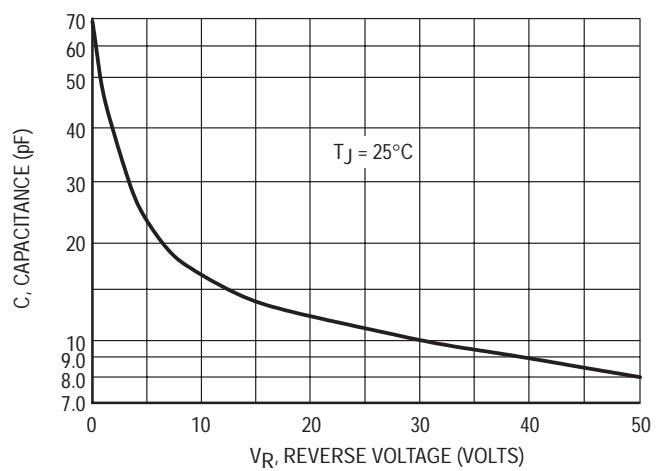


Figure 5. Typical Capacitance

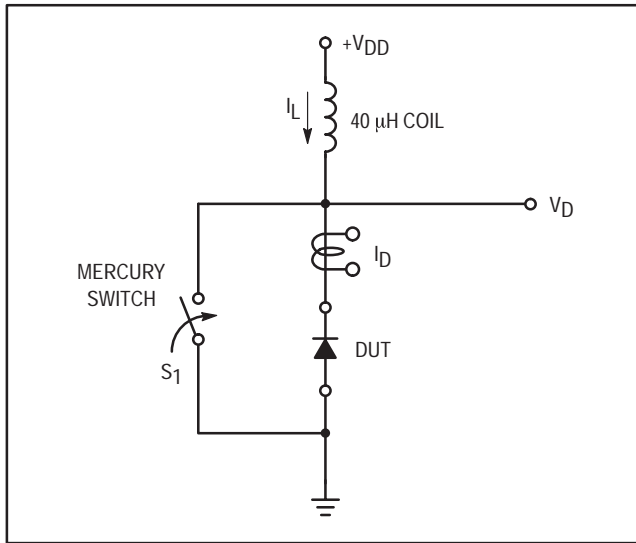


Figure 6. Test Circuit

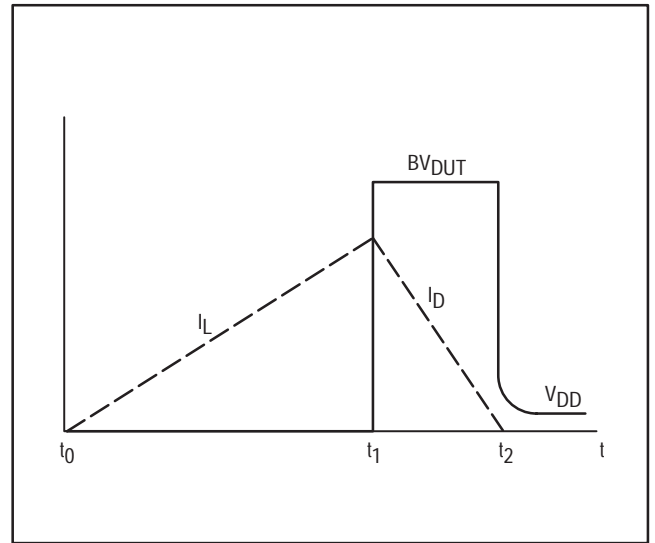


Figure 7. Current–Voltage Waveforms

The unclamped inductive switching circuit shown in Figure 6 was used to demonstrate the controlled avalanche capability of the new “E” series Ultrafast rectifiers. A mercury switch was used instead of an electronic switch to simulate a noisy environment when the switch was being opened.

When S₁ is closed at t₀ the current in the inductor I_L ramps up linearly; and energy is stored in the coil. At t₁ the switch is opened and the voltage across the diode under test begins to rise rapidly, due to di/dt effects, when this induced voltage reaches the breakdown voltage of the diode, it is clamped at BV_{DUT} and the diode begins to conduct the full load current which now starts to decay linearly through the diode, and goes to zero at t₂.

By solving the loop equation at the point in time when S₁ is opened; and calculating the energy that is transferred to the diode it can be shown that the total energy transferred is equal to the energy stored in the inductor plus a finite amount of energy from the V_{DD} power supply while the diode is in breakdown (from t₁ to t₂) minus any losses due to finite com-

ponent resistances. Assuming the component resistive elements are small Equation (1) approximates the total energy transferred to the diode. It can be seen from this equation that if the V_{DD} voltage is low compared to the breakdown voltage of the device, the amount of energy contributed by the supply during breakdown is small and the total energy can be assumed to be nearly equal to the energy stored in the coil during the time when S₁ was closed, Equation (2).

The oscilloscope picture in Figure 8, shows the information obtained for the MUR8100E (similar die construction as the MUR4100E Series) in this test circuit conducting a peak current of one ampere at a breakdown voltage of 1300 volts, and using Equation (2) the energy absorbed by the MUR8100E is approximately 20 mjoules.

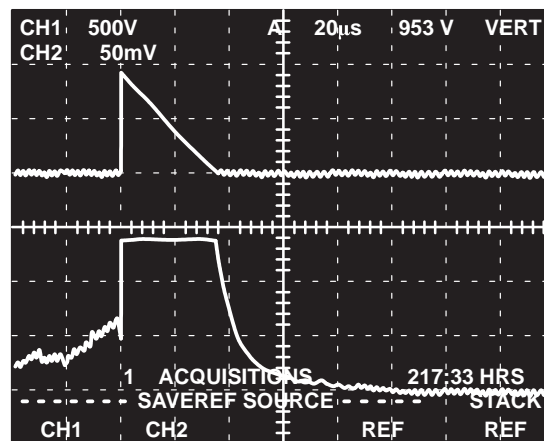
Although it is not recommended to design for this condition, the new “E” series provides added protection against those unforeseen transient viruses that can produce unexplained random failures in unfriendly environments.

EQUATION (1):

$$W_{\text{AVAL}} \approx \frac{1}{2} L I_{\text{LPK}}^2 \left(\frac{BV_{\text{DUT}}}{BV_{\text{DUT}} - V_{\text{DD}}} \right)$$

EQUATION (2):

$$W_{\text{AVAL}} \approx \frac{1}{2} L I_{\text{LPK}}^2$$



CHANNEL 2:
I_L
0.5 AMPS/DIV.

CHANNEL 1:
V_{DUT}
500 VOLTS/DIV.

TIME BASE:
20 μs/DIV.

Figure 8. Current–Voltage Waveforms

NOTE 1 — AMBIENT MOUNTING DATA

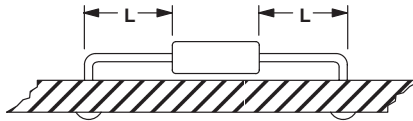
Data shown for thermal resistance junction-to-ambient ($R_{\theta JA}$) for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

TYPICAL VALUES FOR $R_{\theta JA}$ IN STILL AIR

Mounting Method	$R_{\theta JA}$	Lead Length, L (IN)				Units
		1/8	1/4	1/2	3/4	
1		50	51	53	55	°C/W
2		58	59	61	63	°C/W
3		28				°C/W

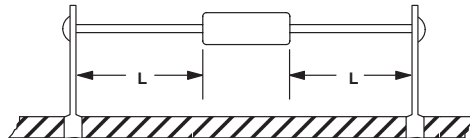
MOUNTING METHOD 1

P.C. Board Where Available Copper Surface area is small.



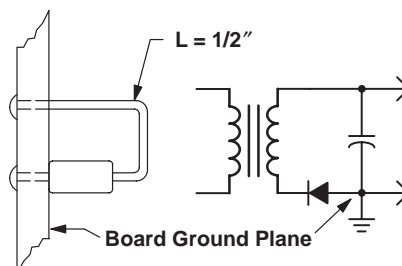
MOUNTING METHOD 2

Vector Push-In Terminals T-28



MOUNTING METHOD 3

P.C. Board with 1-1/2" x 1-1/2" Copper Surface



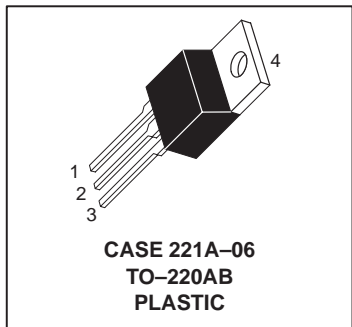
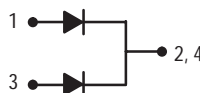
SWITCHMODE™ Power Rectifier

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Popular TO-220 Package

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U620



MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	200	Volts
Average Rectified Forward Voltage (Rated V_R) $T_C = 130^\circ\text{C}$	$I_F(AV)$ Per Diode Total Device	3.0 6.0	Amps
Peak Repetitive Forward Current Per Diode Leg (Rated V_R , Square Wave, 20 kHz) $T_C = 130^\circ\text{C}$	I_{FRM}	6.0	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	75	Amps
Operating Junction Temperature and Storage Temperature	T_J, T_{stg}	-65 to +175	°C

THERMAL CHARACTERISTICS PER DIODE LEG

Rating	Symbol	Typical	Maximum	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	5.0-6.0	7.0	°C/W

ELECTRICAL CHARACTERISTICS PER DIODE LEG

Instantaneous Forward Voltage (1) ($i_F = 3.0$ Amps, $T_C = 150^\circ\text{C}$) ($i_F = 3.0$ Amps, $T_C = 25^\circ\text{C}$)	v_F	0.80 0.94	0.895 0.975	Volts
Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 150^\circ\text{C}$) (Rated dc Voltage, $T_C = 25^\circ\text{C}$)	i_R	2.0-10 0.01-3.0	250 5.0	μA
Reverse Recovery Time ($I_F = 1.0$ Amp, $di/dt = 50$ Amps/ μs)	t_{rr}	20-30	35	ns

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

Preferred devices are Motorola recommended choices for future use and best overall value.

MUR620CT

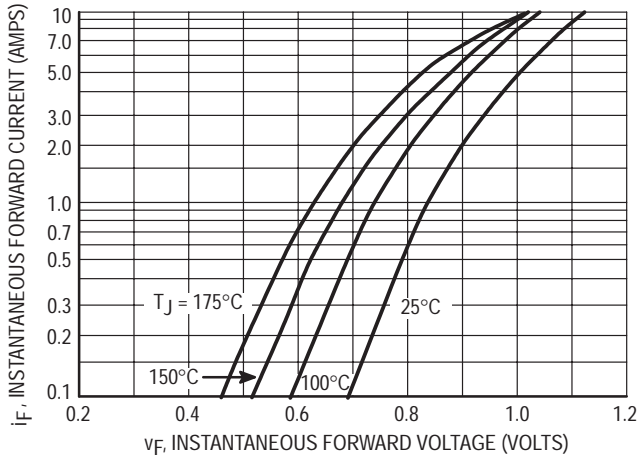


Figure 1. Typical Forward Voltage

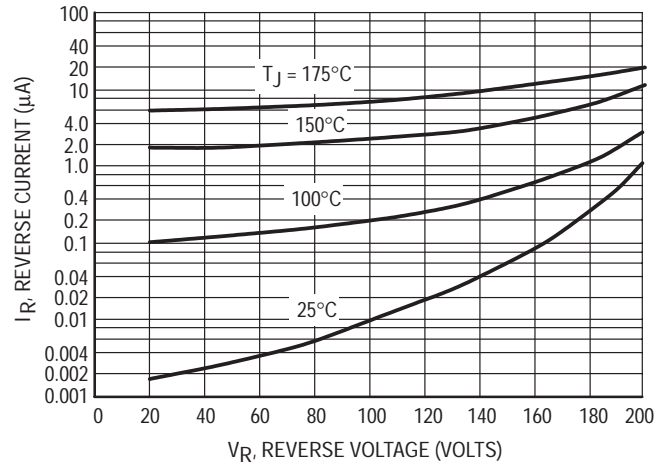


Figure 2. Typical Reverse Current

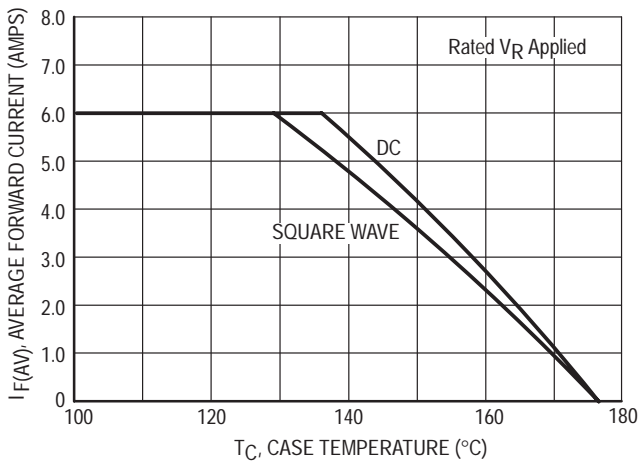


Figure 3. Total Device Current Derating, Case

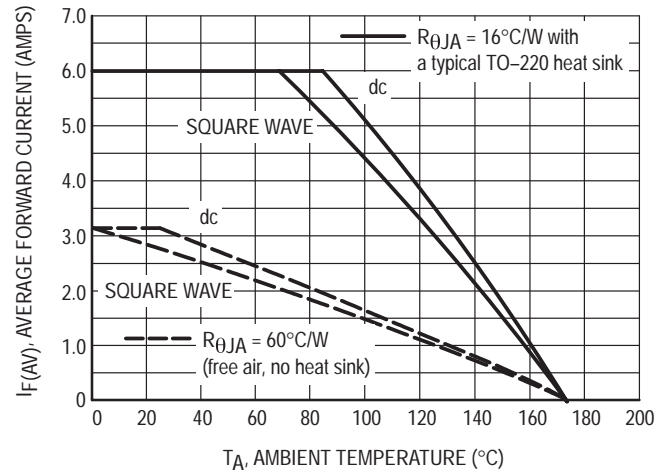


Figure 4. Total Device Current Derating, Ambient

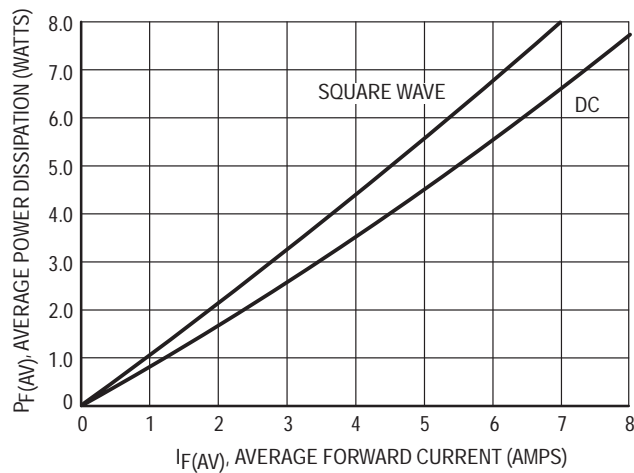


Figure 5. Power Dissipation

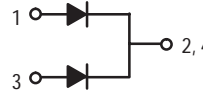
SWITCHMODE™ Power Rectifier

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 28 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Popular TO-220 Package
- Epoxy Meets UL94, V₀ @ 1/8"
- High Temperature Glass Passivated Junction
- High Voltage Capability to 400 Volts
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating @ Both Case and Ambient Temperatures

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: UH840



MURH840CT

Motorola Preferred Device

**ULTRAFAST
RECTIFIER
8.0 AMPERES
400 VOLTS**

**CASE 221A-06
TO-220AB**

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	400	Volts
Average Rectified Forward Current Total Device, (Rated V _R), T _C = 120°C	I _{F(AV)}	4.0 8.0	Amps
Peak Repetitive Forward Current (Rated V _R , Square Wave, 20 kHz), T _C = 120°C	I _{FM}	16	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I _{FSM}	100	Amps
Controlled Avalanche Energy	W _{AVAIL}	20	mJ
Operating Junction Temperature and Storage Temperature	T _J , T _{stg}	-65 to +175	°C

THERMAL CHARACTERISTICS, PER DIODE LEG

Maximum Thermal Resistance, Junction to Case	R _{θJC}	3.0	°C/W
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ELECTRICAL CHARACTERISTICS, PER DIODE LEG

Maximum Instantaneous Forward Voltage (1) (i _F = 4.0 Amps, T _C = 150°C) (i _F = 4.0 Amps, T _C = 25°C)	v _F	1.9 2.2	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, T _C = 150°C) (Rated dc Voltage, T _C = 25°C)	i _R	500 10	μA
Maximum Reverse Recovery Time (I _F = 1.0 Amp, di/dt = 50 Amps/μs)	t _{rr}	28	ns

(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

Preferred devices are Motorola recommended choices for future use and best overall value.

MURH840CT

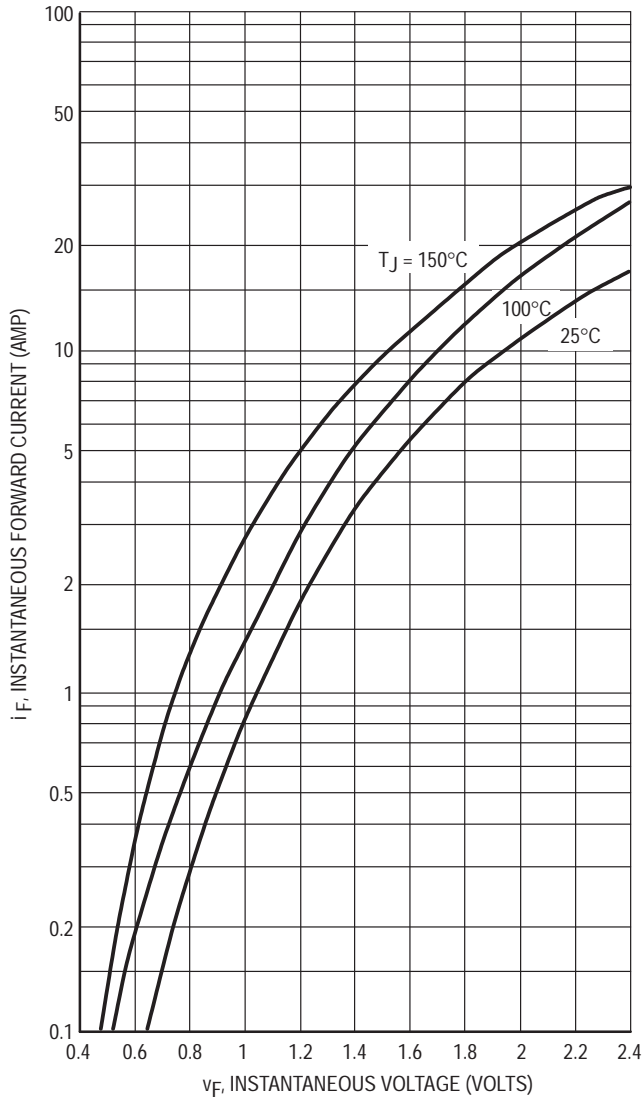


Figure 1. Typical Forward Voltage

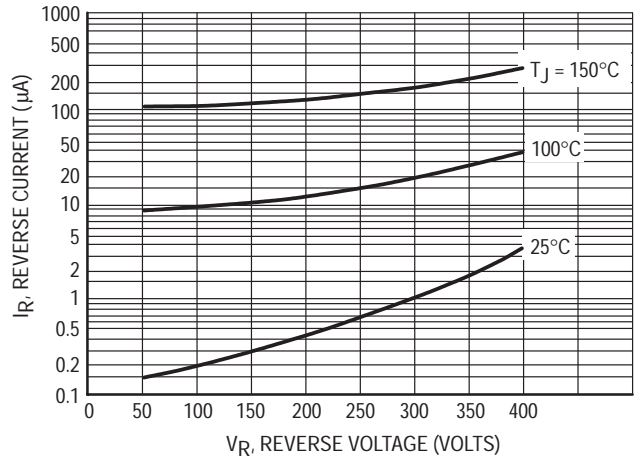


Figure 2. Typical Reverse Current, Per Leg

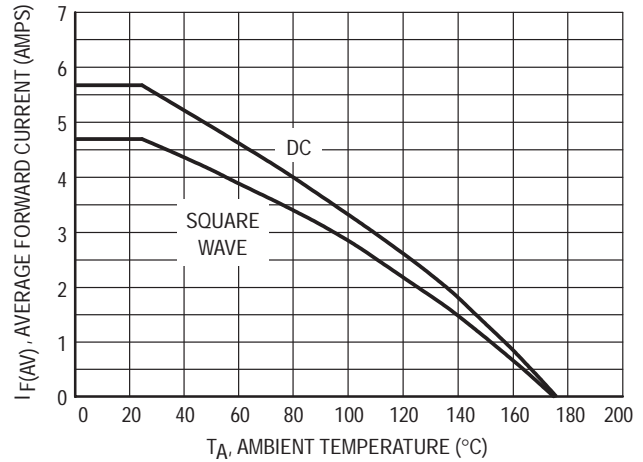


Figure 3. Forward Current Derating, Ambient, Per Leg

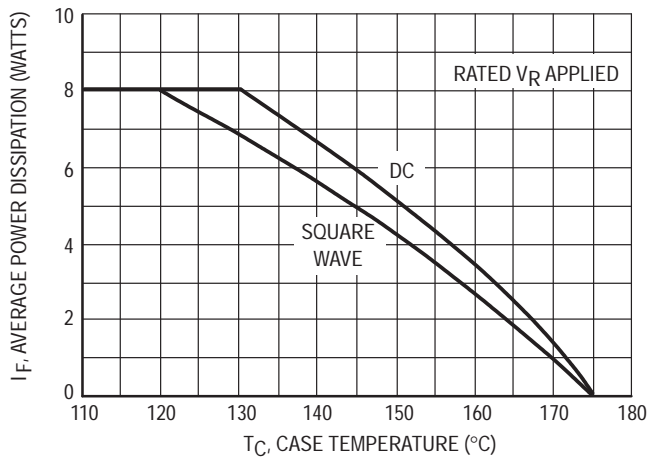


Figure 4. Current Derating, Case, Per Leg

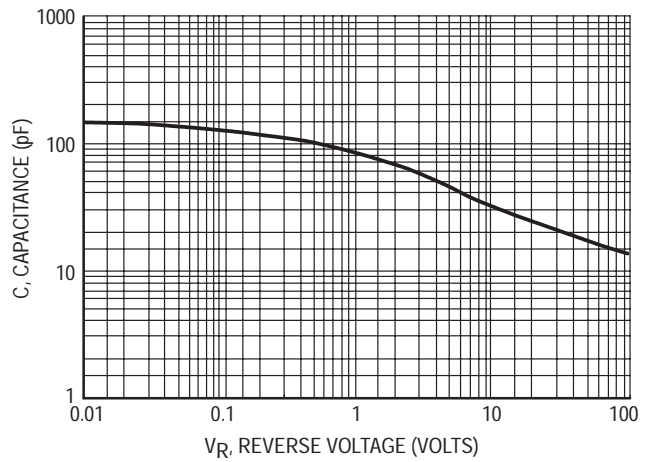


Figure 5. Typical Capacitance, Per Leg

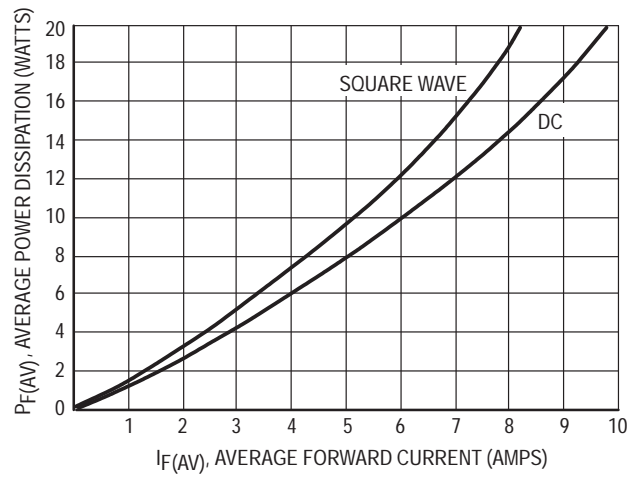


Figure 6. Forward Power Dissipation, Per Leg

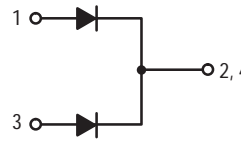
Designer's™ Data Sheet
SWITCHMODE™ Power Rectifier

. . . designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Popular TO-220 Package
- Epoxy Meets UL94, V₀ @ 1/8"
- High Temperature Glass Passivated Junction
- High Voltage Capability to 600 Volts
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating @ Both Case and Ambient Temperatures

Mechanical Characteristics

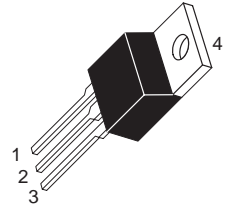
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: UH860



MURH860CT

Motorola Preferred Device

ULTRAFAST RECTIFIER
8.0 AMPERES
600 VOLTS



CASE 221A-06
TO-220AB

MAXIMUM RATINGS, PER LEG

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	600	Volts
Average Rectified Forward Current Total Device, (Rated V_R), $T_C = 120^\circ\text{C}$	$I_{F(AV)}$	4.0 8.0	Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz), $T_C = 120^\circ\text{C}$	I_{FM}	16	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	100	Amps
Operating Junction Temperature and Storage Temperature	T_J, T_{stg}	-65 to +175	$^\circ\text{C}$

THERMAL CHARACTERISTICS, PER LEG

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.0	$^\circ\text{C/W}$
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ELECTRICAL CHARACTERISTICS, PER LEG

Maximum Instantaneous Forward Voltage (1) ($i_F = 4.0$ Amps, $T_C = 150^\circ\text{C}$) ($i_F = 4.0$ Amps, $T_C = 25^\circ\text{C}$)	V_F	2.5 2.8	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 150^\circ\text{C}$) (Rated dc Voltage, $T_C = 25^\circ\text{C}$)	i_R	500 10	μA
Maximum Reverse Recovery Time ($I_F = 1.0$ Amp, $di/dt = 50$ Amps/ μs)	t_{rr}	35	ns

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

MURH860CT

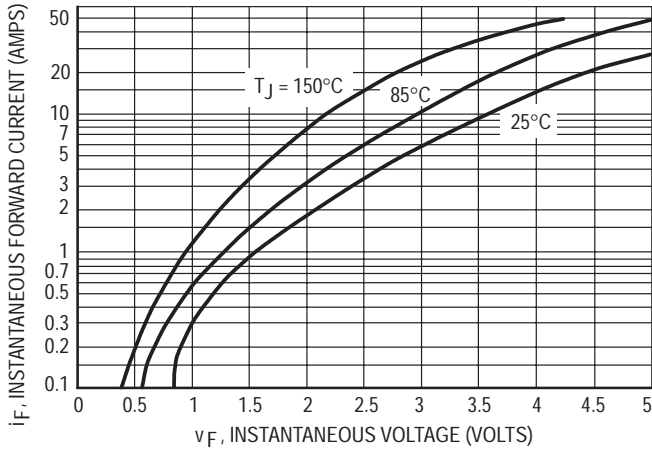


Figure 1. Typical Forward Voltage, Per Leg

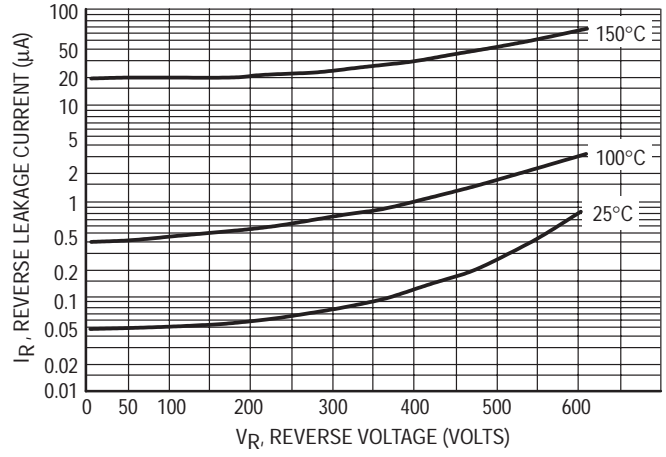


Figure 2. Typical Reverse Leakage Current, Per Leg

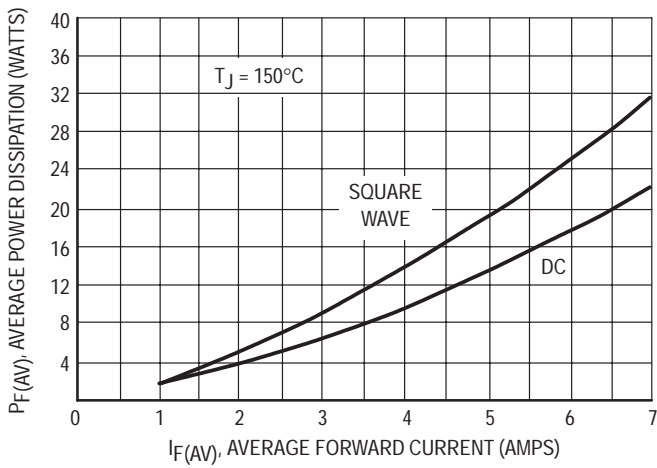


Figure 3. Typical Forward Dissipation, Per Leg

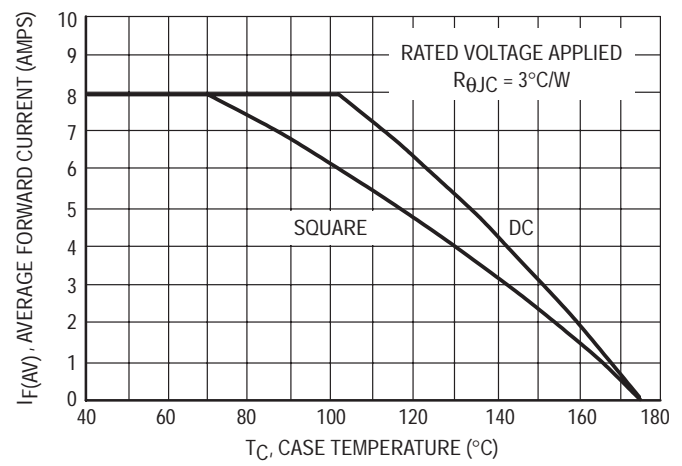


Figure 4. Typical Current Derating, Case, Per Leg

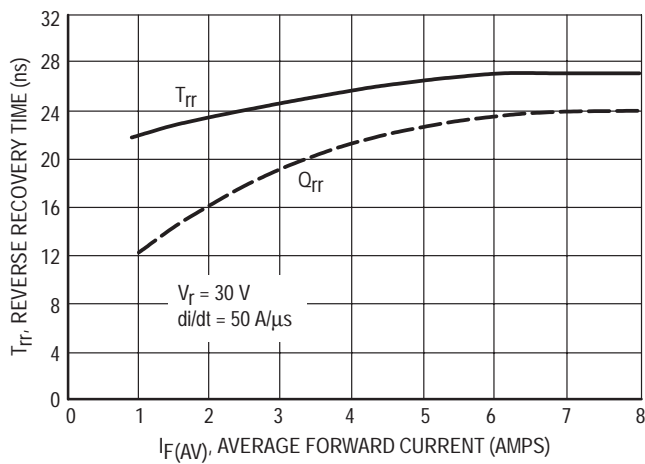


Figure 5. Typical Recovery Characteristics

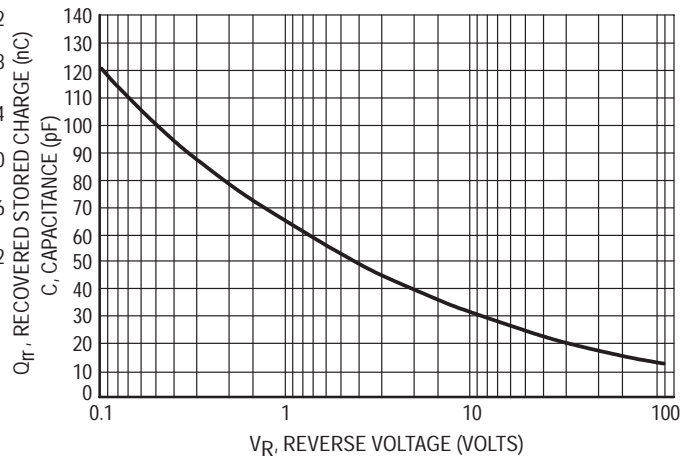


Figure 6. Typical Capacitance, Per Leg

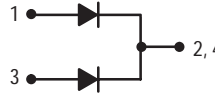
SWITCHMODE™ Power Rectifiers

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 and 60 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Popular TO-220 Package
- Epoxy Meets UL94, V₀ @ 1/8"
- High Temperature Glass Passivated Junction
- High Voltage Capability to 600 Volts
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating @ Both Case and Ambient Temperatures

Mechanical Characteristics:

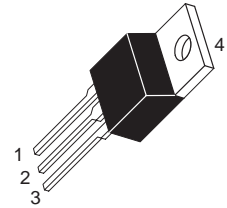
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U1620, U1640, U1660



MUR1620CT
MUR1640CT
MUR1660CT

Motorola Preferred Devices

**ULTRAFAST
RECTIFIERS
8 AMPERES
200-400-600 VOLTS**



**CASE 221A-06
TO-220AB**

MAXIMUM RATINGS

Rating	Symbol	MUR			Unit
		1620CT	1640CT	1660CT	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	200	400	600	Volts
Average Rectified Forward Current Total Device, (Rated V_R), $T_C = 150^\circ\text{C}$	Per Leg Total Device $I_F(AV)$	8.0 16			Amps
Peak Rectified Forward Current (Rated V_R , Square Wave, 20 kHz), $T_C = 150^\circ\text{C}$	Per Diode Leg I_{FM}	16			Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	100			Amps
Operating Junction Temperature and Storage Temperature	T_J, T_{stg}	- 65 to +175			°C

THERMAL CHARACTERISTICS, PER DIODE LEG

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.0	2.0	°C/W
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ELECTRICAL CHARACTERISTICS, PER DIODE LEG

Maximum Instantaneous Forward Voltage (1) ($i_F = 8.0$ Amps, $T_C = 150^\circ\text{C}$) ($i_F = 8.0$ Amps, $T_C = 25^\circ\text{C}$)	v_F	0.895 0.975	1.00 1.30	1.20 1.50	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 150^\circ\text{C}$) (Rated dc Voltage, $T_C = 25^\circ\text{C}$)	i_R	250 5.0	500 10		μA
Maximum Reverse Recovery Time ($I_F = 1.0$ Amp, $di/dt = 50$ Amps/μs) ($I_F = 0.5$ Amp, $I_R = 1.0$ Amp, $I_{REC} = 0.25$ Amp)	t_{rr}	35 25	60 50		ns

(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%

Preferred devices are Motorola recommended choices for future use and best overall value.

MUR1620CT MUR1640CT MUR1660CT

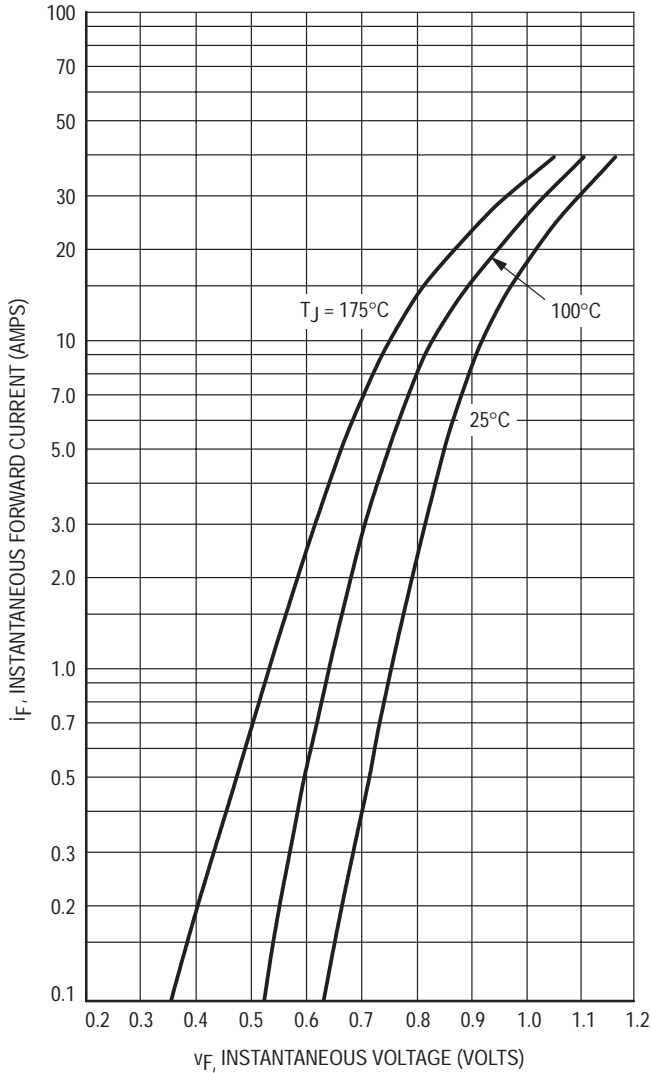


Figure 1. Typical Forward Voltage, Per Leg

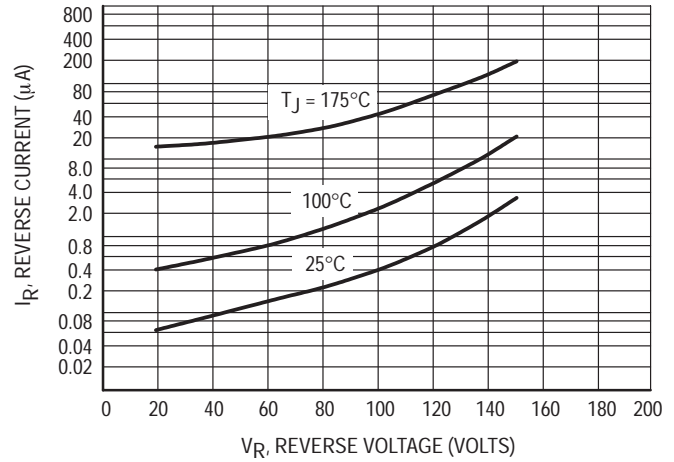


Figure 2. Typical Reverse Current, Per Leg*

* The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V_R is sufficiently below rated V_R .

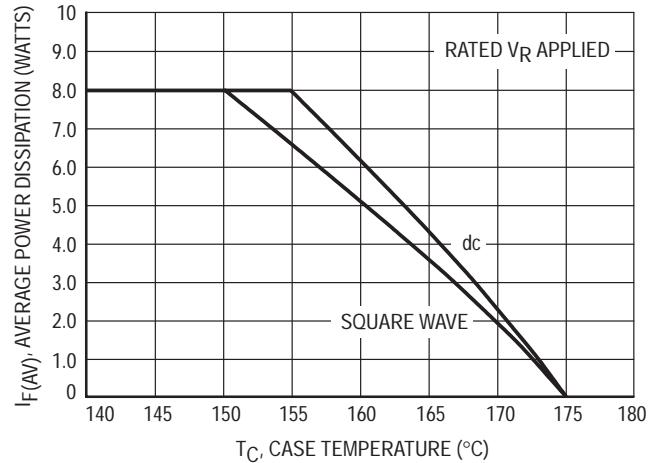


Figure 3. Current Derating, Case, Per Leg

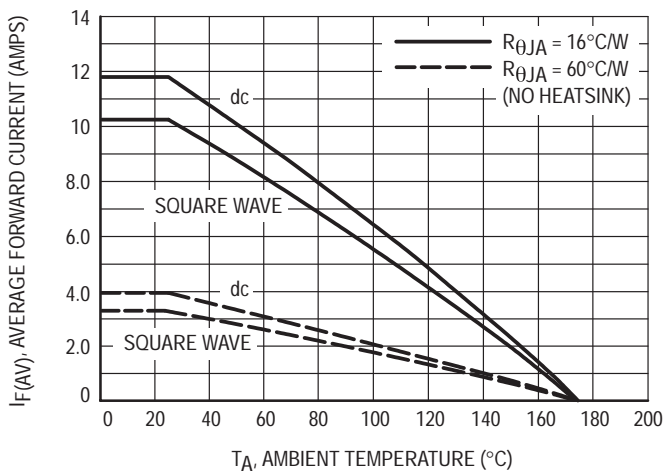


Figure 4. Current Derating, Ambient, Per Leg

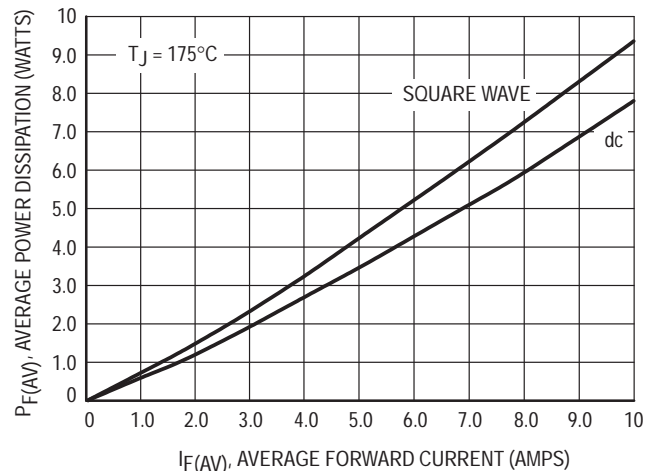


Figure 5. Power Dissipation, Per Leg

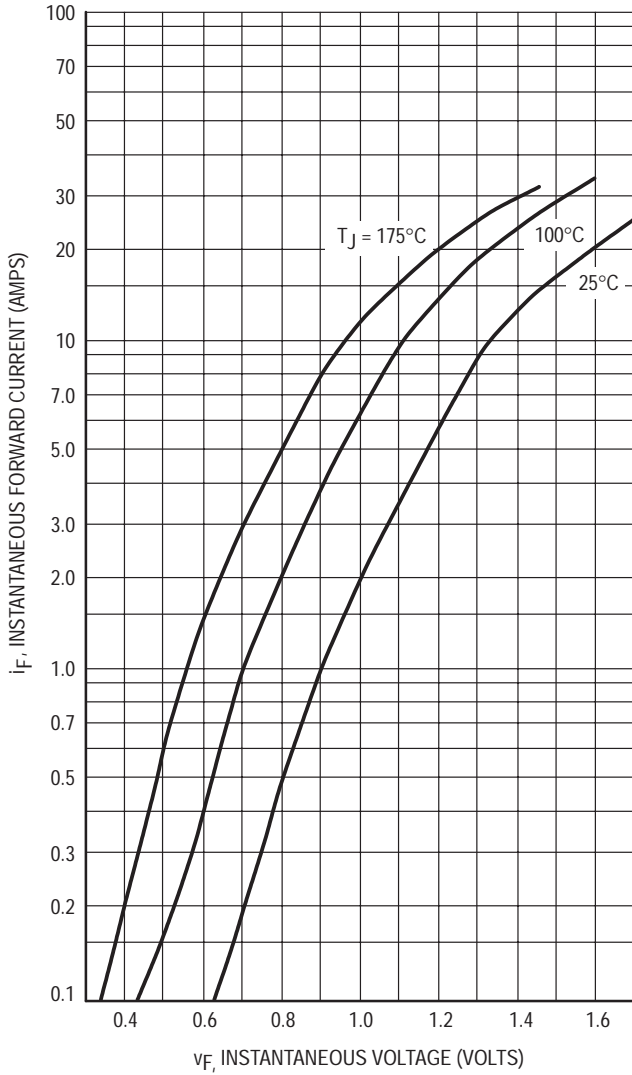


Figure 6. Typical Forward Voltage, Per Leg

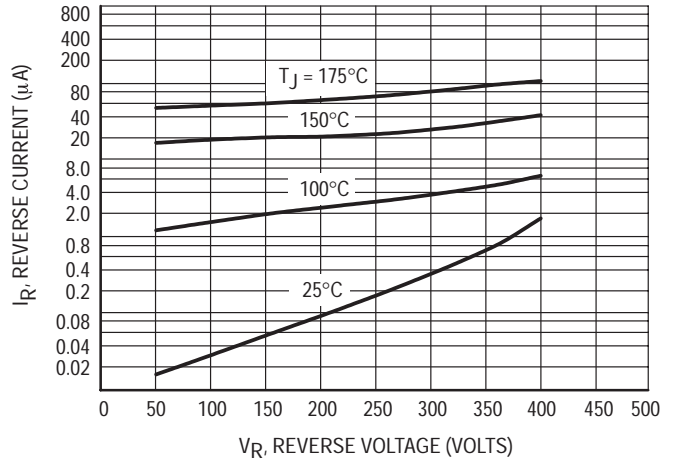


Figure 7. Typical Reverse Current, Per Leg*

* The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these curves if V_R is sufficiently below rated V_R .

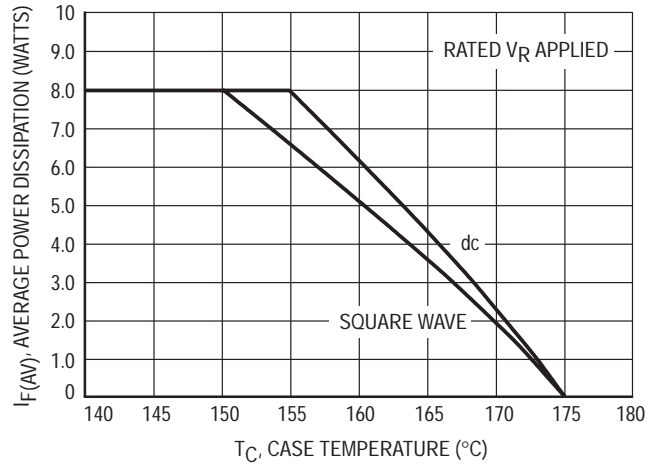


Figure 8. Current Derating, Case, Per Leg

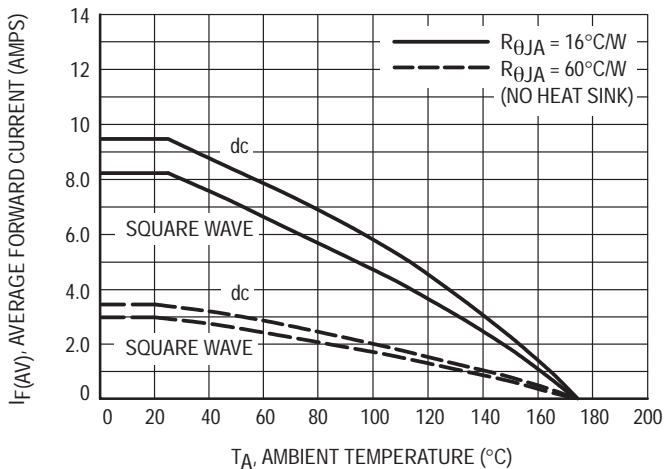


Figure 9. Current Derating, Ambient, Per Leg

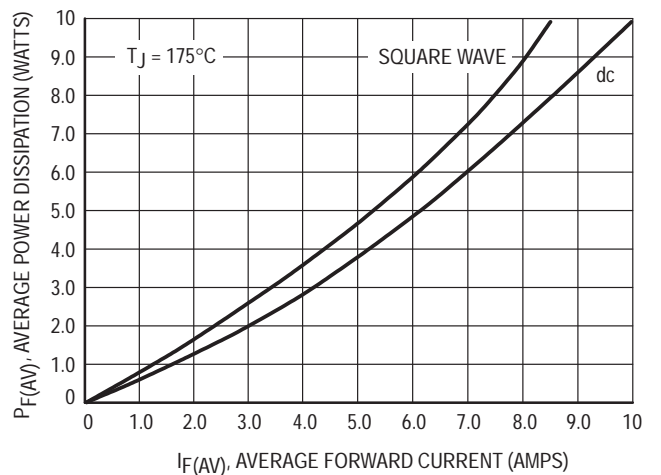


Figure 10. Power Dissipation, Per Leg

MUR1620CT MUR1640CT MUR1660CT

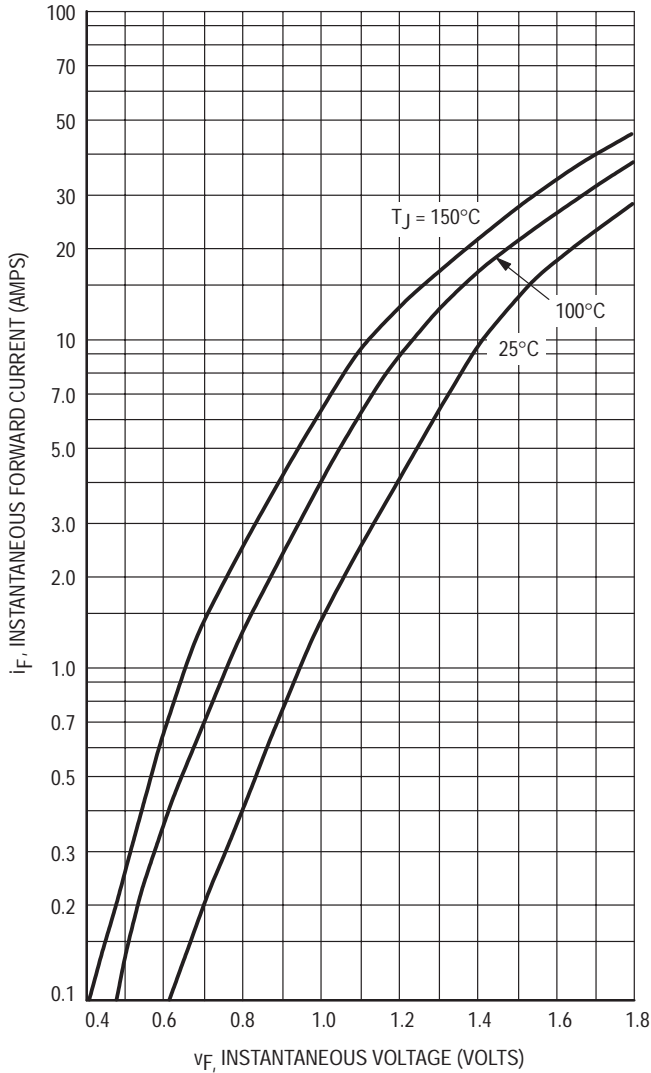


Figure 11. Typical Forward Voltage, Per Leg

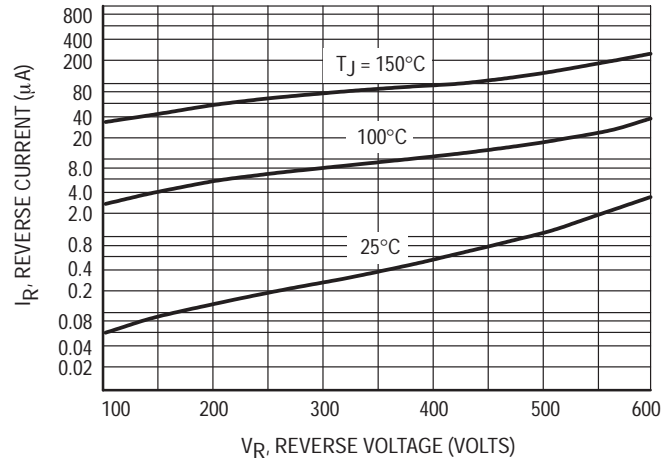


Figure 12. Typical Reverse Current, Per Leg*

* The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V_R is sufficiently below rated V_R .

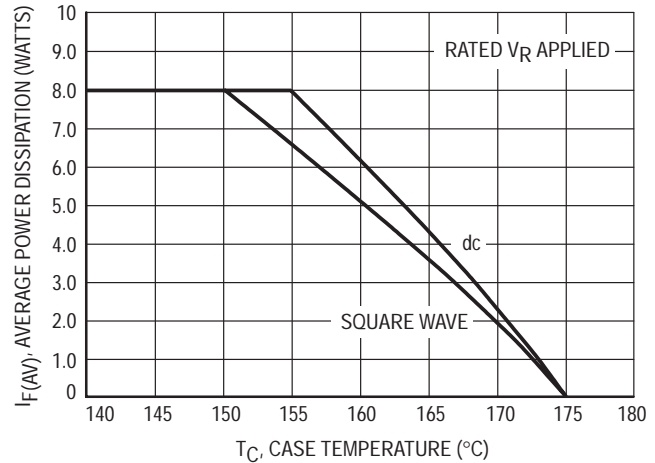


Figure 13. Current Derating, Case, Per Leg

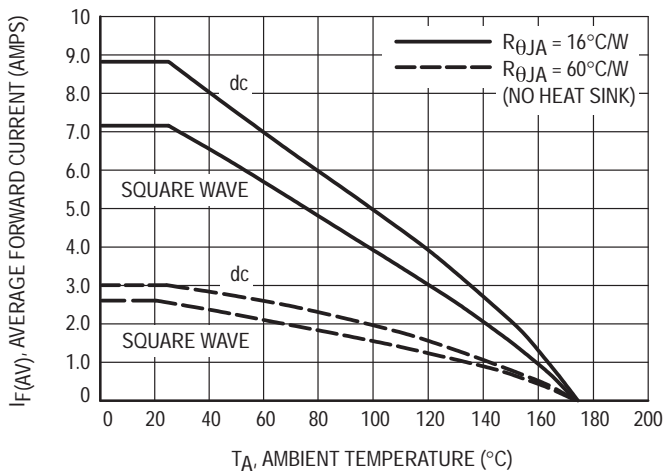


Figure 14. Current Derating, Ambient, Per Leg

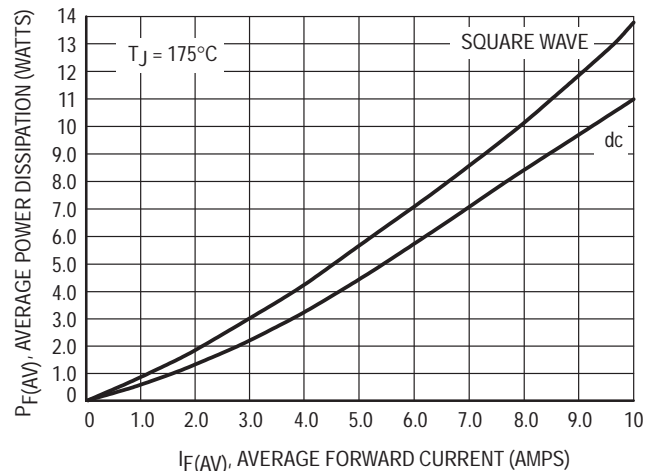


Figure 15. Power Dissipation, Per Leg

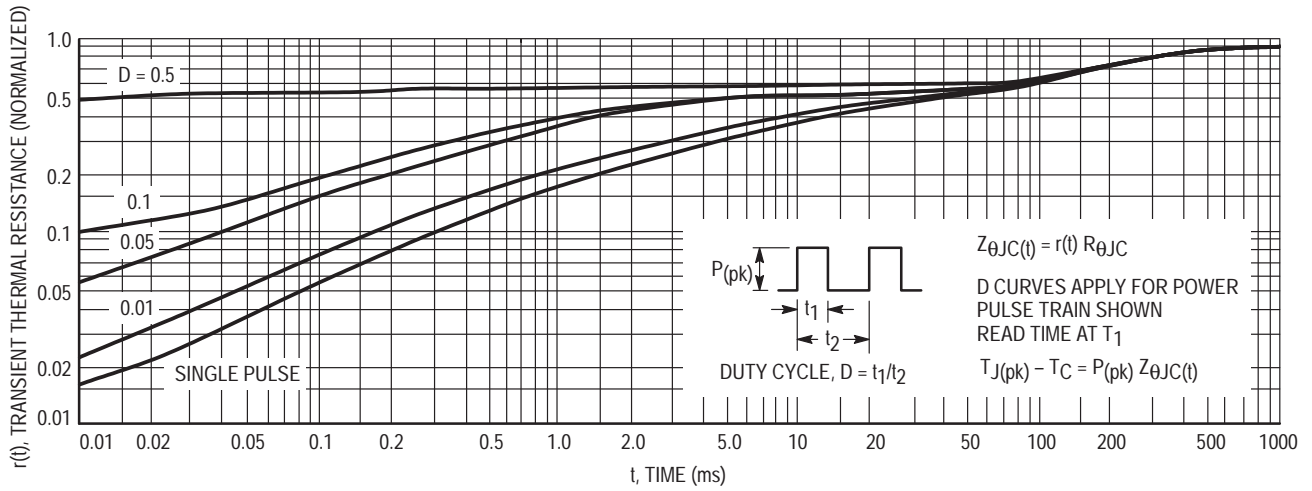


Figure 16. Thermal Response

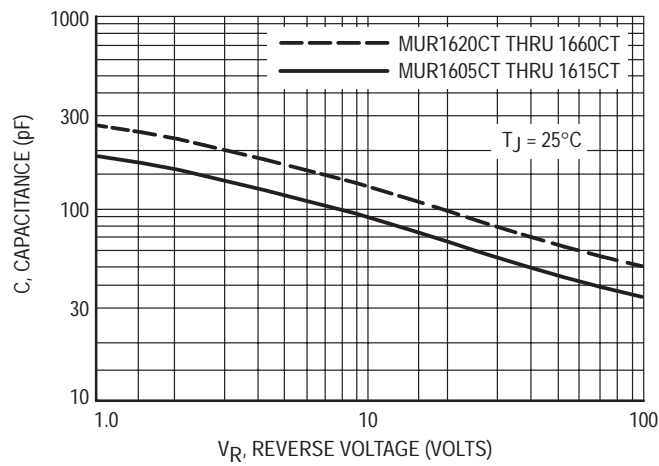


Figure 17. Typical Capacitance, Per Leg

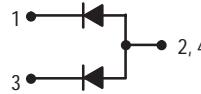
SWITCHMODE™ Dual Ultrafast Power Rectifier

... designed for use in negative switching power supplies, inverters and as free wheeling diodes. Also, used in conjunction with common cathode dual Ultrafast Rectifiers, makes a single phase full-wave bridge. These state-of-the-art devices have the following features:

- Common Anode Dual Rectifier (8.0 A per Leg or 16 A per Package)
- Ultrafast 35 Nanosecond Reverse Recovery Times
- Exhibits Soft Recovery Characteristics
- High Temperature Glass Passivated Junction
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating @ Both Case and Ambient Temperatures
- Epoxy Meets UL94, V_O @ 1/8"
- Complement to MUR1605CT Series of Common Cathode Devices

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U1620R



MUR1620CTR

Motorola Preferred Device

**ULTRAFAST
RECTIFIER
16 AMPERES
200 VOLTS**

**CASE 221A-06
TO-220AB
STYLE 7**

MAXIMUM RATINGS (Per Leg)

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	200	Volts
Average Rectified Forward Voltage, (Rated V_R), $T_C = 160^\circ\text{C}$ Per Leg Per Total Device	$I_F(AV)$	8.0 16	Amps
Peak Repetitive Surge Current, Per Diode (Rated V_R , Square Wave, 20 kHz), $T_C = 140^\circ\text{C}$	I_{FM}	16	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	100	Amps
Operating Junction Temperature and Storage Temperature	T_J, T_{stg}	-65 to +175	$^\circ\text{C}$

THERMAL CHARACTERISTICS (Per Leg)

Thermal Resistance — Junction to Case	$R_{\theta JC}$	2.0	$^\circ\text{C/W}$
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ELECTRICAL CHARACTERISTICS (Per Leg)

Maximum Instantaneous Forward Voltage (1) ($I_F = 8.0$ Amps, $T_C = 25^\circ\text{C}$) ($I_F = 8.0$ Amps, $T_C = 150^\circ\text{C}$)	V_F	1.2 1.1	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 25^\circ\text{C}$) (Rated dc Voltage, $T_C = 150^\circ\text{C}$)	i_R	5.0 500	μA
Maximum Reverse Recovery Time ($I_F = 1.0$ Amp, $di/dt = 50$ Amps/ μs) ($I_F = 0.5$ Amp, $di/dt = 100$ Amps/ μs)	t_{rr}	85 35	ns

(1) Pulse Test: Pulse Width = 5.0 ms, Duty Cycle $\leq 10\%$.

Preferred devices are Motorola recommended choices for future use and best overall value.

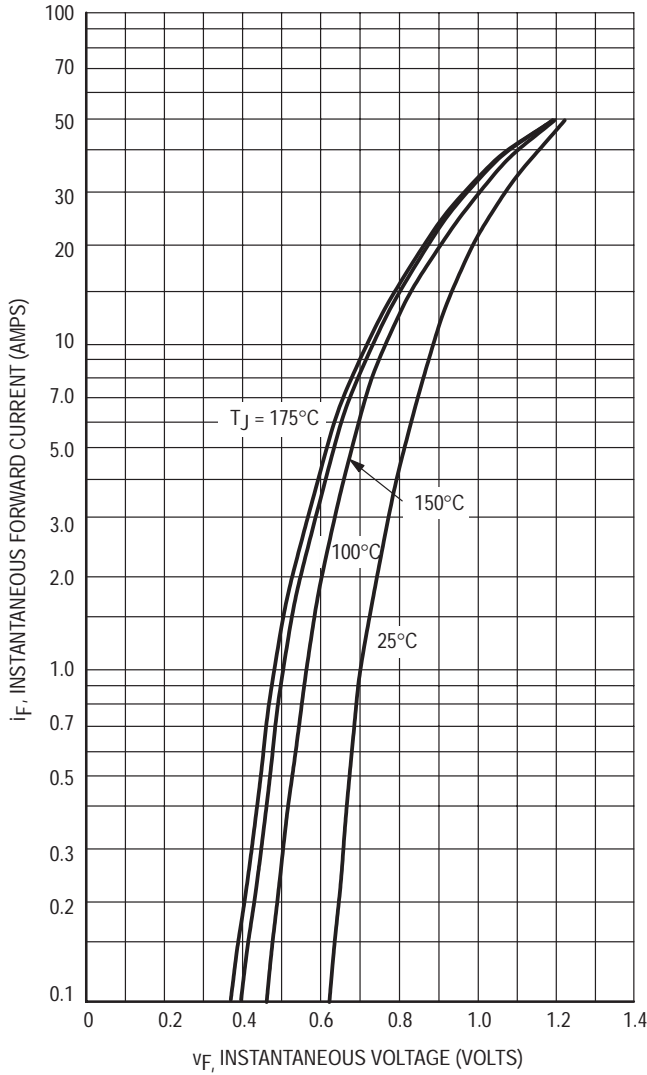


Figure 1. Typical Forward Voltage (Per Leg)

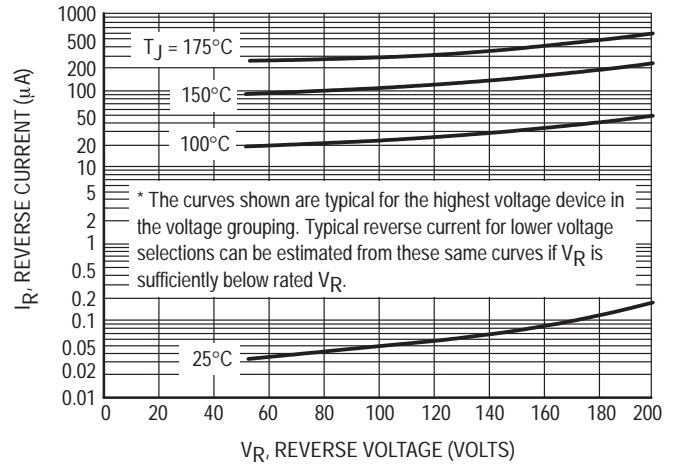


Figure 2. Typical Reverse Current* (Per Leg)

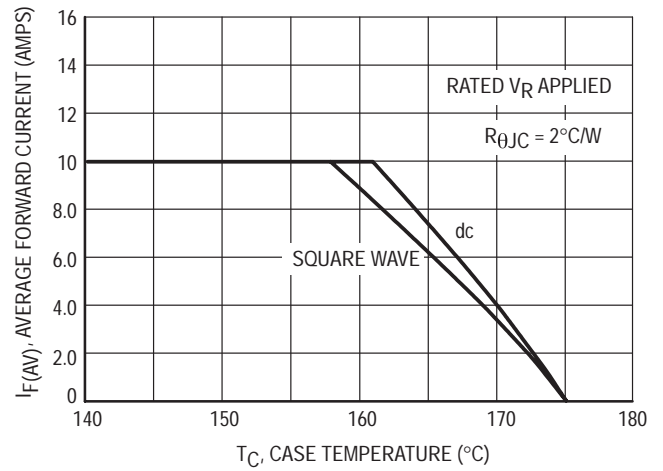


Figure 3. Current Derating, Case (Per Leg)

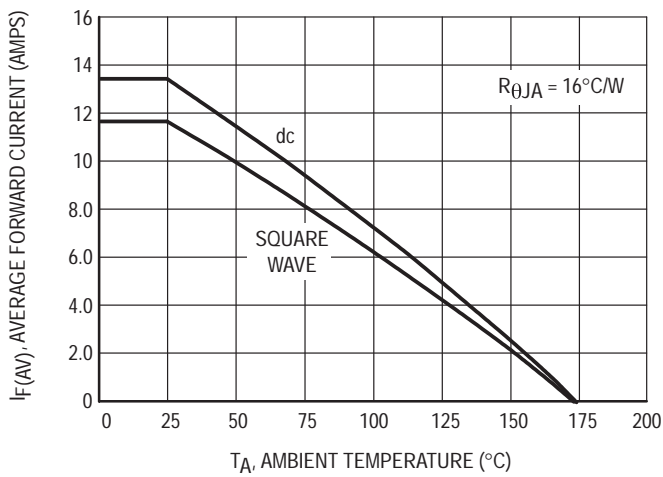


Figure 4. Current Derating, Ambient (Per Leg)

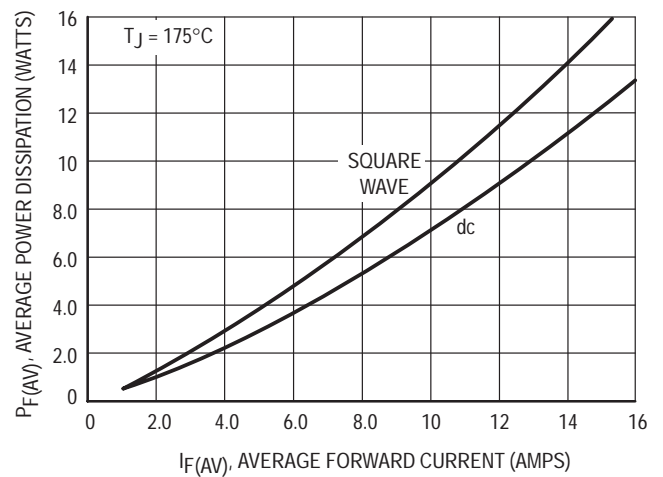


Figure 5. Power Dissipation (Per Leg)

MUR1620CTR

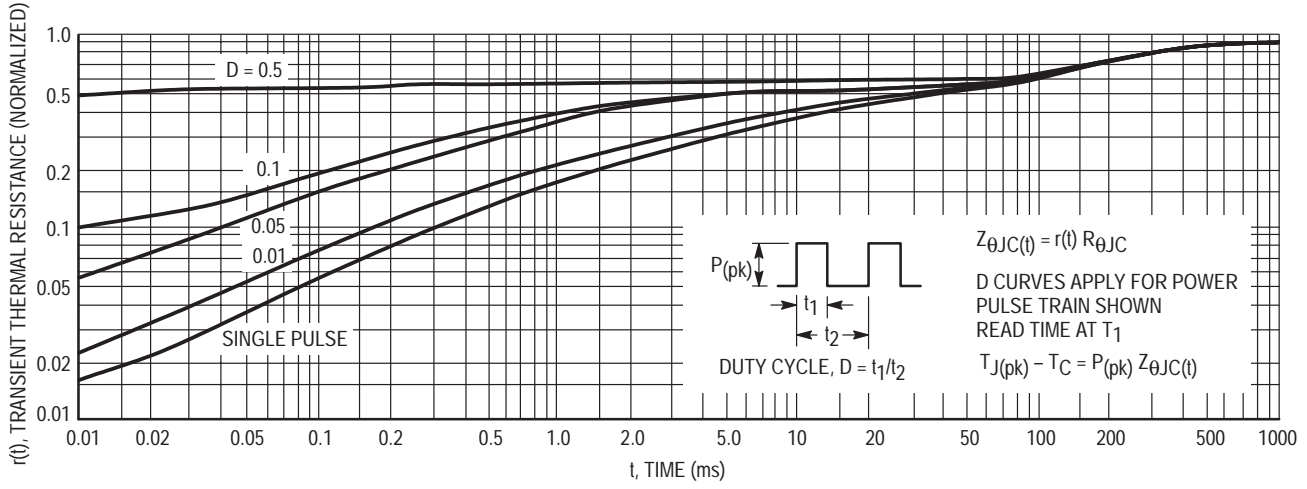


Figure 6. Thermal Response

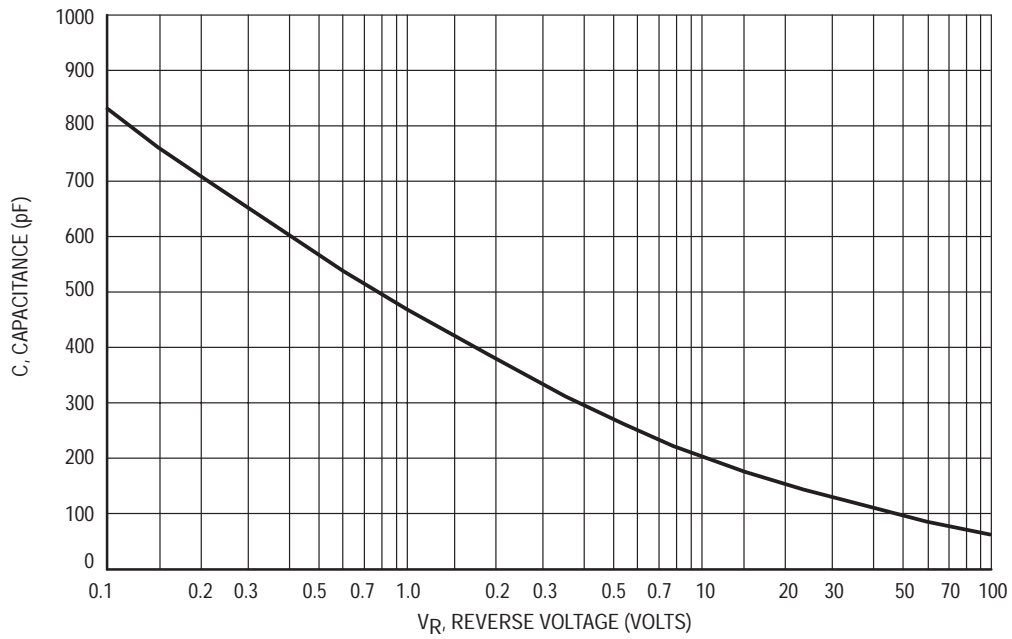


Figure 7. Typical Capacitance (Per Leg)

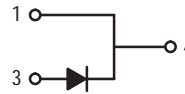
Designer's™ Data Sheet
SCANSWITCH™ Power Rectifier
For Use As A Damper Diode
In High and Very High Resolution Monitors

The MUR5150E is a state-of-the-art Ultrafast Power Rectifier specifically designed for use as a damper diode in horizontal deflection circuits for high and very high resolution monitors. In these applications, the outstanding performance of the MUR5150E is fully realized when paired with the appropriate 1500V SCANSWITCH Bipolar Power Transistor.

- 1500 V Blocking Voltage
- 20 mJoules Avalanche Energy Guaranteed
- Peak Transient Overshoot Voltage Specified, 17 Volts (typical)
- Forward Recovery Time Specified, 175 ns (typical)
- Epoxy Meets UL94, V_O at 1/8"

Mechanical Characteristics

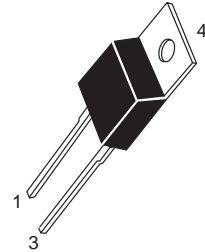
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U5150E



MUR5150E

Motorola Preferred Device

**SCANSWITCH
RECTIFIER
5.0 AMPERES
1500 VOLTS**



**CASE 221B-03
(TO-220AC)**

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	1500	Volts
Average Rectified Forward Current, (Rated V _R), T _C = 100°C	I _{F(AV)}	5.0	Amps
Peak Repetitive Forward Current, Per Leg (Rated V _R , Square Wave, 20 kHz), T _C = 100°C	I _{FRM}	10	Amps
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I _{FSM}	100	Amps
Operating Junction and Storage Temperature	T _J , T _{stg}	-65 to +125	°C
Controlled Avalanche Energy	W _{AVAIL}	20	mJ

THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Case	R _{θJC}	2.0	°C/W
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Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

MUR5150E

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Typ	Max	Unit
Maximum Instantaneous Forward Voltage (1) ($i_F = 2.0$ Amps, $T_J = 25^\circ\text{C}$) ($i_F = 5.0$ Amps, $T_J = 25^\circ\text{C}$)	V_F	1.7 2.0	2.0 2.4	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 125^\circ\text{C}$) (Rated dc Voltage, $T_J = 25^\circ\text{C}$)	i_R	100 10	500 50	μA
Maximum Reverse Recovery Time ($I_F = 1.0$ Amps, $di/dt = 50$ Amps/ μs)	t_{rr}	130	175	ns
Maximum Forward Recovery Time ($I_F = 6.5$ Amps, $di/dt = 12$ Amps/ μs)	t_{fr}	175	225	ns
Peak Transient Overshoot Voltage	V_{RFM}	17	20	Volts

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$

TYPICAL ELECTRICAL CHARACTERISTICS

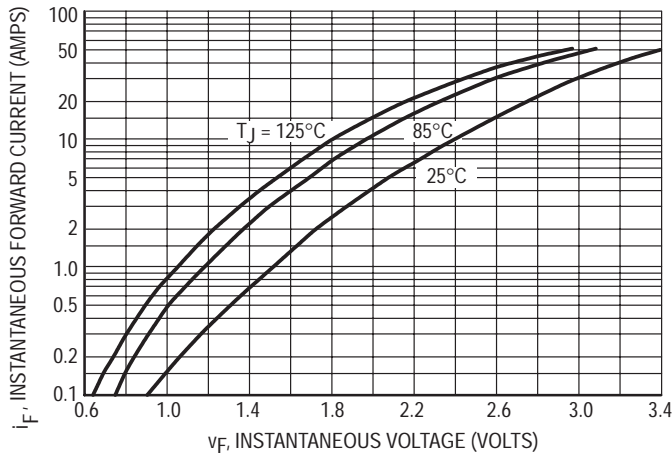


Figure 1. Typical Forward Voltage

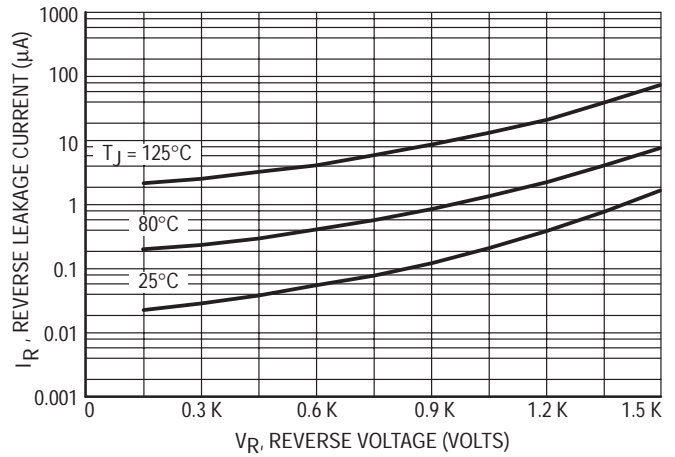


Figure 2. Typical Reverse Leakage Current

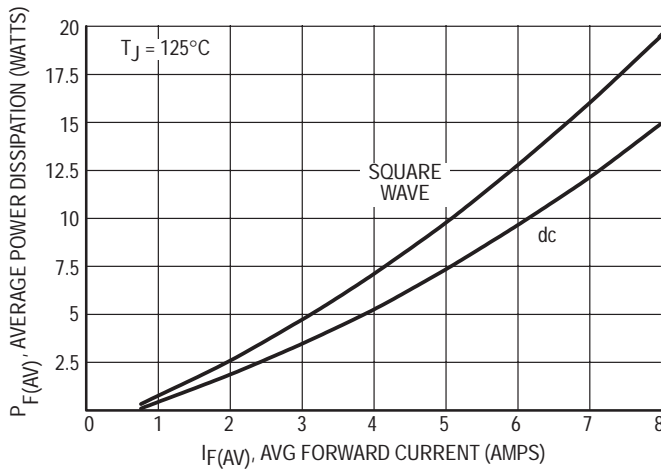


Figure 3. Forward Power Dissipation

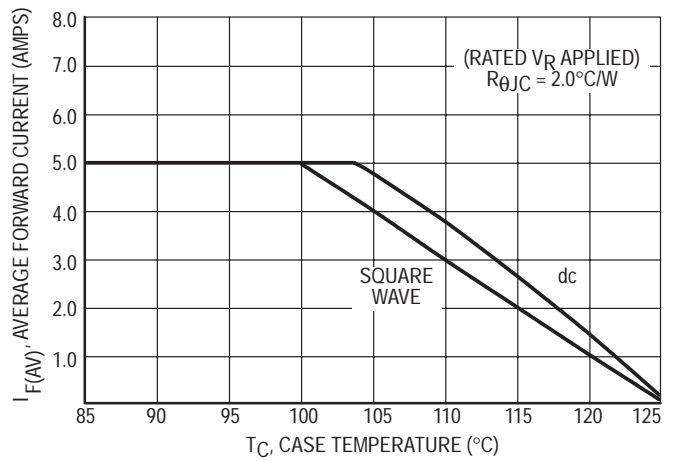


Figure 4. Current Derating Case

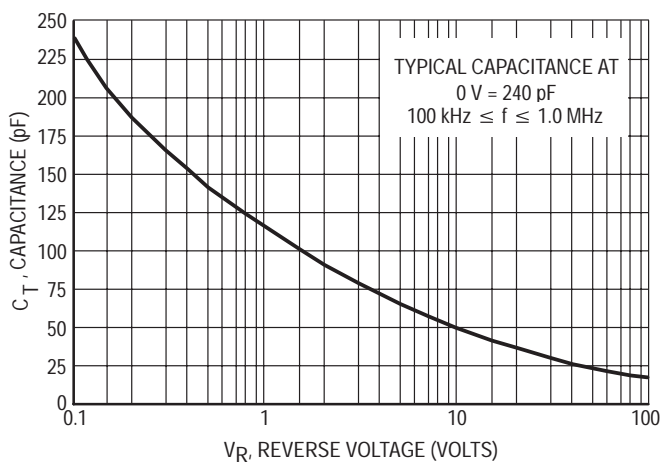


Figure 5. Typical Capacitance

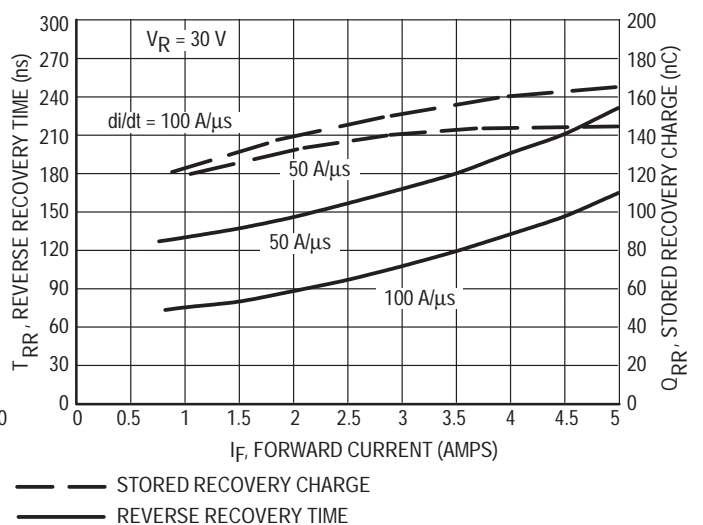


Figure 6. Typical Reverse Switching Characteristics

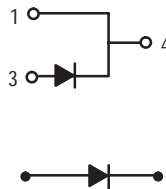
SWITCHMODE™ Power Rectifiers

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 25, 50 and 75 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Popular TO-220 Package
- Epoxy Meets UL94, V₀ @ 1/8"
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- Reverse Voltage to 600 Volts

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U820, U840, U860



MUR820
MUR840
MUR860

Motorola Preferred Devices

ULTRAFAST
RECTIFIERS
8 AMPERES
200-400-600 VOLTS

CASE 221B-03
TO-220AC

MAXIMUM RATINGS

Rating	Symbol	MUR			Unit
		820	840	860	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	200	400	600	Volts
Average Rectified Forward Current Total Device, (Rated V _R), T _C = 150°C	I _{F(AV)}	8.0			Amps
Peak Repetitive Forward Current (Rated V _R , Square Wave, 20 kHz), T _C = 150°C	I _{FM}	16			Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I _{FSM}	100			Amps
Operating Junction Temperature and Storage Temperature	T _J , T _{stg}	-65 to +175			°C

THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	R _{θJC}	3.0	2.0	°C/W
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ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) (I _F = 8.0 Amps, T _C = 150°C) (I _F = 8.0 Amps, T _C = 25°C)	v _F	0.895 0.975	1.00 1.30	1.20 1.50	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, T _J = 150°C) (Rated dc Voltage, T _J = 25°C)	i _R	250 5.0	500 10		μA
Maximum Reverse Recovery Time (I _F = 1.0 Amp, di/dt = 50 Amps/μs) (I _F = 0.5 Amp, i _R = 1.0 Amp, I _{REC} = 0.25 Amp)	t _{rr}	35 25	60 50		ns

(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

Preferred devices are Motorola recommended choices for future use and best overall value.

MUR820

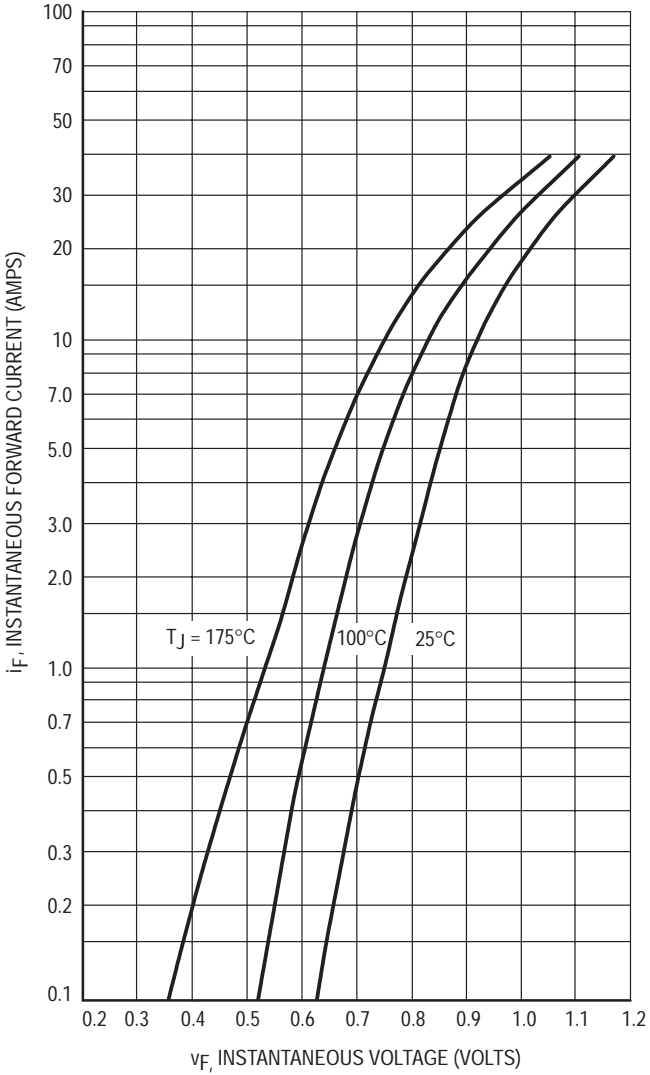


Figure 1. Typical Forward Voltage

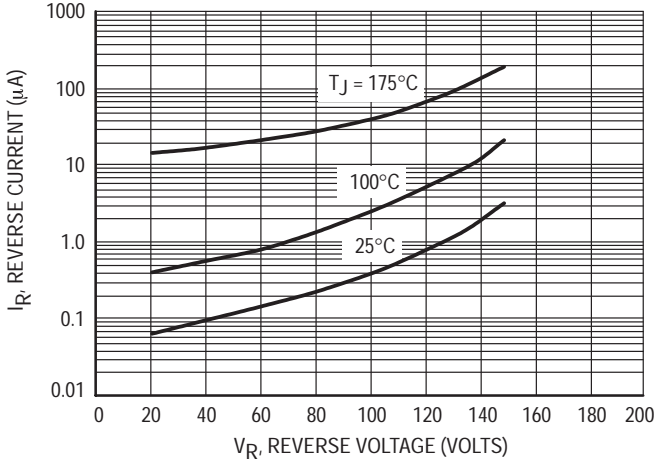


Figure 2. Typical Reverse Current*

* The curves shown are typical for the highest voltage device in the grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V_R is sufficiently below rated V_R .

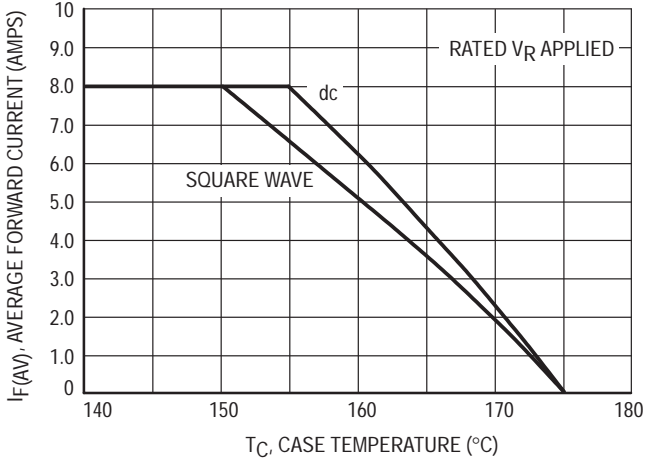


Figure 3. Current Derating, Case

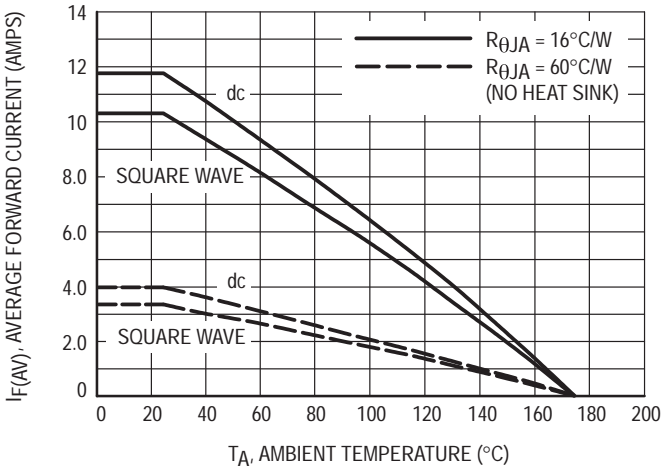


Figure 4. Current Derating, Ambient

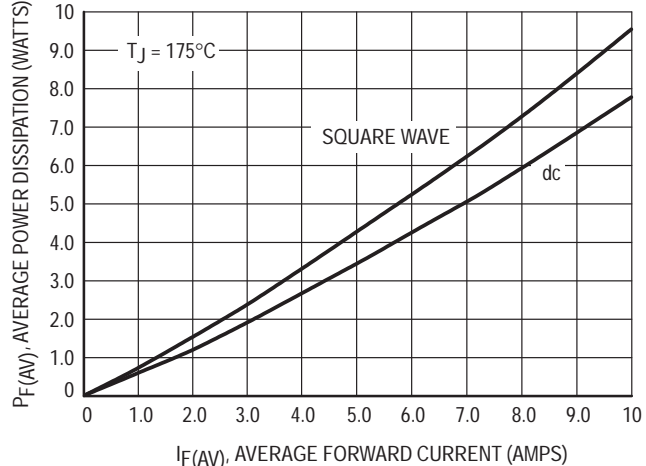


Figure 5. Power Dissipation

MUR840

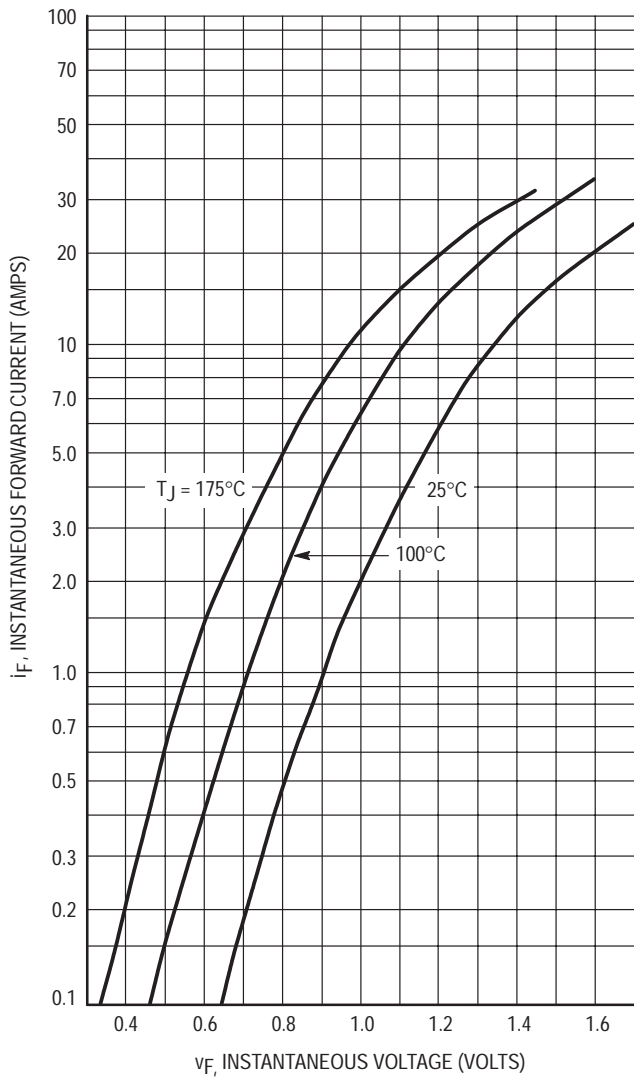


Figure 6. Typical Forward Voltage

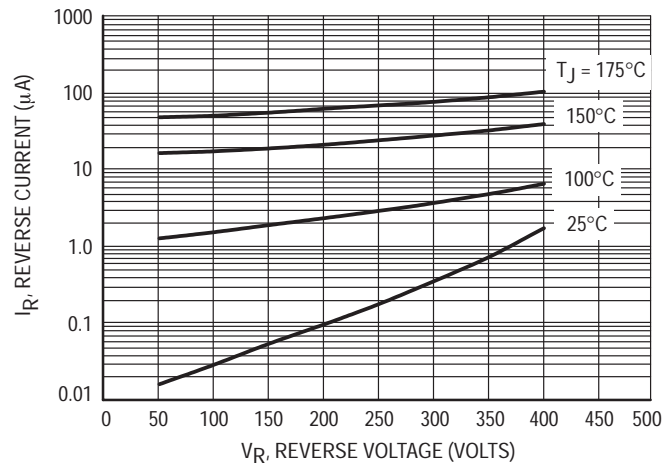


Figure 7. Typical Reverse Current*

* The curves shown are typical for the highest voltage device in the grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V_R is sufficiently below rated V_R .

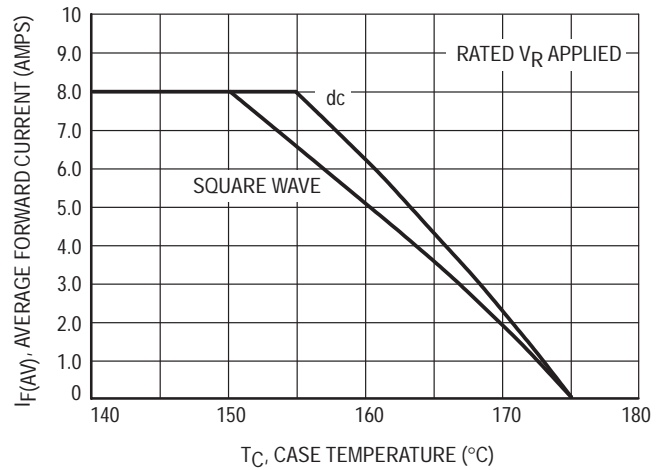


Figure 8. Current Derating, Case

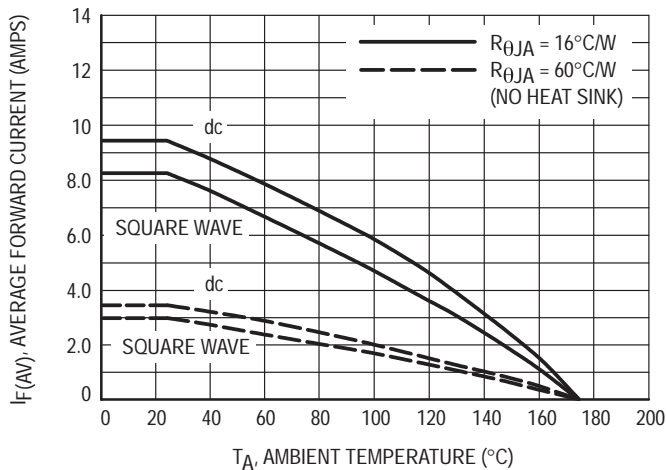


Figure 9. Current Derating, Ambient

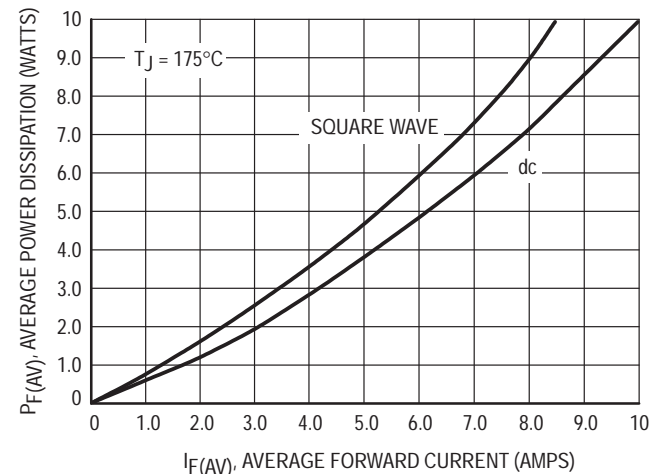


Figure 10. Power Dissipation

MUR860

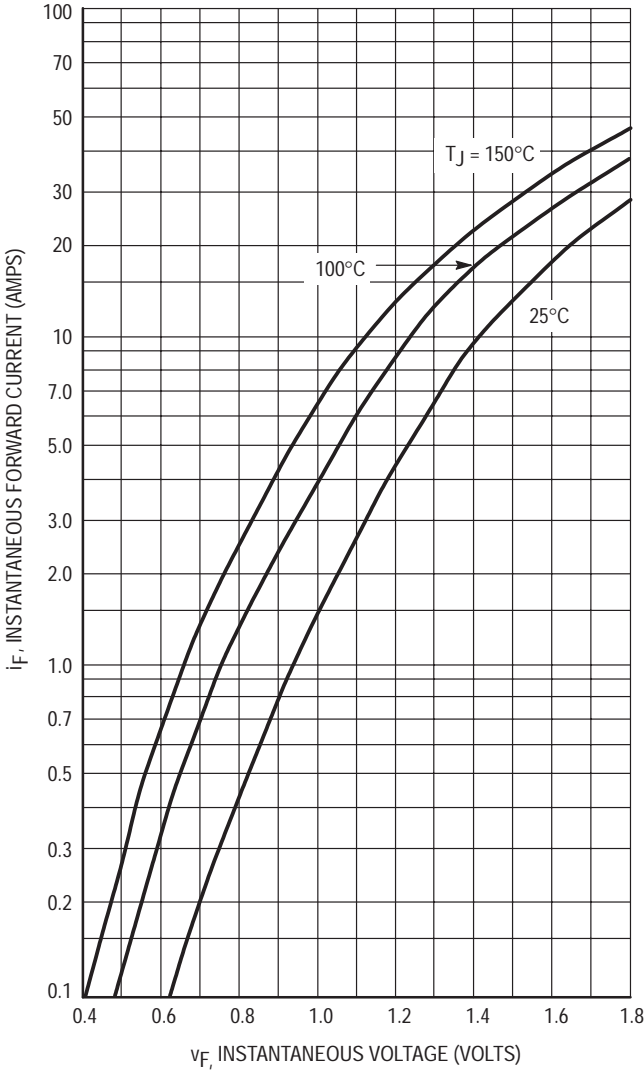


Figure 11. Typical Forward Voltage

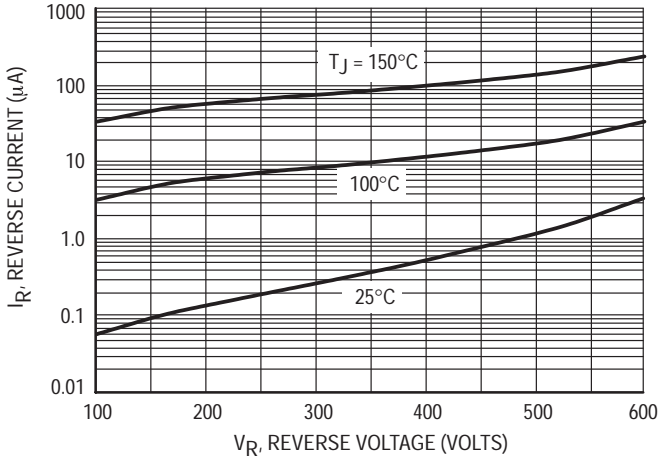


Figure 12. Typical Reverse Current*

* The curves shown are typical for the highest voltage device in the grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V_R is sufficiently below rated V_R .

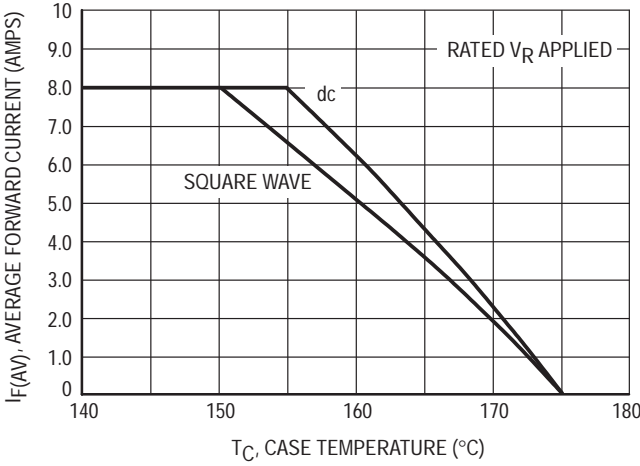


Figure 13. Current Derating, Case

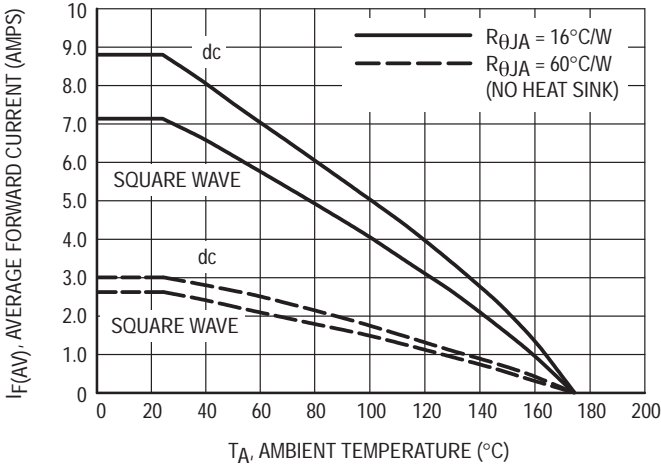


Figure 14. Current Derating, Ambient

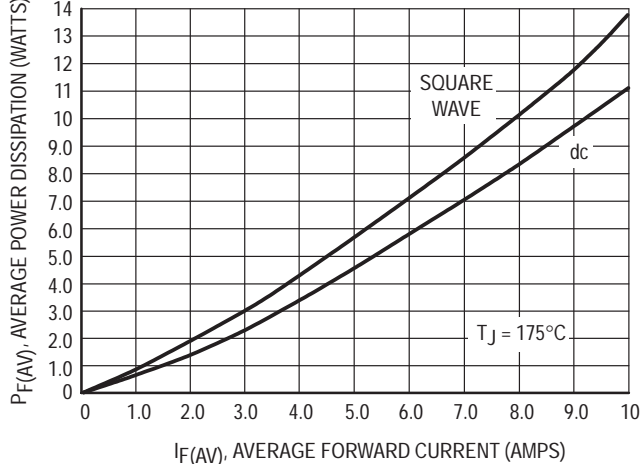


Figure 15. Power Dissipation

MUR820, MUR840, MUR860

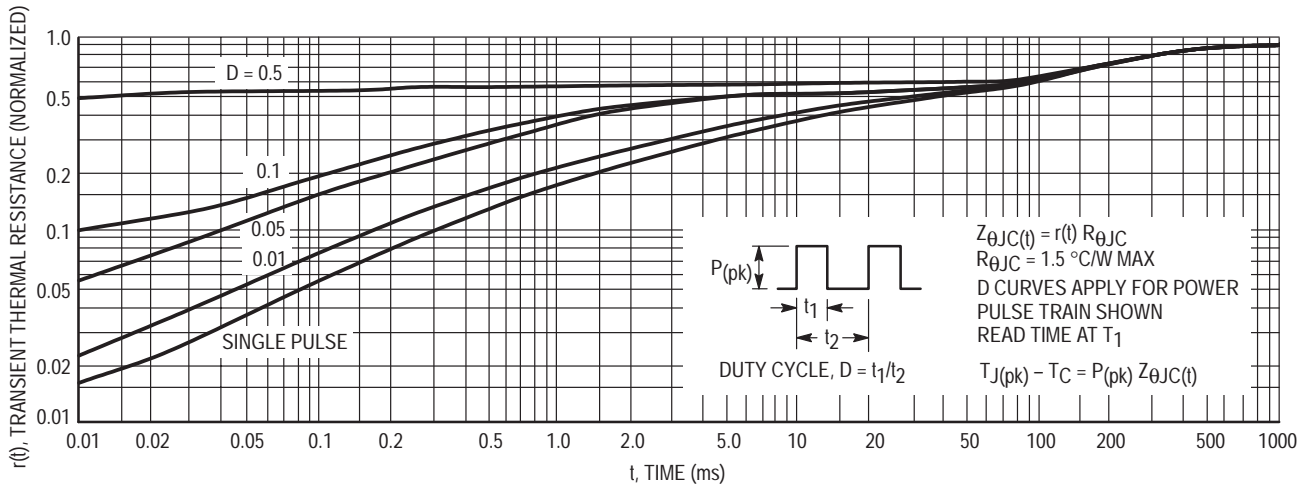


Figure 16. Thermal Response

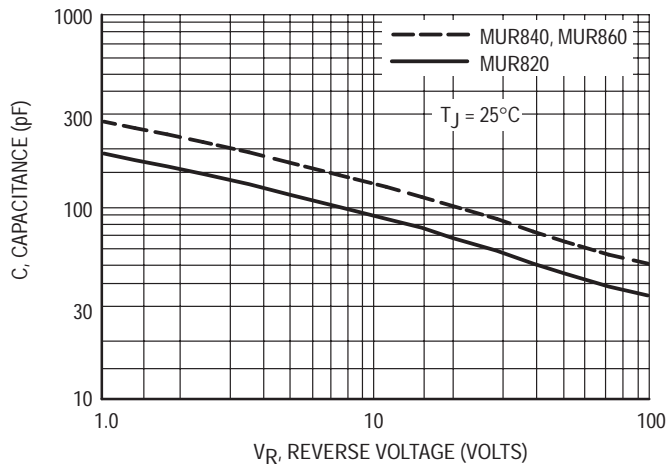


Figure 17. Typical Capacitance

SWITCHMODE™ Power Rectifiers

Ultrafast “E” Series with High Reverse Energy Capability

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- 20 mJoules Avalanche Energy Guaranteed
- Excellent Protection Against Voltage Transients in Switching Inductive Load Circuits
- Ultrafast 75 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Popular TO-220 Package
- Epoxy Meets UL94, V₀ @ 1/8"
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- Reverse Voltage to 1000 Volts

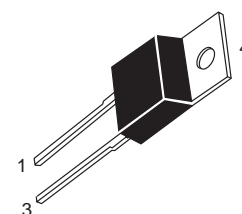
Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U890E, U8100E

MUR890E
MUR8100E

MUR8100E is a
Motorola Preferred Device

**ULTRAFAST
RECTIFIERS**
8.0 AMPERES
900-1000 VOLTS



CASE 221B-03
TO-220AC

MAXIMUM RATINGS

Rating	Symbol	MUR		Unit
		890E	8100E	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	900	1000	Volts
Average Rectified Forward Current Total Device, (Rated V_R), $T_C = 150^\circ\text{C}$	$I_{F(AV)}$	8.0		Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz), $T_C = 150^\circ\text{C}$	I_{FM}	16		Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	100		Amps
Operating Junction Temperature and Storage Temperature	T_J, T_{stg}	-65 to +175		°C

THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	2.0	°C/W
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(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

Preferred devices are Motorola recommended choices for future use and best overall value.

MUR890E MUR8100E**ELECTRICAL CHARACTERISTICS**

Rating	Symbol	MUR		Unit
		890E	8100E	
Maximum Instantaneous Forward Voltage (1) ($i_F = 8.0$ Amps, $T_C = 150^\circ\text{C}$) ($i_F = 8.0$ Amps, $T_C = 25^\circ\text{C}$)	v_F	1.5 1.8		Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 100^\circ\text{C}$) (Rated dc Voltage, $T_C = 25^\circ\text{C}$)	i_R	500 25		μA
Maximum Reverse Recovery Time ($I_F = 1.0$ Amp, $di/dt = 50$ Amps/ μs) ($I_F = 0.5$ Amp, $i_R = 1.0$ Amp, $I_{REC} = 0.25$ Amp)	t_{rr}	100 75		ns
Controlled Avalanche Energy (See Test Circuit in Figure 6)	W_{AVAL}	20		mJ

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

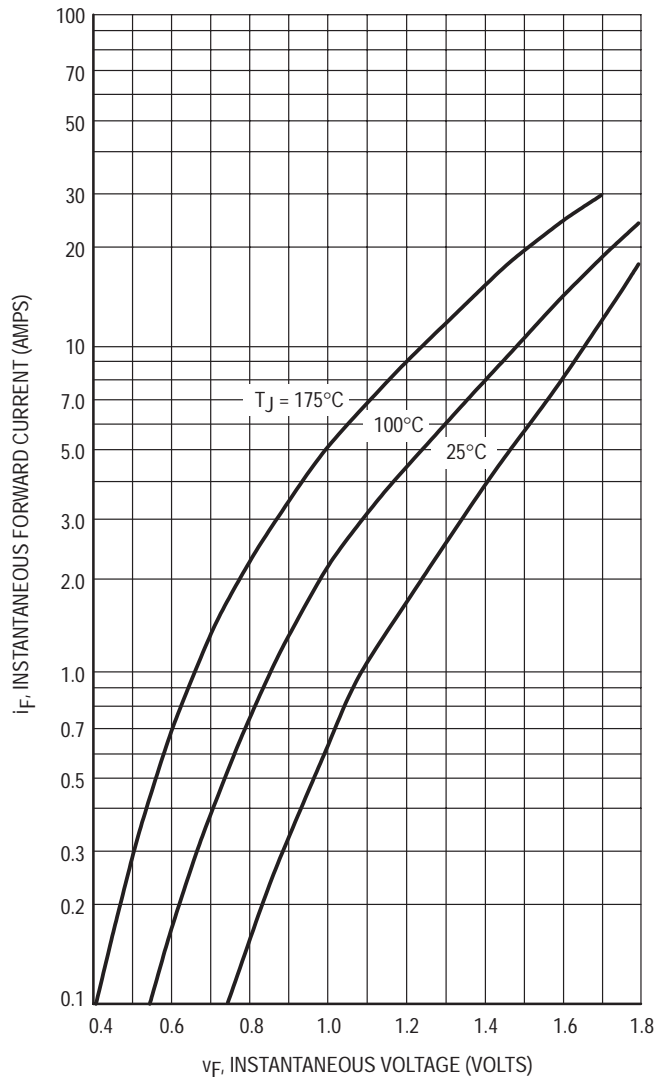


Figure 1. Typical Forward Voltage

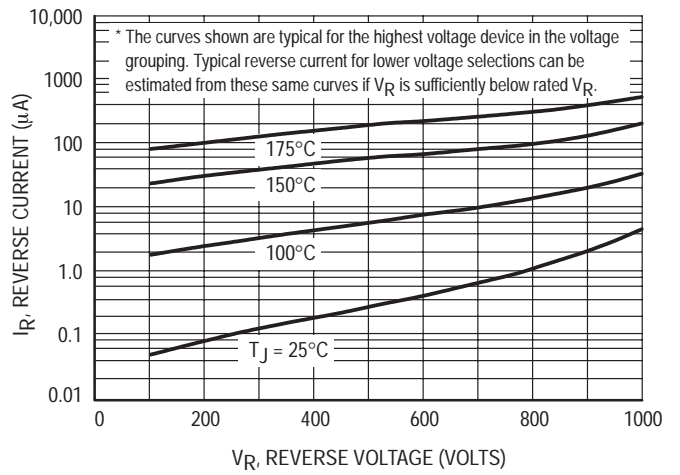


Figure 2. Typical Reverse Current*

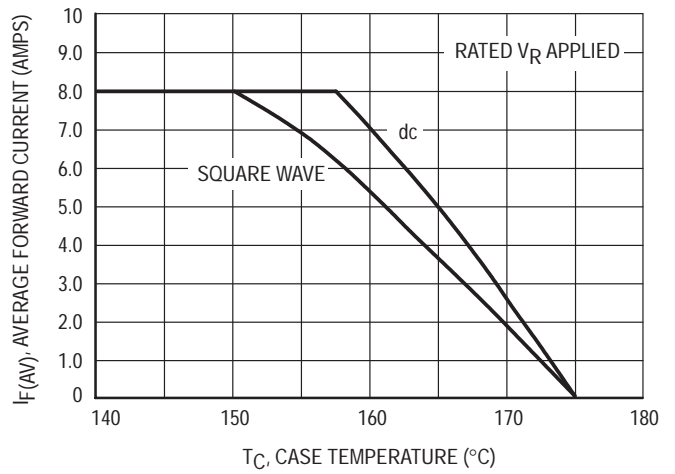


Figure 3. Current Derating, Case

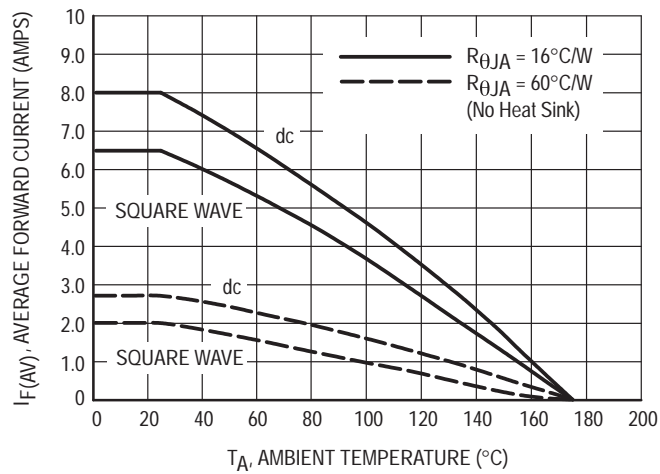


Figure 4. Current Derating, Ambient

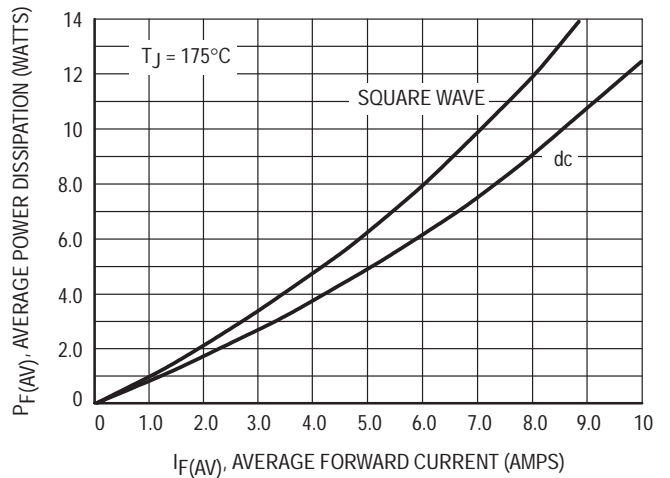


Figure 5. Power Dissipation

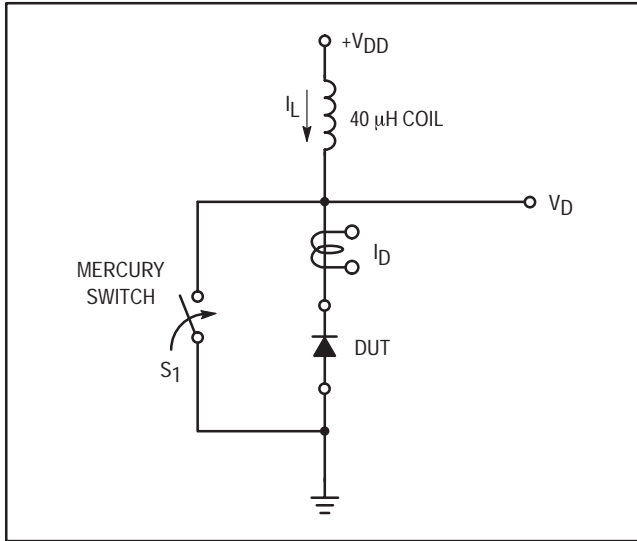


Figure 6. Test Circuit

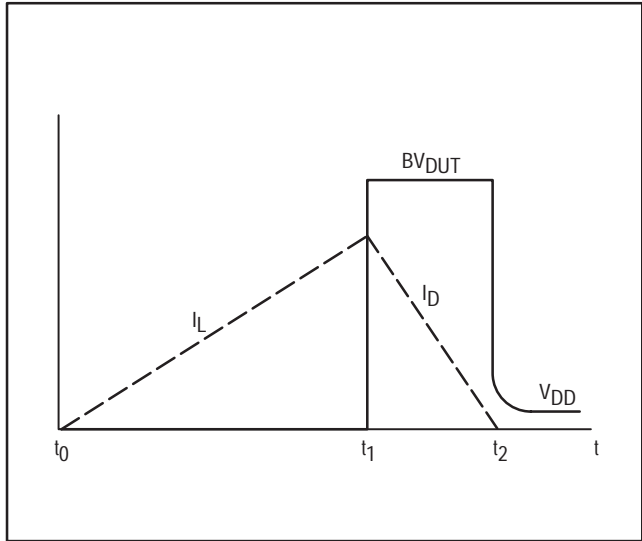


Figure 7. Current–Voltage Waveforms

The unclamped inductive switching circuit shown in Figure 6 was used to demonstrate the controlled avalanche capability of the new “E” series Ultrafast rectifiers. A mercury switch was used instead of an electronic switch to simulate a noisy environment when the switch was being opened.

When S₁ is closed at t₀ the current in the inductor I_L ramps up linearly; and energy is stored in the coil. At t₁ the switch is opened and the voltage across the diode under test begins to rise rapidly, due to di/dt effects, when this induced voltage reaches the breakdown voltage of the diode, it is clamped at BV_{DUT} and the diode begins to conduct the full load current which now starts to decay linearly through the diode, and goes to zero at t₂.

By solving the loop equation at the point in time when S₁ is opened; and calculating the energy that is transferred to the diode it can be shown that the total energy transferred is equal to the energy stored in the inductor plus a finite amount of energy from the V_{DD} power supply while the diode is in

breakdown (from t₁ to t₂) minus any losses due to finite component resistances. Assuming the component resistive elements are small Equation (1) approximates the total energy transferred to the diode. It can be seen from this equation that if the V_{DD} voltage is low compared to the breakdown voltage of the device, the amount of energy contributed by the supply during breakdown is small and the total energy can be assumed to be nearly equal to the energy stored in the coil during the time when S₁ was closed, Equation (2).

The oscilloscope picture in Figure 8, shows the MUR8100E in this test circuit conducting a peak current of one ampere at a breakdown voltage of 1300 volts, and using Equation (2) the energy absorbed by the MUR8100E is approximately 20 mjoules.

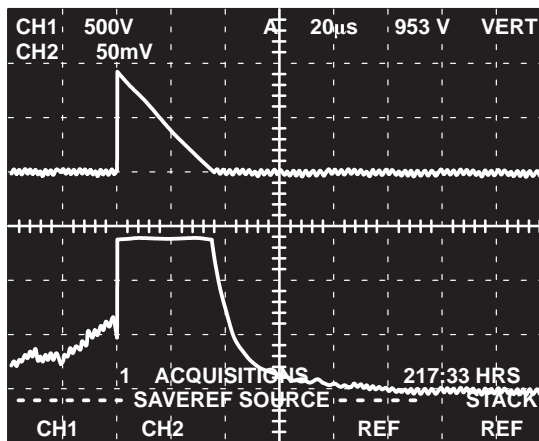
Although it is not recommended to design for this condition, the new “E” series provides added protection against those unforeseen transient viruses that can produce unexplained random failures in unfriendly environments.

EQUATION (1):

$$W_{\text{AVAL}} \approx \frac{1}{2} L I_{\text{LPK}}^2 \left(\frac{BV_{\text{DUT}}}{BV_{\text{DUT}} - V_{\text{DD}}} \right)$$

EQUATION (2):

$$W_{\text{AVAL}} \approx \frac{1}{2} L I_{\text{LPK}}^2$$



CHANNEL 2:

I_L
0.5 AMPS/DIV.

CHANNEL 1:

V_{DUT}
500 VOLTS/DIV.

TIME BASE:
20 μs/DIV.

Figure 8. Current–Voltage Waveforms

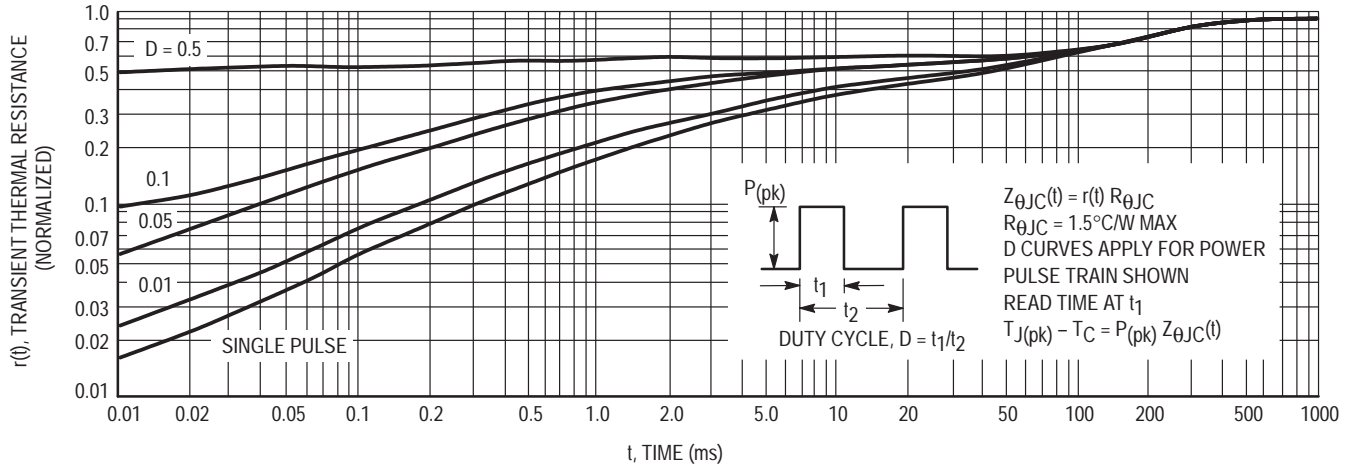


Figure 9. Thermal Response

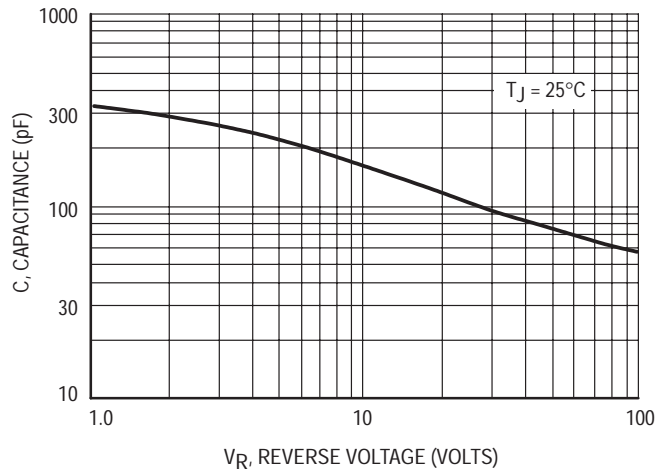


Figure 10. Typical Capacitance

SCANSWITCH™ Power Rectifier

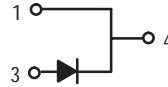
For High and Very High Resolution Monitors

This state-of-the-art power rectifier is specifically designed for use as a damper diode in horizontal deflection circuits for high and very high resolution monitors. In these applications, the outstanding performance of the MUR10120E is fully realized when paired with either the MJH16206 or MJF16206 monitor specific, 1200 volt bipolar power transistor.

- 1200 Volt Blocking Voltage
- 20 mJ Avalanche Energy (Guaranteed)
- 12 Volt (Typical) Peak Transient Overshoot Voltage
- 135 ns (Typical) Forward Recovery Time

Mechanical Characteristics:

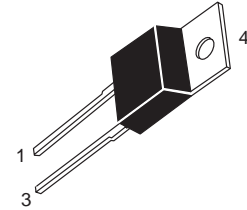
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U10120E



MUR10120E

Motorola Preferred Device

**SCANSWITCH
RECTIFIER
10 AMPERES
1200 VOLTS**



**CASE 221B-03
(TO-220AC)
STYLE 1**

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	1200	Volts
Average Rectified Forward Current (Rated V_R) $T_C = 125^\circ\text{C}$	$I_{F(AV)}$	10	Amps
Peak Repetitive Forward Current, Per Leg (Rated V_R , Square Wave, 20 kHz) $T_C = 125^\circ\text{C}$	I_{FRM}	20	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I_{FSM}	100	Amps
Operating Junction Temperature	T_J	-65 to +125	$^\circ\text{C}$
Controlled Avalanche Energy	W_{AVAL}	20	mJ

THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Case	$R_{\theta JC}$	2.0	$^\circ\text{C/W}$
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(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

Preferred devices are Motorola recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Typ	Max	Unit
Maximum Instantaneous Forward Voltage (1) ($i_F = 6.5$ Amps, $T_J = 125^\circ\text{C}$) ($i_F = 6.5$ Amps, $T_J = 25^\circ\text{C}$)	v_F	1.7 1.9	2.0 2.2	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 25^\circ\text{C}$) (Rated dc Voltage, $T_J = 125^\circ\text{C}$)	i_R	25 750	100 1000	μA
Maximum Reverse Recovery Time ($I_F = 1.0$ A, $di/dt = 50$ Amps/ μs)	t_{rr}	150	175	ns
Maximum Forward Recovery Time $I_F = 6.5$ Amps, $di/dt = 12$ Amps/ μs (As Measured on a Deflection Circuit)	t_{fr}	135	175	ns
Peak Transient Overshoot Voltage	V_{RFM}	12	14	Volts

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

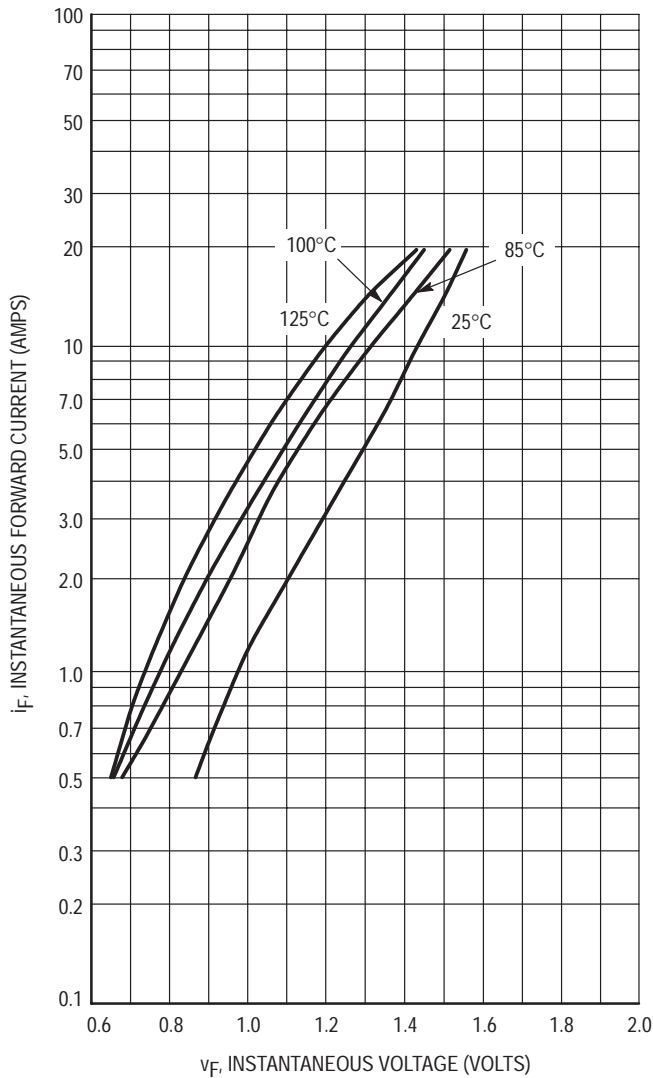


Figure 1. Typical Forward Voltage

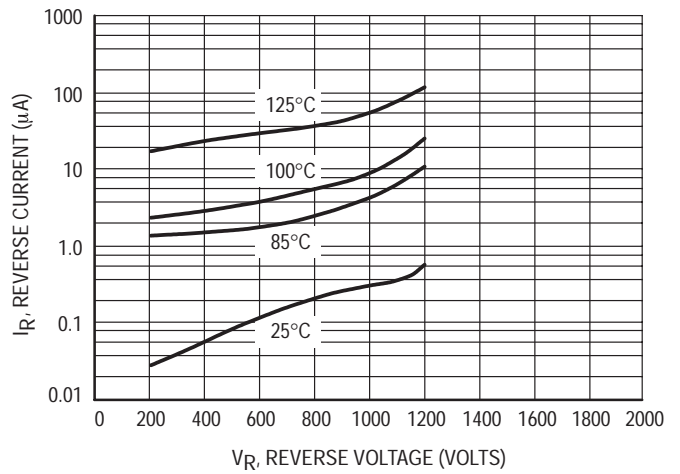


Figure 2. Typical Reverse Current

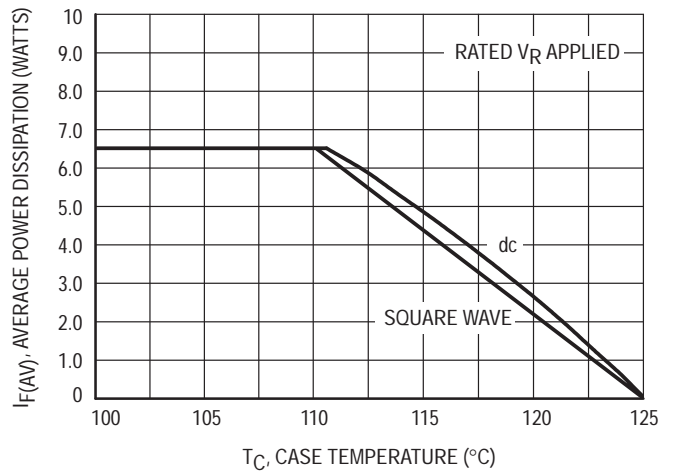


Figure 3. Current Derating, Case

MUR10120E

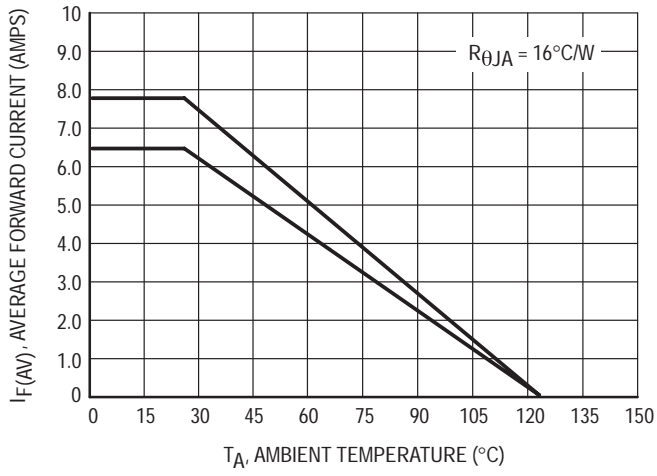


Figure 4. Current Derating, Ambient

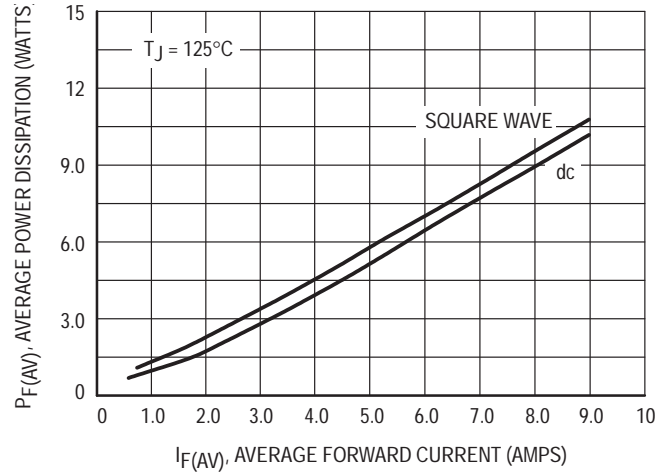


Figure 5. Power Dissipation

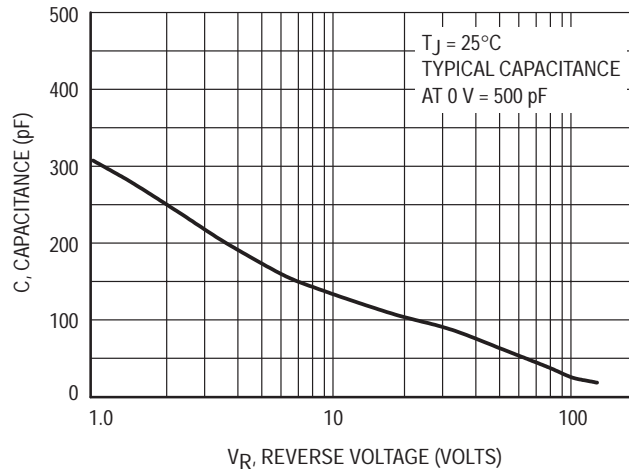


Figure 6. Typical Capacitance

Designer's™ Data Sheet
SCANSWITCH™ Power Rectifier
For Use As A Damper Diode
In High and Very High Resolution Monitors

MUR10150E

Motorola Preferred Device

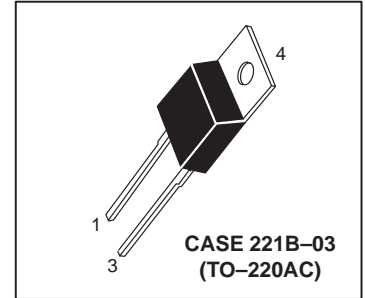
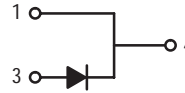
**SCANSWITCH
RECTIFIER
10 AMPERES
1500 VOLTS**

The MUR10150E is a state-of-the-art Power Rectifier specifically designed for use as a damper diode in horizontal deflection circuits for high and very high resolution monitors. In these applications, the outstanding performance of the MUR10150E is fully realized when paired with either the MJW16212 or MJF16212 monitor specific, 1500 V bipolar power transistor.

- 1500 V Blocking Voltage
- 20 mJ Avalanche Energy Guaranteed
- Peak Transient Overshoot Voltage Specified, 14 Volts (typical)
- Forward Recovery Time Specified, 135 ns (typical)
- Epoxy Meets UL94, V₀ at 1/8"

Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U10150E



MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	1500	Volts
Average Rectified Forward Current, (Rated V _R), T _C = 125°C	I _{F(AV)}	10	Amps
Peak Repetitive Forward Current, Per Leg (Rated V _R , Square Wave, 20 kHz), T _C = 125°C	I _{FRM}	20	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I _{FSM}	100	Amps
Operating Junction and Storage Temperature	T _J , T _{stg}	-65 to +125	°C
Controlled Avalanche Energy	W _{AVAIL}	20	mJ

THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Case	R _{θJC}	2.0	°C/W
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ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Typ	Max	Unit
Maximum Instantaneous Forward Voltage (1) (i _F = 6.5 Amps, T _J = 125°C) (i _F = 6.5 Amps, T _J = 25°C)	v _F	1.7 1.9	2.2 2.4	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, T _J = 125°C) (Rated dc Voltage, T _J = 25°C)	i _R	750 25	1000 100	μA
Maximum Reverse Recovery Time (I _F = 1.0 Amp, di/dt = 50 Amps/μs)	t _{rr}	150	175	ns
Maximum Forward Recovery Time (I _F = 6.5 Amps, di/dt = 12 Amps/μs)	t _{fr}	135	175	ns
Peak Transient Overshoot Voltage	V _{RFM}	14	16	Volts

(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

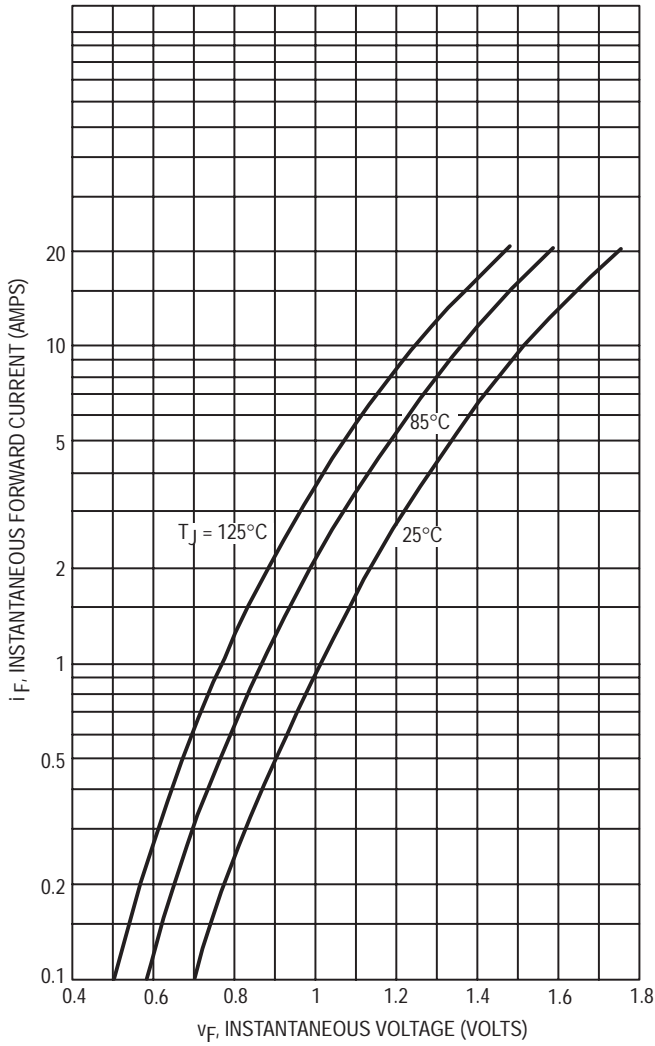


Figure 1. Typical Forward Voltage

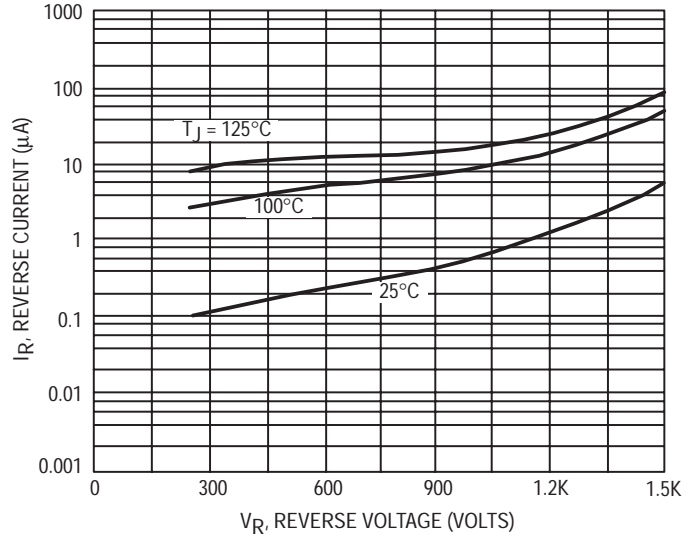


Figure 2. Typical Reverse Current

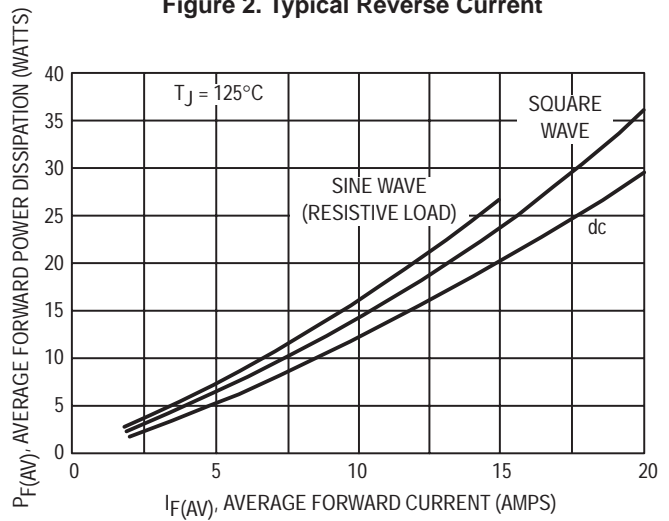


Figure 3. Forward Power Dissipation

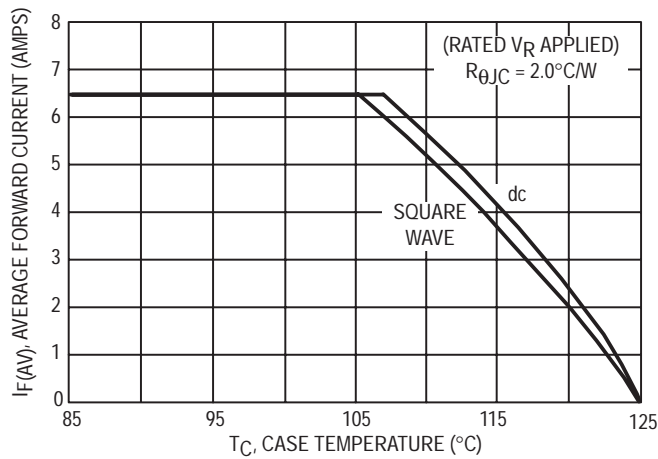


Figure 4. Current Derating Case

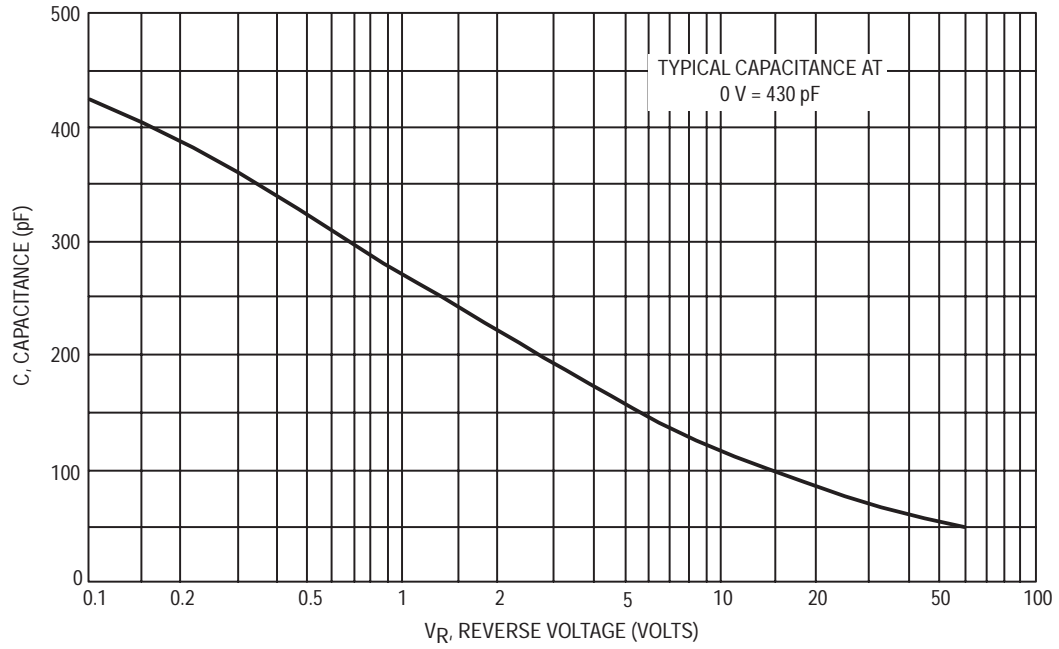


Figure 5. Typical Capacitance

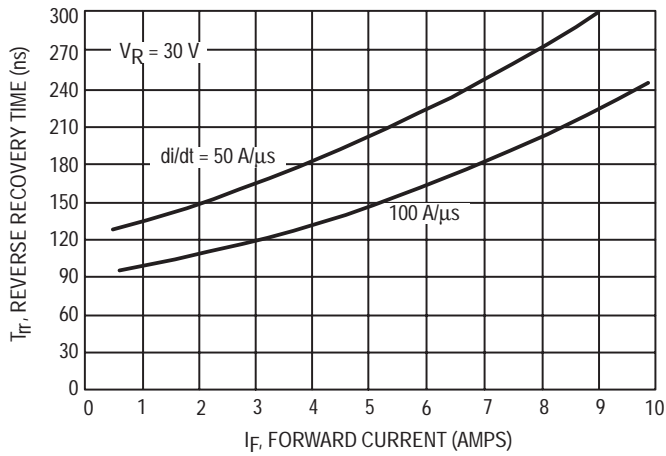


Figure 6. Typical Reverse Recovery Time

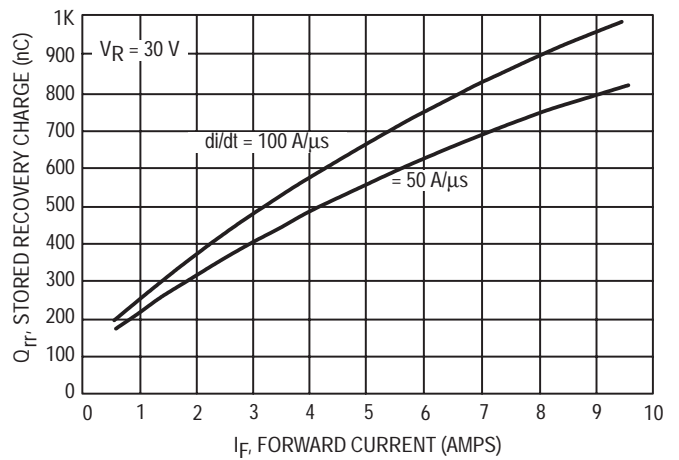


Figure 7. Typical Stored Recovery Charge

SWITCHMODE™ Power Rectifiers

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 and 60 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Popular TO-220 Package
- High Voltage Capability to 600 Volts
- Low Forward Drop
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating Specified @ Both Case and Ambient Temperatures

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U1520, U1540, U1560

MUR1520
MUR1540
MUR1560

Motorola Preferred Devices

**ULTRAFAST
RECTIFIERS**
15 AMPERES
200-400-600 VOLTS

CASE 221B-03
TO-220AC
PLASTIC

MAXIMUM RATINGS

Rating	Symbol	MUR			Unit
		1520	1540	1560	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	200	400	600	Volts
Average Rectified Forward Current (Rated V_R)	$I_{F(AV)}$	15 @ $T_C = 150^\circ C$		15 @ $T_C = 145^\circ C$	Amps
Peak Rectified Forward Current (Rated V_R , Square Wave, 20 kHz)	I_{FRM}	30 @ $T_C = 150^\circ C$		30 @ $T_C = 145^\circ C$	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	200	150		Amps
Operating Junction Temperature and Storage Temperature	T_J, T_{stg}	-65 to +175			°C

THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.5	°C/W
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ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ($I_F = 15$ Amps, $T_C = 150^\circ C$) ($I_F = 15$ Amps, $T_C = 25^\circ C$)	V_F	0.85 1.05	1.12 1.25	1.20 1.50	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 150^\circ C$) (Rated dc Voltage, $T_C = 25^\circ C$)	i_R	500 10	500 10	1000 10	μA
Maximum Reverse Recovery Time ($I_F = 1.0$ Amp, $di/dt = 50$ Amps/μs)	t_{rr}	35	60		ns

(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

Preferred devices are Motorola recommended choices for future use and best overall value.

MUR1520

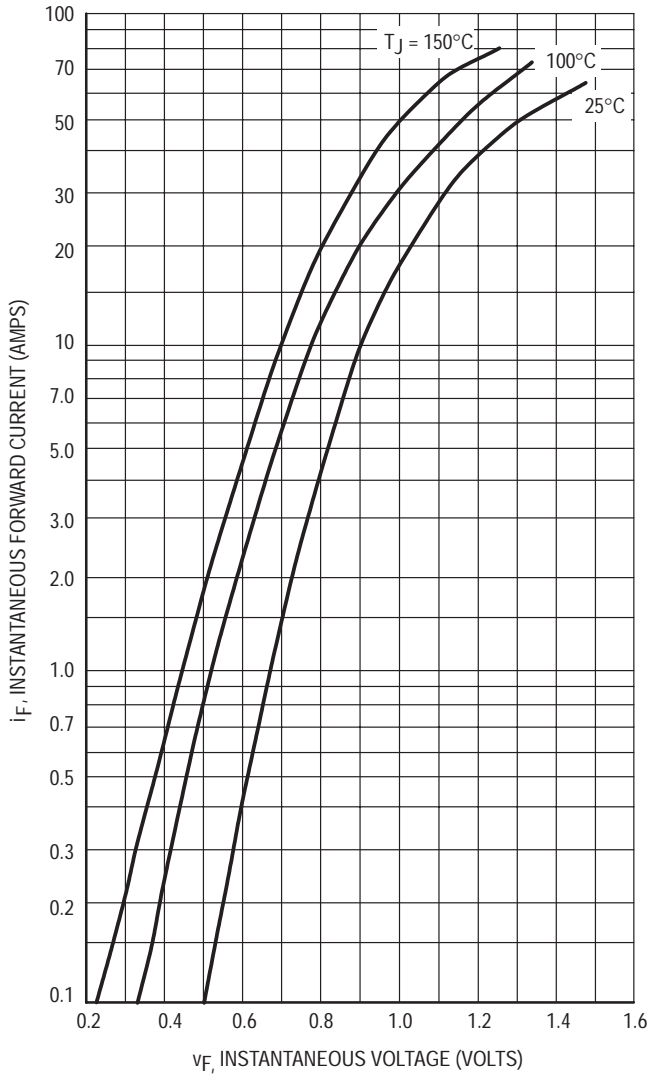


Figure 1. Typical Forward Voltage

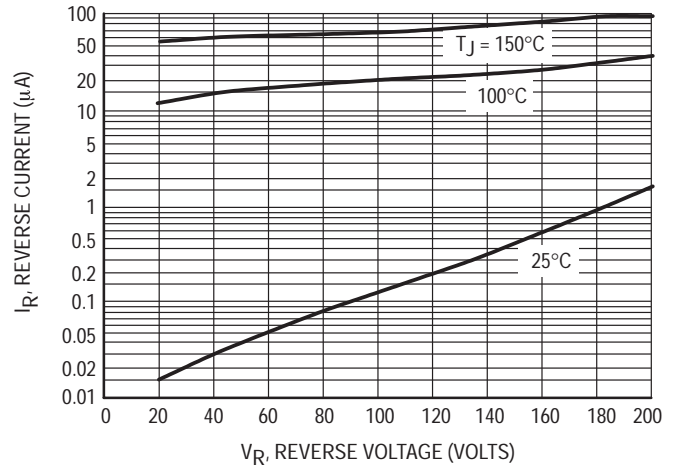


Figure 2. Typical Reverse Current

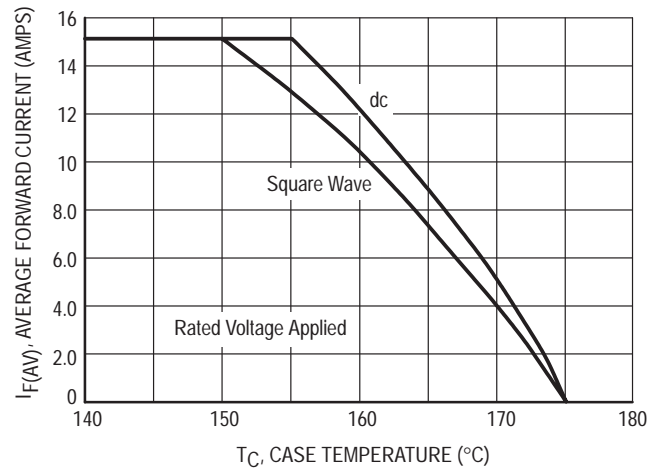


Figure 3. Current Derating, Case

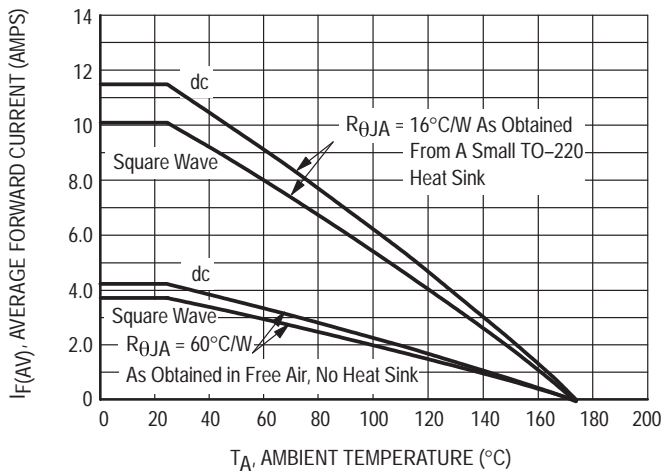


Figure 4. Current Derating, Ambient

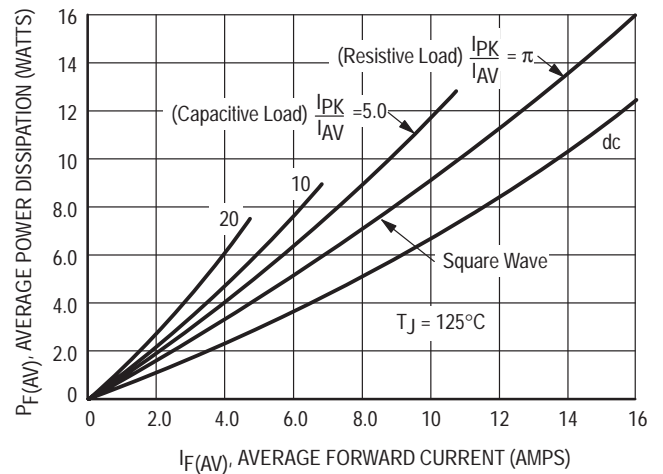


Figure 5. Power Dissipation

MUR1540

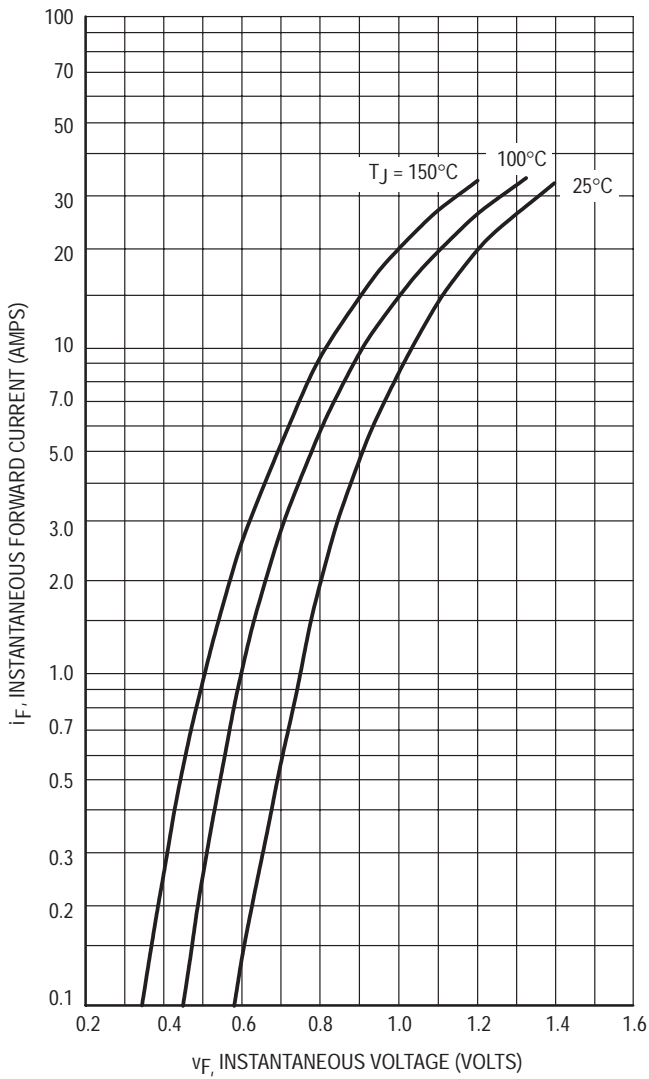


Figure 6. Typical Forward Voltage

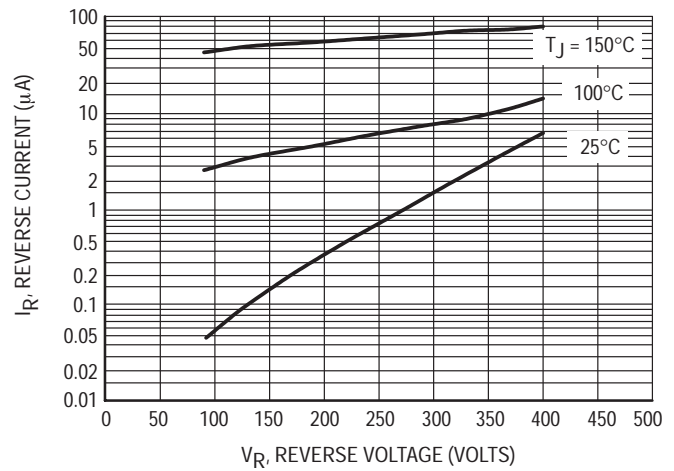


Figure 7. Typical Reverse Current

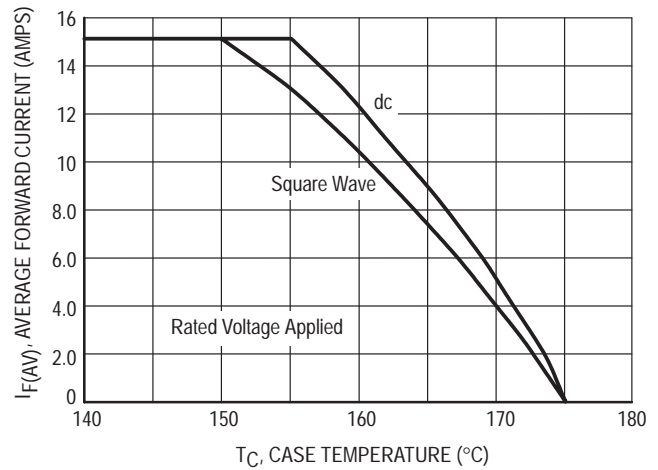


Figure 8. Current Derating, Case

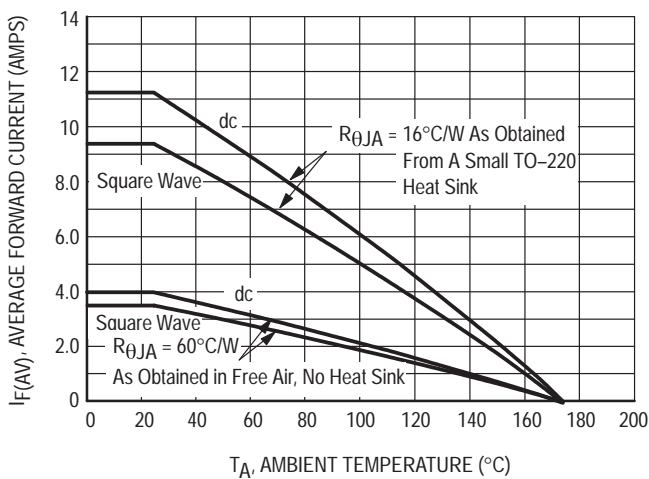


Figure 9. Current Derating, Ambient

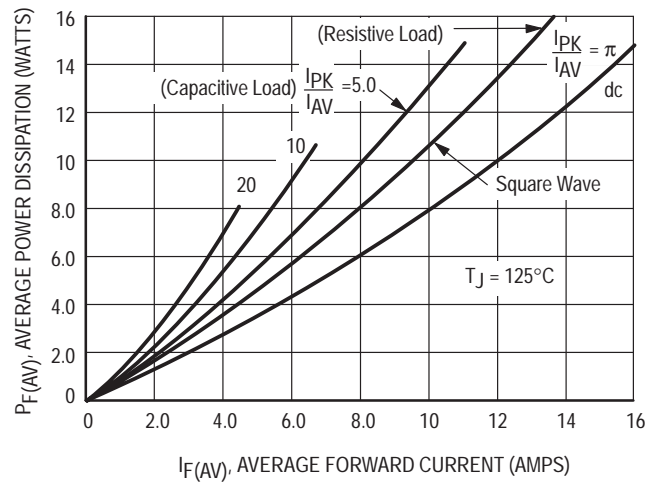


Figure 10. Power Dissipation

MUR1560

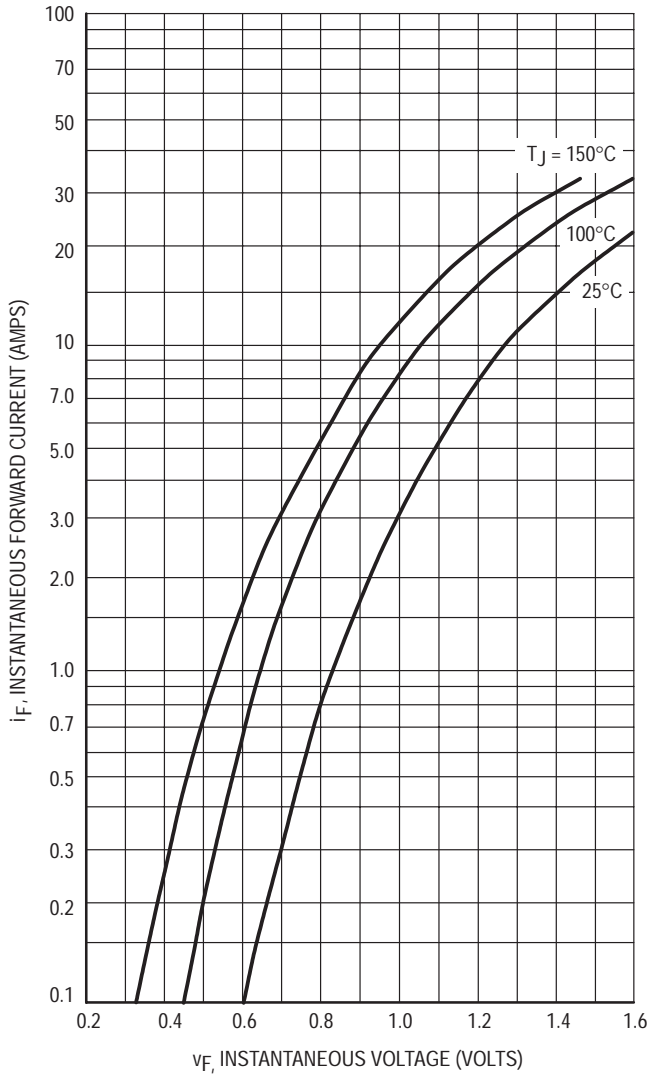


Figure 11. Typical Forward Voltage

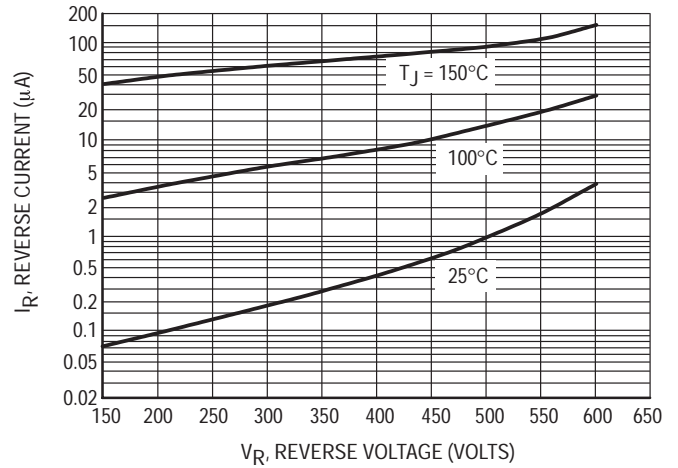


Figure 12. Typical Reverse Current

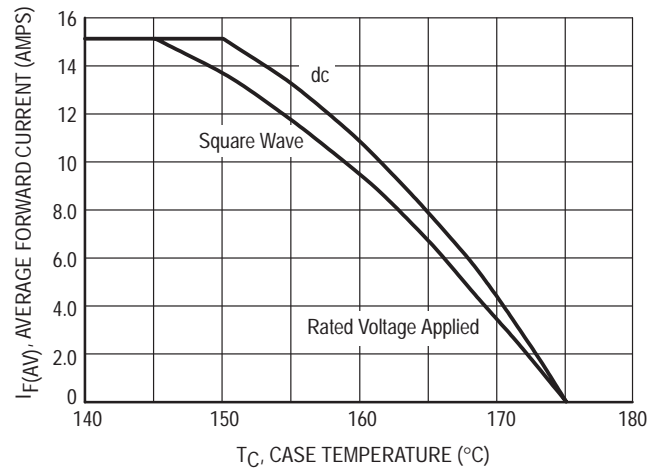


Figure 13. Current Derating, Case

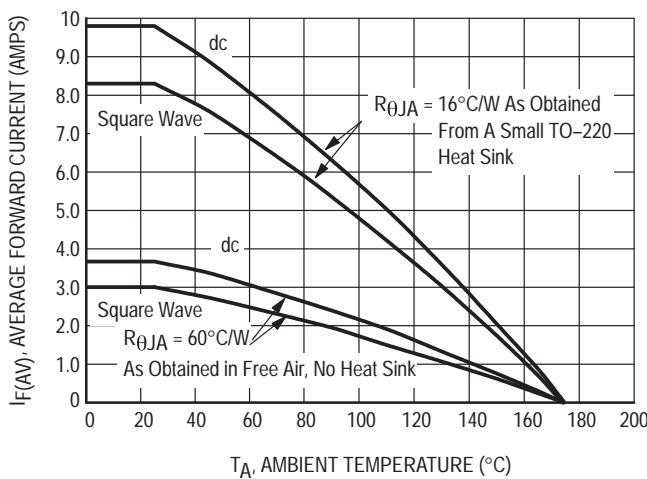


Figure 14. Current Derating, Ambient

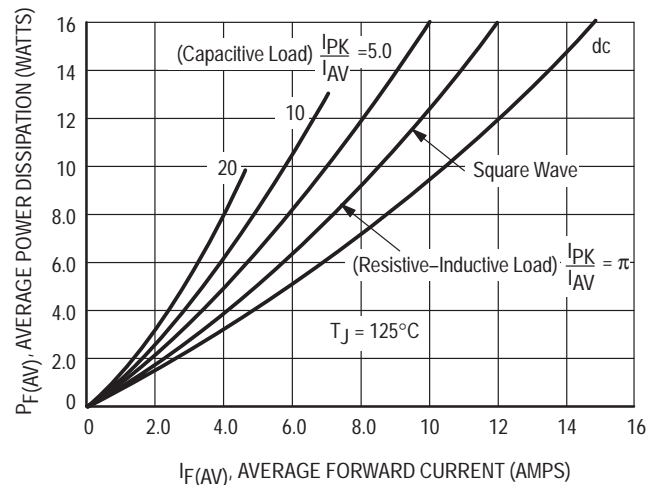


Figure 15. Power Dissipation

MUR1520, MUR1540, MUR1560

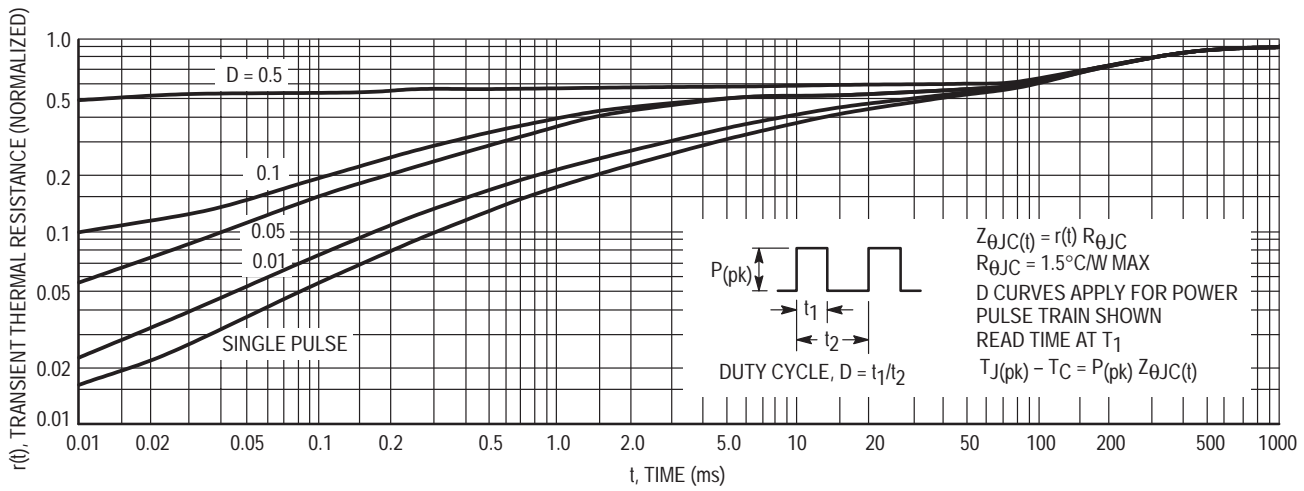


Figure 16. Thermal Response

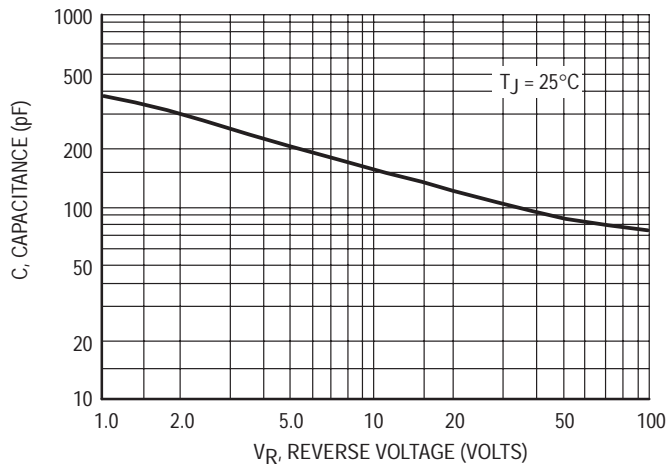


Figure 17. Typical Capacitance

Advance Information
SWITCHMODE™
Power Rectifier

MURF820

Motorola Preferred Device

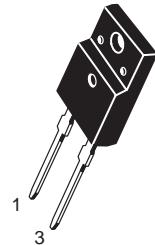
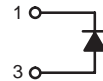
Designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 ns Recovery Times
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, V_O @ 1/8"
- High Temperature Glass Passivated Junction
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating @ Both Case and Ambient Temperatures
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369(1)

Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U820

ULTRAFAST RECTIFIER
8 AMPERES
200 VOLTS



CASE 221E-01
ISOLATED TO-220

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	200	Volts
Average Rectified Forward Current (Rated V_R), $T_C = 150^\circ\text{C}$	$I_{F(AV)}$	8	Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz), $T_C = 150^\circ\text{C}$	I_{FM}	16	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	100	Amps
Operating Junction and Storage Temperature	T_J, T_{stg}	- 65 to +150	°C
RMS Isolation Voltage ($t = 1$ second, R.H. $\leq 30\%$, $T_A = 25^\circ\text{C}$) (2)	Per Figure 3 V_{iso1}	4500	Volts
	Per Figure 4 (1) V_{iso2}	3500	
	Per Figure 5 V_{iso3}	1500	

THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	4.2	°C/W
Lead Temperature for Soldering Purposes: 1/8" from Case for 5 seconds	T_L	260	°C

- (1) UL Recognized mounting method is per Figure 4.
(2) Proper strike and creepage distance must be provided.

This document contains information on a new product. Specifications and information herein are subject to change without notice.

Preferred devices are Motorola recommended choices for future use and best overall value.

MURF820

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (3) ($i_F = 8.0$ Amp, $T_C = 150^\circ\text{C}$) ($i_F = 8.0$ Amp, $T_C = 25^\circ\text{C}$)	v_F	0.895 0.975	Volts
Maximum Instantaneous Reverse Current (3) (Rated dc Voltage, $T_C = 150^\circ\text{C}$) (Rated dc Voltage, $T_C = 25^\circ\text{C}$)	i_R	250 5.0	μA
Maximum Reverse Recovery Time ($I_F = 1.0$ Amp, $di/dt = 50$ Amp/ μs) ($I_F = 0.5$ Amp, $i_R = 1.0$ Amp, $I_{REC} = 0.25$ Amp)	t_{rr}	35 25	ns

(3) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

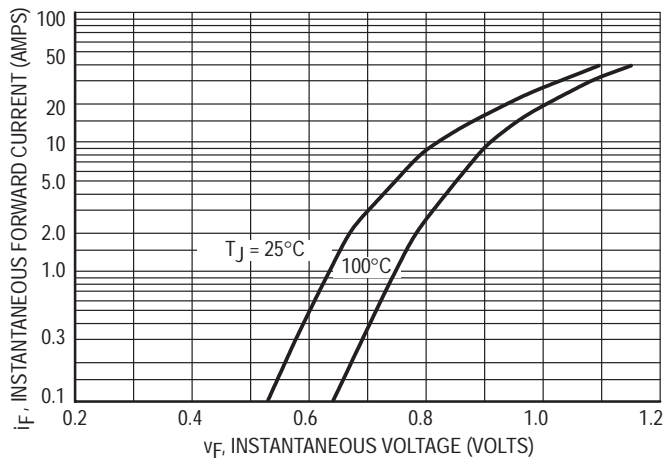


Figure 1. Typical Forward Voltage

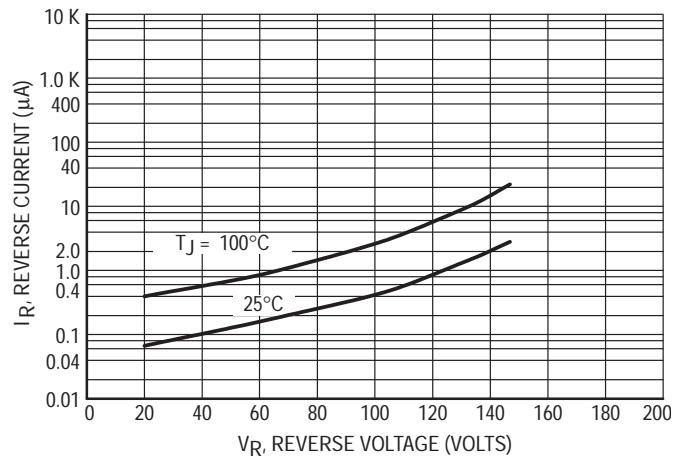
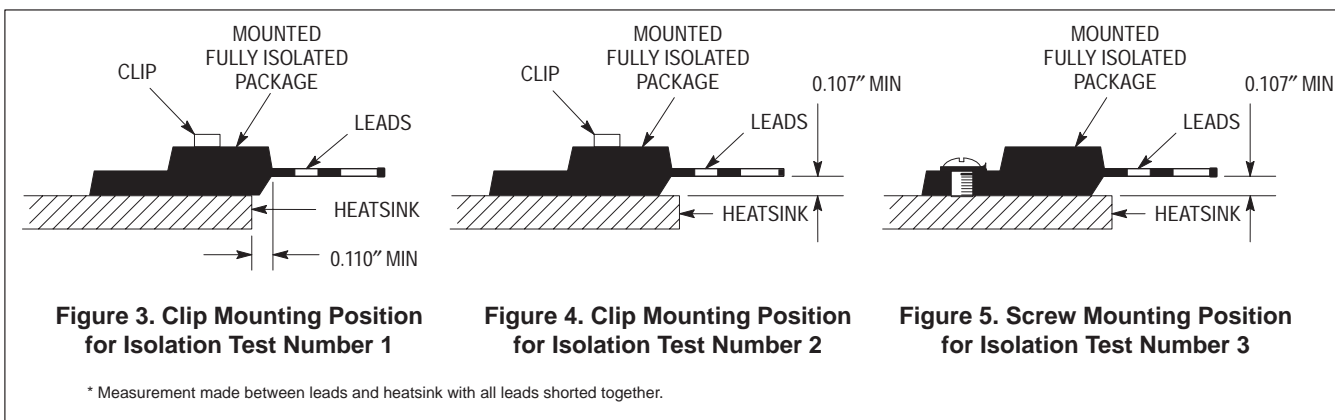
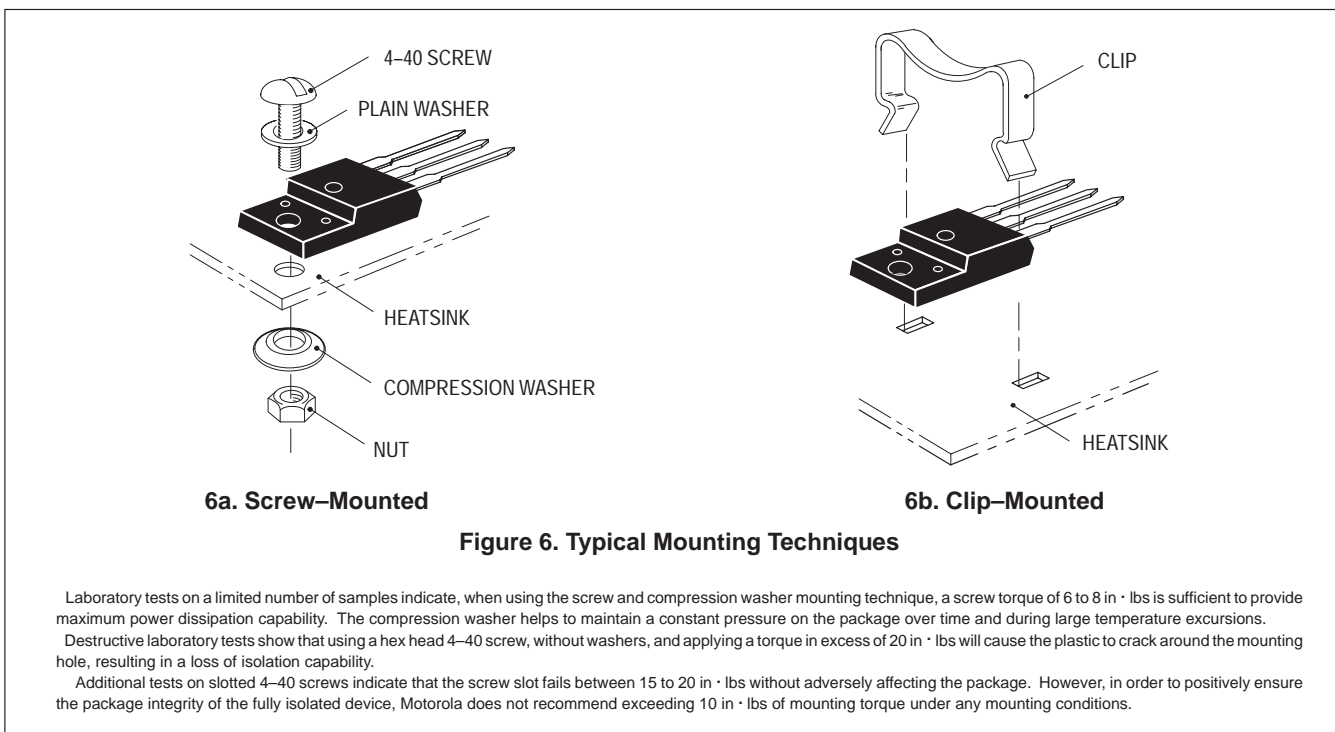


Figure 2. Typical Reverse Leakage Current*

TEST CONDITIONS FOR ISOLATION TESTS*



MOUNTING INFORMATION**



**For more information about mounting power semiconductors see Application Note AN1040.

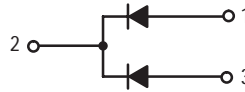
Advance Information
SWITCHMODE™
Power Rectifier

Designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 Nanosecond Recovery Times
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, V_O @ 1/8"
- High Temperature Glass Passivated Junction
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating @ Both Case and Ambient Temperatures
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369 (1)

Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U1620



MURF1620CT
Motorola Preferred Device

ULTRAFAST RECTIFIER
16 AMPERES
200 VOLTS

CASE 221D-02
ISOLATED TO-220

MAXIMUM RATINGS, PER LEG

Rating	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	200	Volts	
Average Rectified Forward Current Total Device, (Rated V_R), $T_C = 150^\circ\text{C}$	$I_{F(AV)}$	8 16	Amps	
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz), $T_C = 150^\circ\text{C}$	I_{FM}	16	Amps	
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	100	Amps	
Operating Junction and Storage Temperature	T_J, T_{stg}	- 65 to +150	°C	
RMS Isolation Voltage (t = 1 second, R.H. ≤ 30%, $T_A = 25^\circ\text{C}$) (2)	Per Figure 3 Per Figure 4 (1) Per Figure 5	V_{iso1} V_{iso2} V_{iso3}	4500 3500 1500	Volts

THERMAL CHARACTERISTICS, PER LEG

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	4.2	°C/W
Lead Temperature for Soldering Purposes: 1/8" from the Case for 5 seconds	T_L	260	°C

- (1) UL Recognized mounting method is per Figure 4.
(2) Proper strike and creepage distance must be provided.

This document contains information on a new product. Specifications and information herein are subject to change without notice.

Preferred devices are Motorola recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS, PER LEG

Characteristic	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (3) ($i_F = 8.0$ Amp, $T_C = 150^\circ\text{C}$) ($i_F = 8.0$ Amp, $T_C = 25^\circ\text{C}$)	v_F	0.895 0.975	Volts
Maximum Instantaneous Reverse Current (3) (Rated dc Voltage, $T_C = 150^\circ\text{C}$) (Rated dc Voltage, $T_C = 25^\circ\text{C}$)	i_R	250 5.0	μA
Maximum Reverse Recovery Time ($I_F = 1.0$ Amp, $di/dt = 50$ Amp/ μs) ($I_F = 0.5$ Amp, $i_R = 1.0$ Amp, $I_{REC} = 0.25$ Amp)	t_{rr}	35 25	ns

(3) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

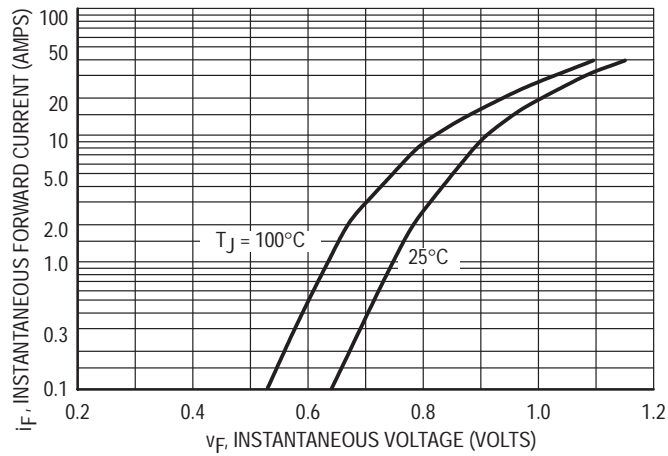


Figure 1. Typical Forward Voltage, Per Leg

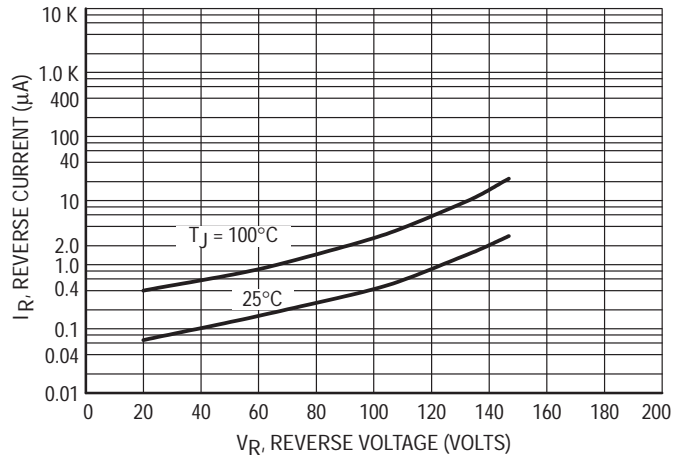
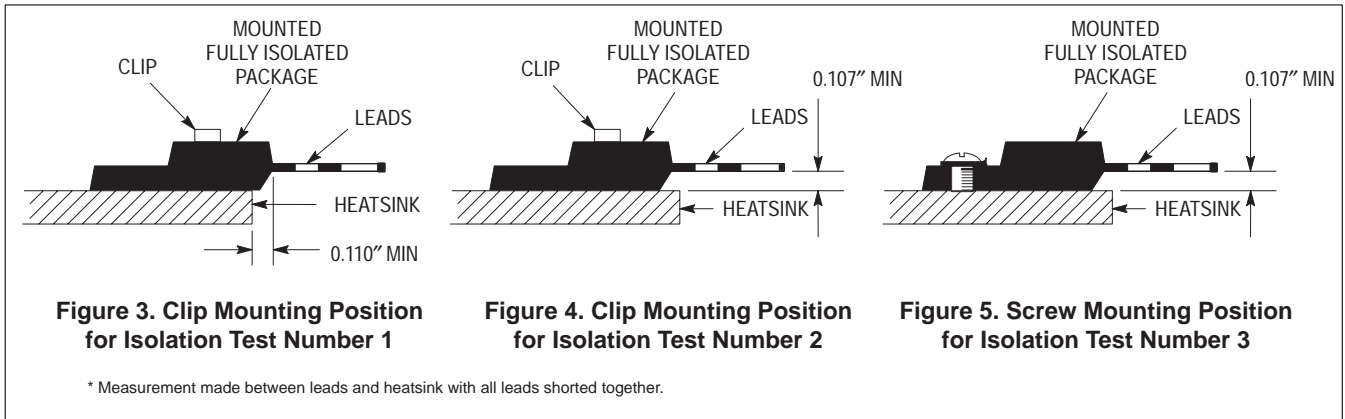
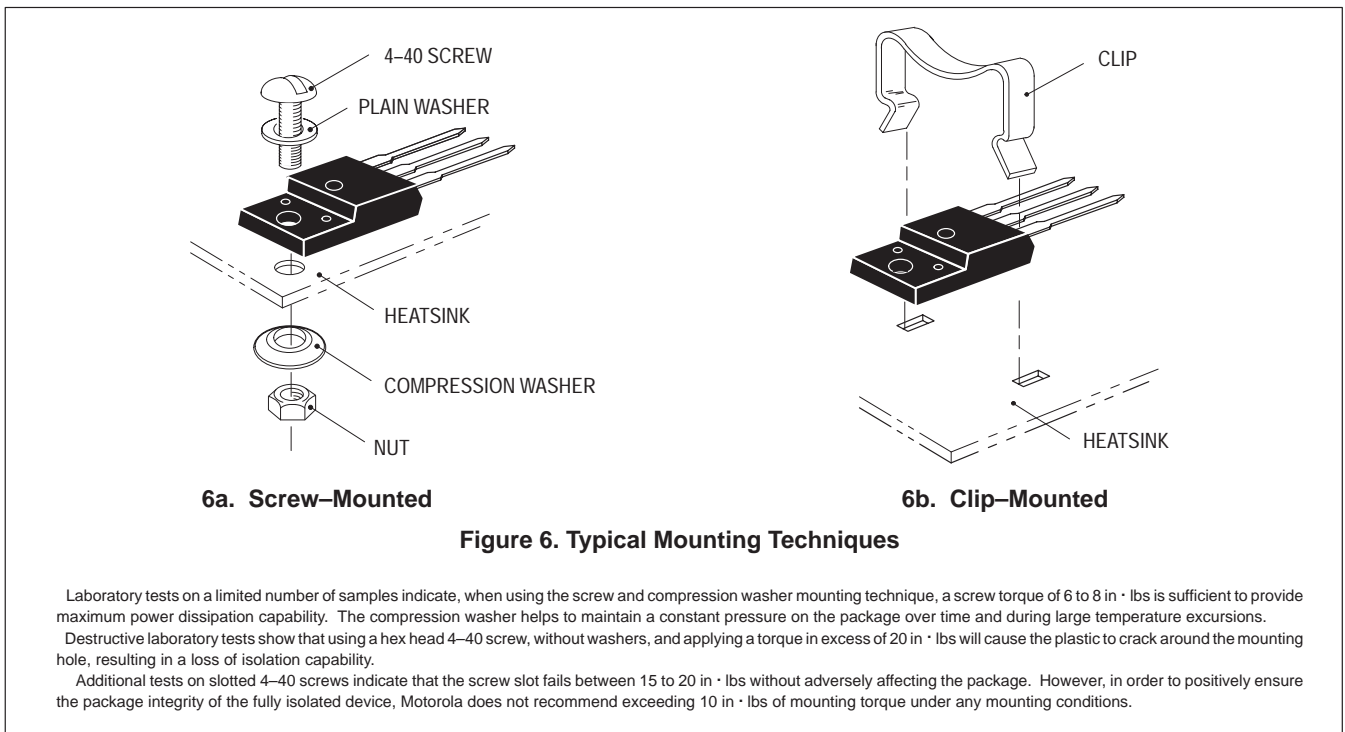


Figure 2. Typical Reverse Current, Per Leg*

TEST CONDITIONS FOR ISOLATION TESTS*



MOUNTING INFORMATION**



**For more information about mounting power semiconductors see Application Note AN1040.

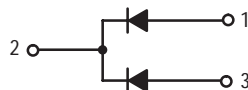
Advance Information
SWITCHMODE™
Power Rectifier

Designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 60 Nanosecond Recovery Times
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, V_O @ 1/8"
- High Temperature Glass Passivated Junction
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating @ Both Case and Ambient Temperatures
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369 (1)

Mechanical Characteristics

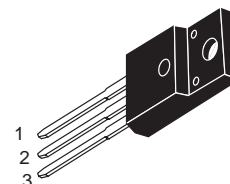
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U1660



MURF1660CT

Motorola Preferred Device

ULTRAFAST RECTIFIER
16 AMPERES
600 VOLTS



CASE 221D-02
ISOLATED TO-220

MAXIMUM RATINGS, PER LEG

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	600	Volts
Average Rectified Forward Current Total Device, (Rated V_R), $T_C = 150^\circ\text{C}$	$I_{F(AV)}$ Per Diode Per Device	8 16	Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz), $T_C = 150^\circ\text{C}$	I_{FM}	16	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	100	Amps
Operating Junction and Storage Temperature	T_J, T_{stg}	- 65 to +150	°C
RMS Isolation Voltage ($t = 1$ second, R.H. $\leq 30\%$, $T_A = 25^\circ\text{C}$) (2)	V_{iso1} V_{iso2} V_{iso3} Per Figure 3 Per Figure 4 (1) Per Figure 5	4500 3500 1500	Volts

THERMAL CHARACTERISTICS, PER LEG

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.0	°C/W
Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	T_L	260	°C

- (1) UL Recognized mounting method is per Figure 4.
(2) Proper strike and creepage distance must be provided.

This document contains information on a new product. Specifications and information herein are subject to change without notice.

Preferred devices are Motorola recommended choices for future use and best overall value.

MURF1660CT

ELECTRICAL CHARACTERISTICS, PER LEG

Characteristic	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (3) ($i_F = 8.0$ Amp, $T_C = 150^\circ\text{C}$) ($i_F = 8.0$ Amp, $T_C = 25^\circ\text{C}$)	v_F	1.20 1.50	Volts
Maximum Instantaneous Reverse Current (3) (Rated dc Voltage, $T_C = 150^\circ\text{C}$) (Rated dc Voltage, $T_C = 25^\circ\text{C}$)	i_R	500 10	μA
Maximum Reverse Recovery Time ($I_F = 1.0$ Amp, $di/dt = 50$ Amp/ μs) ($I_F = 0.5$ Amp, $i_R = 1.0$ Amp, $I_{REC} = 0.25$ Amp)	t_{rr}	60 50	ns

(3) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

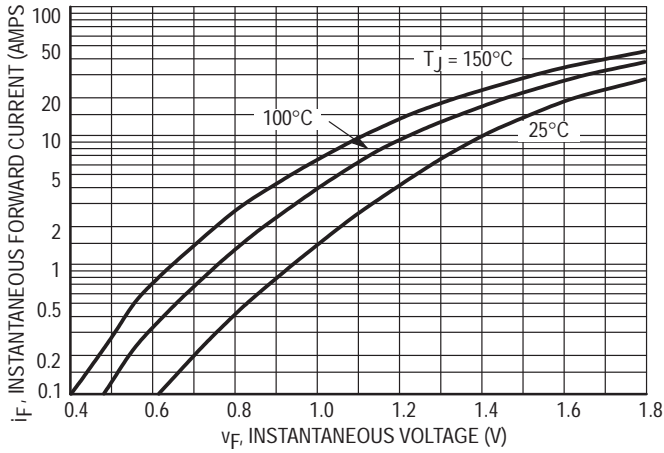


Figure 1. Typical Forward Voltage, Per Leg

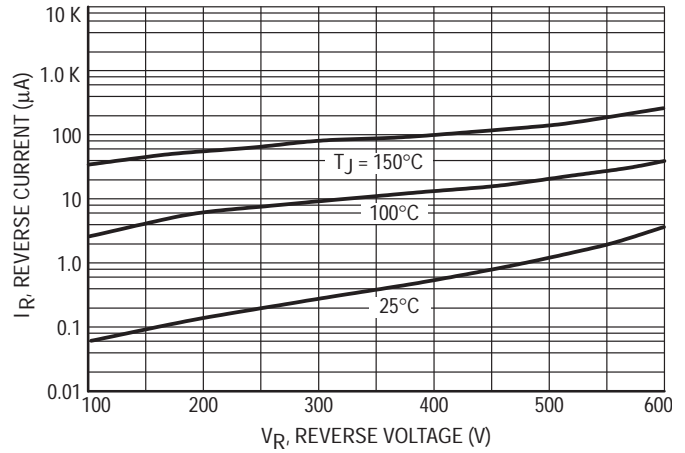
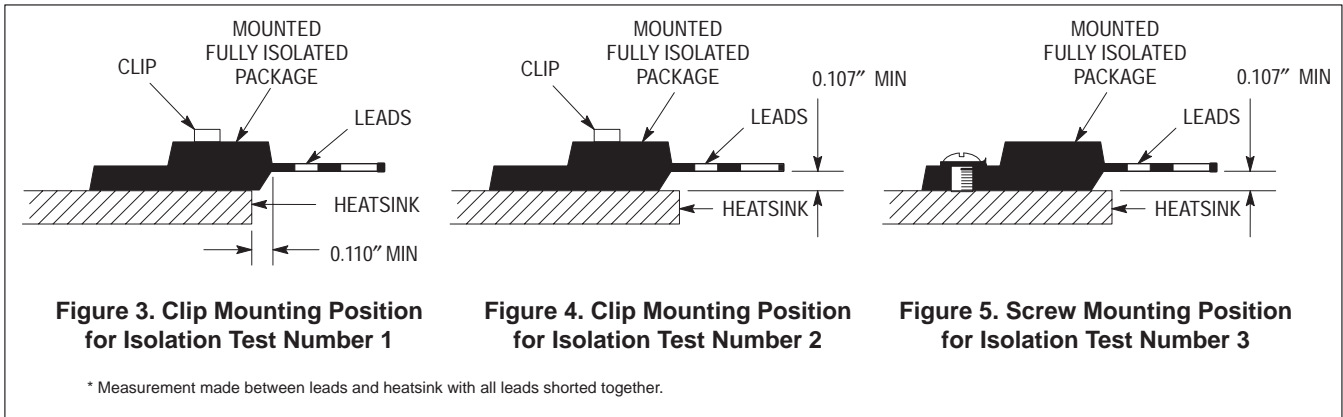
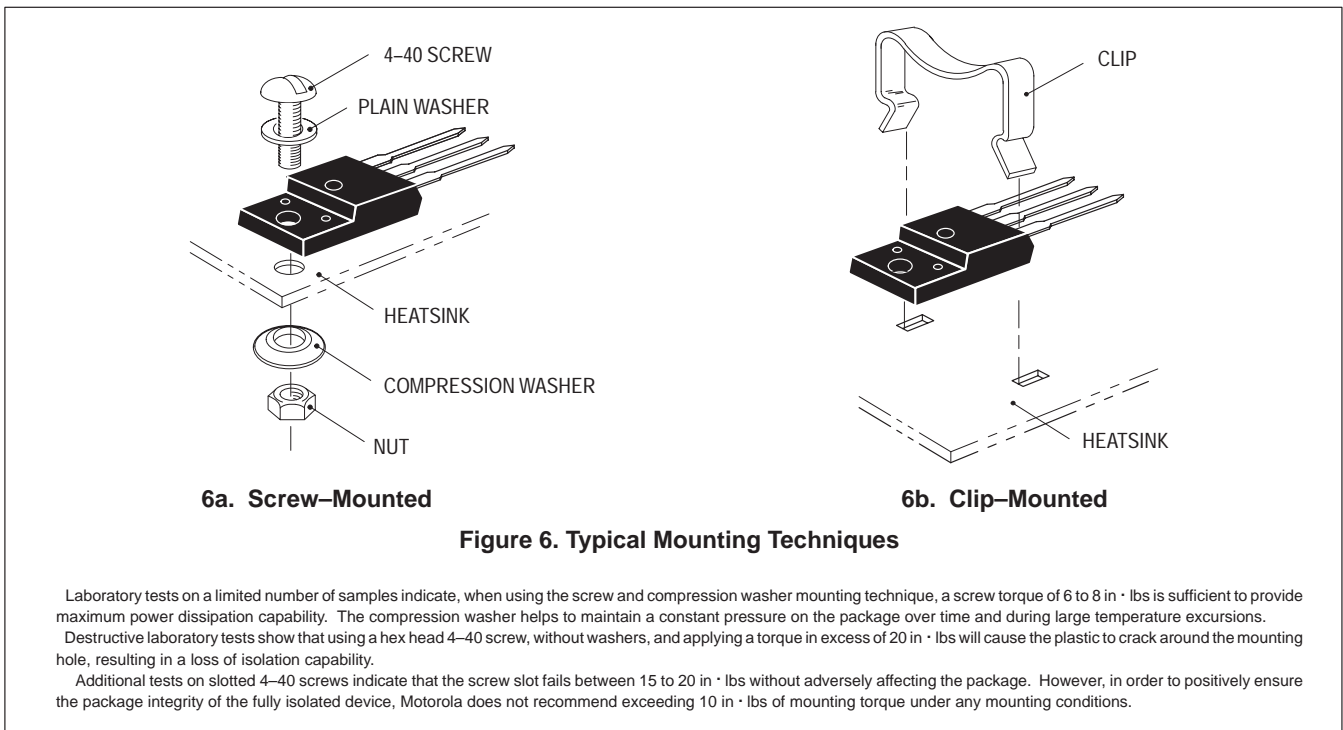


Figure 2. Typical Reverse Current, Per Leg*

TEST CONDITIONS FOR ISOLATION TESTS*



MOUNTING INFORMATION**



**For more information about mounting power semiconductors see Application Note AN1040.

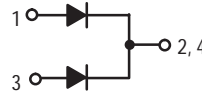
SWITCHMODE™ Power Rectifiers

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 and 60 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Popular TO-247 Package
- High Voltage Capability to 600 Volts
- Low Forward Drop
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating Specified @ Both Case and Ambient Temperatures
- Epoxy Meets UL94, V_O @ 1/8"
- High Temperature Glass Passivated Junction

Mechanical Characteristics

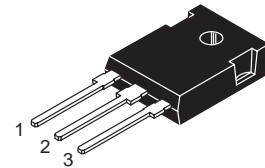
- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 units per plastic tube
- Marking: U3020, U3040, U3060



MUR3020WT
MUR3040WT
MUR3060WT

Motorola Preferred Devices

ULTRAFAST RECTIFIERS
30 AMPERES
200-400-600 VOLTS



CASE 340K-01
TO-247AE

MAXIMUM RATINGS, PER LEG

Rating	Symbol	MUR3020WT	MUR3040WT	MUR3060WT	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	200	400	600	Volts
Average Rectified Forward Current @ 145°C Total Device	I _{F(AV)}		15 30		Amps
Peak Repetitive Surge Current (Rated V _R , Square Wave, 20 kHz, T _C = 145°C)	I _{FM}		30		Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I _{FSM}	200	150		Amps
Operating Junction and Storage Temperature	T _J , T _{stg}	- 65 to +175			°C

THERMAL CHARACTERISTICS, PER LEG

Maximum Thermal Resistance — Junction to Case — Junction to Ambient	R _{θJC} R _{θJA}		1.5 40		°C/W
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ELECTRICAL CHARACTERISTICS, PER LEG

Maximum Instantaneous Forward Voltage (1) (I _F = 15 Amp, T _C = 150°C) (I _F = 15 Amp, T _C = 25°C)	V _F	0.85 1.05	1.12 1.25	1.4 1.7	Volts
Maximum Instantaneous Reverse Current (1) (Rated DC Voltage, T _J = 150°C) (Rated DC Voltage, T _J = 25°C)	i _R	500 10		1000 10	μA
Maximum Reverse Recovery Time (i _F = 1.0 A, di/dt = 50 Amps/μs)	t _{rr}	35	60		ns

(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

Preferred devices are Motorola recommended choices for future use and best overall value.

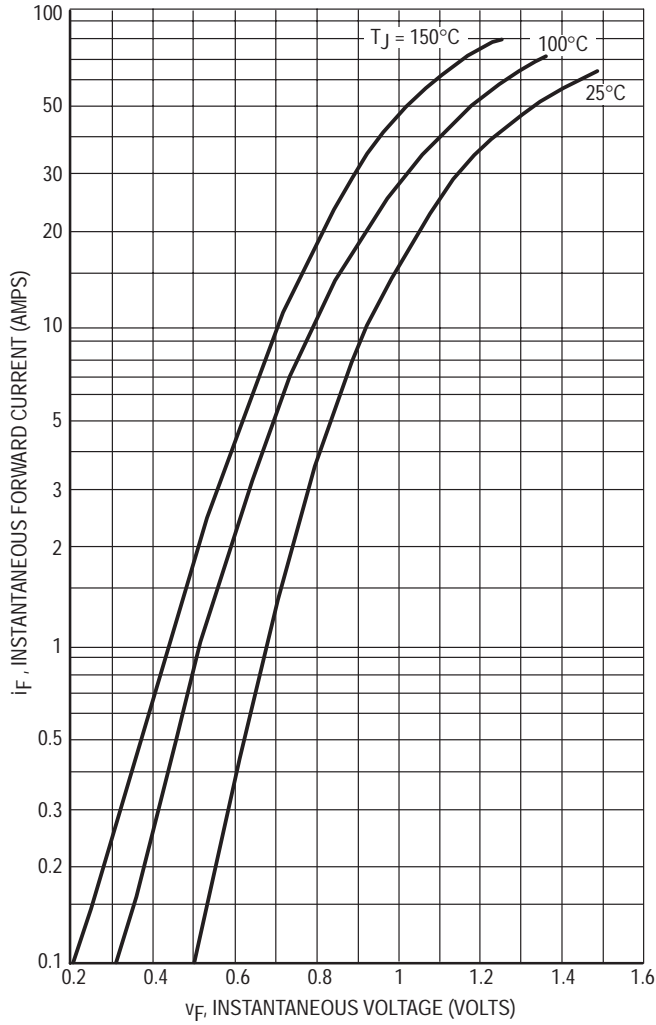
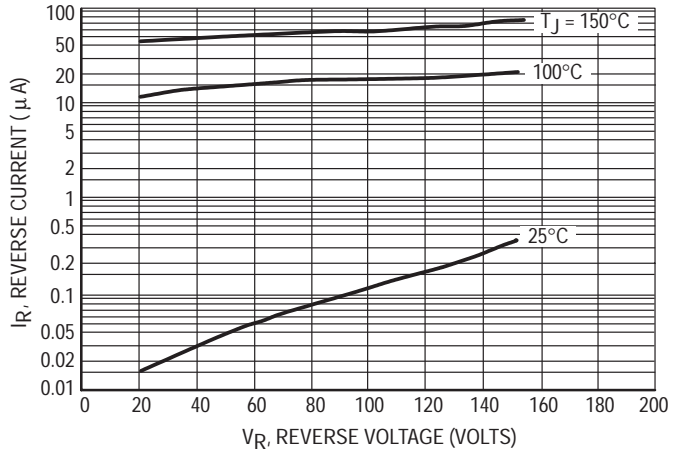


Figure 1. Typical Forward Voltage (Per Leg)



*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V_R is sufficiently below rated V_R .

Figure 2. Typical Reverse Current (Per Leg)*

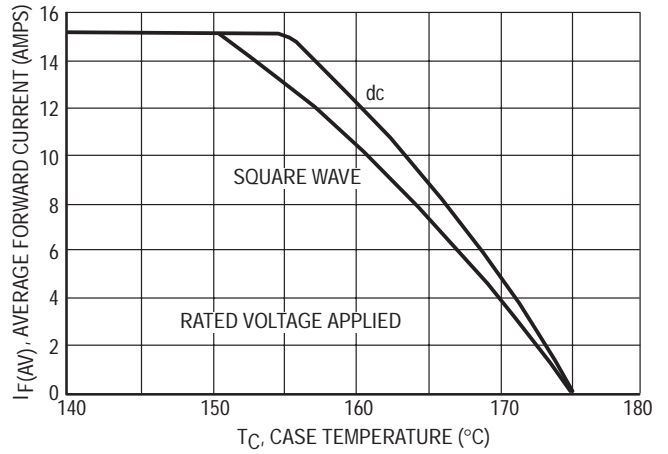


Figure 3. Current Derating, Case (Per Leg)

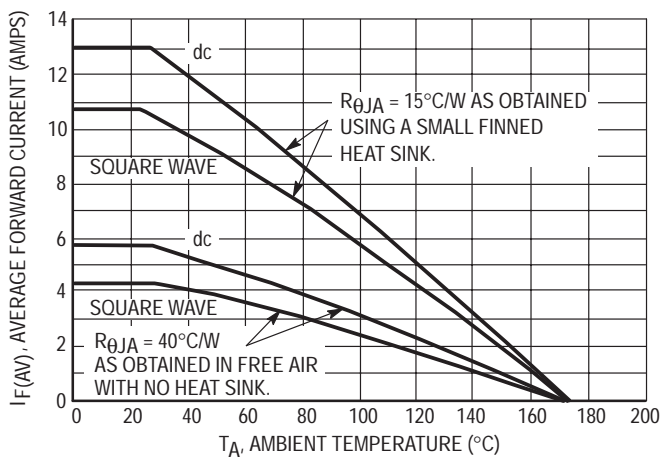


Figure 4. Current Derating, Ambient (Per Leg)

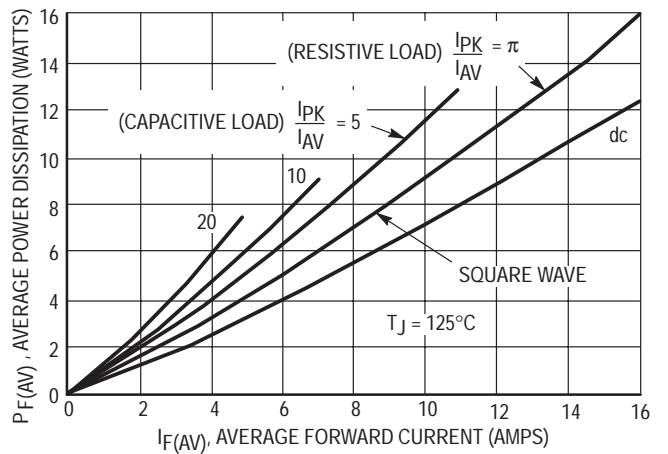


Figure 5. Power Dissipation (Per Leg)

MUR3020WT MUR3040WT MUR3060WT

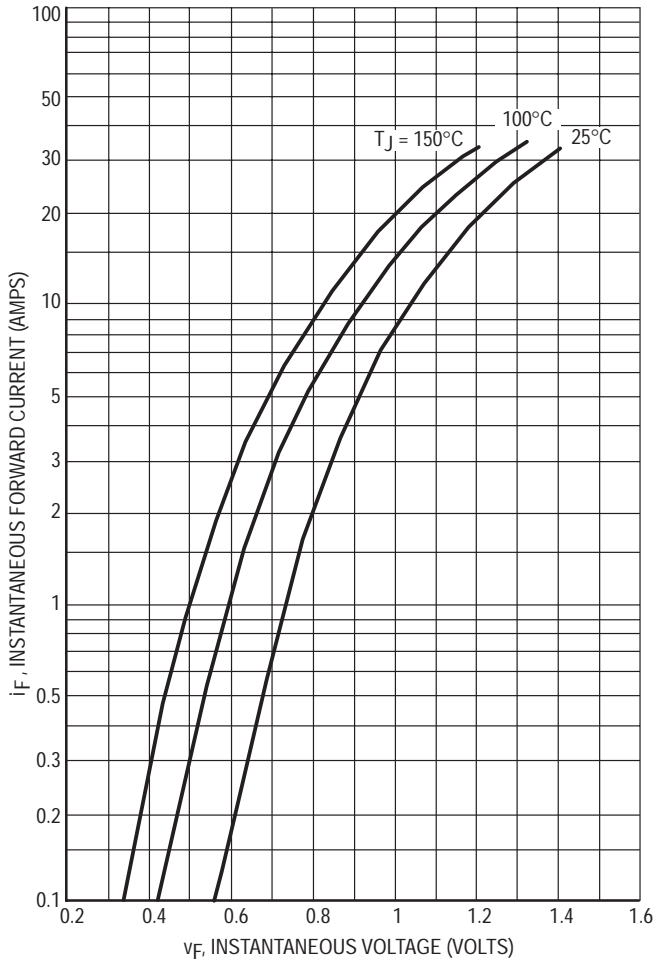
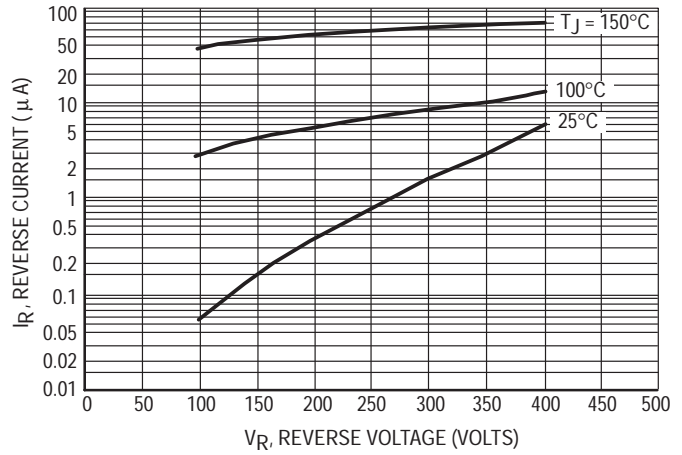


Figure 6. Typical Forward Voltage (Per Leg)



*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V_R is sufficiently below rated V_R .

Figure 7. Typical Reverse Current (Per Leg)*

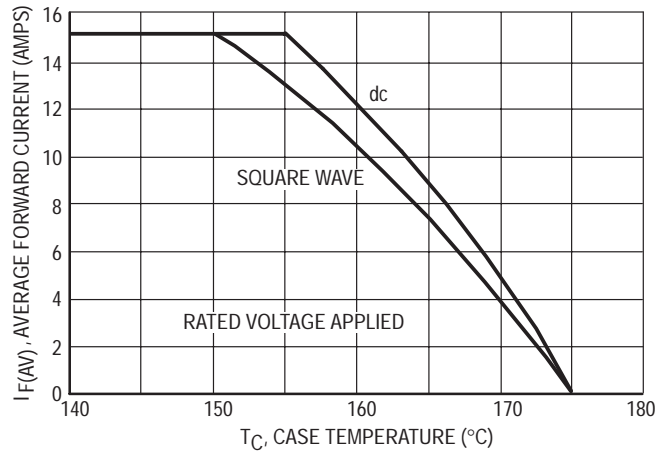


Figure 8. Current Derating, Case (Per Leg)

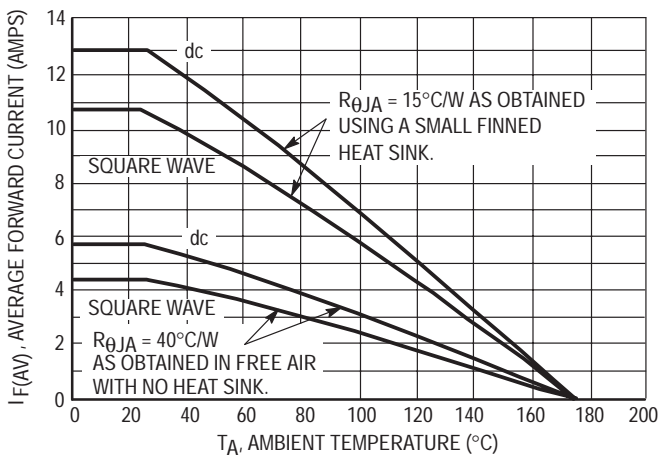


Figure 9. Current Derating, Ambient (Per Leg)

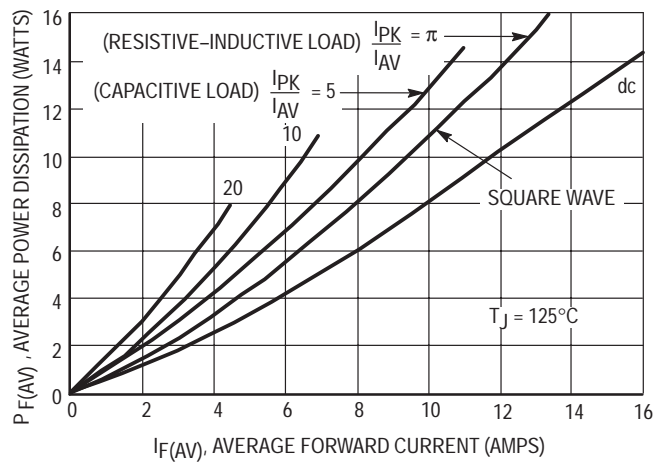


Figure 10. Power Dissipation (Per Leg)

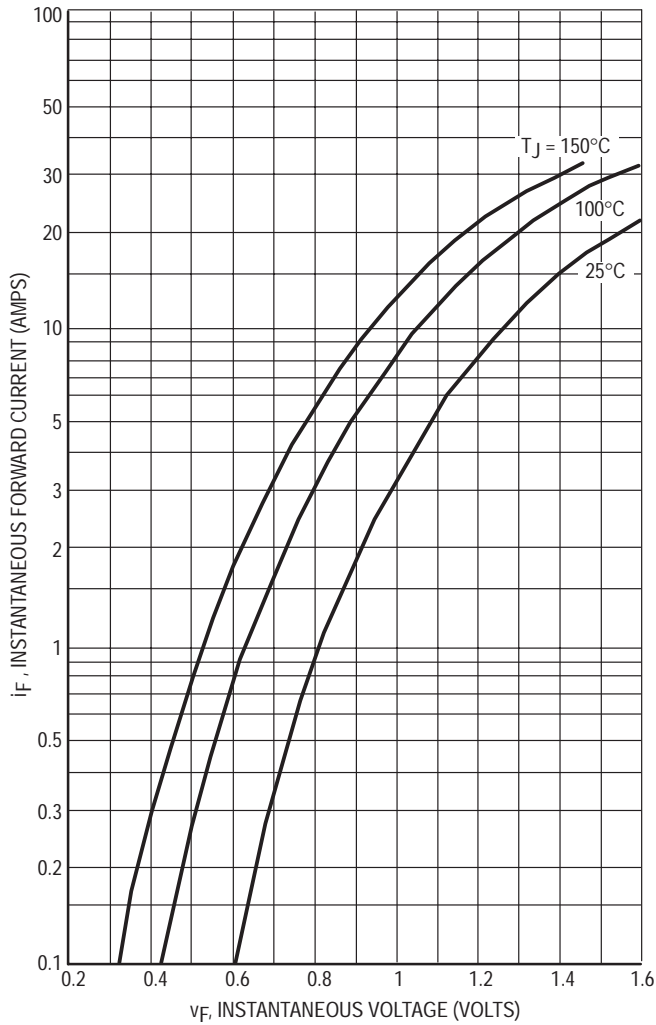
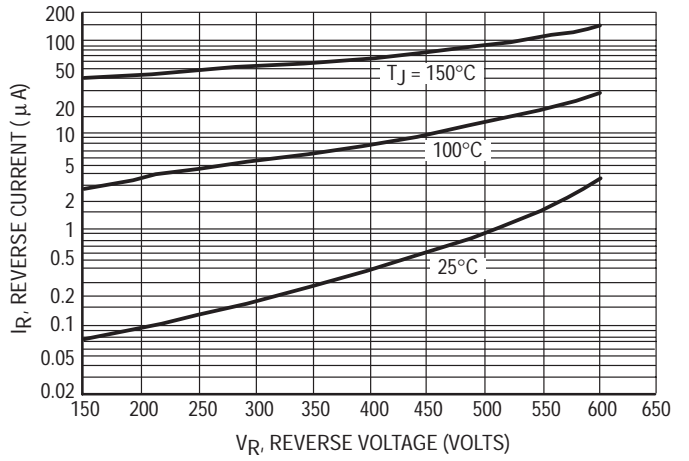


Figure 11. Typical Forward Voltage (Per Leg)



*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V_R is sufficiently below rated V_R .

Figure 12. Typical Reverse Current (Per Leg)*

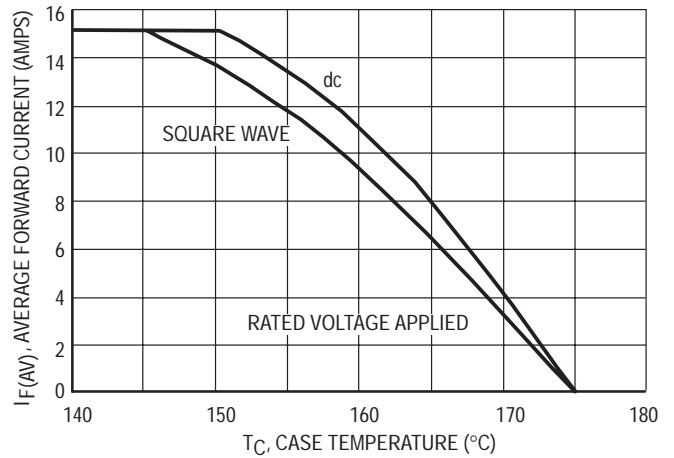


Figure 13. Current Derating, Case (Per Leg)

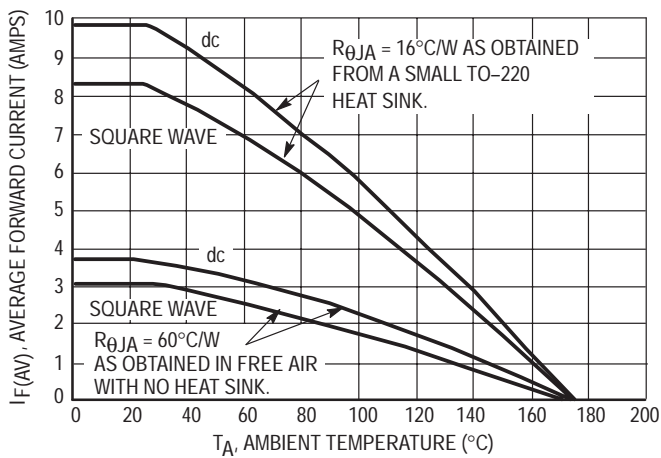


Figure 14. Current Derating, Ambient (Per Leg)

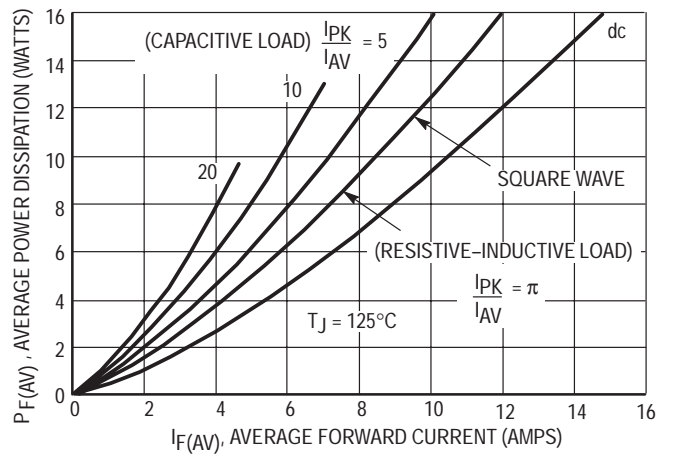


Figure 15. Power Dissipation (Per Leg)

MUR3020WT MUR3040WT MUR3060WT

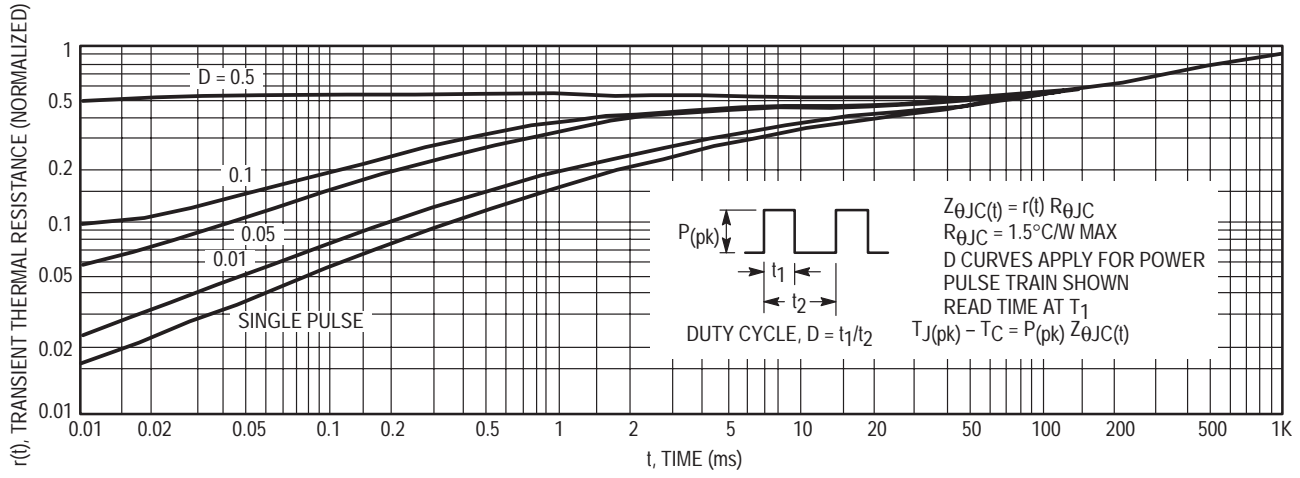


Figure 16. Thermal Response

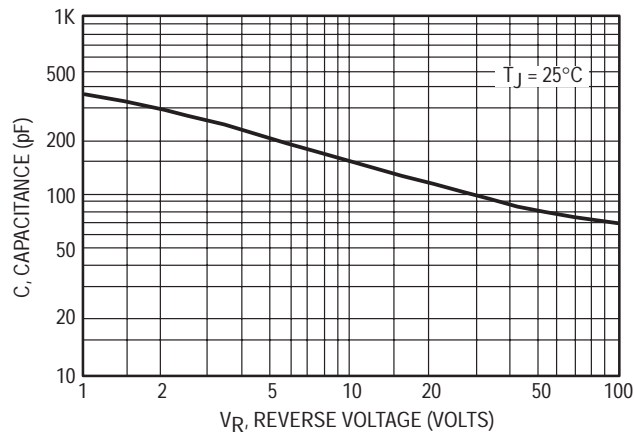


Figure 17. Typical Capacitance (Per Leg)

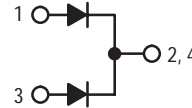
SWITCHMODE™ Power Rectifiers

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 and 60 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- High Voltage Capability to 600 Volts
- Low Forward Drop
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating Specified @ Both Case and Ambient Temperatures
- Epoxy Meets UL94, V_O @ 1/8"
- High Temperature Glass Passivated Junction

Mechanical Characteristics:

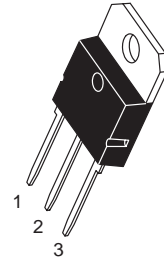
- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 units per plastic tube
- Marking: U3020, U3040, U3060



MUR3020PT
MUR3040PT*
MUR3060PT*

*Motorola Preferred Devices

ULTRAFAST RECTIFIERS
30 AMPERES
200-400-600 VOLTS



CASE 340D-02, Style 2
TO-218AC

MAXIMUM RATINGS, PER LEG

Rating	Symbol	MUR3020PT	MUR3040PT	MUR3060PT	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	200	400	600	Volts
Average Rectified Forward Current (Rated V _R) Per Leg Per Device	I _{F(AV)}	15 @ T _C = 150°C 30 @ T _C = 150°C		15 @ T _C = 30 145°C	Amps
Peak Rectified Forward Current, Per Leg (Rated V _R , Square Wave, 20 kHz, T _C = 150°C)	I _{FRM}	30 @ T _C = 150°C		30 @ T _C = 145°C	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz) Per Leg	I _{FSM}	200		150	Amps
Operating Junction and Storage Temperature	T _J , T _{stg}	- 65 to +175			°C

THERMAL CHARACTERISTICS PER DIODE LEG

Maximum Thermal Resistance — Junction to Case — Junction to Ambient	R _{θJC} R _{θJA}		1.5 40	°C/W
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ELECTRICAL CHARACTERISTICS PER DIODE LEG

Maximum Instantaneous Forward Voltage (1) (I _F = 15 Amp, T _C = 150°C) (I _F = 15 Amp, T _C = 25°C)	V _F	0.85 1.05	1.12 1.25	1.2 1.5	Volts
Maximum Instantaneous Reverse Current (1) (Rated DC Voltage, T _J = 150°C) (Rated DC Voltage, T _J = 25°C)	i _R		500 10	1000 10	μA
Maximum Reverse Recovery Time (i _F = 1.0 Amp, di/dt = 50 Amps/μs)	t _{rr}	35		60	ns

(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

Preferred devices are Motorola recommended choices for future use and best overall value.

MUR3020PT MUR3040PT MUR3060PT

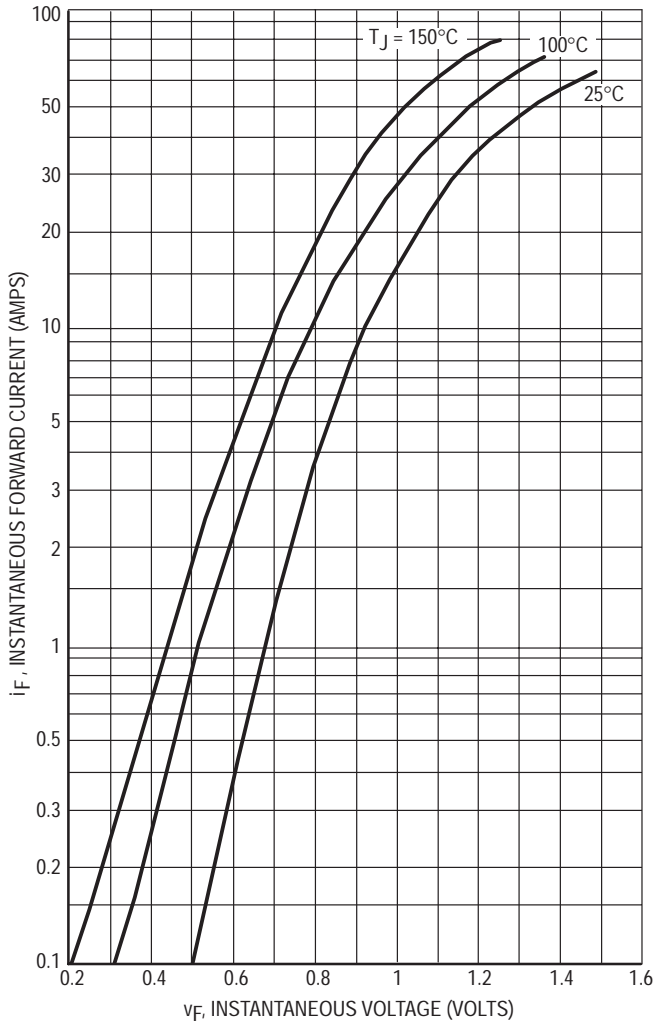


Figure 1. Typical Forward Voltage (Per Leg)

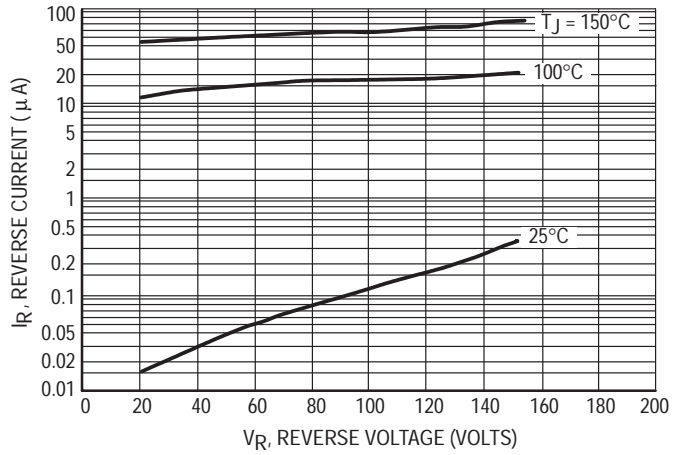


Figure 2. Typical Reverse Current (Per Leg)

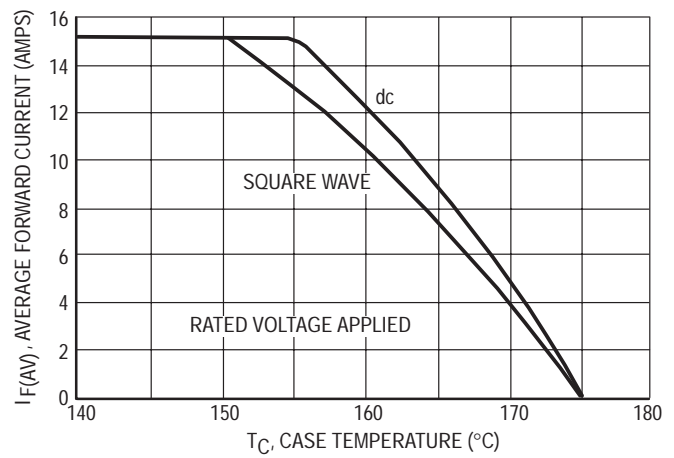


Figure 3. Current Derating, Case (Per Leg)

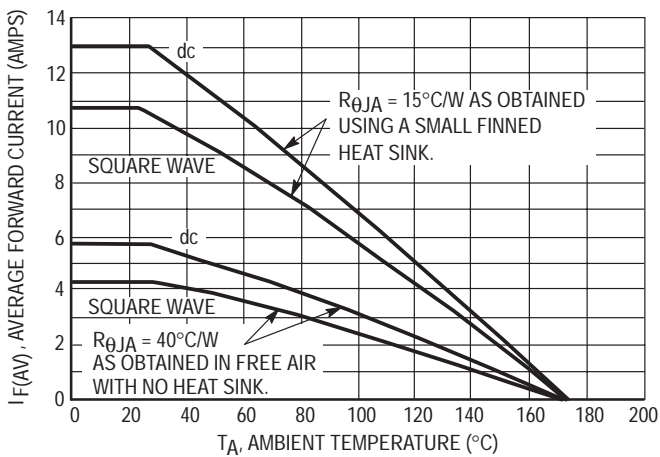


Figure 4. Current Derating, Ambient (Per Leg)

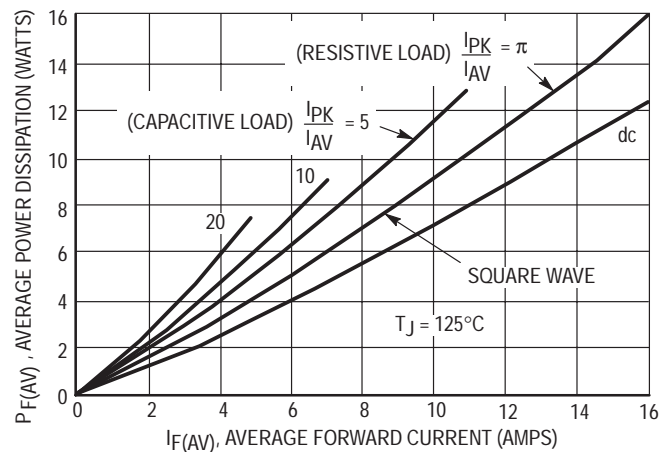


Figure 5. Power Dissipation (Per Leg)

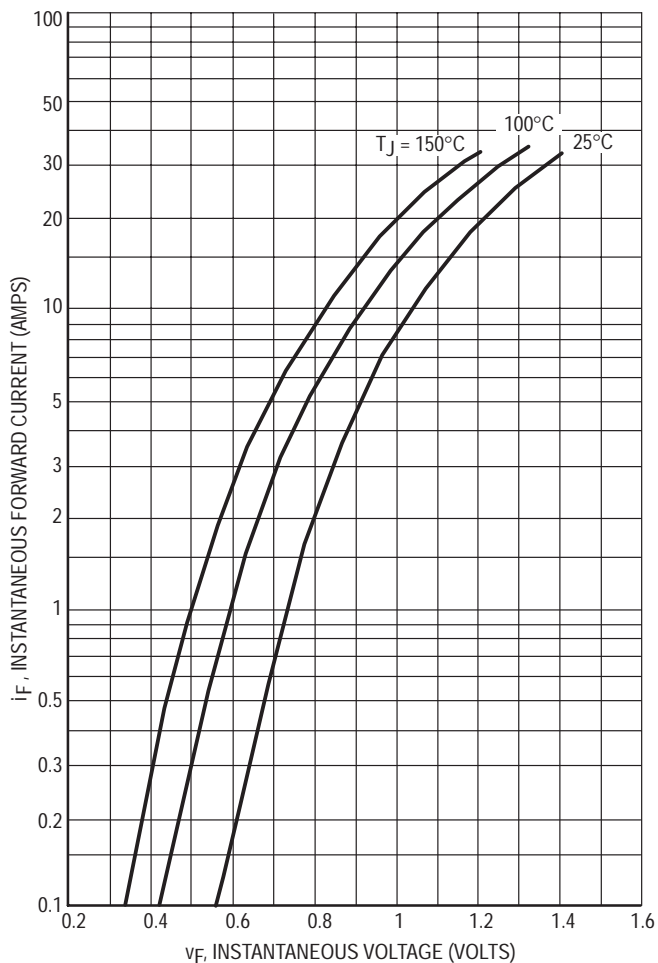


Figure 6. Typical Forward Voltage (Per Leg)

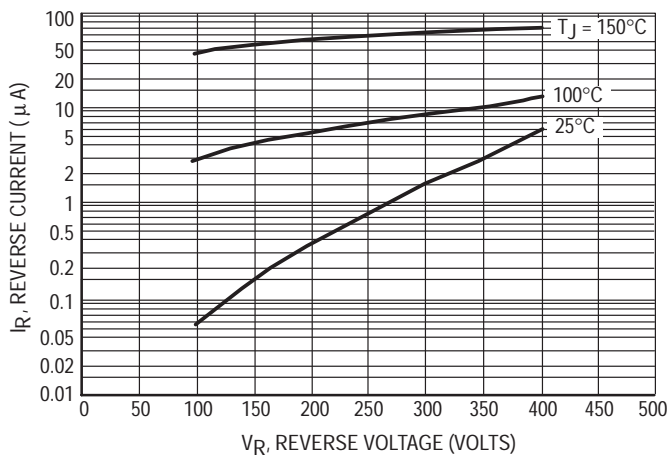


Figure 7. Typical Reverse Current (Per Leg)

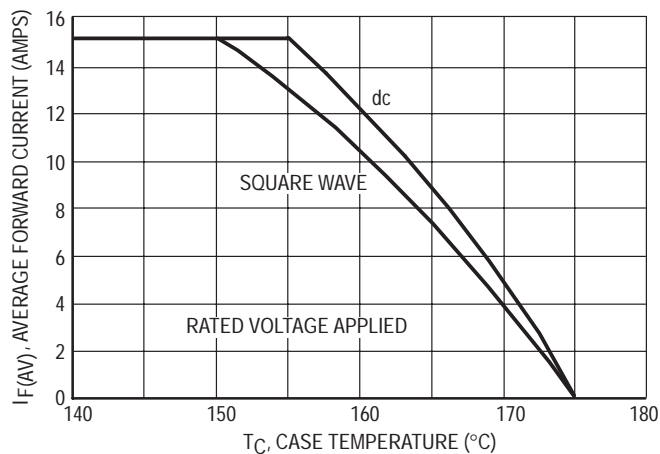


Figure 8. Current Derating, Case (Per Leg)

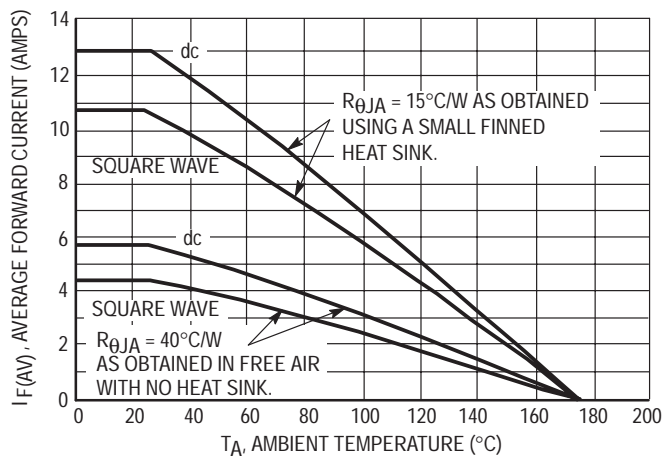


Figure 9. Current Derating, Ambient (Per Leg)

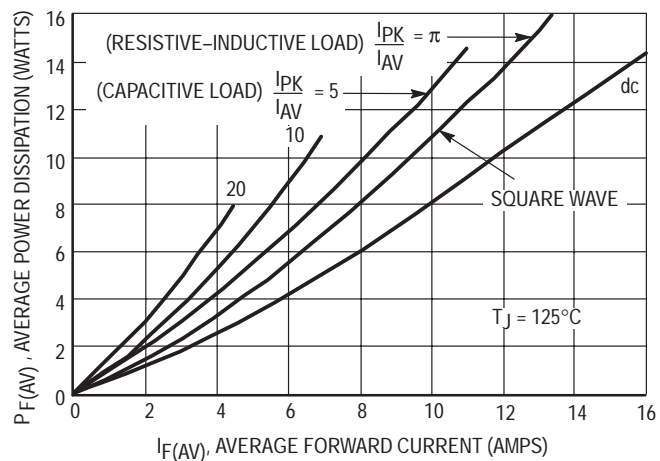


Figure 10. Power Dissipation (Per Leg)

MUR3020PT MUR3040PT MUR3060PT

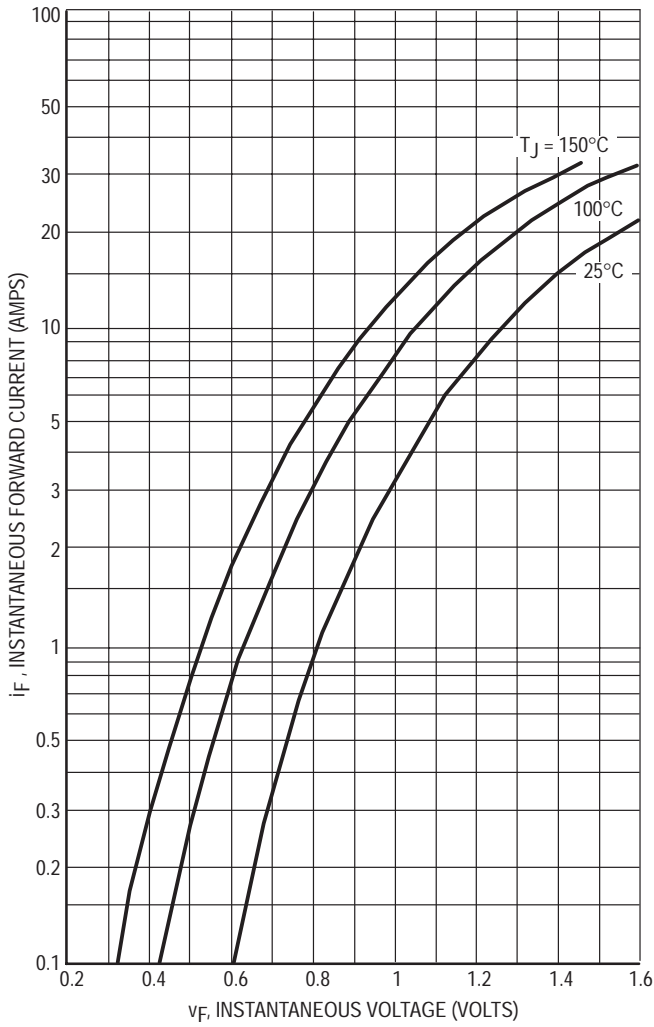


Figure 11. Typical Forward Voltage (Per Leg)

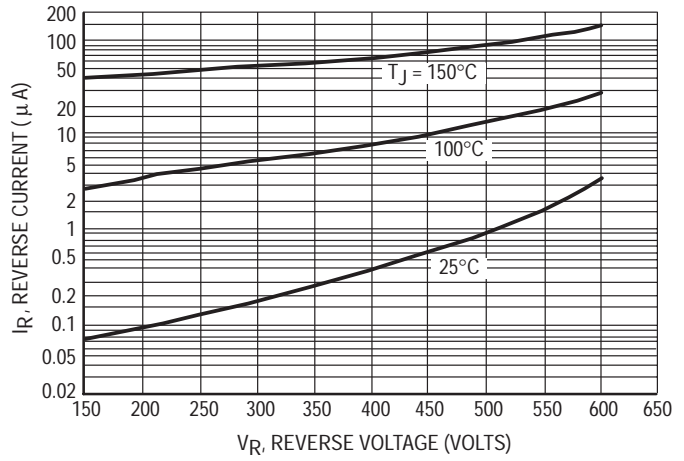


Figure 12. Typical Reverse Current (Per Leg)

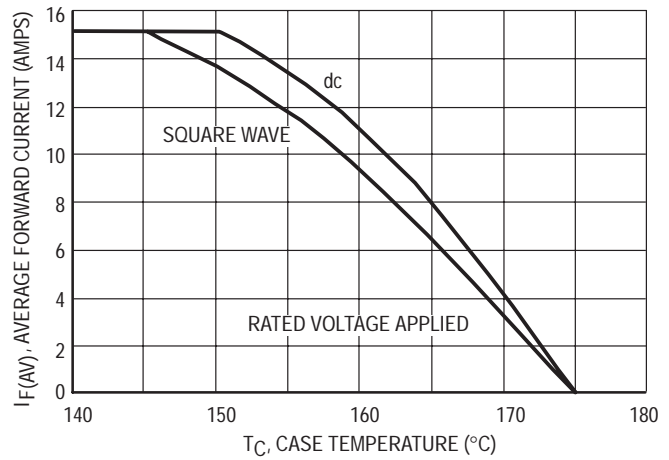


Figure 13. Current Derating, Case (Per Leg)

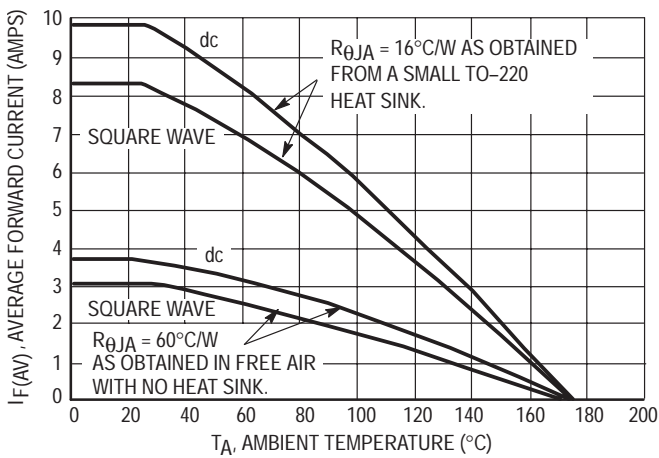


Figure 14. Current Derating, Ambient (Per Leg)

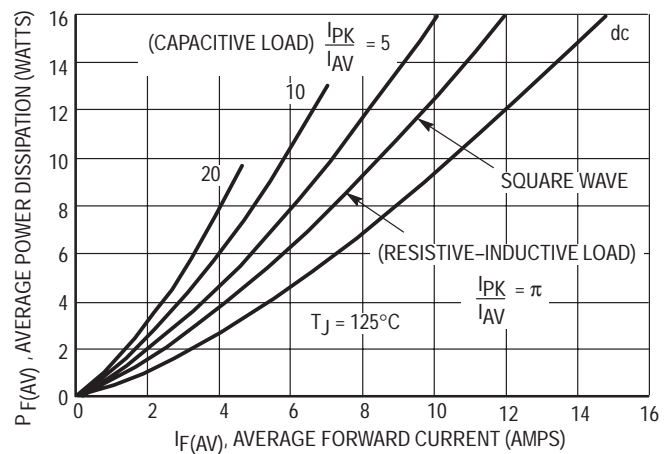


Figure 15. Power Dissipation (Per Leg)

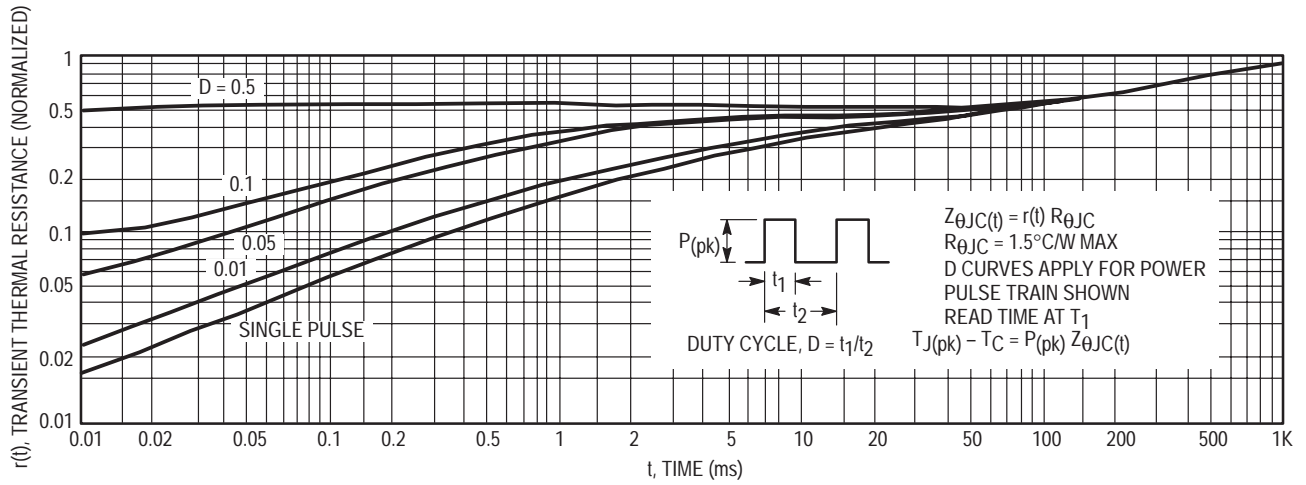


Figure 16. Thermal Response

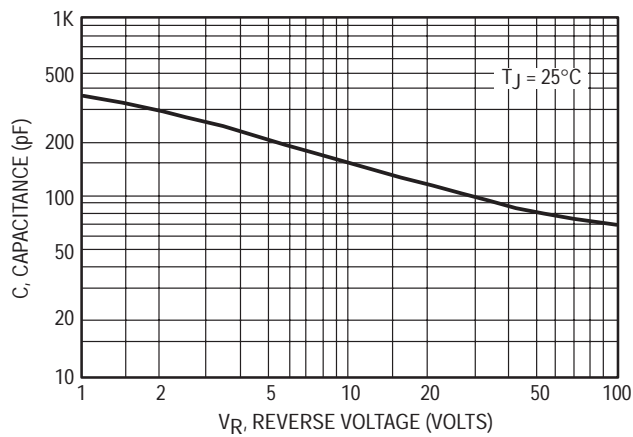


Figure 17. Typical Capacitance (Per Leg)

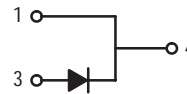
SWITCHMODE™ Power Rectifier

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 100 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- High Voltage Capability to 400 Volts
- Low Forward Voltage Drop
- High Temperature Glass Passivated Junction

Mechanical Characteristics

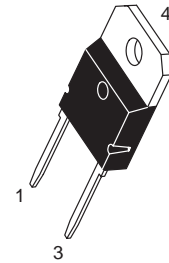
- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 Units Per Plastic Tube
- Marking: U3040



MUR3040

Motorola Preferred Device

ULTRAFAST RECTIFIERS
30 AMPERES
400 VOLTS



CASE 340E-02, STYLE 1

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	400	Volts
Average Rectified Forward Current $T_C = 70^\circ\text{C}$	$I_{F(AV)}$	30	Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz) $T_C = 150^\circ\text{C}$	I_{FRM}	30	Amps
Non Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	300	Amps
Operating Junction Temperature and Storage Temperature	T_J, T_{stg}	-65 to +175	°C

THERMAL CHARACTERISTICS

Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.0	°C/W
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ELECTRICAL CHARACTERISTICS

Instantaneous Forward Voltage (1) @ $I_F = 30$ Amps, $T_C = 100^\circ\text{C}$ @ $I_F = 30$ Amps, $T_C = 25^\circ\text{C}$	V_F	1.4 1.5	Volts
Instantaneous Reverse Current (1) @ Rated dc Voltage, $T_C = 100^\circ\text{C}$ @ Rated dc Voltage, $T_C = 25^\circ\text{C}$	I_R	6.0 35	mA μA
Reverse Recovery Time $I_F = 1.0$ Amp, $dI/dt = 15$ Amp/ μs	t_{RR}	100	ns

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$

Preferred devices are Motorola recommended choices for future use and best overall value.

TYPICAL ELECTRICAL CHARACTERISTICS

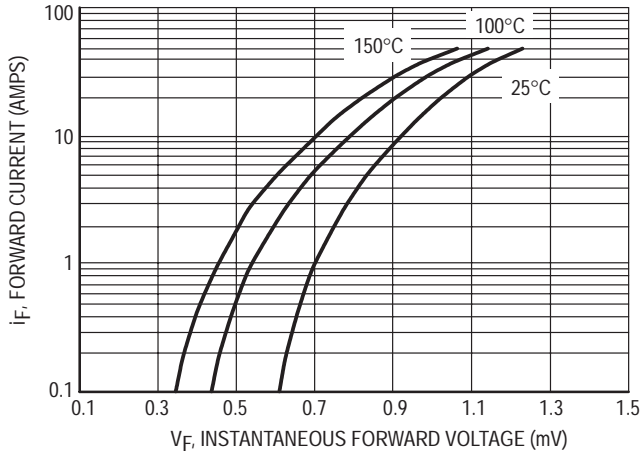


Figure 1. Typical Forward Voltage

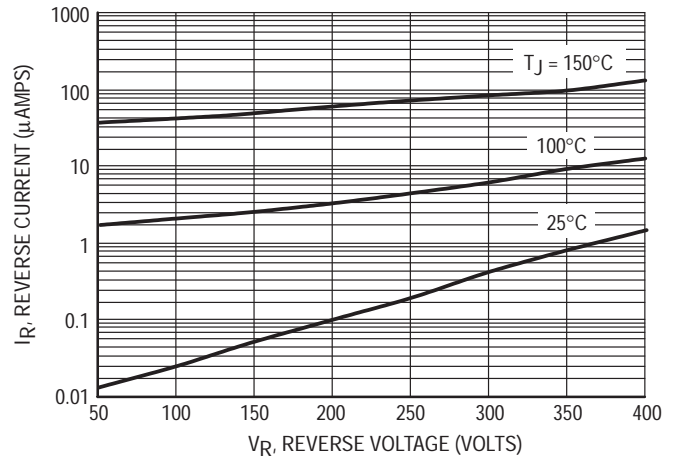


Figure 2. Typical Reverse Current

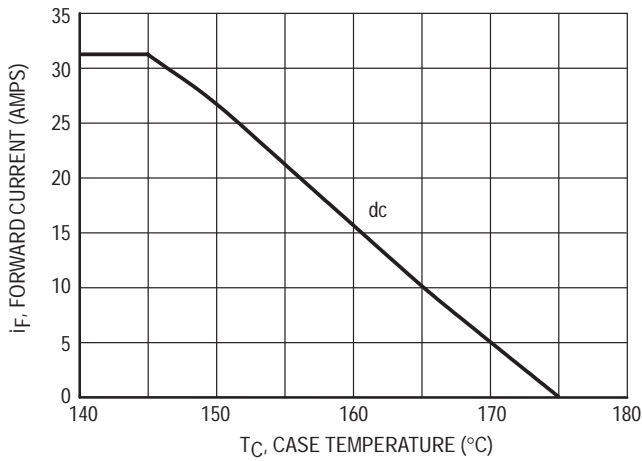


Figure 3. Current Derating, Case

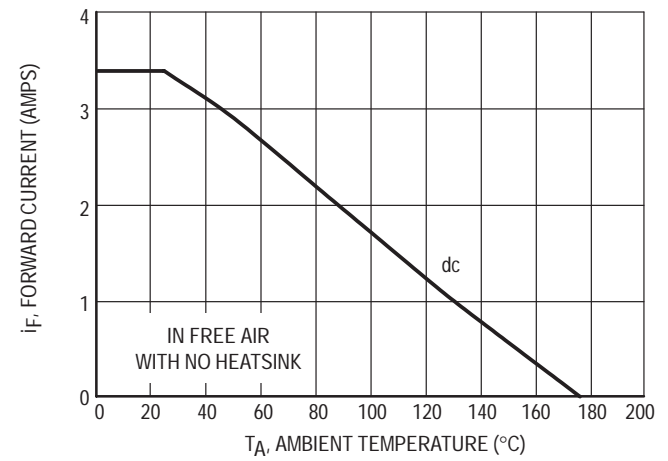


Figure 4. Current Derating, Ambient

Advance Information

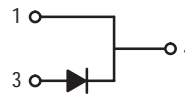
SWITCHMODE™ Power Rectifier

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 75 ns (Typ) Soft Recovery Time
- 175°C Operating Junction Temperature
- High Voltage Capability to 800 Volts
- Low Forward Voltage Drop
- High Temperature Glass Passivated Junction

Mechanical Characteristics

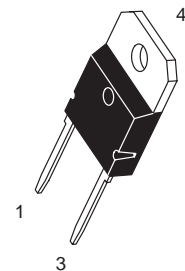
- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 Units Per Plastic Tube
- Marking: U3080



MUR3080

Motorola Preferred Device

ULTRAFAST RECTIFIERS
30 AMPERES
600–800 VOLTS



CASE 340E-02, STYLE 1

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	800	Volts
Average Rectified Forward Current (Rated V_R) $T_C = 70^\circ\text{C}$	$I_F(AV)$	30	Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz) $T_C = 150^\circ\text{C}$	I_{FRM}	30	Amps
Non Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	300	Amps
Operating Junction Temperature	T_J	-65 to +175	°C
Storage Temperature	T_{stg}	-65 to +175	°C

THERMAL CHARACTERISTICS

Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.0	°C/W
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ELECTRICAL CHARACTERISTICS (TYPICAL DATA)

Instantaneous Forward Voltage (1) @ $I_F = 30$ Amps, $T_C = 25^\circ\text{C}$ @ $I_F = 30$ Amps, $T_C = 100^\circ\text{C}$	V_F	1.9 1.8	Volts
Instantaneous Reverse Current (1) @ Rated DC Voltage, $T_C = 25^\circ\text{C}$ @ Rated DC Voltage, $T_C = 100^\circ\text{C}$	I_R	100 5.0	μA mA
Reverse Recovery Time $I_F = 1.0$ Amp, $V_R = 30$ V, $di/dt = 50$ A/ μs	t_{RR}	110	ns

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

This document contains information on a new product. Specifications and information herein are subject to change without notice.

Preferred devices are Motorola recommended choices for future use and best overall value.

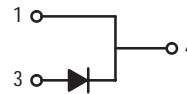
SWITCHMODE™ Power Rectifier

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 100 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- High Voltage Capability to 400 Volts
- Low Forward Voltage Drop
- High Temperature Glass Passivated Junction

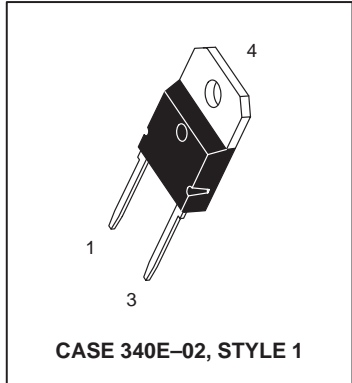
Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 Units Per Plastic Tube
- Marking: U6040



MUR6040
Motorola Preferred Device

ULTRAFAST RECTIFIERS
60 AMPERES
400 VOLTS



MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	400	Volts
Average Rectified Forward Current $T_C = 70^\circ\text{C}$	$I_{F(AV)}$	60	Amps
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz) $T_C = 150^\circ\text{C}$	I_{FRM}	60	Amps
Non Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	600	Amps
Operating Junction Temperature and Storage Temperature	T_J, T_{stg}	-65 to +175	°C

THERMAL CHARACTERISTICS

Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.8	°C/W
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ELECTRICAL CHARACTERISTICS

Instantaneous Forward Voltage (1) @ $I_F = 60$ Amps, $T_C = 100^\circ\text{C}$ @ $I_F = 60$ Amps, $T_C = 25^\circ\text{C}$	V_F	1.4 1.5	Volts
Instantaneous Reverse Current (1) @ Rated dc Voltage, $T_C = 100^\circ\text{C}$ @ Rated dc Voltage, $T_C = 25^\circ\text{C}$	I_R	10 60	mA μA
Reverse Recovery Time $I_F = 1.0$ Amp, $dI/dt = 15$ Amp/ μs	t_{RR}	100	ns

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$

Preferred devices are Motorola recommended choices for future use and best overall value.

TYPICAL ELECTRICAL CHARACTERISTICS

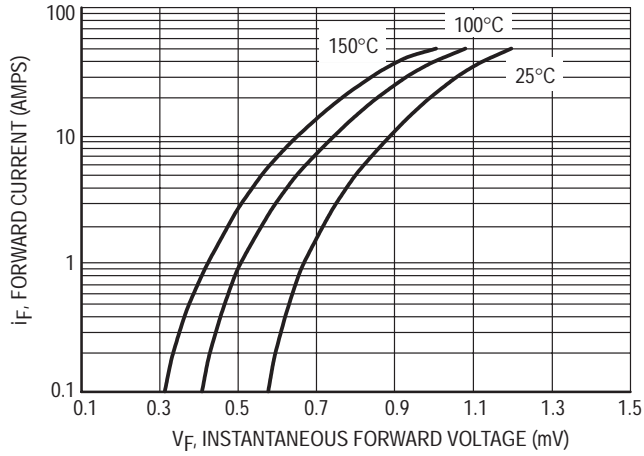


Figure 1. Typical Forward Voltage

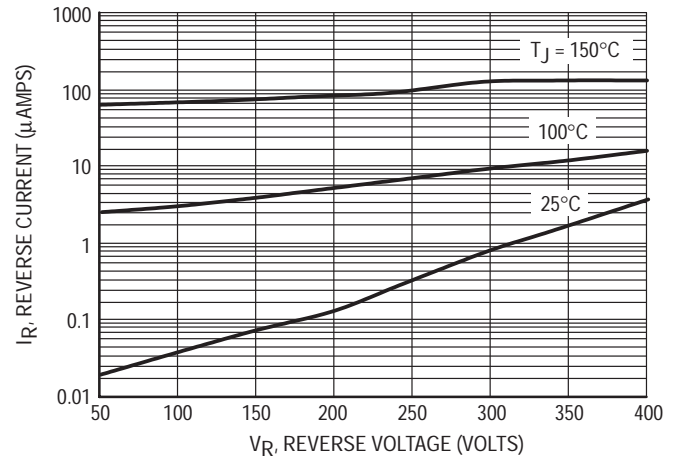


Figure 2. Typical Reverse Current

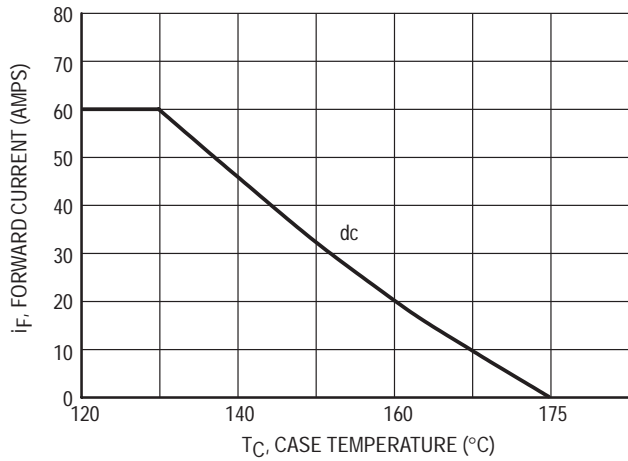


Figure 3. Current Derating, Case

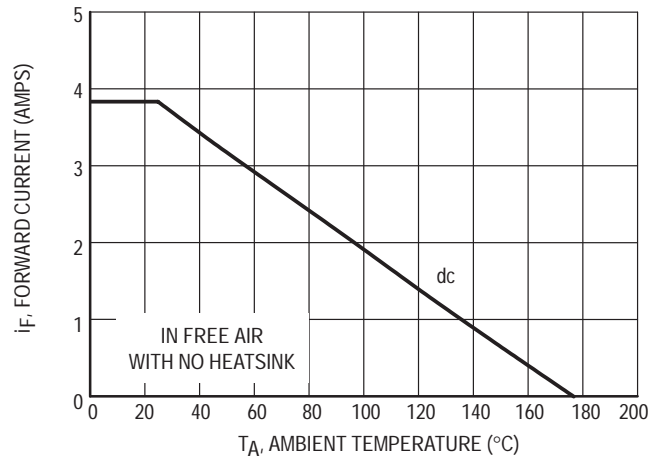



Figure 4. Current Derating, Ambient

Ultrafast Power Rectifiers

Dual high voltage rectifiers ranging from 200 V to 400 V suited for Switch Mode Power Supplies and other power converters.

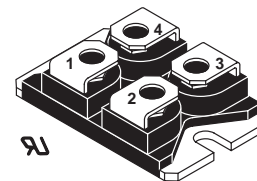
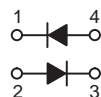
- Very Low Reverse Recovery Time
- Very Low Switching Losses
- Low Noise Turn-Off Switching
- Insulated Package:
Insulating voltage = 2500 V_{RMS}
Capacitance = 45 pF
-  — UL Recognized, File #E69369

Mechanical Characteristics

- Case: Molded epoxy with isolated metal base
- Weight: 28 g (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Shipped 10 units per plastic tube
- Marking: BYT230PIV-400M

BYT230PIV-400M

**ULTRAFAST
RECTIFIERS
60 AMPS
400 VOLTS**



SOT-227B

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	400	V
Average Rectified Current T _C = 75°C	I _{F(AV)} Per Device Per Diode	60 30	A
Peak Repetitive Forward Current, Per Diode t _p < 10 μs	I _{FRM}	500	A
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I _{FSM}	350	A
Operating Junction Temperature	T _J	-40 to +150	°C
Storage Temperature	T _{stg}	-40 to +150	°C

THERMAL CHARACTERISTICS

Thermal Resistance, Junction to Case	Per Diode	R _{θJC}	1.5	°C/W
	Per Device	R _{θJC}	0.8	
Coupling		R _{θC}	0.1	

ELECTRICAL CHARACTERISTICS PER DIODE

Instantaneous Forward Voltage (1) I _F = 30 A, T _C = 25°C I _F = 30 A, T _C = 100°C	V _F	1.5 1.4	V
Instantaneous Reverse Current (2) V _R = 400 V, T _C = 25°C V _R = 400 V, T _C = 100°C	I _R	35 6	μA mA

(1) Pulse Test: Pulse Width = 380 μs, Duty Cycle ≤ 2%.

(2) Pulse Test: Pulse Width = 5 ms, Duty Cycle < 2%.

BYT230PIV-400M**RECOVERY CHARACTERISTICS**

Test Conditions	Symbol	Typ	Max	Unit
$I_F = 1 \text{ A}$, $V_R = 30 \text{ V}$, $dI_F/dt = -15 \text{ A}/\mu\text{s}$ $I_F = 0.5 \text{ A}$, $I_R = 1 \text{ A}$, $I_{rr} = 0.25 \text{ A}$	t_{rr}	— —	100 50	ns

TURN-OFF SWITCHING CHARACTERISTICS (without series inductance)

Test Conditions	Symbol	Typ	Max	Unit
$V_{CC} = 200 \text{ V}$, $I_F = 30 \text{ A}$, $T_J = 100^\circ\text{C}$, $L_p < 0.05 \mu\text{H}$ (See Figure 11) $dI_F/dt = -120 \text{ A}/\mu\text{s}$ $dI_F/dt = -240 \text{ A}/\mu\text{s}$	t_{IRM}	— 50	75 —	ns
$dI_F/dt = -120 \text{ A}/\mu\text{s}$ $dI_F/dt = -240 \text{ A}/\mu\text{s}$	I_{RM}	— 12	9 —	A

TURN-OFF OVERVOLTAGE COEFFICIENT (with series inductance)

Test Conditions	Symbol	Typ	Max	Unit
$T_J = 100^\circ\text{C}$, $V_{CC} = 60 \text{ V}$, $I_F = I_F(AV)$ $dI_F/dt = -30 \text{ A}/\mu\text{s}$, $L_p = 1 \mu\text{H}$ (See Figure 12)	$C = \frac{V_{RP}}{V_{CC}}$	3.3	—	

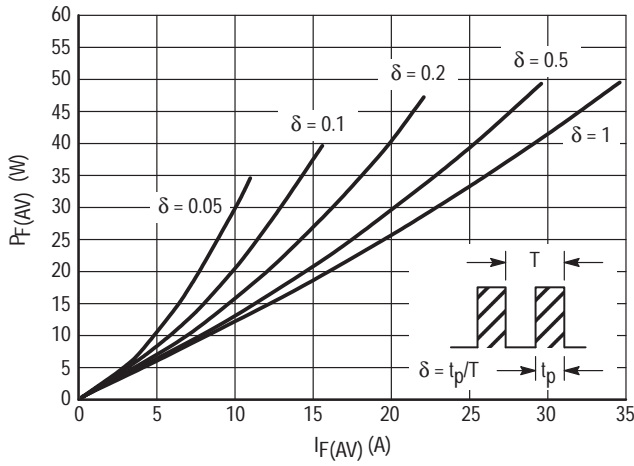


Figure 1. Low Frequency Power Losses versus Average Current

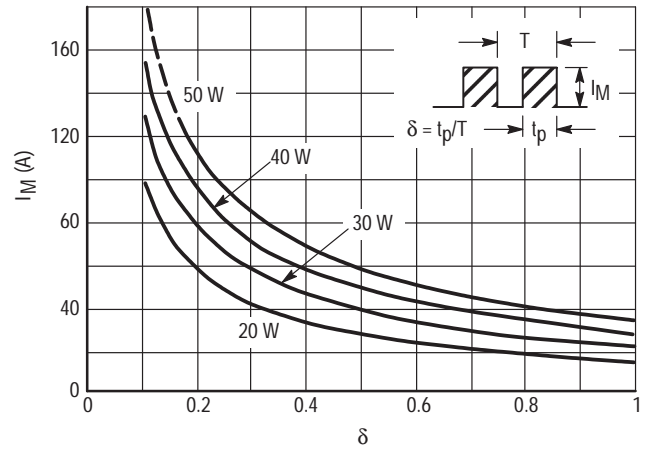


Figure 2. Peak Current versus Form Factor

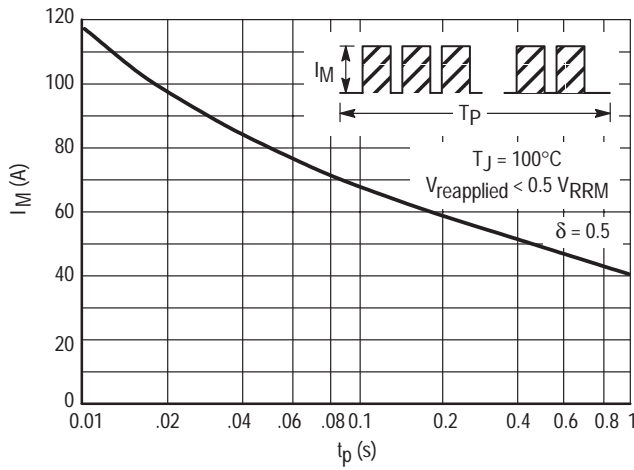


Figure 3. Non-Repetitive Peak Surge Current versus Overload Duration

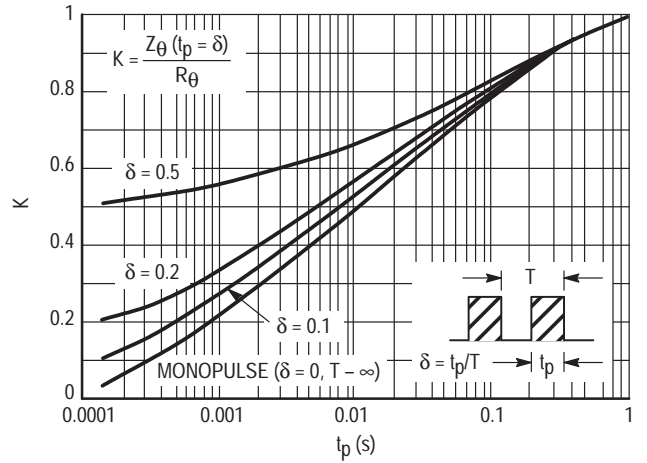


Figure 4. Relative Variation of Thermal Impedance Junction to Case versus Pulse Duration

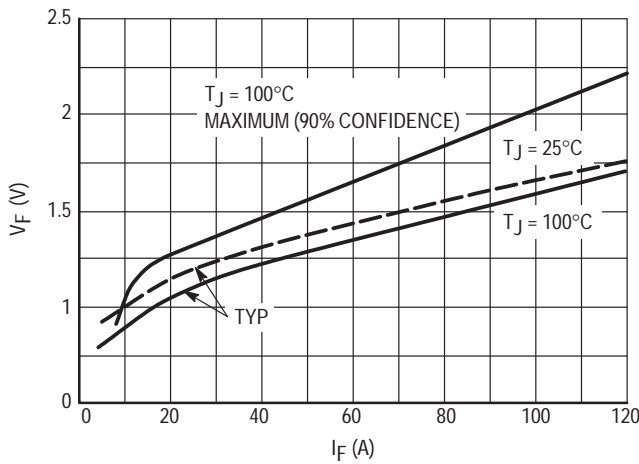


Figure 5. Voltage Drop versus Forward Current

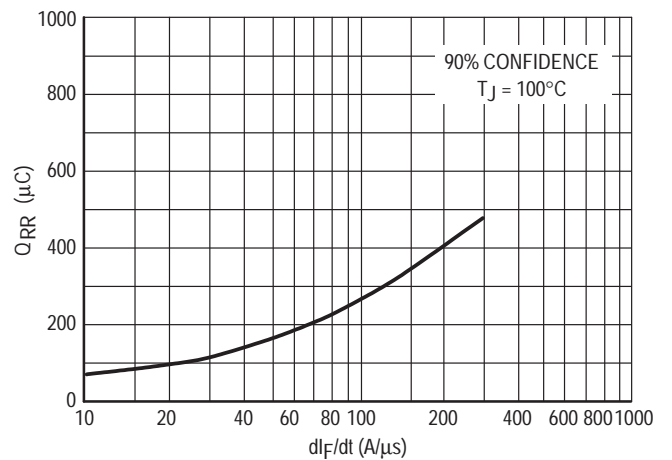


Figure 6. Recovery Charge versus di_F/dt

BYT230PIV-400M

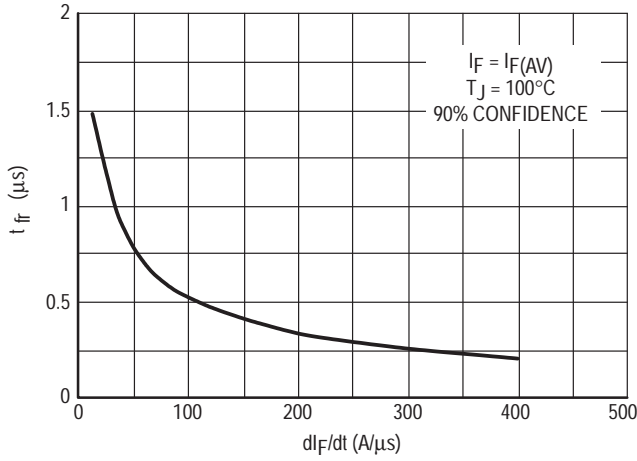


Figure 7. Recovery Time versus dI_F/dt

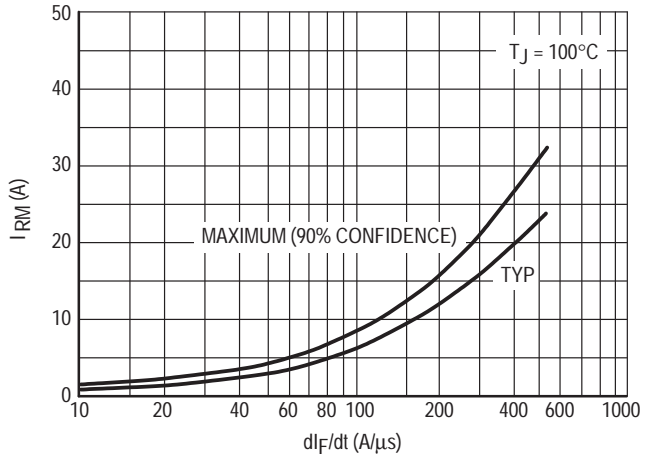


Figure 8. Peak Reverse Current versus dI_F/dt

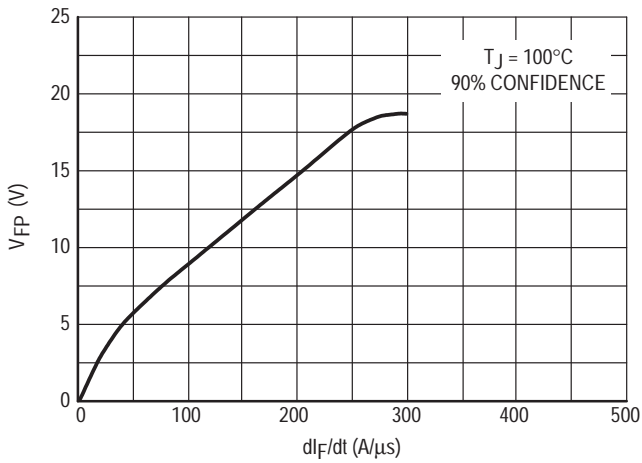


Figure 9. Peak Forward Voltage versus dI_F/dt

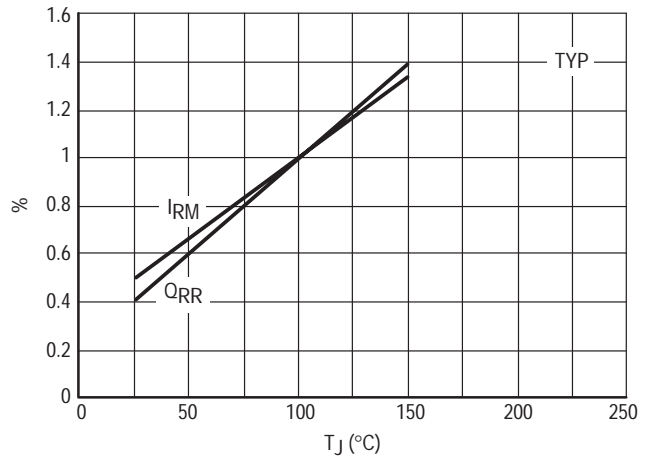


Figure 10. Dynamic Parameters versus Junction Temperature

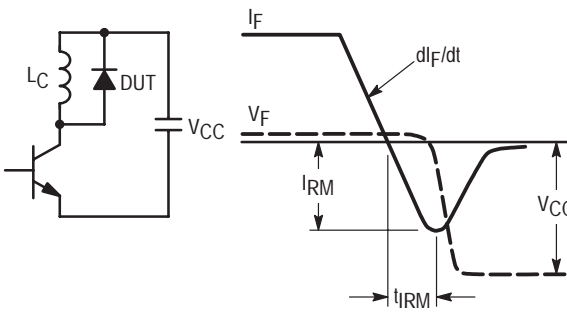


Figure 11. Turn-Off Switching Characteristics (Without series inductance)

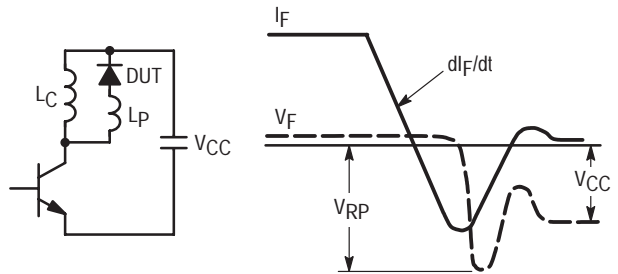
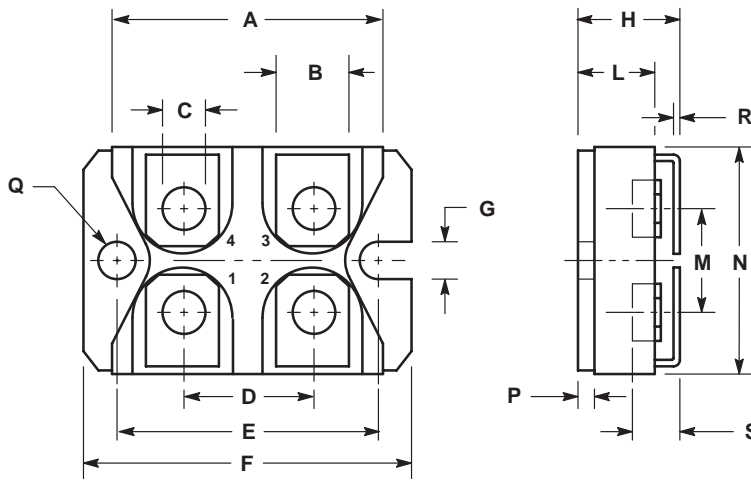


Figure 12. Turn-Off Switching Characteristics (With series inductance)

PACKAGE DIMENSIONS




- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETERS.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	31.50	31.70	1.240	1.248
B	7.80	8.20	0.307	0.322
C	4.10	4.30	0.161	0.169
D	14.90	15.10	0.586	0.590
E	30.10	30.30	1.185	1.193
F	38.00	38.20	1.496	1.503
G	4.00	—	0.157	—
H	11.80	12.20	0.464	0.480
L	8.90	9.10	0.350	0.358
M	12.60	12.80	0.496	0.503
N	25.20	25.40	0.992	1.000
P	1.95	2.05	0.076	0.080
Q	4.10	—	0.157	—
R	0.75	0.85	0.030	0.033
S	5.50	—	0.217	—

Recommended screw torque: 1.3 ± 0.2 Nm
 Maximum screw torque: 1.5 Nm

SOT-227B

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51 Ting Kok Road, Tai Po, N.T., Hong Kong. 852-26629298

HOME PAGE: <http://motorola.com/sps/>



Ultrafast Power Rectifiers

Dual high voltage rectifiers suited for Switchmode Power Supplies and other power converters.

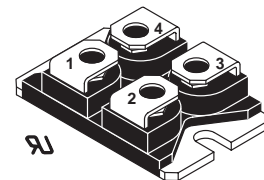
- Very Low Reverse Recovery Time
- Very Low Switching Losses
- Low Noise Turn-Off Switching
- Insulated Package:
Insulating voltage = 2500 V_{RMS}
Capacitance = 45 pF
-  — UL Recognized, File #E69369

Mechanical Characteristics

- Case: Molded epoxy with isolated metal base
- Weight: 28 g (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Shipped 10 units per plastic tube
- Marking: BYT230PIV-1000M

BYT230PIV-1000M

**ULTRAFAST
RECTIFIERS
60 AMPS
1000 VOLTS**



SOT-227B

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	1000	V
Average Rectified Current T _C = 55°C	I _{F(AV)} Per Device Per Diode	60 30	A
Peak Repetitive Forward Current, Per Diode t _p < 10 μs	I _{FRM}	375	A
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I _{FSM}	200	A
Operating Junction Temperature	T _J	-40 to +150	°C
Storage Temperature	T _{stg}	-40 to +150	°C

THERMAL CHARACTERISTICS

Thermal Resistance, Junction to Case	Per Diode	R _{θJC}	1.5	°C/W
Coupling	Per Device	R _{θJC}	0.8	
		R _{θC}	0.1	

ELECTRICAL CHARACTERISTICS PER DIODE

Instantaneous Forward Voltage (1) I _F = 30 A, T _C = 25°C I _F = 30 A, T _C = 100°C	V _F	1.9 1.8	V
Instantaneous Reverse Current (2) V _R = 1000 V, T _C = 25°C V _R = 1000 V, T _C = 100°C	I _R	100 5	μA mA

(1) Pulse Test: Pulse Width = 380 μs, Duty Cycle ≤ 2%

(2) Pulse Test: Pulse Width = 5 ms, Duty Cycle < 2%

BYT230PIV-1000M**RECOVERY CHARACTERISTICS**

Test Conditions	Symbol	Typ	Max	Unit
$I_F = 1 \text{ A}$, $V_R = 30 \text{ V}$, $dI_F/dt = -15 \text{ A}/\mu\text{s}$ $I_F = 0.5 \text{ A}$, $I_R = 1 \text{ A}$, $I_{rr} = 0.25 \text{ A}$	t_{rr}	— —	165 70	ns

TURN-OFF SWITCHING CHARACTERISTICS (without series inductance)

Test Conditions	Symbol	Typ	Max	Unit
$V_{CC} = 200 \text{ V}$, $I_F = 30 \text{ A}$, $T_J = 100^\circ\text{C}$, $L_p < 0.05 \mu\text{H}$ (See Figure 11) $dI_F/dt = -120 \text{ A}/\mu\text{s}$ $dI_F/dt = -240 \text{ A}/\mu\text{s}$	t_{IRM}	— 120	200 —	ns
$dI_F/dt = -120 \text{ A}/\mu\text{s}$ $dI_F/dt = -240 \text{ A}/\mu\text{s}$	I_{RM}	— 22	19.5 —	A

TURN-OFF OVERVOLTAGE COEFFICIENT (with series inductance)

Test Conditions	Symbol	Typ	Max	Unit
$T_J = 100^\circ\text{C}$, $V_{CC} = 200 \text{ V}$, $I_F = I_{F(AV)}$ $dI_F/dt = -30 \text{ A}/\mu\text{s}$, $L_p = 5 \mu\text{H}$ (See Figure 12)	$C = \frac{V_{RP}}{V_{CC}}$	—	4.5	

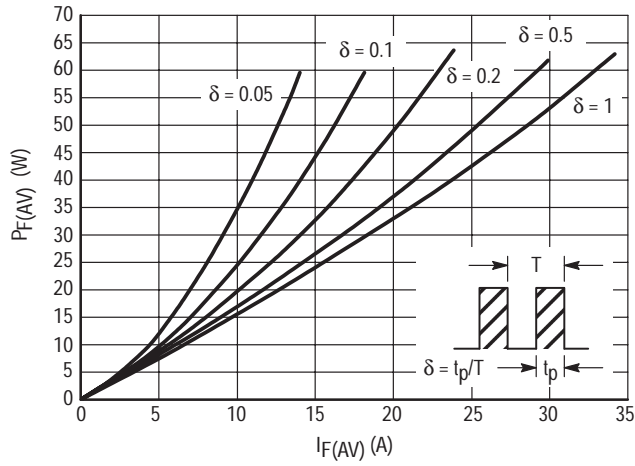


Figure 1. Low Frequency Power Losses versus Average Current

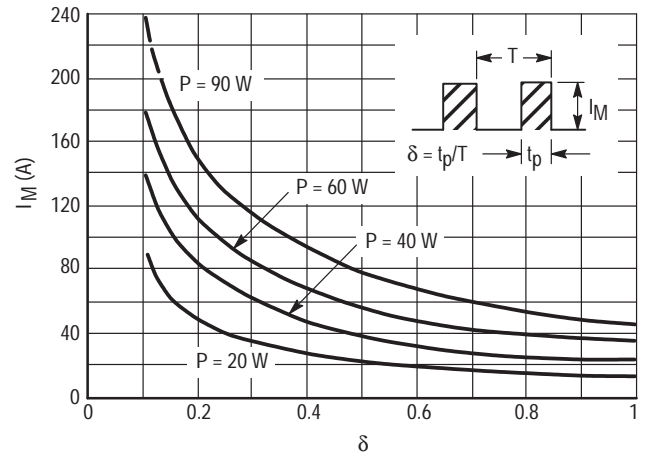


Figure 2. Peak Current versus Form Factor

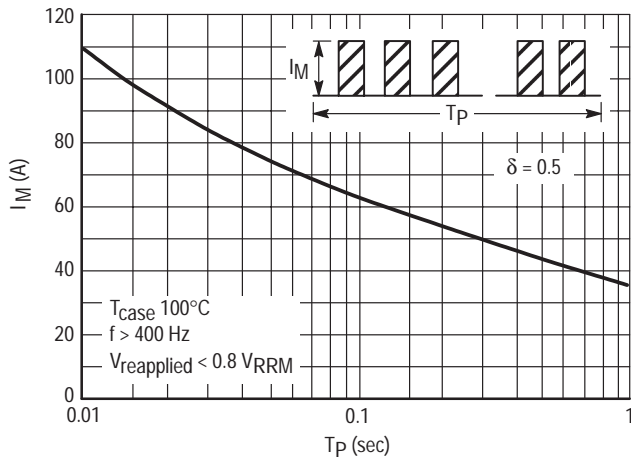


Figure 3. Non-Repetitive Peak Surge Current versus Overload Duration

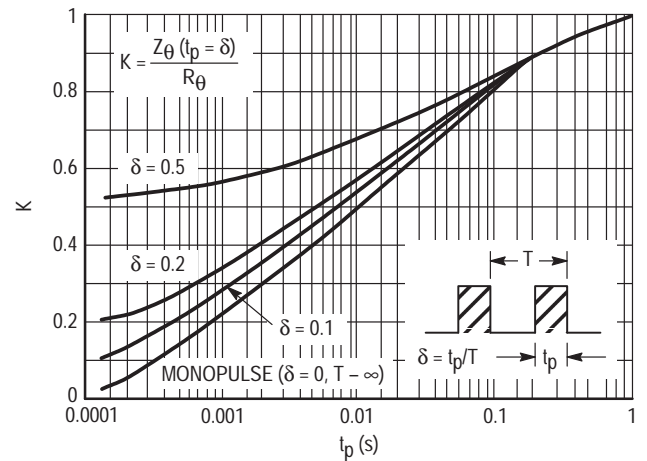


Figure 4. Relative Variation of Thermal Impedance Junction to Case versus Pulse Duration

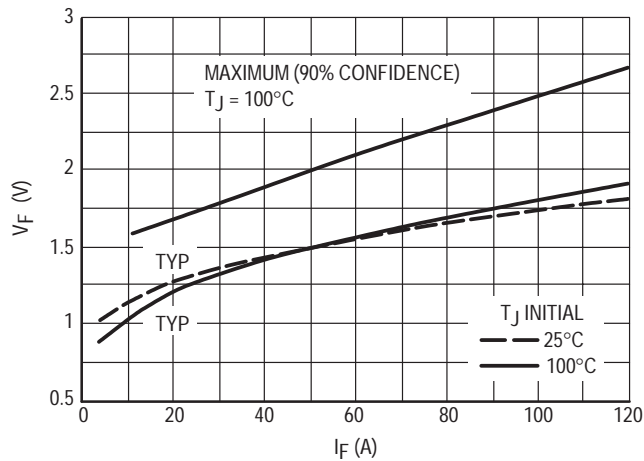


Figure 5. Voltage Drop versus Forward Current

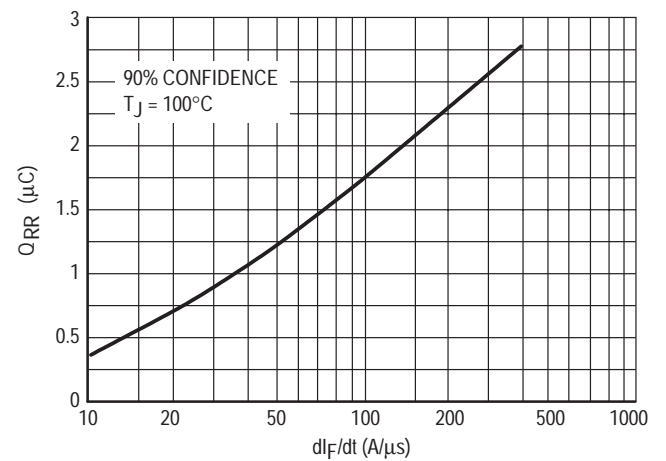


Figure 6. Recovery Charge versus dI_F/dt

BYT230PIV-1000M

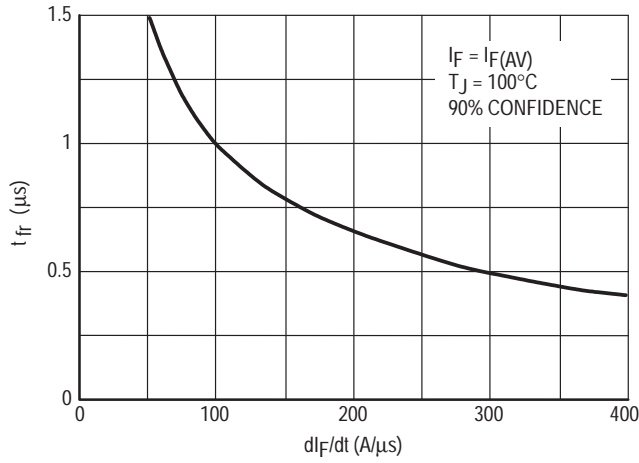


Figure 7. Recovery Time versus dI_F/dt

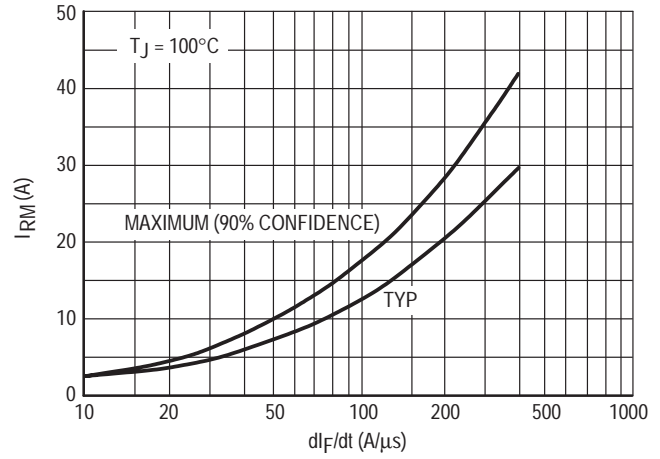


Figure 8. Peak Reverse Current versus dI_F/dt

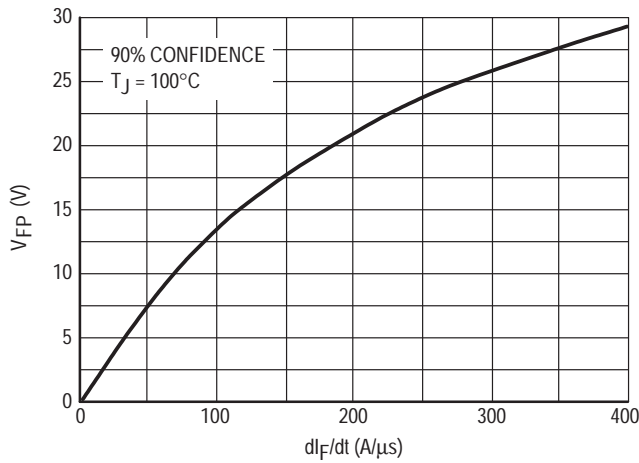


Figure 9. Peak Forward Voltage versus dI_F/dt

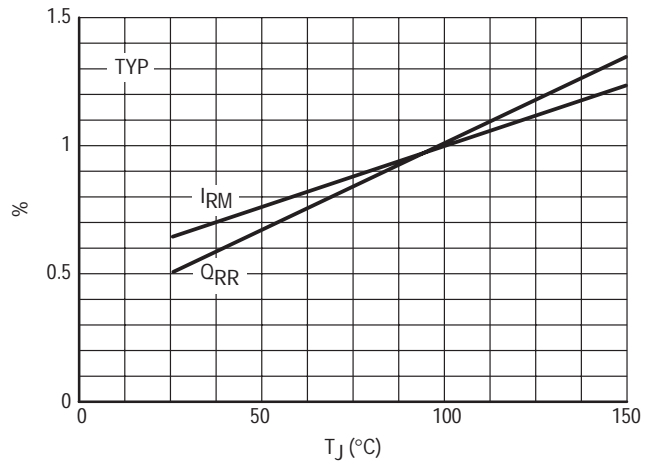


Figure 10. Dynamic Parameters versus Junction Temperature

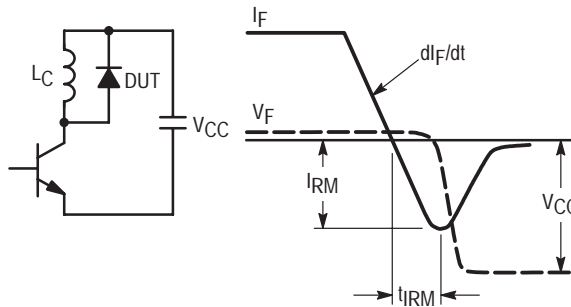


Figure 11. Turn-Off Switching Characteristics (Without series inductance)

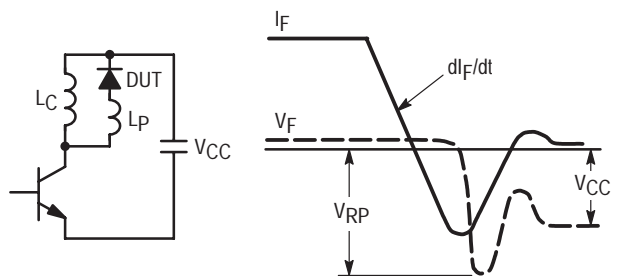



Figure 12. Turn-Off Switching Characteristics (With series inductance)

Ultrafast Power Rectifiers

Dual high voltage rectifiers suited for Switchmode Power Supplies and other power converters.

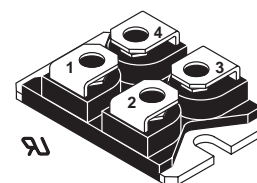
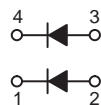
- Very Low Reverse Recovery Time
- Very Low Switching Losses
- Low Noise Turn-Off Switching
- Insulated Package:
Insulating voltage = 2500 V_{RMS}
Capacitance = 45 pF
-  — UL Recognized, File #E69369

Mechanical Characteristics

- Case: Molded epoxy with isolated metal base
- Weight: 28 g (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Shipped 10 units per plastic tube
- Marking: BYT261PIV-400M

BYT261PIV-400M

**ULTRAFAST
RECTIFIERS
120 AMPS
400 VOLTS**



SOT-227B, STYLE 2

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage	V _R RM	400	V
Average Rectified Current T _C = 80°C	I _F (AV) Per Device Per Diode	120 60	A
Peak Repetitive Forward Current, Per Diode t _p < 10 μs	I _F RM	800	A
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I _F SM	600	A
Operating Junction Temperature	T _J	-40 to +150	°C
Storage Temperature	T _{stg}	-40 to +150	°C

THERMAL CHARACTERISTICS

Thermal Resistance, Junction to Case	Per Diode	R _θ JC	0.85	°C/W
Coupling	Per Device	R _θ JC	0.5	
		R _θ C	0.1	

ELECTRICAL CHARACTERISTICS PER DIODE

Instantaneous Forward Voltage (1) I _F = 60 A, T _C = 25°C I _F = 60 A, T _C = 100°C	V _F	1.5 1.4	V
Instantaneous Reverse Current (2) V _R = 400 V, T _C = 25°C V _R = 400 V, T _C = 100°C	I _R	60 6	μA mA

(1) Pulse Test: Pulse Width = 380 μs, Duty Cycle ≤ 2%

(2) Pulse Test: Pulse Width = 5 ms, Duty Cycle < 2%

BYT261PIV-400M**RECOVERY CHARACTERISTICS**

Test Conditions	Symbol	Typ	Max	Unit
$I_F = 1 \text{ A}$, $V_R = 30 \text{ V}$, $dI/dt = -15 \text{ A}/\mu\text{s}$	t_{rr}	—	100	ns
$I_F = 0.5 \text{ A}$, $I_R = 1 \text{ A}$, $I_{rr} = 0.25 \text{ A}$		—	50	

TURN-OFF SWITCHING CHARACTERISTICS (without series inductance)

Test Conditions	Symbol	Typ	Max	Unit
$V_{CC} = 200 \text{ V}$, $I_F = 60 \text{ A}$, $T_J = 100^\circ\text{C}$, $L_p < 0.05 \mu\text{H}$ (See Figure 11) $dI/dt = -240 \text{ A}/\mu\text{s}$ $dI/dt = -480 \text{ A}/\mu\text{s}$	t_{IRM}	—	75	ns
		50	—	
$dI/dt = -240 \text{ A}/\mu\text{s}$ $dI/dt = -480 \text{ A}/\mu\text{s}$	I_{RM}	—	18	A
		24	—	

TURN-OFF OVERVOLTAGE COEFFICIENT (with series inductance)

Test Conditions	Symbol	Typ	Max	Unit
$T_J = 100^\circ\text{C}$, $V_{CC} = 120 \text{ V}$, $I_F = I_{F(AV)}$ $dI/dt = -60 \text{ A}/\mu\text{s}$, $L_p = 0.8 \mu\text{H}$ (See Figure 12)	$C = \frac{V_{RP}}{V_{CC}}$	3.3	4	

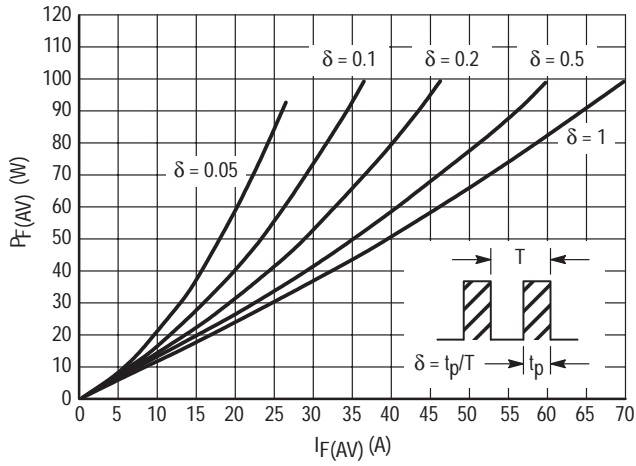


Figure 1. Low Frequency Power Losses versus Average Current

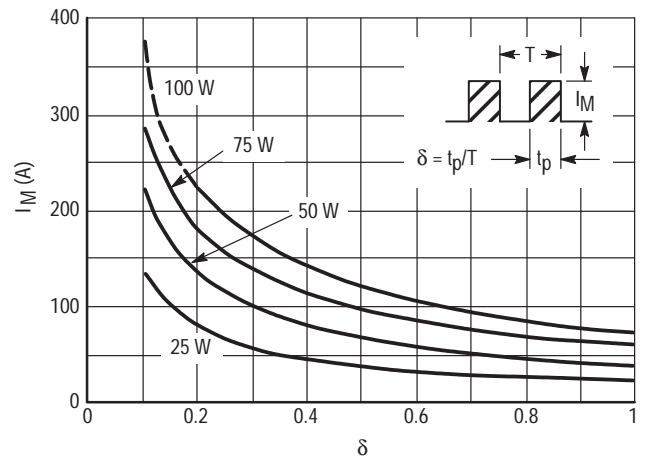


Figure 2. Peak Current versus Form Factor

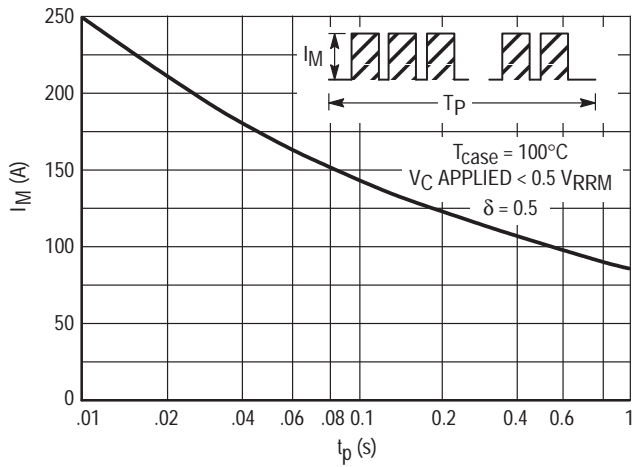


Figure 3. Non-Repetitive Peak Surge Current versus Overload Duration

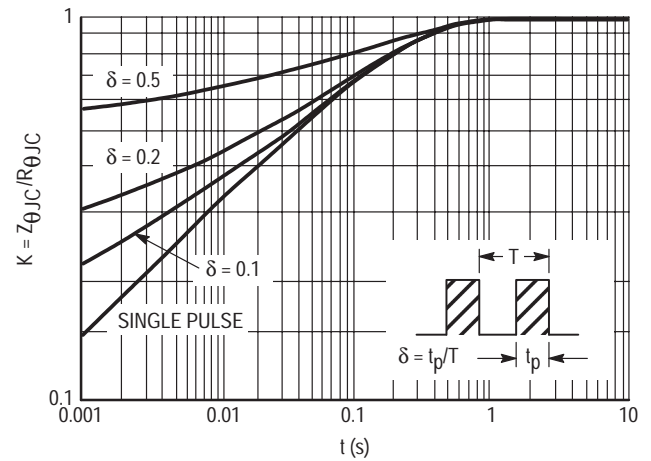


Figure 4. Relative Variation of Thermal Impedance Junction to Case versus Pulse Duration

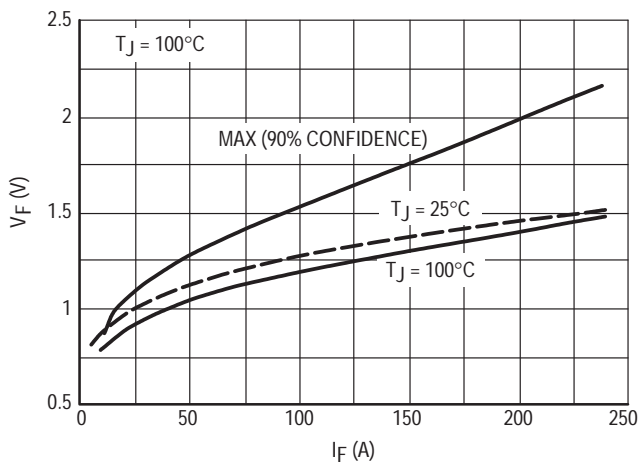


Figure 5. Voltage Drop versus Forward Current

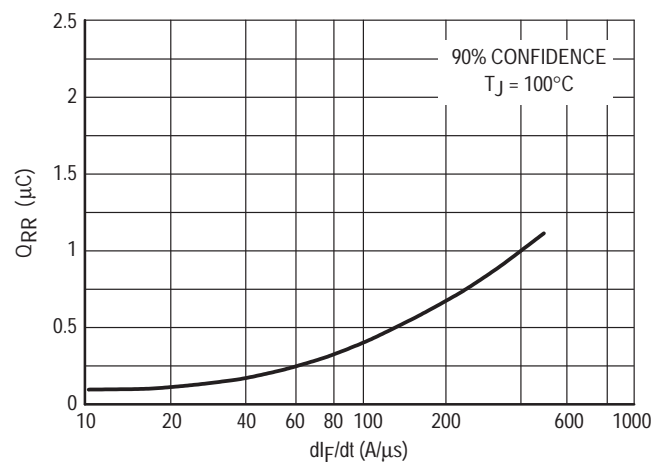


Figure 6. Recovery Charge versus dI_F/dt

BYT261PIV-400M

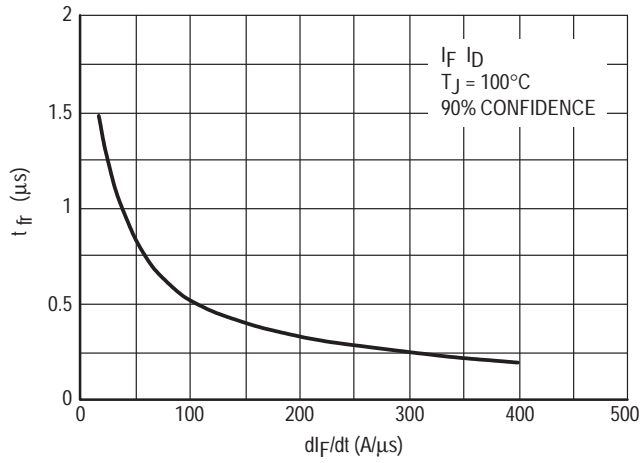


Figure 7. Recovery Time versus dI_F/dt

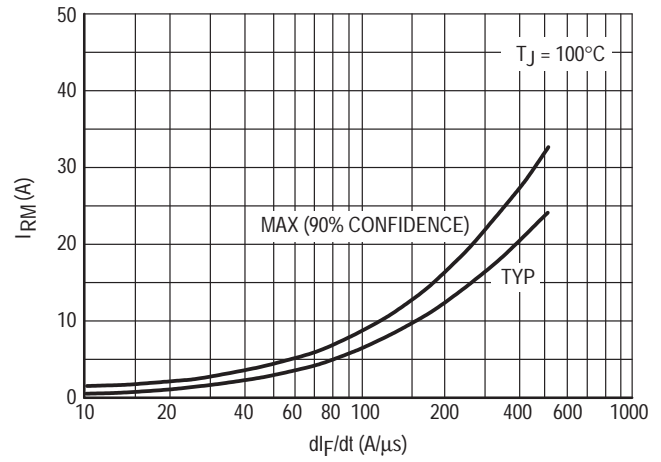


Figure 8. Peak Reverse Current versus dI_F/dt

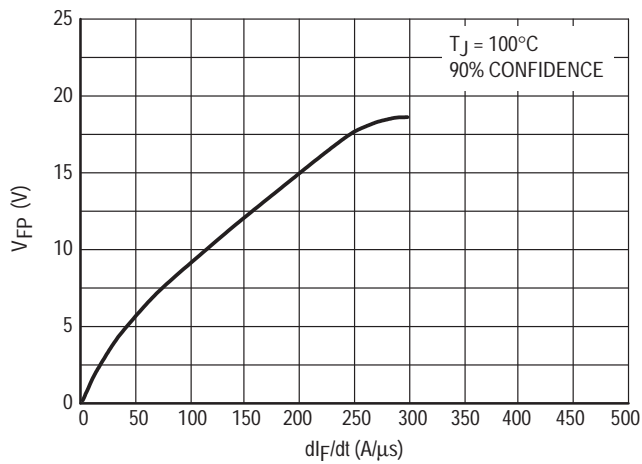


Figure 9. Peak Forward Voltage versus dI_F/dt

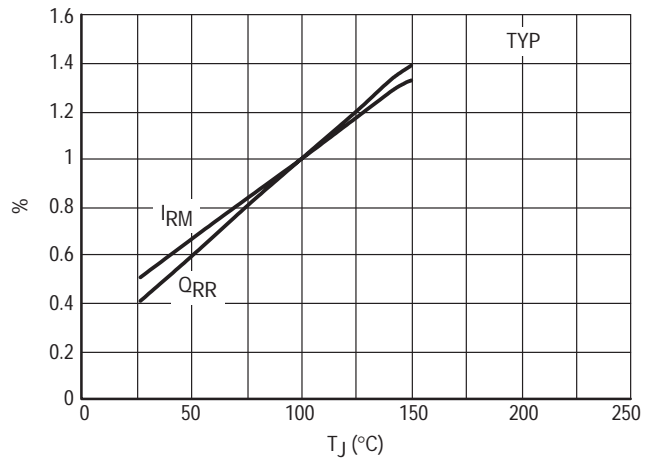


Figure 10. Dynamic Parameters versus Junction Temperature

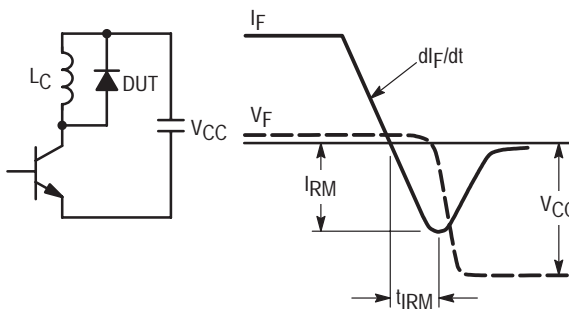


Figure 11. Turn-Off Switching Characteristics (Without series inductance)

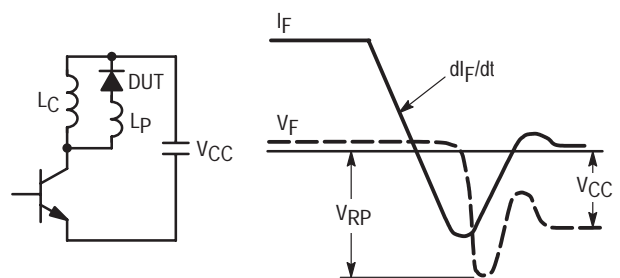



Figure 12. Turn-Off Switching Characteristics (With series inductance)

Ultrafast Power Rectifiers

Dual high voltage rectifiers suited for Switchmode Power Supplies and other power converters.

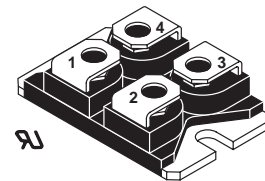
- Very Low Reverse Recovery Time
- Very Low Switching Losses
- Low Noise Turn-Off Switching
- Insulated Package:
Insulating voltage = 2500 V_{RMS}
Capacitance = 45 pF
-  — UL Recognized, File #E69369

Mechanical Characteristics

- Case: Molded epoxy with isolated metal base
- Weight: 28 g (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Shipped 10 units per plastic tube
- Marking: BYT261PIV-1000M

BYT261PIV-1000M

**ULTRAFAST
RECTIFIERS
120 AMPS
1000 VOLTS**



SOT-227B, STYLE 2

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage	V _R RM	1000	V
Average Rectified Current T _C = 60°C	I _F (AV) Per Device Per Diode	120 60	A
Peak Repetitive Forward Current, Per Diode t _p < 10 μs	I _F RM	750	A
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I _F SM	400	A
Operating Junction Temperature	T _J	-40 to +150	°C
Storage Temperature	T _{stg}	-40 to +150	°C

THERMAL CHARACTERISTICS

Thermal Resistance, Junction to Case	Per Diode	R _θ JC	1.1	°C/W
Coupling	Per Device	R _θ JC	0.6	
		R _θ C	0.1	

ELECTRICAL CHARACTERISTICS PER DIODE

Instantaneous Forward Voltage (1) I _F = 60 A, T _C = 25°C I _F = 60 A, T _C = 100°C	V _F	1.9 1.8	V
Instantaneous Reverse Current (2) V _R = 1000 V, T _C = 25°C V _R = 1000 V, T _C = 100°C	I _R	100 6	μA mA

- (1) Pulse Test: Pulse Width = 380 μs, Duty Cycle ≤ 2%
(2) Pulse Test: Pulse Width = 5 ms, Duty Cycle < 2%

BYT261PIV-1000M**RECOVERY CHARACTERISTICS**

Test Conditions	Symbol	Typ	Max	Unit
$I_F = 1\text{ A}$, $V_R = 30\text{ V}$, $dI_F/dt = -15\text{ A}/\mu\text{s}$ $I_F = 0.5\text{ A}$, $I_R = 1\text{ A}$, $I_{rr} = 0.25\text{ A}$	t_{rr}	— —	170 70	ns

TURN-OFF SWITCHING CHARACTERISTICS (without series inductance)

Test Conditions	Symbol	Typ	Max	Unit
$V_{CC} = 200\text{ V}$, $I_F = 60\text{ A}$, $T_J = 100^\circ\text{C}$, $L_p < 0.05\text{ }\mu\text{H}$ (See Figure 11) $dI_F/dt = -240\text{ A}/\mu\text{s}$ $dI_F/dt = -480\text{ A}/\mu\text{s}$	t_{IRM}	— 120	200 —	ns
$dI_F/dt = -240\text{ A}/\mu\text{s}$ $dI_F/dt = -480\text{ A}/\mu\text{s}$	I_{RM}	— 44	40 —	A

TURN-OFF OVERVOLTAGE COEFFICIENT (with series inductance)

Test Conditions	Symbol	Typ	Max	Unit
$T_J = 100^\circ\text{C}$, $V_{CC} = 200\text{ V}$, $I_F = I_{F(AV)}$ $dI_F/dt = -60\text{ A}/\mu\text{s}$, $L_p = 2.5\text{ }\mu\text{H}$ (See Figure 12)	$C = \frac{V_{RP}}{V_{CC}}$	3.3	4.5	

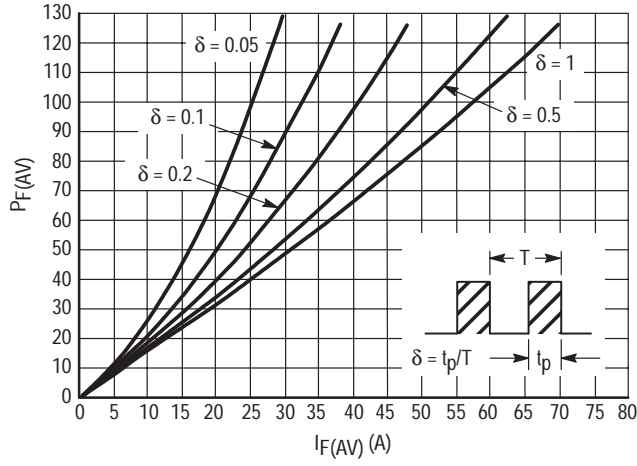


Figure 1. Low Frequency Power Losses versus Average Current

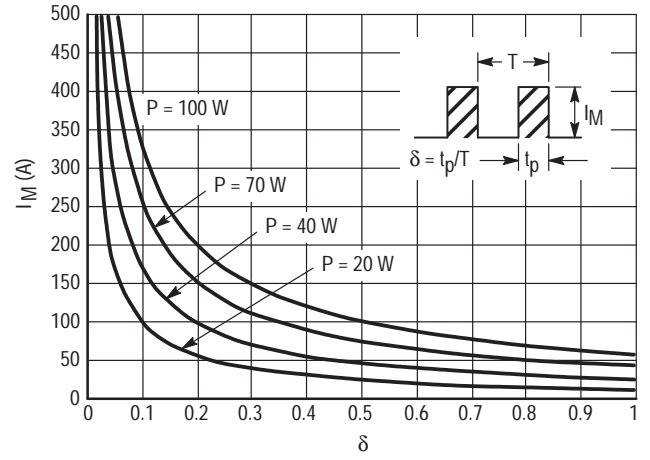


Figure 2. Peak Current versus Form Factor

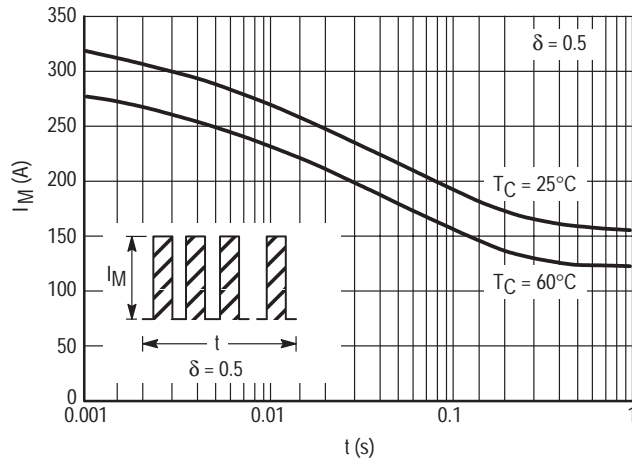


Figure 3. Non-Repetitive Peak Surge Current versus Overload Duration

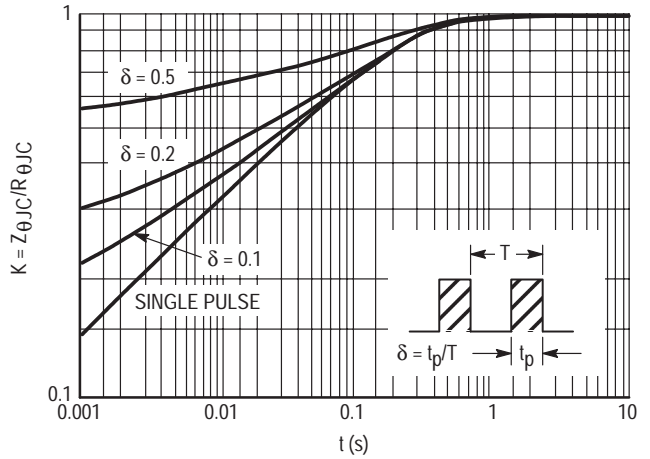


Figure 4. Relative Variation of Thermal Impedance Junction to Case versus Pulse Duration

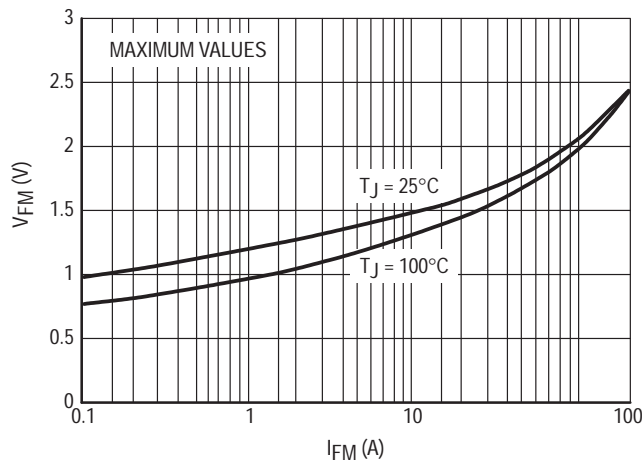


Figure 5. Voltage Drop versus Forward Current

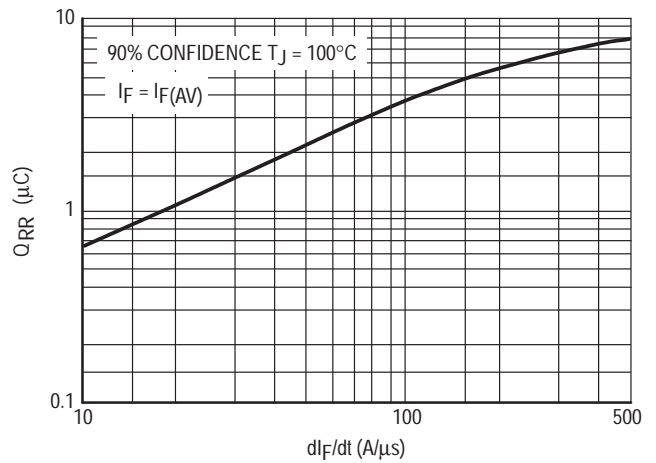


Figure 6. Recovery Charge versus di_F/dt

BYT261PIV-1000M

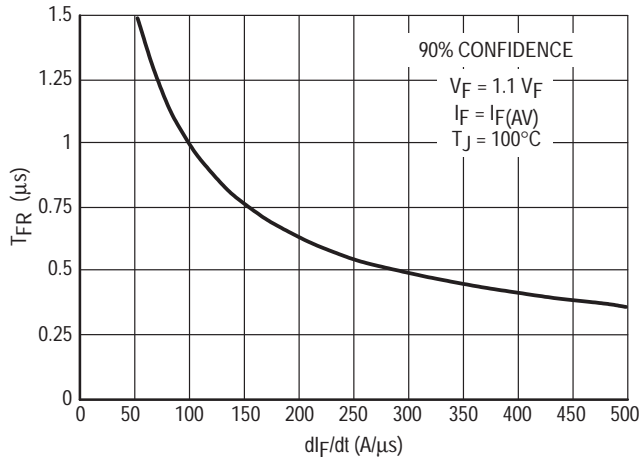


Figure 7. Recovery Time versus dI_F/dt

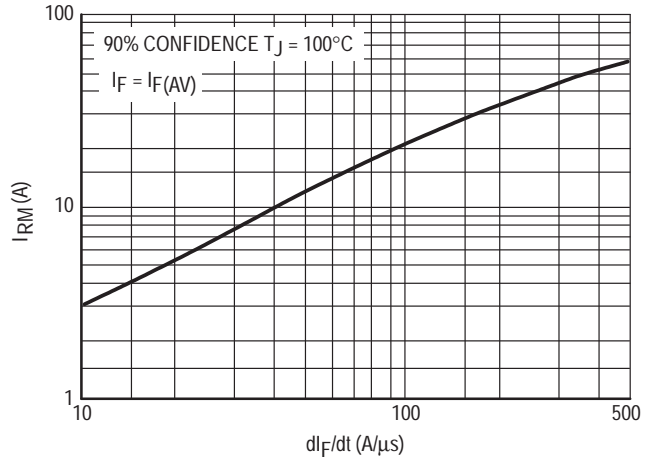


Figure 8. Peak Reverse Current versus dI_F/dt

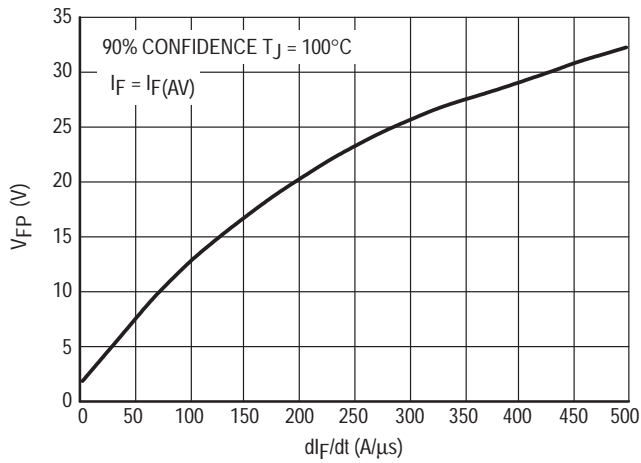


Figure 9. Peak Forward Voltage versus dI_F/dt

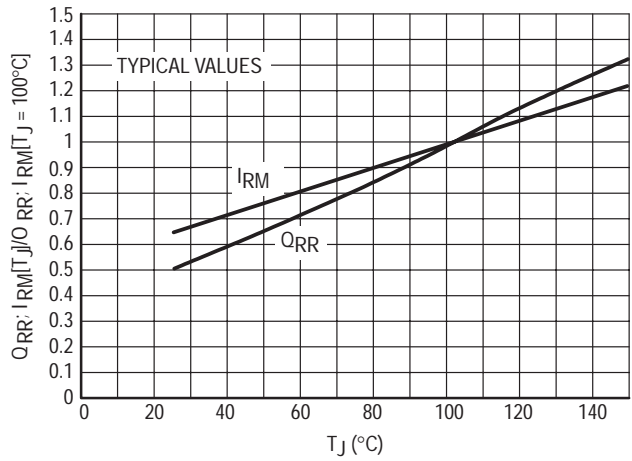


Figure 10. Dynamic Parameters versus Junction Temperature

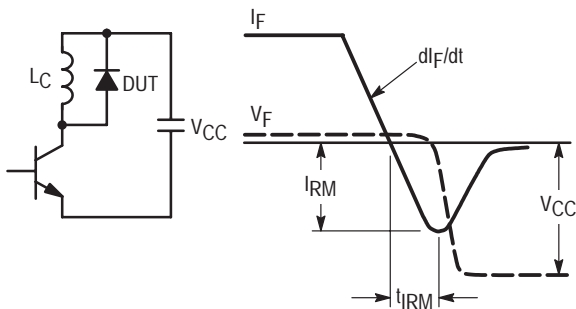


Figure 11. Turn-Off Switching Characteristics (Without series inductance)

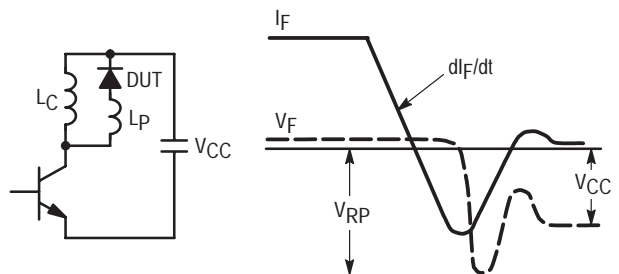


Figure 12. Turn-Off Switching Characteristics (With series inductance)

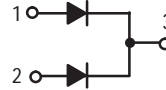
Preliminary Data Sheet
POWERTAP II Ultrafast
SWITCHMODE™ Power Rectifiers

. . . designed for use in switching power supplies, inverters, and as free wheeling diodes. These state-of-the-art devices have the following features:

- Dual Diode Construction
- Low Leakage Current
- Low Forward Voltage
- 175°C Operating Junction Temperature
- Labor Saving POWERTAP Package

Mechanical Characteristics:

- Case: Epoxy, Molded with metal heatsink base
- Weight: 80 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Top Terminal Torque: 25–40 lb-in max
- Base Plate Torques: See procedure given in the Package Outline Section
- Shipped 25 units per foam
- Marking: UP20020



MURP20020CT
MURP20040CT
Motorola Preferred Devices

ULTRAFAST
RECTIFIERS
200 AMPERES
200–400 VOLTS

CASE 357C-03
POWERTAP II

MAXIMUM RATINGS

Rating	Symbol	MURP20020CT	MURP20040CT	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	200	400	Volts
Average Rectified Forward Current (Rated V_R)	$I_{F(AV)}$ Per Device Per Leg	200 ($T_C = 130^\circ\text{C}$) 100 ($T_C = 130^\circ\text{C}$)	200 ($T_C = 100^\circ\text{C}$) 100 ($T_C = 100^\circ\text{C}$)	Amps
Peak Repetitive Forward Current, Per Leg (Rated V_R , Square Wave, 20 kHz), $T_C = 95^\circ\text{C}$	I_{FRM}	200	200	Amps
Nonrepetitive Peak Surge Current Per Leg (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	800	800	Amps
Operating Junction Temperature	T_J	-55 to +175	-55 to +175	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55 to +150	-55 to +150	$^\circ\text{C}$

THERMAL CHARACTERISTICS PER LEG

Rating	Symbol	Max		Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.45	0.45	$^\circ\text{C/W}$

ELECTRICAL CHARACTERISTICS PER LEG

Instantaneous Forward Voltage (1) ($i_F = 100$ Amps, $T_C = +25^\circ\text{C}$) ($i_F = 200$ Amps, $T_C = 25^\circ\text{C}$) ($i_F = 100$ Amps, $T_C = 125^\circ\text{C}$)	V_F	1.00 1.10 0.95	1.30 1.75 1.15	Volts
Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$) (Rated dc Voltage, $T_C = 25^\circ\text{C}$)	i_R	1000 150	500 50	μA
Maximum Reverse Recovery Time ($I_F = 1.0$ Amp, $di/dt = 50$ Amps/ μs)	t_{rr}	50	75	ns

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

This document contains information on a product under development. Motorola reserves the right to change or discontinue this product without notice.

Preferred devices are Motorola recommended choices for future use and best overall value.

Section 5

Standard and Fast Recovery Data Sheets

Axial Lead Standard Recovery Rectifiers

This data sheet provides information on subminiature size, axial lead mounted rectifiers for general-purpose low-power applications.

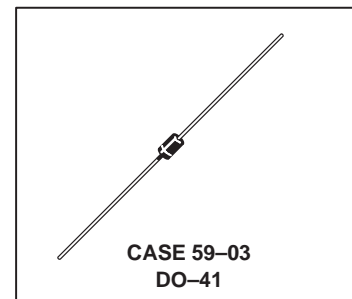
Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 1000 per bag.
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: 1N4001, 1N4002, 1N4003, 1N4004, 1N4005, 1N4006, 1N4007

**1N4001
thru
1N4007**

1N4004 and 1N4007 are
Motorola Preferred Devices

**LEAD MOUNTED
RECTIFIERS
50–1000 VOLTS
DIFFUSED JUNCTION**



MAXIMUM RATINGS

Rating	Symbol	1N4001	1N4002	1N4003	1N4004	1N4005	1N4006	1N4007	Unit
*Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	50	100	200	400	600	800	1000	Volts
*Non–Repetitive Peak Reverse Voltage (halfwave, single phase, 60 Hz)	V_{RSM}	60	120	240	480	720	1000	1200	Volts
*RMS Reverse Voltage	$V_R(RMS)$	35	70	140	280	420	560	700	Volts
*Average Rectified Forward Current (single phase, resistive load, 60 Hz, see Figure 8, $T_A = 75^\circ C$)	I_O	1.0							Amp
*Non–Repetitive Peak Surge Current (surge applied at rated load conditions, see Figure 2)	I_{FSM}	30 (for 1 cycle)							Amp
Operating and Storage Junction Temperature Range	T_J T_{stg}	– 65 to +175							°C

ELECTRICAL CHARACTERISTICS*

Rating	Symbol	Typ	Max	Unit
Maximum Instantaneous Forward Voltage Drop ($i_F = 1.0$ Amp, $T_J = 25^\circ C$) Figure 1	V_F	0.93	1.1	Volts
Maximum Full–Cycle Average Forward Voltage Drop ($I_O = 1.0$ Amp, $T_L = 75^\circ C$, 1 inch leads)	$V_F(AV)$	—	0.8	Volts
Maximum Reverse Current (rated dc voltage) ($T_J = 25^\circ C$) ($T_J = 100^\circ C$)	I_R	0.05 1.0	10 50	μA
Maximum Full–Cycle Average Reverse Current ($I_O = 1.0$ Amp, $T_L = 75^\circ C$, 1 inch leads)	$I_R(AV)$	—	30	μA

*Indicates JEDEC Registered Data

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 5

Axial-Lead Fast-Recovery Rectifiers

Axial-lead, fast-recovery rectifiers are designed for special applications such as dc power supplies, inverters, converters, ultrasonic systems, choppers, low RF interference and free wheeling diodes. A complete line of fast recovery rectifiers having typical recovery time of 150 nanoseconds providing high efficiency at frequencies to 250 kHz.

Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 1000 per bag.
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: 1N4933, 1N4934, 1N4935, 1N4936, 1N4937

**1N4933
thru
1N4937**

1N4935 and 1N4937 are
Motorola Preferred Devices

**FAST RECOVERY
RECTIFIERS
50-600 VOLTS
1.0 AMPERE**



CASE 59-03
DO-41

MAXIMUM RATINGS (1)

Rating	Symbol	1N4933	1N4934	1N4935	1N4936	1N4937	Unit
*Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	50	100	200	400	600	Volts
*Non-Repetitive Peak Reverse Voltage RMS Reverse Voltage	V_{RSM} $V_{R(RMS)}$	75 35	150 70	250 140	450 280	650 420	Volts
*Average Rectified Forward Current (Single phase, resistive load, $T_A = 75^\circ\text{C}$) (2)	I_O	1.0					Amp
*Non-Repetitive Peak Surge Current (Surge applied at rated load conditions)	I_{FSM}	30					Amps
Operating Junction Temperature Range Storage Temperature Range	T_J T_{stg}	- 65 to +150 - 65 to +150					$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient (Typical Printed Circuit Board Mounting)	$R_{\theta JC}$	65	$^\circ\text{C/W}$

* Indicates JEDEC Registered Data for 1N4933 Series.

(1) Ratings at 25°C ambient temperature unless otherwise specified.

(2) Derate by 20% for capacitive loads.

Preferred devices are Motorola recommended choices for future use and best overall value.

1N4933 thru 1N4937**ELECTRICAL CHARACTERISTICS**

Characteristic	Symbol	Min	Typ	Max	Unit
Instantaneous Forward Voltage ($I_F = 3.14$ Amp, $T_J = 125^\circ\text{C}$)	v_F	—	1.0	1.2	Volts
Forward Voltage ($I_F = 1.0$ Amp, $T_A = 25^\circ\text{C}$)	V_F	—	1.0	1.1	Volts
*Reverse Current (Rated dc Voltage) $T_A = 25^\circ\text{C}$ $T_A = 100^\circ\text{C}$	I_R	— —	1.0 50	5.0 100	μA

***REVERSE RECOVERY CHARACTERISTICS**

Characteristic	Symbol	Min	Typ	Max	Unit
Reverse Recovery Time ($I_F = 1.0$ Amp to $V_R = 30$ Vdc) ($I_{FM} = 15$ Amp, $di/dt = 10$ A/ μs)	t_{rr}	— —	150 175	200 300	ns
Reverse Recovery Current ($I_F = 1.0$ Amp to $V_R = 30$ Vdc)	$I_{RM(REC)}$	—	1.0	2.0	Amp

* Indicates JEDEC Registered Data for 1N4933 Series.

Axial-Lead Standard Recovery Rectifiers

Lead mounted standard recovery rectifiers are designed for use in power supplies and other applications having need of a device with the following features:

- High Current to Small Size
- High Surge Current Capability
- Low Forward Voltage Drop
- Void-Free Economical Plastic Package
- Available in Volume Quantities

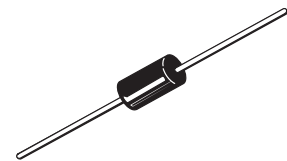
Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 5,000 per bag.
- Available Tape and Reeled, 1500 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: 1N5400, 1N5401, 1N5402, 1N5404, 1N5406, 1N5407, 1N5408

**1N5400
thru
1N5408**

1N5404 and 1N5406 are
Motorola Preferred Devices

**STANDARD
RECOVERY RECTIFIERS
50–1000 VOLTS
3.0 AMPERE**



CASE 267-03

MAXIMUM RATINGS

Rating	Symbol	1N5400	1N5401	1N5402	1N5404	1N5406	1N5407	1N5408	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	50	100	200	400	600	800	1000	Volts
Non-repetitive Peak Reverse Voltage	V_{RSM}	100	200	300	525	800	1000	1200	Volts
Average Rectified Forward Current (Single Phase Resistive Load, 1/2" Leads, $T_L = 105^\circ\text{C}$)	I_O	3.0							Amp
Non-repetitive Peak Surge Current (Surge Applied at Rated Load Conditions)	I_{FSM}	200 (one cycle)							Amp
Operating and Storage Junction Temperature Range	T_J T_{stg}	– 65 to +170 – 65 to +175							°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Typ	Unit
Thermal Resistance, Junction to Ambient (PC Board Mount, 1/2" Leads)	$R_{\theta JA}$	53	°C/W

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Min	Typ	Max	Unit
*Instantaneous Forward Voltage (1) ($i_F = 9.4$ Amp)	v_F	—	—	1.2	Volts
Average Reverse Current (1) DC Reverse Current (Rated dc Voltage, $T_L = 80^\circ\text{C}$)	$I_{R(AV)}$ I_R	—	—	500 500	μA

* JEDEC Registered Data.

(1) Measured in a single phase halfwave circuit such as shown in Figure 6.25 of EIA RS–282, November 1963. Operated at rated load conditions
 $T_L = 80^\circ\text{C}$, $I_O = 3.0$ A, $V_r = V_{RWM}$.

Preferred devices are Motorola recommended choices for future use and best overall value.

Ratings at 25°C ambient temperature unless otherwise specified.

60 Hz resistive or inductive loads.

For capacitive load, derate current by 20%.

Rev 2

Axial Lead Fast Recovery Rectifiers

Axial lead mounted fast recovery power rectifiers are designed for special applications such as dc power supplies, inverters, converters, ultrasonic systems, choppers, low RF interference and free wheeling diodes. A complete line of fast recovery rectifiers having typical recovery time of 100 nanoseconds providing high efficiency at frequencies to 250 kHz.

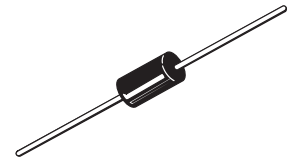
Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 5,000 per bag.
- Available Tape and Reeled, 1500 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: R850, R851, R852, R854, R856

MR850
MR851
MR852
MR854
MR856

MR852 and MR856 are
Motorola Preferred Devices

FAST RECOVERY
POWER RECTIFIERS
50–600 VOLTS
3.0 AMPERES



CASE 267-03

MAXIMUM RATINGS

Rating	Symbol	MR850	MR851	MR852	MR854	MR856	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	50	100	200	400	600	Volts
Non-Repetitive Peak Reverse Voltage	V_{RSM}	75	150	250	450	650	Volts
RMS Reverse Voltage	$V_{R(RMS)}$	35	70	140	280	420	Volts
Average Rectified Forward Current (Single phase resistive load, $T_A = 80^\circ\text{C}$)	I_O	3.0					Amp
Non-Repetitive Peak Surge Current (surge applied at rated load conditions)	I_{FSM}	100 (one cycle)					Amp
Operating and Storage Junction Temperature Range	T_J , T_{stg}	– 65 to +125 – 65 to +150					$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient (Recommended Printed Circuit Board Mounting, See Note 4, Page 5)	$R_{\theta JA}$	28	$^\circ\text{C/W}$

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 2

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Min	Typ	Max	Unit
Forward Voltage ($I_F = 3.0$ Amp, $T_J = 25^\circ\text{C}$)	V_F	—	1.04	1.25	Volts
Reverse Current (rated dc voltage) $T_J = 25^\circ\text{C}$	I_R	—	2.0	10	μA
$T_J = 80^\circ\text{C}$ <ul style="list-style-type: none"> MR850 MR851 MR852 MR854 MR856 		—	—	150	
		—	60	150	
		—	—	200	
		—	—	250	
		—	100	300	

REVERSE RECOVERY CHARACTERISTICS

Characteristic	Symbol	Min	Typ	Max	Unit
Reverse Recovery Time ($I_F = 1.0$ Amp to $V_R = 30$ Vdc, Figure 9) ($I_F = 15$ Amp, $di/dt = 10$ A/ μs , Figure 10)	t_{rr}	—	100 150	200 300	ns
Reverse Recovery Current ($I_F = 1.0$ Amp to $V_R = 30$ Vdc, Figure 9)	$I_{RM(REC)}$	—	—	2.0	Amp

Designer's™ Data Sheet

High Current Lead Mounted Rectifiers

- Current Capacity Comparable to Chassis Mounted Rectifiers
- Very High Surge Capacity
- Insulated Case

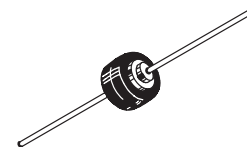
Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 2.5 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Cathode Polarity Band
- Shipped 1000 units per plastic bag. Available Tape and Reeled, 800 units per reel by adding a "RL" suffix to the part number
- Marking: R750, R751, R752, R754, R758, R760

MR750
MR751
MR752
MR754
MR756
MR758
MR760

MR754 and MR760 are
Motorola Preferred Devices

**HIGH CURRENT
LEAD MOUNTED
SILICON RECTIFIERS
50–1000 VOLTS
DIFFUSED JUNCTION**



CASE 194-04

MAXIMUM RATINGS

Characteristic	Symbol	MR750	MR751	MR752	MR754	MR756	MR758	MR760	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	50	100	200	400	600	800	1000	Volts
Non-Repetitive Peak Reverse Voltage (Halfwave, single phase, 60 Hz peak)	V_{RSM}	60	120	240	480	720	960	1200	Volts
RMS Reverse Voltage	$V_{R(RMS)}$	35	70	140	280	420	560	700	Volts
Average Rectified Forward Current (Single phase, resistive load, 60 Hz) See Figures 5 and 6	I_O	← 22 ($T_L = 60^\circ\text{C}$, 1/8" Lead Lengths) 6.0 ($T_A = 60^\circ\text{C}$, P.C. Board mounting) →							Amps
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions)	I_{FSM}	← 400 (for 1 cycle) →							Amps
Operating and Storage Junction Temperature Range	T_J, T_{stg}	← -65 to +175 →							°C

ELECTRICAL CHARACTERISTICS

Characteristic and Conditions	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage Drop ($I_F = 100$ Amps, $T_J = 25^\circ\text{C}$)	V_F	1.25	Volts
Maximum Forward Voltage Drop ($I_F = 6.0$ Amps, $T_A = 25^\circ\text{C}$, 3/8" leads)	V_F	0.90	Volts
Maximum Reverse Current (Rated dc Voltage)	I_R	25 1.0	μA mA
			$T_J = 25^\circ\text{C}$ $T_J = 100^\circ\text{C}$

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 2

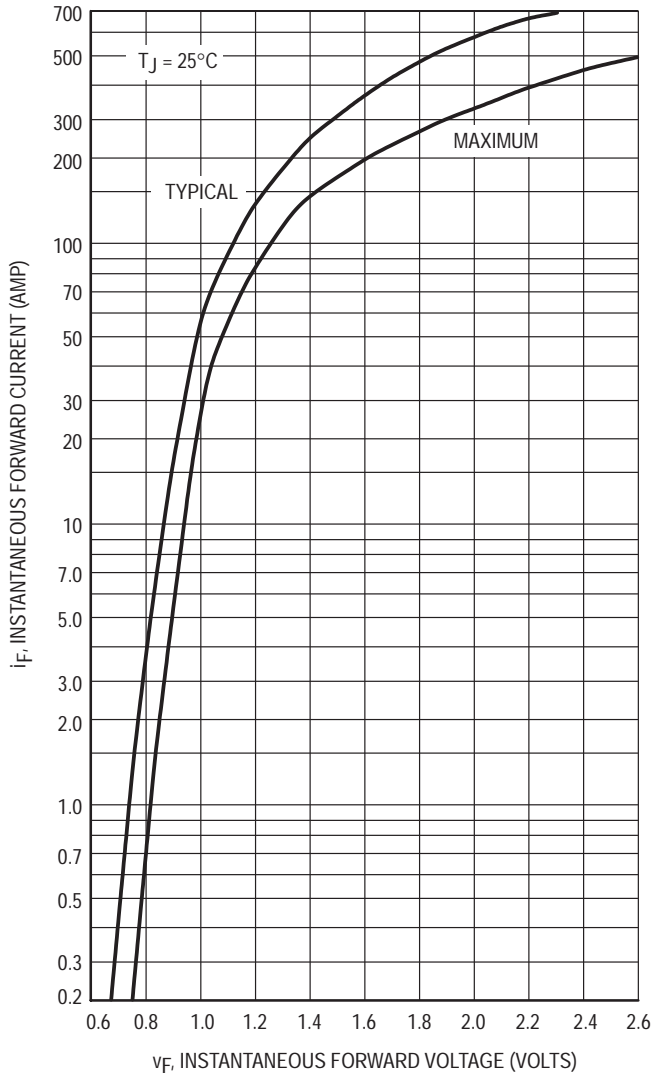


Figure 1. Forward Voltage

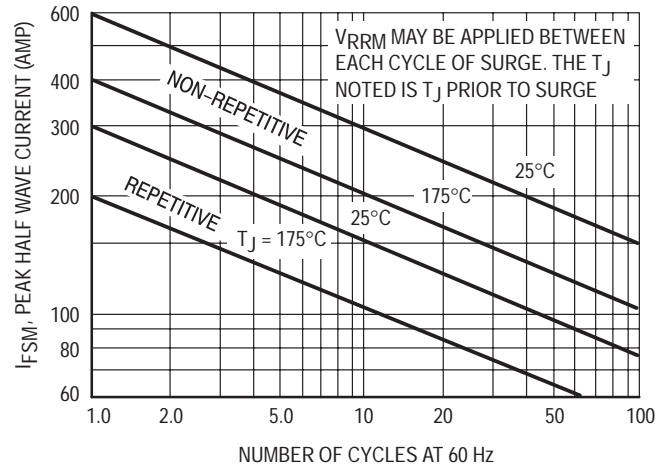


Figure 2. Maximum Surge Capability

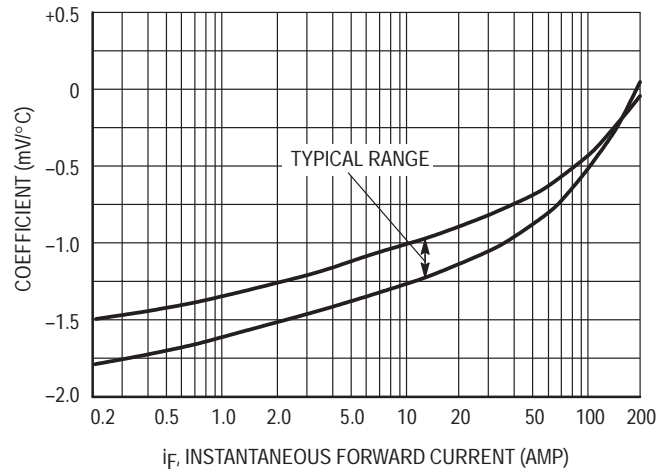


Figure 3. Forward Voltage Temperature Coefficient

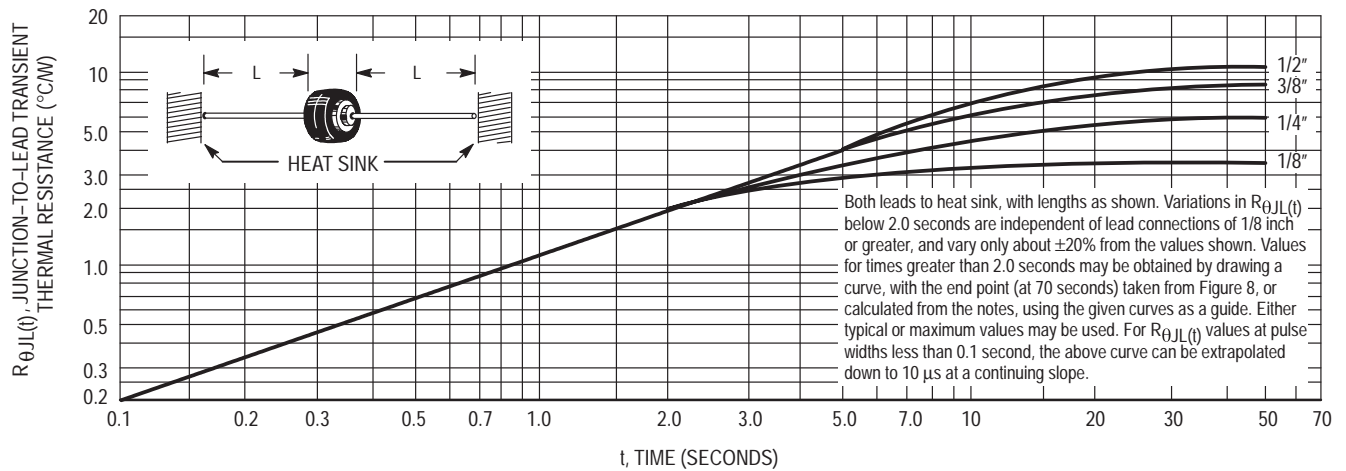


Figure 4. Typical Transient Thermal Resistance

MR750 MR751 MR752 MR754 MR756 MR758 MR760

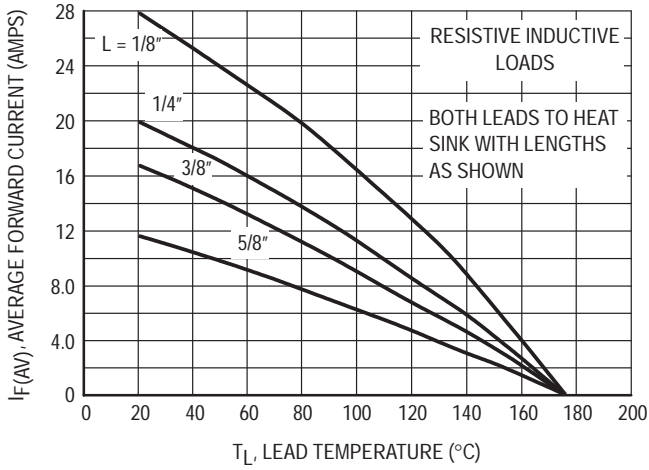


Figure 5. Maximum Current Ratings

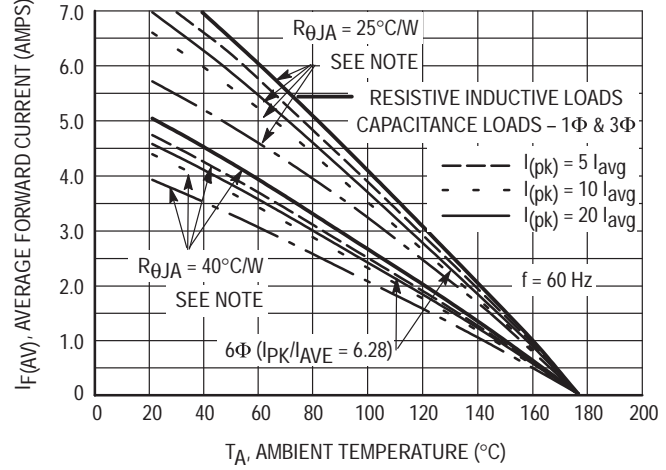


Figure 6. Maximum Current Ratings

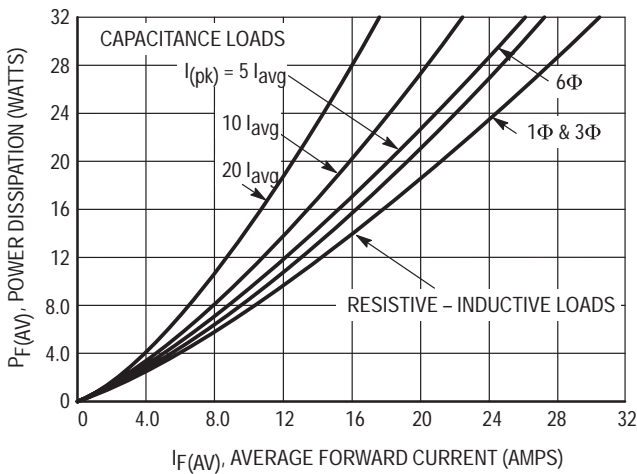


Figure 7. Power Dissipation

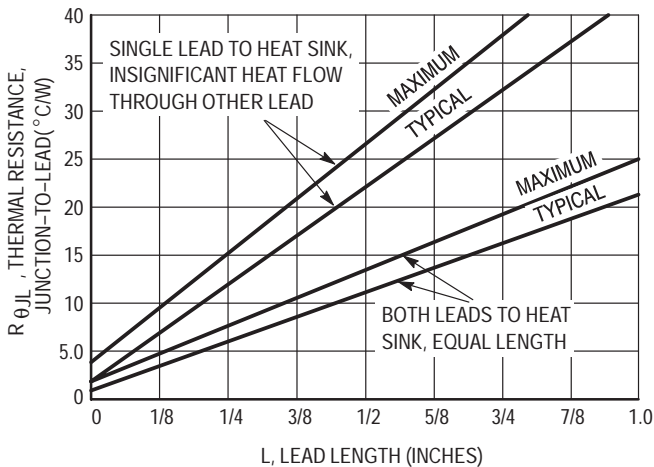
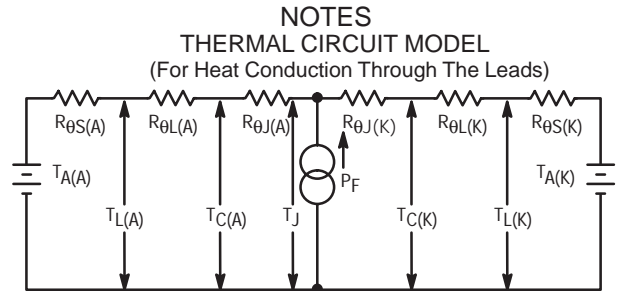


Figure 8. Steady State Thermal Resistance



Use of the above model permits junction to lead thermal resistance for any mounting configuration to be found. Lowest values occur when one side of the rectifier is brought as close as possible to the heat sink as shown below. Terms in the model signify:

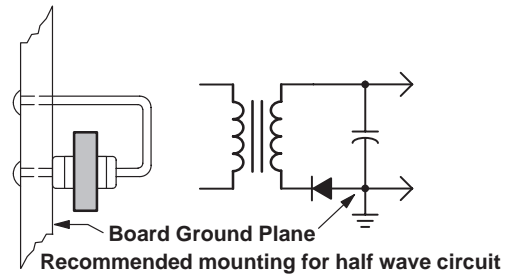
- T_A = Ambient Temperature
- T_C = Case Temperature
- T_L = Lead Temperature
- T_J = Junction Temperature
- $R_{\theta S}$ = Thermal Resistance, Heat Sink to Ambient
- $R_{\theta L}$ = Thermal Resistance, Lead to Heat Sink
- $R_{\theta J}$ = Thermal Resistance, Junction to Case
- P_F = Power Dissipation

(Subscripts A and K refer to anode and cathode sides, respectively.)

Values for thermal resistance components are:
 $R_{\theta L} = 40^\circ\text{C/W/in.}$ Typically and 44°C/W/in. Maximum.
 $R_{\theta J} = 2^\circ\text{C/W}$ typically and 4°C/W Maximum.

Since $R_{\theta J}$ is so low, measurements of the case temperature, T_C , will be approximately equal to junction temperature in practical lead mounted applications. When used as a 60 Hz rectifier the slow thermal response holds $T_{J(pk)}$ close to $T_{J(av)}$. Therefore maximum lead temperature may be found from: $T_L = 175^\circ - R_{\theta JL} P_F$. P_F may be found from Figure 7.

The recommended method of mounting to a P.C. board is shown on the sketch, where $R_{\theta JA}$ is approximately 25°C/W for a $1-1/2" \times 1-1/2"$ copper surface area. Values of 40°C/W are typical for mounting to terminal strips or P.C. boards where available surface area is small.



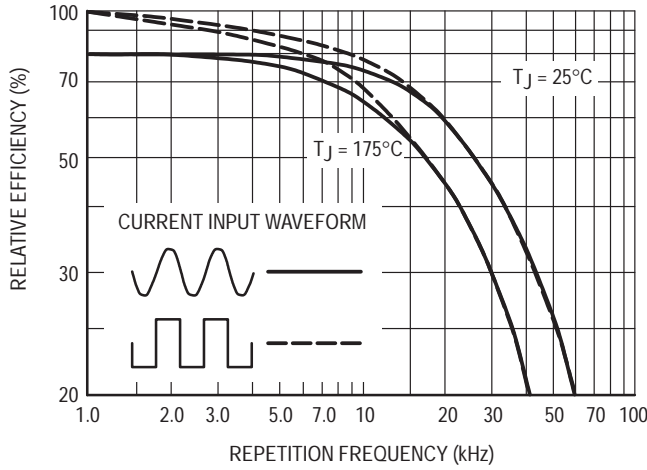


Figure 9. Rectification Efficiency

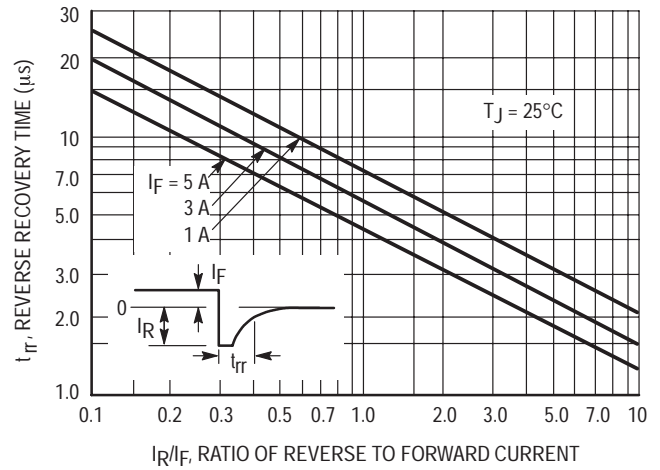


Figure 10. Reverse Recovery Time

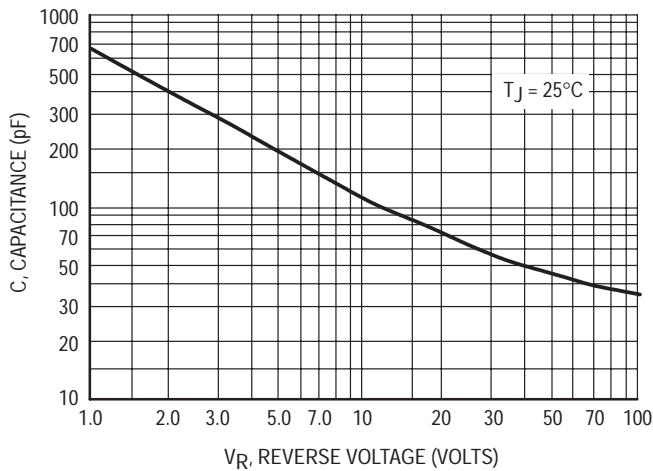


Figure 11. Junction Capacitance

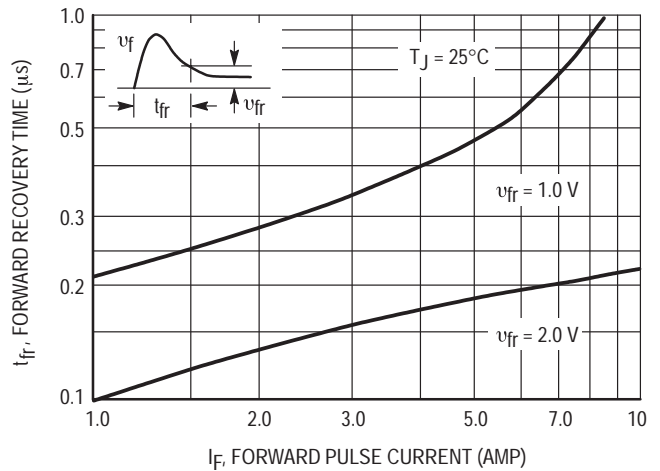


Figure 12. Forward Recovery Time

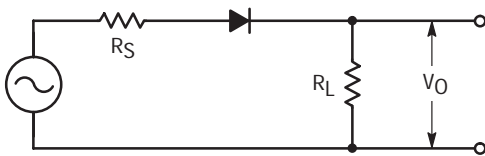


Figure 13. Single-Phase Half-Wave Rectifier Circuit

The rectification efficiency factor σ shown in Figure 9 was calculated using the formula:

$$\sigma = \frac{P_{(dc)}}{P_{(rms)}} = \frac{\frac{V_{2O(dc)}^2}{R_L}}{\frac{V_{2O(rms)}^2}{R_L}} \cdot 100\% = \frac{V_{2O(dc)}}{V_{2O(ac)} + V_{2O(dc)}} \cdot 100\% \quad (1)$$

For a sine wave input $V_m \sin(\omega t)$ to the diode, assumed lossless, the maximum theoretical efficiency factor becomes:

$$\sigma_{(sine)} = \frac{\frac{V_m^2}{\pi^2 R_L}}{\frac{V_m^2}{4R_L}} \cdot 100\% = \frac{4}{\pi^2} \cdot 100\% = 40.6\% \quad (2)$$

For a square wave input of amplitude V_m , the efficiency factor becomes:

$$\sigma_{(square)} = \frac{\frac{V_m^2}{2R_L}}{\frac{V_m^2}{R_L}} \cdot 100\% = 50\% \quad (3)$$

(A full wave circuit has twice these efficiencies)

As the frequency of the input signal is increased, the reverse recovery time of the diode (Figure 10) becomes significant, resulting in an increasing ac voltage component across R_L which is opposite in polarity to the forward current, thereby reducing the value of the efficiency factor σ , as shown on Figure 9.

It should be emphasized that Figure 9 shows waveform efficiency only; it does not provide a measure of diode losses. Data was obtained by measuring the ac component of V_O with a true rms ac voltmeter and the dc component with a dc voltmeter. The data was used in Equation 1 to obtain points for Figure 9.

Medium-Current Silicon Rectifiers

. . . compact, highly efficient silicon rectifiers for medium-current applications requiring:

- High Current Surge — 400 Amperes @ $T_J = 175^\circ\text{C}$
- Peak Performance @ Elevated Temperature — 25 Amperes @ $T_C = 150^\circ\text{C}$
- Low Cost
- Compact, Molded Package — For Optimum Efficiency in a Small Case Configuration
- Available with a Single Lead Attached, Consult Factory

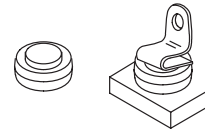
Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.8 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminals are Readily Solderable
- Lead Temperature for Soldering Purposes: requires a custom temperature soldering profile
- Polarity: Cathode Polarity Band
- Shipped 5000 units per box
- Marking: R2500, R2501, R2502, R2504, R2506, R2510

MR2500 Series

MR2504 and MR2510 are
Motorola Preferred Devices

**MEDIUM-CURRENT
SILICON RECTIFIERS
50-1000 VOLTS
25 AMPERES
DIFFUSED JUNCTION**



CASE 193-04

MAXIMUM RATINGS

Characteristic	Symbol	MR2500	MR2501	MR2502	MR2504	MR2506	MR2510	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWVM} V_R	50	100	200	400	600	1000	Volts
Non-Repetitive Peak Reverse Voltage (Halfwave, single phase, 60 Hz peak)	V_{RSM}	60	120	240	480	720	1200	Volts
Average Rectified Forward Current (Single phase, resistive load, 60 Hz, $T_C = 150^\circ\text{C}$)	I_O	25						Amps
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I_{FSM}	400 (for 1 cycle)						Amps
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-65 to +175						$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case (Single Side Cooled)	$R_{\theta JC}$	1.0	$^\circ\text{C}/\text{W}$

ELECTRICAL CHARACTERISTICS

Characteristics and Conditions	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage ($I_F = 78.5$ Amperes, $T_C = 25^\circ\text{C}$)	V_F	1.18	Volts
Maximum Reverse Current (rated dc voltage) $T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$	I_R	100 500	μA

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 2

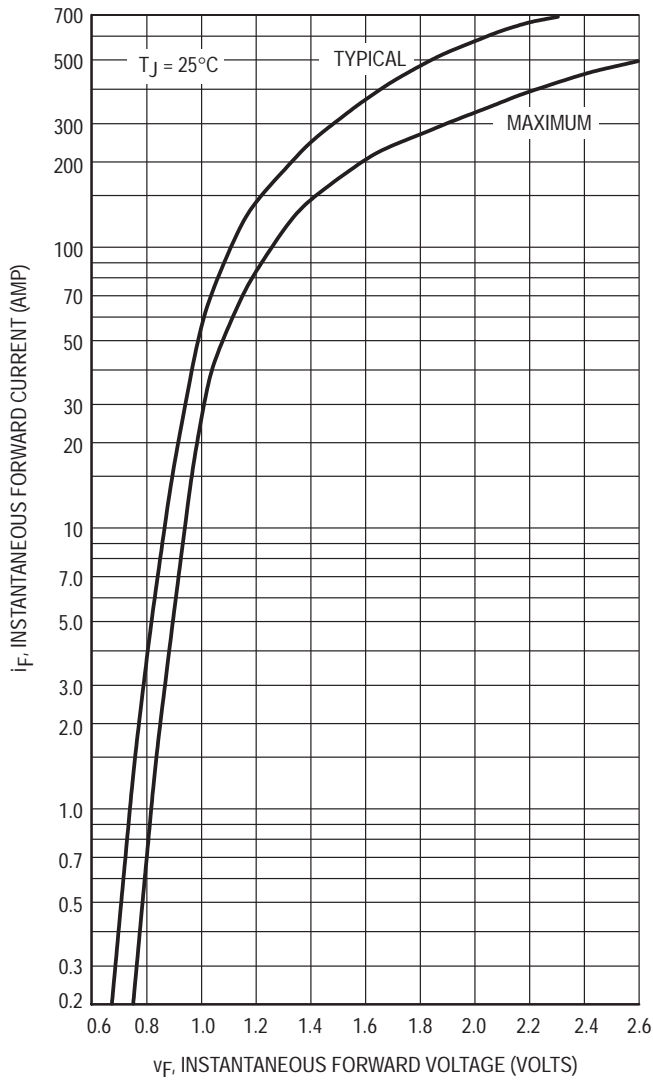


Figure 1. Forward Voltage

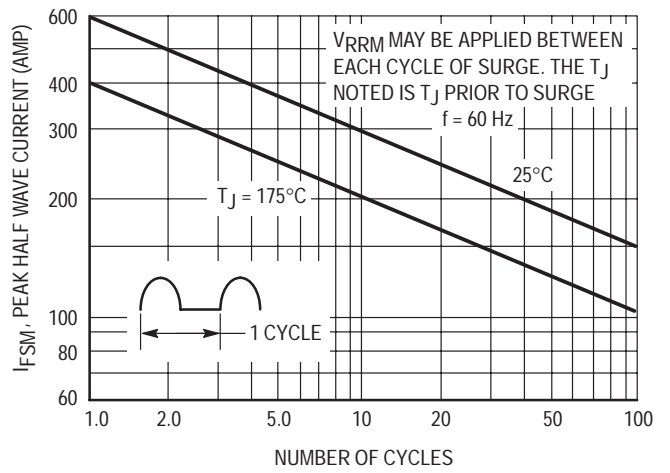


Figure 2. Non-Repetitive Surge Current

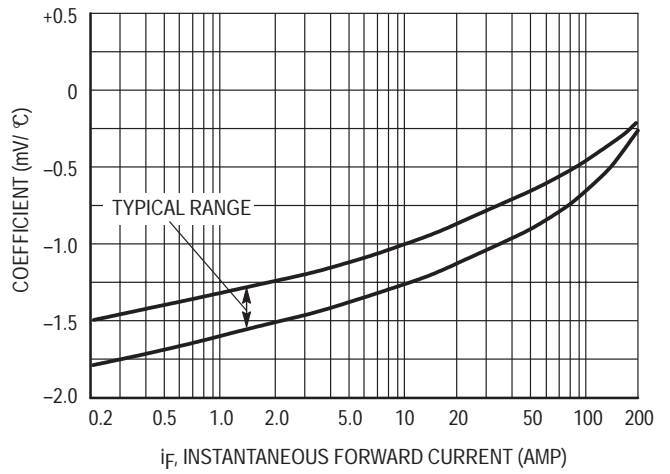


Figure 3. Forward Voltage Temperature Coefficient

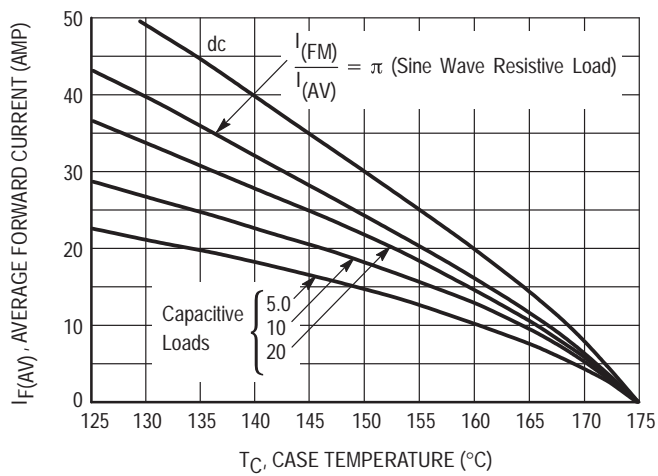


Figure 4. Current Derating

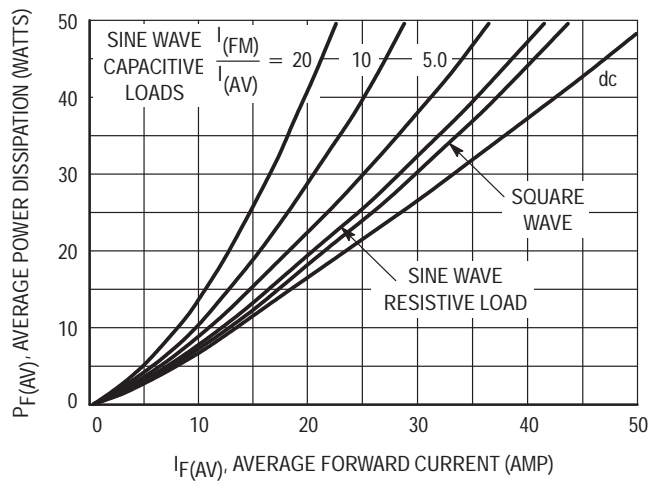


Figure 5. Forward Power Dissipation

MR2500 Series

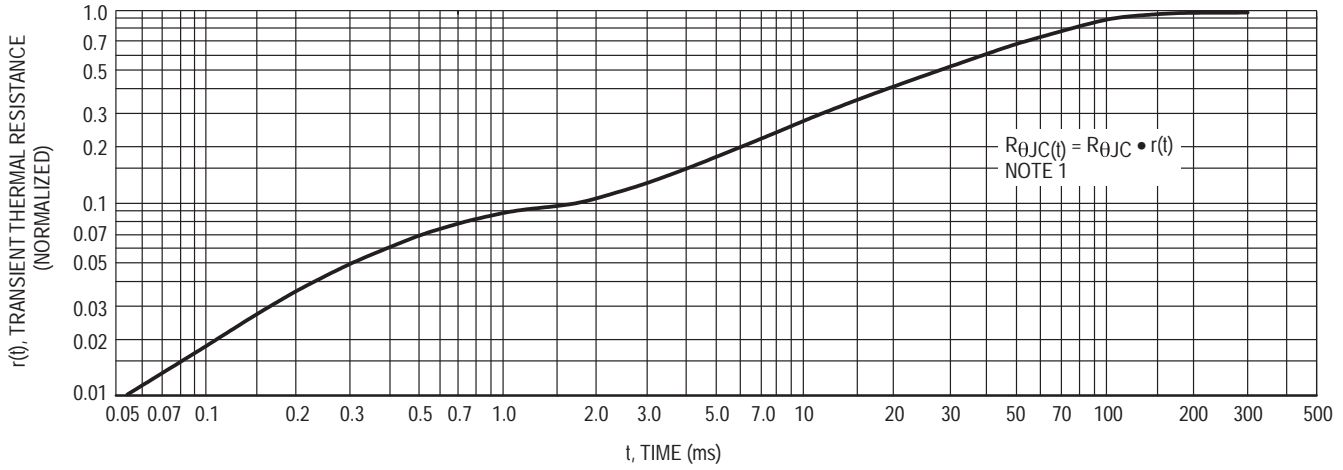


Figure 6. Thermal Response

DUTY CYCLE, $D = t_p/t_1$
 PEAK POWER, P_{pk} , is peak of an equivalent square power pulse.

To determine maximum junction temperature of the diode in a given situation, the following procedure is recommended:
 The temperature of the case should be measured using a thermocouple placed on the case at the temperature reference point (see the outline drawing on page 1). The thermal mass connected to the case is normally large enough so that it will not significantly respond to heat surges generated in the diode as a result of pulsed operation once steady-state conditions are achieved. Using the measured value of T_C , the junction temperature may be determined by:

$$T_J = T_C + \Delta T_{JC}$$

where ΔT_{JC} is the increase in junction temperature above the case temperature, it may be determined by:
 $\Delta T_{JC} = P_{pk} \cdot R_{\theta JC} [D + (1 - D) \cdot r(t_1 + t_p) + r(t_p) - r(t_1)]$ where
 $r(t)$ = normalized value of transient thermal resistance at time, t , from Figure 6, i.e.:
 $r(t_1 + t_p)$ = normalized value of transient thermal resistance at time $t_1 + t_p$.

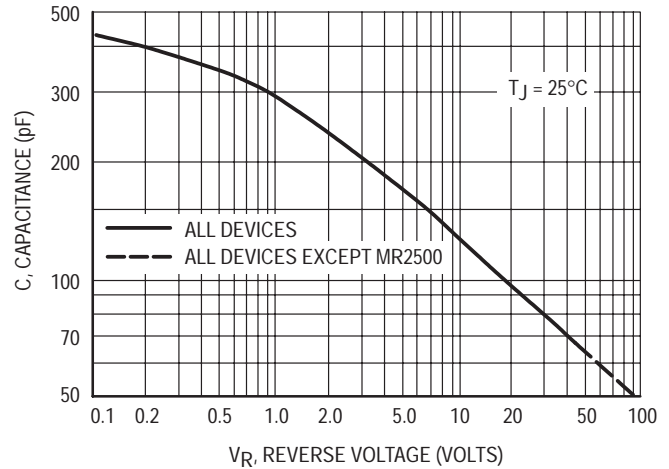


Figure 7. Capacitance

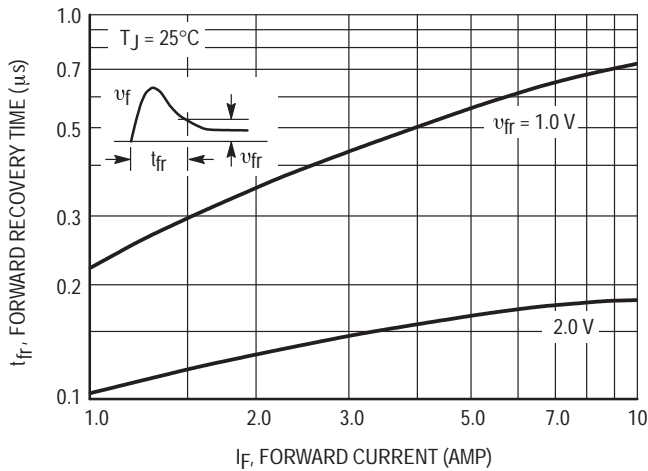


Figure 8. Forward Recovery Time

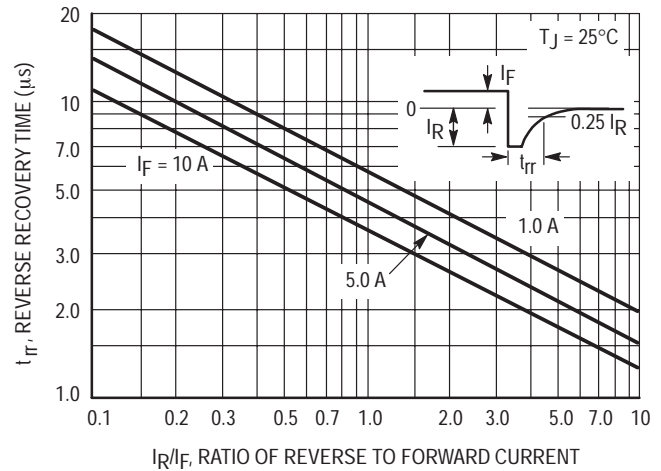


Figure 9. Reverse Recovery Time

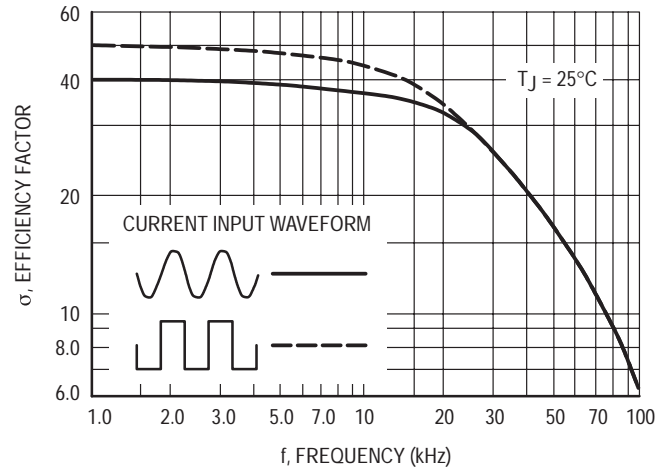


Figure 10. Rectification Waveform Efficiency

RECTIFICATION EFFICIENCY NOTE

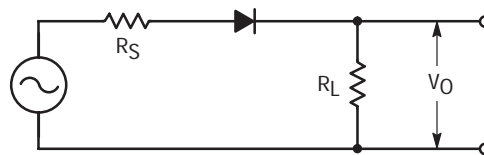


Figure 11. Single-Phase Half-Wave Rectifier Circuit

The rectification efficiency factor σ shown in Figure 10 was calculated using the formula:

$$\sigma = \frac{P_{(dc)}}{P_{(rms)}} = \frac{\frac{V_{2O(dc)}^2}{R_L}}{\frac{V_{2O(ac)}^2 + V_{2O(dc)}^2}{R_L}} \cdot 100\% = \frac{V_{2O(dc)}^2}{V_{2O(ac)}^2 + V_{2O(dc)}^2} \cdot 100\% \quad (1)$$

For a sine wave input $V_m \sin(\omega t)$ to the diode, assume lossless, the maximum theoretical efficiency factor becomes:

$$\sigma_{(sine)} = \frac{\frac{V_m^2}{\pi^2 R_L}}{\frac{V_m^2}{4R_L}} \cdot 100\% = \frac{4}{\pi^2} \cdot 100\% = 40.6\% \quad (2)$$

For a square wave input of amplitude V_m , the efficiency factor becomes:

$$\sigma_{(square)} = \frac{\frac{V_m^2}{2R_L}}{\frac{V_m^2}{R_L}} \cdot 100\% = 50\% \quad (3)$$

(A full wave circuit has twice these efficiencies)

As the frequency of the input signal is increased, the reverse recovery time of the diode (Figure 9) becomes significant, resulting in an increasing ac voltage component across R_L which is opposite in polarity to the forward current, thereby reducing the value of the efficiency factor σ , as shown on Figure 10.

It should be emphasized that Figure 10 shows waveform efficiency only; it does not provide a measure of diode losses. Data was obtained by measuring the ac component of V_O with a true rms ac voltmeter and the dc component with a dc voltmeter. The data was used in Equation 1 to obtain points for Figure 10.

MR2500 Series

ASSEMBLY AND SOLDERING INFORMATION

There are *two basic areas* of consideration for successful implementation of button rectifiers:

1. Mounting and Handling
2. Soldering

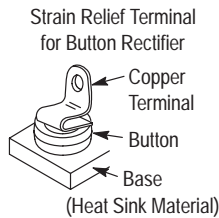
each should be carefully examined before attempting a finished assembly or mounting operation.

MOUNTING AND HANDLING

The button rectifier lends itself to a multitude of assembly arrangements but one key consideration must *always* be included:

One Side of the Connections to the Button Must Be Flexible!

This stress relief to the button should also be chosen for maximum contact area to afford the best heat transfer — but not at the expense of flexibility. For an annealed copper terminal a thickness of 0.015" is suggested.



The base heat sink may be of various materials whose shape and size are a function of the individual application and the heat transfer requirements.

Common Materials

Advantages and Disadvantages

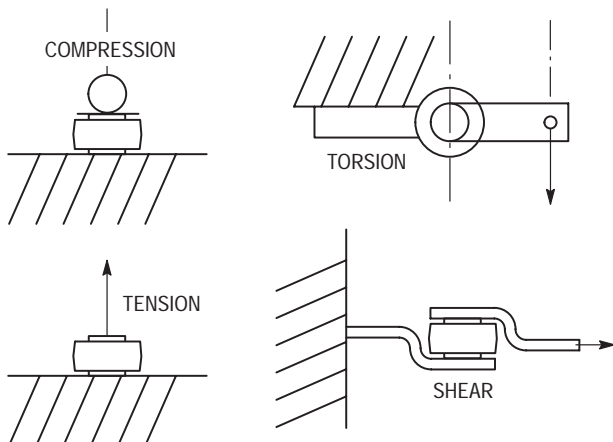
Material	Advantages	Disadvantages
Steel	Low Cost;	relatively low heat conductivity
Copper	High Cost;	high heat conductivity
Aluminum	Medium Cost;	medium heat conductivity
	Relatively expensive to plate and not all platers can process aluminum.	

Handling of the button during assembly must be relatively gentle to minimize sharp impact shocks and avoid nicking of the plastic. Improperly designed automatic handling equipment is the worst source of unnecessary shocks. Techniques for vacuum handling and spring loading should be investigated.

The mechanical stress limits for the button diode are as follows:

Compression	32 lbs.	142.3 Newton
Tension	32 lbs.	142.3 Newton
Torsion	6-inch lbs.	0.68 Newton-meters
Shear	55 lbs.	244.7 Newton

MECHANICAL STRESS



Exceeding these recommended maximums can result in electrical degradation of the device.

SOLDERING

The button rectifier is basically a semiconductor chip bonded between two nickel-plated copper heat sinks with an encapsulating material of thermal-setting silicone. The exposed metal areas are also tin plated to enhance solderability.

In the soldering process it is important that the temperature not exceed 250°C if device damage is to be avoided. Various solder alloys can be used for this operation but two types are recommended for best results:

1. 96.5% tin, 3.5% silver; Melting point is 221°C (this particular eutetic is used by Motorola for its button rectifier assemblies).
2. 63% tin, 37% lead; Melting point 183°C (eutetic).

Solder is available as preforms or paste. The paste contains both the metal and flux and can be dispensed rapidly. The solder preform requires the application of a flux to assure good wetting of the solder. The type of flux used depends upon the degree of cleaning to be accomplished and is a function of the metals involved. These fluxes range from a mild rosin to a strong acid; e.g., Nickel plating oxides are best removed by an acid base flux while an activated rosin flux may be sufficient for tin plated parts.

Since the button is relatively light-weight, there is a tendency for it to float when the solder becomes liquid. To prevent bad joints and misalignment it is suggested that a weighting or spring loaded fixture be employed. It is also important that severe thermal shock (either heating or cooling) be avoided as it may lead to damage of the die or encapsulant of the part.

Button holding fixtures for use during soldering may be of various materials. Stainless steel has a longer use life while black anodized aluminum is less expensive and will limit heat reflection and enhance absorption. The assembly volume will influence the choice of materials. Fixture dimension tolerances for locating the button must allow for expansion during soldering as well as allowing for button clearance.

HEATING TECHNIQUES

The following four heating methods have their advantages and disadvantages depending on volume of buttons to be soldered.

1. **Belt Furnaces** readily handle large or small volumes and are adaptable to establishment of "on-line" assembly since a variable belt speed sets the run rate. Individual furnace zone controls make excellent temperature control possible.
2. **Flame Soldering** involves the directing of natural gas flame jets at the base of a heatsink as the heatsink is indexed to various loading-heating-cooling-unloading positions. This is the most economical labor method of soldering large volumes. Flame soldering offers good temperature control but requires sophisticated temperature monitoring systems such as infrared.

ASSEMBLY AND SOLDERING INFORMATION (continued)

3. **Ovens** are good for batch soldering and are production limited. There are handling problems because of slow cooling. Response time is load dependent, being a function of the watt rating of the oven and the mass of parts. Large ovens may not give an acceptable temperature gradient. Capital cost is low compared to belt furnaces and flame soldering.
4. **Hot Plates** are good for soldering small quantities of prototype devices. Temperature control is fair with overshoot common because of the exposed heating surface. Solder flow and positioning can be corrected during soldering since the assembly is exposed. Investment cost is very low.

Regardless of the heating method used, a soldering profile giving the time–temperature relationship of the particular method must be determined to assure proper soldering. Profiling must be performed on a scheduled basis to minimize poor soldering. The time–temperature relationship will change depending on the heating method used.

SOLDER PROCESS EVALUATION

Characteristics to look for when setting up the soldering process:

- I **Overttemperature** is indicated by any one or all three of the following observations.
 1. Remelting of the solder inside the button rectifier shows the temperature has exceeded 285°C and is noted by “islands” of shiny solder and solder dewetting when a unit is broken apart.
 2. Cracked die inside the button may be observed by a moving reverse oscilloscope trace when pressure is applied to the unit.
 3. Cracked plastic may be caused by thermal shock as well as overtemperature so cooling rate should also be checked.
- II **Cold soldering** gives a grainy appearance and solder build–up without a smooth continuous solder fillet. The temperature must be adjusted until the proper solder fillet is obtained within the maximum temperature limits.
- III **Incomplete solder fillets** result from insufficient solder or parts not making proper contact.
- IV **Tilted buttons** can cause a void in the solder between the heatsink and button rectifier which will result in poor heat transfer during operation. An eight degree tilt is a suggested maximum value.
- V **Plating problems** require a knowledge of plating operations for complete understanding of observed deficiencies.

1. Peeling or plating separation is generally seen when a button is broken away for solder inspection. If heatsink or terminal base metal is present the plating is poor and must be corrected.
2. Thin plating allows the solder to penetrate through to the base metal and can give a poor connection. A suggested minimum plating thickness is 300 microinches.
3. Contaminated soldering surfaces may out–gas and cause non–wetting resulting in voids in the solder connection. The exact cause is not always readily apparent and can be because of:
 - (a) improper plating
 - (b) mishandling of parts
 - (c) improper and/or excessive storage time

SOLDER PROCESS MONITORING

Continuous monitoring of the soldering process must be established to minimize potential problems. All parts used in the soldering operation should be sampled on a lot by lot basis by assembly of a controlled sample. Evaluate the control sample by break–apart tests to view the solder connections, by physical strength tests and by dimensional characteristics for part mating.

A shear test is a suggested way of testing the solder bond strength.

POST SOLDERING OPERATION CONSIDERATIONS

After soldering, the completed assembly must be unloaded, washed and inspected.

Unloading must be done carefully to avoid unnecessary stress. Assembly fixtures should be cooled to room temperature so solder profiles are not affected.

Washing is mandatory if an acid flux is used because of its ionic and corrosive nature. Wash the assemblies in agitated hot water and detergent for three to five minutes. After washing; rinse, blow off excessive water and bake 30 minutes at 150°C to remove trapped moisture.

Inspection should be both electrical and physical. Any rejects can be reworked as required.

SUMMARY

The Button Rectifier is an excellent building block for specialized applications. The prime example of its use is the output bridge of the automotive alternator where millions are used each year. Although the material presented here is not all inclusive, primary considerations for use are presented. For further information, contact the nearest Motorola Sales Office or franchised distributor.

Complementary Medium Current Silicon Rectifiers

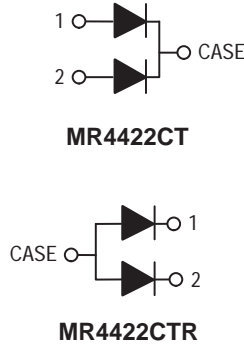
For Linear Power Supply Applications

... using monolithic silicon technology for perfect matching of diodes in center tap configuration. These devices have the following features:

- Low Forward Voltage Drop
- Soft Reverse Recovery for Low Noise
- High Surge Current Capability
- 150°C Operating Junction Temperature
- Direct Replacement for Varo R711 and R711A

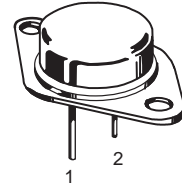
Mechanical Characteristics

- Case: Welded Steel can, hermetically sealed
- Weight: 11 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 100 units per foam tray
- Marking: R4422T, R4422R



MR4422CT
MR4422CTR

POWER RECTIFIERS
30 AMPERES
100 VOLTS



CASE 1-07
(TO-204AA)

MAXIMUM RATINGS (PER LEG)

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	100	Volts
Average Rectified Forward Current (Rated V_R) $T_C = 125^\circ\text{C}$	$I_{F(AV)}$	15 30	Amps Per Leg Per Device
Peak Repetitive Forward Current, Per Diode Leg (Rated V_R , Square Wave, 20 kHz) $T_C = 125^\circ\text{C}$	I_{FRM}	30	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	400	Amps
Peak Repetitive Reverse Surge Current (2.0 μs , 1.0 kHz)	I_{RRM}	2.0	Amps
Operating Junction Temperature	T_J	-65 to +150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +175	$^\circ\text{C}$

THERMAL CHARACTERISTICS (PER LEG)

Thermal Resistance — Junction to Case	$R_{\theta JC}$	1.4	5C/W
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ELECTRICAL CHARACTERISTICS (PER LEG)

Maximum Instantaneous Forward Voltage (1) ($I_F = 15$ Amps, $T_C = 25^\circ\text{C}$) ($I_F = 10$ Amps, $T_C = 125^\circ\text{C}$)	i_F	1.2 1.1	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 25^\circ\text{C}$) (Rated dc Voltage, $T_C = 125^\circ\text{C}$)	i_R	1.0 250	mA

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

Advance Information

Overvoltage Transient Suppressors

... designed for applications requiring a low voltage rectifier with reverse avalanche characteristics for use as reverse power transient suppressors. Developed to suppress transients in the automotive system, these devices operate in the forward mode as standard rectifiers or reverse mode as power avalanche rectifier and will protect electronic equipment from overvoltage conditions.

- Avalanche Voltage 24 to 32 Volts
- High Power Capability
- Economical
- Increased Capacity by Parallel Operation

Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 2.5 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: cathode polarity band
- MR2535L shipped 1000 units per plastic bag. Available Tape and Reeled, 800 units per reel by adding a "RL" suffix to the part number.
- MR2535S shipped pocket tape and reeled, 500 per 13" reel
- Marking: MR2535L, MR2535S

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
DC Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	20	Volts
Repetitive Peak Reverse Surge Current (Time Constant = 10 ms, Duty Cycle \leq 1%, $T_C = 25^\circ\text{C}$) (See Figure 1)	I_{RSM}	110	Amps
Average Rectified Forward Current (Single Phase, Resistive Load, 60 Hz, $T_C = 150^\circ\text{C}$)	I_O	35	Amps
Non-Repetitive Peak Surge Current Surge Supplied at Rated Load Conditions Halfwave, Single Phase	I_{FSM}	600	Amps
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-65 to +175	$^\circ\text{C}$

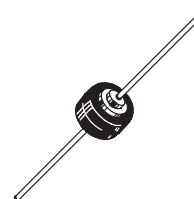
THERMAL CHARACTERISTICS

Characteristic	Lead Length	Symbol	Max	Unit
Thermal Resistance, Junction to Lead @ Both Leads to Heat Sink, Equal Length	1/4"	$R_{\theta JL}$	7.5	$^\circ\text{C/W}$
	3/8"		10	
	1/2"		13	
Thermal Resistance Junction to Case		$R_{\theta JC}$	0.8*	$^\circ\text{C/W}$

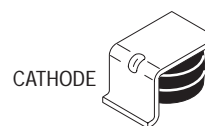
*Typical

MR2535L
MR2535S

MEDIUM CURRENT
OVERVOLTAGE
TRANSIENT
SUPPRESSORS



CASE 194-04



CASE 421A-01

This document contains information on a new product. Specifications and information herein are subject to change without notice.

Rev 2

MR2535L MR2535S

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Min	Max	Unit
Instantaneous Forward Voltage (1) ($I_F = 100$ Amps, $T_C = 25^\circ\text{C}$)	V_F	—	1.1	Volts
Reverse Current ($V_R = 20$ Vdc, $T_C = 25^\circ\text{C}$)	I_R	—	200	nAdc
Breakdown Voltage (1) ($I_R = 100$ mAdc, $T_C = 25^\circ\text{C}$)	$V_{(BR)}$	24	32	Volts
Breakdown Voltage (1) ($I_R = 90$ Amp, $T_C = 150^\circ\text{C}$, $PW = 80 \mu\text{s}$)	$V_{(BR)}$	—	40	Volts
Breakdown Voltage Temperature Coefficient	$V_{(BR)TC}$	—	0.096*	$\% / ^\circ\text{C}$
Forward Voltage Temperature Coefficient @ $I_F = 10$ mA	V_{FTC}	—	2*	$\text{mV} / ^\circ\text{C}$

(1) Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2\%$.

*Typical

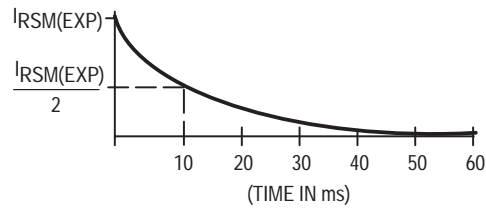


Figure 1. Surge Current Characteristics

Section 6

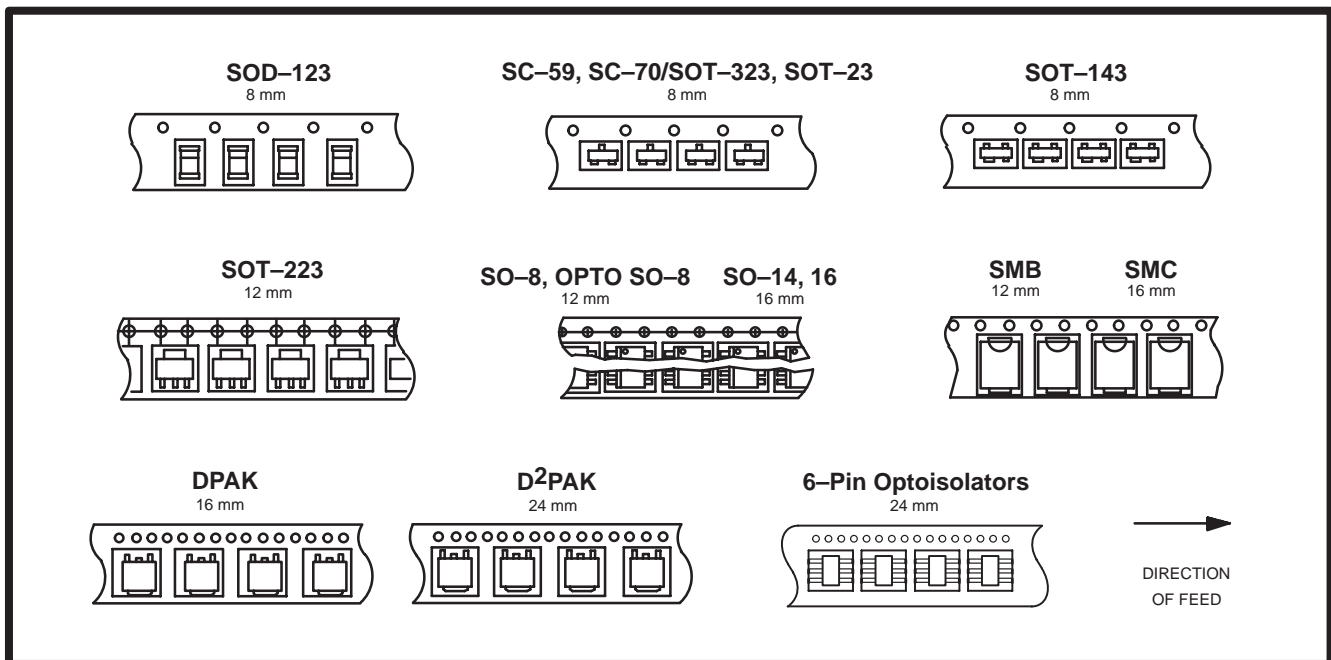
Tape and Reel/ Packaging Specifications

Tape and Reel Specifications and Packaging Specifications

Embossed Tape and Reel is used to facilitate automatic pick and place equipment feed requirements. The tape is used as the shipping container for various products and requires a minimum of handling. The antistatic/conductive tape provides a secure cavity for the product when sealed with the “peel-back” cover tape.

- Two Reel Sizes Available (7” and 13”)
- Used for Automatic Pick and Place Feed Systems
- Minimizes Product Handling
- EIA 481, -1, -2
- SOD-123, SC-59, SC-70/SOT-323, SOT-23, SOT-143 in 8 mm Tape
- SO-8, OPTO SO-8, SOT-223, SMB in 12 mm Tape
- DPAK, SO-14, SO-16, SMC in 16 mm Tape
- D²PAK, 6-Pin Optoisolators in 24 mm Tape

Use the standard device title and add the required suffix as listed in the option table on the following page. Note that the individual reels have a finite number of devices depending on the type of product contained in the tape. Also note the minimum lot size is one full reel for each line item, and orders are required to be in increments of the single reel quantity.

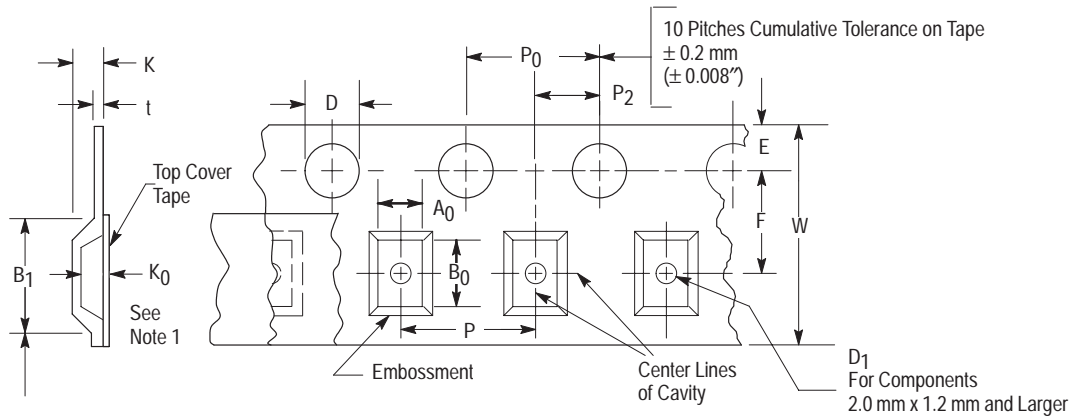


EMBOSSED TAPE AND REEL ORDERING INFORMATION

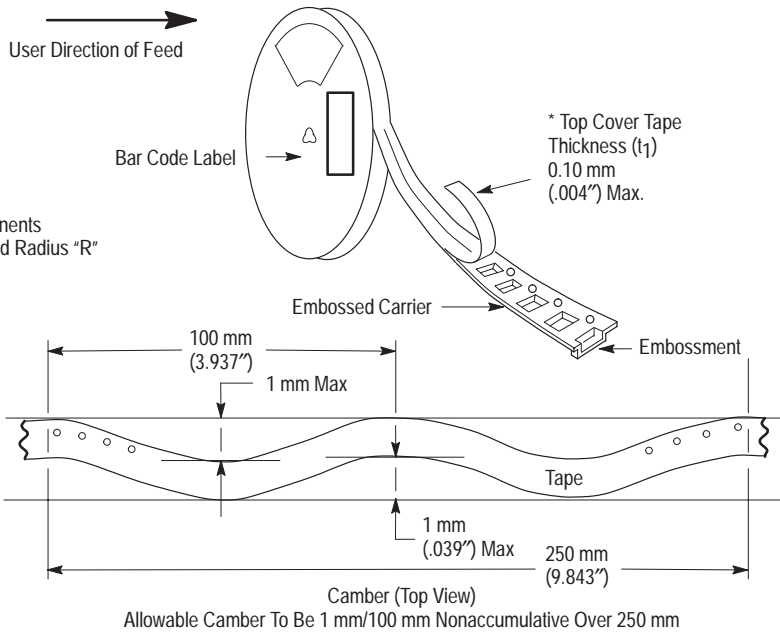
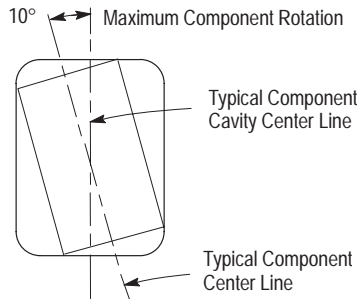
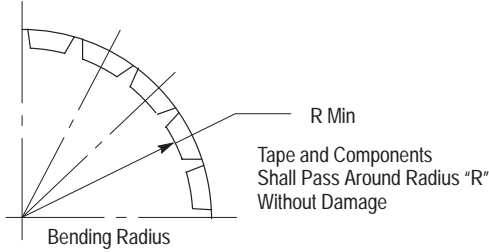
Package	Tape Width (mm)	Pitch mm (inch)	Reel Size mm (inch)	Devices Per Reel and Minimum Order Quantity	Device Suffix
DPAK	16	8.0 ± 0.1 (.315 ± .004)	330 (13)	2,500	T4
D ² PAK	24	16.0 ± 0.1 (.630 ± .004)	330 (13)	800	T4
SC-59	8	4.0 ± 0.1 (.157 ± .004)	178 (7)	3,000	T1
SC-70/SOT-323	8	4.0 ± 0.1 (.157 ± .004)	178 (7)	3,000	T1
	8		330 (13)	10,000	T3
SMB	12	8.0 ± 0.1 (.315 ± .004)	330 (13)	2,500	T3
SMC	16	8.0 ± 0.1 (.315 ± .004)	330 (13)	2,500	T3
SO-8, OPTO SO-8	12	8.0 ± 0.1 (.315 ± .004)	178 (7)	500	R1
	12		330 (13)	2,500	R2
SO-14	16	8.0 ± 0.1 (.315 ± .004)	178 (7)	500	R1
	16		330 (13)	2,500	R2
SO-16	16	8.0 ± 0.1 (.315 ± .004)	178 (7)	500	R1
	16		330 (13)	2,500	R2
SOD-123	8	4.0 ± 0.1 (.157 ± .004)	178 (7)	3,000	T1
	8		330 (13)	10,000	T3
SOT-23	8	4.0 ± 0.1 (.157 ± .004)	178 (7)	3,000	T1
	8		330 (13)	10,000	T3
SOT-143	8	4.0 ± 0.1 (.157 ± .004)	178 (7)	3,000	T1
	8		330 (13)	10,000	T3
SOT-223	12	8.0 ± 0.1 (.315 ± .004)	178 (7)	1,000	T1
	12		330 (13)	4,000	T3
6-Pin Optoisolators	24	12.0 ± 0.1 (.472 ± .004)	330 (13)	1000	R2

EMBOSSSED TAPE AND REEL DATA FOR DISCRETES

CARRIER TAPE SPECIFICATIONS



For Machine Reference Only
Including Draft and RADII
Concentric Around B₀



DIMENSIONS

Tape Size	B ₁ Max	D	D ₁	E	F	K	P ₀	P ₂	R Min	T Max	W Max
8 mm	4.55 mm (.179")	1.5 + 0.1 mm - 0.0 (.059 + .004" - 0.0)	1.0 Min (.039")	1.75 ± 0.1 mm (.069 ± .004")	3.5 ± 0.05 mm (.138 ± .002")	2.4 mm Max (.094")	4.0 ± 0.1 mm (.157 ± .004")	2.0 ± 0.1 mm (.079 ± .002")	25 mm (.98")	0.6 mm (.024")	8.3 mm (.327")
12 mm	8.2 mm (.323")		1.5 mm Min (.060")		5.5 ± 0.05 mm (.217 ± .002")	6.4 mm Max (.252")					12 ± .30 mm (.470 ± .012")
16 mm	12.1 mm (.476")				7.5 ± 0.10 mm (.295 ± .004")	7.9 mm Max (.311")					16.3 mm (.642")
24 mm	20.1 mm (.791")				11.5 ± 0.1 mm (.453 ± .004")	11.9 mm Max (.468")					24.3 mm (.957")

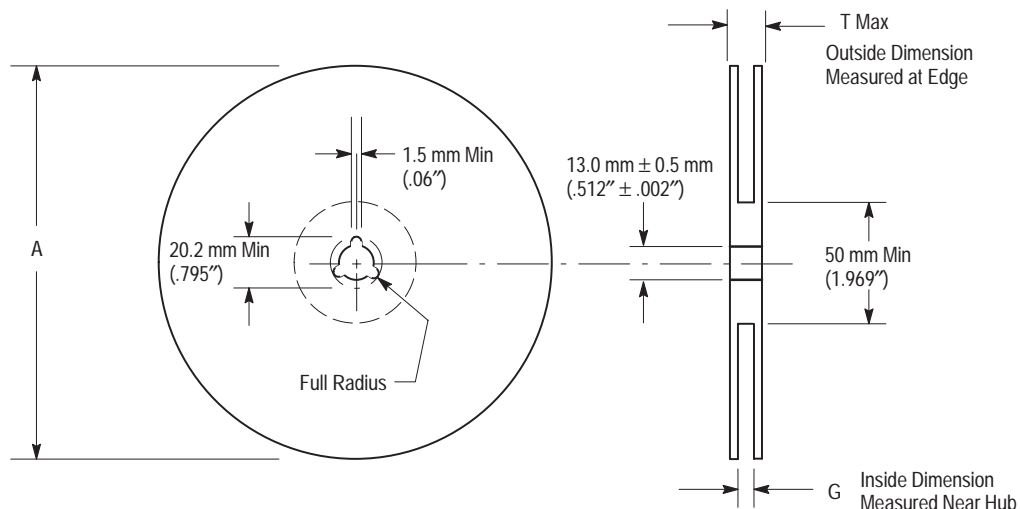
Metric dimensions govern — English are in parentheses for reference only.

NOTE 1: A₀, B₀, and K₀ are determined by component size. The clearance between the components and the cavity must be within .05 mm min. to .50 mm max., the component cannot rotate more than 10° within the determined cavity.

NOTE 2: If B₁ exceeds 4.2 mm (.165) for 8 mm embossed tape, the tape may not feed through all tape feeders.

NOTE 3: Pitch information is contained in the Embossed Tape and Reel Ordering Information on pg. 6-3.

EMBOSSED TAPE AND REEL DATA FOR DISCRETES



Size	A Max	G	T Max
8 mm	330 mm (12.992")	8.4 mm + 1.5 mm, -0.0 (.33" + .059", -0.00)	14.4 mm (.56")
12 mm	330 mm (12.992")	12.4 mm + 2.0 mm, -0.0 (.49" + .079", -0.00)	18.4 mm (.72")
16 mm	360 mm (14.173")	16.4 mm + 2.0 mm, -0.0 (.646" + .078", -0.00)	22.4 mm (.882")
24 mm	360 mm (14.173")	24.4 mm + 2.0 mm, -0.0 (.961" + .070", -0.00)	30.4 mm (1.197")

Reel Dimensions

Metric Dimensions Govern — English are in parentheses for reference only

LEAD TAPE PACKAGING STANDARDS FOR AXIAL-LEAD COMPONENTS

Case Type	Product Category	Device Title Suffix	MPQ Quantity Per Reel (Item 3.3.7)	Component Spacing A Dimension	Tape Spacing B Dimension	Reel Dimension C	Reel Dimension D (Max)	Max Off Alignment E
Case 17-02	Surmetic 40 & 600 Watt TVS	RL	4000	0.2 +/- 0.015	2.062 +/- 0.059	3	14	0.047
Case 41A-02	1500 Watt TVS	RL4	1500	0.4 +/- 0.02	2.062 +/- 0.059	3	14	0.047
Case 51-02	DO-7 Glass (For Reference only)	RL	3000	0.2 +/- 0.02	2.062 +/- 0.059	3	14	0.047
Case 59-03	DO-41 Glass & DO-41 Surmetic 30	RL	6000	0.2 +/- 0.015	2.062 +/- 0.059	3	14	0.047
	Rectifier							
Case 59-04	500 Watt TVS	RL	5000	0.2 +/- 0.02	2.062 +/- 0.059	3	14	0.047
	Rectifier							
Case 194-04	110 Amp TVS (Automotive)	RL	800	0.4 +/- 0.02	1.875 +/- 0.059	3	14	0.047
	Rectifier							
Case 267-02	Rectifier	RL	1500	0.4 +/- 0.02	2.062 +/- 0.059	3	14	0.047
Case 299-02	DO-35 Glass	RL	5000	0.2 +/- 0.02	2.062 +/- 0.059	3	14	0.047

Table 1. Packaging Details (all dimensions in inches)

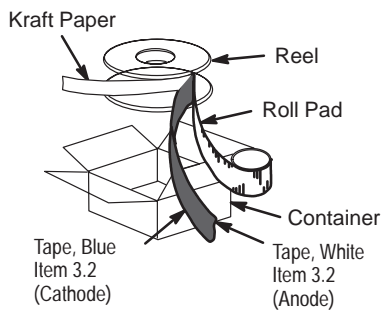


Figure 1. Reel Packing

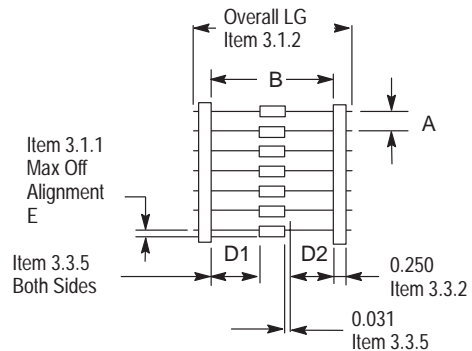


Figure 2. Component Spacing

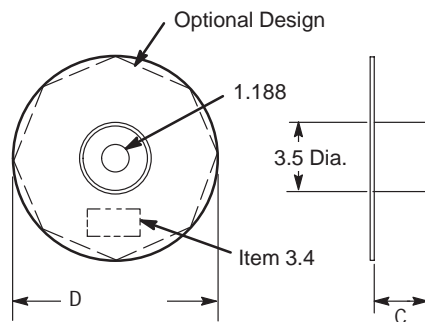


Figure 3. Reel Dimensions

Section 7

Surface Mount Information

INFORMATION FOR USING SURFACE MOUNT PACKAGES

RECOMMENDED FOOTPRINTS FOR SURFACE MOUNTED APPLICATIONS

Surface mount board layout is a critical portion of the total design. The footprint for the semiconductor packages must be the correct size to ensure proper solder connection interface between the board and the package. With the correct pad

geometry, the packages will self align when subjected to a solder reflow process.

POWER DISSIPATION FOR A SURFACE MOUNT DEVICE

The power dissipation for a surface mount device is a function of the drain/collector pad size. These can vary from the minimum pad size for soldering to a pad size given for maximum power dissipation. Power dissipation for a surface mount device is determined by $T_{J(max)}$, the maximum rated junction temperature of the die, $R_{\theta JA}$, the thermal resistance from the device junction to ambient, and the operating temperature, T_A . Using the values provided on the data sheet, P_D can be calculated as follows:

$$P_D = \frac{T_{J(max)} - T_A}{R_{\theta JA}}$$

The values for the equation are found in the maximum ratings table on the data sheet. Substituting these values into the equation for an ambient temperature T_A of 25°C, one can calculate the power dissipation of the device. For example, for a SOT-223 device, P_D is calculated as follows.

$$P_D = \frac{150^\circ\text{C} - 25^\circ\text{C}}{156^\circ\text{C/W}} = 800 \text{ milliwatts}$$

The 156°C/W for the SOT-223 package assumes the use of the recommended footprint on a glass epoxy printed circuit board to achieve a power dissipation of 800 milliwatts. There are other alternatives to achieving higher power dissipation from the surface mount packages. One is to increase the area of the drain/collector pad. By increasing the area of the drain/collector pad, the power dissipation can be increased. Although the power dissipation can almost be doubled with this method, area is taken up on the printed circuit board which can defeat the purpose of using surface mount technology. For example, a graph of $R_{\theta JA}$ versus drain pad area is shown in Figures 1, 2 and 3.

Another alternative would be to use a ceramic substrate or an aluminum core board such as Thermal Clad™. Using a board material such as Thermal Clad, an aluminum core board, the power dissipation can be doubled using the same footprint.

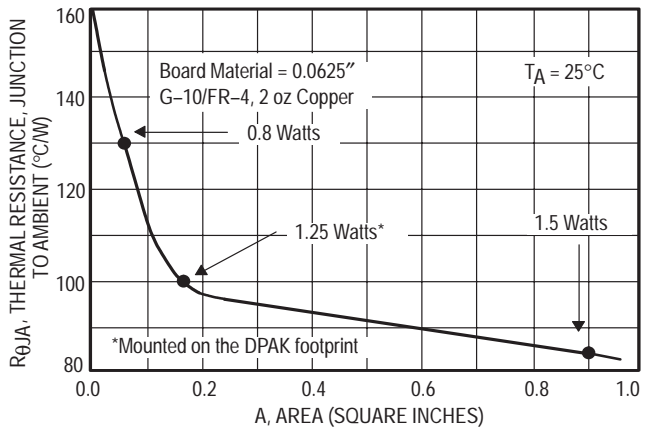


Figure 1. Thermal Resistance versus Drain Pad Area for the SOT-223 Package (Typical)

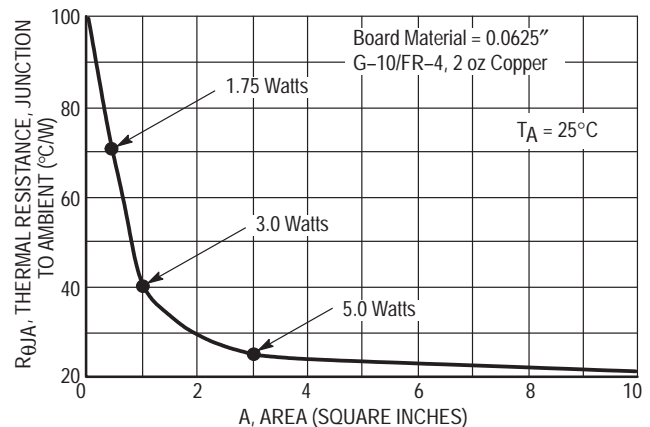


Figure 2. Thermal Resistance versus Drain Pad Area for the DPAK Package (Typical)

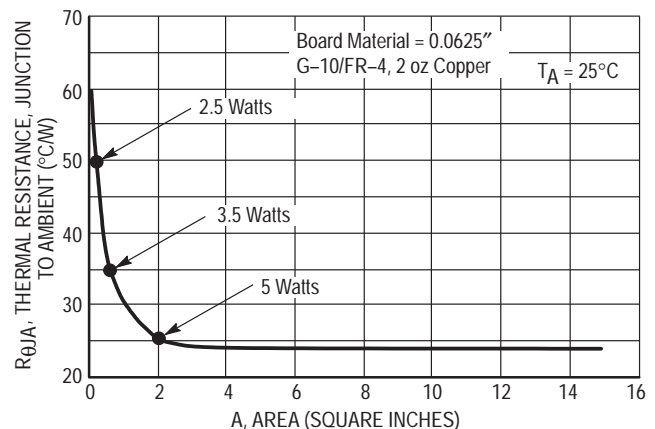


Figure 3. Thermal Resistance versus Drain Pad Area for the D²PAK Package (Typical)

SOLDER STENCIL GUIDELINES

Prior to placing surface mount components onto a printed circuit board, solder paste must be applied to the pads. Solder stencils are used to screen the optimum amount. These stencils are typically 0.008 inches thick and may be made of brass or stainless steel. For packages such as the SC-59, SC-70/SOT-323, SOD-123, SOT-23, SOT-143, SOT-223, SO-8, SO-14, SO-16, and SMB/SMC diode packages, the stencil opening should be the same as the pad size or a 1:1 registration. This is not the case with the DPAK and D²PAK packages. If a 1:1 opening is used to screen solder onto the drain pad, misalignment and/or “tombstoning” may occur due to an excess of solder. For these two packages, the opening in the stencil for the paste should be approximately 50% of the pad area. The opening for the leads is still a 1:1 registration. Figure 4 shows a typical stencil for the DPAK and D²PAK

packages. The pattern of the opening in the stencil for the drain pad is not critical as long as it allows approximately 50% of the pad to be covered with paste.

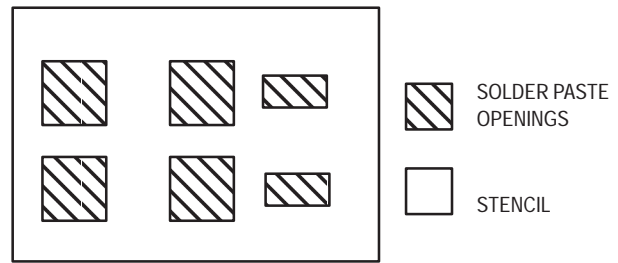


Figure 4. Typical Stencil for DPAK and D²PAK Packages

SOLDERING PRECAUTIONS

The melting temperature of solder is higher than the rated temperature of the device. When the entire device is heated to a high temperature, failure to complete soldering within a short time could result in device failure. Therefore, the following items should always be observed in order to minimize the thermal stress to which the devices are subjected.

- Always preheat the device.
- The delta temperature between the preheat and soldering should be 100°C or less.*
- When preheating and soldering, the temperature of the leads and the case must not exceed the maximum temperature ratings as shown on the data sheet. When using infrared heating with the reflow soldering method, the difference should be a maximum of 10°C.
- The soldering temperature and time should not exceed 260°C for more than 10 seconds.
- When shifting from preheating to soldering, the maximum temperature gradient shall be 5°C or less.

- After soldering has been completed, the device should be allowed to cool naturally for at least three minutes. Gradual cooling should be used since the use of forced cooling will increase the temperature gradient and will result in latent failure due to mechanical stress.
- Mechanical stress or shock should not be applied during cooling.

* Soldering a device without preheating can cause excessive thermal shock and stress which can result in damage to the device.

* Due to shadowing and the inability to set the wave height to incorporate other surface mount components, the D²PAK is not recommended for wave soldering.

TYPICAL SOLDER HEATING PROFILE

For any given circuit board, there will be a group of control settings that will give the desired heat pattern. The operator must set temperatures for several heating zones and a figure for belt speed. Taken together, these control settings make up a heating “profile” for that particular circuit board. On machines controlled by a computer, the computer remembers these profiles from one operating session to the next. Figure 5 shows a typical heating profile for use when soldering a surface mount device to a printed circuit board. This profile will vary among soldering systems, but it is a good starting point. Factors that can affect the profile include the type of soldering system in use, density and types of components on the board, type of solder used, and the type of board or substrate material being used. This profile shows temperature versus time. The line on the graph shows the actual temperature that might be

experienced on the surface of a test board at or near a central solder joint. The two profiles are based on a high density and a low density board. The Vitronics SMD310 convection/infrared reflow soldering system was used to generate this profile. The type of solder used was 62/36/2 Tin Lead Silver with a melting point between 177–189°C. When this type of furnace is used for solder reflow work, the circuit boards and solder joints tend to heat first. The components on the board are then heated by conduction. The circuit board, because it has a large surface area, absorbs the thermal energy more efficiently, then distributes this energy to the components. Because of this effect, the main body of a component may be up to 30 degrees cooler than the adjacent solder joints.

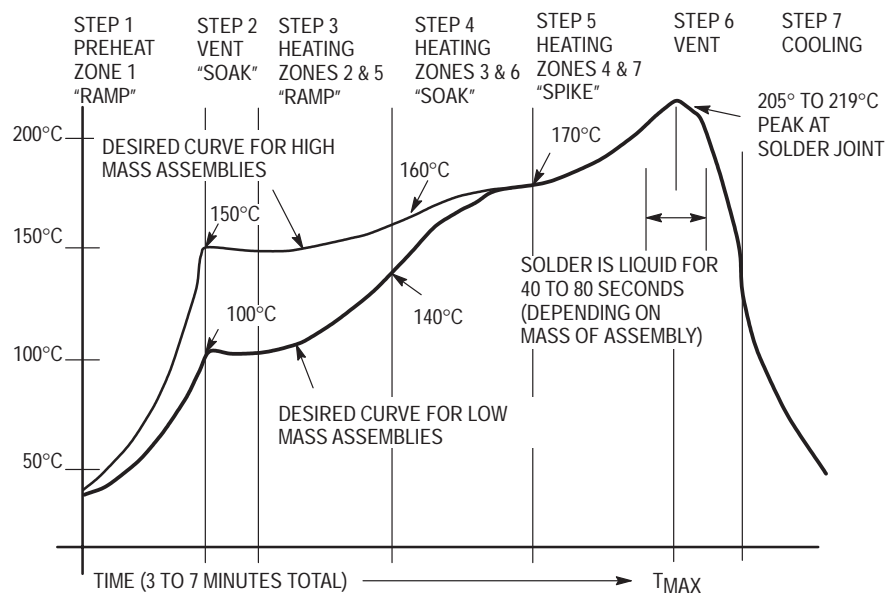
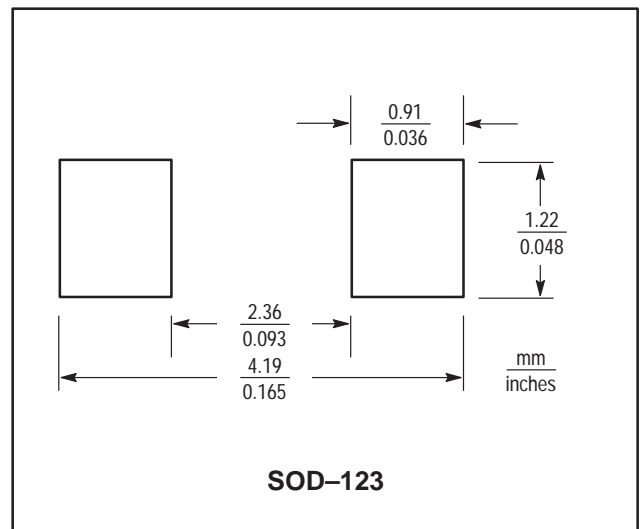
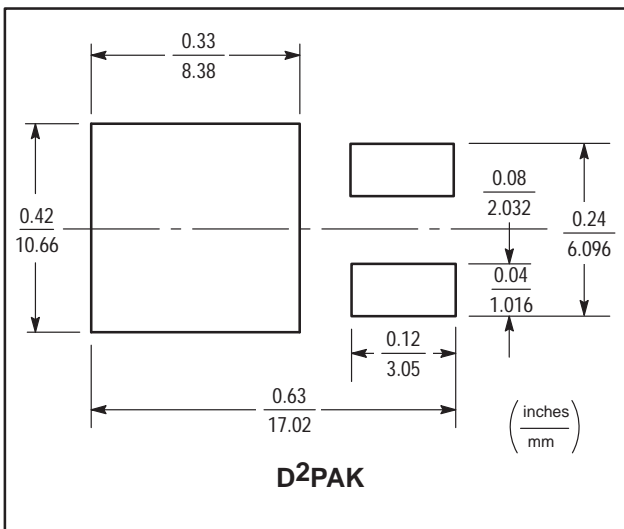
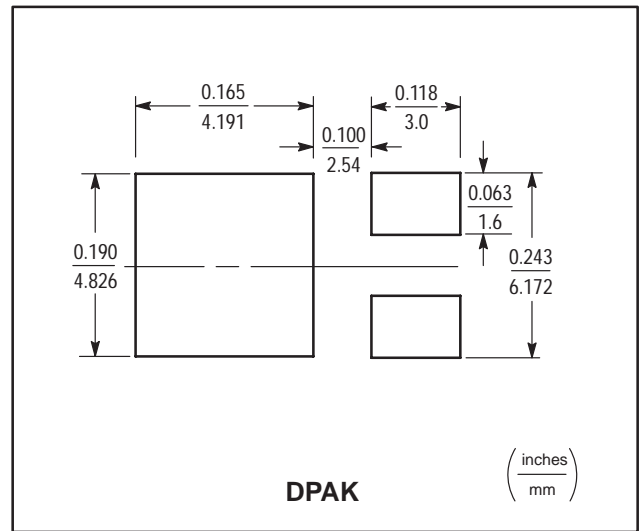
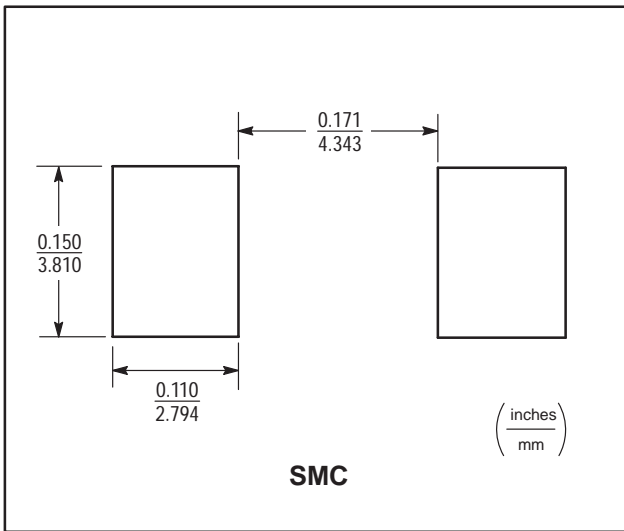
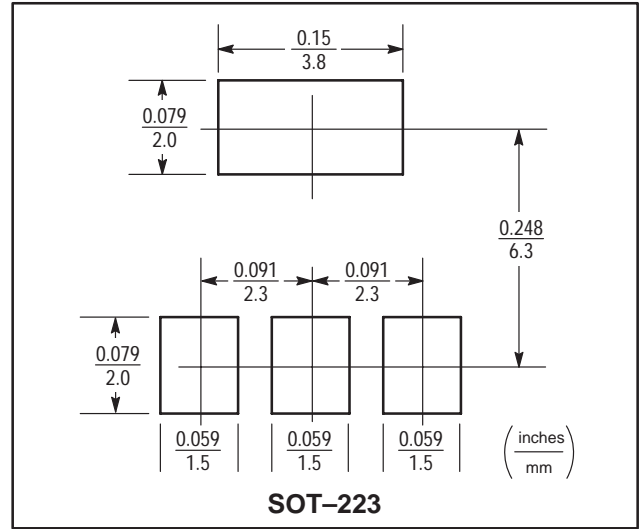
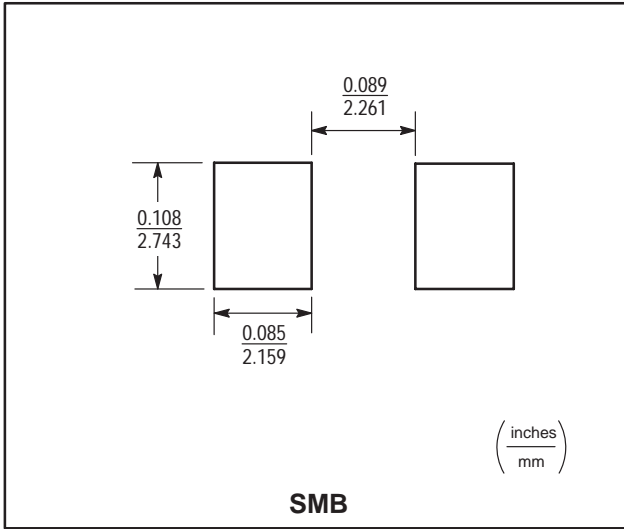


Figure 5. Typical Solder Heating Profile

Footprints for Soldering

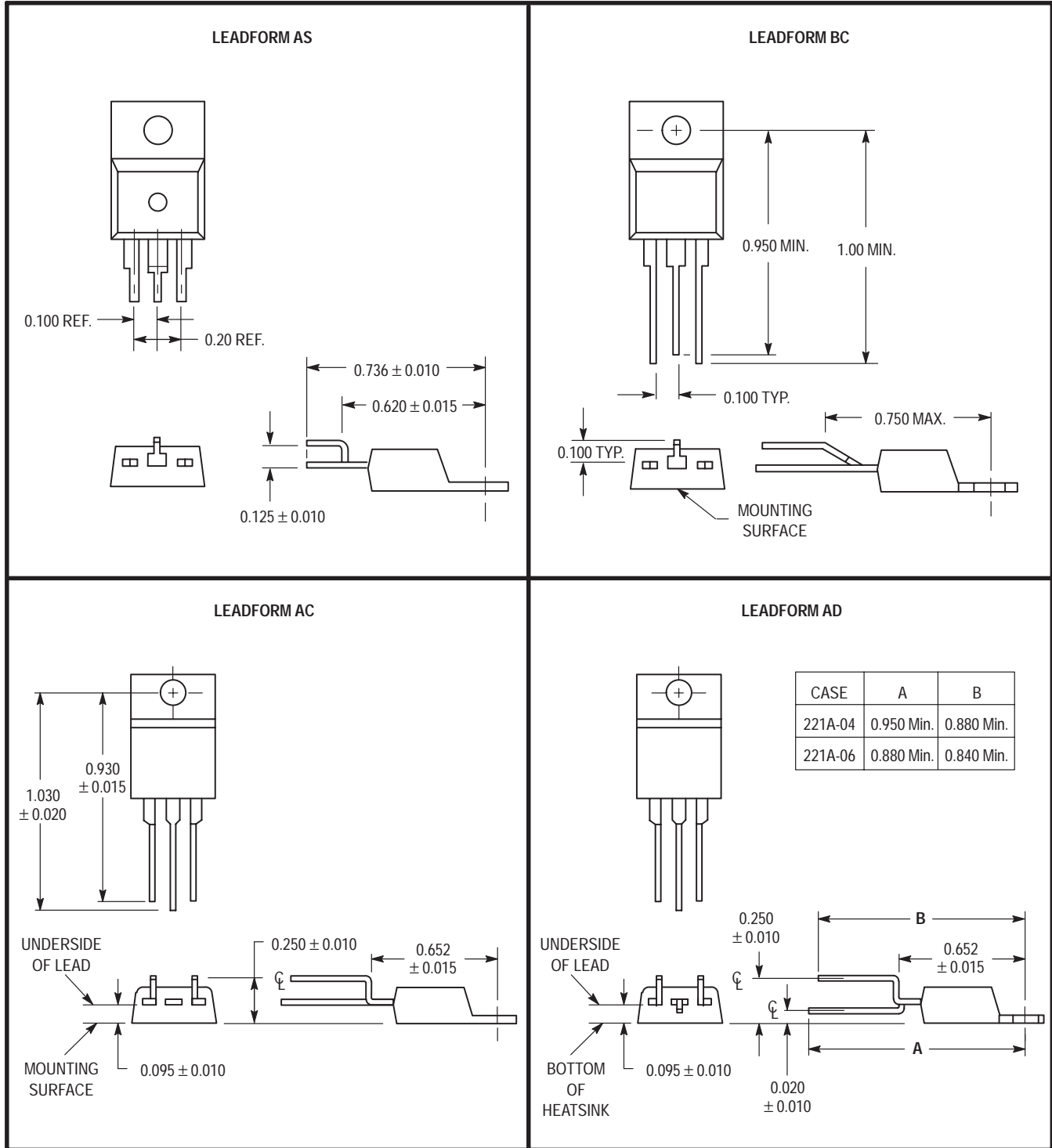


Section 8

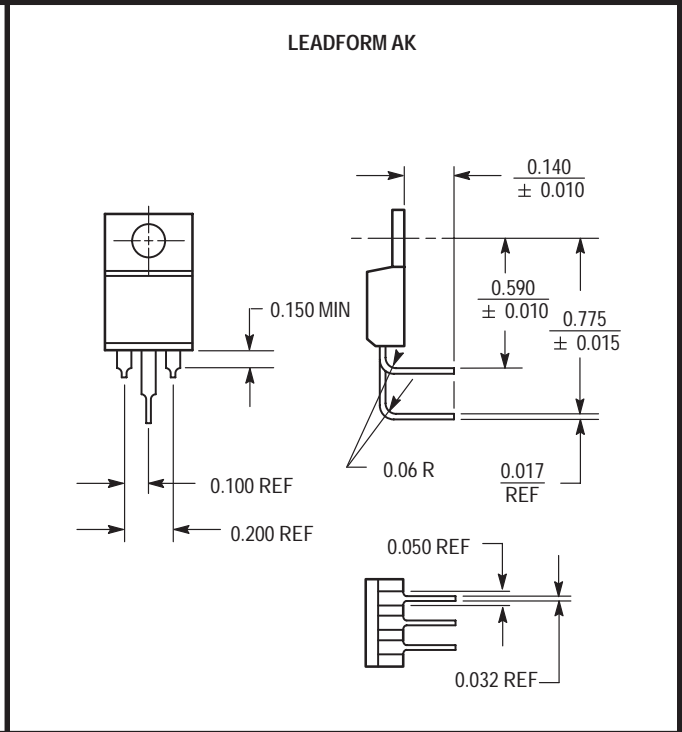
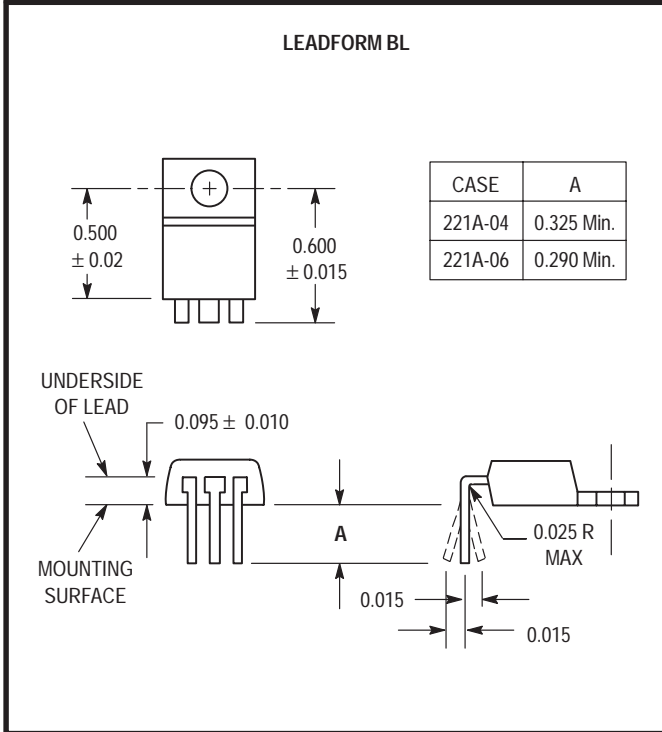
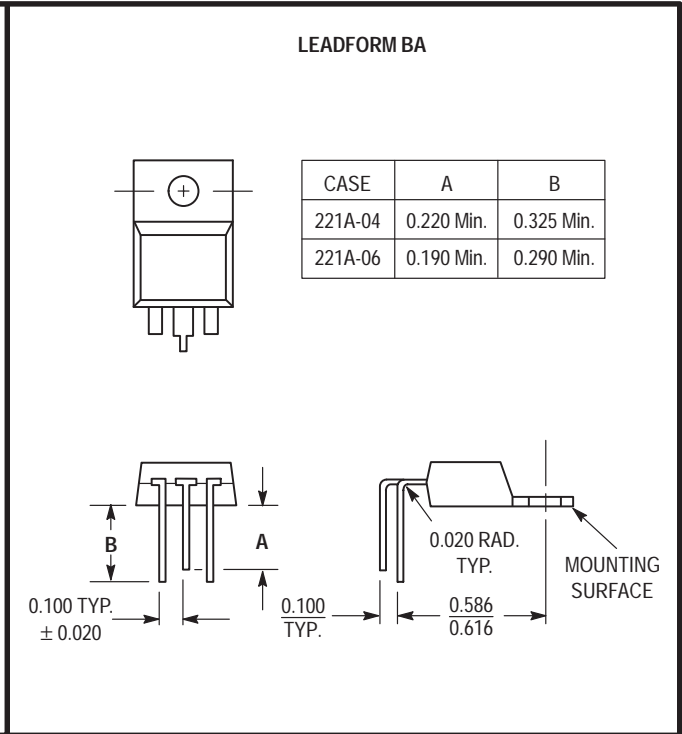
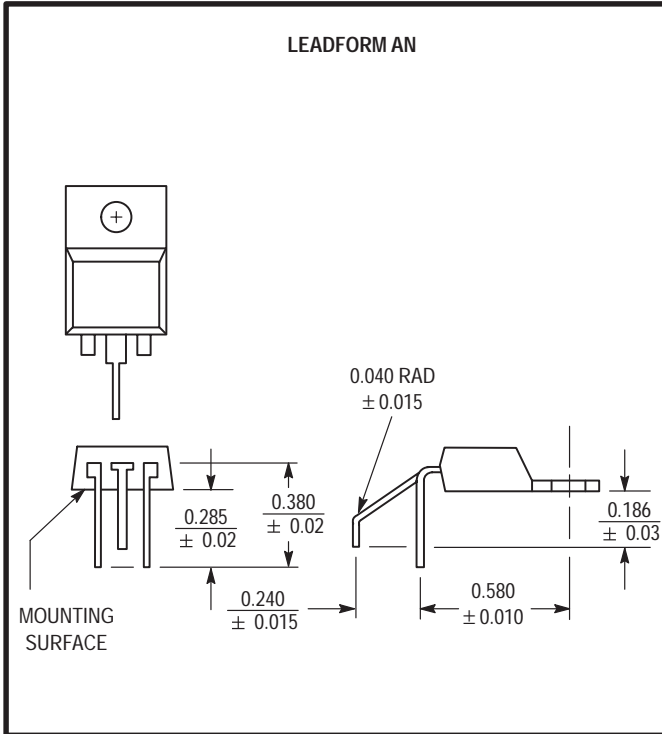
TO–220 Leadform Information

Leadform Options — TO-220 (Case 221A)

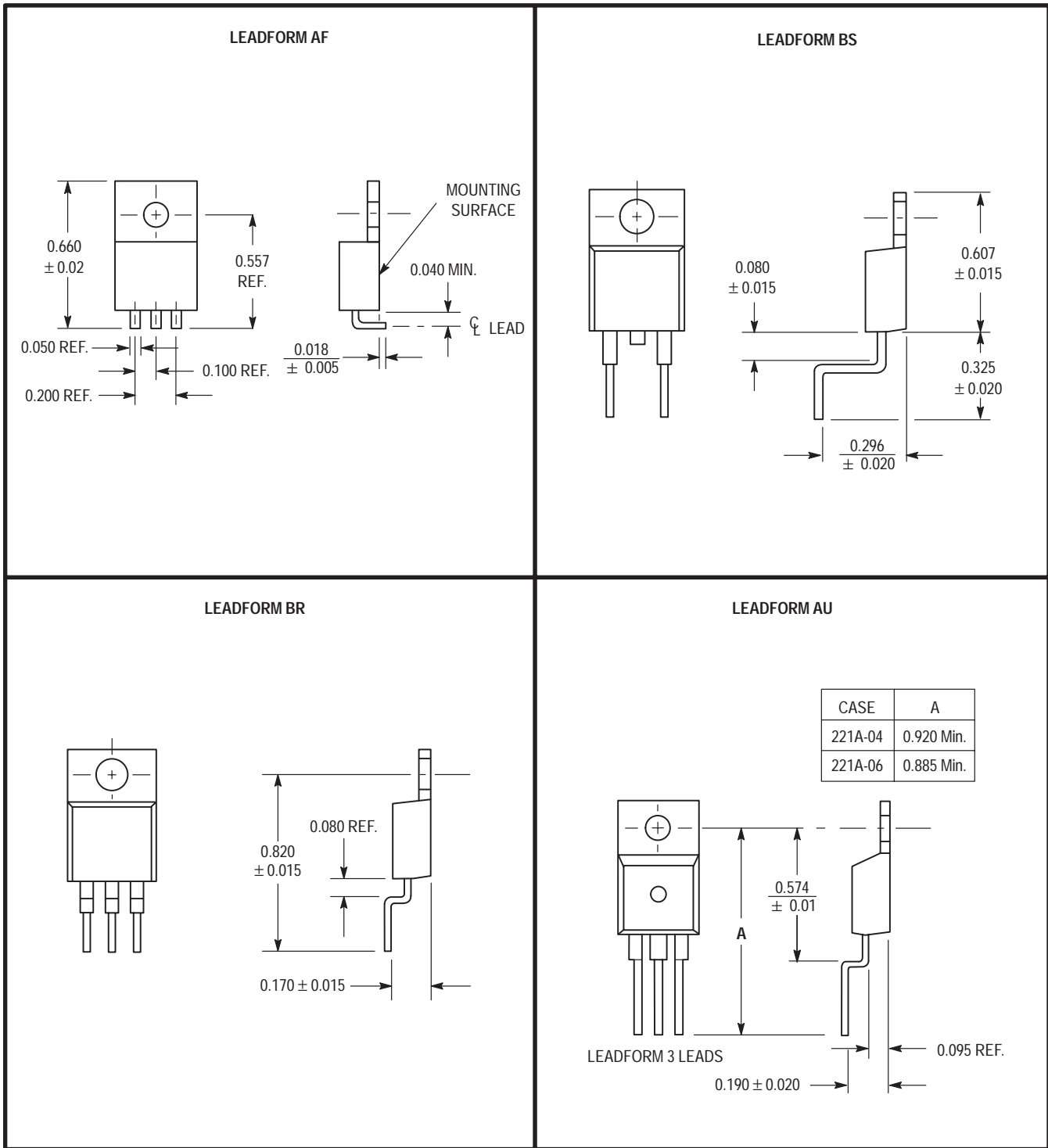
- Leadform options require assignment of a special part number before ordering.
- Contact your local Motorola representative for special part number and pricing.
- 10,000 piece minimum quantity orders are required.
- Leadform orders are non-cancellable after processing.
- Leadforms apply to both Motorola Case 221A-04 and 221A-06 except as noted.



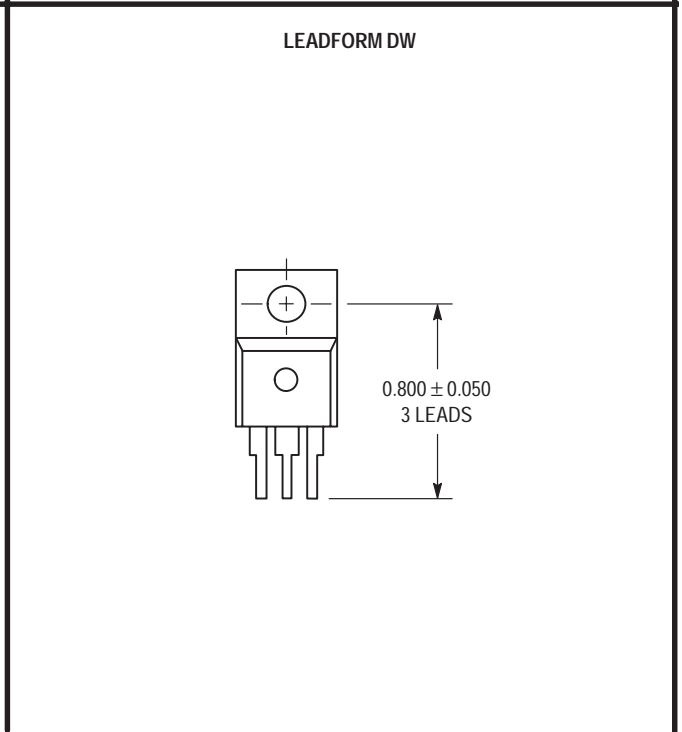
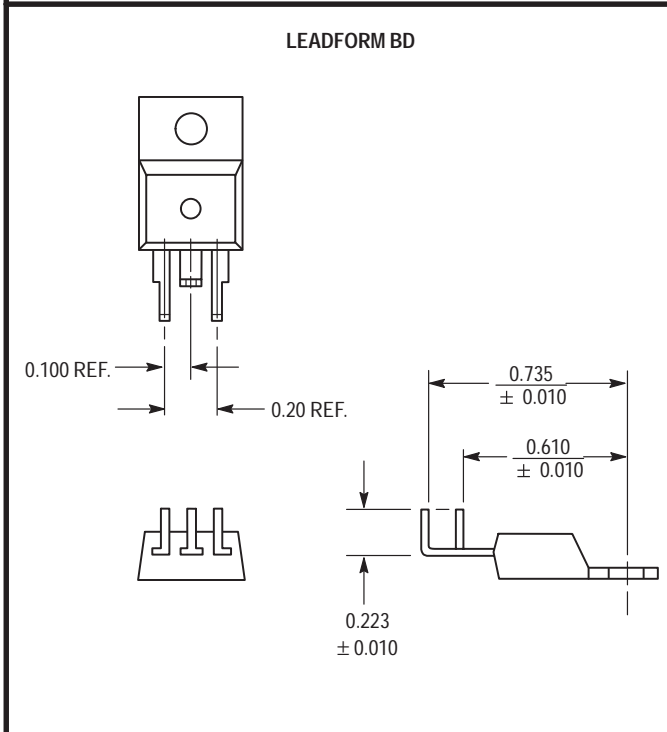
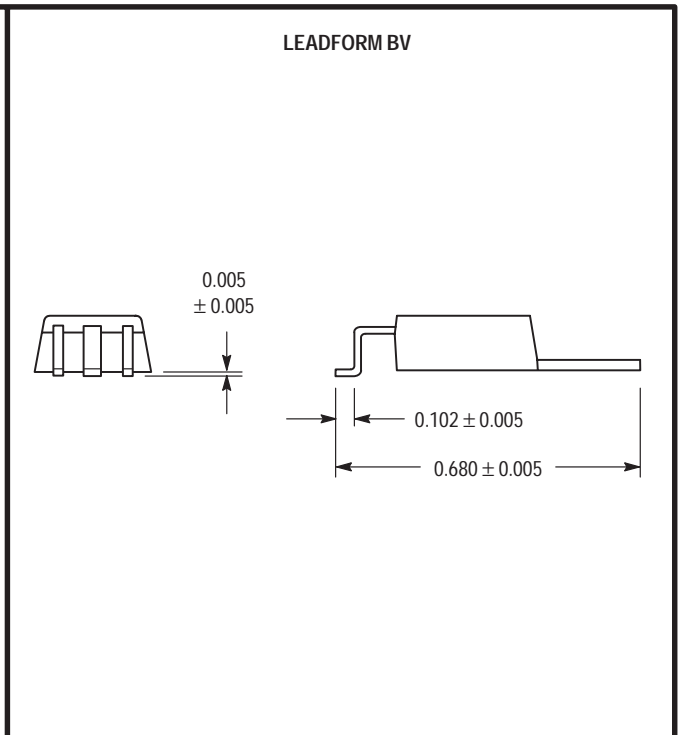
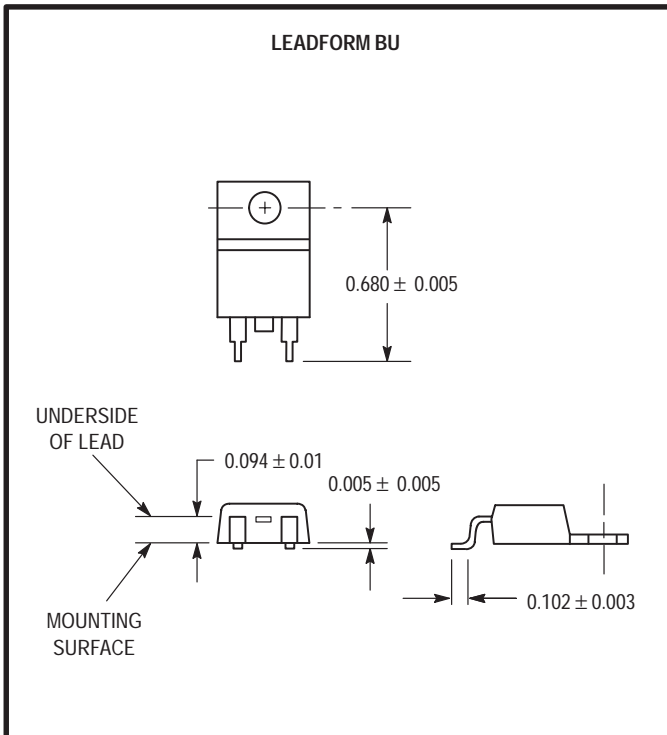
TO-220 Leadform Options (continued)



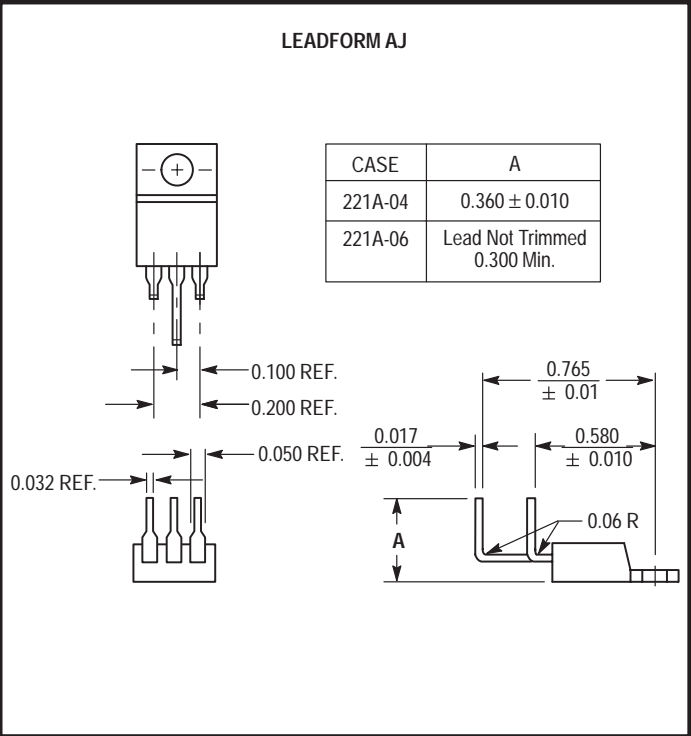
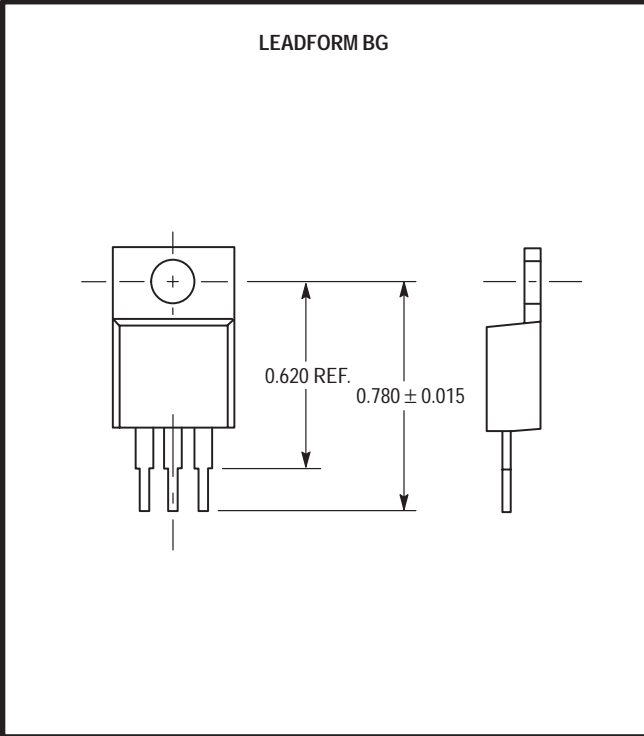
TO-220 Leadform Options (continued)



TO-220 Leadform Options (continued)



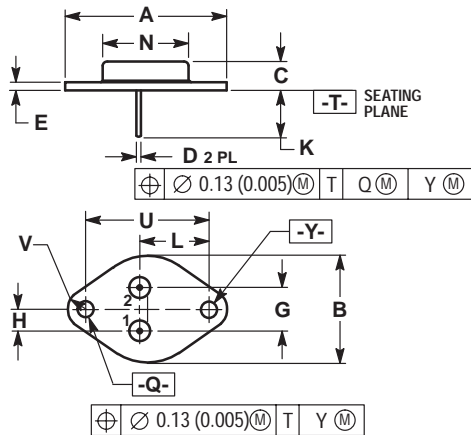
TO-220 Leadform Options (continued)



Section 9

Package Outline Dimensions and Footprints

Package Outline Dimensions and Footprints

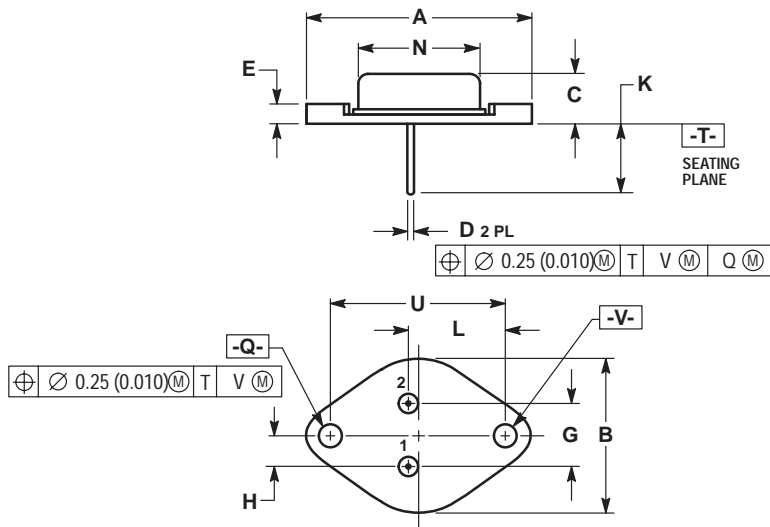


- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. ALL RULES AND NOTES ASSOCIATED WITH REFERENCED TO-204AA OUTLINE SHALL APPLY.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	1.550 REF	—	39.37 REF	—
B	—	1.050	—	26.67
C	0.250	0.335	6.35	8.51
D	0.038	0.043	0.97	1.09
E	0.055	0.070	1.40	1.77
G	0.430 BSC	—	10.92 BSC	—
H	0.215 BSC	—	5.46 BSC	—
K	0.440	0.480	11.18	12.19
L	0.665 BSC	—	16.89 BSC	—
N	—	0.830	—	21.08
Q	0.151	0.165	3.84	4.19
U	1.187 BSC	—	30.15 BSC	—
V	0.131	0.188	3.33	4.77

- | | | | | |
|--|--|---|---|---|
| STYLE 1:
PIN 1. BASE
2. EMITTER
CASE: COLLECTOR | STYLE 2:
PIN 1. BASE
2. COLLECTOR
CASE: EMITTER | STYLE 3:
PIN 1. GATE
2. SOURCE
CASE: DRAIN | STYLE 4:
PIN 1. GROUND
2. INPUT
CASE: OUTPUT | STYLE 5:
PIN 1. CATHODE
2. EXTERNAL TRIP/DELAY
CASE: ANODE |
| STYLE 6:
PIN 1. GATE
2. EMITTER
CASE: COLLECTOR | STYLE 7:
PIN 1. ANODE
2. OPEN
CASE: CATHODE | STYLE 8:
PIN 1. CATHODE #1
2. CATHODE #2
CASE: ANODE | STYLE 9:
PIN 1. ANODE #1
2. ANODE #2
CASE: CATHODE | |

**CASE 1-07
ISSUE Z**



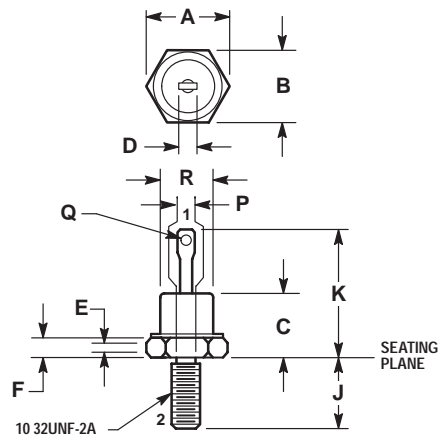
- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	—	1.550	—	39.37
B	—	1.050	—	26.67
C	0.250	0.450	6.35	11.43
D	0.039	0.043	0.99	1.09
E	—	0.135	—	3.43
G	0.430 BSC	—	10.92 BSC	—
H	0.215 BSC	—	5.46 BSC	—
K	0.440	0.480	11.18	12.19
L	0.665 BSC	—	16.89 BSC	—
N	—	0.830	—	21.08
Q	0.151	0.161	3.84	4.09
U	1.187 BSC	—	30.15 BSC	—
V	0.151	0.161	3.84	4.09

- | | | | | |
|--|--|--|---|---|
| STYLE 1:
PIN 1. BASE
2. EMITTER
CASE: COLLECTOR | STYLE 2:
PIN 1. EMITTER
2. BASE
CASE: COLLECTOR | STYLE 3:
PIN 1. ANODE
2. CATHODE | STYLE 4:
PIN 1. ANODE #1
2. ANODE #2
CASE: CATHODE | STYLE 5:
1. CATHODE #1
2. CATHODE #2
CASE: ANODE |
|--|--|--|---|---|

**CASE 11-03
ISSUE G**

PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)



NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

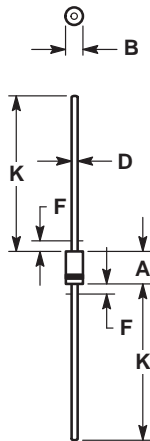
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	—	0.505	—	12.82
B	0.424	0.437	10.77	11.09
C	—	0.405	—	10.28
D	—	0.250	—	6.35
E	0.060	—	1.53	—
F	0.075	0.175	1.91	4.44
J	0.422	0.453	10.72	11.50
K	0.600	0.800	15.24	20.32
P	0.163	0.189	4.14	4.80
Q	0.060	0.095	1.53	2.41
R	0.265	0.424	6.74	10.76

STYLE 1:
 TERM. 1. CATHODE
 2. ANODE

STYLE 2:
 TERM. 1. ANODE
 2. CATHODE

STYLE 3:
 TERM. 1. ANODE
 2. ANODE

**CASE 56-03
 (DO-4)
 ISSUE G**

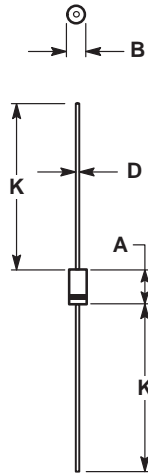


NOTES:
 1. POLARITY DENOTED BY CATHODE BAND.
 2. LEAD DIAMETER NOT CONTROLLED WITHIN DIMENSION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.07	5.20	0.160	0.205
B	2.04	2.71	0.080	0.107
D	0.71	0.86	0.028	0.034
F	—	1.27	—	0.050
K	27.94	—	1.100	—

**CASE 59-03
 (DO-41)
 ISSUE M**

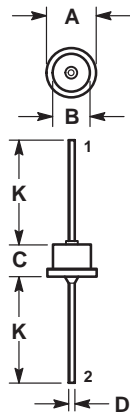
PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)



- NOTES:
 1. POLARITY DENOTED BY CATHODE BAND.
 2. LEAD DIAMETER NOT CONTROLLED WITHIN F DIMENSION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	5.97	6.60	0.235	0.260
B	2.79	3.05	0.110	0.120
D	0.76	0.86	0.030	0.034
K	27.94	—	1.100	—

**CASE 59-04
 (DO-41)
 ISSUE M**



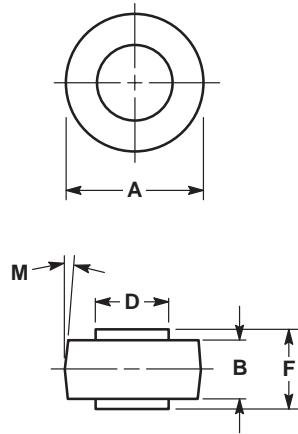
- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	—	0.450	—	11.43
B	—	0.350	—	8.89
C	—	0.300	—	7.62
D	0.046	0.056	1.17	1.42
K	0.980	—	24.90	—

- STYLE 1:
 PIN 1. CATHODE
 2. ANODE
- STYLE 2:
 PIN 1. ANODE
 2. CATHODE

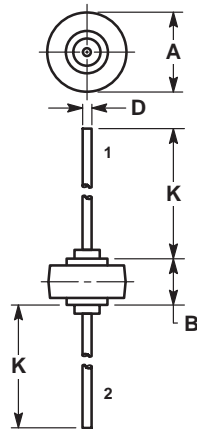
**CASE 60-01
 ISSUE E**

PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.43	8.69	0.332	0.342
B	4.19	4.45	0.165	0.175
D	5.54	5.64	0.218	0.222
F	5.94	6.25	0.234	0.246
M	5° NOM		5° NOM	

CASE 193-04
ISSUE J



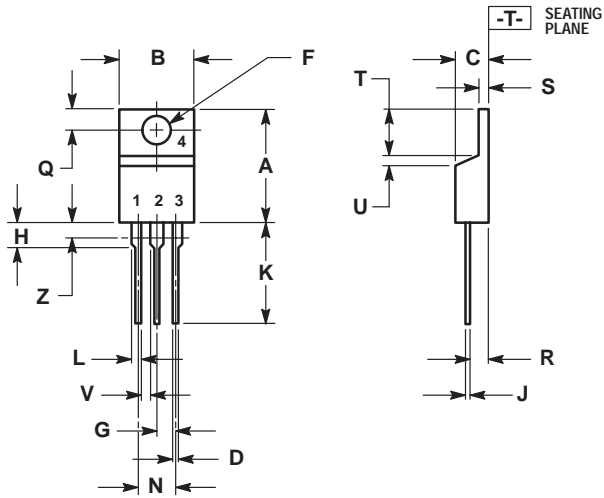
NOTES:
1. CATHODE SYMBOL ON PACKAGE.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.43	8.69	0.332	0.342
B	5.94	6.25	0.234	0.246
D	1.27	1.35	0.050	0.053
K	25.15	25.65	0.990	1.010

STYLE 1:
PIN 1. CATHODE
2. ANODE

CASE 194-04
ISSUE F

PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.570	0.620	14.48	15.75
B	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
H	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	—	1.15	—
Z	—	0.080	—	2.04

STYLE 1:
PIN 1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

STYLE 2:
PIN 1. BASE
2. EMITTER
3. COLLECTOR
4. EMITTER

STYLE 3:
PIN 1. CATHODE
2. ANODE
3. GATE
4. ANODE

STYLE 4:
PIN 1. MAIN TERMINAL 1
2. MAIN TERMINAL 2
3. GATE
4. MAIN TERMINAL 2

STYLE 5:
PIN 1. GATE
2. DRAIN
3. SOURCE
4. DRAIN

STYLE 6:
PIN 1. ANODE
2. CATHODE
3. ANODE
4. CATHODE

STYLE 7:
PIN 1. CATHODE
2. ANODE
3. CATHODE
4. ANODE

STYLE 8:
PIN 1. CATHODE
2. ANODE
3. EXTERNAL TRIP/DELAY
4. ANODE

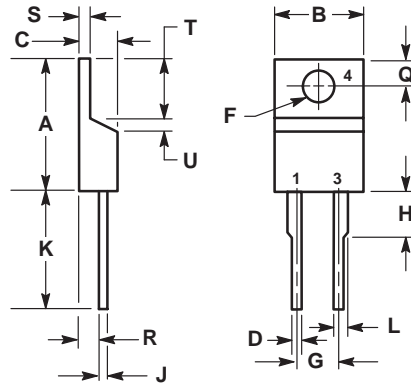
STYLE 9:
PIN 1. GATE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

STYLE 10:
PIN 1. GATE
2. SOURCE
3. DRAIN
4. SOURCE

STYLE 11:
PIN 1. DRAIN
2. SOURCE
3. GATE
4. SOURCE

**CASE 221A-06
(TO-220AB)
ISSUE Y**

PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)

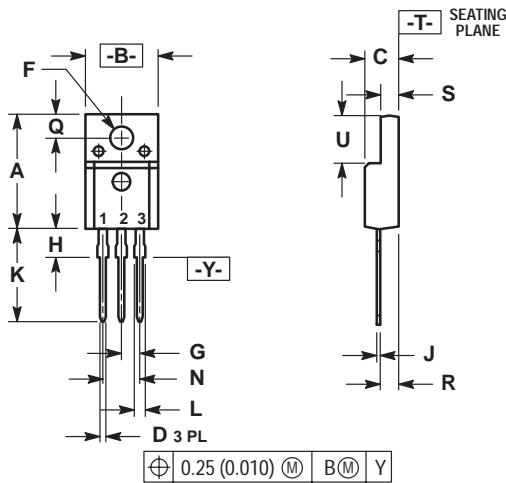


NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.595	0.620	15.11	15.75
B	0.380	0.405	9.65	10.29
C	0.160	0.190	4.06	4.82
D	0.025	0.035	0.64	0.89
F	0.142	0.147	3.61	3.73
G	0.190	0.210	4.83	5.33
H	0.110	0.130	2.79	3.30
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.14	1.52
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.14	1.39
T	0.235	0.255	5.97	6.48
U	0.000	0.050	0.00	1.27

- | | |
|----------------|--------------|
| STYLE 1: | STYLE 2: |
| PIN 1. CATHODE | PIN 1. ANODE |
| 2. N/A | 2. N/A |
| 3. ANODE | 3. CATHODE |
| 4. CATHODE | 4. ANODE |

**CASE 221B-03
ISSUE B**



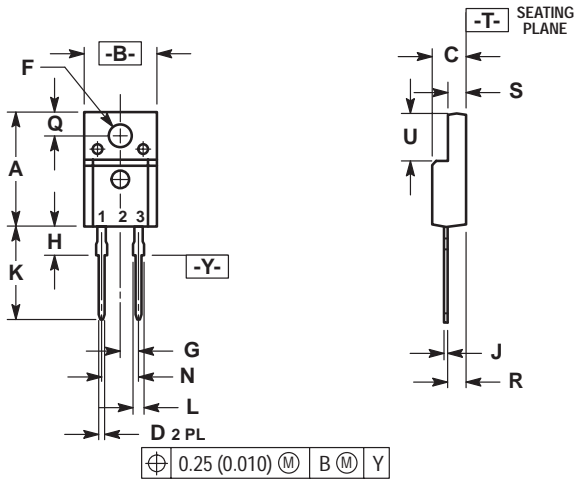
NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.621	0.629	15.78	15.97
B	0.394	0.402	10.01	10.21
C	0.181	0.189	4.60	4.80
D	0.026	0.034	0.67	0.86
F	0.121	0.129	3.08	3.27
G	0.100 BSC		2.54 BSC	
H	0.123	0.129	3.13	3.27
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.14	1.52
N	0.200 BSC		5.08 BSC	
Q	0.126	0.134	3.21	3.40
R	0.107	0.111	2.72	2.81
S	0.096	0.104	2.44	2.64
U	0.259	0.267	6.58	6.78

- | | | | | | |
|-------------|--------------|--------------|----------------|----------------|-------------|
| STYLE 1: | STYLE 2: | STYLE 3: | STYLE 4: | STYLE 5: | STYLE 6: |
| PIN 1. GATE | PIN 1. BASE | PIN 1. ANODE | PIN 1. CATHODE | PIN 1. CATHODE | PIN 1. MT 1 |
| 2. DRAIN | 2. COLLECTOR | 2. CATHODE | 2. ANODE | 2. ANODE | 2. MT 2 |
| 3. SOURCE | 3. EMITTER | 3. ANODE | 3. CATHODE | 3. GATE | 3. GATE |

**CASE 221D-02
ISSUE D**

PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)

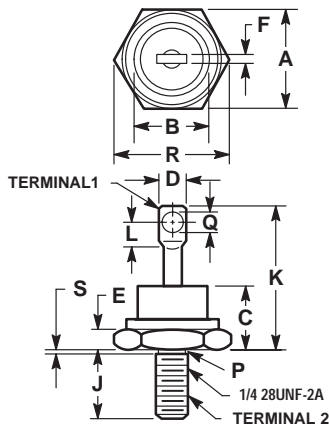


- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.621	0.629	15.78	15.97
B	0.394	0.402	10.01	10.21
C	0.181	0.189	4.60	4.80
D	0.026	0.034	0.67	0.86
F	0.121	0.129	3.08	3.27
G	0.100 BSC		2.54 BSC	
H	0.123	0.129	3.13	3.27
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.14	1.52
N	0.200 BSC		5.08 BSC	
Q	0.126	0.134	3.21	3.40
R	0.107	0.111	2.72	2.81
S	0.096	0.104	2.44	2.64
U	0.259	0.267	6.58	6.78

- STYLE 1:
 PIN 1: CATHODE
 2. N/A
 3. ANODE

CASE 221E-01
 ISSUE O



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. DIMENSION P IS A DIAMETER.
 3. CHAMFER OR UNDERCUT ON ONE OR BOTH ENDS OF HEXAGONAL BASE IS OPTIONAL.
 4. ANGULAR ORIENTATION AND CONTOUR OF TERMINAL ONE IS OPTIONAL.
 5. THREADS ARE PLATED.

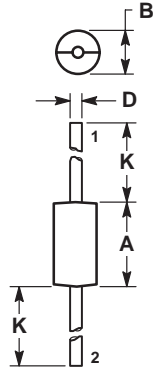
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	16.94	17.45	0.669	0.687
B	—	16.94	—	0.667
C	—	11.43	—	0.450
D	—	9.53	—	0.375
E	2.92	5.08	0.115	0.200
F	—	2.03	—	0.080
J	10.72	11.51	0.422	0.453
K	—	25.40	—	1.000
L	3.86	—	0.156	—
P	5.59	6.32	0.220	0.249
Q	3.56	4.45	0.140	0.175
R	—	20.16	—	0.794
S	—	2.26	—	0.089

- STYLE 1:
 TERMINAL 1: CATHODE
 2. ANODE (CASE)

- STYLE 2:
 TERMINAL 1: ANODE
 2. CATHODE (CASE)

CASE 257-01
 ISSUE B

PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)

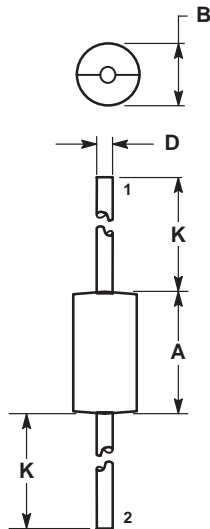


- NOTES:
 1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	—	0.370	—	9.39
B	—	0.250	—	6.35
D	0.048	0.052	1.22	1.32
K	1.000	—	25.40	—

STYLE 1:
 PIN 1. CATHODE
 2. ANODE

**CASE 267-02
 ISSUE B**



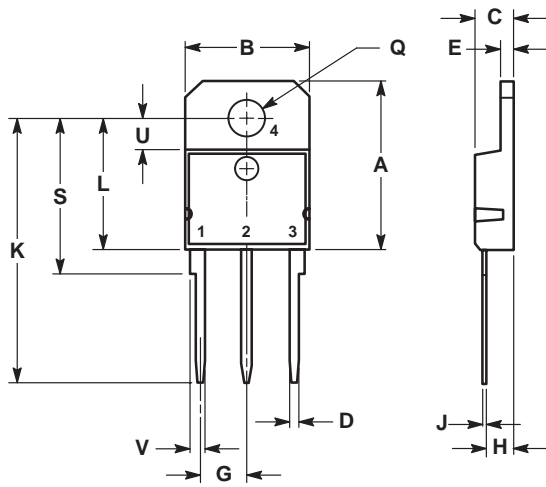
- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.370	0.380	9.40	9.65
B	0.190	0.210	4.83	5.33
D	0.048	0.052	1.22	1.32
K	1.000	—	25.40	—

STYLE 1:
 PIN 1. CATHODE
 2. ANODE

**CASE 267-03
 ISSUE C**

PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)

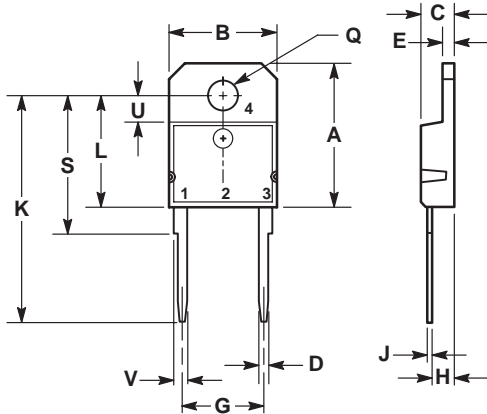


- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	19.00	19.60	0.749	0.771
B	14.00	14.50	0.551	0.570
C	4.20	4.70	0.165	0.185
D	1.00	1.30	0.040	0.051
E	1.45	1.65	0.058	0.064
G	5.21	5.72	0.206	0.225
H	2.60	3.00	0.103	0.118
J	0.40	0.60	0.016	0.023
K	28.50	32.00	1.123	1.259
L	14.70	15.30	0.579	0.602
Q	4.00	4.25	0.158	0.167
S	17.50	18.10	0.689	0.712
U	3.40	3.80	0.134	0.149
V	1.50	2.00	0.060	0.078

- STYLE 1:
 PIN 1. BASE
 2. COLLECTOR
 3. EMITTER
 4. COLLECTOR
- STYLE 2:
 PIN 1. ANODE
 2. CATHODE
 3. ANODE
 4. CATHODE

**CASE 340D-01
 ISSUE A**



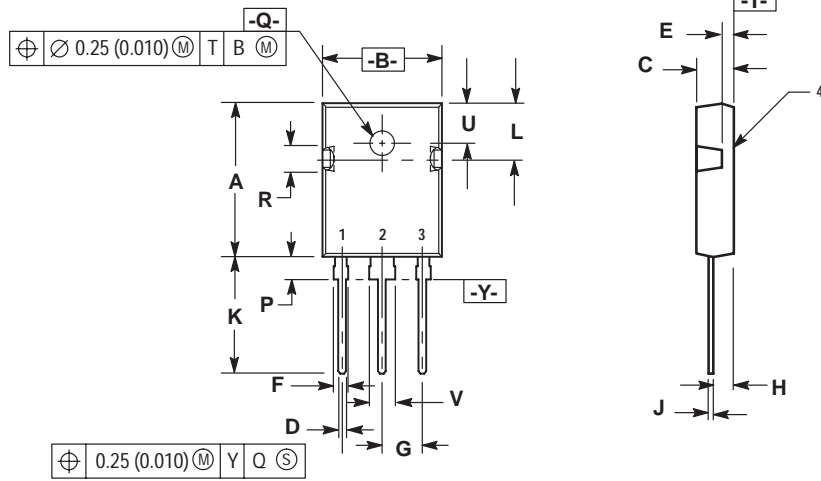
- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982
 2. CONTROLLING DIMENSION: MILLIMETER.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	19.00	19.60	0.749	0.771
B	14.00	14.50	0.551	0.570
C	4.20	5.00	0.165	0.196
D	1.00	1.30	0.040	0.051
E	1.45	1.65	0.058	0.064
G	10.42	11.44	0.411	0.450
H	2.60	3.00	0.103	0.118
J	0.40	0.60	0.016	0.023
K	28.50	32.00	1.123	1.259
L	14.70	15.30	0.579	0.602
Q	4.00	4.25	0.158	0.167
S	17.50	19.50	0.689	0.767
U	3.40	3.80	0.134	0.149
V	1.50	2.00	0.060	0.078

- STYLE 1:
 PIN 1. CATHODE
 3. ANODE
 4. CATHODE

**CASE 340E-01
 ISSUE O**

PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)



NOTES:
 4. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 5. CONTROLLING DIMENSION: MILLIMETER.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	20.40	20.90	0.803	0.823
B	15.44	15.95	0.608	0.628
C	4.70	5.21	0.185	0.205
D	1.09	1.30	0.043	0.051
E	1.50	1.63	0.059	0.064
F	1.80	2.18	0.071	0.086
G	5.45 BSC		0.215 BSC	
H	2.56	2.87	0.101	0.113
J	0.48	0.68	0.019	0.027
K	15.57	16.08	0.613	0.633
L	7.26	7.50	0.286	0.295
P	3.10	3.38	0.122	0.133
Q	3.50	3.70	0.138	0.145
R	3.30	3.80	0.130	0.150
U	5.30 BSC		0.209 BSC	
V	3.05	3.40	0.120	0.134

- | | | | |
|--|--|---|---|
| STYLE 1:
PIN 1. GATE
2. DRAIN
3. SOURCE
4. DRAIN | STYLE 2:
PIN 1. ANODE 1
2. CATHODE(S)
3. ANODE 2
4. CATHODE(S) | STYLE 3:
PIN 1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR | STYLE 4:
PIN 1. GATE
2. COLLECTOR
3. EMITTER
4. COLLECTOR |
|--|--|---|---|

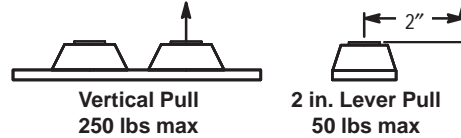
CASE 340F-03
 ISSUE E

PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)

MAXIMUM MECHANICAL RATINGS

Terminal Penetration:	0.235 max
Terminal Torque:	25–40 in-lb max
Mounting Torque — Outside Holes:	30–40 in-lb max
Mounting Torque — Center Hole:	8–10 in-lb max
Seating Plane Flatness	1 mil per in. (between mounting holes)

POWERTAP MECHANICAL DATA APPLIES OVER OPERATING TEMPERATURE



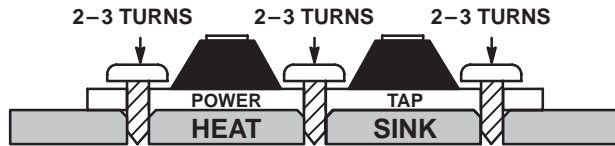
Note: While the POWERTAP is capable of sustaining these vertical and levered tensions, the intimate contact between POWERTAP and heat sink may be lost. This could lead to thermal runaway. The use of very flexible leads is recommended for the anode connections. Use of thermal grease is highly recommended.

MOUNTING PROCEDURE

The POWERTAP package requires special mounting considerations because of the long longitudinal axis of the copper heat sink. It is important to follow the proper tightening sequence to avoid warping the heat sink, which can reduce thermal contact between the POWERTAP and heat sink.

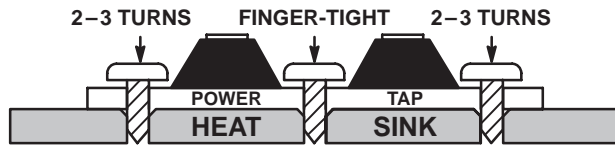
STEP 1:

Locate the POWERTAP on the heat sink and start mounting bolts into the threads by hand (2 or 3 turns).



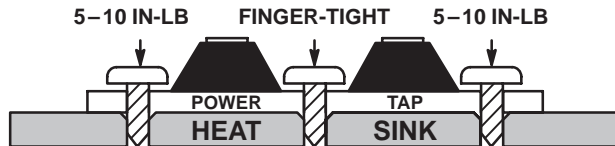
STEP 2:

Finger tighten the center bolt. The bolt may catch on the threads of the heat sink so it is important to make sure the face of the bolt or washer is in contact with the surface of the POWERTAP.



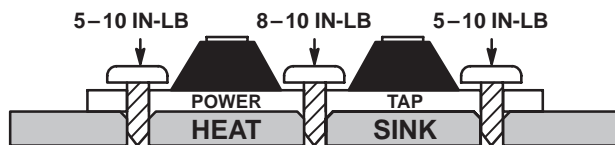
STEP 3:

Tighten each of the end bolts between 5 to 10 in-lb.



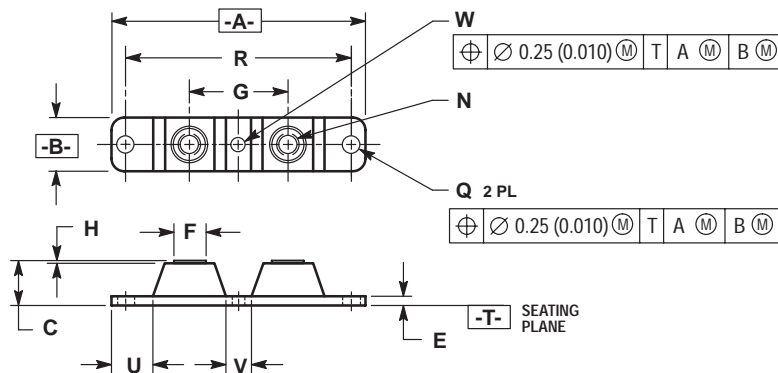
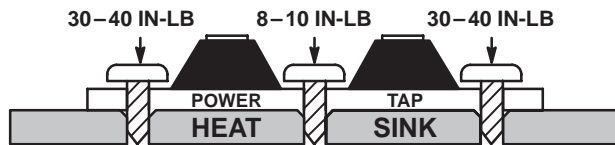
STEP 4:

Tighten the center bolt between 8 to 10 in-lb.



STEP 5:

Finally, tighten the end bolts between 30 to 40 in-lb.

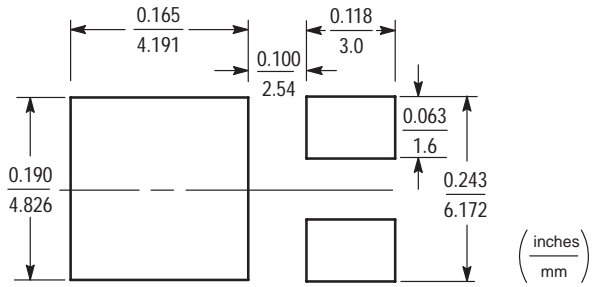


- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. TERMINAL PENETRATION: 5.97 (0.235) MAXIMUM.

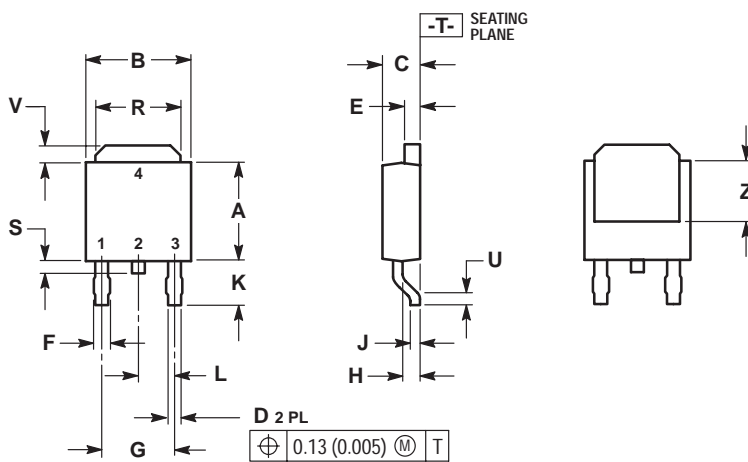
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	3.450	3.635	87.63	92.33
B	0.700	0.810	17.78	20.57
C	0.615	0.640	15.53	16.26
E	0.120	0.130	3.05	3.30
F	0.435	0.445	11.05	11.30
G	1.370	1.380	34.80	35.05
H	0.007	0.030	0.18	0.76
N	1/4–20UNC 2B		1/4–20UNC 2B	
Q	0.270	0.285	6.86	7.32
R	31.50 BSC		80.01 BSC	
U	0.600	0.630	15.24	16.00
V	0.330	0.375	8.39	9.52
W	0.170	0.190	4.32	4.82

CASE 357C–03
ISSUE C

PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)



DPAK
FOOTPRINT



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.235	0.250	5.97	6.35
B	0.250	0.265	6.35	6.73
C	0.086	0.094	2.19	2.38
D	0.027	0.035	0.69	0.88
E	0.033	0.040	0.84	1.01
F	0.037	0.047	0.94	1.19
G	0.180 BSC		4.58 BSC	
H	0.034	0.040	0.87	1.01
J	0.018	0.023	0.46	0.58
K	0.102	0.114	2.60	2.89
L	0.090 BSC		2.29 BSC	
R	0.175	0.215	4.45	5.46
S	0.020	0.050	0.51	1.27
U	0.020	—	0.51	—
V	0.030	0.050	0.77	1.27
Z	0.138	—	3.51	—

- STYLE 1:
PIN 1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

- STYLE 2:
PIN 1. GATE
2. DRAIN
3. SOURCE
4. DRAIN

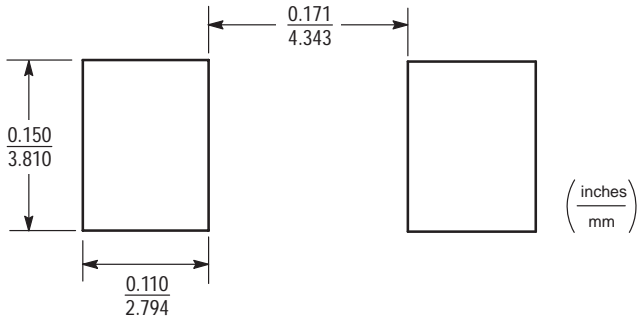
- STYLE 3:
PIN 1. ANODE
2. N/A
3. ANODE
4. CATHODE

- STYLE 4:
PIN 1. CATHODE
2. ANODE
3. GATE
4. ANODE

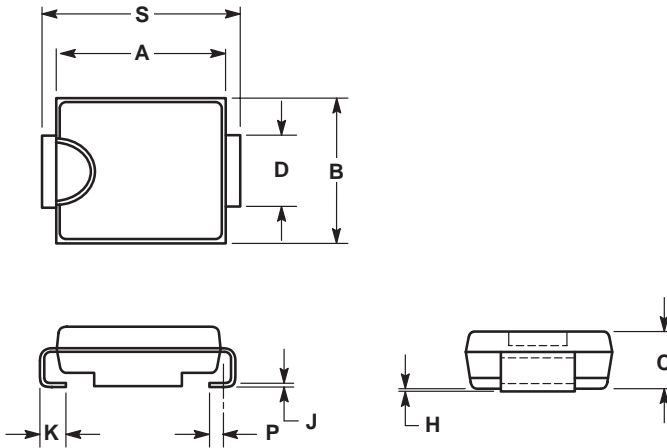
- STYLE 5:
PIN 1. GATE
2. ANODE
3. CATHODE
4. ANODE

CASE 369A-13
(DPAK)
ISSUE W

PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)



**SMC
FOOTPRINT**

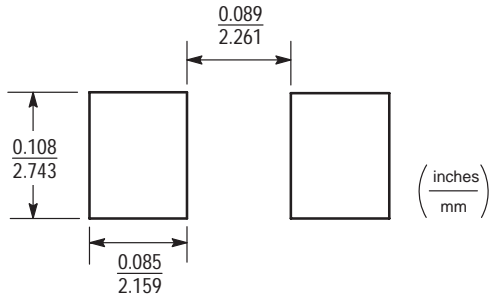


- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. D DIMENSION SHALL BE MEASURED WITHIN DIMENSION P.

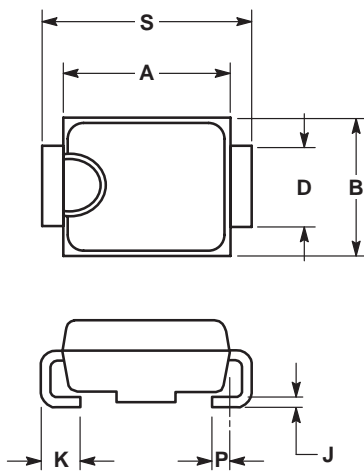
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.260	0.280	6.60	7.11
B	0.220	0.240	5.59	6.10
C	0.075	0.095	1.90	2.41
D	0.115	0.121	2.92	3.07
H	0.0020	0.0060	0.051	0.152
J	0.006	0.012	0.15	0.30
K	0.030	0.050	0.76	1.27
P	0.020 REF		0.51 REF	
S	0.305	0.320	7.75	8.13

**CASE 403-03
(SMC)
ISSUE B**

PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)



**SMB
FOOTPRINT**

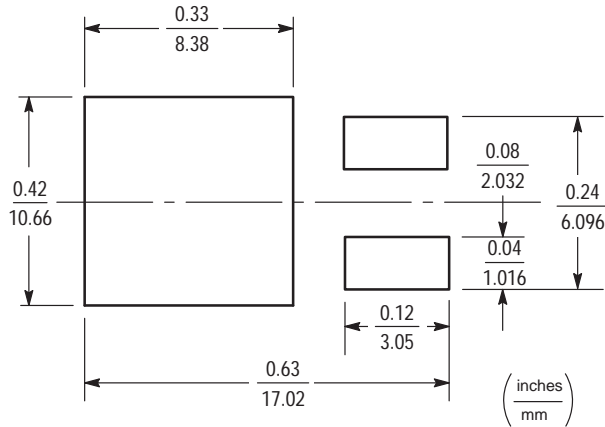


- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. D DIMENSION SHALL BE MEASURED WITHIN DIMENSION P.

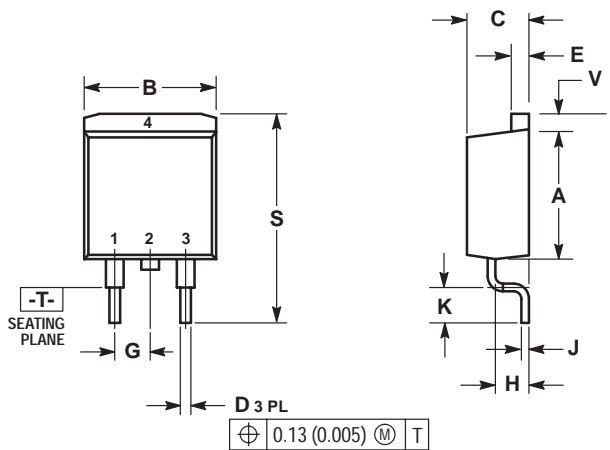
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.160	0.180	4.06	4.57
B	0.130	0.150	3.30	3.81
C	0.075	0.095	1.90	2.41
D	0.077	0.083	1.96	2.11
H	0.0020	0.0060	0.051	0.152
J	0.006	0.012	0.15	0.30
K	0.030	0.050	0.76	1.27
P	0.020 REF		0.51 REF	
S	0.205	0.220	5.21	5.59

**CASE 403A-03
(SMB)
ISSUE B**

PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)



**D2PAK
FOOTPRINT**



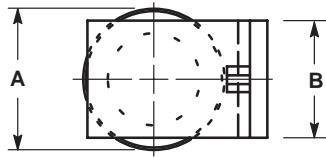
- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.340	0.380	8.64	9.65
B	0.380	0.405	9.65	10.29
C	0.160	0.190	4.06	4.83
D	0.020	0.035	0.51	0.89
E	0.045	0.055	1.14	1.40
G	0.100 BSC		2.54 BSC	
H	0.080	0.110	2.03	2.79
J	0.018	0.025	0.46	0.64
K	0.090	0.110	2.29	2.79
S	0.575	0.625	14.60	15.88
V	0.045	0.055	1.14	1.40

- STYLE 1:
 PIN 1. BASE
 2. COLLECTOR
 3. EMITTER
 4. COLLECTOR
- STYLE 2:
 PIN 1. GATE
 2. DRAIN
 3. SOURCE
 4. DRAIN
- STYLE 3:
 PIN 1. ANODE
 2. N/A
 3. ANODE
 4. CATHODE

**CASE 418B-02
D2PAK
ISSUE B**

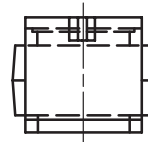
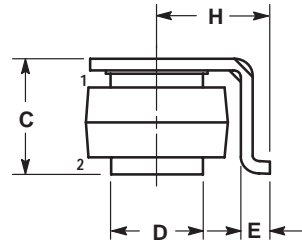
PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)



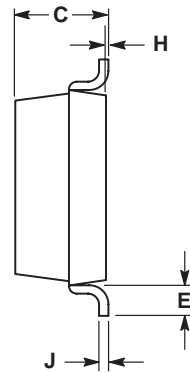
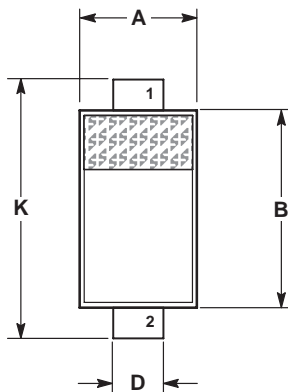
- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.330	0.342	8.38	8.69
B	0.270	0.090	6.86	7.37
C	0.275	0.290	6.98	7.37
D	0.218	0.223	5.54	5.66
E	0.060	0.080	1.52	2.03
H	0.255	0.275	6.48	6.98

- STYLE 1:
 PIN 1. CATHODE
 2. ANODE



**CASE 421A-01
 ISSUE O**



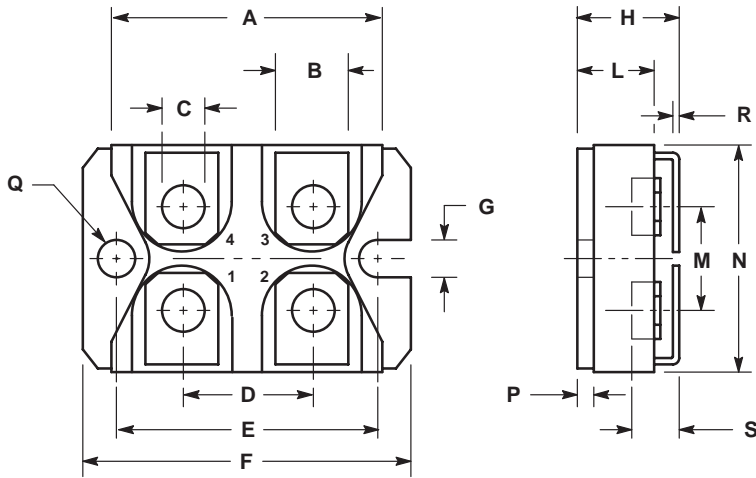
- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.055	0.071	1.40	1.80
B	0.100	0.112	2.55	2.85
C	0.037	0.053	0.95	1.35
D	0.020	0.028	0.50	0.70
E	0.010	—	0.25	—
H	0.000	0.004	0.00	0.10
J	—	0.006	—	0.15
K	0.140	0.152	3.55	3.85

- STYLE 1:
 PIN 1. CATHODE
 2. ANODE

**CASE 425-04
 (SOD-123)
 ISSUE C**

PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)



Recommended screw torque: 1.3 ± 0.2 Nm
 Maximum screw torque: 1.5 Nm

STYLE 1:
 PIN 3. SOURCE
 4. GATE
 5. DRAIN
 6. SOURCE 2

STYLE 2:
 PIN 1. CATHODE 1
 2. ANODE 1
 3. ANODE 2
 4. CATHODE 2

STYLE 3:
 PIN 1. CATHODE 1
 2. ANODE 2
 3. CATHODE 2
 4. ANODE 1

NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETERS.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	31.50	31.70	1.240	1.248
B	7.80	8.20	0.307	0.322
C	4.10	4.30	0.161	0.169
D	14.90	15.10	0.586	0.590
E	30.10	30.30	1.185	1.193
F	38.00	38.20	1.496	1.503
G	4.00	—	0.157	—
H	11.80	12.20	0.464	0.480
L	8.90	9.10	0.350	0.358
M	12.60	12.80	0.496	0.503
N	25.20	25.40	0.992	1.000
P	1.95	2.05	0.076	0.080
Q	4.10	—	0.157	—
R	0.75	0.85	0.030	0.033
S	5.50	—	0.217	—

SOT-227B

Section 10

AR598: Avalanche Capability of Today's Power Semiconductors

AVALANCHE CAPABILITY OF TODAY'S POWER SEMICONDUCTORS

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Abstract. Power semiconductors are used to switch high currents in fractions of a second and therefore belong inherently to a world of voltage spikes. To avoid unnecessary breakdown voltage guardbands, new generations of semiconductors are now avalanche rugged and characterized in avalanche energy.

This characterization is often far from application conditions and thus quite useless to the designer. It is easy to verify that an energy rating is not the best approach to a ruggedness quantification because of avalanche energy fluctuations with test conditions.

A physical and thermal analysis of the failure mechanisms leads to a new characterization method generating easy-to-use data for safe designs. The short-term avalanche capability will be discussed with an insight of the different technologies developed to meet these new ruggedness requirements.

Keywords. Avalanche, breakdown, unclamped inductive switching energy, safe operating areas.

INTRODUCTION

One obvious trend for new power electronic designs is to work at very high switching frequencies in order to reduce the volume and weight of all the capacitive and inductive elements. The consequence is that most applications today require switching very high currents in fractions of a microsecond and therefore generate $L \times di/dt$ voltage spikes due to parasitic inductance. Unfortunately these undesirable voltage levels sometimes reach the breakdown voltage of power semiconductors that are not intended to be used in avalanche.

The necessity for avalanche rugged power semiconductors has clearly been perceived by many semiconductor manufacturers who have come up with avalanche-energy rated devices.

This paper will show the limits of an energy-based characterization model. It will concentrate on three different devices: Ultra Fast recovery Rectifiers, Schottky Barrier Rectifiers and MOSFETs. It will study their main failure mechanisms and show the technological improvements that guarantee an enhanced ruggedness.

This will lead to a new characterization that will help the designer choose correctly between overall cost and reliability.

LIMITS OF AN AVALANCHE ENERGY CHARACTERIZATION

Practically all the characterizations are based on the following Unclamped Inductive Switching (UIS) test circuit (fig 1) :

Figure 1. Standard UIS Characterization Circuit.

The energy is first stored in inductor L by turning on transistor Q for a period of time proportional to the peak current desired in the inductor. When Q is turned off, the inductor reverses its voltage and avalanches the Device Under Test until all its energy is transferred. The DUT can be a rectifier or a MOSFET (the gate should always be shorted to the source).

The standard characterization method consists in increasing the peak current in the inductor until the device fails. The energy that the device can sustain without failing becomes a figure of merit of the ruggedness to avalanche :

$$W_{aval} = 1/2 L I_{peak}^2 BV(DUT) / (BV(DUT) - V_{CC}) \quad [1]$$

The main limit of this method is that the energy level that causes a failure in the DUT is not a constant but a function of L and V_{cc}. This results of the fact that the avalanche duration is function of the current decay slope $(BV(DUT) - V_{CC})/L$:

Table 1. Peak Current and Energy Causing Failures in a 1A, 1000V Ultra Fast Recovery Rectifier.

Inductor Value :	10mH	50mH	100mH
Peak Current :	1.7A	0.9A	0.8A
Energy :	14mJ	20mJ	32mJ

Table 1 indicates that the failure is not caused by an energy (i.e. it is not independent of the avalanche duration) but rather by a current level that has to be derated versus time : the devices can sustain a low current for a long period of time (high energy) but at high avalanche currents they will fail after a few microseconds (low energy).

Therefore, unless the designer has a parasitic inductance of value L in his circuit, the standard characterization data will be useless, or worse, it might lead to an overestimate of the ruggedness of his application : because parasitic inductances are often an order of magnitude less than the test circuit inductance, the expected energy capability leads to excessive current levels.

The UIS test circuit is very easy to implement : the only important point is that the transistor has to have a breakdown voltage higher than the DUT. For low breakdown voltage devices, a MOSFET might be preferred to the bipolar transistor.

The advantages of using a MOSFET are multiple : it is a more rugged device, it is much easier to drive and its switching characteristics can be controlled by adding a resistor in series with the gate. It is mandatory to limit this switching speed to avoid having an avalanche energy measurement dependent on the gate drive (i.e. gate resistor and gate to source voltage values).

Anyhow, it is possible to generate very useful information with this UIS test circuit by varying the inductor value. It is also very important to present the data independently of the values of V_{cc} and L . One solution can be to plot the maximum peak current versus the avalanche duration (fig 2) :

Figure 2. Maximum Peak Current versus Avalanche Duration for a 15A, 60V MOSFET in an UIS Test Circuit.

The advantage of this new graph is that the designer can easily calculate the safety margin of his application and he will not be misled by an energy value that depends on too many different parameters. If he knows the value of the parasitic inductance in his circuit he will be able to determine its maximum peak current.

For instance, let us assume that the designer uses the 15A, 60V MOSFET characterized in figure 2. This device sustains 500mJ with an inductor of 75mH according to equation [1]. Its typical breakdown voltage is 80V.

If the supply voltage V_{dd} is 12V and the parasitic inductance L is 250 μ H, then the avalanche duration and maximum peak current are related by

$$I_{peak} = t (BV_{DSS} - V_{DD}) / L \quad [2]$$

This relationship can be added to figure 2 (see fig 3) :

Figure 3. figure 2 + equation [2].

Thus the maximum peak current that can flow through the parasitic inductance L is approximately 28A instead of 58A that would have resulted of using equation [1].

UNDERSTANDING THE FAILURE MECHANISMS

Physical Approach

The following microscope photographs show the failure locations for an Ultra Fast Recovery Rectifier (UFR), a Schottky Barrier Rectifier (SBR) and a MOSFET :

Figure 4. 4A, 1000V UFR Avalanche Failure.

and becomes visible in the forward characteristic of the diode. Finally, when the punchthrough reaches considerable dimensions, the device looks very similar to a low value resistor.

The failure does not always appear in the same region of the die. For instance, high voltage UFRs have their punchthrough always located in a corner, MOSFETs often fail in the corners or on the sides whereas SBRs have randomly located failures.

Thermal Approach

Transient thermal response graphs generated by a standard ΔV_{DS} method show the junction temperature evolution for forward and avalanche constant current conduction in a MOSFET. These graphs (fig 7) prove that the silicon efficiency during avalanche and forward currents are similar.

Figure 5. 25A, 35V SBR Avalanche Failure.

Figure 7. 15A, 60V MOSFET Transient Thermal Response for 800W, 400W, 200W Avalanche and 600W Forward Conduction.

Figure 7 can be used to generate a transient thermal resistance graph by plotting the temperature divided by the power : the four graphs should then normally match. Some slight differences show that the transient thermal resistance increases with the current level : i.e. the 800W curve (10A constant avalanche current) has a higher transient thermal resistance than the 200W (2.5A). Therefore the thermal efficiency in a MOSFET is not perfectly homogeneous versus the avalanche current.

A similar analysis on an UFR or an SBR shows poor thermal efficiency in avalanche. This can be shown by comparing the temperature rise after 1ms for forward and avalanche conduction pulses of same power (400W) :

MOSFET	$\Delta T_{direct}=160^{\circ}\text{C}$	$\Delta T_{avalanche}=180^{\circ}\text{C}$	ratio=0.9
UFR	$\Delta T_{direct}=120^{\circ}\text{C}$	$\Delta T_{avalanche}=175^{\circ}\text{C}$	ratio=0.7
SBR	$\Delta T_{direct}=100^{\circ}\text{C}$	$\Delta T_{avalanche}=150^{\circ}\text{C}$	ratio=0.7

Electrical Approach

Considering the transient thermal responses of a device, it is possible to simulate the instantaneous junction temperature for any sort of power pulse.

Figure 6. 20A, 500V MOSFET Avalanche Failure.

These photographs show that the failure is generally a punchthrough. The melt-through hole dimensions depend on the current level and avalanche duration.

A close look at the electrical characteristics of failed rectifiers on a curve tracer show three levels of degradation : low stressed diodes have a normal forward characteristic but show an unusual leakage current before entering breakdown as if they had a high-value resistor in parallel : this resistance can be explained by a small punchthrough. For medium degradation levels, the value of this pseudo-resistance decreases

Conducting this simulation on the data generated by the UIS test it is possible to show that all the parts fail when they reach a “critical temperature” (fig 8) :

Figure 8. 15A, 60V MOSFET Failure Points and Critical Temperature for different Inductor Values.

At these critical temperatures the intrinsic carrier concentration, n_i , reaches levels close to those of the doping concentrations :

$$n_i \text{ is proportional to } T^{3/2} e^{-E_g / 2kT} \quad [3]$$

where T is the absolute temperature, E_g the energy bandgap and k is Boltzmann’s constant.

At 200°C, n_i exceeds $2 \cdot 10^{14} \text{ cm}^{-3}$ which corresponds to a 1000V material epitaxy concentration level. This means that when the junction temperature reaches 300°C, the rectifier looks more like a resistor than a diode. A local thermal runaway then generates a hot spot and a punchthrough as can be seen in figures 4, 5 and 6.

This failure analysis has shown that the failure mechanism is essentially thermal : the devices are heated by the $BV_R \times I_R$ power dissipation. Unfortunately, this power does not remain constant because the UIS circuit generates a linear current decay and also the breakdown voltage varies with the current level and with the junction temperature.

In order to have a complete characterization of the device it is interesting to see how it reacts to a constant avalanche current and different ambient temperatures.

NEW CHARACTERIZATION METHOD PROPOSAL

During the prototype phase, it is easier for the designer to measure the avalanche current and duration than the circuit’s parasitic inductance. Therefore, the characterization should be based on easy to measure parameters. The failure analysis proves that the main cause of degradation is the inability to handle an excessive power (avalanche current I_R multiplied by breakdown voltage BV_R). A proper characterization should present the maximum power capability versus time.

As the avalanche voltage varies only slightly with the current level, the proposed method is based on avalanching a

device at a constant current and presenting the maximum current capability versus time :

Figure 9. Constant Current Characterization Circuit.

Different test circuits similar to figure 9 have been proposed by Gauen (1) and Pshaenich (2). Some unexpected failures in MOSFETs suggest that the DUT should always be referenced to ground. Unlike UFRs and SBRs, MOSFETs react differently whether they are tied to ground or floating around a fluctuating voltage. Many floating transistors fail at very low stress levels probably due to capacitive coupled currents that turn-on the internal parasitic transistor.

The test circuit shown in figure 9 sets a constant avalanche current through the device until it fails, this duration can then be plotted for different current levels. This generates a graph similar to the UIS method, except that the current is constant instead of decreasing linearly.

This leads to the definition of a “Safe Avalanching Area” (fig 10) that will guarantee a short-term reliability if the device is used within this clearly defined area.

Figure 10. 1A, 30V SBR Safe Avalanching Area.

This graph gives the maximum avalanche duration for any value of avalanche current.

The Safe Avalanching Area is generated by taking a safety margin from the failure points. Another approach would be to dynamically measure the temperature as in figure 7 and generate an area defined by a maximum allowable junction temperature.

As the failure mechanism is related to a peak junction temperature, it is necessary to give Safe Avalanching Areas for different ambient temperatures (fig 11) :

Figure 11. 25A, 35V SBR Safe Avalanching Areas for different ambient temperatures.

When the data in figures 10 and 11 is plotted on log/log axes instead of lin/log or lin/lin, an interesting feature appears (fig 12) :

Figure 12. figure 12 on log/log axes.

Figure 12 shows a linear relationship between current and time on a log/log plot. This means that :

$$\begin{aligned} \text{so} \quad \log(I_R) &= A \log(t) + B, \\ I_R &= k T^A \end{aligned} \quad [4]$$

where k is a constant function of the die size, the breakdown voltage and other parameters. Constant A can be extracted from figure 12 and similar figures for UFRs and MOSFETs :

$$I_R = k T^{-0.55} \quad [5]$$

Relation [5] is a consequence of heat propagation laws which explain that the temperature in a semiconductor rises proportionally to $t^{0.5}$ (for a constant current pulse and as long as the temperature remains within the silicon die). This can be seen in any transient thermal resistance graph.

A standard thermal calculation shows that :

$$\begin{aligned} T_J &= T_A + P_D R_{thJA}(t), \\ \text{or} \quad P_D &= (T_J - T_A) / R_{thJA}(t) \end{aligned} \quad [6]$$

where :

T_J, T_A are the junction and ambient temperatures,
 P_D is the power dissipation,
 $R_{thJA}(t)$ is the transient thermal resistance.

Given a constant power pulse and for values of t less than 1ms, [6] is equivalent to :

$$\begin{aligned} I_R BVR &= (T_J - T_A) / (k t^{0.5}) \\ \text{so} \quad I_R &= k t^{-0.5} \end{aligned} \quad [7]$$

This relation is similar to [5]. For avalanche durations of less than 500 μ s the heat propagates within the silicon only. For longer durations the heat reaches the solder and the package so the propagation characteristics are modified . The devices heat faster or slower and therefore the $I_R=f(t)$ slope changes. Empirical data shows that A in relation [4] remains within -0.5 to -0.6.

Relation [7] can also be expressed by :

$$I_R^2 t = k \quad (k:\text{constant}) \quad [7\text{bis}]$$

This rule of thumb works out much better than the, unfortunately too common, $1/2 L I^2$ law.

For example, when applied to the example following figure 2 (which is UIS and not Constant Current generated) to determine the maximum peak current in a 250 μ H inductor and by choosing for instance the 9A,500 μ s point, relation [7bis] can be written :

$$9A^2 500\mu s = I_{\text{peak}}^2 100\mu s$$

This gives a conservative value of 20A instead of a real value of 28A whereas the $1/2 L I^2$ method generates a catastrophic 58A value.

TECHNOLOGY TRADEOFFS

Ultra Fast Recovery Rectifiers

The UFR devices are based on a Mesa technology (fig 13) with a Phosphorus doped (n-type) substrate. The heavily doped N+ substrate is followed by a lighter N- epitaxial layer. The P+ is diffused into the epitaxy to form the P-N junction. The passivation follows the perimeter of the die.

Figure 13. UFR Technology, Profile and Electric Field.

The epitaxy characteristics determine the major electrical parameters of the device. A designed experiment was conducted varying the epitaxy thickness and resistivity. The output responses were the forward voltage, the breakdown voltage, the leakage current and the avalanche capability. A wide range of epitaxy materials was chosen to determine the general trends for all the effects.

Although the results were predictable for the static parameters, the avalanche capability results were not.

A key issue is the electric field extension. If it terminates before the substrate the avalanche capability increases by increasing the epitaxy resistivity. If the field extends into the N+ region (reach-through) the avalanche capability is considerably reduced.

The avalanche capability is proportional to the die size and not to the perimeter. This confirms that the avalanche current is vertical and not only a surface or passivation related phenomenon.

The failures always occur in the corners where the electric field is most critical. These failures are essentially function of the thermal characteristics of the device when conducting avalanche currents. Therefore the avalanche capability decreases when the ambient temperature increases and the failures can normally be predicted by Safe Avalanche Areas such as figure 12.

Some unexpected defects though can radically degrade the avalanche capability. Defects in the epi such as pipes cause premature failures but can often be screened by a leakage current test that eliminates soft breakdown devices. Defects in the passivation can generate parasitic oscillations during breakdown.

Schottky Rectifiers

Due to P-N junction guard rings, SBR devices are very similar to UFRs when conducting avalanche currents. These rectifiers have very low breakdown voltages and therefore very thin epitaxy layers. This probably explains that the avalanche-related failures occur anywhere on the die surface : the thin N- region is relatively more heterogeneous with respect to avalanche capability and thermal dissipation than a thick UFR epitaxy.

Figure 14. SBR Technology with P-N Guard Rings

MOSFETs

MOSFETs can also be compared to UFRs as long as the internal parasitic bipolar transistor (due to the P-tub) does not turn-on. The latest MOSFET generations reduce the P-resistance to avoid biasing this NPN.

While analyzing different constant current test circuits, it appeared that devices used in a floating configuration can have very poor avalanche capabilities.

Due to their cellular technology, MOSFETs conduct very efficiently avalanche currents. They can sustain avalanche power levels close to those of forward conduction ratings.

CONCLUSION

The necessity of characterizing the avalanche capability of power semiconductors has been explained. An analysis of the standard UIS test circuit has shown the limits of a characterization based on energy ratings. Throughout a discussion of the main failure mechanisms, a new thermal approach has been proposed to help designers set safety levels in their designs. This paper sets new standards for characterizing avalanche ruggedness.

Acknowledgements

The authors would like to thank Jean-Michel REYNES, design engineer at MOTOROLA Toulouse, for his help in understanding the failure mechanisms.

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